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H8/3857 Group, H8/3857 F-ZTAT™, H8/3854 Group, H8/3854 F-ZTAT™ Hardware Manual Renesas 8-Bit Single-Chip

Microcomputer
H8 Family/H8/300L Series

H8/3857 HD6433857, HCD6433857 HD6433856, HCD6433856 H8/3856 HD6433855, HCD6433855 H8/3855 H8/3857 F-ZTAT™ HD64F3857, HCD64F3857 HD6433854, HCD6433854 H8/3854 H8/3853 HD6433853, HCD6433853 H8/3852 HD6433852, HCD6433852 HD64F3854, HCD64F3854 H8/3854 F-ZTAT™

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions may occur due to the false recognition of the pin state as an input signal. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

— The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

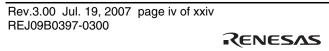
— When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.

— The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.





Preface

The H8/300L Series of single-chip microcomputers has the high-speed H8/300L CPU at its core, with many necessary peripheral functions on-chip. The H8/300L CPU instruction set is compatible with the H8/300 CPU.

The H8/3857 Group has the following on-chip peripheral functions required for system configuration: a maximum 1,280-dot display LCD controller, four types of timers, a 14-bit PWM, a 2-channel serial communication interface, and an 8-channel A/D converter.

The H8/3854 Group has the following on-chip peripheral functions required for system configuration: a maximum 640-dot display LCD controller, three types of timers, a single-channel serial communication interface, and a 4-channel A/D converter.

Both series can be used as embedded microcomputers in systems requiring LCD display.

The H8/3857, H8/3856, H8/3855, H8/3854, H8/3853, and H8/3852 are available in mask ROM versions, and the H8/3857 and H8/3854 are also available in an F-ZTAT^{TM*} version which allows programs to be written after the chip is mounted on a board.

Note: * F-ZTAT (Flexible Zero Turn-Around Time) is a trademark of Renesas Technology Corp.

This manual describes the hardware of the H8/3857 Group and H8/3854 Group. For details on the H8/3857 Group and H8/3854 Group instruction set, refer to the H8/300L Series Software Manual.

List of Functions

| Group | | H8/3857 Group | | | | H8/3854 Group | | | |
|----------------------------|----------------------|--|---------------|---------------|---------------|---|---------------|---------------|---------------|
| | | F-ZTAT Version | Mask RO | OM Versio | on | F-ZTAT Version | Mask RO | OM Versio | on |
| Part No. | | H8/3857F | H8/3857 | H8/3856 | H8/3855 | H8/3854F | H8/3854 | H8/3853 | H8/3852 |
| ROM size | (kbytes) | 60 | 60 | 48 | 40 | 60* | 32* | 24 | 16 |
| RAM size (| (kbytes) | 2 | 2 | 2 | 2 | 2* | 1* | 1* | 1* |
| I/O ports | Input/output ports | 35 | 35 | 35 | 35 | 24 | 24 | 24 | 24 |
| | Input ports | 9 | 9 | 9 | 9 | 5 | 5 | 5 | 5 |
| Interrupts | External interrupts | 13 sources | 13 sources | 13 sources | 13 sources | 12 sources | 12 sources | 12 sources | 12 sources |
| | Internal interrupts | 16 sources | 16 sources | 16 sources | 16 sources | 14 sources | 14 sources | 14 sources | 14 sources |
| Timer A (fo | or realtime | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Timer B (8 bits) | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Timer C (8 bits) | | 0 | 0 | 0 | 0 | _ | _ | _ | _ |
| Timer F (10 | 6 bits) | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Watchdog | timer | 0 | _ | _ | _ | 0 | _ | _ | _ |
| 14-bit PWN | M | 0 | 0 | 0 | 0 | _ | _ | _ | _ |
| Serial com interface (S | munication SCI) | × 2 | × 2 | × 2 | × 2 | × 1 | × 1 | × 1 | × 1 |
| A/D convei | rter | 8 ch | 8 ch | 8 ch | 8 ch | 4 ch | 4 ch | 4 ch | 4 ch |
| LCD controller | Max. display dots | 1280 dots | 1280 dots | 1280 dots | 1280 dots | 640 dots | 640 dots | 640 dots | 640 dots |
| | Display RAM size | 2048 bits | 2048 bits | 2048 bits | 2048 bits | 640 bits | 640 bits | 640 bits | 640 bits |
| Packages | Pins | 144 | 144 | 144 | 144 | 100 | 100 | 100 | 100 |
| | Shipping form | FP-144H (20 × 20 mm) TFP-144 (16 × 16 mm) Die (F-ZTAT version: 7.08 × 7.31 mm / mask ROM version: 6.21 × 6.21 mm) | | | | FP-100B (14 × 14 mm) TFP-100G (12 × 12 mm) Die (F-ZTAT version: 6.34 × 6.34 mm / mask ROM version: 4.69 × 4.69 mm) | | | |

Note: * Note that the H8/3854F (F-ZTAT version) and H8/3854 (mask ROM version) have different ROM and RAM sizes.

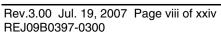
When carrying out program development using the H8/3854F with the intention of mask ROM implementation, care must be taken with ROM and RAM sizes since the maximum sizes for the mask ROM version are 32 kbytes of ROM and 1 kbyte of RAM.



Main Revisions for This Edition

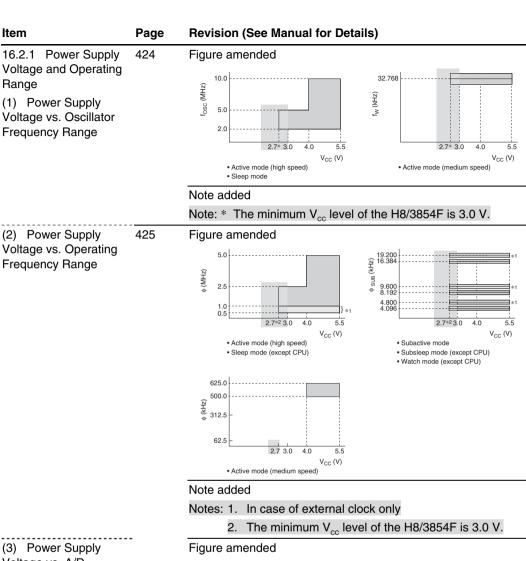
| Item | Page | Revision (See Manual for Details) |
|--|------|--|
| All | | Company name and brand names amended (Before) Hitachi, Ltd. → (After) Renesas Technology Corp. Designation for categories amended (Before) H8/3857 Series → (After) H8/3857 Group (Before) H8/3854 Series → (After) H8/3854 Group |
| 2.2.1 General Registers Figure 2.2 Stack Pointer | 29 | Figure amended Lower address side [H'0000] Unused area Stack area Upper address side [H'FFFF] |
| 4.3 Subclock Generator Table 4.2 DC Characteristics and Timing | 98 | Table condition amended $(V_{cc}=2.7 \text{ V to } 5.5 \text{ V of the mask ROM version of H8/3852,} \\ \text{H8/3853, and H8/3854, } V_{cc}=3.0 \text{ V to } 5.5 \text{ V of H8/3854F and} \\ \text{H8/3857 Group, } \text{AV}_{cc}=3.0 \text{ V to } 5.5 \text{ V, } \text{V}_{ss}=\text{AV}_{ss}=0.0 \text{ V,} \\ \text{T}_a=-20^{\circ}\text{C to } +75^{\circ}\text{C*, unless otherwise specified, including subactive mode)} \\ \hline \text{Table note amended} \\ \text{Note: * The guaranteed temperature as an electrical characteristic for die type products is } 75^{\circ}\text{C}.}$ |
| 6.2.1 Features 6.5.4 Erase-Verify | 120 | Description amended • Programming/erase methods The flash memory is programmed 32 bytes at a time. Erasing is performed in block units. To erase multiple blocks, each block must be erased in turn. In block erasing, 1-kbyte, 28-kbyte, 16-kbyte, and 12-kbyte blocks can be set arbitrarily. Description amended |
| Mode Verily | 110 | After the elapse of the erase time, erase mode is exited (the E bit in FLMCR1 is cleared, then the ESU bit in FLMCR2 is cleared at least (α) μ s later). |

| Item | Page | Revision (See Manual for Details) |
|--|--------------|--|
| 8.3 Port 2 | 182 | Description amended |
| | | The UD function multiplexed with the $P2_1$ pin is provided only in the H8/3857 Group, and not in the H8/3854 Group. |
| 11.3 Operation | 314 | Figure amended |
| Figure 11.2 PWM | | $T_H = t_{H1} + t_{H2} + t_{H3} + \dots t_{H64}$ |
| Output Waveform | | $t_{f1} = t_{f2} = t_{f3} \dots = t_{f64}$ |
| 15.2.2 DC | 409 | Table note amended |
| Characteristics | | Notes: 4. The guaranteed temperature as an electrical |
| Table15.2 DC Characteristics of H8/3855, H8/3856, and H8/3857 (1) | | characteristic for die type products is 75°C. |
| Table15.3 DC | 410 | Table amended |
| Characteristics of H8/3855, H8/3856, and | l | Item Symbol |
| H8/3857 (2) | | Allowable I _{ol} |
| | | output low |
| | | current (per pin) |
| | | Allowable ΣI_{OL} |
| | | output low |
| | | Current (total) Allowable -I _{OH} |
| | | output high |
| | | current |
| | <u></u> A | (per pin) |
| | | Allowable Σ -I _{OH} output high |
| | | current (total) |
| | | Table note amended |
| | | Notes: 2. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |

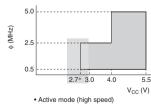




| Item | Page | Revision (See Manual for Details) |
|---|----------|--|
| 15.2.3 AC Characteristics Table15.4 Control Signal Timing of H8/3855, H8/3856, and H8/3857 | 412 | Table note amended Notes: 3. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| Table15.5 Serial Interface (SCI1) Timing of H8/3855, H8/3856, and H8/3857 | 413 | Table note amended Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| Table15.6 Serial Interface (SCI3) Timing of H8/3855, H8/3856, and H8/3857 | 414 | Table note amended Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| 15.2.4 A/D Converter Characteristics Table15.7 A/D Converter Characteristics of H8/3855, H8/3856, and H8/3857 | 415 | Table note amended Notes: 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| 15.2.5 LCD Characteristics Table15.8 LCD Characteristics of H8/3855, H8/3856, and H8/3857 | 416 | Table note amended Notes: 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| Table15.9 Step-Up Circuit Characteristics of H8/3855, H8/3856, and H8/3857 | 417 f | Table note amended Notes: 2. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| 15.4 Output Load Circuit Figure 15.10 Output Load Conditions | 422 | Figure amended $\begin{array}{c} v_{CC} \\ & \geq 2.4 \ k\Omega \\ \\ LSI \ Chip \ Output \ pin \\ \hline \\ & = 12 \ k\Omega \\ \\ \end{array}$ |



(3) Power Supply Voltage vs. A/D Converter Operating Range



2.7 3.0 · Active mode (medium speed)

V_{CC} (V)

500.0 (KHZ)

312.5

Sleep mode

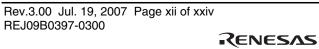
Note added

Note: * The minimum V_{cc} level of the H8/3854F is 3.0 V.



| Item | Page | Revision (See Manual for Details) |
|---|------|---|
| 16.2.2 DC Characteristics Table 16.2 DC Characteristics of H8/3852, H8/3853, and H8/3854 (1) | 426 | Table condition amended $V_{cc} = 2.7 \text{ V to } 5.5 \text{ V of the mask ROM version of H8/3852,}$ H8/3853, and H8/3854, $V_{cc} = 3.0 \text{ V to } 5.5 \text{ V of H8/3854F,}$ $V_{ss} = 0.0 \text{ V, } T_a = -20^{\circ}\text{C to } +75^{\circ}\text{C*}^4$, including subactive mode, unless otherwise specified. Table note amended Notes: 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| Table 16.3 DC Characteristics of H8/3852, H8/3853, and H8/3854 (2) | 430 | Table condition amended $V_{cc} = 2.7 \text{ V to } 5.5 \text{ V of the mask ROM version of H8/3852,} \\ \text{H8/3853, and H8/3854, } V_{cc} = 3.0 \text{ V to } 5.5 \text{ V of H8/3854F,} \\ V_{ss} = 0.0 \text{ V, } T_a = -20^{\circ}\text{C to } +75^{\circ}\text{C*}^2, \text{ including subactive mode,} \\ \text{unless otherwise specified.}$ |
| | | Table amended |
| | | Item Symbol Allowable I _{oL} output low current (per pin) Allowable Σ I _{oL} |
| | | output low current (total) Allowable -I _{OH} |
| | | output high current (per pin) |
| | | Allowable Σ -I _{OH} output high current (total) |
| | | Table note amended Notes: 2. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |

| Item | Page | Revision (See Manual for Details) |
|---|------|--|
| 16.2.3 AC | 431 | Description amended |
| Characteristics | | Table 16.4 shows the control signal timing, and table 16.5 shows the serial interface timing, of the H8/3852, H8/3853, and H8/3854. |
| Table 16.4 Control | - | Table condition amended |
| Signal Timing of H8/3852, H8/3853, and H8/3854 | | $V_{cc}=2.7$ V to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, $V_cC=3.0$ V to 5.5 V of H8/3854F, $V_{ss}=0.0$ V, $T_a=-20^{\circ}C$ to $+75^{\circ}C^{*3}$, including subactive mode, unless otherwise specified. |
| | 432 | Table note amended |
| | | Notes: 3. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| Table 16.5 Serial | 433 | Table condition amended |
| Interface (SCI3) Timing of H8/3852, H8/3853, and H8/3854 | | $\begin{split} &V_{\text{cc}}=2.7\text{ V to }5.5\text{ V of the mask ROM version of H8/3852,}\\ &\text{H8/3853, and H8/3854, }V_{\text{cc}}=3.0\text{ V to }5.5\text{ V of H8/3854F,}\\ &V_{\text{ss}}=0.0\text{ V, }T_{\text{a}}=-20^{\circ}\text{C to }+75^{\circ}\text{C*, unless otherwise specified.} \end{split}$ |
| | | Table note amended |
| | | Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| 16.2.4 A/D Converter | 434 | Table condition amended |
| Characteristics Table 16.6 A/D Converter Characteristics of | | $\begin{split} &V_{\rm cc}=2.7~V~to~5.5~V~of~the~mask~ROM~version~of~H8/3852,\\ &H8/3853,~and~H8/3854,~V_{\rm cc}=3.0~V~to~5.5~V~of~H8/3854F,\\ &V_{\rm ss}=0.0~V,~T_{\rm a}=-20^{\circ}C~to~+75^{\circ}C^{*},~unless~otherwise~specified. \end{split}$ |
| H8/3852, H8/3853, and | | Table note amended |
| H8/3854 | | Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C. |
| 16.2.5 LCD | 435 | Table condition amended |
| Characteristics Table 16.7 LCD Characteristics of H8/3852, H8/3853, and H8/3854 | | $\rm V_{cc}=2.7~V$ to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, $\rm V_{cc}=3.0~V$ to 5.5 V of H8/3854F, $\rm V_{ss}=0.0~V, T_a=-20^{\circ}C$ to $+75^{\circ}C^{*^2},$ including subactive mode, unless otherwise specified. |
| 1 10/0004 | | Table note amended |
| | | Notes: 2. The guaranteed temperature as an electrical characteristic for die type products is 75°C. |



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| register 2 | | 1 Functions as \overline{IRQ}_0 input pin |



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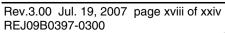
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Section 1 Overview

1.1 Overview

The H8/300L Series is a series of single-chip microcomputers (MCU: microcomputer unit), built around the high-speed H8/300L CPU and equipped with peripheral system functions on-chip.

Within the H8/300L Series, the H8/3857 Group and H8/3854 Group feature on-chip liquid crystal display (LCD) controllers. Other on-chip peripheral functions include a LCD controller, timers, serial communication interface, and an analog-to-digital (A/D) converter. Together these functions make the H8/3857 Group and H8/3854 Group ideally suited for embedded control of systems requiring an LCD display.

The H8/3857 Group comprises the H8/3855, with 40 kbytes of ROM and 2 kbytes of RAM onchip, the H8/3856, with 48 kbytes of ROM and 2 kbytes of RAM, and the H8/3857, with 60 kbytes of ROM and 2 kbytes of RAM. H8/3854 Group mask ROM versions are the H8/3852, with 16 kbytes of ROM and 1 kbyte of RAM on-chip, the H8/3853, with 24 kbytes of ROM and 1 kbyte of RAM, and the H8/3854, with 32 kbytes of ROM and 1 kbyte of RAM.

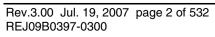
Two F-ZTAT versions—the H8/3857F and H8/3854F—are also available, with user-programmable on-chip flash ROM. These models have 60 kbytes of ROM and 2 kbytes of RAM.

Note that the H8/3854 mask ROM and F-ZTAT versions have different ROM and RAM sizes.

Table 1.1 summarizes the features of the H8/3857 Group and H8/3854 Group.

Table 1.1 Features

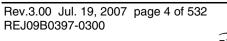
| Item | Description | | |
|------------------------|---|--|--|
| CPU | High-speed H8/300L CPU | | |
| | General-register architecture | | |
| | General registers: Sixteen 8-bit registers (can be used as eight 16-bit registers) | | |
| | Operating speed | | |
| | Max. operating speed: 5 MHz | | |
| | — Add/subtract: 0.4 μs (operating at 5 MHz) | | |
| | — Multiply/divide: 2.8 μs (operating at 5 MHz) | | |
| | Can run on 32.768 kHz subclock | | |
| | Instruction set compatible with H8/300 CPU | | |
| | Instruction length of 2 bytes or 4 bytes | | |
| | Basic arithmetic operations between registers | | |
| | MOV instruction for data transfer between memory and registers | | |
| | Typical instructions | | |
| | Multiply (8 bits × 8 bits) | | |
| | • Divide (16 bits ÷ 8 bits) | | |
| | Bit accumulator | | |
| | Register-indirect designation of bit position | | |
| Interrupts | H8/3857 Group: 29 interrupt sources | | |
| | 13 external interrupt sources: IRQ₄ to IRQ₀, WKP₇ to WKP₀ | | |
| | 16 internal interrupt sources | | |
| | H8/3854 Group: 26 interrupt sources | | |
| | • 12 external interrupt sources: IRQ ₄ , IRQ ₃ , IRQ ₁ , IRQ ₀ , WKP ₇ to WKP ₀ | | |
| | 14 internal interrupt sources | | |
| Clock pulse generators | Two on-chip clock pulse generators | | |
| | System clock pulse generator: 1 to 10 MHz | | |
| | Subclock pulse generator: 32.768 kHz | | |
| Power-down modes | Six power-down modes | | |
| | Sleep mode | | |
| | Standby mode | | |
| | Watch mode | | |
| | Subsleep mode | | |
| | Subactive mode | | |
| | Active (medium-speed) mode | | |





| Item | Description |
|-----------|---|
| Memory | H8/3857 Group |
| | H8/3855: 40-kbyte ROM, 2-kbyte RAM |
| | H8/3856: 48-kbyte ROM, 2-kbyte RAM |
| | H8/3857: 60-kbyte ROM, 2-kbyte RAM |
| | H8/3857F: 60-kbyte ROM, 2-kbyte RAM |
| | H8/3854 Group |
| | H8/3852: 16-kbyte ROM, 1-kbyte RAM |
| | H8/3853: 24-kbyte ROM, 1-kbyte RAM |
| | H8/3854: 32-kbyte ROM, 1-kbyte RAM |
| | H8/3854F: 60-kbyte ROM, 2-kbyte RAM |
| | Note that the H8/3854 (mask ROM version) and H8/3854F (F-ZTAT version) have different ROM and RAM sizes. |
| I/O ports | H8/3857 Group: 44 I/O port pins |
| | • I/O pins: 35 |
| | Input pins: 9 |
| | H8/3854 Group: 29 I/O port pins |
| | • I/O pins: 24 |
| | Input pins: 5 |
| Timers | Four on-chip timers (three in the H8/3854 Group) |
| | Timer A: 8-bit timer |
| | Count-up timer with selection of eight internal clock signals divided from the system clock (φ)*¹ and four clock signals divided from the watch clock (φ_w)*¹ Timer B: 8-bit timer |
| | Count-up timer with selection of seven internal clock signals or event input from external pin |
| | — Auto-reloading |
| | Timer C: 8-bit timer (in H8/3857 Group only) Count-up/count-down timer with selection of seven internal clock signals or event input from external pin |
| | — Auto-reloading |
| | Timer F: 16-bit timer |
| | Can be used as two independent 8-bit timers. |
| | Count-up timer with selection of four internal clock signals or ovent input from external pin |
| | event input from external pin |
| | Compare-match function with toggle output |

| Item | Description | | |
|-------------------------|---|--|--|
| Serial communication | H8/3857 Group: Two channels on chip | | |
| interface | SCI1: synchronous serial interface | | |
| | Choice of 8-bit or 16-bit data transfer | | |
| | SCI3: 8-bit synchronous or asynchronous serial interface | | |
| | Built-in function for multiprocessor communication | | |
| | H8/3854 Group: One channel on chip | | |
| | SCI3: 8-bit synchronous or asynchronous serial interface | | |
| | Built-in function for multiprocessor communication | | |
| 14-bit PWM | Pulse-division PWM output for reduced ripple | | |
| (in H8/3857 Group only) | Can be used as a 14-bit D/A converter by connecting to an external low-pass filter. | | |
| A/D converter | H8/3857 Group | | |
| | Successive approximations using a resistance ladder resolution: 8 bits | | |
| | 8-channel analog input port | | |
| | Conversion time: 31/φ or 62/φ per channel | | |
| | H8/3854 Group | | |
| | Successive approximations using a resistance ladder resolution: 8 bits | | |
| | 4-channel analog input port | | |
| | Conversion time: 31/φ or 62/φ per channel | | |
| LCD controller | H8/3857 Group: Up to 64 segment pins and 32 common pins | | |
| | • Choice of three duty cycles (1/8, 1/16, 1/32) | | |
| | With 1/8 duty selected: 64 SEG \times 8 COM, 40 SEG \times 8 COM | | |
| | With 1/16 duty selected: 56 SEG \times 16 COM, 40 SEG \times 16 COM | | |
| | With 1/32 duty selected: 40 SEG \times 32 COM | | |
| | Built-in 2048-bit display data RAM | | |
| | Built-in 2× or 3× LCD step-up circuit | | |
| | Built-in contrast control circuit | | |
| | Built-in LCD power supply bleeder resistance and voltage follower op- amp circuits | | |
| | H8/3854 Group: 40 segment pins and up to 16 common pins | | |
| | • Choice of two duty cycles (1/8, 1/16) | | |
| | With 1/8 duty selected: $40 \text{ SEG} \times 8 \text{ COM}$ | | |
| | With 1/16 duty selected: 40 SEG × 16 COM | | |
| | Built-in 640-bit display data RAM | | |
| | Built-in LCD power supply bleeder resistance | | |





Item

Description

Product lineup

H8/3857 Group

Part No.

| Mask ROM Version | F-ZTAT Version | – Package | ROM/RAM Size |
|---------------------|-------------------|------------------------|-----------------|
| HD6433855FQ | _ | 144-pin QFP (FP-144H) | ROM: 40 kbytes |
| HD6433855TG | _ | 144-pin TQFP (TFP-144) | RAM: 2 kbytes |
| HCD6433855 | _ | Die | _ |
| HD6433856FQ | _ | 144-pin QFP (FP-144H) | ROM: 48 kbytes |
| HD6433856TG | _ | 144-pin TQFP (TFP-144) | RAM: 2 kbytes |
| HCD6433856 | _ | Die | _ |
| HD6433857FQ | HD64F3857FQ | 144-pin QFP (FP-144H) | ROM: 60 kbytes |
| HD6433857TG | HD64F3857TG | 144-pin TQFP (TFP-144) | RAM: 2 kbytes |
| HCD6433857 | HCD64F3857 | Die | _ |

H8/3854 Group

Part No.

| | | _ | |
|-----------------------------------|-------------------|-------------------------|-----------------|
| Mask ROM Version* ² | F-ZTAT Version | Package | ROM/RAM Size |
| HD6433852H | _ | 100-pin QFP (FP-100B) | ROM: 16 kbytes |
| HD6433852W | _ | 100-pin TQFP (TFP-100G) | RAM: 1 kbyte |
| HCD6433852 | _ | Die | - |
| HD6433853H | _ | 100-pin QFP (FP-100B) | ROM: 24 kbytes |
| HD6433853W | _ | 100-pin TQFP (TFP-100G) | RAM: 1 kbyte |
| HCD6433853 | _ | Die | - |
| HD6433854H | _ | 100-pin QFP (FP-100B) | ROM: 32 kbytes |
| HD6433854W | _ | 100-pin TQFP (TFP-100G) | RAM: 1 kbyte |
| HCD6433854 | _ | Die | - |
| _ | HD64F3854H | 100-pin QFP (FP-100B) | ROM: 60 kbytes |
| _ | HD64F3854W | 100-pin TQFP (TFP-100G) | RAM: 2 kbytes |
| _ | HCD64F3854 | Die | - |
| | | | |

Notes: 1. ϕ and ϕ_w are defined in section 4, Clock Pulse Generators.

2. Under development

1.2 Internal Block Diagram

Figures 1.1 and 1.2 show internal block diagrams of the H8/3857 Group and H8/3854 Group.

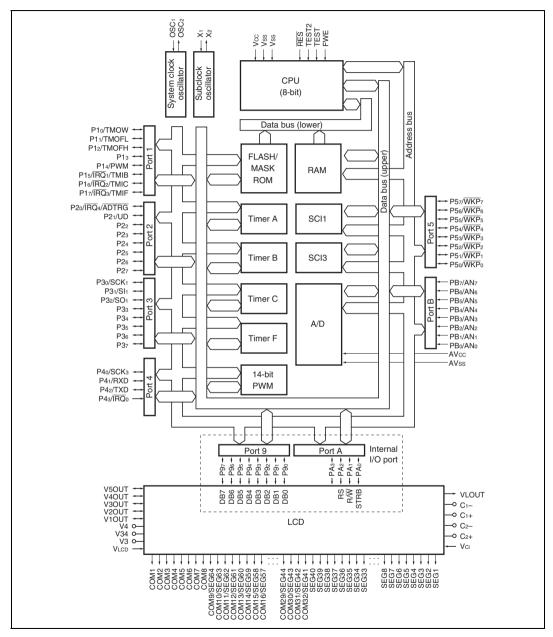


Figure 1.1 H8/3857 Group Internal Block Diagram

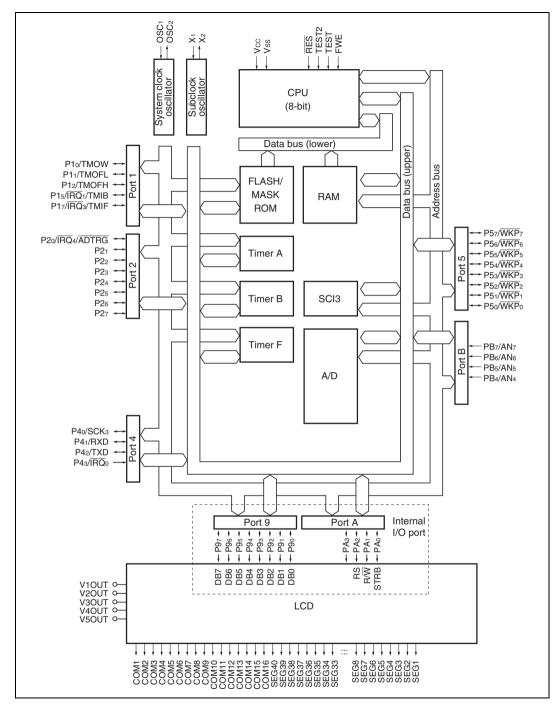


Figure 1.2 H8/3854 Group Internal Block Diagram

1.3 Pin Arrangement and Functions

1.3.1 Pin Arrangement

The pin arrangements of the H8/3857 Group and H8/3854 Group are shown in figures 1.3 and 1.4. The HCD64F3857 pad layout is shown in figure 1.5, and the pad coordinates in table 1.2; the HCD6433855, HCD6433856, and HCD6433857 pad layout is shown in figure 1.6, and the pad coordinates in table 1.3; the HCD64F3854 pad layout is shown in figure 1.7, and the pad coordinates in table 1.4; and the HCD6433852, HCD6433853, and HCD6433854 pad layout is shown in figure 1.8, and the pad coordinates in table 1.5.

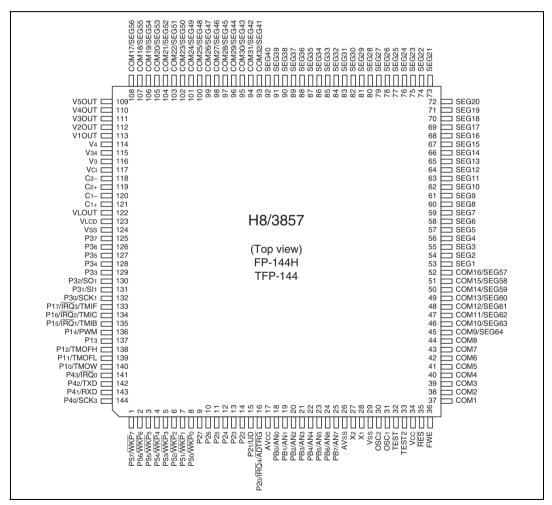


Figure 1.3 H8/3857 Group Pin Arrangement (FP-144H, TFP-144: Top View)

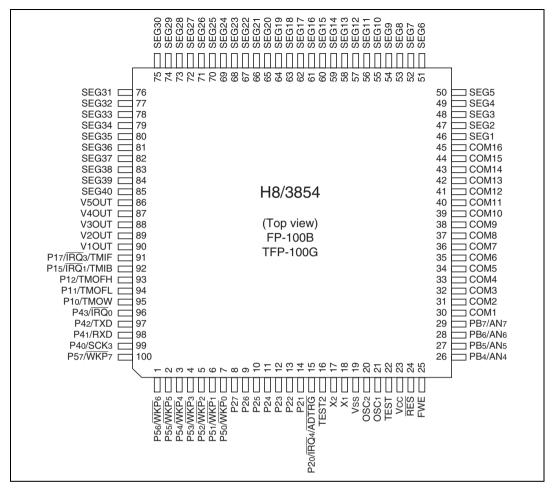


Figure 1.4 H8/3854 Group Pin Arrangement (FP-100B, TFP-100G: Top View)

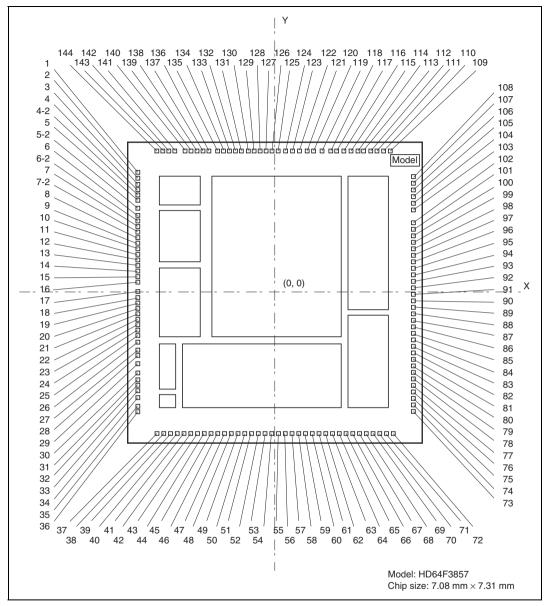


Figure 1.5 Pad Layout of HCD64F3857 (F-ZTAT Version) (Top View)

Table 1.2 HCD64F3857 Pad Coordinates

| No. Pack Name | Pad | | Coord | linates*1 | Pad | | Coord | linates*1 | Pad | | Coord | inates*1 |
|--|-----|--|--------|-----------|-----|-----------------|--------|-----------|-----|-------------|--------|----------|
| Ps_WWR_s | No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) |
| 3 | 1 | P5 ₇ /WKP ₇ | -3348 | 2928 | 32 | TEST | -3348 | -2264 | 67 | SEG15 | 2032 | -3463 |
| 4 P5, WKP₂3348 2506 35 RES3348 - 2794 70 SEG18 2522 - 3463 4.2 NC4*² - 3348 2372 36 FWE - 3348 - 2944 71 SEG19 2686 - 3463 5 P5, WKF₂ - 3348 2288 37 COM1 - 2862 - 3463 72 SEG20 2848 - 3463 5.2 NC3*³3348 1854 39 COM2 - 2700 - 3463 73 SEG21 3348 - 2907 6 P5, WKF₂ - 3348 1854 39 COM3 - 2536 - 3463 74 SEG22 3348 - 2207 6 P5, WKF₂ - 3348 1854 39 COM3 - 2536 - 3463 74 SEG22 3348 - 2207 7 P5, WKF₂ - 3348 1590 41 COM5 - 2210 - 3463 76 SEG21 3348 - 2427 7 P5, WKF₂ - 3348 1590 41 COM5 - 2210 - 3463 76 SEG23 3348 - 2427 7 P5, WKF₂ - 3348 1590 41 COM5 - 2210 - 3463 76 SEG26 3348 - 2427 7 P5, WKF₂ - 3348 1316 43 COM7 - 1884 - 3463 77 SEG25 3348 - 2267 8 P5, WKF₂ - 3348 1316 43 COM7 - 1884 - 3463 78 SEG26 3348 - 2210 9 P2, - 3348 1039 45 COM9/SEG64 - 1556 - 3463 79 SEG27 3348 - 1947 10 P2₂ - 3348 905 46 COM10/SEG63 - 1394 - 3463 81 SEG28 3348 - 1627 11 P2₂ - 3348 905 46 COM10/SEG63 - 1394 - 3463 81 SEG28 3348 - 1627 11 P2₂ - 3348 503 49 COM15/SEG62 - 1231 - 3463 82 SEG30 3348 - 1467 13 P2₂ - 3348 503 49 COM15/SEG60 - 905 - 3463 82 SEG30 3348 - 1467 13 P2₂ - 3348 503 49 COM15/SEG60 - 905 - 3463 83 SEG31 3348 - 1467 13 P2₂ - 3348 503 49 COM15/SEG60 - 905 - 3463 83 SEG31 3348 - 988 16 P2₂/IDD - 3348 369 50 COM14/SEG61 - 1069 - 3463 83 SEG31 3348 - 988 16 P2₂/IDD - 3348 369 50 COM14/SEG60 - 905 - 3463 85 SEG33 3348 - 988 16 P2₂/IDD - 3348 369 50 COM14/SEG50 - 905 - 3463 85 SEG33 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 85 SEG34 3348 - 868 16 P2₂/IRQ /ADTRG - 3348 - 235 51 COM15/SEG58 - 579 - 3463 81 SEG39 3348 - 280 SEG39 | 2 | P5 ₆ /WKP ₆ | -3348 | 2784 | 33 | TEST2 | -3348 | -2404 | 68 | SEG16 | 2196 | -3463 |
| 4-2 NCA*** -3348 2372 36 FWE -3348 -2944 71 SEG19 2686 -3463 5 P5, WKP ₃ -3348 2238 37 COM1 -2862 -3463 72 SEG20 2848 -3463 5-2 NC3*** -3348 2044 38 COM2 -2700 -3463 73 SEG21 3348 -2907 6 P5, WKP ₃ -3348 1854 39 COM3 -2536 -3463 74 SEG22 3348 -2247 6-2 NC2*** -3348 1590 41 COM5 -2210 -3463 75 SEG23 3348 -2267 7-2 NC1*** -3348 1316 42 COM6 -2466 -3463 77 SEG25 3348 -2267 7-2 NC1*** -3348 1131 44 COM6 -1720 -3463 79 SEG26 3348 -2107 10 P2,< | 3 | P5 ₅ /WKP ₅ | -3348 | 2640 | 34 | V _{cc} | -3348 | -2599 | 69 | SEG17 | 2360 | -3463 |
| 5 P5,/WKP ₃ -3348 2238 37 COM1 -2862 -3463 72 SEG20 2848 -9463 5-2 NC3*** -3348 2044 38 COM2 -2700 -3463 73 SEG21 3348 -2907 6 P5,/WKP ₂ -3348 1854 39 COM3 -2536 -3463 74 SEG22 3348 -2747 6c2 NC2*** -3348 1720 40 COM4 -2374 -3463 75 SEG23 3348 -2427 7c NC1*** -3348 1456 42 COM6 -2466 -3463 77 SEG25 3348 -2267 7c NC1*** -3348 1316 43 COM7 -1844 -3463 78 SEG26 3348 -2267 7c NC1**** -3348 1039 45 COM9/SEG64 -1556 -3463 80 SEG28 3348 -17627 11 <td< td=""><td>4</td><td>P5₄/WKP₄</td><td>-3348</td><td>2506</td><td>35</td><td>RES</td><td>-3348</td><td>-2794</td><td>70</td><td>SEG18</td><td>2522</td><td>-3463</td></td<> | 4 | P5 ₄ /WKP ₄ | -3348 | 2506 | 35 | RES | -3348 | -2794 | 70 | SEG18 | 2522 | -3463 |
| 5-2 NC3*² -3348 2044 38 COM2 -2700 -3463 73 SEG21 3348 -2907 6 P5,WKP₂ -3348 1854 39 COM3 -2536 -3463 75 SEG22 3348 -2747 6-2 NC2*² -3348 1720 40 COM4 -2374 -3463 75 SEG23 3348 -2287 7 P5,WKP, -3348 1456 42 COM6 -2046 -3463 76 SEG24 3348 -2287 7-2 NC1*² -3348 1456 42 COM6 -2046 -3463 77 SEG25 3348 -2107 9 P2, -3348 1103 44 COM8 -1720 -3463 80 SEG27 3348 -1947 10 P2, -3348 1039 45 COM9/SEG64 -1556 -3463 81 SEG27 3348 -1487 11 P2, | 4-2 | NC4*2 | -3348 | 2372 | 36 | FWE | -3348 | -2944 | 71 | SEG19 | 2686 | -3463 |
| 6 P5,/WKP ₃ -3348 1854 39 COM3 -2536 -3463 74 SEG22 3348 -2747 6-2 NC2*** -3468 1720 40 COM4 -2374 -3463 75 SEG23 3348 -2587 7 P5,/WKP ₁ -3348 1590 41 COM5 -2210 -3463 76 SEG24 3348 -2267 7-2 NC1*** -3348 1456 42 COM6 -2046 -3463 77 SEG25 3348 -2267 8 P5,/WKP ₀ -3348 1316 43 COM7 -1884 -3463 78 SEG26 3348 -2107 9 P2, -3348 1173 44 COM8 -1720 -3463 79 SEG27 3348 -1947 10 P2, -3348 1039 45 COM9/SEG64 -1556 -3463 80 SEG28 3348 -1627 11 P2, -3348 771 47 COM11/SEG62 -1231 -3463 82 SEG30 3348 -11627 12 P2, -3348 637 48 COM12/SEG61 -1069 -3463 82 SEG30 3348 -11467 13 P2, -3348 637 48 COM12/SEG61 -1069 -3463 84 SEG31 3348 -11467 14 P2, -3348 869 50 COM14/SEG69 -905 -3463 84 SEG31 3348 -1148 15 P2,/UD -3348 369 50 COM14/SEG59 -741 -3463 85 SEG33 3348 -888 16 P2,//////////////////////////////////// | 5 | P5 ₃ /WKP ₃ | -3348 | 2238 | 37 | COM1 | -2862 | -3463 | 72 | SEG20 | 2848 | -3463 |
| 6-2 NC2** -3348 1720 40 COM4 -2374 -3463 75 SEG23 3348 -2587 7 P5, WKPp, -3348 1590 41 COM5 -2210 -3463 76 SEG24 3348 -2427 7-2 NC1*** -3348 1456 42 COM6 -2046 -3463 77 SEG25 3348 -2267 8 P5, WKPp, -3348 1316 43 COM7 -1884 -3463 78 SEG26 3348 -2107 9 P2, -3348 1039 45 COM9/SEG64 -1556 -3463 80 SEG28 3348 -1947 10 P2, -3348 905 46 COM10/SEG63 -1394 -3463 81 SEG29 3348 -1627 12 P2, -3348 637 48 COM12/SEG62 -1231 -3463 81 SEG29 3348 -1467 13 P2 | 5-2 | NC3*2 | -3348 | 2044 | 38 | COM2 | -2700 | -3463 | 73 | SEG21 | 3348 | -2907 |
| 7 P5, \(\begin{array}{c} \) P5, \(\begin{array}{c} \) P5, \(\begin{array}{c} \) P7, \(\begin{array}{c} \) P5, \(\begin{array}{c} \) P2, \(\cdots \) 348 1456 \\ | 6 | P5 ₂ /WKP ₂ | -3348 | 1854 | 39 | COM3 | -2536 | -3463 | 74 | SEG22 | 3348 | -2747 |
| 7.2 NC1** | 6-2 | NC2*2 | -3348 | 1720 | 40 | COM4 | -2374 | -3463 | 75 | SEG23 | 3348 | -2587 |
| 8 P5 ₀ /WKF₀ -3348 1316 43 COM7 -1884 -3463 78 SEG26 3348 -2107 9 P2 ₂ -3348 1173 44 COM8 -1720 -3463 79 SEG27 3348 -1947 10 P2 ₆ -3348 1039 45 COM9/SEG64 -1556 -3463 80 SEG28 3348 -1787 11 P2 ₆ -3348 905 46 COM10/SEG63 -1394 -3463 81 SEG29 3348 -1627 12 P2 ₄ -3348 771 47 COM11/SEG62 -1231 -3463 82 SEG30 3348 -1467 13 P2 ₂ -3348 503 49 COM13/SEG60 -905 -3463 84 SEG32 3348 -1307 14 P2 ₂ -3348 269 50 COM14/SEG59 -741 -3463 85 SEG32 3348 -188 15 | 7 | P5,/WKP, | -3348 | 1590 | 41 | COM5 | -2210 | -3463 | 76 | SEG24 | 3348 | -2427 |
| 9 P2, | 7-2 | NC1*2 | -3348 | 1456 | 42 | COM6 | -2046 | -3463 | 77 | SEG25 | 3348 | -2267 |
| 10 | 8 | P5 _o /WKP _o | -3348 | 1316 | 43 | COM7 | -1884 | -3463 | 78 | SEG26 | 3348 | -2107 |
| 11 P2 | 9 | P2, | -3348 | 1173 | 44 | COM8 | -1720 | -3463 | 79 | SEG27 | 3348 | -1947 |
| 12 P2 ₄ | 10 | P2 ₆ | -3348 | 1039 | 45 | COM9/SEG64 | -1556 | -3463 | 80 | SEG28 | 3348 | -1787 |
| 13 P2 _s | 11 | P2 ₅ | -3348 | 905 | 46 | COM10/SEG63 | -1394 | -3463 | 81 | SEG29 | 3348 | -1627 |
| 14 P2 ₂ | 12 | P2 ₄ | -3348 | 771 | 47 | COM11/SEG62 | -1231 | -3463 | 82 | SEG30 | 3348 | -1467 |
| 15 P2,/UD | 13 | P2 ₃ | -3348 | 637 | 48 | COM12/SEG61 | -1069 | -3463 | 83 | SEG31 | 3348 | -1307 |
| 16 P2 _o /IRQ ₄ /ADTRG -3348 235 51 COM15/SEG58 -579 -3463 86 SEG34 3348 -828 17 AV _{cc} -3348 22 52 COM16/SEG57 -415 -3463 87 SEG35 3348 -668 18 PB _o /AN _o -3348 -143 53 SEG1 -251 -3463 88 SEG36 3348 -508 19 PB _I /AN _I -3348 -273 54 SEG2 -89 -3463 89 SEG37 3348 -348 20 PB _o /AN _I -3348 -403 55 SEG3 75 -3463 90 SEG38 3348 -188 21 PB _o /AN _I -3348 -533 56 SEG4 237 -3463 91 SEG39 3348 -28 22 PB _o /AN _I -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB _o | 14 | P2 ₂ | -3348 | 503 | 49 | COM13/SEG60 | -905 | -3463 | 84 | SEG32 | 3348 | -1148 |
| 17 AV _{cc} -3348 22 52 COM16/SEG57 -415 -3463 87 SEG35 3348 -668 18 PB _o /AN _o -3348 -143 53 SEG1 -251 -3463 88 SEG36 3348 -508 19 PB _o /AN _o -3348 -273 54 SEG2 -89 -3463 89 SEG37 3348 -348 20 PB _o /AN _o -3348 -403 55 SEG3 75 -3463 90 SEG38 3348 -188 21 PB _o /AN _o -3348 -533 56 SEG4 237 -3463 91 SEG39 3348 -28 22 PB _o /AN _o -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB _o /AN _o -3348 -923 59 SEG7 727 -3463 93 COM32/SEG41 3348 452 25 < | 15 | P2,/UD | -3348 | 369 | 50 | COM14/SEG59 | -741 | -3463 | 85 | SEG33 | 3348 | -988 |
| 18 PB _o /AN _o -3348 -143 53 SEG1 -251 -3463 88 SEG36 3348 -508 19 PB _o /AN _o -3348 -273 54 SEG2 -89 -3463 89 SEG37 3348 -348 20 PB _o /AN _o -3348 -403 55 SEG3 75 -3463 90 SEG38 3348 -188 21 PB _o /AN _o -3348 -533 56 SEG4 237 -3463 91 SEG39 3348 -28 22 PB _o /AN _o -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB _o /AN _o -3348 -793 58 SEG6 565 -3463 93 COM32/SEG41 3348 292 24 PB _o /AN _o -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB _o /AN _o -3348 -1053 60 SEG8 891 -3463 95 | 16 | P2 ₀ /IRQ ₄ /ADTRG | -3348 | 235 | 51 | COM15/SEG58 | -579 | -3463 | 86 | SEG34 | 3348 | -828 |
| 19 PB ₁ /AN ₁ -3348 -273 54 SEG2 -89 -3463 89 SEG37 3348 -348 20 PB ₂ /AN ₂ -3348 -403 55 SEG3 75 -3463 90 SEG38 3348 -188 21 PB ₃ /AN ₃ -3348 -533 56 SEG4 237 -3463 91 SEG39 3348 -28 22 PB ₄ /AN ₄ -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB ₅ /AN ₅ -3348 -793 58 SEG6 565 -3463 93 COM32/SEG41 3348 292 24 PB ₆ /AN ₆ -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB ₇ /AN ₇ -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 17 | AV _{cc} | -3348 | 22 | 52 | COM16/SEG57 | -415 | -3463 | 87 | SEG35 | 3348 | -668 |
| 20 PB ₂ /AN ₂ -3348 -403 55 SEG3 75 -3463 90 SEG38 3348 -188 21 PB ₃ /AN ₃ -3348 -533 56 SEG4 237 -3463 91 SEG39 3348 -28 22 PB ₄ /AN ₄ -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB ₅ /AN ₅ -3348 -793 58 SEG6 565 -3463 93 COM32/SEG41 3348 292 24 PB ₆ /AN ₆ -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB ₇ /AN ₇ -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{8S} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{SS} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 18 | PB₀/AN₀ | -3348 | -143 | 53 | SEG1 | -251 | -3463 | 88 | SEG36 | 3348 | -508 |
| 21 PB ₃ /AN ₃ -3348 -533 56 SEG4 237 -3463 91 SEG39 3348 -28 22 PB ₄ /AN ₄ -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB ₅ /AN ₅ -3348 -793 58 SEG6 565 -3463 93 COM32/SEG41 3348 292 24 PB ₆ /AN ₆ -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB ₇ /AN ₇ -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 19 | PB ₁ /AN ₁ | -3348 | -273 | 54 | SEG2 | -89 | -3463 | 89 | SEG37 | 3348 | -348 |
| 22 PB ₄ /AN ₄ -3348 -663 57 SEG5 401 -3463 92 SEG40 3348 132 23 PB ₅ /AN ₅ -3348 -793 58 SEG6 565 -3463 93 COM32/SEG41 3348 292 24 PB ₆ /AN ₆ -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB ₇ /AN ₇ -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 20 | PB ₂ /AN ₂ | -3348 | -403 | 55 | SEG3 | 75 | -3463 | 90 | SEG38 | 3348 | -188 |
| 23 PB _s /AN _s -3348 -793 58 SEG6 565 -3463 93 COM32/SEG41 3348 292 24 PB ₆ /AN ₆ -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB ₇ /AN ₇ -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 21 | PB ₃ /AN ₃ | -3348 | -533 | 56 | SEG4 | 237 | -3463 | 91 | SEG39 | 3348 | -28 |
| 24 PB _e /AN _e -3348 -923 59 SEG7 727 -3463 94 COM31/SEG42 3348 452 25 PB _r /AN _r -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 22 | PB ₄ /AN ₄ | -3348 | -663 | 57 | SEG5 | 401 | -3463 | 92 | SEG40 | 3348 | 132 |
| 25 PB ₇ /AN ₇ -3348 -1053 60 SEG8 891 -3463 95 COM30/SEG43 3348 612 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 23 | PB ₅ /AN ₅ | -3348 | -793 | 58 | SEG6 | 565 | -3463 | 93 | COM32/SEG41 | 3348 | 292 |
| 26 AV _{ss} -3348 -1228 61 SEG9 1055 -3463 96 COM29/SEG44 3348 772 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 24 | PB ₆ /AN ₆ | -3348 | -923 | 59 | SEG7 | 727 | -3463 | 94 | COM31/SEG42 | 3348 | 452 |
| 27 X ₂ -3348 -1438 62 SEG10 1217 -3463 97 COM28/SEG45 3348 932 28 X ₁ -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 25 | PB ₇ /AN ₇ | -3348 | -1053 | 60 | SEG8 | 891 | -3463 | 95 | COM30/SEG43 | 3348 | 612 |
| 28 X, -3348 -1568 63 SEG11 1380 -3463 98 COM27/SEG46 3348 1092 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 26 | AV _{ss} | -3348 | -1228 | 61 | SEG9 | 1055 | -3463 | 96 | COM29/SEG44 | 3348 | 772 |
| 29 V _{ss} -3348 -1763 64 SEG12 1542 -3463 99 COM26/SEG47 3348 1252 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 27 | X_2 | -3348 | -1438 | 62 | SEG10 | 1217 | -3463 | 97 | COM28/SEG45 | 3348 | 932 |
| 30 OSC ₂ -3348 -1981 65 SEG13 1706 -3463 100 COM25/SEG48 3348 1411 | 28 | X ₁ | -3348 | -1568 | 63 | SEG11 | 1380 | -3463 | 98 | COM27/SEG46 | 3348 | 1092 |
| | 29 | V _{ss} | -3348 | -1763 | 64 | SEG12 | 1542 | -3463 | 99 | COM26/SEG47 | 3348 | 1252 |
| 31 OSC, -3348 -2134 66 SEG14 1870 -3463 101 COM24/SEG49 3348 1571 | 30 | OSC ₂ | -3348 | -1981 | 65 | SEG13 | 1706 | -3463 | 100 | COM25/SEG48 | 3348 | 1411 |
| | 31 | OSC, | -3348 | -2134 | 66 | SEG14 | 1870 | -3463 | 101 | COM24/SEG49 | 3348 | 1571 |

1. Overview

| Pad | | Coord | linates*1 | Pad | | Coord | linates*1 | Pad | | Coord | inates*1 |
|-----|-----------------|--------|-----------|-----|----------------------------------|--------|-----------|-----|---|--------|----------|
| No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) |
| 102 | COM23/SEG50 | 3348 | 1731 | 117 | V _{ci} | 1471 | 3463 | 132 | P3 ₀ /SCK ₁ | -982 | 3463 |
| 103 | COM22/SEG51 | 3348 | 2063 | 118 | C ₂ - | 1341 | 3463 | 133 | P1,/IRQ,/TMIF | -1116 | 3463 |
| 104 | COM21/SEG52 | 3348 | 2223 | 119 | C ₂ + | 1125 | 3463 | 134 | P1 ₆ /IRQ ₂ /TMIC | -1250 | 3463 |
| 105 | COM20/SEG53 | 3348 | 2383 | 120 | C,- | 925 | 3463 | 135 | P1 ₅ /IRQ ₁ /TMIB | -1383 | 3463 |
| 106 | COM19/SEG54 | 3348 | 2543 | 121 | C,+ | 747 | 3463 | 136 | P1 ₄ /PWM | -1611 | 3463 |
| 107 | COM18/SEG55 | 3348 | 2703 | 122 | VLOUT | 569 | 3463 | 137 | P1 ₃ | -1761 | 3463 |
| 108 | COM17/SEG56 | 3348 | 2863 | 123 | V _{LCD} | 395 | 3463 | 138 | P1 ₂ /TMOFH | -1911 | 3463 |
| 109 | V5OUT | 2776 | 3463 | 124 | V _{ss} | 226 | 3463 | 139 | P1,/TMOFL | -2045 | 3463 |
| 110 | V4OUT | 2616 | 3463 | 125 | P3, | 74 | 3463 | 140 | P1 _o /TMOW | -2180 | 3463 |
| 111 | V3OUT | 2456 | 3463 | 126 | P3 ₆ | -78 | 3463 | 141 | P4 ₃ /IRQ ₀ | -2447 | 3463 |
| 112 | V2OUT | 2296 | 3463 | 127 | P3 ₅ | -234 | 3463 | 142 | P4 ₂ /TXD | -2587 | 3463 |
| 113 | V1OUT | 2136 | 3463 | 128 | P3 ₄ | -386 | 3463 | 143 | P4 ₁ /RXD | -2737 | 3463 |
| 114 | V_4 | 1976 | 3463 | 129 | P3 ₃ | -538 | 3463 | 144 | P4 ₀ /SCK ₃ | -2888 | 3463 |
| 115 | V ₃₄ | 1816 | 3463 | 130 | P3 ₂ /SO ₁ | -690 | 3463 | | | | , |
| 116 | V ₃ | 1656 | 3463 | 131 | P3, /SI, | -848 | 3463 | | | | |

Notes: 1. Numbers indicate coordinates at the center of the pad area, with an accuracy of $\pm 5~\mu m$. The origin is the center of the chip, and the center is at a point halfway between pads, horizontally and vertically.

2. NC1 to NC4 are test pads; they should be left open.



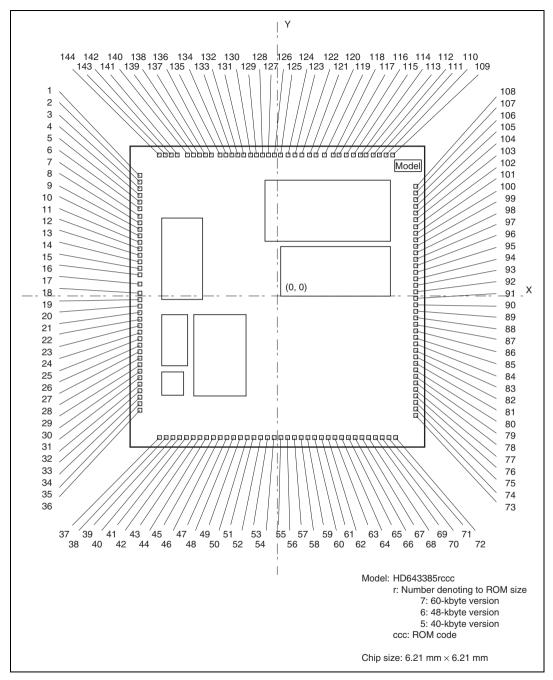
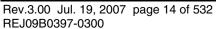


Figure 1.6 Pad Layout of HCD6433855, HCD6433856, and HCD6433857 (Mask ROM Version) (Top View)

Table 1.3 HCD6433855, HCD6433856, and HCD6433857 Pad Coordinates

| Pad | | Coord | linates*1 | Pad | | Coord | inates*1 | Pad | | Coord | inates*1 |
|-----|--|--------|-----------|-----|-------------|--------|----------|-----|-------------|--------|----------|
| | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) |
| 1 | P5,/WKP, | -2913 | 2515 | 36 | FWE*2 | -2913 | -2534 | 71 | SEG19 | 2305 | -2913 |
| 2 | P5 ₆ /WKP ₆ | -2913 | 2365 | 37 | COM1 | -2495 | -2913 | 72 | SEG20 | 2495 | -2913 |
| 3 | P5 ₅ /WKP ₅ | -2913 | 2215 | 38 | COM2 | -2305 | -2913 | 73 | SEG21 | 2913 | -2495 |
| 4 | P5 ₄ /WKP ₄ | -2913 | 2070 | 39 | СОМЗ | -2125 | -2913 | 74 | SEG22 | 2913 | -2305 |
| 5 | P5 ₃ /WKP ₃ | -2913 | 1930 | 40 | COM4 | -1955 | -2913 | 75 | SEG23 | 2913 | -2125 |
| 6 | P5 ₂ /WKP ₂ | -2913 | 1795 | 41 | COM5 | -1795 | -2913 | 76 | SEG24 | 2913 | -1955 |
| 7 | P5 ₁ /WKP ₁ | -2913 | 1660 | 42 | COM6 | -1645 | -2913 | 77 | SEG25 | 2913 | -1795 |
| 8 | P5 ₀ /WKP ₀ | -2913 | 1530 | 43 | COM7 | -1505 | -2913 | 78 | SEG26 | 2913 | -1645 |
| 9 | P2, | -2913 | 1400 | 44 | COM8 | -1365 | -2913 | 79 | SEG27 | 2913 | -1505 |
| 10 | P2 ₆ | -2913 | 1271 | 45 | COM9/SEG64 | -1235 | -2913 | 80 | SEG28 | 2913 | -1365 |
| 11 | P2 ₅ | -2913 | 1141 | 46 | COM10/SEG63 | -1105 | -2913 | 81 | SEG29 | 2913 | -1235 |
| 12 | P2 ₄ | -2913 | 1011 | 47 | COM11/SEG62 | -975 | -2913 | 82 | SEG30 | 2913 | -1105 |
| 13 | P2 ₃ | -2913 | 881 | 48 | COM12/SEG61 | -845 | -2913 | 83 | SEG31 | 2913 | -975 |
| 14 | P2 ₂ | -2913 | 751 | 49 | COM13/SEG60 | -715 | -2913 | 84 | SEG32 | 2913 | -845 |
| 15 | P2, /UD | -2913 | 621 | 50 | COM14/SEG59 | -585 | -2913 | 85 | SEG33 | 2913 | -715 |
| 16 | P2 ₀ /IRQ ₄ /ADTRG | -2913 | 491 | 51 | COM15/SEG58 | -455 | -2913 | 86 | SEG34 | 2913 | -585 |
| 17 | AV_{cc} | -2913 | 290 | 52 | COM16/SEG57 | -325 | -2913 | 87 | SEG35 | 2913 | -455 |
| 18 | PB _o /AN _o | -2913 | 125 | 53 | SEG1 | -195 | -2913 | 88 | SEG36 | 2913 | -325 |
| 19 | PB ₁ /AN ₁ | -2913 | -5 | 54 | SEG2 | -65 | -2913 | 89 | SEG37 | 2913 | -195 |
| 20 | PB ₂ /AN ₂ | -2913 | -135 | 55 | SEG3 | 65 | -2913 | 90 | SEG38 | 2913 | -65 |
| 21 | PB ₃ /AN ₃ | -2913 | -265 | 56 | SEG4 | 195 | -2913 | 91 | SEG39 | 2913 | 65 |
| 22 | PB ₄ /AN ₄ | -2913 | -395 | 57 | SEG5 | 325 | -2913 | 92 | SEG40 | 2913 | 195 |
| 23 | PB ₅ /AN ₅ | -2913 | -525 | 58 | SEG6 | 455 | -2913 | 93 | COM32/SEG41 | 2913 | 325 |
| 24 | PB ₆ /AN ₆ | -2913 | -655 | 59 | SEG7 | 585 | -2913 | 94 | COM31/SEG42 | 2913 | 455 |
| 25 | PB ₇ /AN ₇ | -2913 | -785 | 60 | SEG8 | 715 | -2913 | 95 | COM30/SEG43 | 2913 | 585 |
| 26 | AV _{ss} | -2913 | -960 | 61 | SEG9 | 845 | -2913 | 96 | COM29/SEG44 | 2913 | 715 |
| 27 | X_{2} | -2913 | -1169 | 62 | SEG10 | 975 | -2913 | 97 | COM28/SEG45 | 2913 | 845 |
| 28 | X, | -2913 | -1299 | 63 | SEG11 | 1105 | -2913 | 98 | COM27/SEG46 | 2913 | 975 |
| 29 | V _{ss} | -2913 | -1428 | 64 | SEG12 | 1235 | -2913 | 99 | COM26/SEG47 | 2913 | 1105 |
| 30 | OSC ₂ | -2913 | -1581 | 65 | SEG13 | 1365 | -2913 | 100 | COM25/SEG48 | 2913 | 1235 |
| 31 | OSC, | -2913 | -1734 | 66 | SEG14 | 1505 | -2913 | 101 | COM24/SEG49 | 2913 | 1365 |
| 32 | TEST | -2913 | -1874 | 67 | SEG15 | 1645 | -2913 | 102 | COM23/SEG50 | 2913 | 1505 |
| 33 | TEST2 | -2913 | -2024 | 68 | SEG16 | 1795 | -2913 | 103 | COM22/SEG51 | 2913 | 1645 |
| 34 | V _{cc} | -2913 | -2189 | 69 | SEG17 | 1955 | -2913 | 104 | COM21/SEG52 | 2913 | 1795 |
| 35 | RES | -2913 | -2384 | 70 | SEG18 | 2125 | -2913 | 105 | COM20/SEG53 | 2913 | 1955 |
| | | | | | | | | | | | |





| Pad | | Coord | linates*1 | Pad | | Coord | linates*1 | Pad | | Coord | inates*1 |
|-----|------------------|--------|-----------|-----|----------------------------------|--------|-----------|-----|---|--------|----------|
| | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) | | Pad Name | X (μm) | Υ (μm) |
| 106 | COM19/SEG54 | 2913 | 2125 | 119 | C ₂ + | 995 | 2913 | 132 | P3 ₀ /SCK ₁ | -715 | 2913 |
| 107 | COM18/SEG55 | 2913 | 2305 | 120 | C,- | 865 | 2913 | 133 | P1,/IRQ,/TMIF | -845 | 2913 |
| 108 | COM17/SEG56 | 2913 | 2495 | 121 | C ₁ + | 735 | 2913 | 134 | P1 ₆ /IRQ ₂ /TMIC | -975 | 2913 |
| 109 | V5OUT | 2435 | 2913 | 122 | VLOUT | 605 | 2913 | 135 | P1 ₅ /IRQ ₁ /TMIB | -1105 | 2913 |
| 110 | V4OUT | 2275 | 2913 | 123 | V _{LCD} | 475 | 2913 | 136 | P1 ₄ /PWM | -1235 | 2913 |
| 111 | V3OUT | 2125 | 2913 | 124 | V _{ss} | 325 | 2913 | 137 | P1 ₃ | -1365 | 2913 |
| 112 | V2OUT | 1975 | 2913 | 125 | P3, | 195 | 2913 | 138 | P1 ₂ /TMOFH | -1505 | 2913 |
| 113 | V1OUT | 1825 | 2913 | 126 | P3 ₆ | 65 | 2913 | 139 | P1,/TMOFL | -1645 | 2913 |
| 114 | V ₄ | 1675 | 2913 | 127 | P3 ₅ | -65 | 2913 | 140 | P1 _o /TMOW | -1795 | 2913 |
| 115 | V ₃₄ | 1520 | 2913 | 128 | P3 ₄ | -195 | 2913 | 141 | P4 ₃ /IRQ ₀ | -1955 | 2913 |
| 116 | V ₃ | 1385 | 2913 | 129 | P3 ₃ | -325 | 2913 | 142 | P4 ₂ /TXD | -2125 | 2913 |
| 117 | V _{ci} | 1255 | 2913 | 130 | P3 ₂ /SO ₁ | -455 | 2913 | 143 | P4,/RXD | -2305 | 2913 |
| 118 | C ₂ - | 1125 | 2913 | 131 | P3,/SI, | -585 | 2913 | 144 | P4 ₀ /SCK ₃ | -2495 | 2913 |

Notes: 1. Numbers indicate coordinates at the center of the pad area, with an accuracy of $\pm 5 \mu m$. The origin is the center of the chip, and the center is at a point halfway between pads, horizontally and vertically.

2. Connect FWE to V_{ss}.

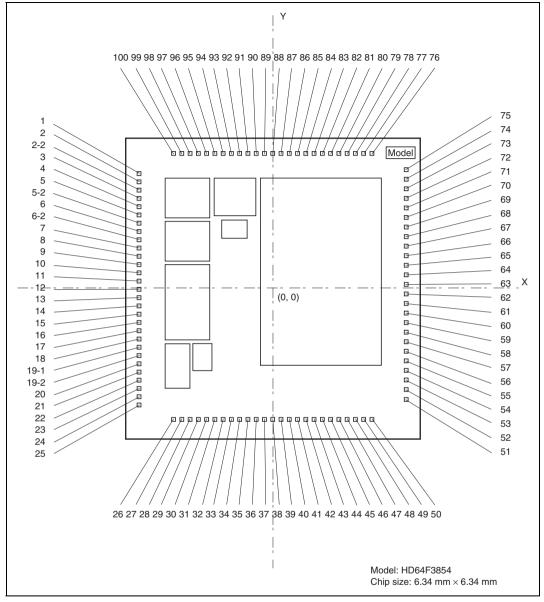


Figure 1.7 Pad Layout of HCD64F3854 (F-ZTAT Version) (Top View)

Table 1.4 HCD64F3854 Pad Coordinates

| Pad | | Coord | linates*1 | Pad | | Coord | linates*1 | Pad | | Coord | inates*1 |
|------|--|--------|-----------|-----|----------|--------|-----------|-----|---|--------|----------|
| No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) | No. | Pad Name | X (μm) | Υ (μm) |
| 1 | P5 ₆ /WKP ₆ | -2985 | 2494 | 31 | COM2 | -1413 | -2985 | 66 | SEG21 | 2985 | 627 |
| 2 | P5 ₅ /WKP ₅ | -2985 | 2333 | 32 | COM3 | -1210 | -2985 | 67 | SEG22 | 2985 | 831 |
| 2-2 | NC1*2 | -2985 | 2139 | 33 | COM4 | -1006 | -2985 | 68 | SEG23 | 2985 | 1036 |
| 3 | P5 ₄ /WKP ₄ | -2985 | 1950 | 34 | COM5 | -801 | -2985 | 69 | SEG24 | 2985 | 1240 |
| 4 | P5 ₃ /WKP ₃ | -2985 | 1788 | 35 | COM6 | -597 | -2985 | 70 | SEG25 | 2985 | 1443 |
| 5 | P5 ₂ /WKP ₂ | -2985 | 1626 | 36 | COM7 | -393 | -2985 | 71 | SEG26 | 2985 | 1647 |
| 5-2 | NC2*2 | -2985 | 1419 | 37 | COM8 | -189 | -2985 | 72 | SEG27 | 2985 | 1851 |
| 6 | P5,/WKP, | -2985 | 1215 | 38 | COM9 | 16 | -2985 | 73 | SEG28 | 2985 | 2055 |
| 6-2 | NC3*2 | -2985 | 1054 | 39 | COM10 | 219 | -2985 | 74 | SEG29 | 2985 | 2259 |
| 7 | P5 ₀ /WKP ₀ | -2985 | 897 | 40 | COM11 | 423 | -2985 | 75 | SEG30 | 2985 | 2463 |
| 8 | P2, | -2985 | 735 | 41 | COM12 | 627 | -2985 | 76 | SEG31 | 2435 | 2985 |
| 9 | P2 ₆ | -2985 | 573 | 42 | COM13 | 831 | -2985 | 77 | SEG32 | 2234 | 2985 |
| 10 | P2 ₅ | -2985 | 412 | 43 | COM14 | 1035 | -2985 | 78 | SEG33 | 2032 | 2985 |
| 11 | P2 ₄ | -2985 | 250 | 44 | COM15 | 1240 | -2985 | 79 | SEG34 | 1830 | 2985 |
| 12 | P2 ₃ | -2985 | 88 | 45 | COM16 | 1443 | -2985 | 80 | SEG35 | 1629 | 2985 |
| 13 | P2 ₂ | -2985 | -73 | 46 | SEG1 | 1647 | -2985 | 81 | SEG36 | 1427 | 2985 |
| 14 | P2, | -2985 | -234 | 47 | SEG2 | 1851 | -2985 | 82 | SEG37 | 1226 | 2985 |
| 15 | P2 ₀ /IRQ ₄ /ADTRG | -2985 | -396 | 48 | SEG3 | 2055 | -2985 | 83 | SEG38 | 1025 | 2985 |
| 16 | TEST2 | -2985 | -558 | 49 | SEG4 | 2259 | -2985 | 84 | SEG39 | 823 | 2985 |
| 17 | X ₂ | -2985 | -716 | 50 | SEG5 | 2463 | -2985 | 85 | SEG40 | 621 | 2985 |
| 18 | X, | -2985 | -873 | 51 | SEG6 | 2985 | -2433 | 86 | V5OUT | 434 | 2985 |
| 19-1 | V _{ss} * ³ | -2985 | -1031 | 52 | SEG7 | 2985 | -2229 | 87 | V4OUT | 233 | 2985 |
| | V _{ss} * ³ | -2985 | -1267 | 53 | SEG8 | 2985 | -2025 | 88 | V3OUT | 31 | 2985 |
| 20 | OSC ₂ | -2985 | -1526 | 54 | SEG9 | 2985 | -1821 | 89 | V2OUT | -171 | 2985 |
| 21 | OSC, | -2985 | -1707 | 55 | SEG10 | 2985 | -1617 | 90 | V1OUT | -372 | 2985 |
| 22 | TEST | -2985 | -1864 | 56 | SEG11 | 2985 | -1413 | 91 | P1,/IRQ,/TMIF | -574 | 2985 |
| 23 | V _{cc} | -2985 | -2101 | 57 | SEG12 | 2985 | -1210 | 92 | P1 _s /IRQ ₁ /TMIB | -780 | 2985 |
| 24 | RES | -2985 | -2336 | 58 | SEG13 | 2985 | -1005 | 93 | P1 ₂ /TMOFH | -985 | 2985 |
| 25 | FWE | -2985 | -2494 | 59 | SEG14 | 2985 | -801 | 94 | P1₁/TMOFL | -1191 | 2985 |
| 26 | PB ₄ /AN ₄ | -2448 | -2985 | 60 | SEG15 | 2985 | -597 | 95 | P1 _o /TMOW | -1396 | 2985 |
| 27 | PB ₅ /AN ₅ | -2244 | -2985 | 61 | SEG16 | 2985 | -393 | 96 | P4 ₃ /IRQ ₀ | -1618 | 2985 |
| 28 | PB ₆ /AN ₆ | -2040 | -2985 | 62 | SEG17 | 2985 | -189 | 97 | P4 ₂ /TXD | -1820 | 2985 |
| 29 | PB ₇ /AN ₇ | -1836 | -2985 | 63 | SEG18 | 2985 | 15 | 98 | P4,/RXD | -2022 | 2985 |
| 30 | COM1 | -1617 | -2985 | 64 | SEG19 | 2985 | 219 | 99 | P4 ₀ /SCK ₃ | -2234 | 2985 |
| | | | | 65 | SEG20 | 2985 | 423 | 100 | P5,/WKP, | -2446 | 2985 |
| | | | | | | | | | | | |

Notes: 1. Numbers indicate coordinates at the center of the pad area, with an accuracy of $\pm 5~\mu m$. The origin is the center of the chip, and the center is at a point halfway between pads, horizontally and vertically.

- 2. NC1 to NC3 are test pads; they should be left open.
- 3. Connect both 19-1 and 19-2 to V_{ss} .

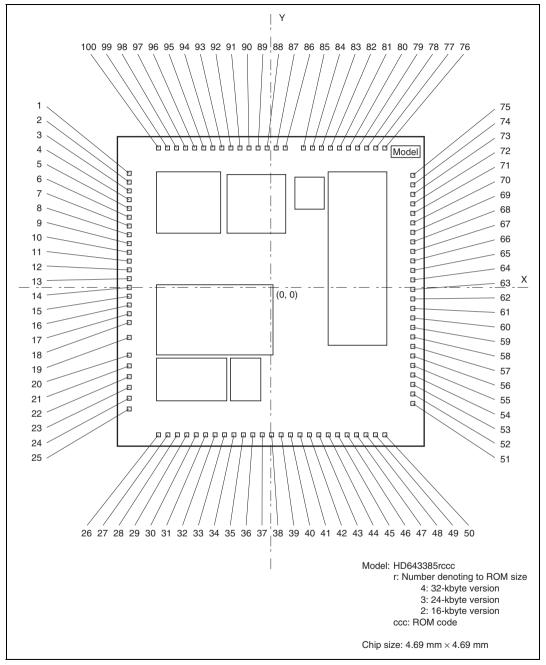


Figure 1.8 Pad Layout of HCD6433854, HCD6433853, and HCD6433852 (Mask ROM Version) (Top View)

Table 1.5 HCD6433852, HCD6433853, and HCD6433854 Pad Coordinates

| Pad | | Coordi | nates*1 | Pad | | Coordi | nates*1 | Pad | | Coordi | nates*1 |
|-----|--|--------|---------|-----|----------|--------|---------|-----|---|--------|---------|
| | Pad Name | X (μm) | Υ (μm) | | Pad Name | X (μm) | Υ (μm) | | Pad Name | X (μm) | Υ (μm) |
| 1 | P5 ₆ /WKP ₆ | -2161 | 1738 | 35 | COM6 | -390 | -2161 | 68 | SEG23 | 2161 | 650 |
| 2 | P5 _s /WKP _s | -2161 | 1590 | 36 | COM7 | -260 | -2161 | 69 | SEG24 | 2161 | 780 |
| 3 | P5 ₄ /WKP ₄ | -2161 | 1445 | 37 | COM8 | -130 | -2161 | 70 | SEG25 | 2161 | 910 |
| 4 | P5 ₃ /WKP ₃ | -2161 | 1305 | 38 | COM9 | 0 | -2161 | 71 | SEG26 | 2161 | 1060 |
| 5 | P5 ₂ /WKP ₂ | -2161 | 1171 | 39 | COM10 | 130 | -2161 | 72 | SEG27 | 2161 | 1213 |
| 6 | P5 ₁ /WKP ₁ | -2161 | 1041 | 40 | COM11 | 260 | -2161 | 73 | SEG28 | 2161 | 1383 |
| 7 | P5 ₀ /WKP ₀ | -2161 | 911 | 41 | COM12 | 390 | -2161 | 74 | SEG29 | 2161 | 1551 |
| 8 | P2, | -2161 | 781 | 42 | COM13 | 520 | -2161 | 75 | SEG30 | 2161 | 1721 |
| 9 | P2 ₆ | -2161 | 651 | 43 | COM14 | 650 | -2161 | 76 | SEG31 | 1716 | 2161 |
| 10 | P2 ₅ | -2161 | 521 | 44 | COM15 | 780 | -2161 | 77 | SEG32 | 1565 | 2161 |
| 11 | P2 ₄ | -2161 | 391 | 45 | COM16 | 910 | -2161 | 78 | SEG33 | 1422 | 2161 |
| 12 | P2 ₃ | -2161 | 261 | 46 | SEG1 | 1060 | -2161 | 79 | SEG34 | 1282 | 2161 |
| 13 | P2 ₂ | -2161 | 131 | 47 | SEG2 | 1213 | -2161 | 80 | SEG35 | 1150 | 2161 |
| 14 | P2, | -2161 | 1 | 48 | SEG3 | 1383 | -2161 | 81 | SEG36 | 1020 | 2161 |
| 15 | P2 ₀ /IRQ ₄ /ADTRG | -2161 | -129 | 49 | SEG4 | 1551 | -2161 | 82 | SEG37 | 890 | 2161 |
| 16 | TEST2 | -2161 | -259 | 50 | SEG5 | 1721 | -2161 | 83 | SEG38 | 760 | 2161 |
| 17 | X_2 | -2161 | -389 | 51 | SEG6 | 2161 | -1721 | 84 | SEG39 | 630 | 2161 |
| 18 | X, | -2161 | -519 | 52 | SEG7 | 2161 | -1551 | 85 | SEG40 | 500 | 2161 |
| 19 | V _{ss} | -2161 | -764 | 53 | SEG8 | 2161 | -1383 | 86 | V5OUT | 197 | 2161 |
| 20 | OSC ₂ | -2161 | -1020 | 54 | SEG9 | 2161 | -1213 | 87 | V4OUT | 67 | 2161 |
| 21 | OSC, | -2161 | -1173 | 55 | SEG10 | 2161 | -1060 | 88 | V3OUT | -63 | 2161 |
| 22 | TEST | -2161 | -1312 | 56 | SEG11 | 2161 | -910 | 89 | V2OUT | -193 | 2161 |
| 23 | V _{cc} | -2161 | -1497 | 57 | SEG12 | 2161 | -780 | 90 | V1OUT | -323 | 2161 |
| 24 | RES | -2161 | -1657 | 58 | SEG13 | 2161 | -650 | 91 | P1,/IRQ3/TMIF | -453 | 2161 |
| 25 | FWE*2 | -2161 | -1821 | 59 | SEG14 | 2161 | -520 | 92 | P1 ₅ /IRQ ₁ /TMIB | -583 | 2161 |
| 26 | PB ₄ /AN ₄ | -1722 | -2161 | 60 | SEG15 | 2161 | -390 | 93 | P1 ₂ /TMOFH | -713 | 2161 |
| 27 | PB _s /AN _s | -1552 | -2161 | 61 | SEG16 | 2161 | -260 | 94 | P1₁/TMOFL | -843 | 2161 |
| 28 | PB ₆ /AN ₆ | -1395 | -2161 | 62 | SEG17 | 2161 | -130 | 95 | P1 _o /TMOW | -973 | 2161 |
| 29 | PB ₇ /AN ₇ | -1236 | -2161 | 63 | SEG18 | 2161 | 0 | 96 | P4 ₃ /IRQ ₀ | -1104 | 2161 |
| 30 | COM1 | -1060 | -2161 | 64 | SEG19 | 2161 | 130 | 97 | P4 ₂ /TXD | -1244 | 2161 |
| 31 | COM2 | -910 | -2161 | 65 | SEG20 | 2161 | 260 | 98 | P4,/RXD | -1383 | 2161 |
| 32 | COM3 | -780 | -2161 | 66 | SEG21 | 2161 | 390 | 99 | P4 ₀ /SCK ₃ | -1534 | 2161 |
| 33 | COM4 | -650 | -2161 | 67 | SEG22 | 2161 | 520 | 100 | P5,/WKP, | -1698 | 2161 |
| 34 | COM5 | -520 | -2161 | | | | | | | | |

Notes: 1. Numbers indicate coordinates at the center of the pad area, with an accuracy of $\pm 5~\mu m$. The origin is the center of the chip, and the center is at a point halfway between pads, horizontally and vertically.

2. Connect FWE to V_{ss} .

1.3.2 Pin Functions

Table 1.6 outlines the pin functions of the H8/3857 Group.

Table 1.6 Pin Functions

| | | H8/385 | 7 Group | H8/385 | 4 Group | | | |
|-------------------|------------------|--------------------|---------|---------------------|---------------|--------|---|--|
| | | Pin No. | | Pin No. | | _ | Name and Functions | |
| Туре | Symbol | FP-144H TFP-144 | Pad No. | FP-100B TFP-100G | Pad No. | I/O | | |
| Power source pins | V _{cc} | 34 | 34 | 23 | 23 | Input | Power supply: All $V_{\rm cc}$ pins should be connected to the system power supply (+5 V) | |
| | V _{ss} | 29, 124 | 29, 124 | 19 | 19-1, 19-2 | Input | Ground: All V _{ss} pins should be connected to the system power supply (0 V) | |
| | AV _{cc} | 17 | 17 | _ | _ | Input | Analog power supply (H8/3857 Group only): This is the power supply pin for the A/D converter. When the A/D converter is not used, connect this pin to the system power supply (+5 V). | |
| | AV _{ss} | 26 | 26 | _ | _ | Input | Analog ground (H8/3857 Group only): This is the A/D converter ground pin. It should be connected to the system power supply (0 V). | |
| Clock pins | OSC ₁ | 31 | 31 | 21 | 21 | Input | This pin connects to a crystal or ceramic oscillator. | |
| | OSC ₂ | 30 | 30 | 20 | 20 | Output | See section 4, Clock Pulse Generators, for a typical connection diagram. | |
| | X, | 28 | 28 | 18 | 18 | Input | This pin connects to a 32.768-kHz crystal oscillator, or can be used to input an external clock. | |
| | X_2 | 27 | 27 | 17 | 17 | Output | See section 4, Clock Pulse Generators, for a typical connection diagram. | |



| | | H8/385 | 7 Group | H8/385 | 4 Group | | |
|----------------|--------------------------------------|------------|------------|----------------|----------------|--------|---|
| | | Pin No. | | Pin No. | | _ | |
| | | FP-144H | _ | FP-100B | _ | | |
| Туре | Symbol | TFP-144 | Pad No. | TFP-100G | Pad No. | I/O | Name and Functions |
| System control | RES | 35 | 35 | 24 | 24 | Input | Reset: When this pin is driven low, the chip is reset |
| | FWE | 36 | 36 | 25 | 25 | Input | Flash write enable: This pin enables or disables flash memory programming. In the mask ROM version, ground this pin to the V _{ss} potential. |
| | TEST | 32 | 32 | 22 | 22 | Input | Test: This is a test pin, not for use in application systems. It should be connected to V _{ss} . |
| | TEST2 | 33 | 33 | 16 | 16 | Input | Test pin: This pin sets the flash memory operating mode. In the mask ROM version, ground this pin to the V _{ss} potential. |
| Interrupt pins | IRQ₀ IRQ₁ | 141 135 | 141 135 | 96 92 | 96 92 | Input | External interrupt request 4 to 0 (H8/3857 Group) |
| | IRQ ₂ IRQ ₃ | 134 133 | 134 133 | 91 15 | 91 | | External interrupt request 4, 3, 1, 0 (H8/3854 Group) |
| | ĪRQ₄ | 16 | 16 | 15 | 15 | | These are input pins for external interrupts for which there is a choice between rising and falling edge sensing. |
| | WKP, to | 1 to 8 | 1 to 8 | 100, 1 to 7 | 100, 1 to 7 | Input | Wakeup interrupt request 0 to 7: These are input pins for external interrupts that are detected at the falling edge |
| Timer pins | TMOW | 140 | 140 | 95 | 95 | Output | Clock output: This is an output pin for waveforms generated by the timer A output circuit |
| | TMIB | 135 | 135 | 92 | 92 | Input | Timer B event counter input: This is an event input pin for input to the timer B counter |
| | TMIC | 134 | 134 | _ | _ | Input | Timer C event counter input (H8/3857 Group only): This is an event input pin for input to the timer C counter |

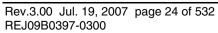
| | H8/3857 Group H8/3854 Group | | 4 Group | | | | | | |
|----------------------|--|---|---|--------------------------------|--------------------------------|--------|--|--|--|
| | | Pin No. | | Pin No. | | _ | | | |
| Туре | Symbol | FP-144H TFP-144 | Pad No. | FP-100B TFP-100G | Pad No. | I/O | Name and Functions | | |
| Timer pins | UD | 15 | 15 | _ | _ | Input | Timer C up/down select (H8/3857 Group only): This pin selects whether the timer C counter is used for up- or down-counting. At high level it selects upcounting, and at low level down-counting. | | |
| | TMIF | 133 | 133 | 91 | 91 | Input | Timer F event counter input: This is an event input pin for input to the timer F counter | | |
| | TMOFL | 139 | 139 | 94 | 94 | Output | Timer FL output: This is an output pin for waveforms generated by the timer FL output compare function | | |
| | TMOFH | 138 | 138 | 93 | 93 | Output | Timer FH output: This is an output pin for waveforms generated by the timer FH output compare function | | |
| 14-bit PWM pin | PWM | 136 | 136 | _ | _ | Output | 14-bit PWM output (H8/3857 Group only): This is an output pin for waveforms generated by the 14-bit PWM | | |
| I/O ports | , , | | 25 to 22 21 to 18 | 29 to 26 — | 29 to 26 — | Input | Port B: This is an 8-bit input port in the H8/3857 Group, and a 4-bit input port in the H8/3854 Group | | |
| | P4 ₃ | 141 | 141 | 96 | 96 | Input | Port 4 (bit 3): This is a 1-bit input port | | |
| | P4 ₂ to P4 ₀ | 142 to 144 | 142 to 144 | 97 to 99 | 97 to 99 | I/O | Port 4 (bits 2 to 0): This is a 3-bit I/O port. Input or output can be designated for each bit by means of port control register 4 (PCR4). | | |
| | P1 ₇ , P1 ₆ , P1 ₅ , P1 ₄ , P1 ₃ , P1 ₂ to P1 ₀ | 133 134 135 136, 137 138 to 140 | 133 134 135 136, 137 138 to 140 | 91 — 92 — 93 to 95 | 91 — 92 — 93 to 95 | I/O | Port 1: This is an 8-bit I/O port in the H8/3857 Group, and a 5-bit I/O port in the H8/3854 Group. Input or output can be designated for each bit by means of port control register 1 (PCR1). | | |

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| | | H8/3857 | 7 Group | H8/385 | 4 Group | | |
|------------------------------|------------------------------------|--------------------|------------|---------------------|----------------|--------|---|
| | | Pin No. | | Pin No. | | _ | |
| Туре | Symbol | FP-144H TFP-144 | Pad No. | FP-100B TFP-100G | Pad No. | I/O | Name and Functions |
| I/O ports | P2 ₇ to P2 ₀ | 9 to 16 | 9 to 16 | 8 to 15 | 8 to 15 | I/O | Port 2: This is an 8-bit I/O port. Input or output can be designated for each bit by means of port control register 2 (PCR2). |
| | P3 ₇ to P3 ₀ | 125 to 132 | 125 to 132 | _ | _ | I/O | Port 3 (H8/3857 Group only): This is an 8-bit I/O port. Input or output can be designated for each bit by means of port control register 3 (PCR3). |
| | P5 ₇ to P5 ₀ | 1 to 8 | 1 to 8 | 100, 1 to 7 | 100, 1 to 7 | I/O | Port 5: This is an 8-bit I/O port. Input or output can be designated for each bit by means of port control register 5 (PCR5). |
| Internal I/O ports | PA ₃ to PA ₀ | _ | _ | _ | _ | I/O | Port A: This is a 4-bit I/O port. Input or output can be designated for each bit by means of port control register A (PCRA). PA ₂ to PA ₀ are connected internally to LCD pins RS, R/W, and STRB. |
| | P9 ₇ to P9 ₀ | _ | _ | _ | _ | I/O | Port 9: This is an 8-bit I/O port. Input or output can be designated for each bit by means of port control register 9 (PCR9). P9, to P9, are connected internally to LCD pins DB, to DB,. |
| Serial commu- nication | SI, | 131 | 131 | _ | _ | Input | SCI1 receive data input (H8/3857 Group only): This is the SCI1 data input pin |
| interface (SCI) | SO, | 130 | 130 | _ | _ | Output | SCI1 send data output (H8/3857 Group only): This is the SCI1 data output pin |
| | SCK, | 132 | 132 | _ | _ | I/O | SCI1 clock I/O (H8/3857 Group only): This is the SCI1 clock I/O pin |
| | RXD | 143 | 143 | 98 | 98 | Input | SCI3 receive data input: This is the SCI3 data input pin |

| | H8/3857 Group H8/3854 Group | | 4 Group | | | | |
|------------------------------|--|------------------------------------|------------------------------------|---------------------|---------------|--------|--|
| | | Pin No. | | Pin No. | | = | |
| Туре | Symbol | FP-144H TFP-144 | Pad No. | FP-100B TFP-100G | Pad No. | I/O | Name and Functions |
| Serial commu- nication | TXD | 142 | 142 | 97 | 97 | Output | SCI3 send data output: This is the SCI3 data output pin |
| interface (SCI) | SCK₃ | 144 | 144 | 99 | 99 | I/O | SCI3 clock I/O : This is the SCI3 clock I/O pin |
| A/D converter | AN ₇ to AN ₄ AN ₃ to AN ₀ | | 25 to 22 21 to 18 | 29 to 26 — | 29 to 26 — | Input | Analog input (channels 7 to 0 in H8/3857 Group, channels 7 to 4 in H8/3854 Group): These are analog data input channels to the A/D converter |
| | ADTRG | 16 | 16 | 15 | 15 | Input | A/D converter trigger input: This is the external trigger input pin to the A/D converter |
| LCD controller | COM32 to COM17 COM16 to COM1 | 93 to 108 52 to 37 | 93 to 108 52 to 37 | — 45 to 30 | — 45 to 30 | Output | LCD common output: These are LCD common output pins. The maximum number of pins is 32 in the H8/3857 Group, and 16 in the H8/3854 Group. In standby mode and module standby mode, all pins output the V _{ss} level. |
| | SEG64 to SEG41 SEG40 to SEG1 | 45 to 52 108 to 93, 92 to 53 | 45 to 52 108 to 93, 92 to 53 | — 85 to 46 | — 85 to 46 | Output | LCD segment output: These are LCD segment output pins. The maximum number of pins is 64 in the H8/3857 Group, and 40 in the H8/3854 Group. In standby mode and module standby mode, all pins output the V _{ss} level. |
| | V3, V4 | 116, 114 | 116, 114 | _ | _ | Input | LCD bias setting pins (H8/3857 Group only): 1/4 bias drive is selected when V3 and V4 are shorted, and 1/5 bias drive when V3 and V4 are left open. |
| | V34 | 115 | 115 | _ | _ | Input | LCD test pin (H8/3857 Group only): This is the LCD built-in resistance test pin. V3 and V34 must be shorted. |

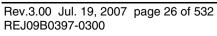




| | | H8/385 | 7 Group | H8/3854 Group | | | |
|--|-----------------------|--------------------|------------|---------------------|---------|--------|---|
| | | Pin No. | | Pin No. | | | |
| Туре | Symbol | FP-144H TFP-144 | Pad No. | FP-100B TFP-100G | Pad No. | I/O | Name and Functions |
| LCD controller | C1+, C1-, C2+, C2- | 121 to 118 | 121 to 118 | _ | _ | _ | LCD step-up circuit capacitance connection pins (H8/3857 Group only): These pins connect external capacitances for LCD step-up. Connect capacitances according to the step-up factor. |
| H8/3857 Group LCD power supply | V1OUT to V5OUT | 113 to 109 | 113 to 109 | _ | _ | I/O | LCD drive power supply level (H8/3857 Group): When the OPON bit is set high, these bits output LCD drive power supply levels V1 to V5. If the built-in op-amp drive capacity is inadequate, connect a capacitor to provide stabilization. If levels V1 to V5 are input from an external source, set the OPON bit low. |
| | V _{ci} | 117 | 117 | _ | _ | Input | LCD step-up circuit reference power supply (H8/3857 Group only): This pin doubles as the LCD step-up circuit reference input voltage and step-up circuit power supply, and provides the LCD drive voltage. Set 1.6 V \leq V $_{\rm cc}$. If the step-up circuit is not used, connect V $_{\rm d}$ to V $_{\rm cc}$. |
| | VLOUT | 122 | 122 | _ | _ | Output | LCD step-up voltage output (H8/3857 Group only): This is the LCD step- up voltage output pin. Connect a capacitance. |
| | V _{LCD} | 123 | 123 | _ | _ | Input | LCD drive power supply (H8/3857 Group only): This is the LCD drive power supply input pin. If the builtin step-up circuit output voltage is used for the LCD drive power supply, short this pin to VLOUT. Set $V_{\text{CC}} \le V_{\text{LCD}} \le 7.0 \text{ V}$. |

1. Overview

| | | H8/385 | 7 Group | H8/385 | 4 Group | | |
|--|-------------------|--------------------|---------|---------------------|----------|-----|---|
| | | Pin No. | | Pin No. | | _ | |
| Туре | Symbol | FP-144H TFP-144 | Pad No. | FP-100B TFP-100G | Pad No. | I/O | Name and Functions |
| H8/3854 Group LCD power supply | V1OUT to V5OUT | _ | _ | 90 to 86 | 90 to 86 | I/O | LCD drive power supply level (H8/3854 Group): When the LPS1 and LPS0 bits are set high, these pins output LCD drive power supply levels V1 to V5. If the drive capacity is inadequate, connect a capacitor to provide stabilization. If levels V1 to V5 are input from an external source, set the LPS1 and LPS0 bits low. The V1 to V5 levels must not exceed V _{cc} . When driving with a 1/4 bias, short V3OUT and V4OUT. |





Section 2 CPU

2.1 Overview

The H8/300L CPU has sixteen 8-bit general registers, which can also be paired as eight 16-bit registers. Its concise, optimized instruction set is designed for high-speed operation.

2.1.1 Features

Features of the H8/300L CPU are listed below.

- General-register architecture
 - Sixteen 8-bit general registers, also usable as eight 16-bit general registers
- Instruction set with 55 basic instructions, including:
 - Multiply and divide instructions
 - Powerful bit-manipulation instructions
- Eight addressing modes
 - Register direct
 - Register indirect
 - Register indirect with displacement
 - Register indirect with post-increment or pre-decrement
 - Absolute address
 - Immediate
 - Program-counter relative
 - Memory indirect
- 64-kbyte address space
- High-speed operation
 - All frequently used instructions are executed in two to four states
 - High-speed arithmetic and logic operations

8- or 16-bit register-register add or subtract: 0.4 μs*

 8×8 -bit multiply: 2.8 μ s*

 $16 \div 8$ -bit divide: $2.8 \,\mu s^*$

Note: * These values are at $\phi = 5$ MHz.

• Low-power operation modes

SLEEP instruction for transfer to low-power operation

2.1.2 Address Space

The H8/300L CPU supports an address space of up to 64 kbytes for storing program code and data.

See section 2.8, Memory Map, for details of the memory map.

2.1.3 Register Configuration

Figure 2.1 shows the register structure of the H8/300L CPU. There are two groups of registers: the general registers and control registers.

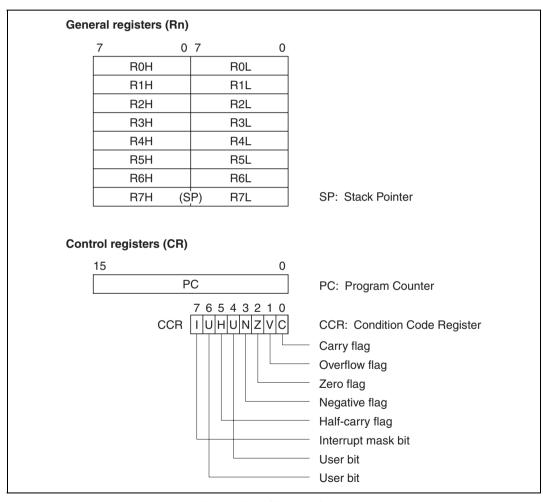


Figure 2.1 CPU Registers

2.2 Register Descriptions

2.2.1 General Registers

All the general registers can be used as both data registers and address registers.

When used as data registers, they can be accessed as 16-bit registers (R0 to R7), or the high bytes (R0H to R7H) and low bytes (R0L to R7L) can be accessed separately as 8-bit registers.

When used as address registers, the general registers are accessed as 16-bit registers (R0 to R7).

R7 also functions as the stack pointer (SP), used implicitly by hardware in exception processing and subroutine calls. When it functions as the stack pointer, as indicated in figure 2.2, SP (R7) points to the top of the stack.

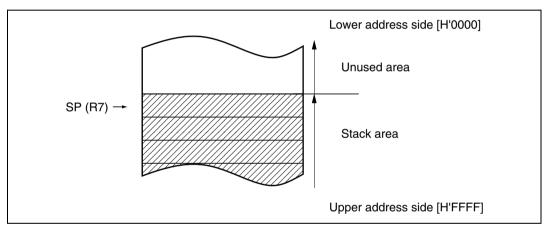


Figure 2.2 Stack Pointer

2.2.2 Control Registers

The CPU control registers include a 16-bit program counter (PC) and an 8-bit condition code register (CCR).

Program Counter (PC): This 16-bit register indicates the address of the next instruction the CPU will execute. All instructions are fetched 16 bits (1 word) at a time, so the least significant bit of the PC is ignored (always regarded as 0).

Condition Code Register (CCR): This 8-bit register contains internal status information, including the interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags. These bits can be read and written by software (using the LDC, STC, ANDC,

ORC, and XORC instructions). The N, Z, V, and C flags are used as branching conditions for conditional branching (Bcc) instructions.

Bit 7—Interrupt Mask Bit (I): When this bit is set to 1, interrupts are masked. This bit is set to 1 automatically at the start of exception handling. The interrupt mask bit may be read and written by software. For further details, see section 3.3, Interrupts.

Bit 6—User Bit (U): Can be used freely by the user.

Bit 5—Half-Carry Flag (H): When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B, or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and is cleared to 0 otherwise.

The H flag is used implicitly by the DAA and DAS instructions.

When the ADD.W, SUB.W, or CMP.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and is cleared to 0 otherwise.

Bit 4—User Bit (U): Can be used freely by the user.

Bit 3—Negative Flag (N): Indicates the most significant bit (sign bit) of the result of an instruction.

Bit 2—Zero Flag (Z): Set to 1 to indicate a zero result, and cleared to 0 to indicate a non-zero result.

Bit 1—Overflow Flag (V): Set to 1 when an arithmetic overflow occurs, and cleared to 0 at other times.

Bit 0—Carry Flag (C): Set to 1 when operation execution generates a carry, and cleared to 0 otherwise. Used by:

- Add instructions, to indicate a carry
- Subtract instructions, to indicate a borrow
- Shift and rotate instructions

The carry flag is also used as a bit accumulator by bit manipulation instructions.

Some instructions leave some or all of the flag bits unchanged.

Refer to the H8/300L Series Software Manual for the action of each instruction on the flag bits.



2.2.3 Initial Register Values

When the CPU is reset, the program counter (PC) is initialized to the value stored at address H'0000 in the vector table, and the I bit in the CCR is set to 1. The other CCR bits and the general registers are not initialized. In particular, the stack pointer (R7) is not initialized. To prevent program crashes the stack pointer should be initialized by software, by the first instruction executed after a reset.

2.3 Data Formats

The H8/300L CPU can process 1-bit data, 4-bit (BCD) data, 8-bit (byte) data, and 16-bit (word) data.

- Bit manipulation instructions operate on 1-bit data specified as bit n in a byte operand (n = 0, 1, 2, ..., 7).
- All arithmetic and logic instructions except ADDS and SUBS can operate on byte data.
- The MOV.W, ADD.W, SUB.W, CMP.W, ADDS, SUBS, MULXU (8 bits × 8 bits), and DIVXU (16 bits ÷ 8 bits) instructions operate on word data.
- The DAA and DAS instructions perform decimal arithmetic adjustments on byte data in packed BCD form. Each nibble of the byte is treated as a decimal digit.

2.3.1 Data Formats in General Registers

The general register data formats are shown in figure 2.3.

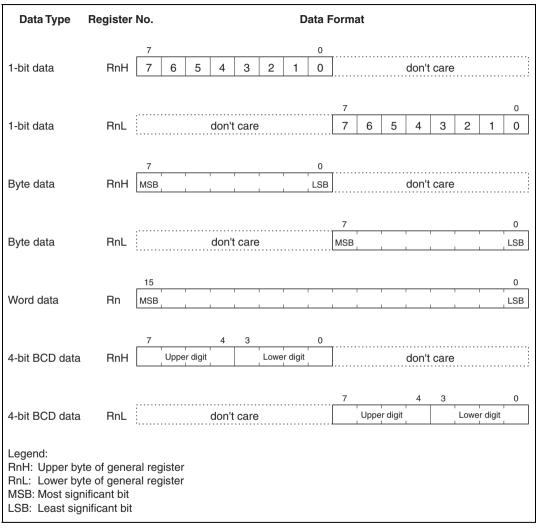


Figure 2.3 Register Data Formats

2.3.2 Memory Data Formats

Figure 2.4 indicates the data formats in memory. For access by the H8/300L CPU, word data stored in memory must always begin at an even address. In word access the least significant bit of the address is regarded as 0. If an odd address is specified, the access is performed at the preceding even address. This rule affects the MOV.W instruction, and also applies to instruction fetching.

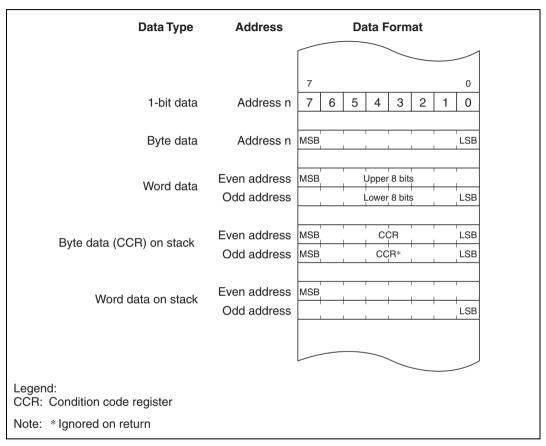


Figure 2.4 Memory Data Formats

When the stack is accessed using R7 as an address register, word access should always be performed. For the CCR, the same value is stored in the upper 8 bits and lower 8 bits as word data. On return, the lower 8 bits are ignored.

2.4 Addressing Modes

2.4.1 Addressing Modes

The H8/300L CPU supports the eight addressing modes listed in table 2.1. Each instruction uses a subset of these addressing modes.

Table 2.1 Addressing Modes

| No. | Address Modes | Symbol |
|-----|---------------------------------------|-----------------|
| 1 | Register direct | Rn |
| 2 | Register indirect | @Rn |
| 3 | Register indirect with displacement | @(d:16, Rn) |
| 4 | Register indirect with post-increment | @Rn+ |
| | Register indirect with pre-decrement | @-Rn |
| 5 | Absolute address | @aa:8 or @aa:16 |
| 6 | Immediate | #xx:8 or #xx:16 |
| 7 | Program-counter relative | @(d:8, PC) |
| 8 | Memory indirect | @@aa:8 |

1. Register Direct—Rn: The register field of the instruction specifies an 8- or 16-bit general register containing the operand.

Only the MOV.W, ADD.W, SUB.W, CMP.W, ADDS, SUBS, MULXU (8 bits \times 8 bits), and DIVXU (16 bits \div 8 bits) instructions have 16-bit operands.

- **2. Register Indirect**—@**Rn:** The register field of the instruction specifies a 16-bit general register containing the address of the operand in memory.
- **3.** Register Indirect with Displacement—@(d:16, Rn): The instruction has a second word (bytes 3 and 4) containing a 16-bit displacement which is added to the contents of the specified general register (16-bit) to obtain the operand address in memory.

This mode is used only in MOV instructions. For the MOV.W instruction, the resulting address must be even.



4. Register Indirect with Post-Increment or Pre-Decrement—@Rn+ or @-Rn:

- Register indirect with post-increment—@Rn+
 The @Rn+ mode is used with MOV instructions that load registers from memory.
 The register field of the instruction specifies a 16-bit general register containing the address of the operand. After the operand is accessed, the register is incremented by 1 for MOV.B or 2 for MOV.W. For MOV.W, the original contents of the 16-bit general register must be even.
- Register indirect with pre-decrement—@-Rn
 The @-Rn mode is used with MOV instructions that store register contents to memory.
 The register field of the instruction specifies a 16-bit general register which is decremented by 1 or 2 to obtain the address of the operand in memory. The register retains the decremented value. The size of the decrement is 1 for MOV.B or 2 for MOV.W. For MOV.W, the original contents of the register must be even.
- **5. Absolute Address**—@aa:8 or @aa:16: The instruction specifies the absolute address of the operand in memory.

The absolute address may be 8 bits long (@aa:8) or 16 bits long (@aa:16). The MOV.B and bit manipulation instructions can use 8-bit absolute addresses. The MOV.B, MOV.W, JMP, and JSR instructions can use 16-bit absolute addresses.

For an 8-bit absolute address, the upper 8 bits are assumed to be 1 (H'FF). The address range is H'FF00 to H'FFFF (65280 to 65535).

6. Immediate—#xx:8 or #xx:16: The instruction contains an 8-bit operand (#xx:8) in its second byte, or a 16-bit operand (#xx:16) in its third and fourth bytes. Only MOV.W instructions can contain 16-bit immediate values.

The ADDS and SUBS instructions implicitly contain the value 1 or 2 as immediate data. Some bit manipulation instructions contain 3-bit immediate data in the second or fourth byte of the instruction, specifying a bit number.

7. **Program-Counter Relative—@(d:8, PC):** This mode is used in the Bcc and BSR instructions. An 8-bit displacement in byte 2 of the instruction code is sign-extended to 16 bits and added to the program counter contents to generate a branch destination address. The possible branching range is –126 to +128 bytes (–63 to +64 words) from the current address. The displacement should be an even number.

8. Memory Indirect—@@aa:8: This mode can be used by the JMP and JSR instructions. The second byte of the instruction code specifies an 8-bit absolute address. The word located at this address contains the branch destination address.

The upper 8 bits of the absolute address are assumed to be 0 (H'00), so the address range is from H'0000 to H'00FF (0 to 255). Note that with the H8/300L Series, the lower end of the address area is also used as a vector area. See section 3.3, Interrupts, for details on the vector area.

If an odd address is specified as a branch destination or as the operand address of a MOV.W instruction, the least significant bit is regarded as 0, causing word access to be performed at the address preceding the specified address. See section 2.3.2, Memory Data Formats, for further information.

2.4.2 Effective Address Calculation

Table 2.2 shows how effective addresses are calculated in each of the addressing modes.

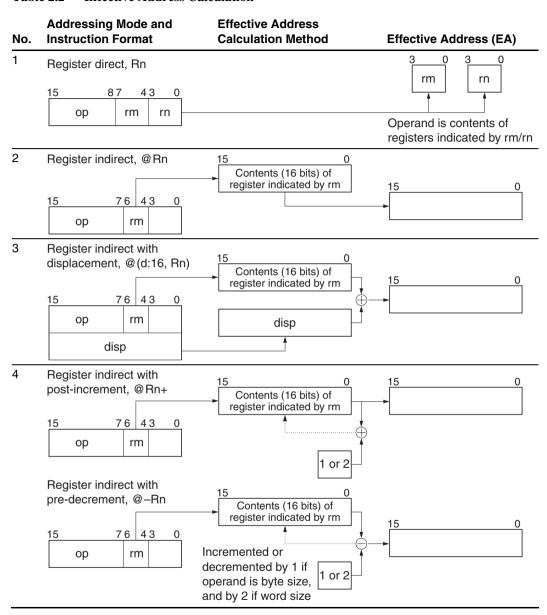
Arithmetic and logic instructions use register direct addressing (1). The ADD.B, ADDX, SUBX, CMP.B, AND, OR, and XOR instructions can also use immediate addressing (6).

Data transfer instructions can use all addressing modes except program-counter relative (7) and memory indirect (8).

Bit manipulation instructions use register direct (1), register indirect (2), or absolute addressing (8-bit) (5) to specify a byte operand, and 3-bit immediate addressing (6) to specify a bit position in that byte. The BSET, BCLR, BNOT, and BTST instructions can also use register direct addressing (1) to specify the bit position.



Table 2.2 Effective Address Calculation



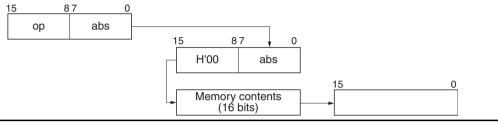
| No. | Addressing Mode and Instruction Format | Effective Address Calculation Method | Effective Address (EA) |
|-----|--|--------------------------------------|--|
| 5 | Absolute address @aa:8 | | 15 87 0 H'FF |
| | 15 87 0 op abs | | |
| | @aa:16 15 0 op | | 15 0 |
| | abs | | |
| 6 | Immediate #xx:8 | | |
| | 15 87 0 op IMM | | |
| | #xx:16 15 0 | | Operand is 1- or 2-byte immediate data |
| 7 | Program-counter relative @(d:8, PC) | PC contents | 15 0 |
| | 15 8 7 0 op disp | Sign disp extension | |

| | Addressing Mode and |
|-----|---------------------|
| No. | Instruction Format |

Effective Address Calculation Method

Effective Address (EA)

8 Memory indirect, @@aa:8



Legend:

rm, rn: Register fieldop: Operation fielddisp: DisplacementIMM: Immediate dataabs: Absolute address

2.5 Instruction Set

The H8/300L Series can use a total of 55 instructions, which are grouped by function in table 2.3.

Table 2.3 Instruction Set

| Function | Instructions | Number |
|-----------------------|--|--------|
| Data transfer | MOV, PUSH* ¹ , POP* ¹ | 1 |
| Arithmetic operations | ADD, SUB, ADDX, SUBX, INC, DEC, ADDS, SUBS, DAA, DAS, MULXU, DIVXU, CMP, NEG | 14 |
| Logic operations | AND, OR, XOR, NOT | 4 |
| Shift | SHAL, SHAR, SHLL, SHLR, ROTL, ROTR, ROTXL, ROTXR | 8 |
| Bit manipulation | BSET, BCLR, BNOT, BTST, BAND, BIAND, BOR, BIOR, BXOR, BIXOR, BLD, BILD, BST, BIST | 14 |
| Branch | Bcc* ² , JMP, BSR, JSR, RTS | 5 |
| System control | RTE, SLEEP, LDC, STC, ANDC, ORC, XORC, NOP | 8 |
| Block data transfer | EEPMOV | 1 |

Total: 55

Notes: 1. PUSH Rn is equivalent to MOV.W Rn, @-SP.
POP Rn is equivalent to MOV.W @SP+, Rn. The machine language is also the same.

2. Bcc is the generic term for conditional branch instructions.

The functions of the instructions are shown in tables 2.4 to 2.11. The meaning of the operation symbols used in the tables is as follows.



Operation Notation

| - | |
|--------------------|--|
| Rd | General register (destination) |
| Rs | General register (source) |
| Rn | General register |
| (EAd), <ead></ead> | Destination operand |
| (EAs), <eas></eas> | Source operand |
| CCR | Condition code register |
| N | N (negative) flag of CCR |
| Z | Z (zero) flag of CCR |
| V | V (overflow) flag of CCR |
| С | C (carry) flag of CCR |
| PC | Program counter |
| SP | Stack pointer |
| #IMM | Immediate data |
| disp | Displacement |
| + | Addition |
| _ | Subtraction |
| × | Multiplication |
| ÷ | Division |
| ^ | AND logical |
| V | OR logical |
| \oplus | Exclusive OR logical |
| \rightarrow | Move |
| ~ | Logical negation (logical complement) |
| :3 | 3-bit length |
| :8 | 8-bit length |
| :16 | 16-bit length |
| (), < > | Contents of operand indicated by effective address |
| | |

2.5.1 Data Transfer Instructions

Table 2.4 describes the data transfer instructions. Figure 2.5 shows their object code formats.

Table 2.4 Data Transfer Instructions

| Instruction | n Size* | Function |
|-------------|--------------|--|
| MOV | B/W | $(EAs) \rightarrow Rd, Rs \rightarrow (EAd)$ |
| | | Moves data between two general registers or between a general register and memory, or moves immediate data to a general register. |
| | | The Rn, @Rn, @(d:16, Rn), @aa:16, #xx:16, @-Rn, and @Rn+addressing modes are available for byte or word data. The @aa:8 addressing mode is available for byte data only. |
| | | The @-R7 and @R7+ modes require word operands. Do not specify byte size for these two modes. |
| POP | W | @ SP+ → Rn |
| | | Pops a 16-bit general register from the stack. Equivalent to MOV.W @ SP+, Rn. |
| PUSH | W | $Rn \rightarrow @-SP$ |
| | | Pushes a 16-bit general register onto the stack. Equivalent to MOV.W Rn, @-SP. |
| Note: * | Size: Operan | d size |
| | B: Byte | |
| | W: Word | |

Certain precautions are required in data access. See section 2.9.1, Notes on Data Access, for details.

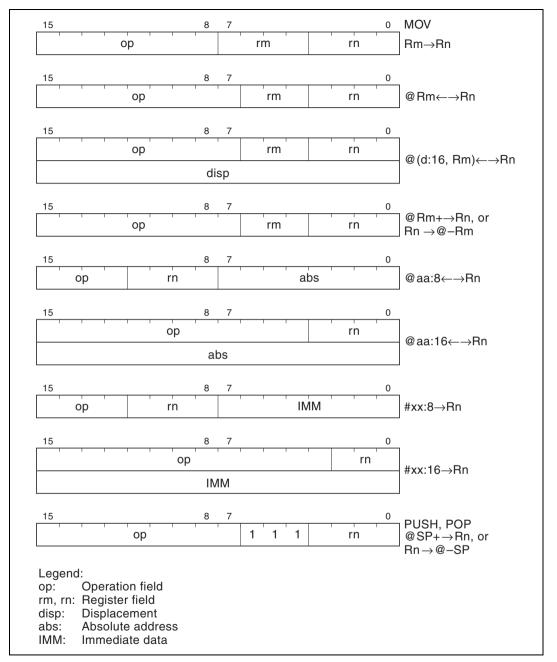


Figure 2.5 Data Transfer Instruction Codes

2.5.2 Arithmetic Operations

Table 2.5 describes the arithmetic instructions.

Table 2.5 Arithmetic Instructions

| Instruction | Size* | Function |
|-------------|-------------|---|
| ADD | B/W | $Rd \pm Rs \rightarrow Rd, Rd + \#IMM \rightarrow Rd$ |
| SUB | | Performs addition or subtraction on data in two general registers, or addition on immediate data and data in a general register. Immediate data cannot be subtracted from data in a general register. Word data can be added or subtracted only when both words are in general registers. |
| ADDX | В | $Rd \pm Rs \pm C \rightarrow Rd, Rd \pm \#IMM \pm C \rightarrow Rd$ |
| SUBX | | Performs addition or subtraction with carry or borrow on byte data in two general registers, or addition or subtraction on immediate data and data in a general register. |
| INC | В | $Rd \pm 1 \rightarrow Rd$ |
| DEC | | Increments or decrements a general register by 1. |
| ADDS | W | $Rd \pm 1 \rightarrow Rd, Rd \pm 2 \rightarrow Rd$ |
| SUBS | | Adds or subtracts immediate data to or from data in a general register. The immediate data must be 1 or 2. |
| DAA | В | Rd decimal adjust → Rd |
| DAS | | Decimal-adjusts (adjusts to packed 4-bit BCD) an addition or subtraction result in a general register by referring to the CCR |
| MULXU | В | $Rd \times Rs \rightarrow Rd$ |
| | | Performs 8-bit \times 8-bit unsigned multiplication on data in two general registers, providing a 16-bit result |
| DIVXU | В | $Rd \div Rs \rightarrow Rd$ |
| | | Performs 16-bit ÷ 8-bit unsigned division on data in two general registers, providing an 8-bit quotient and 8-bit remainder |
| CMP | B/W | Rd – Rs, Rd – #IMM |
| | | Compares data in a general register with data in another general register or with immediate data, and the result is stored in the CCR. Word data can be compared only between two general registers. |
| NEG | В | $0 - Rd \rightarrow Rd$ |
| | | Obtains the two's complement (arithmetic complement) of data in a general register |
| Note: * | Size: Opera | nd size |
| | B: Byte | |

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Word

REJ09B0397-0300

W:

2.5.3 Logic Operations

Table 2.6 describes the four instructions that perform logic operations.

Table 2.6 Logic Operation Instructions

| Instruction | n S | ize* | Function |
|-------------|-------|---------|--|
| AND | В | | $Rd \wedge Rs \rightarrow Rd, Rd \wedge \#IMM \rightarrow Rd$ |
| | | | Performs a logical AND operation on a general register and another general register or immediate data |
| OR | В | | $Rd \lor Rs \rightarrow Rd, Rd \lor \#IMM \rightarrow Rd$ |
| | | | Performs a logical OR operation on a general register and another general register or immediate data |
| XOR | В | | $Rd \oplus Rs \to Rd, \ Rd \oplus \#IMM \to Rd$ |
| | | | Performs a logical exclusive OR operation on a general register and another general register or immediate data |
| NOT | В | | $\sim Rd \rightarrow Rd$ |
| | | | Obtains the one's complement (logical complement) of general register contents |
| Note: * | Size: | Operand | l size |
| | D. | Duto | |

B: Byte

2.5.4 Shift Operations

Table 2.7 describes the eight shift instructions.

Table 2.7 Shift Instructions

| Instruction | Size* | Function |
|-------------|-------|---|
| SHAL | В | Rd shift → Rd |
| SHAR | | Performs an arithmetic shift operation on general register contents |
| SHLL | В | Rd shift → Rd |
| SHLR | | Performs a logical shift operation on general register contents |
| ROTL | В | Rd rotate → Rd |
| ROTR | | Rotates general register contents |
| ROTXL | В | Rd rotate \rightarrow Rd |
| ROTXR | | Rotates general register contents through the carry flag. |
| | | |

Note: * Size: Operand size

B: Byte

Figure 2.6 shows the instruction code format of arithmetic, logic, and shift instructions.

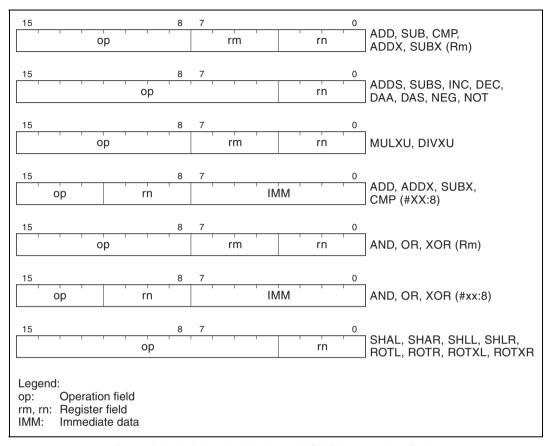


Figure 2.6 Arithmetic, Logic, and Shift Instruction Codes

2.5.5 Bit Manipulations

Table 2.8 describes the bit-manipulation instructions. Figure 2.7 shows their object code formats.

Table 2.8 Bit-Manipulation Instructions

| Instruction | Size* | Function |
|-------------|-------|---|
| BSET | В | $1 \rightarrow (\langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle)$ |
| | | Sets a specified bit to 1 in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BCLR | В | $0 \rightarrow (\text{sbit-No.} > \text{of } < \text{EAd} >)$ |
| | | Clears a specified bit to 0 in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BNOT | В | ~ (<bit-no.> of <ead>) \rightarrow (<bit-no.> of <ead>)</ead></bit-no.></ead></bit-no.> |
| | | Inverts a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BTST | В | \sim (<bit-no.> of <ead>) → Z</ead></bit-no.> |
| | | Tests a specified bit in a general register or memory operand and sets or clears the Z flag accordingly. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BAND | В | $C \land (< bit-No. > of < EAd >) \rightarrow C$ |
| | | ANDs the C flag with a specified bit in a general register or memory operand, and stores the result in the C flag. |
| BIAND | В | $C \wedge [\sim (of)] \rightarrow C$ |
| | | ANDs the C flag with the inverse of a specified bit in a general register or memory operand, and stores the result in the C flag. |
| | | The bit number is specified by 3-bit immediate data. |
| BOR | В | $C \lor (\text{sbit-No.} \Rightarrow \text{cos}) \to C$ |
| | | ORs the C flag with a specified bit in a general register or memory operand, and stores the result in the C flag. |
| BIOR | В | $C \vee [\sim (\text{-bit-No.} > \text{of } <\text{EAd}>)] \rightarrow C$ |
| | | ORs the C flag with the inverse of a specified bit in a general register or memory operand, and stores the result in the C flag. |
| | | The bit number is specified by 3-bit immediate data. |

Note: * Size: Operand size

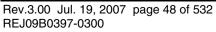
B: Byte

| Instruction | Size* | Function |
|-------------|-------|---|
| BXOR | В | $C \oplus (< bit-No. > of < EAd >) \rightarrow C$ |
| | | XORs the C flag with a specified bit in a general register or memory operand, and stores the result in the C flag. |
| BIXOR | В | $C \oplus [\sim (< bit-No.> of < EAd>)] \rightarrow C$ |
| | | XORs the C flag with the inverse of a specified bit in a general register or memory operand, and stores the result in the C flag. |
| | | The bit number is specified by 3-bit immediate data. |
| BLD | В | $($ < bit-No. $>$ of < EAd $>$ $) \rightarrow C$ |
| | | Copies a specified bit in a general register or memory operand to the C flag. |
| BILD | В | ~ (<bit-no.> of <ead>) \rightarrow C</ead></bit-no.> |
| | | Copies the inverse of a specified bit in a general register or memory operand to the C flag. |
| | | The bit number is specified by 3-bit immediate data. |
| BST | В | $C \rightarrow (\text{sbit-No.} > \text{of } < \text{EAd} >)$ |
| | | Copies the C flag to a specified bit in a general register or memory operand. |
| BIST | В | \sim C \rightarrow (<bit-no.> of <ead>)</ead></bit-no.> |
| | | Copies the inverse of the C flag to a specified bit in a general register or memory operand. |
| - | | The bit number is specified by 3-bit immediate data. |

Note: * Size: Operand size

B: Byte

Certain precautions are required in bit manipulation. See section 2.9.2, Notes on Bit Manipulation, for details.





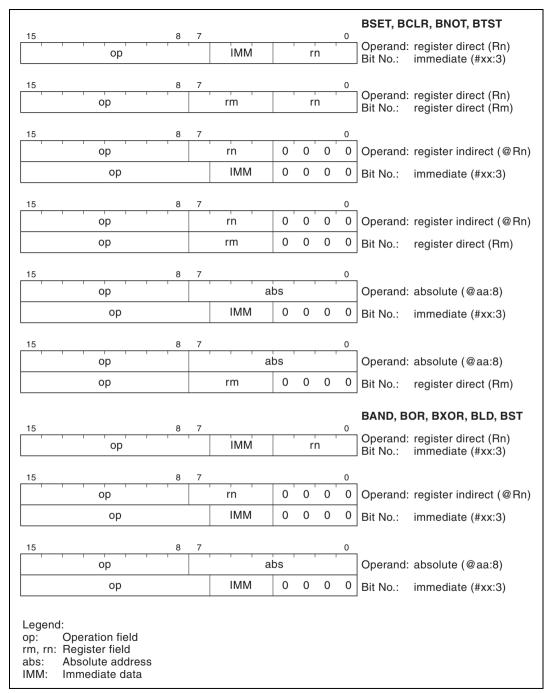


Figure 2.7 Bit Manipulation Instruction Codes (1)

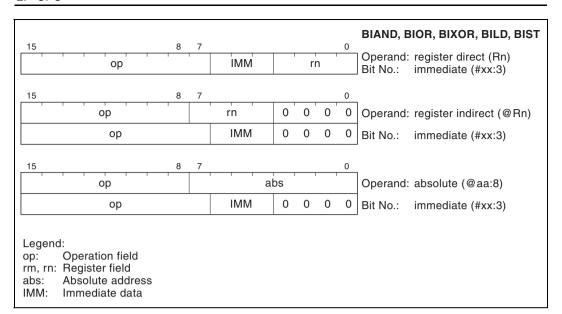


Figure 2.7 Bit Manipulation Instruction Codes (2)

2.5.6 Branching Instructions

Table 2.9 describes the branching instructions. Figure 2.8 shows their object code formats.

Table 2.9 Branching Instructions

| 1 able 2.9 | Diancin | ing mistructions | | | | | | |
|-------------|---------|------------------|--|-----------------|--|--|--|--|
| Instruction | Size | Function | | | | | | |
| Bcc | _ | | Branches to the designated address if the specified condition is true. The branching conditions are given below. | | | | | |
| | | Mnemonic | Description | Condition | | | | |
| | | BRA (BT) | Always (true) | Always | | | | |
| | | BRN (BF) | Never (false) | Never | | | | |
| | | BHI | High | C ∨ Z = 0 | | | | |
| | | BLS | Low or same | C ∨ Z = 1 | | | | |
| | | BCC (BHS) | Carry clear (high or same) | C = 0 | | | | |
| | | BCS (BLO) | Carry set (low) | C = 1 | | | | |
| | | BNE | Not equal | Z = 0 | | | | |
| | | BEQ | Equal | Z = 1 | | | | |
| | | BVC | Overflow clear | V = 0 | | | | |
| | | BVS | Overflow set | V = 1 | | | | |
| | | BPL | Plus | N = 0 | | | | |
| | | ВМІ | Minus | N = 1 | | | | |
| | | BGE | Greater or equal | N ⊕ V = 0 | | | | |
| | | BLT | Less than | N ⊕ V = 1 | | | | |
| | | BGT | Greater than | Z ∨ (N ⊕ V) = 0 | | | | |
| | | BLE | Less or equal | Z ∨ (N ⊕ V) = 1 | | | | |
| | | | Pr. 11 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | | | | | |
| JMP | _ | | onditionally to a specified address | | | | | |
| BSR | _ | Branches to a | subroutine at a specified address | S | | | | |
| JSR | _ | Branches to a | subroutine at a specified address | S | | | | |
| RTS | _ | Returns from a | a subroutine | | | | | |

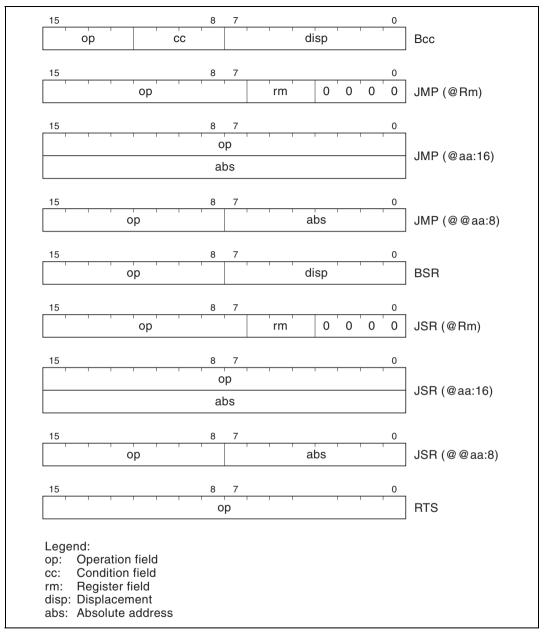


Figure 2.8 Branching Instruction Codes

2.5.7 System Control Instructions

Table 2.10 describes the system control instructions. Figure 2.9 shows their object code formats.

Table 2.10 System Control Instructions

| Instruction | Size* | Function |
|-------------|-------|---|
| RTE | _ | Returns from an exception-handling routine |
| SLEEP | _ | Causes a transition from active mode to a power-down mode. See section 5, Power-Down Modes, for details |
| LDC | В | $Rs \rightarrow CCR$, $\#IMM \rightarrow CCR$ |
| | | Moves immediate data or general register contents to the condition code register |
| STC | В | $CCR \rightarrow Rd$ |
| | | Copies the condition code register to a specified general register |
| ANDC | В | $CCR \land \#IMM \rightarrow CCR$ |
| | | Logically ANDs the condition code register with immediate data |
| ORC | В | $CCR \lor \#IMM \to CCR$ |
| | | Logically ORs the condition code register with immediate data |
| XORC | В | $CCR \oplus \#IMM \rightarrow CCR$ |
| | | Logically exclusive-ORs the condition code register with immediate data |
| NOP | _ | $PC + 2 \rightarrow PC$ |
| | | Only increments the program counter |
| N | _ | |

Note: * Size: Operand size

B: Byte

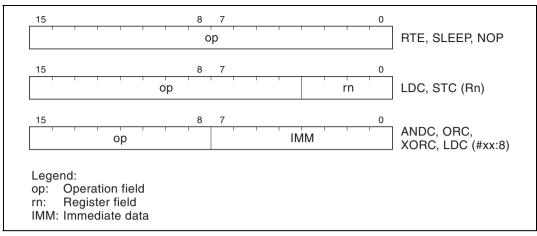


Figure 2.9 System Control Instruction Codes

2.5.8 Block Data Transfer Instruction

Table 2.11 describes the block data transfer instruction. Figure 2.10 shows its object code format.

Table 2.11 Block Data Transfer Instruction

| Instruction | Size | Function |
|-------------|------|--|
| EEPMOV | | if R4L ≠ 0 then |
| | | repeat $@R5+ \rightarrow @R6+$ |
| | | $R4L - 1 \rightarrow R4L$ |
| | | until $R4L = 0$ |
| | | else next; |
| | | Block transfer instruction. Transfers the number of bytes specified by R4L, from locations starting at the address specified by R5, to locations starting at the address specified by R6. On completion of the transfer, the next instruction is executed. |

Certain precautions are required in using the EEPMOV instruction. See section 2.9.3, Notes on Use of the EEPMOV Instruction, for details.

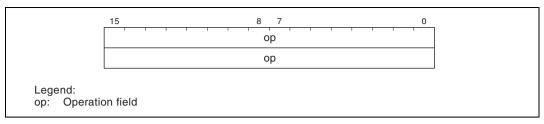


Figure 2.10 Block Data Transfer Instruction Code

2.6 Basic Operational Timing

CPU operation is synchronized by a system clock (ϕ) or a subclock (ϕ_{SUB}) . For details on these clock signals see section 4, Clock Pulse Generators. The period from a rising edge of ϕ or ϕ_{SUB} to the next rising edge is called one state. A bus cycle consists of two states or three states. The cycle differs depending on whether access is to on-chip memory or to on-chip peripheral modules.

2.6.1 Access to On-Chip Memory (RAM, ROM)

Access to on-chip memory takes place in two states. The data bus width is 16 bits, allowing access in byte or word size. Figure 2.11 shows the on-chip memory access cycle.

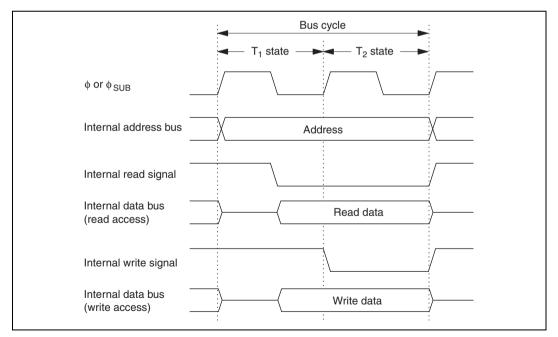


Figure 2.11 On-Chip Memory Access Cycle

2.6.2 Access to On-Chip Peripheral Modules

On-chip peripheral modules are accessed in two states or three states. The data bus width is 8 bits, so access is by byte size only. This means that for accessing word data, two instructions must be used. Figures 2.12 and 2.13 show the on-chip peripheral module access cycle.

Two-State Access to On-Chip Peripheral Modules

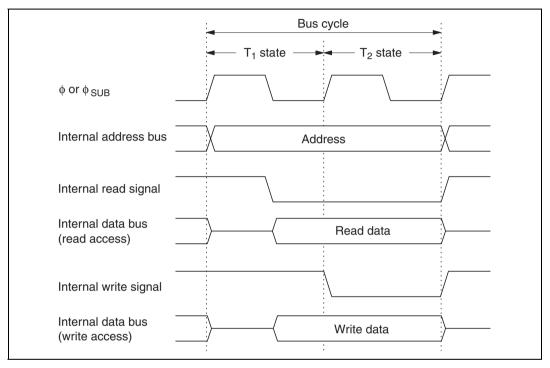


Figure 2.12 On-Chip Peripheral Module Access Cycle (2-State Access)

Three-State Access to On-Chip Peripheral Modules

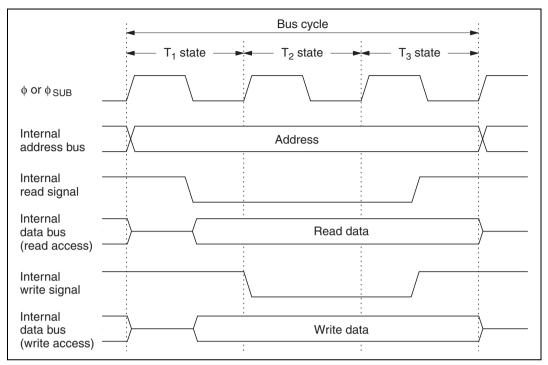


Figure 2.13 On-Chip Peripheral Module Access Cycle (3-State Access)

2.7 CPU States

2.7.1 Overview

There are four CPU states: the reset state, program execution state, program halt state, and exception-handling state. The program execution state includes active (high-speed or medium-speed) mode and subactive mode. In the program halt state there are a sleep mode, standby mode, watch mode, and sub-sleep mode. These states are shown in figure 2.14.

Figure 2.15 shows the state transitions.

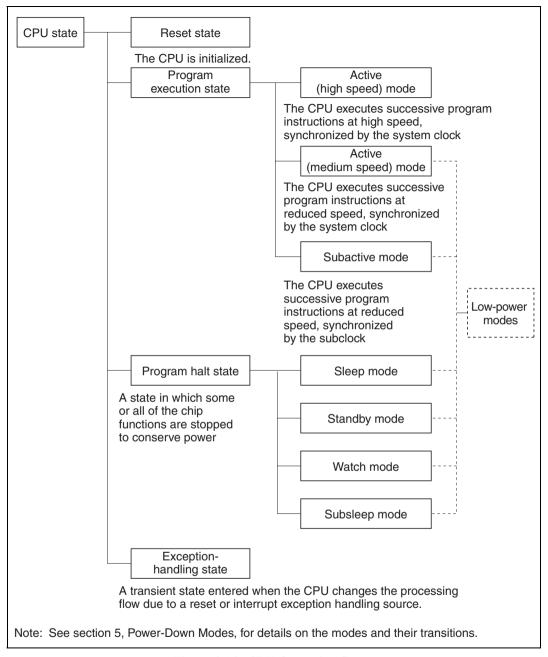


Figure 2.14 CPU Operation States

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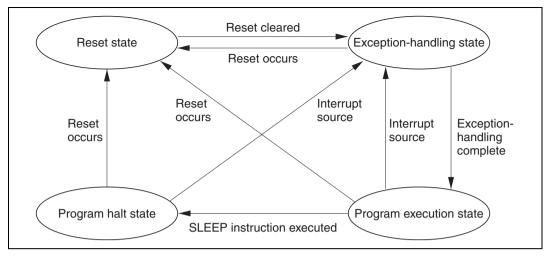


Figure 2.15 State Transitions

2.7.2 Program Execution State

In the program execution state the CPU executes program instructions in sequence.

There are three modes in this state, two active modes (high speed and medium speed) and one subactive mode. Operation is synchronized with the system clock in active mode (high speed and medium speed), and with the subclock in subactive mode. See section 5, Power-Down Modes for details on these modes.

2.7.3 Program Halt State

In the program halt state there are four modes: sleep mode, standby mode, watch mode, and subsleep mode. See section 5, Power-Down Modes for details on these modes.

2.7.4 Exception-Handling State

The exception-handling state is a transient state occurring when exception handling is started by a reset or interrupt and the CPU changes its normal processing flow. In exception handling caused by an interrupt, SP (R7) is referenced and the PC and CCR values are saved on the stack.

For details on interrupt handling, see section 3.3 Interrupts.

2.8 Memory Map

2.8.1 Memory Map

The memory maps of the H8/3857 Group and H8/3854 Group are shown in figures 2.16 (a) and (b).

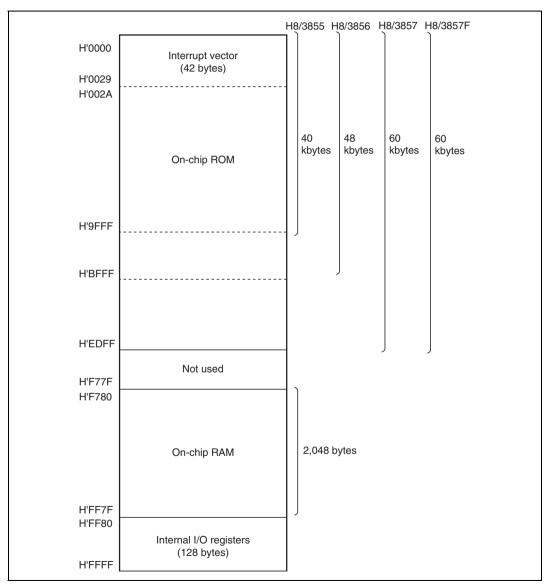


Figure 2.16 (a) H8/3857 Group Memory Map

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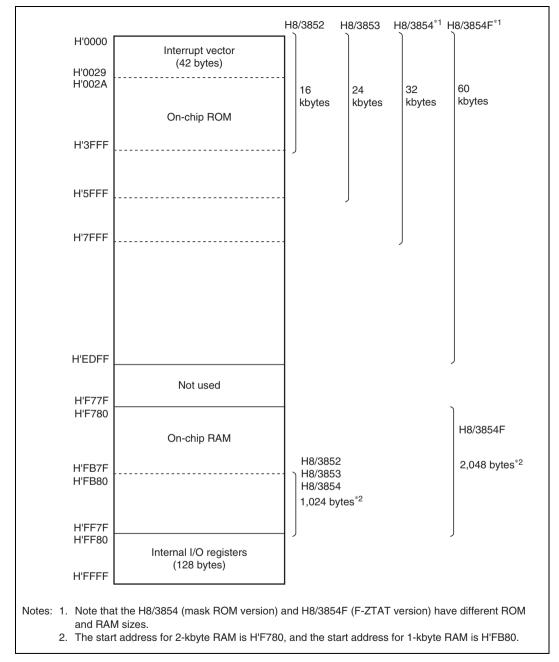


Figure 2.16 (b) H8/3854 Group Memory Map

2.9 Application Notes

2.9.1 Notes on Data Access

Access to Empty Areas: The address space of the H8/300L CPU includes empty areas in addition to the RAM, registers, and ROM areas available to the user. If these empty areas are mistakenly accessed by an application program, the following results will occur.

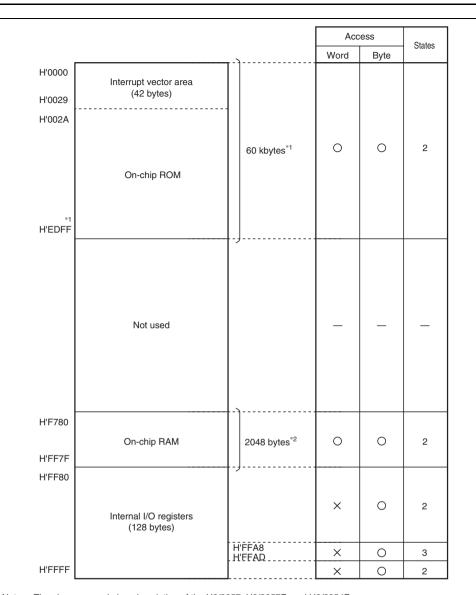
- Data transfer from CPU to empty area
 The transferred data will be lost. This action may also cause the CPU to misoperate.
- Data transfer from empty area to CPU Unpredictable data is transferred.

Access to Internal I/O Registers: Internal data transfer to or from on-chip modules other than the ROM and RAM areas makes use of an 8-bit data width. If word access is attempted to these areas, the following results will occur.

- Word access from CPU to I/O register area
 - Upper byte: Will be written to I/O register.
 - Lower byte: Transferred data will be lost.
- Word access from I/O register to CPU
 - Upper byte: Will be written to upper part of CPU register.
 - Lower byte: Unpredictable data will be written to lower part of CPU register.

Byte size instructions should therefore be used when transferring data to or from I/O registers other than the on-chip ROM and RAM areas. Figure 2.17 shows the data size and number of states in which on-chip peripheral modules can be accessed.





Notes: The above example is a description of the H8/3857, H8/3857F, and H8/3854F.

- The H8/3855 has 40 kbytes of on-chip ROM, ending at address H'9FFF, the H8/3856 has 48 kbytes, ending at address H'BFFF, the H8/3852 has 16 kbytes, ending at address H'3FFF, the H8/3853 has 24 kbytes, ending at address H'5FFF, and the H8/3854 (mask ROM version) has 32 kbytes, ending at address H'7FFF.
- The H8/3857 Group and the H8/3854F have 2,048 bytes of on-chip RAM, and the H8/3854 Group (mask ROM version) has 1,024 bytes, starting at address H'FB80.

Figure 2.17 Data Size and Number of States for Access to and from On-Chip Peripheral Modules

2.9.2 Notes on Bit Manipulation

The BSET, BCLR, BNOT, BST, and BIST instructions read one byte of data, modify the data, then write the data byte again. Special care is required when using these instructions in cases where two registers are assigned to the same address, in the case of registers that include write-only bits, and when the instruction accesses an I/O.

| Order of Operation | | Operation |
|--------------------|--------|---|
| 1 | Read | Read byte data at the designated address |
| 2 | Modify | Modify a designated bit in the read data |
| 3 | Write | Write the altered byte data to the designated address |

Bit Manipulation in Two Registers Assigned to the Same Address

Example 1: Timer load register and timer count bit manipulation

Figure 2.18 shows an example in which two timer registers share the same address. When a bit manipulation instruction accesses the timer load register and timer counter of a reloadable timer, since these two registers share the same address, the following operations take place.

| Order of Operation | | Operation | | | | |
|--------------------|--------|---|--|--|--|--|
| 1 | Read | Timer counter data is read (one byte) | | | | |
| 2 | Modify | The CPU modifies (sets or resets) the bit designated in the instruction | | | | |
| 3 | Write | The altered byte data is written to the timer load register | | | | |

The timer counter is counting, so the value read is not necessarily the same as the value in the timer load register. As a result, bits other than the intended bit in the timer load register may be modified to the timer counter value.

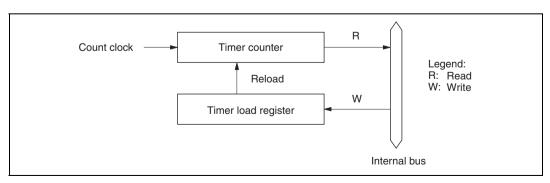


Figure 2.18 Timer Configuration Example

Example 2: When a BSET instruction is executed on port 3

 $P3_7$ and $P3_6$ are designated as input pins, with a low-level signal input at $P3_7$ and a high-level signal at $P3_6$. The remaining pins, $P3_5$ to $P3_9$, are output pins and output low-level signals. In this example, the BSET instruction is used to change pin $P3_9$ to high-level output.

[A: Prior to executing BSET]

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 ₀ |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

[B: BSET instruction executed]

| BSET | #0 | , | @PDR3 |
|------|----|---|-------|
| | | | |

The BSET instruction is executed designating port 3.

[C: After executing BSET]

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3, | P3 _o |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|--------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR3 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 |

[D: Explanation of how BSET operates]

When the BSET instruction is executed, first the CPU reads port 3.

Since $P3_7$ and $P3_6$ are input pins, the CPU reads the pin states (low-level and high-level input). $P3_5$ to $P3_0$ are output pins, so the CPU reads the value in PDR3. In this example PDR3 has a value of H'80, but the value read by the CPU is H'40.

Next, the CPU sets bit 0 of the read data to 1, changing the PDR3 data to H'41. Finally, the CPU writes this value (H'41) to PDR3, completing execution of BSET.

As a result of this operation, bit 0 in PDR3 becomes 1, and P3₀ outputs a high-level signal. However, bits 7 and 6 of PDR3 end up with different values.

To avoid this problem, store a copy of the PDR3 data in a work area in memory. Perform the bit manipulation on the data in the work area, then write this data to PDR3.

[A: Prior to executing BSET]

| MOV. | В | #80, | ROL |
|------|---|------|-------|
| MOV. | В | ROL, | @RAM0 |
| MOV. | В | ROL, | @PDR3 |

The PDR3 value (H'80) is written to a work area in memory (RAM0) as well as to PDR3.

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 _o |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RAM0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

[B: BSET instruction executed]

| BSET | #0 | , | @RAM0 |
|------|----|---|-------|
| | | | |

The BSET instruction is executed designating the PDR3 work area (RAM0).

[C: After executing BSET]

The work area (RAM0) value is written to PDR3.

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 ₀ |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| RAM0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

Bit Manipulation in a Register Containing a Write-Only Bit

Example 3: When a BCLR instruction is executed on PCR3 of port 3

As in the examples above, $P3_7$ and $P3_6$ are input pins, with a low-level signal input at $P3_7$ and a high-level signal at $P3_6$. The remaining pins, $P3_5$ to $P3_0$, are output pins that output low-level signals. In this example, the BCLR instruction is used to change pin $P3_0$ to an input port. It is assumed that a high-level signal will be input to this input pin.

[A: Prior to executing BCLR]

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3, | P3 ₀ |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|--------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

[B: BCLR instruction executed]

| BCLR | #0 | , | @PCR3 |
|------|----|---|-------|
| | | | |

The BCLR instruction is executed designating PCR3.

[C: After executing BCLR]

| | P3, | P3 ₆ | P3₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3, | P3 _o |
|--------------|--------------|-----------------|--------------|-----------------|-----------------|-----------------|--------------|-----------------|
| Input/output | Output | Output | Output | Output | Output | Output | Output | Input |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR3 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

[D: Explanation of how BCLR operates]

When the BCLR instruction is executed, first the CPU reads PCR3. Since PCR3 is a write-only register, the CPU reads a value of H'FF, even though the PCR3 value is actually H'3F.

Next, the CPU clears bit 0 in the read data to 0, changing the data to H'FE. Finally, this value (H'FE) is written to PCR3 and BCLR instruction execution ends.

As a result of this operation, bit 0 in PCR3 becomes 0, making P3₀ an input port. However, bits 7 and 6 in PCR3 change to 1, so that P3, and P3, change from input pins to output pins.

To avoid this problem, store a copy of the PCR3 data in a work area in memory. Perform the bit manipulation on the data in the work area, then write this data to PCR3.

[A: Prior to executing BCLR]

| MOV. | В | #3F, | ROL |
|------|---|------|-------|
| MOV. | В | ROL, | @RAM0 |
| MOV. | В | ROL, | @PCR3 |

The PCR3 value (H'3F) is written to a work area in memory (RAM0) as well as to PCR3.

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 _o |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RAM0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |

[B: BCLR instruction executed]

| BCLR | #0 | , | @RAM0 |
|------|----|---|-------|
| | | | |

The BCLR instruction is executed designating the PCR3 work area (RAM0).

[C: After executing BCLR]

| MOV. | В | @RAM0, | ROL |
|------|---|--------|-------|
| MOV. | В | ROL, | @PCR3 |

The work area (RAM0) value is written to PCR3.

| | P3, | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 ₀ |
|--------------|--------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR3 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| PDR3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RAM0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |



Table 2.12 lists registers that share the same address, and table 2.13 lists registers that contain write-only bits.

Table 2.12 Registers with shared addresses

| Register Name | Abbreviation | Address |
|---|--------------|---------|
| Timer counter B and timer load register B | TCB/TLB | H'FFB3 |
| Timer counter C and timer load register C*2 | TCC/TLC | H'FFB5 |
| Port data register 1*1*3 | PDR1 | H'FFD4 |
| Port data register 2*1 | PDR2 | H'FFD5 |
| Port data register 3*1*2 | PDR3 | H'FFD6 |
| Port data register 4*1 | PDR4 | H'FFD7 |
| Port data register 5*1 | PDR5 | H'FFD8 |
| Port data register 9*1 | PDR9 | H'FFDC |
| Port data register A*1 | PDRA | H'FFDD |

Notes: 1. These port registers are used also for pin input.

- 2. A function of the H8/3857 Group only; not provided in the H8/3854 Group.
- 3. Some bits are not present in the H8/3854 Group.

Table 2.13 Registers with write-only bits

| Register Name | Abbreviation | Address |
|---------------------------|--------------|---------|
| Port control register 1*1 | PCR1 | H'FFE4 |
| Port control register 2 | PCR2 | H'FFE5 |
| Port control register 3*2 | PCR3 | H'FFE6 |
| Port control register 4 | PCR4 | H'FFE7 |
| Port control register 5 | PCR5 | H'FFE8 |
| Port control register 9 | PCR9 | H'FFEC |
| Port control register A | PCRA | H'FFED |
| Timer control register F | TCRF | H'FFB6 |
| PWM control register*2 | PWCR | H'FFD0 |
| PWM data register U*2 | PWDRU | H'FFD1 |
| PWM data register L*2 | PWDRL | H'FFD2 |

Notes: 1. Some bits are not present in the H8/3854 Group.

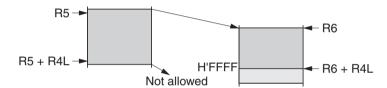
2. A function of the H8/3857 Group only; not provided in the H8/3854 Group.

2.9.3 Notes on Use of the EEPMOV Instruction

• The EEPMOV instruction is a block data transfer instruction. It moves the number of bytes specified by R4L from the address specified by R5 to the address specified by R6.



 When setting R4L and R6, make sure that the final destination address (R6 + R4L) does not exceed H'FFFF. The value in R6 must not change from H'FFFF to H'0000 during execution of the instruction.



Section 3 Exception Handling

3.1 Overview

Exception handling is performed in the H8/3857 Group when a reset or interrupt occurs. Table 3.1 shows the priorities of these two types of exception handling.

Table 3.1 Exception Handling Types and Priorities

| Priority | Exception Source | Time of Start of Exception Handling |
|----------|-------------------------|--|
| High | Reset | Exception handling starts as soon as the reset state is cleared |
| l ow | Interrupt | When an interrupt is requested, exception handling starts after execution of the present instruction or the exception handling in progress is completed. |
| Low | | in progress is completed |

3.2 Reset

3.2.1 Overview

A reset is the highest-priority exception. The internal state of the CPU and the registers of the onchip peripheral modules are initialized.

3.2.2 Reset Sequence

As soon as the \overline{RES} pin goes low, all processing is stopped and the H8/3857 enters the reset state.

To make sure the chip is reset properly, observe the following precautions.

- At power on: Hold the \overline{RES} pin low until the clock pulse generator output stabilizes.
- Resetting during operation: Hold the RES pin low for at least 10 system clock cycles.

When the \overline{RES} pin goes high again after being held low for a given period, reset exception handling begins. Reset exception handling takes place as follows:

- The CPU internal state and the registers of on-chip peripheral modules are initialized, with the I bit of the condition code register (CCR) set to 1.
- The PC is loaded from the reset exception handling vector address (H'0000 to H'0001), after which the program starts executing from the address indicated in PC.

When system power is turned on or off, the \overline{RES} pin should be held low.

Figure 3.1 shows the reset sequence.

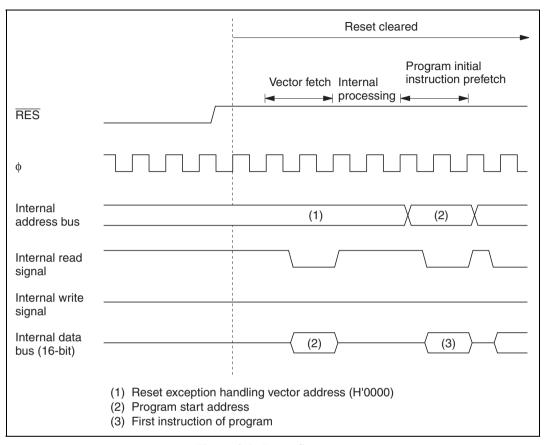


Figure 3.1 Reset Sequence

3.2.3 Interrupt Immediately after Reset

After a reset, if an interrupt were to be accepted before the stack pointer (SP: R7) was initialized, PC and CCR would not be pushed onto the stack correctly, resulting in program runaway. To prevent this, immediately after reset exception handling all interrupts are masked. For this reason, the initial program instruction is always executed immediately after a reset. This instruction should initialize the stack pointer (e.g. MOV.W #xx: 16, SP).

3.3 Interrupts

3.3.1 Overview

In the H8/3857 Group, sources that initiate interrupt exception handling include 13 external interrupts (WKP $_7$ to WKP $_0$, and IRQ $_4$ to IRQ $_0$), and 16 internal interrupts from on-chip peripheral modules. In the H8/3854 Group, sources that initiate interrupt exception handling include 12 external interrupts (WKP $_7$ to WKP $_0$, IRQ $_4$, IRQ $_3$, IRQ $_1$, and IRQ $_0$), and 14 internal interrupts from on-chip peripheral modules. Table 3.2 shows the interrupt sources, their priorities, and their vector addresses. When more than one interrupt is requested, the interrupt with the highest priority is processed.

The interrupts have the following features:

- Both internal and external interrupts can be masked by the I bit of CCR. When this bit is set to 1, interrupt request flags are set but interrupts are not accepted.
- The external interrupt pins IRQ₀ to IRQ₄ can each be set independently to either rising edge sensing or falling edge sensing.

Table 3.2 Interrupt Sources and Priorities

| Priority | Interrupt Source | Interrupt | Vector Number | Vector Address*1 |
|----------|---|-------------------------------|------------------|------------------|
| High | RES | Reset | 0 | H'0000 to H'0001 |
| 1 | ĪRQ₀ | IRQ₀ | 4 | H'0008 to H'0009 |
| | ĪRQ ₁ | IRQ, | 5 | H'000A to H'000B |
| | $\overline{IRQ}_{\scriptscriptstyle 2}^{*^2}$ | $IRQ_{\scriptscriptstyle 2}$ | 6 | H'000C to H'000D |
| | $\overline{IRQ}_{\scriptscriptstyle 3}$ | IRQ_3 | 7 | H'000E to H'000F |
| | ĪRQ₄ | IRQ₄ | 8 | H'0010 to H'0011 |
| | WKP _₀ | WKP ₀ | 9 | H'0012 to H'0013 |
| | WKP ₁ | WKP, | | |
| | $\overline{WKP}_{\scriptscriptstyle 2}$ | WKP ₂ | | |
| | $\overline{WKP}_{\scriptscriptstyle 3}$ | WKP ₃ | | |
| | $\overline{WKP}_{_{4}}$ | WKP₄ | | |
| | $\overline{WKP}_{\scriptscriptstyle{5}}$ | WKP ₅ | | |
| | $\overline{WK}P_{\scriptscriptstyle{6}}$ | WKP ₆ | | |
| | \overline{WKP}_{7} | WKP ₇ | | |
| | SCI1*2 | SCI1 transfer complete | 10 | H'0014 to H'0015 |
| | Timer A | Timer A overflow | 11 | H'0016 to H'0017 |
| | Timer B | Timer B overflow | 12 | H'0018 to H'0019 |
| | Timer C*2 | Timer C overflow or underflow | 13 | H'001A to H'001B |
| | Timer FL | Timer FL compare match | 14 | H'001C to H'001D |
| | | Timer FL overflow | | |
| | Timer FH | Timer FH compare match | 15 | H'001E to H'001F |
| | | Timer FH overflow | | |
| | SCI3 | SCI3 transmit end | 18 | H'0024 to H'0025 |
| | | SCI3 transmit data empty | | |
| | | SCI3 receive data full | | |
| | | SCI3 overrun error | | |
| | | SCI3 framing error | | |
| | | SCI3 parity error | | |
| | A/D converter | A/D conversion end | 19 | H'0026 to H'0027 |
| ↓ Low | (SLEEP instruction executed) | Direct transfer | 20 | H'0028 to H'0029 |

Notes: 1. Vector addresses H'0002 to H'0007 and H'0020 to H'0023 are reserved and cannot be used.

2. Applies to the H8/3857 Group. In the H8/3854 Group, these vector addresses are reserved.

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3.3.2 Interrupt Control Registers

Table 3.3 lists the registers that control interrupts.

Table 3.3 Interrupt Control Registers

| Register Name | Abbreviation | R/W | Initial Value | Address |
|-----------------------------------|--------------|-------------------|---------------|---------|
| IRQ edge select register*2 | IEGR | R/W | H'E0 | H'FFF2 |
| Interrupt enable register 1*2 | IENR1 | R/W | H'00 | H'FFF3 |
| Interrupt enable register 2*2 | IENR2 | R/W | H'00 | H'FFF4 |
| Interrupt request register 1*2 | IRR1 | R/W* ¹ | H'20 | H'FFF6 |
| Interrupt request register 2*2 | IRR2 | R/W*1 | H'00 | H'FFF7 |
| Wakeup interrupt request register | IWPR | R/W*1 | H'00 | H'FFF9 |

Notes: 1. Write is enabled only for writing of 0 to clear a flag.

2. There are some differences in functions between the H8/3857 Group and the H8/3854 Group. For details, see the individual register descriptions.

IRQ Edge Select Register (IEGR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|------|------|-------|------|------|
| | | | | IEG4 | IEG3 | IEG2* | IEG1 | IEG0 |
| Initial value | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | R/W | R/W | R/W | R/W | R/W |

Note: * Applies to the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

IEGR is an 8-bit read/write register, used to designate whether pins \overline{IRQ}_0 to \overline{IRQ}_4 are set to rising edge sensing or falling edge sensing.

Bits 7 to 5—Reserved Bits: Bits 7 to 5 are reserved; they are always read as 1, and cannot be modified.

Bit 4—IRQ₄ Edge Select (IEG4): Bit 4 selects the input sensing of pin $\overline{IRQ}_4/\overline{ADTRG}$.

| Bit 4: IEG4 | Description | |
|-------------|--|-----------------|
| 0 | Falling edge of IRQ4/ADTRG pin input is detected | (initial value) |
| 1 | Rising edge of IRQ,/ADTRG pin input is detected | |

Bit 3—IRQ, Edge Select (IEG3): Bit 3 selects the input sensing of pin IRQ,/TMIF.

| Bit 3: IEG3 | Description | |
|-------------|--|-----------------|
| 0 | Falling edge of IRQ ₃ /TMIF pin input is detected | (initial value) |
| 1 | Rising edge of IRQ ₃ /TMIF pin input is detected | |

Bit 2—IRQ₂ Edge Select (IEG2): Bit 2 is used in the H8/3857 Group to select the input sensing of pin \overline{IRQ} ,/TMIC. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 2: IEG2 | Description | |
|-------------|--|-----------------|
| 0 | Falling edge of IRQ ₂ /TMIC pin input is detected | (initial value) |
| 1 | Rising edge of IRQ ₂ /TMIC pin input is detected | |

Bit 1—IRQ₁ Edge Select (IEG1): Bit 1 selects the input sensing of pin \overline{IRQ} ₁/TMIB.

| Bit 1: IEG1 | Description | |
|-------------|---|-----------------|
| 0 | Falling edge of IRQ,/TMIB pin input is detected | (initial value) |
| 1 | Rising edge of IRQ,/TMIB pin input is detected | |

Bit 0—IRQ₀ Edge Select (IEG0): Bit 0 selects the input sensing of pin \overline{IRQ}_0 .

| Bit 0: IEG0 | Description | |
|-------------|--|-----------------|
| 0 | Falling edge of $\overline{\text{IRQ}}_{\scriptscriptstyle 0}$ pin input is detected | (initial value) |
| 1 | Rising edge of $\overline{\text{IRQ}}_{\scriptscriptstyle 0}$ pin input is detected | |

Interrupt Enable Register 1 (IENR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|--------|-------|------|------|-------|------|------|
| | IENTA | IENS1* | IENWP | IEN4 | IEN3 | IEN2* | IEN1 | IEN0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Applies to the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

IENR1 is an 8-bit read/write register that enables or disables interrupt requests.



Bit 7—Timer A Interrupt Enable (IENTA): Bit 7 enables or disables timer A overflow interrupt requests.

| Bit 7: IENTA | Description | |
|--------------|-----------------------------|-----------------|
| 0 | Disables timer A interrupts | (initial value) |
| 1 | Enables timer A interrupts | _ |

Bit 6—SCI1 Interrupt Enable (IENS1): Bit 6 is used in the H8/3857 Group to enable or disable SCI1 transfer complete interrupt requests. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 6: IENS1 | Description | |
|--------------|--------------------------|-----------------|
| 0 | Disables SCI1 interrupts | (initial value) |
| 1 | Enables SCI1 interrupts | _ |

Bit 5—Wakeup Interrupt Enable (IENWP): Bit 5 enables or disables WKP₇ to WKP₀ interrupt requests.

| Bit 5: IENWP | Description | |
|--------------|---|-----------------|
| 0 | Disables interrupt requests from $\overline{\text{WKP}}_{_7}$ to $\overline{\text{WKP}}_{_0}$ | (initial value) |
| 1 | Enables interrupt requests from WKP, to WKP | _ |

Bits 4, 3, 1, and 0—IRQ,, IRQ,, IRQ,, and IRQ, Interrupt Enable (IEN4, IEN3, IEN1,

IEN0): Bits 4 to 0 enable or disable \overline{IRQ}_4 , \overline{IRQ}_3 , \overline{IRQ}_1 , and \overline{IRQ}_0 interrupt requests.

| Bit n: IENn | Description | |
|-------------|---------------------------------|-----------------|
| 0 | Disables interrupt request IRQn | (initial value) |
| 1 | Enables interrupt request IRQn | |

Note: n = 4, 3, 1, or 0

Bit 2—IRQ₂ **Interrupt Enable (IEN2):** Bit 2 is used in the H8/3857 Group to enable or disable $\overline{\text{IRQ}}_2$ interrupt requests. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 2: IEN2 | Description | |
|-------------|--|-----------------|
| 0 | Disables interrupt request $\overline{IRQ}_{\scriptscriptstyle{2}}$ | (initial value) |
| 1 | Enables interrupt request $\overline{\text{IRQ}}_{\scriptscriptstyle 2}$ | |

Interrupt Enable Register 2 (IENR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-----|-----|--------|--------|--------|-------|
| | IENDT | IENAD | _ | _ | IENTFH | IENTFL | IENTC* | IENTB |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Applies to the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

IENR2 is an 8-bit read/write register that enables or disables interrupt requests.

Bit 7—Direct Transfer Interrupt Enable (IENDT): Bit 7 enables or disables direct transfer interrupt requests.

| Bit 7: IENDT | Description | |
|--------------|---|-----------------|
| 0 | Disables direct transfer interrupt requests | (initial value) |
| 1 | Enables direct transfer interrupt requests | |

Bit 6—A/D Converter Interrupt Enable (IENAD): Bit 6 enables or disables A/D converter interrupt requests.

| Bit 6: IENAD | Description | |
|--------------|---|-----------------|
| 0 | Disables A/D converter interrupt requests | (initial value) |
| 1 | Enables A/D converter interrupt requests | |

Bits 5 and 4—Reserved Bits: Bits 5 and 4 are reserved; they should always be cleared to 0.

Bit 3—Timer FH Interrupt Enable (IENTFH): Bit 3 enables or disables timer FH compare match and overflow interrupt requests.

| Bit 3: IENTFH | Description | |
|---------------|------------------------------|-----------------|
| 0 | Disables timer FH interrupts | (initial value) |
| 1 | Enables timer FH interrupts | _ |

Bit 2—Timer FL Interrupt Enable (IENTFL): Bit 2 enables or disables timer FL compare match and overflow interrupt requests.

| Bit 2: IENTFL | Description | |
|---------------|------------------------------|-----------------|
| 0 | Disables timer FL interrupts | (initial value) |
| 1 | Enables timer FL interrupts | |

Bit 1—Timer C Interrupt Enable (IENTC): Bit 1 is used in the H8/3857 Group to enable or disable timer C overflow or underflow interrupt requests. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 1: IENTC | Description | |
|--------------|-----------------------------|-----------------|
| 0 | Disables timer C interrupts | (initial value) |
| 1 | Enables timer C interrupts | |

Bit 0—Timer B Interrupt Enable (IENTB): Bit 0 enables or disables timer B overflow or underflow interrupt requests.

| Bit 0: IENTB | Description | |
|--------------|-----------------------------|-----------------|
| 0 | Disables timer B interrupts | (initial value) |
| 1 | Enables timer B interrupts | |

SCI3 interrupt control is covered in 10.4.2, in the description of serial control register 3 (SCR3).

Interrupt request register 1 (IRR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|---------|---|-------|-------|---------|-------|-------|
| | IRRTA | IRRS1*2 | | IRRI4 | IRRI3 | IRRI2*2 | IRRI1 | IRRI0 |
| Initial value | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W*1 | R/W*1 | | R/W*1 | R/W*1 | R/W*1 | R/W*1 | R/W*1 |

Notes: 1. Only a write of 0 for flag clearing is possible.

2. Applies to the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

IRR1 is an 8-bit read/write register, in which the corresponding bit is set to 1 when a timer A, SCI1, or IRQ₄ to IRQ₀ interrupt is requested. The flags are not cleared automatically when an interrupt is accepted. It is necessary to write 0 to clear each flag.

Bit 7—Timer A Interrupt Request Flag (IRRTA)

| Bit 7: IRRTA | Description | |
|--------------|--|-----------------|
| 0 | Clearing condition: When IRRTA = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When the timer A counter value overflows (goes from H'FF to H'C | 00) |

Bit 6—SCI1 Interrupt Request Flag (IRRS1): Bit 6 is used in the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 6: IRRS1 | Description | |
|--------------|---|-----------------|
| 0 | Clearing condition: When IRRS1 = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When an SCI1 transfer is completed | |

Bit 5—Reserved Bit: Bit 5 is reserved; it is always read as 1, and cannot be modified.

Bits 4, 3, 1, and 0—IRQ, IRQ, IRQ, and IRQ Interrupt Request Flags (IRRI4, IRRI3, IRRI1, IRRI0)

| Bit n: IRRIn | Description | |
|--------------|--|---|
| 0 | Clearing condition: When IRRIn = 1, it is cleared by writing 0 to IRRIn (initial value) | , |
| 1 | Setting condition: IRRIn is set when pin $\overline{IRQ}_{_{n}}$ is set to interrupt input, and the designated signal edge is detected | _ |

Note: n = 4, 3, 1, or 0

Bit 2—IRQ, Interrupt Request Flag (IRRI2): Bit 2 is used in the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 2: IRRI2 | Description | |
|--------------|---|--------|
| 0 | Clearing condition: When IRRI2 = 1, it is cleared by write 0 to IRRI2 (initial | value) |
| 1 | Setting condition: IRRI2 is set when pin $\overline{\text{IRQ}}_2$ is set to interrupt input, and the designated signedge is detected | gnal |

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Interrupt Request Register 2 (IRR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|---|---|--------|--------|---------|-------|
| | IRRDT | IRRAD | _ | _ | IRRTFH | IRRTFL | IRRTC*2 | IRRTB |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W*1 | R/W*1 | | _ | R/W*1 | R/W*1 | R/W*1 | R/W*1 |

Notes: 1. Only a write of 0 for flag clearing is possible.

2. Applies to the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

IRR2 is an 8-bit read/write register, in which the corresponding bit is set to 1 when a direct transfer, A/D converter, timer FH, timer FL, timer C, or timer B interrupt is requested. The flags are not cleared automatically when an interrupt is accepted. It is necessary to write 0 to clear each flag.

Bit 7—Direct Transfer Interrupt Request Flag (IRRDT)

| Bit 7: IRRDT | Description | |
|--------------|---|-----------------|
| 0 | Clearing condition: When IRRDT = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When DTON = 1 and a direct transfer is made immediately after a instruction is executed | a SLEEP |

Bit 6—A/D Converter Interrupt Request Flag (IRRAD)

| Bit 6: IRRAD | Description | |
|--------------|---|-----------------|
| 0 | Clearing condition: When IRRAD = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When A/D conversion is completed and ADSF is reset | |

Bits 5 and 4—Reserved Bits: Bits 5 and 4 are reserved; they should always be cleared to 0.

Bit 3—Timer FH Interrupt Request Flag (IRRTFH)

| Bit 3: IRRTFH | Description | |
|---------------|---|-----------------|
| 0 | Clearing condition: When IRRTFH = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When counter FH matches output compare register FH in 8-bit tir when 16-bit counter F (TCFL, TCFH) matches output compare re (OCRFL, OCRFH) in 16-bit timer mode | |

Bit 2—Timer FL Interrupt Request Flag (IRRTFL)

| Bit 2: IRRTFL | Description | |
|---------------|--|-----------------|
| 0 | Clearing condition When IRRTFL = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When counter FL matches output compare register FL in 8-bit til | mer mode |

Bit 1—Timer C Interrupt Request Flag (IRRTC): Bit 1 is used in the H8/3857 Group. In the H8/3854 Group, this bit must always be cleared to 0.

| Bit 1: IRRTC | Description | |
|--------------|--|-----------------|
| 0 | Clearing condition: When IRRTC = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When the timer C counter value overflows (goes from H'FF to H'0 underflows (goes from H'00 to H'FF) | 0) or |

Bit 0—Timer B Interrupt Request Flag (IRRTB)

| Bit 0: IRRTB | Description | |
|--------------|--|-----------------|
| 0 | Clearing condition: When IRRTB = 1, it is cleared by writing 0 | (initial value) |
| 1 | Setting condition: When the timer B counter value overflows (goes from H'FF to H'0 | 00) |

Wakeup Interrupt Request Register (IWPR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | IWPF7 | IWPF6 | IWPF5 | IWPF4 | IWPF3 | IWPF2 | IWPF1 | IWPF0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W* |

Note: * Only a write of 0 for flag clearing is possible.

IWPR is an 8-bit read/write register, in which the corresponding bit is set to 1 when pins \overline{WKP} , to \overline{WKP}_0 are set to wakeup input and a pin receives a falling edge input. The flags are not cleared automatically when an interrupt is accepted. It is necessary to write 0 to clear each flag.

Bits 7 to 0—Wakeup Interrupt Request Flags (WKPF7 to WKPF0)

| Bit n: IWPFn | Description |
|--------------|--|
| 0 | Clearing condition: When IWPFn = 1, it is cleared by writing 0 to IWPFn |
| 1 | Setting condition: IWPFn is set when pin $\overline{WKP}_{_{n}}$ is set to wakeup interrupt input, and a falling edge input is detected at the pin |

Note: n = 7 to 0

3.3.3 External Interrupts

The H8/3857 Group has 13 external interrupt sources, WKP₇ to WKP₀, and IRQ₄ to IRQ₀. The H8/3854 Group has 12 external interrupt sources, WKP₇ to WKP₀, IRQ₄, IRQ₃, IRQ₁, and IRQ₀.

Interrupts WKP₀ to WKP₇: Interrupts WKP₀ to WKP₇ are requested by falling edge inputs at pins $\overline{WKP_0}$ to $\overline{WKP_0}$, to $\overline{WKP_0}$, to $\overline{WKP_0}$, when these pins are designated as $\overline{WKP_0}$ to $\overline{WKP_0}$ pins in port mode register 5 (PMR5) and falling edge input is detected, the corresponding bit in the wakeup interrupt request register (IWPR) is set to 1, requesting an interrupt. Wakeup interrupt requests can be disabled by clearing the IENWP bit in IENR1 to 0. It is also possible to mask all interrupts by setting the CCR I bit to 1.

When an interrupt exception handling request is received for interrupts WKP₀ to WKP₇, the CCR I bit is set to 1. The vector number for interrupts WKP₀ to WKP₇ is 9. Since all eight interrupts are assigned the same vector number, the interrupt source must be determined by the exception handling routine.

Interrupts IRQ₀ to IRQ₄: Interrupts IRQ₀ to IRQ₄ are requested by into pins inputs to $\overline{\text{IRQ}}_0$ to $\overline{\text{IRQ}}_4$. These interrupts are detected by either rising edge sensing or falling edge sensing, depending on the settings of bits IEG0 to IEG4 in the edge select register (IEGR). The IRQ₂ interrupt is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

When these pins are designated as pins \overline{IRQ}_0 to \overline{IRQ}_4 in port mode registers 1 and 2 (PMR1 and PMR2) and the designated edge is input, the corresponding bit in IRR1 is set to 1, requesting an interrupt. Interrupts IRQ_0 to IRQ_4 can be disabled by clearing bits IEN0 to IEN4 in IENR1 to 0. All interrupts can be masked by setting the I bit in CCR to 1.

When IRQ_0 to IRQ_4 interrupt exception handling is initiated, the I bit is set to 1. Vector numbers 4 to 8 are assigned to interrupts IRQ_0 to IRQ_4 . The order of priority is from IRQ_0 (high) to IRQ_4 (low). Table 3.2 gives details. In the H8/3854 Group, exception handling vector number 6 is reserved.

3.3.4 Internal Interrupts

There are 16 internal interrupts that can be requested by the on-chip peripheral modules in the H8/3857 Group, and 14 in the H8/3854 Group. When a peripheral module requests an interrupt, the corresponding bit in IRR1 or IRR2 is set to 1. Individual interrupt requests can be disabled by clearing the corresponding bit in IENR1 or IENR2 to 0. All interrupts can be masked by setting the I bit in CCR to 1. When an internal interrupt request is accepted, the I bit is set to 1. Vector numbers 10 to 20 are assigned to these interrupts. Table 3.2 shows the order of priority of interrupts from on-chip peripheral modules. In the H8/3854 Group, exception handling vector numbers 10 and 13 are reserved.

3.3.5 Interrupt Operations

Interrupts are controlled by an interrupt controller. Figure 3.2 shows a block diagram of the interrupt controller. Figure 3.3 shows the flow up to interrupt acceptance.

Interrupt operation is described as follows.

- When an interrupt condition is met while the interrupt enable register bit is set to 1, an interrupt request signal is sent to the interrupt controller.
- When the interrupt controller receives an interrupt request, it sets the interrupt request flag.
- From among the interrupts with interrupt request flags set to 1, the interrupt controller selects the interrupt request with the highest priority and holds the others pending. (Refer to table 3.2 for a list of interrupt priorities.)
- The interrupt controller checks the I bit of CCR. If the I bit is 0, the selected interrupt request is accepted; if the I bit is 1, the interrupt request is held pending.



- If the interrupt is accepted, after processing of the current instruction is completed, both PC and CCR are pushed onto the stack. The state of the stack at this time is shown in figure 3.4. The PC value pushed onto the stack is the address of the first instruction to be executed upon return from interrupt handling.
- The I bit of CCR is set to 1, masking all further interrupts.
- The vector address corresponding to the accepted interrupt is generated, and the interrupt handling routine located at the address indicated by the contents of the vector address is executed.
- Notes: 1. When disabling interrupts by clearing bits in an interrupt enable register, or when clearing bits in an interrupt request register, always do so while interrupts are masked (I = 1).
 - 2. If the above clear operations are performed while I = 0, and as a result a conflict arises between the clear instruction and an interrupt request, exception processing for the interrupt will be executed after the clear instruction has been executed.

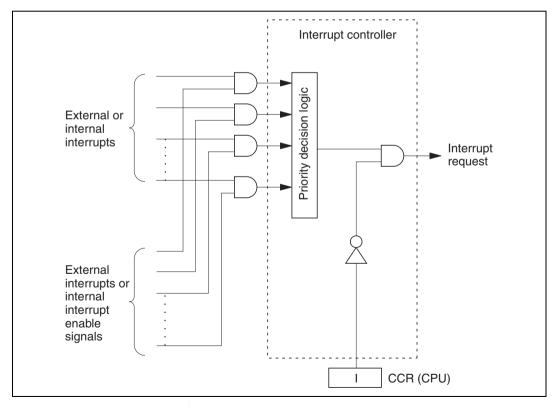


Figure 3.2 Block Diagram of Interrupt Controller

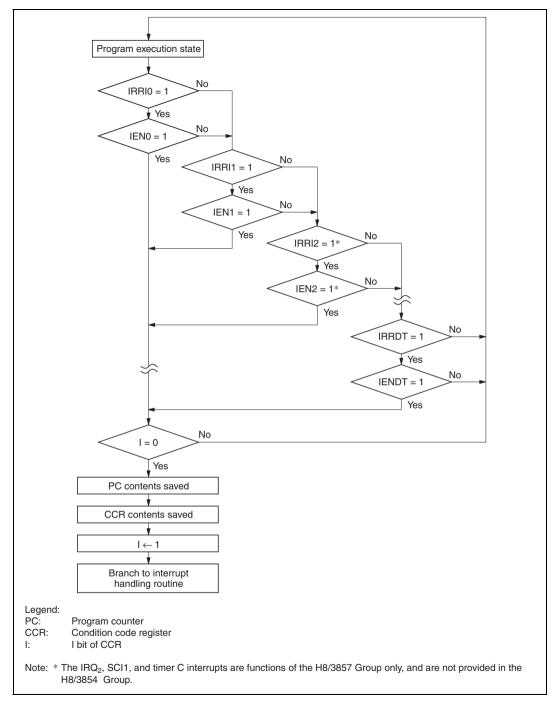


Figure 3.3 Flow up to Interrupt Acceptance

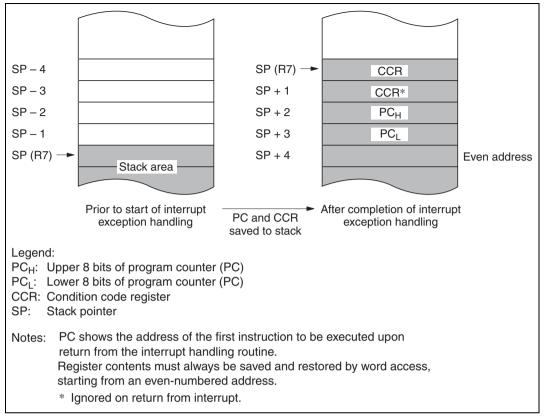


Figure 3.4 Stack State after Completion of Interrupt Exception Handling

Figure 3.5 shows a typical interrupt sequence where the program area is in the on-chip ROM and the stack area is in the on-chip RAM.

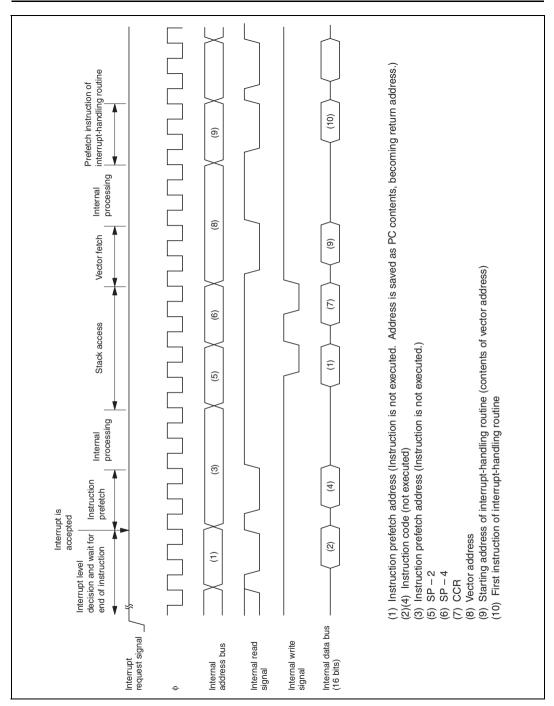


Figure 3.5 Interrupt Sequence

3.3.6 **Interrupt Response Time**

Table 3.4 shows the number of wait states after an interrupt request flag is set until the first instruction of the interrupt handler is executed.

Table 3.4 **Interrupt Wait States**

| Item | States | |
|---|----------|--|
| Waiting time for completion of executing instruction* | 1 to 13 | |
| Saving of PC and CCR to stack | 4 | |
| Vector fetch | 2 | |
| Instruction fetch | 4 | |
| Internal processing | 4 | |
| Total | 15 to 27 | |

Note: Not including EEPMOV instruction.

3.4 **Application Notes**

3.4.1 Notes on Stack Area Use

When word data is accessed in the H8/3857 Group, the least significant bit of the address is regarded as 0. Access to the stack always takes place in word size, so the stack pointer (SP: R7) should never indicate an odd address. Use PUSH Rn (MOV.W Rn, @-SP) or POP Rn (MOV.W @SP+, Rn) to save or restore register values.

Setting an odd address in SP may cause a program to crash. An example is shown in figure 3.6.

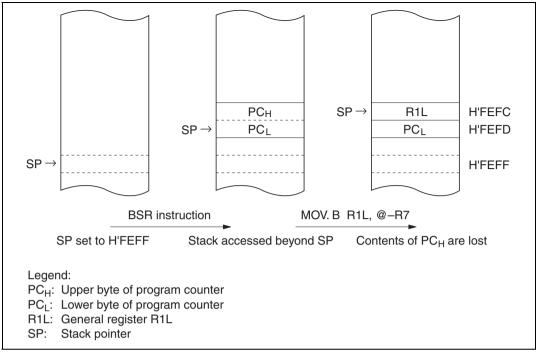


Figure 3.6 Operation when Odd Address Is Set in SP

When CCR contents are saved to the stack during interrupt exception handling or restored when RTE is executed, this also takes place in word size. Both the upper and lower bytes of word data are saved to the stack; on return, the even address contents are restored to CCR while the odd address contents are ignored.

3.4.2 Notes on Rewriting Port Mode Registers

When a port mode register is rewritten to switch the functions of external interrupt pins, the following points should be observed.

When an external interrupt pin function is switched by rewriting the port mode register that controls these pins $(\overline{IRQ}_4, \overline{IRQ}_5, \overline{IRQ}_2, \overline{IRQ}_1, \overline{IRQ}_6)$, and \overline{WKP}_7 to \overline{WKP}_0), the interrupt request flag may be set to 1 at the time the pin function is switched, even if no valid interrupt is input at the pin. Be sure to clear the interrupt request flag to 0 after switching pin functions. Table 3.5 shows the conditions under which interrupt request flags are set to 1 in this way.

Note: * Applies to the H8/3857 Group; not provided in the H8/3854 Group.



Conditions under which Interrupt Request Flag Is Set to 1 **Table 3.5**

| Interrupt Request Flags Set to 1 | | Conditions |
|----------------------------------|--------|--|
| IRR1 | IRRI4 | • When PMR2 bit IRQ4 is changed from 0 to 1 while pin $\overline{\text{IRQ}}_4$ is low and IEGR bit IEG4 = 0. |
| | | • When PMR2 bit IRQ4 is changed from 1 to 0 while pin \overline{IRQ}_4 is low and IEGR bit IEG4 = 1. |
| | IRRI3 | • When PMR1 bit IRQ3 is changed from 0 to 1 while pin \overline{IRQ}_3 is low and IEGR bit IEG3 = 0. |
| | | • When PMR1 bit IRQ3 is changed from 1 to 0 while pin $\overline{IRQ}_{_3}$ is low and IEGR bit IEG3 = 1. |
| | IRRI2* | • When PMR1 bit IRQ2 is changed from 0 to 1 while pin $\overline{\text{IRQ}}_2$ is low and IEGR bit IEG2 = 0. |
| | | • When PMR1 bit IRQ2 is changed from 1 to 0 while pin $\overline{\text{IRQ}}_2$ is low and IEGR bit IEG2 = 1. |
| | IRRI1 | When PMR1 bit IRQ1 is changed from 0 to 1 while pin IRQ, is low and IEGR bit IEG1 = 0. When PMR1 bit IRQ1 is changed from 1 to 0 while pin IRQ. |
| | | When PMR1 bit IRQ1 is changed from 1 to 0 while pin IRQ, is low and IEGR bit IEG1 = 1. |
| | IRRI0 | • When PMR2 bit IRQ0 is changed from 0 to 1 while pin \overline{IRQ}_0 is low and IEGR bit IEG0 = 0. |
| | | • When PMR2 bit IRQ0 is changed from 1 to 0 while pin \overline{IRQ}_0 is low and IEGR bit IEG0 = 1. |
| IWPR | IWPF7 | When PMR5 bit WKP7 is changed from 0 to 1 while pin $\overline{\text{WKP}}_{7}$ is low |
| | IWPF6 | When PMR5 bit WKP6 is changed from 0 to 1 while pin $\overline{\text{WKP}}_{\epsilon}$ is low |
| | IWPF5 | When PMR5 bit WKP5 is changed from 0 to 1 while pin $\overline{\text{WKP}}_{\scriptscriptstyle{5}}$ is low |
| | IWPF4 | When PMR5 bit WKP4 is changed from 0 to 1 while pin $\overline{\text{WKP}}_{_4}$ is low |
| | IWPF3 | When PMR5 bit WKP3 is changed from 0 to 1 while pin WKP3 is low |
| | IWPF2 | When PMR5 bit WKP2 is changed from 0 to 1 while pin WKP ₂ is low |
| | IWPF1 | When PMR5 bit WKP1 is changed from 0 to 1 while pin WKP, is low |
| | IWPF0 | When PMR5 bit WKP0 is changed from 0 to 1 while pin $\overline{\text{WKP}}_{_0}$ is low |

Note: Applies to the H8/3857 Group. In the H8/3854 Group, this flag must always be cleared to 0.

Figure 3.7 shows the procedure for setting a bit in a port mode register and clearing the interrupt request flag.

When switching a pin function, mask the interrupt before setting the bit in the port mode register. After accessing the port mode register, execute at least one instruction (e.g., NOP), then clear the interrupt request flag from 1 to 0. If the instruction to clear the flag is executed immediately after the port mode register access without executing an intervening instruction, the flag will not be cleared.

An alternative method is to avoid the setting of interrupt request flags when pin functions are switched by keeping the pins at the high level so that the conditions in table 3.5 do not occur.

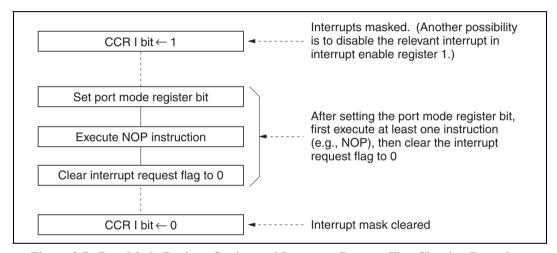


Figure 3.7 Port Mode Register Setting and Interrupt Request Flag Clearing Procedure

Section 4 Clock Pulse Generators

4.1 Overview

Clock oscillator circuitry (CPG: clock pulse generator) is provided on-chip, including both a system clock pulse generator and a subclock pulse generator. The system clock pulse generator consists of a system clock oscillator and system clock dividers. The subclock pulse generator consists of a subclock oscillator circuit and a subclock divider.

4.1.1 Block Diagram

Figure 4.1 shows a block diagram of the clock pulse generators.

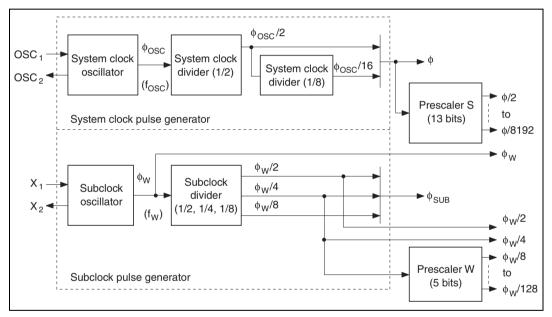


Figure 4.1 Block Diagram of Clock Pulse Generators

4.1.2 System Clock and Subclock

The basic clock signals that drive the CPU and on-chip peripheral modules are ϕ and ϕ_{SUB} . Four of the clock signals have names: ϕ is the system clock, ϕ_{SUB} is the subclock, ϕ_{osc} is the oscillator clock, and ϕ_{w} is the watch clock.

The clock signals available for use by peripheral modules are $\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, $\phi/32$, $\phi/64$, $\phi/128$, $\phi/256$, $\phi/512$, $\phi/1024$, $\phi/2048$, $\phi/4096$, $\phi/8192$, ϕ_w , $\phi_w/2$, $\phi_w/4$, $\phi_w/8$, $\phi_w/16$, $\phi_w/32$, $\phi_w/64$, and $\phi_w/128$. The clock requirements differ from one module to another.

4.2 System Clock Generator

Clock pulse can be supplied to the system clock divider either by connecting a crystal or ceramic oscillator, or by providing external clock input.

Connecting a Crystal Oscillator: Figure 4.2 shows a typical method of connecting a crystal oscillator.

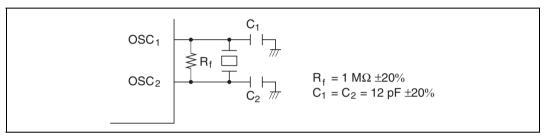


Figure 4.2 Typical Connection to Crystal Oscillator

Figure 4.3 shows the equivalent circuit of a crystal oscillator. An oscillator having the characteristics given in table 4.1 should be used.

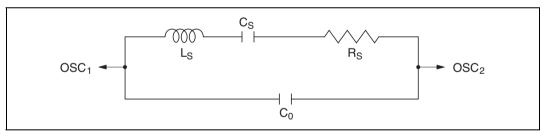


Figure 4.3 Equivalent Circuit of Crystal Oscillator

Table 4.1 Crystal Oscillator Parameters

| Frequency (MHz) | 2 | 4 | 8 | 10 |
|----------------------|-------|-------|------|------|
| R _s (max) | 500 Ω | 100 Ω | 50 Ω | 30 Ω |
| C ₀ (max) | 7 pF | 7 pF | 7 pF | 7 pF |

Connecting a Ceramic Oscillator: Figure 4.4 shows a typical method of connecting a ceramic oscillator.

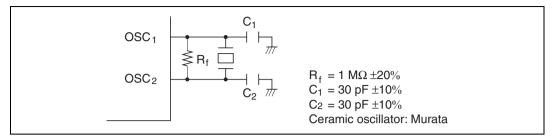


Figure 4.4 Typical Connection to Ceramic Oscillator

Notes on Board Design: When generating clock pulses by connecting a crystal or ceramic oscillator, pay careful attention to the following points.

Avoid running signal lines close to the oscillator circuit, since the oscillator may be adversely affected by induction currents. (See figure 4.5.)

The board should be designed so that the oscillator and load capacitors are located as close as possible to pins OSC₁ and OSC₂.

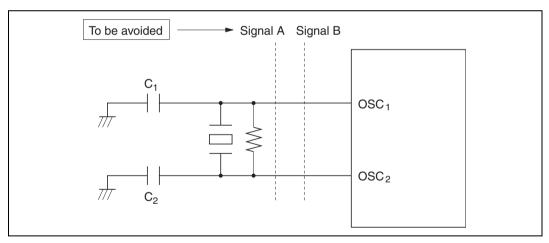


Figure 4.5 Board Design of Oscillator Circuit

Inputting an External Clock: When inputting an external clock, connect it to the OSC₁ pin via a resistance R, and leave the OSC₂ pin open.

An example of the connection in this case is shown in figure 4.6.

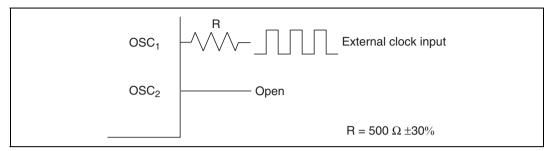


Figure 4.6 Example of Connection when Inputting an External Clock

| Frequency | OSC clock (ϕ_{osc}) |
|-----------|----------------------------|
| Duty | 45% to 55% |

4.3 Subclock Generator

Connecting a 32.768-kHz Crystal Oscillator: Clock pulses can be supplied to the subclock divider by connecting a 32.768-kHz crystal oscillator, as shown in figure 4.7. Following the same connection precautions as mentioned in Notes on Board Design in section 4.2, System Clock Generator.

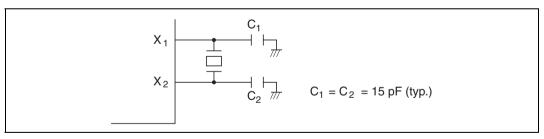


Figure 4.7 Typical Connection to 32.768-kHz Crystal Oscillator

Figure 4.8 shows the equivalent circuit of the 32.768-kHz crystal oscillator.

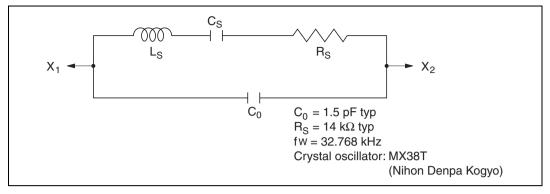


Figure 4.8 Equivalent Circuit of 32.768-kHz Crystal Oscillator

Inputting an External Clock

• Circuit configuration

An external clock is input to the X_1 pin. The X_2 pin should be left open. An example of the connection in this case is shown in figure 4.9.

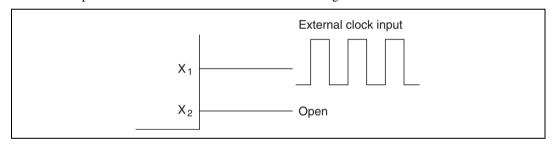


Figure 4.9 Example of Connection when Inputting an External Clock

External clock

Input a square waveform to the X1 pin. When using the CPU, timer A, timer C*, or an LCD, with a subclock (ϕ w) clock selected, do not stop the clock supply to the X₁ pin.

Note: * This is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

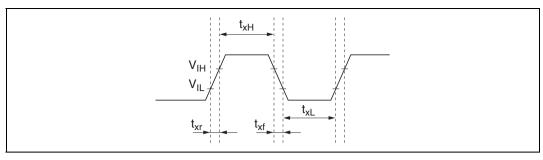


Figure 4.10 External Subclock Timing

The DC characteristics and timing of an external clock input to the X₁ pin are shown in table 4.2.

Table 4.2 DC Characteristics and Timing

 $(V_{cc} = 2.7 \text{ V to } 5.5 \text{ V of the mask ROM version of H8/3852, H8/3853, and H8/3854,}$ $V_{cc} = 3.0 \text{ V to } 5.5 \text{ V of H8/3854F and H8/3857 Group, } AV_{cc} = 3.0 \text{ V to } 5.5 \text{ V,}$ $V_{ss} = AV_{ss} = 0.0 \text{ V, } T_a = -20 ^{\circ}\text{C to } + 75 ^{\circ}\text{C*}, \text{ unless otherwise specified, including subactive mode)}$

| | | A | T | | Values | ; | | |
|---|-----------------|-------------------|--------------------|----------------------|--------|----------------------|------|-------------|
| Item | Symbol | Applicable Pin | Test Conditions | Min | Тур | Max | Unit | Notes |
| Input high voltage | V _{IH} | X ₁ | | V _{cc} -0.3 | _ | V _{cc} +0.3 | V | Figure 4.10 |
| Input low voltage | V _{IL} | _ | | -0.3 | _ | 0.3 | | |
| External subclock rise time | t _{xr} | _ | | _ | _ | 100 | ns | Figure 4.10 |
| External subclock fall time | t_{xf} | _ | | _ | _ | 100 | _ | |
| External subclock oscillation frequency | f _x | _ | fx = 32.768 kHz | _ | 32.768 | _ | kHz | |
| External subclock high width | t _{xH} | _ | | 12.0 | _ | _ | μS | Figure 4.10 |
| External subclock low width | t _{xL} | _ | | 12.0 | _ | _ | _ | |
| External subclock oscillation frequency | f _x | _ | fx = 38.4 kHz | _ | 38.4 | _ | kHz | |
| External subclock high width | t _{xH} | _ | | 10.0 | _ | _ | μS | Figure 4.10 |
| External subclock low width | t _{xL} | _ | | 10.0 | _ | _ | _ | |

Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C.



4.4 Prescalers

The H8/3857 Group and H8/3854 Group are equipped with two on-chip prescalers having different input clocks (prescaler S and prescaler W). Prescaler S is a 13-bit counter using the system clock (ϕ) as its input clock. Its prescaled outputs provide internal clock signals for on-chip peripheral modules. Prescaler W is a 5-bit counter using a 32.768-kHz signal divided by 4 (ϕ_w /4) as its input clock. Its prescaled outputs are used by timer A as a time base for timekeeping.

Prescaler S (PSS): Prescaler S is a 13-bit counter using the system clock (ϕ) as its input clock. It is incremented once per clock period.

Prescaler S is initialized to H'0000 by a reset, and starts counting on exit from the reset state.

In standby mode, watch mode, subactive mode, and subsleep mode, the system clock pulse generator stops. Prescaler S also stops and is initialized to H'0000.

The CPU cannot read or write prescaler S.

The output from prescaler S is shared by timer A, timer B, timer C*, timer F, SCI1*, SCI3, the A/D converter, LCD controller, and 14-bit PWM*. The divider ratio can be set separately for each on-chip peripheral function.

In active (medium-speed) mode the clock input to prescaler S is $\phi_{osc}/16$.

Note: * This is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

Prescaler W (**PSW**): Prescaler W is a 5-bit counter using a 32.768 kHz signal divided by 4 (ϕ_w /4) as its input clock.

Prescaler W is initialized to H'00 by a reset, and starts counting on exit from the reset state.

Even in standby mode, watch mode, subactive mode, or subsleep mode, prescaler W continues functioning so long as clock signals are supplied to pins X_1 and X_2 .

Prescaler W can be reset by setting 1s in bits TMA3 and TMA2 of timer mode register A (TMA).

Output from prescaler W can be used to drive timer A, in which case timer A functions as a time base for timekeeping.

4.5 Note on Oscillators

Oscillator characteristics of both the mask ROM and F-ZTAT versions are closely related to board design and should be carefully evaluated by the user, referring to the examples shown in this section. Oscillator circuit constants will differ depending on the oscillator element, stray capacitance in its interconnecting circuit, and other factors. Suitable constants should be determined in consultation with the oscillator element manufacturer. Design the circuit so that the oscillator element never receives voltages exceeding its maximum rating.



Section 5 Power-Down Modes

5.1 Overview

The H8/3857 Group and H8/3854 Group have seven modes of operation after a reset. These include six power-down modes, in which power dissipation is significantly reduced.

Table 5.1 gives a summary of the seven operation modes.

Table 5.1 Operation Modes

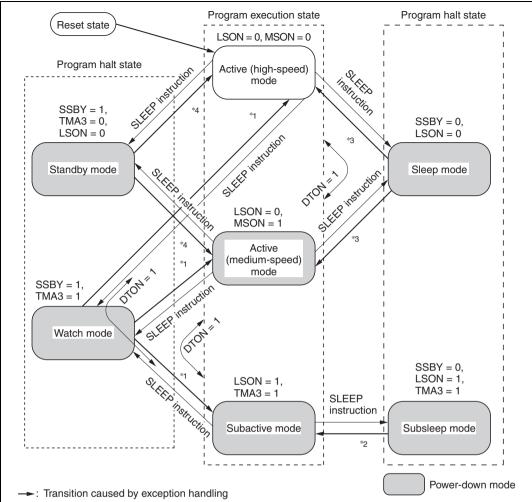
| Operating Mode | Description |
|----------------------------|--|
| Active (high-speed) mode | The CPU runs on the system clock, executing program instructions at high speed |
| Active (medium-speed) mode | The CPU runs on the system clock, executing program instructions at reduced speed |
| Subactive mode | The CPU runs on the subclock, executing program instructions at reduced speed |
| Sleep mode | The CPU halts. On-chip peripheral modules continue to operate on the system clock. |
| Subsleep mode | The CPU halts. Timer A, timer C*, and the LCD controller continue to operate on the subclock. |
| Watch mode | The CPU halts. The time-base function of timer A and the LCD controller continue to operate on the subclock. |
| Standby mode | The CPU and all on-chip peripheral modules stop operating |

Note: * This is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

All the above operating modes except active (high-speed) mode are referred to as power-down modes.

In this section the two active modes (high-speed and medium-speed) are referred to collectively as active mode.

Figure 5.1 shows the transitions among these operation modes. Table 5.2 indicates the internal states in each mode.



- A transition between different modes cannot be made to occur simply because an interrupt request is generated. Make sure that the interrupt is accepted and interrupt handling is performed.
- Details on the mode transition conditions are given in the explanations of each mode, in sections 5.2 through 5.8.
- The module standby mode for the LCD controller is initiated by setting a register within the LCD controller itself, and so is not shown in this diagram.

Notes: 1. Timer A interrupt, IRQ₀ interrupt, WKP₀ to WKP₇ interrupts

- 2. Timer A interrupt, timer C interrupt*, timer IRQ₀ to IRQ₄ interrupts*, WKP₀ to WKP₇ interrupts
- 3. All interrupts*
- 4. IRQ₀ interrupt, IRQ₁ interrupt, WKP₀ to WKP₇ interrupts
- * The timer C, SCI1, and IRQ₂ interrupts are functions of the H8/3857 Group only, and are not provided in the H8/3854 Group.

Figure 5.1 Operation Mode Transition Diagram

Table 5.2 **Internal State in Each Operation Mode**

Active Mode

| | | Active wode | | | | | | |
|---------------------|---------------------|---------------|-----------------|---------------|---------------|--------------------------------------|--------------------------------------|-----------------|
| Function | | High Speed | Medium Speed | Sleep Mode | Watch Mode | Subactive Mode | Subsleep Mode | Standby Mode |
| System clo | ck oscillator | Functions | Functions | Functions | Halted | Halted | Halted | Halted |
| Subclock o | scillator | Functions | Functions | Functions | Functions | Functions | Functions | Functions |
| CPU | Instructions | Functions | Functions | Halted | Halted | Functions | Halted | Halted |
| operation | RAM | _ | | Retained | Retained | _ | Retained | Retained |
| | Registers | _ | | | | | | |
| | I/O | _ | | | | | | Retained*1 |
| External | IRQ₀ | Functions | Functions | Functions | Functions | Functions | Functions | Functions |
| interrupts | IRQ, | _ | | | Retained*⁴ | _ | | |
| | IRQ ₂ *6 | _ | | | | | | Retained*4 |
| | IRQ₃ | _ | | | | | | |
| | IRQ₄ | _ | | | | | | |
| | WKP _o | Functions | Functions | Functions | Functions | Functions | Functions | Functions |
| | WKP ₁ | _ | | | | | | |
| | WKP ₂ | _ | | | | | | |
| | WKP ₃ | _ | | | | | | |
| | WKP ₄ | _ | | | | | | |
| | WKP ₅ | _ | | | | | | |
| | WKP ₆ | _ | | | | | | |
| | WKP, | _ | | | | | | |
| Peripheral | Timer A | Functions | Functions | Functions | Functions*3 | Functions*3 | Functions*3 | Retained |
| module functions | Timer B | _ | | | Retained | Retained | Retained | = |
| Tunctions | Timer C*6 | _ | | | | Functions/ Retained* ² | Functions/ Retained* ² | - |
| | Timer F | _ | | | | Retained | Retained | = |
| | SCI1*6 | Functions | Functions | Functions | Retained | Retained | Retained | Retained |
| | SCI3 | _ | | | Reset | Reset | Reset | Reset |
| | PWM* ⁶ | Functions | Functions | Retained | Retained | Retained | Retained | Retained |
| | A/D | Functions | Functions | Functions | Retained | Retained | Retained | Retained |
| | LCD*5 | Functions | Functions | Functions | Functions | Functions | Functions | Retained |

Register contents held; high-impedance output.

- Functions only if external clock or φ_w/4 internal clock is selected; otherwise halted and retained.
- 3. Functions when timekeeping time-base function is selected.
- 4. External interrupt requests are ignored. The interrupt request register contents are not affected.
- 5. In module standby mode, only the clock supplied to the LCD controller is stopped. Register values are retained, and all outputs go to the V_{ss} potential.
- 6. This is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

5.1.1 System Control Registers

The operation mode is selected using the system control registers described in table 5.3.

Table 5.3 System Control Register

| Name | Abbreviation | R/W | Initial Value | Address |
|---------------------------|--------------|-----|---------------|---------|
| System control register 1 | SYSCR1 | R/W | H'07 | H'FFF0 |
| System control register 2 | SYSCR2 | R/W | H'E0 | H'FFF1 |

System Control Register 1 (SYSCR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|---|---|---|
| | SSBY | STS2 | STS1 | STS0 | LSON | _ | | _ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | _ | _ | _ |

SYSCR1 is an 8-bit read/write register for control of the power-down modes.

Bit 7—Software Standby (SSBY): This bit designates transition to standby mode or watch mode.

| Bit 7: SSBY | Description |
|-------------|--|
| 0 | When a SLEEP instruction is executed in active mode, a transition is made to sleep mode (initial value) |
| | When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode. |
| 1 | When a SLEEP instruction is executed in active mode, a transition is made to standby mode or watch mode. |
| | When a SLEEP instruction is executed in subactive mode, a transition is made to watch mode. |



Bits 6 to 4—Standby Timer Select 2 to 0 (STS2 to STS0): These bits designate the time the CPU and peripheral modules wait for stable clock operation after exiting from standby mode or watch mode to active mode due to an interrupt. The designation should be made according to the clock frequency so that the waiting time is at least 10 ms.

| Bit 6: STS2 | Bit 5: STS1 | Bit 4: STS0 | Description | |
|-------------|-------------|-------------|----------------------------|-----------------|
| 0 | 0 | 0 | Wait time = 8,192 states | (initial value) |
| | | 1 | Wait time = 16,384 states | |
| | 1 | 0 | Wait time = 32,768 states | _ |
| | | 1 | Wait time = 65,536 states | _ |
| 1 | * | * | Wait time = 131,072 states | |

Legend: * Don't care

Bit 3—Low Speed on Flag (LSON): This bit chooses the system clock (ϕ) or subclock (ϕ_{sup}) as the CPU operating clock when watch mode is cleared. The resulting operation mode depends on the combination of other control bits and interrupt input.

| Bit 3: LSON | Description | |
|-------------|--|-----------------|
| 0 | The CPU operates on the system clock (ϕ) | (initial value) |
| 1 | The CPU operates on the subclock $(\phi_{\text{\tiny SUB}})$ | _ |

Bits 2 to 0—Reserved Bits: These bits are reserved; they are always read as 1, and cannot be modified.

System Control Register 2 (SYSCR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|-------|------|------|-----|-----|
| | _ | _ | _ | NESEL | DTON | MSON | SA1 | SA0 |
| Initial value | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | R/W | R/W | R/W | R/W | R/W |

SYSCR2 is an 8-bit read/write register for power-down mode control.

Bits 7 to 5—Reserved Bits: These bits are reserved; they are always read as 1, and cannot be modified.

Bit 4—Noise Elimination Sampling Frequency Select (NESEL): This bit selects the frequency at which the watch clock signal (ϕ_w) generated by the subclock pulse generator is sampled, in relation to the oscillator clock (ϕ_{osc}) generated by the system clock pulse generator. When $\phi_{osc} = 2$ to 10 MHz, clear NESEL to 0.

| Bit 4: NESEL | Description | | | |
|--------------|-------------------------------------|-----------------|--|--|
| 0 | Sampling rate is $\phi_{osc}/16$ | (initial value) | | |
| 1 | Sampling rate is $\phi_{\rm osc}/4$ | | | |

Bit 3—Direct Transfer on Flag (DTON): This bit designates whether or not to make direct transitions among active (high-speed), active (medium-speed) and subactive mode when a SLEEP instruction is executed. The mode to which the transition is made after the SLEEP instruction is executed depends on a combination of this and other control bits.

| Bit 3: DTON | Description | | | | |
|-------------|--|--|--|--|--|
| 0 | When a SLEEP instruction is executed in active mode, a transition is made to standby mode, watch mode, or sleep mode. (initial value) | | | | |
| | When a SLEEP instruction is executed in subactive mode, a transition is made to watch mode or subsleep mode. | | | | |
| 1 | When a SLEEP instruction is executed in active (high-speed) mode, a direct transition is made to active (medium-speed) mode if SSBY = 0, MSON = 1, and LSON = 0, or to subactive mode if SSBY = 1, TMA3 = 1, and LSON = 1. | | | | |
| | When a SLEEP instruction is executed in active (medium-speed) mode, a direct transition is made to active (high-speed) mode if SSBY = 0, MSON = 0, and LSON = 0, or to subactive mode if SSBY = 1, TMA3 = 1, and LSON = 1. | | | | |
| | When a SLEEP instruction is executed in subactive mode, a direct transition is made to active (high-speed) mode if SSBY = 1, TMA3 = 1, LSON = 0, and MSON = 0, or to active (medium-speed) mode if SSBY = 1, TMA3 = 1, LSON = 0, and MSON = 1. | | | | |

Bit 2—Medium Speed on Flag (MSON): After standby, watch, or sleep mode is cleared, this bit selects active (high-speed) or active (medium-speed) mode.

| Bit 2: MSON | Description | |
|-------------|--|-----------------|
| 0 | Operation is in active (high-speed) mode | (initial value) |
| 1 | Operation is in active (medium-speed) mode | |



Bits 1 and 0—Subactive Mode Clock Select (SA1, SA0): These bits select the CPU clock rate $(\phi_w/2, \phi_w/4, \text{ or } \phi_w/8)$ in subactive mode. SA1 and SA0 cannot be modified in subactive mode.

| Bit 1: SA1 | Bit 0: SA0 | Description | |
|------------|------------|-------------------|-----------------|
| 0 | 0 | φ _w /8 | (initial value) |
| | 1 | φ _w /4 | |
| 1 | * | φ _w /2 | |

Legend: * Don't care

5.2 Sleep Mode

5.2.1 **Transition to Sleep Mode**

The system goes from active mode to sleep mode when a SLEEP instruction is executed while the SSBY and LSON bits in system control register 1 (SYSCR1) are cleared to 0. In sleep mode CPU operation is halted but the on-chip peripheral functions other than PWM* are operational. The CPU register contents are retained.

This is a function of the H8/3857 Group only, and is not provided in the H8/3854 Note: * Group.

5.2.2 Clearing Sleep Mode

Sleep mode is cleared by an interrupt (timer A, timer B, timer C*, timer F, IRQ₀, IRQ₁, IRQ₂*, IRQ₂, IRQ₄, WKP₀ to WKP₇, SCI1*, SCI3, A/D converter) or by input at the RES pin.

The timer C, SCI1, and IRQ, interrupts are functions of the H8/3857 Group only, and are not provided in the H8/3854 Group.

Clearing by Interrupt: When an interrupt is requested, sleep mode is cleared and interrupt exception handling starts. Operation resumes in active (high-speed) mode if MSON = 0 in SYSCR2, or active (medium-speed) mode if MSON = 1. Sleep mode is not cleared if the I bit of the condition code register (CCR) is set to 1 or the particular interrupt is disabled in the interrupt enable register.

Clearing by \overline{RES} Input: When the \overline{RES} pin goes low, the CPU goes into the reset state and sleep mode is cleared

5.3 Standby Mode

5.3.1 Transition to Standby Mode

The system goes from active mode to standby mode when a SLEEP instruction is executed while the SSBY bit in SYSCR1 is set to 1, the LSON bit is cleared to 0, and bit TMA3 in timer register A (TMA) is cleared to 0. In standby mode the clock pulse generator stops, so the CPU and on-chip peripheral modules stop functioning. As long as a minimum required voltage is applied, the contents of CPU registers and some on-chip peripheral registers, and data in the on-chip RAM, are retained. Data in the on-chip RAM will be retained as long as the specified RAM data retention voltage is supplied. The I/O ports go to the high-impedance state.

5.3.2 Clearing Standby Mode

Standby mode is cleared by an interrupt (IRQ₀, IRQ₁, WKP₀ to WKP₇) or by input at the \overline{RES} pin.

Clearing by Interrupt: When an interrupt is requested, the system clock pulse generator starts. After the time set in bits STS2–STS0 in SYSCR1 has elapsed, a stable system clock signal is supplied to the entire chip, standby mode is cleared, and interrupt exception handling starts. Operation resumes in active (high-speed) mode if MSON = 0 in SYSCR2, or active (medium-speed) mode if MSON = 1. Standby mode is not cleared if the I bit of CCR is set to 1 or the particular interrupt is disabled in the interrupt enable register.

Clearing by \overline{RES} Input: When the \overline{RES} pin goes low, the system clock pulse generator starts. After the pulse generator output has stabilized, if the \overline{RES} pin is driven high, the CPU starts reset exception handling.

Since system clock signals are supplied to the entire chip as soon as the system clock pulse generator starts functioning, the \overline{RES} pin should be kept at the low level until the pulse generator output stabilizes.

5.3.3 Oscillator Settling Time after Standby Mode Is Cleared

Bits STS2 to STS0 in SYSCR1 should be set as follows.

When a Crystal Oscillator is Used
 The table below gives settings for various operating frequencies. Set bits STS2 to STS0 for a waiting time of at least 10 ms.



| STS2 | STS1 | STS0 | Waiting Time | 5 MHz | 4 MHz | 2 MHz | 1 MHz | 0.5 MHz |
|------|------|------|----------------|-------|-------|-------|-------|---------|
| 0 | 0 | 0 | 8,192 states | 1.6 | 2.0 | 4.1 | 8.2 | 16.4 |
| | | 1 | 16,384 states | 3.2 | 4.1 | 8.2 | 16.4 | 32.8 |
| | 1 | 0 | 32,768 states | 6.6 | 8.2 | 16.4 | 32.8 | 65.5 |
| | | 1 | 65,536 states | 13.1 | 16.4 | 32.8 | 65.5 | 131.1 |
| 1 | * | * | 131,072 states | 26.2 | 32.8 | 65.5 | 131.1 | 262.1 |

Table 5.4 Clock Frequency and Settling Time (Times are in ms)

Legend: * Don't care

When an External Clock is Used
 Any values may be set. Normally the minimum time (STS2 = STS1 = STS0 = 0) should be set.

5.3.4 Transition to Standby Mode and Port Pin States

The system goes from active (high-speed or medium-speed) mode to standby mode when a SLEEP instruction is executed while the SSBY bit in SYSCR1 is set to 1, the LSON bit is cleared to 0, and bit TMA3 in TMA is cleared to 0. Port pins (except those with their MOS pull-up turned on) enter high-impedance state when the transition to standby mode is made. This timing is shown in figure 5.2.

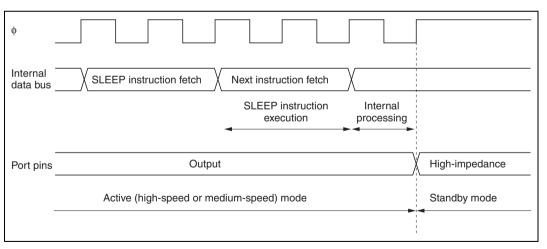


Figure 5.2 Transition to Standby Mode and Port Pin States

5.3.5 Notes on External Input Signal Changes before/after Standby Mode

2. When external input signals cannot be captured because internal clock stops

- 1. When external input signal changes before/after standby mode or watch mode When an external input signal such as IRQ or WKP is input, both the high- and low-level widths of the signal must be at least two cycles of system clock φ or subclock φ_{SUB} (referred to together in this section as the internal clock). As the internal clock stops in standby mode and watch mode, the width of external input signals requires careful attention when a transition is made via these operating modes. Ensure that external input signals conform to the conditions stated in 3, Recommended timing of external input signals, below
- The case of falling edge capture is illustrated in figure 5.3

 As shown in the case marked "Capture not possible," when an external input signal falls immediately after a transition to active (high-speed or medium-speed) mode or subactive mode, after oscillation is started by an interrupt via a different signal, the external input signal cannot be captured if the high-level width at that point is less than 2 t_{eve} or 2 t_{subeve}.
- 3. Recommended timing of external input signals

 To ensure dependable capture of an external input signal, high- and low-level signal widths of

at least 2 t_{cyc} or 2 t_{subcyc} are necessary before a transition is made to standby mode or watch mode, as shown in "Capture possible: case 1."

External input signal capture is also possible with the timing shown in "Capture possible: case 2" and "Capture possible: case 3," in which a 2 t_{cyc} or 2 t_{subcyc} level width is secured.



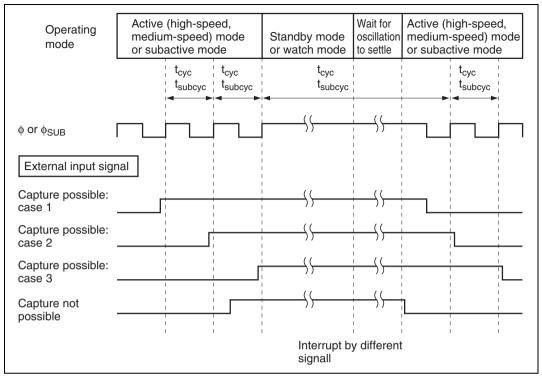


Figure 5.3 External Input Signal Capture when Signal Changes before/after Standby Mode or Watch Mode

4. Input pins to which these notes apply:

 \overline{IRQ}_4 , \overline{IRQ}_3 , \overline{IRQ}_2 *, \overline{IRQ}_1 , \overline{IRQ}_0 , \overline{WKP}_7 to \overline{WKP}_0 , \overline{ADTRG} , TMIB, TMIC*, TMIF

Note: * H8/3857 Group pin, not provided in the H8/3854 Group.

5.4 Watch Mode

5.4.1 Transition to Watch Mode

The system goes from active or subactive mode to watch mode when a SLEEP instruction is executed while the SSBY bit in SYSCR1 is set to 1 and bit TMA3 in TMA is set to 1.

In watch mode, operation of on-chip peripheral modules other than timer A and the LCD controller is halted. The LCD controller can be selected to operate or to halt. As long as a minimum required voltage is applied, the contents of CPU registers and some registers of the on-chip peripheral modules, and the on-chip RAM contents, are retained. I/O ports keep the same states as before the transition.

5.4.2 Clearing Watch Mode

Watch mode is cleared by an interrupt (timer A, IRQ_0 , WKP_0 to WKP_7) or by a input at the \overline{RES} pin.

Clearing by Interrupt: Watch mode is cleared when an interrupt is requested. The mode to which a transition is made depends on the settings of LSON in SYSCR1 and MSON in SYSCR2. If both LSON and MSON are cleared to 0, transition is to active (high-speed) mode; if LSON = 0 and MSON = 1, transition is to active (medium-speed) mode; if LSON = 1, transition is to subactive mode. When the transition is to active mode, after the time set in SYSCR1 bits STS2–STS0 has elapsed, a stable clock signal is supplied to the entire chip, and interrupt exception handling starts. Watch mode is not cleared if the I bit of CCR is set to 1 or the particular interrupt is disabled in the interrupt enable register.

Clearing by \overline{RES} Input: Clearing by \overline{RES} pin is the same as for standby mode; see section 5.3.2, Clearing Standby Mode.

5.4.3 Oscillator Settling Time after Watch Mode Is Cleared

The waiting time is the same as for standby mode; see section 5.3.3, Oscillator Settling Time after Standby Mode is Cleared.

5.4.4 Notes on External Input Signal Changes before/after Watch Mode

See section 5.3.5, Notes on External Input Signal Changes before/after Standby Mode.

5.5 Subsleep Mode

5.5.1 Transition to Subsleep Mode

The system goes from subactive mode to subsleep mode when a SLEEP instruction is executed while the SSBY bit in SYSCR1 is cleared to 0, LSON bit in SYSCR1 is set to 1, and TMA3 bit in TMA is set to 1.

In subsleep mode, operation of on-chip peripheral modules other than timer A, timer C*, and the LCD controller is halted. As long as a minimum required voltage is applied, the contents of CPU registers and some registers of the on-chip peripheral modules, and the on-chip RAM contents, are retained. I/O ports keep the same states as before the transition.

Note: * This is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.



5.5.2 Clearing Subsleep Mode

Subsleep mode is cleared by an interrupt (timer A, timer C*, IRQ_0 , IRQ_1 , IRQ_2 *, IRQ_3 , IRQ_4 , WKP_0 to WKP_7) or by a low input at the \overline{RES} pin.

Note: * The timer C and IRQ₂ interrupts are functions of the H8/3857 Group only, and are not provided in the H8/3854 Group.

Clearing by Interrupt: When an interrupt is requested, subsleep mode is cleared and interrupt exception handling starts. Subsleep mode is not cleared if the I bit of CCR is set to 1 or the particular interrupt is disabled in the interrupt enable register.

Clearing by \overline{RES} Input: Clearing by \overline{RES} pin is the same as for standby mode; see section 5.3.2, Clearing Standby Mode.

5.6 Subactive Mode

5.6.1 Transition to Subactive Mode

Subactive mode is entered from watch mode if a timer A, IRQ_0 , or WKP_0 to WKP_7 interrupt is requested while the LSON bit in SYSCR1 is set to 1. From subsleep mode, subactive mode is entered if a timer A, timer C*, IRQ_0 , IRQ_1 , IRQ_2 *, IRQ_3 , IRQ_4 , or WKP_0 to WKP_7 interrupt is requested. A transition to subactive mode does not take place if the I bit of CCR is set to 1 or the particular interrupt is disabled in the interrupt enable register.

Note: * The timer C and IRQ₂ interrupts are functions of the H8/3857 Group only, and are not provided in the H8/3854 Group.

5.6.2 Clearing Subactive Mode

Subactive mode is cleared by a SLEEP instruction or by a input at the \overline{RES} pin.

Clearing by SLEEP Instruction: If a SLEEP instruction is executed while the SSBY bit in SYSCR1 is set to 1 and TMA3 bit in TMA is set to 1, subactive mode is cleared and watch mode is entered. If a SLEEP instruction is executed while SSBY = 0 and LSON = 1 in SYSCR1 and TMA3 = 1 in TMA, subsleep mode is entered. Direct transfer to active mode is also possible; see section 5.8, Direct Transfer, below.

Clearing by \overline{RES} Pin: Clearing by \overline{RES} pin is the same as for standby mode; see Clearing by \overline{RES} pin in section 5.3.2, Clearing Standby Mode.

5.6.3 Operating Frequency in Subactive Mode

The operating frequency in subactive mode is set in bits SA1 and SA0 in SYSCR2. The choices are $\phi_w/2$, $\phi_w/4$, and $\phi_w/8$.

5.7 Active (medium-speed) Mode

5.7.1 Transition to Active (medium-speed) Mode

If the MSON bit in SYSCR2 is set to 1 while the LSON bit in SYSCR1 is cleared to 0, a transition to active (medium-speed) mode results from IRQ_0 , IRQ_1 , or WKP_0 to WKP_7 interrupts in standby mode, timer A, IRQ_0 , or WKP_0 to WKP_7 interrupts in watch mode, or any interrupt in sleep mode. A transition to active (medium-speed) mode does not take place if the I bit of CCR is set to 1 or the particular interrupt is disabled in the interrupt enable register.

5.7.2 Clearing Active (medium-speed) Mode

Active (medium-speed) mode is cleared by a SLEEP instruction or by a input at the \overline{RES} pin.

Clearing by SLEEP Instruction: A transition to standby mode takes place if a SLEEP instruction is executed while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, and TMA3 bit in TMA is cleared to 0. The system goes to watch mode if the SSBY bit in SYSCR1 is set to 1 and TMA3 bit in TMA is set to 1 when a SLEEP instruction is executed. Sleep mode is entered if both SSBY and LSON are cleared to 0 when a SLEEP instruction is executed. Direct transfer to active (high-speed) mode or to subactive mode is also possible. See section 5.8, Direct Transfer, below for details.

Clearing by \overline{RES} Pin: When the \overline{RES} pin goes low, the CPU enters the reset state and active (medium-speed) mode is cleared.

5.7.3 Operating Frequency in Active (medium-speed) Mode

In active (medium-speed) mode, the CPU is clocked at 1/8 the frequency in active (high-speed) mode.



5.8 Direct Transfer

5.8.1 Direct Transfer Overview

The CPU can execute programs in three modes: active (high-speed) mode, active (medium-speed) mode, and subactive mode. A direct transfer is a transition among these three modes without the stopping of program execution. A direct transfer can be made by executing a SLEEP instruction while the DTON bit in SYSCR2 is set to 1. After the mode transition, direct transfer interrupt exception handling starts.

If the direct transfer interrupt is disabled in interrupt enable register 2 (IENR2), a transition is made instead to sleep mode or watch mode. Note that if a direct transition is attempted while the I bit in CCR is set to 1, sleep mode or watch mode will be entered, and it will be impossible to clear the resulting mode by means of an interrupt.

Direct Transfer from Active (High-Speed) Mode to Active (Medium-Speed) Mode: When a SLEEP instruction is executed in active (high-speed) mode while the SSBY and LSON bits in SYSCR1 are cleared to 0, the MSON bit in SYSCR2 is set to 1, and the DTON bit in SYSCR2 is set to 1, a transition is made to active (medium-speed) mode via sleep mode.

Direct Transfer from Active (Medium-Speed) Mode to Active (High-Speed) Mode: When a SLEEP instruction is executed in active (medium-speed) mode while the SSBY and LSON bits in SYSCR1 are cleared to 0, the MSON bit in SYSCR2 is cleared to 0, and the DTON bit in SYSCR2 is set to 1, a transition is made to active (high-speed) mode via sleep mode.

Direct Transfer from Active (High-Speed) Mode to Subactive Mode: When a SLEEP instruction is executed in active (high-speed) mode while the SSBY and LSON bits in SYSCR1 are set to 1, the DTON bit in SYSCR2 is set to 1, and TMA3 bit in TMA is set to 1, a transition is made to subactive mode via watch mode.

Direct Transfer from Subactive Mode to Active (High-Speed) Mode: When a SLEEP instruction is executed in subactive mode while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, the MSON bit in SYSCR2 is cleared to 0, the DTON bit in SYSCR2 is set to 1, and TMA3 bit in TMA is set to 1, a transition is made directly to active (high-speed) mode via watch mode after the waiting time set in SYSCR1 bits STS2 to STS0 has elapsed.

Direct Transfer from Active (Medium-Speed) Mode to Subactive Mode: When a SLEEP instruction is executed in active (medium-speed) while the SSBY and LSON bits in SYSCR1 are set to 1, the DTON bit in SYSCR2 is set to 1, and TMA3 bit in TMA is set to 1, a transition is made to subactive mode via watch mode.

Direct Transfer from Subactive Mode to Active (Medium-Speed) Mode: When a SLEEP instruction is executed in subactive mode while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, the MSON bit in SYSCR2 is set to 1, the DTON bit in SYSCR2 is set to 1, and TMA3 bit in TMA is set to 1, a transition is made directly to active (medium-speed) mode via watch mode after the waiting time set in SYSCR1 bits STS2 to STS0 has elapsed.

5.8.2 Calculation of Direct Transfer Time before Transition

Time Required before Direct Transfer from Active (High-speed) Mode to Active (Medium-Speed) Mode: A direct transfer is made from active (high-speed) mode to active (medium-speed) mode when a SLEEP instruction is executed in active (high-speed) mode while the SSBY and LSON bits in SYSCR1 are cleared to 0, the MSON bit in SYSCR2 is set to 1, and the DTON bit in SYSCR2 is set to 1. A direct transfer time, that is, the time from SLEEP instruction execution to interrupt exception handling completion is calculated by expression (1) below.

Direct transfer time = (number of states for SLEEP instruction execution + number of states for internal processing) × tcyc before transition + number of states for interrupt exception handling execution × tcyc after transition (1)

Example: Direct transfer time for the H8/3857 Group and H8/3854 Group = $(2 + 1) \times 2 tosc + 14 \times 16 tosc = 230 tosc$

Legend:

tosc: OSC clock cycle time tcyc: System clock (\$\phi\$) cycle time

Time Required before Direct Transfer from Active (Medium-Speed) Mode to Active (High-Speed) Mode: A direct transfer is made from active (medium-speed) mode to active (high-speed) mode when a SLEEP instruction is executed in active (medium-speed) mode while the SSBY and LSON bits in SYSCR1 are cleared to 0, the MSON bit in SYSCR2 is cleared to 0, and the DTON bit in SYSCR2 is set to 1. A direct transfer time, that is, the time from SLEEP instruction execution to interrupt exception handling completion is calculated by expression (2) below.

Direct transfer time = (number of states for SLEEP instruction execution + number of states for internal processing) × tcyc before transition + number of states for interrupt exception handling execution × tcyc after transition (2)

Example: Direct transfer time for the H8/3857 Group and H8/3854 Group

 $= (2 + 1) \times 16 tosc + 14 \times 2 tosc = 76 tosc$

Legend:

tosc: OSC clock cycle time tcyc: System clock (ϕ) cycle time

Time Required before Direct Transfer from Subactive Mode to Active (High-Speed) Mode:

A direct transfer is made from subactive mode to active (high-speed) mode when a SLEEP instruction is executed in subactive mode while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, the MSON bit in SYSCR2 is cleared to 0, the DTON bit in SYSCR2 is set to 1, and the TMA3 bit in TMA is set to 1. A direct transfer time, that is, the time from SLEEP instruction execution to interrupt exception handling completion is calculated by expression (3) below.

Direct transfer time = (number of states for SLEEP instruction execution + number of states for internal processing) × tsubcyc before transition + (wait time designated by STS2 to STS0 bits in SCR + number of states for interrupt exception handling execution) × tcyc after transition (3)

Example: Direct transfer time for the H8/3857 Group and H8/3854 Group (when CPU clock frequency is ϕ w/8 and wait time is 8192 states) = $(2 + 1) \times 8$ tw + $(8192 + 14) \times 2$ tosc = 24tw + 16412tosc

Legend:

tosc: OSC clock cycle time tw: Watch clock cycle time tcyc: System clock (ϕ) cycle time tsubcyc: Subclock (ϕ_{SUB}) cycle time

Time Required before Direct Transfer from Subactive Mode to Active (Medium-Speed)

Mode: A direct transfer is made from subactive mode to active (medium-speed) mode when a SLEEP instruction is executed in subactive mode while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, the MSON and DTON bits in SYSCR2 are set to 1, and the TMA3 bit in TMA is set to 1. A direct transfer time, that is, the time from SLEEP instruction execution to interrupt exception handling completion is calculated by expression (4) below.

Direct transfer time = (number of states for SLEEP instruction execution + number of states for internal processing) × tsubcyc before transition + (wait time designated by STS2 to STS0 bits in SCR + number of states for interrupt exception handling execution) × tcyc after transition

..... (4)

Example: Direct transfer time for the H8/3857 Group and H8/3854 Group (when CPU clock frequency is φw/8 and wait time is 8192 states)

 $= (2 + 1) \times 8tw + (8192 + 14) \times 16tosc = 24tw + 131296tosc$

Legend:

tosc: OSC clock cycle time tw: Watch clock cycle time tcyc: System clock (ϕ) cycle time tsubcyc: Subclock (ϕ _{SUB}) cycle time

5.8.3 Notes on External Input Signal Changes before/after Direct Transition

- Direct transition from active (high-speed) mode to subactive mode
 Since the mode transition is performed via watch mode, see section 5.3.5, Notes on External Input Signal Changes before/after Standby Mode.
- Direct transition from active (medium-speed) mode to subactive mode
 Since the mode transition is performed via watch mode, see section 5.3.5, Notes on External Input Signal Changes before/after Standby Mode.
- 3. Direct transition from subactive mode to active (high-speed) mode
 Since the mode transition is performed via watch mode, see section 5.3.5, Notes on External
 Input Signal Changes before/after Standby Mode.
- 4. Direct transition from subactive mode to active (medium-speed) mode
 Since the mode transition is performed via watch mode, see section 5.3.5, Notes on External
 Input Signal Changes before/after Standby Mode.



Section 6 ROM

6.1 Overview

The H8/3857 has 60 kbytes of on-chip flash memory or mask ROM, while the H8/3856 has 48 kbytes, and the H8/3855 40 kbytes, of on-chip mask ROM. The H8/3854 has 60 kbytes of on-chip flash memory or 32 kbytes of on-chip mask ROM, while the H8/3853 has 24 kbytes, and the H8/3852 16 kbytes, of on-chip mask ROM. Note that the H8/3854 flash memory and mask ROM versions have different ROM sizes. The ROM is connected to the CPU by a 16-bit data bus, allowing high-speed 2-state data access for both byte data and word data.

With the flash memory versions (H8/3857F, H8/3854F), programs can be written and erased and programmed either with a general-purpose PROM programmer or on-board.

When carrying out program development using the H8/3854F with the intention of mask ROM implementation, care must be taken with ROM and RAM sizes since the maximum sizes for the mask ROM version are 32 kbytes of ROM and 1 kbyte of RAM.

6.1.1 Block Diagram

Figure 6.1 shows a block diagram of the on-chip ROM.

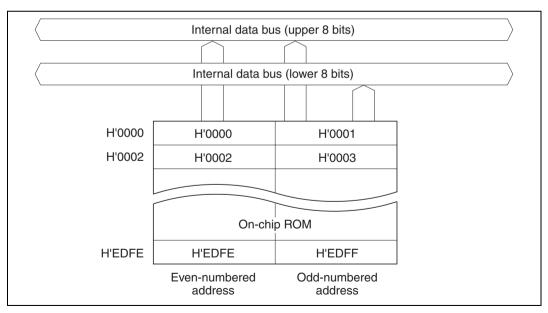


Figure 6.1 ROM Block Diagram (60 kbytes)

6.2 Overview of Flash Memory

6.2.1 Features

Features of the flash memory are summarized below.

- Four flash memory operating modes
 - Program mode
 - Erase mode
 - Program-verify mode
 - Erase-verify mode
- Programming/erase methods

The flash memory is programmed 32 bytes at a time. Erasing is performed in block units. To erase multiple blocks, each block must be erased in turn. In block erasing, 1-kbyte, 28-kbyte, 16-kbyte, and 12-kbyte blocks can be set arbitrarily.

• Programming/erase times

The flash memory programming time is 10 ms (typ.)* for simultaneous 32-byte programming, equivalent to 300 μ s (typ.)* per byte, and the erase time is 100 ms (typ.)* per block.

Reprogramming capability

The flash memory can be reprogrammed up to 100 times.

• On-board programming modes

There are two modes in which flash memory can be programmed/erased/verified on-board:

- Boot mode
- User program mode
- Automatic bit rate adjustment

For data transfer in boot mode, the chip's bit rate can be automatically adjusted to match the transfer bit rate of the host (9600, 4800, or 2400 bps).

Protect modes

There are three protect modes—hardware, software, and error—which allow protected status to be designated for flash memory program/erase/verify operations.

Writer mode

Flash memory can be programmed/erased in Writer mode, using a PROM programmer, as well as in on-board programming mode.

- Notes: 1. Shows the total time during which the P bit in flash memory control register 1 (FLMCR1) is set. The program-verify time is not included.
 - 2. Shows the total time during which the E bit in flash memory control register 1 (FLMCR1) is set. The erase-verify time is not included.



6.2.2 Block Diagram

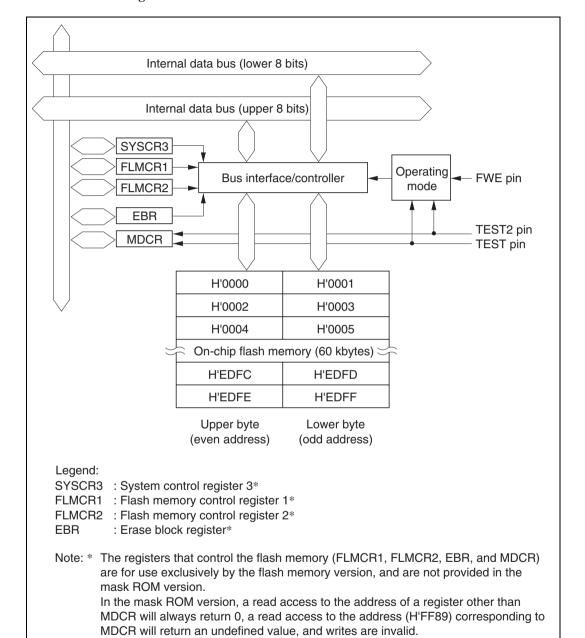


Figure 6.2 Block Diagram of Flash Memory

6.2.3 Flash Memory Operating Modes

Mode Transition Diagram: When the TEST₂, TEST, and FWE pins are set in the reset state and a reset start is effected, the chip enters one of the operating modes shown in figure 6.3. In user mode, the flash memory can be read but cannot be programmed or erased.

Modes in which the flash memory can be programmed and erased are boot mode, user program mode, and Writer mode.

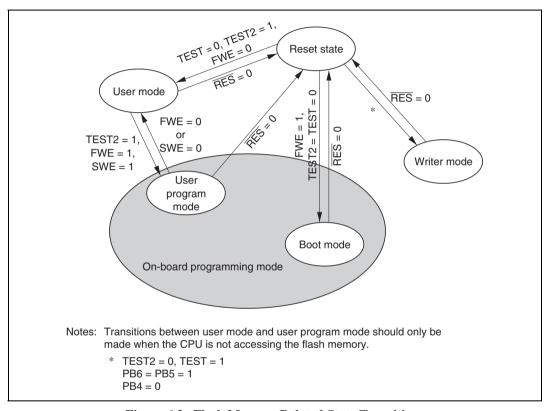


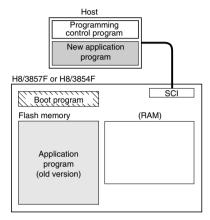
Figure 6.3 Flash Memory Related State Transitions

On-Board Programming Modes

Boot Mode

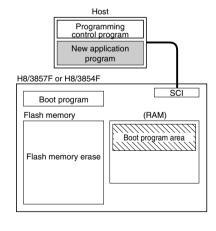
Initial state

The flash memory is in the erased state when shipped. The procedure for rewriting an old version of an application program or data is described here. The user should prepare a programming control program and the new application program beforehand in the host



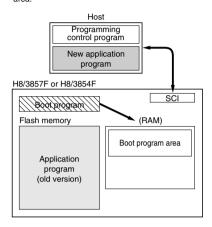
3. Flash memory initialization

The erase program in the boot program area (in RAM) is executed, and the flash memory is initialized (to H'FF). In boot mode, total flash memory erasure is performed, without regard to blocks.



2. Programming control program transfer

When boot mode is entered, the boot program in the chip (already incorporated in the chip) is started, an SCI communication check is carried out, and the boot program required for flash memory erasing is automatically transferred to the RAM boot program area.



4. Writing new application program

The programming control program in the host is transferred to RAM by SCI communication and executed, and the new application program in the host is written into the flash memory.

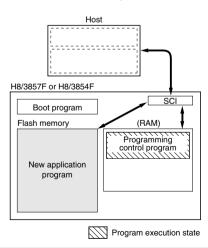
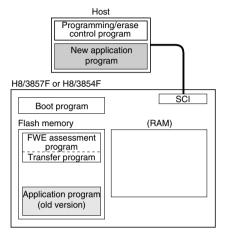


Figure 6.4 Boot Mode

User Program Mode

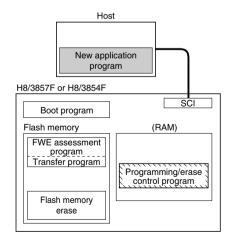
1. Initial state

The FWE assessment program that confirms that a high level has been applied to the FWE pin, and the program that will transfer the programming/erase control program from flash memory to on-chip RAM, should be written into the flash memory by the user beforehand. The programming/erase control program should be prepared in the host or in the flash memory.

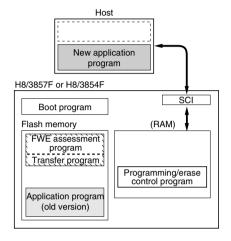


3. Flash memory initialization

The programming/erase program in RAM is executed, and the flash memory is initialized (to H'FF). Erasing can be performed in block units, but not in byte units.



Programming/erase control program transfer When a high level is applied to the FWE pin, user software confirms this fact, executes the transfer program in the flash memory, and transfers the programming/erase control program to RAM.



4. Writing new application program

Next, the new application program in the host is written into the erased flash memory blocks. Do not write to unerased blocks.

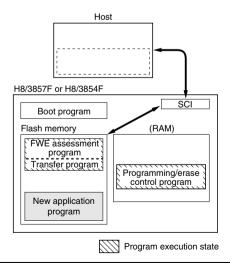


Figure 6.5 User Program Mode (Example)

Differences between Boot Mode and User Program Mode

Table 6.1 Differences between Boot Mode and User Program Mode

| | Boot Mode | User Program Mode |
|------------------------------|------------------------|------------------------|
| Total erase | Possible | Possible |
| Block erase | Not possible | Possible |
| Programming control program* | Program/program-verify | Erase/erase-verify |
| | | Program/program-verify |

Note: * To be provided by the user, in accordance with the recommended algorithm.

Block Configuration: The flash memory is divided into one 12-kbyte block, one 16-kbyte block, one 28-kbyte block, and four 1-kbyte blocks.

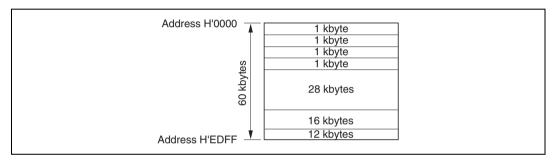


Figure 6.6 Flash Memory Blocks

6.2.4 Pin Configuration

The flash memory is controlled by means of the pins shown in table 6.2.

Table 6.2 Flash Memory Pins

| Pin Name | Abbr. | I/O | Function |
|--------------------|-------|--------|--|
| Reset | RES | Input | Reset |
| Flash write enable | FWE | Input | Flash program/erase protection by hardware |
| Test 2 | TEST2 | Input | Sets H8/3857F operating mode |
| Test | TEST | Input | Sets H8/3857F operating mode |
| Transmit data* | TXD | Output | SCI3 transmit data output |
| Receive data* | RXD | Input | SCI3 receive data input |

Note: * The transmit data pin and receive data pin are used in boot mode.

6.2.5 Register Configuration

The registers used to control the on-chip flash memory when enabled are shown in table 6.3. In order to access these registers, the FLSHE bit in SYSCR3 must be set to 1.

Table 6.3 Flash Memory Registers

| Register Name | Abbr. | R/W | Initial Value | Address |
|---------------------------------|----------|-------------------|---------------|----------|
| Flash memory control register 1 | FLMCR1*5 | R/W* ² | H'00*3 | H'FF80*1 |
| Flash memory control register 2 | FLMCR2*5 | R/W* ² | H'00*4 | H'FF81*1 |
| Erase block register | EBR*5 | R/W* ² | H'00*4 | H'FF83*1 |
| Mode control register | MDCR | R | Undefined | H'FF89 |
| System control register 3 | SYSCR3 | R/W | H'00 | H'FF8F |

Notes: 1. Flash memory register selection is performed by means of the FLSHE bit in system control register 3 (SYSCR3).

- 2. When the FWE bit in FLMCR1 is cleared to 0, writes are invalid.
- 3. When a high level is input to the FWE pin, the initial value is H'80.
- 4. When a low level is input to the FWE pin, or if a high level is input and the SWE bit in FLMCR1 is not set, these registers are initialized to H'00.
- FLMCR1, FLMCR2, and EBR are 8-bit registers. Only byte accesses are valid for these registers, the access requiring 2 states.

The registers shown in table 6.3 are for use exclusively by the flash memory version. In the mask ROM version, a read access to the address of a register other than MDCR will always return 0, a read access to the MDCR address will return an undefined value, and writes are invalid.

6.3 Flash Memory Register Descriptions

6.3.1 Flash Memory Control Register 1 (FLMCR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|---|---|-----|-----|-----|-----|
| | FWE | SWE | _ | _ | EV | PV | Е | Р |
| Initial value | * | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R/W | _ | _ | R/W | R/W | R/W | R/W |

Note: * Determined by the state of the FWE pin.

FLMCR1 is an 8-bit register used for flash memory operating mode control. Program-verify mode or erase-verify mode is entered by setting SWE to 1 when FWE = 1, then setting the corresponding bit. Program mode is entered by setting SWE to 1 when FWE = 1, then setting the PSU bit in FLMCR2, and finally setting the P bit. Erase mode is entered by setting SWE to 1

when FWE = 1, then setting the ESU bit in FLMCR2, and finally setting the E bit. FLMCR1 is initialized by a reset and in standby mode. Its initial value is H'80 when a high level is input to the FWE pin, and H'00 when a low level is input.

Writes to the SWE bit in FLMCR1 are enabled only when FWE = 1; writes to the EV and PV bits only when FWE = 1 and SWE = 1; writes to the E bit only when FWE = 1, SWE = 1, and ESU = 1; and writes to the P bit only when FWE = 1, SWE = 1, and PSU = 1.

Bit 7—Flash Write Enable (FWE): Bit 7 sets hardware protection against flash memory programming/erasing. See section 6.9, Flash Memory Programming and Erasing Precautions, for more information on the use of this bit.

Bit 7: FWE Description

| 0 | When a low level is input to the FWE pin (hardware-protected state) |
|---|---|
| 1 | When a high level is input to the FWE pin |

Bit 6—Software Write Enable (SWE)*1*2: Bit 6 enables or disables flash memory programming and erasing. (This bit should be set before setting bits ESU, PSU, EV, PV, E, P, and EB6 to EB0, and should not be cleared at the same time as these bits.)

Bit 6: SWE Description

| 0 | Programming/erasing disabled | (initial value) | | | | |
|---|------------------------------|-----------------|--|--|--|--|
| 1 | Programming/erasing enabled | | | | | |
| | [Setting condition] | | | | | |
| | When FWE = 1 | | | | | |

Bits 5 and 4—Reserved Bits: Bits 5 and 4 are reserved; they are always read as 0 and cannot be modified.

Bit 3—Erase-Verify (EV)*1: Bit 3 selects erase-verify mode transition or clearing. (Do not set the SWE, ESU, PSU, PV, E, or P bit at the same time.)

Bit 3: EV Description

| 0 | Erase-verify mode cleared | (initial value) | | | |
|--------------------------|---------------------------------|-----------------|--|--|--|
| 1 | Transition to erase-verify mode | | | | |
| | | | | | |
| When FWE = 1 and SWE = 1 | | | | | |

Bit 2—Program-Verify (PV)*¹: Bit 2 selects program-verify mode transition or clearing. (Do not set the SWE, ESU, PSU, EV, E, or P bit at the same time.)

| Bit 2: PV | Description | | | |
|-----------|-----------------------------------|-----------------|--|--|
| 0 | Program-verify mode cleared | (initial value) | | |
| 1 | Transition to program-verify mode | | | |
| | [Setting condition] | | | |
| | When FWE = 1 and SWE = 1 | | | |

Bit 1—Erase (E)*¹*³: Bit 1 selects erase mode transition or clearing. (Do not set the SWE, ESU, PSU, EV, PV, or P bit at the same time.)

| Bit 1: E | Description | | | |
|----------|------------------------------------|-----------------|--|--|
| 0 | Erase mode cleared | (initial value) | | |
| 1 | Transition to erase mode | | | |
| | [Setting condition] | | | |
| | When FWE = 1, SWE = 1, and ESU = 1 | | | |

Bit 0—Program (P)*¹*³: Bit 0 selects program mode transition or clearing. (Do not set the SWE, ESU, PSU, EV, PV, or E bit at the same time.)

| Bit 0: P | Description | |
|----------|------------------------------------|-----------------|
| 0 | Program mode cleared | (initial value) |
| 1 | Transition to program mode | |
| | [Setting condition] | |
| | When FWE = 1, SWE = 1, and PSU = 1 | |

Notes: 1. Do not set multiple bits simultaneously. Do not cut V_{cc} while a bit is set.

- 2. The SWE bit must not be set or cleared at the same time as other bits (bits EV, PV, E, and P in FLMCR1, and bits ESU and PSU in FLMCR2).
- 3. P bit and E bit setting should be carried out in accordance with the program/erase algorithms shown in section 6.5, Flash Memory Programming/Erasing. Before setting either of these bits, a watchdog timer setting should be made to prevent program runaway. See section 6.9, Flash Memory Programming and Erasing Precautions, for more information on the use of these bits.

6.3.2 Flash Memory Control Register 2 (FLMCR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|-----|-----|
| | FLER | | _ | | _ | | ESU | PSU |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | | _ | _ | _ | _ | R/W | R/W |

FLMCR2 is an 8-bit register used for monitoring of flash memory program/erase protection (error protection) and for flash memory program/erase mode setup. FLMCR2 is initialized to H'00 by a reset. The ESU and PSU bits are cleared to 0 in standby mode, hardware protect mode, and software protect mode.

Bit 7—Flash Memory Error (FLER): Bit 7 indicates that an error has occurred during an operation on flash memory (programming or erasing). When FLER is set to 1, flash memory goes to the error-protection state.

Bit 7: FLER Description

| 0 | Flash memory is operating normally | |
|---|--|-----------------|
| | Flash memory program/erase protection (error protection) is disabled | |
| | [Clearing condition] | |
| | Reset | (initial value) |
| 1 | An error occurred during flash memory programming/erasing | |
| | Flash memory program/erase protection (error protection) is enabled | |
| | [Setting condition] | |
| | See section 6.6.3, Error Protection | |

Bits 6 to 2—Reserved Bits: Bits 6 to 2 are reserved; they are always read as 0 and cannot be modified.

Bit 1—Erase Setup (ESU)*: Bit 1 prepares for a transition to erase mode. Set this bit to 1 before setting the E bit in FLMCR1. (Do not set the SWE, PSU, EV, PV, E, or P bit at the same time.)

Bit 1: ESU Description

| 0 | Erase setup cleared | (initial value) |
|---|--------------------------|-----------------|
| 1 | Erase setup | |
| | [Setting condition] | |
| | When FWE = 1 and SWE = 1 | |

Bit 0—Program Setup (PSU)*: Bit 0 prepares for a transition to program mode. Set this bit to 1 before setting the P bit in FLMCR1. (Do not set the SWE, ESU, EV, PV, E, or P bit at the same time.)

| Bit 0: | PSU | Description |
|--------|-----|-------------|
| D | | Booonipaion |

| 0 | Program setup cleared | (initial value) |
|---|--------------------------|-----------------|
| 1 | Program setup | |
| | [Setting condition] | |
| | When FWE = 1 and SWE = 1 | |

Note: * Do not set multiple bits simultaneously. Do not cut V_{cc} while a bit is set.

6.3.3 Erase Block Register (EBR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|-----|-----|-----|-----|-----|-----|-----|
| | | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | R/W |

EBR is a register that specifies the flash memory erase area, block by block. Bits 6 to 0 of EBR are read/write bits. EBR is initialized to H'00 by a reset, in standby mode, when a low level is input to the FWE pin, and when a high level is input to the FWE pin while the SWE bit in FLMCR1 is cleared to 0. When a bit in EBR is set to 1, the corresponding block can be erased. Other blocks are erase-protected. As erasing is carried out on a block-by-block basis, only one bit in EBR should be set at a time (more than one bit must not be set).

The flash memory block configuration is shown in table 6.4. To erase the entire flash memory, individual blocks must be erased in succession.

Table 6.4 Flash Memory Erase Blocks

| Block (Size) | Addresses |
|-----------------|------------------|
| EB0 (1 kbyte) | H'0000 to H'03FF |
| EB1 (1 kbyte) | H'0400 to H'07FF |
| EB2 (1 kbyte) | H'0800 to H'0BFF |
| EB3 (1 kbyte) | H'0C00 to H'0FFF |
| EB4 (28 kbytes) | H'1000 to H'7FFF |
| EB5 (16 kbytes) | H'8000 to H'BFFF |
| EB6 (12 kbytes) | H'C000 to H'EDFF |

6.3.4 Mode Control Register (MDCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|-------|-------|
| | | | _ | _ | _ | _ | TSDS2 | TSDS1 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | * | * |
| Read/Write | _ | | _ | _ | _ | _ | R | R |

Note: * Determined by the TEST2 and TEST pins.

MDCR is an 8-bit read-only register used to monitor the current operating mode of the H8/3857F.

Bits 7 to 2—Reserved Bits: Bits 7 to 2 are reserved; they are always read as 0 and cannot be modified.

Bits 1 and 0—Test Pin Monitor 2 and 1 (TSDS2, TSDS1): Bits 1 and 0 show values that reflect the input levels at the test pins (TEST2 and TEST) (i.e. they indicate the current operating mode). Bits TSDS2 and TSDS1 correspond to pins TEST2 and TEST, respectively. These bits are read-only, and cannot be modified.

6.3.5 System Control Register 3 (SYSCR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|-------|---|---|---|
| | _ | _ | _ | _ | FLSHE | _ | _ | _ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | _ | R/W | _ | _ | _ |

SYSCR3 is an 8-bit read/write register that controls the on-chip flash memory.

SYSCR3 is initialized to H'00 by a reset.

Bits 7 to 4—Reserved Bits: Bits 7 to 4 are reserved; they are always read as 0 and cannot be modified.

Bit 3—Flash Memory Control Register Enable (FLSHE): Bit 3 controls CPU access to the flash memory control registers (FLMCR1, FLMCR2, and EBR). When the FLSHE bit is set to 1, the flash memory control registers can be read and written to. When FLSHE is cleared to 0, the flash memory control registers are unselected. In this case, the contents of the flash memory control registers are retained.

Bit 3: FLSHE Description

| 0 | Flash memory control registers are unselected for addresses H'FF80 to H'FF83 |
|---|--|
| | (initial value) |
| 1 | Flash memory control registers are selected for addresses H'FF80 to H'FF83 |

Bits 2 to 0—Reserved Bits: Bits 2 to 0 are reserved; they are always read as 0 and cannot be modified.

6.4 On-Board Programming Modes

When an on-board programming mode is selected, the on-chip flash memory can be programmed, erased, and verified. There are two on-board programming modes: boot mode and user program mode. Table 6.5 shows the pin settings for transition to each mode. A state transition diagram for flash memory related modes is shown in figure 6.3.

Table 6.5 On-Board Programming Mode Selection

| Mode | Pins | | | |
|---------------------|------|-------|------|--|
| MCU Mode | FWE | TEST2 | TEST | |
| Boot mode | 1*2 | 0 | 0 | |
| User program mode*1 | 1 | 1 | 0 | |

Notes: 1. The FWE pin should normally be set to 0. Before performing programming, erasing, or verifying, set the FWE pin to 1 and make a transition to user program mode.

2. For the high level application timing, see items (f) and (g) under (3) Notes on Use of Boot Mode in section 6.4.1, Boot Mode.



6.4.1 Boot Mode

To use boot mode, a user program for programming and erasing the flash memory must be provided in advance in the host. SCI3 is used in asynchronous mode.

When a reset start is executed after the chip's pins have been set to boot mode, the built-in boot program is activated, and the programming control program provided in the host is transferred sequentially to the chip using SCI3. The chip writes the programming control program received via SCI3 to the programming control program area in the on-chip RAM. After the transfer is completed, execution branches to the start address (H'FB80) of the programming control program area, and the programming control program execution state is entered (flash memory programming is performed).

Therefore, a routine conforming to the programming algorithm described later must be provided in the programming control program transferred from the host.

Figure 6.7 shows the system configuration in boot mode, and figure 6.8 shows the boot mode execution procedure.

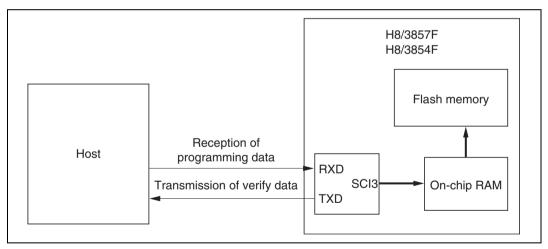


Figure 6.7 System Configuration when Using Boot Mode

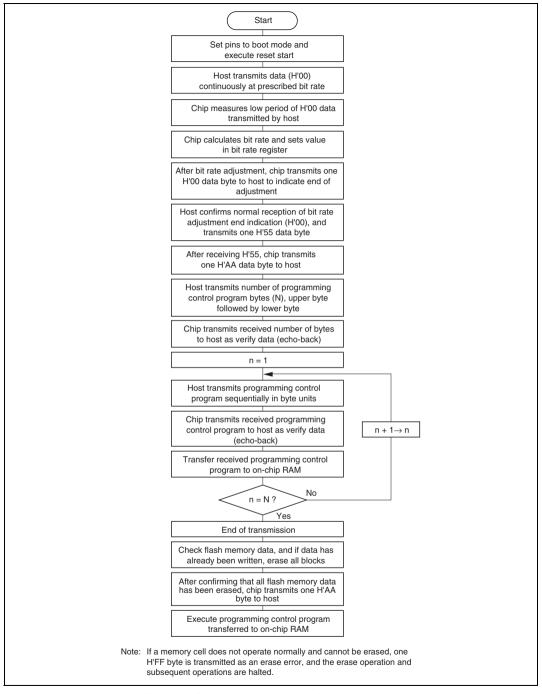


Figure 6.8 Boot Mode Execution Procedure

Automatic SCI Bit Rate Adjustment

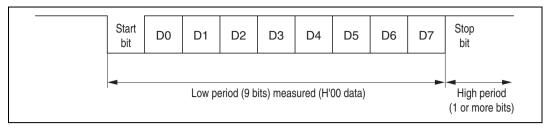


Figure 6.9 RXD Input Signal in Automatic SCI Bit Rate Adjustment

When boot mode is initiated, the chip measures the low period of the asynchronous SCI communication data (H'00) transmitted continuously from the host. The SCI transmit/receive format should be set as 8-bit data, 1 stop bit, no parity. The chip calculates the bit rate of the transmission from the host from the measured low period, and transmits one H'00 byte to the host to indicate the end of bit rate adjustment. The host should confirm that this adjustment end indication (H'00) has been received normally, and transmit one H'55 byte to the chip. If reception cannot be performed normally, initiate boot mode again (reset), and repeat the above operations. Depending on the host's transmission bit rate and the chip's system clock frequency, there will be a discrepancy between the bit rates of the host and the chip. To ensure correct SCI operation, the host's transfer bit rate should be set to 2400, 4800, or 9600 bps*1.

Table 6.6 shows typical host transfer bit rates and system clock frequencies for which automatic adjustment of the chip's bit rate is possible. The boot program should be executed within this system clock oscillation frequency range*².

- Notes: 1. Use a host bit rate setting of 2400, 4800, or 9600 bps only. No other setting should be used.
 - 2. Although the chip may also perform automatic bit rate adjustment with bit rate and system clock combinations other than those shown in table 6.6, a degree of error will arise between the bit rates of the host and the chip, and subsequent transfer will not be performed normally. Therefore, only a combination of bit rate and system clock oscillation frequency within one of the ranges shown in table 6.6 can be used for boot mode execution.

2400bps

Table 6.6 System Clock Oscillation Frequencies for which Automatic Adjustment of Chip's Bit Rate is Possible

1.2288 MHz, 2 MHz to 10 MHz

| Host Bit Rate | of Chip's Bit Rate is Possible |
|---------------|---|
| 9600bps | 1.2288 MHz, 2.4576 MHz, 4.9152 MHz, 6 MHz to 10 MHz |
| 4800bps | 1.2288 MHz, 2.4576 MHz, 4 MHz to 10 MHz |

System Clock Oscillation Frequencies (f) for which Automatic Adjustment

On-Chip RAM Area Divisions in Boot Mode: In boot mode, the 1-kbyte area from H'F780 to H'FB7F is reserved as an area for use by the boot program, as shown in figure 6.10. The area to which the programming control program is transferred comprises addresses H'FB80 to H'FF7F. The boot program area becomes available when the programming control program transferred to RAM switches to the execution state. A stack area should be set up as necessary.

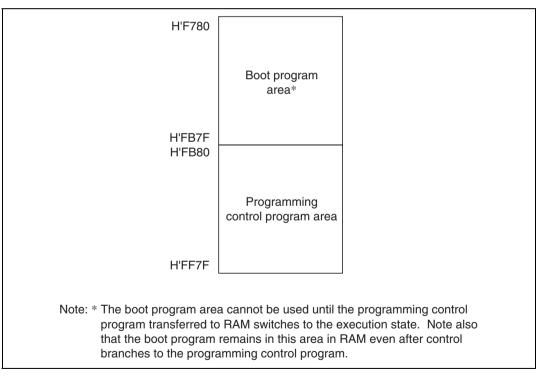


Figure 6.10 RAM Areas in Boot Mode

Notes on Use of Boot Mode

- 1. When the chip comes out of reset in boot mode, it measures the low period of the input at the SCI3's RXD pin. The reset should end with RXD high. After the reset ends, it takes about 100 states for the chip to get ready to measure the low period of the RXD input.
- 2. In boot mode, if any data has been programmed into the flash memory (if all data is not 1), all flash memory blocks are erased. Boot mode is for use when user program mode is unavailable, such as the first time on-board programming is performed, or if the program activated in user program mode is accidentally erased.
- 3. Interrupts cannot be used while the flash memory is being programmed or erased.
- 4. The RXD and TXD lines should be pulled up on the board.
- 5. Before branching to the programming control program (RAM area address HFB80), the chip terminates transmit and receive operations by the on-chip SCI3 (by clearing the RE and TE bits to 0 in SCR3), but the adjusted bit rate value remains set in BRR. The transmit data output pin, TXD, goes to the high-level output state (PCR4₂ = 1 in port control register 4, P4₂ = 1 in port data register 4).

The contents of the CPU's internal general registers are undefined at this time, so these registers must be initialized immediately after branching to the programming control program. In particular, since the stack pointer (SP) is used implicitly in subroutine calls, etc., a stack area must be specified for use by the programming control program.

The initial values of other on-chip registers are not changed.

- 6. Boot mode can be entered by making the pin settings shown in table 6.5, and then executing a reset start.
 - Boot mode can be exited by waiting at least 10 system clock cycles after driving the reset pin low*², then setting the FWE, TEST2, and TEST pins to execute reset release*¹. Boot mode can also be exited when a WDT overflow reset occurs.
 - Do not change the input levels at the FWE, TEST2, and TEST pins while in boot mode. The FWE pin must not be driven low while the boot program is running or flash memory is being programmed or erased*³.
- 7. If the input level of the TEST2, TEST, or FWE pin is changed (for example, from low to high) during a reset, the MCU's operating mode will change, and as a result, the port states will also change. Therefore, care must be taken to make pin settings to prevent these pins from becoming output signal pins during a reset, or to prevent collision with signals outside the MCU.
- Notes: 1. TEST2, TEST, and FWE pin input must satisfy the mode programming setup time (t_{MDS} = 4 states) with respect to the reset release timing.
 - 2. See section 3.2.2, Reset Sequence, and section 6.9, Flash Memory Programming and Erasing Precautions.

3. For further information on FWE application and disconnection, see section 6.9, Flash Memory Programming and Erasing Precautions.

6.4.2 User Program Mode

When set to user program mode, the chip can program and erase its flash memory by executing a user programming/erase control program. Therefore, on-board reprogramming of the on-chip flash memory can be carried out by providing on-board means of FWE control and supply of programming data, and incorporating a programming/erase control program in part of the program area as necessary.

To select user program mode, start up in user program mode (TEST2 = 1, TEST = 0), and apply a high level to the FWE pin. In this mode, on-chip supporting modules other than flash memory operate as they normally would in user mode.

The flash memory itself cannot be read while the SWE bit is set to 1 to carry out flash memory programming or erasing, so the control program that performs programming and erasing must be executed in on-chip RAM.



Figure 6.11 shows the execution procedure when the programming/erase control program is transferred to on-chip RAM.

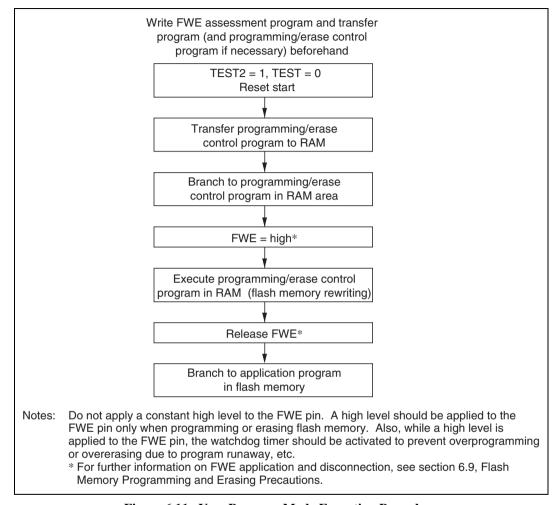


Figure 6.11 User Program Mode Execution Procedure

6.5 Flash Memory Programming/Erasing

A software method, using the CPU, is employed to program and erase flash memory in the on-board programming modes. There are four flash memory operating modes: program mode, erase mode, program-verify mode, and erase-verify mode. Transitions to these modes are made by setting the PSU and ESU bits in FLMCR2, and the P, E, PV, and EV bits in FLMCR1.

The flash memory cannot be read while being programmed or erased. Therefore, the program that controls flash memory programming/erasing (the programming control program) should be placed in on-chip RAM, and executed there.

See section 6.9, Flash Memory Programming and Erasing Precautions, for points to note concerning programming and erasing, and section 15.2.6, Flash Memory Characteristics, for the wait times after setting or clearing FLMCR1 and FLMCR2 bits.

- Notes: 1. Operation is not guaranteed if setting/resetting of the SWE, EV, PV, E, and P bits in FLMCR1 and the ESU and PSU bits in FLMCR2 is executed by a program in flash memory.
 - 2. When programming or erasing, set FWE to 1 (programming/erasing will not be executed if FWE = 0).
 - 3. Programming should be performed in the erased state. Do not perform additional programming on addresses that have already been programmed.

6.5.1 Program Mode

When writing data or programs to flash memory, the program/program-verify flowchart shown in figure 6.12 should be followed. Performing programming operations according to this flowchart will enable data or programs to be written to flash memory without subjecting the device to voltage stress or sacrificing programming data reliability. Programming should be carried out 32 bytes at a time.

The wait times $(x, y, z, \alpha, \beta, \gamma, \epsilon, \eta)$ after bits are set or cleared in flash memory control register 1 (FLMCR1) and flash memory control register 2 (FLMCR2), and the maximum number of programming operations (N), are shown in table 15.10 in section 15.2.6, Flash Memory Characteristics.

Following the elapse of (x) µs or more after the SWE bit is set to 1 in FLMCR1, 32-byte programming data is stored in the programming data area and the reprogramming data area, and the 32 bytes of data in the reprogramming data area in RAM are written consecutively to the write addresses. The lower 8 bits of the first address written to must be H'00, H'20, H'40, H'60, H'80, H'A0, H'C0, or H'E0. Thirty-two consecutive byte data transfers are performed. The programming address and programming data are latched in the flash memory. A 32-byte data transfer must be



performed even if writing fewer than 32 bytes; in this case, H'FF data must be written to the extra addresses.

Next, the watchdog timer is set to prevent overprogramming in the event of program runaway, etc. Set a value greater than $(y + z + \alpha + \beta)$ µs as the WDT overflow period. After this, preparation for program mode (program setup) is carried out by setting the PSU bit in FLMCR2, and after the elapse of (y) µs or more, the operating mode is switched to program mode by setting the P bit in FLMCR1. The time during which the P bit is set is the flash memory programming time. Make a program setting so that the time for one programming operation is within the range of (z) µs.

6.5.2 Program-Verify Mode

In program-verify mode, the data written in program mode is read to check whether it has been correctly written in the flash memory.

After the elapse of the given programming time, the programming mode is exited (the P bit in FLMCR1 is cleared, then the PSU bit in FLMCR2 is cleared at least (α) μ s later). The watchdog timer is cleared following the elapse of more than ($y + z + \alpha + \beta$) μ s after being set, and the operating mode is switched to program-verify mode by setting the PV bit in FLMCR1. Before reading in program-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) μ s or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) μ s after the dummy write before performing this read operation. Next, the originally written data is compared with the verify data, and reprogramming data is computed (see figure 6.12) and transferred to the reprogramming data area. After 32 bytes of data have been verified, exit program-verify mode, wait for at least (η) μ s, then clear the SWE bit in FLMCR1. If reprogramming is necessary, set program mode again, and repeat the program/program-verify sequence as before. However, ensure that the program/program-verify sequence is not repeated more than (N) times on the same bits.

Note: A 32-byte area for storing programming data and a 32-byte area for storing reprogramming data must be provided in RAM.



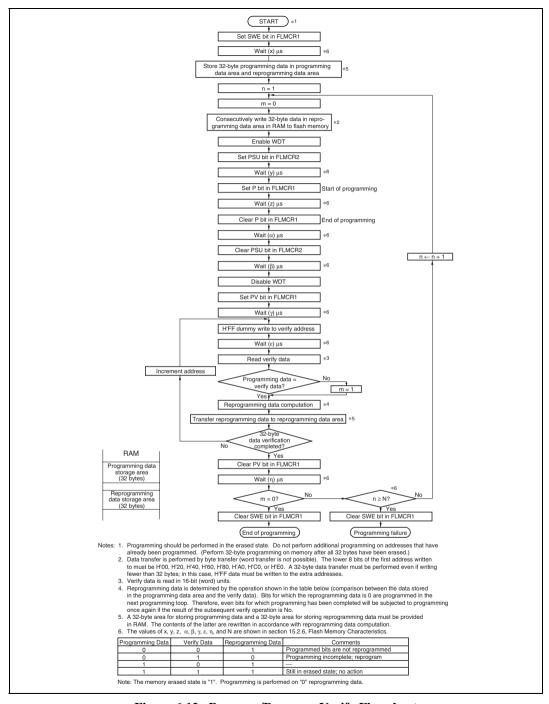


Figure 6.12 Program/Program-Verify Flowchart

6.5.3 Erase Mode

To erase an individual flash memory block, follow the erase/erase-verify flowchart (single-block erase) shown in figure 6.13.

The wait times $(x, y, z, \alpha, \beta, \gamma, \epsilon, \eta)$ after bits are set or cleared in flash memory control register 1 (FLMCR1) and flash memory control register 2 (FLMCR2), and the maximum number of erase operations (N), are shown in table 15.10 in section 15.2.6, Flash Memory Characteristics.

To perform data or program erasure, make a 1-bit setting for the flash memory area to be erased in the erase block register (EBR) at least (x) μ s after setting the SWE bit to 1 in flash memory control register 1 (FLMCR1). Next, set up the watchdog timer to prevent overerasing in the event of program runaway, etc. Set a value greater than $(y + z + \alpha + \beta)$ μ s as the WDT overflow period. After this, preparation for erase mode (erase setup) is carried out by setting the ESU bit in FLMCR2, and after the elapse of (y) μ s or more, the operating mode is switched to erase mode by setting the E bit in FLMCR1. The time during which the E bit is set is the flash memory erase time. Ensure that the erase time does not exceed (z) ms.

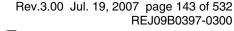
Note: With flash memory erasing, prewriting (setting memory data in the memory to be erased to all 0) is not necessary before starting the erase procedure.

6.5.4 Erase-Verify Mode

In erase-verify mode, data is read after memory has been erased to check whether it has been correctly erased.

After the elapse of the erase time, erase mode is exited (the E bit in FLMCR1 is cleared, then the ESU bit in FLMCR2 is cleared at least (α) μ s later). The watchdog timer is cleared following the elapse of more than ($y + z + \alpha + \beta$) μ s after being set, and the operating mode is switched to eraseverify mode by setting the EV bit in FLMCR1. Before reading in erase-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (y) μ s or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) μ s after the dummy write before performing this read operation. If the read data has been erased (all 1), execute a dummy write to the next address, and perform an erase-verify. If the read data has not been erased, select erase mode again and repeat the erase/erase-verify sequence as before. However, ensure that the erase/erase-verify sequence is not repeated more than (N) times.

When verification is completed, exit erase-verify mode, and wait for at least (η) μ s. If erasure has been completed on all the erase blocks, clear the SWE bit in FLMCR1. If there are any unerased blocks, make a 1-bit setting in EBR for the flash memory block to be erased, and repeat the erase/erase-verify sequence as before.



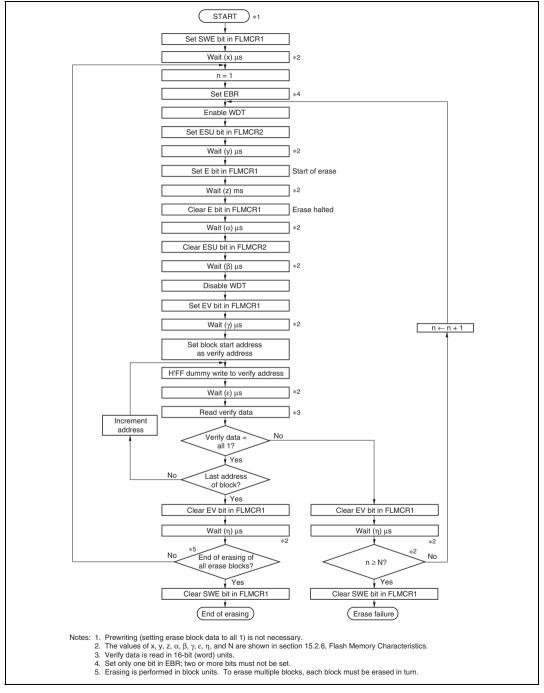


Figure 6.13 Erase/Erase-Verify Flowchart (Single-Block Erase)

6.6 **Flash Memory Protection**

There are three kinds of flash memory program/erase protection: hardware, software, and error protection.

6.6.1 **Hardware Protection**

Hardware protection refers to a state in which programming/erasing of flash memory is forcibly disabled or aborted. In this state, the settings in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the erase block register (EBR) are reset. (See table 6.7.)

Table 6.7 **Hardware Protection**

| | | | Functions | 6 |
|--------------------------|--|-----------------|-------------------------------|-----------------|
| Item | Description | Program | Erase | Verify*1 |
| FWE pin protection | When a low level is input to the FWE pin, FLMCR1, FLMCR2 (except the FLER bit), and EBR are initialized, and the program/erase-protected state is entered.*3 | Not possible | Not possible*2 | Not possible |
| Reset/standby protection | In a reset (including a WDT overflow reset) and in standby mode, FLMCR1, FLMCR2, and EBR are initialized, and the program/ erase-protected state is entered. In a reset via the RES pin, the reset state is not entered unless the RES pin is held low for a minimum of 40 ms (oscillation stabilization time)*⁴ after powering on. In the case of a reset during operation, hold the RES pin low for a minimum of 10 system clock cycles (10φ). | Not possible | Not possible* ² | Not possible |

- Notes: 1. Two modes: program-verify and erase-verify.
 - 2. All blocks are unerasable and block-by-block specification is not possible.
 - 3. For details see section 6.9, Flash Memory Programming and Erasing Precautions.
 - 4. For details see the AC characteristics in sections 15.2.3 and 16.2.3. Electrical Characteristics.



6.6.2 Software Protection

Software protection can be implemented by setting the SWE bit in flash memory control register 1 (FLMCR1), and the erase block register (EBR). With software protection, setting the P or E bit in FLMCR1 does not cause a transition to program mode or erase mode. (See table 6.8.)

Table 6.8 Software Protection

| | | | Function | s |
|---------------------|--|-------------------|-----------------|-----------------|
| Item | Description | Program | Erase | Verify*1 |
| SWE bit protection | Clearing the SWE bit to 0 in FLMCR1 sets the program/erase-protected state for all blocks. (Execute in on-chip RAM.) | s Not possible | Not possible | Not possible |
| Block protection | Individual blocks can be protected from erasing and programming by settings in the erase block register (EBR)*2. | — ne | Not possible | Possible |
| | If H'00 is set in EBR, all blocks are protect from erasing and programming. | ted | | |

Notes: 1. Two modes: program-verify and erase-verify.

2. When not erasing, clear all EBR bits to 0.

6.6.3 Error Protection

In error protection, an error is detected when MCU runaway occurs during flash memory programming/erasing*¹, or operation is not performed in accordance with the program/erase algorithm, and the program/erase operation is aborted. Aborting the program/erase operation prevents damage to the flash memory due to overprogramming or overerasing.

If the MCU malfunctions during flash memory programming/erasing, the FLER bit is set to 1 in FLMCR2 and the error protection state is entered. FLMCR1, FLMCR2, and EBR settings*2 are retained, but program mode or erase mode is aborted at the point at which the error occurred. Program mode or erase mode cannot be re-entered by re-setting the P or E bit. However, PV and EV bit setting is enabled, and a transition can be made to verify mode.

FLER bit setting conditions are as follows:

- 1. When flash memory is read*³ during programming/erasing (including a vector read or instruction fetch)
- 2. Immediately after the start of exception handling (excluding a reset) during programming/erasing*⁴



3. When a SLEEP instruction (including software standby) is executed during programming/erasing

Error protection is released only by a reset.

Figure 6.14 shows the flash memory state transition diagram.

Notes: 1. This is the state in which the P bit or E bit is set to 1 in FLMCR1.

- 2. FLMCR1, FLMCR2, and EBR can be written to. However, registers will be initialized if a transition is made to software standby mode in the error protection state.
- 3. The read value is undefined.
- 4. Before exception handling stack and vector read operations are performed.

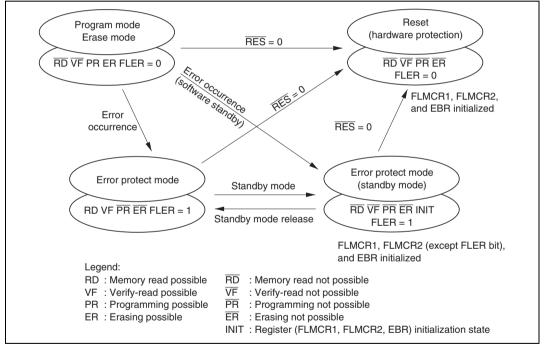


Figure 6.14 Flash Memory State Transitions

The error protection function is invalid for abnormal operations other than the FLER bit setting conditions. Also, if a certain time has elapsed before this protection state is entered, damage may already have been caused to the flash memory. Consequently, this function cannot provide complete protection against damage to flash memory.

To prevent such abnormal operations, therefore, it is necessary to ensure correct operation in accordance with the program/erase algorithm, with the flash write enable (FWE) voltage applied, and to conduct constant monitoring for MCU errors, internally and externally, using the watchdog timer or other means. There may also be cases where the flash memory is in an erroneous programming or erroneous erasing state at the point of transition to the protect mode, or where programming or erasing is not properly carried out because of an abort. In cases such as these, a forced recovery (program rewrite) must be executed using boot mode. However, it may also happen that boot mode cannot be normally initiated because of overprogramming or overerasing.

6.7 Interrupt Handling during Flash Memory Programming and Erasing

All interrupts should be disabled when flash memory is being programmed or erased (while the P or E bit is set in FLMCR1) and while the boot program is executing in boot mode*¹, to give priority to the program or erase operation. There are three reasons for this:

- 1. Interrupt occurrence during programming or erasing might cause a violation of the programming or erasing algorithm, with the result that normal operation could not be assured.
- 2. In the interrupt exception handling sequence during programming or erasing, the vector would not be read correctly*², possibly resulting in MCU runaway.
- 3. If an interrupt occurred during boot program execution, it would not be possible to execute the normal boot mode sequence.

For these reasons, there are conditions for disabling interrupts in the on-board programming modes alone, as an exception to the general rule. However, this provision does not guarantee normal erasing and programming or MCU operation.

All interrupt requests must therefore be disabled inside and outside the MCU when flash memory is programmed or erased.

- Notes: 1. Interrupt requests must be disabled inside and outside the MCU until programming by the programming control program has been completed.
 - 2. The vector may not be read correctly in this case for the following two reasons:
 - If flash memory is read while being programmed or erased (while the P or E bit is set in FLMCR1), correct read data will not be obtained (undefined values will be returned).
 - If a value has not yet been written in the interrupt vector table, interrupt exception handling will not be executed correctly.



Flash Memory Writer Mode 6.8

6.8.1 Writer Mode Setting

Programs and data can be written and erased in Writer mode as well as in the on-board programming modes. In Writer mode, the on-chip ROM can be freely programmed using a PROM programmer that supports the Renesas Technology microcomputer device type with 64-kbyte onchip flash memory. Flash memory read mode, auto-program mode, auto-erase mode, and status read mode are supported with this device type. In auto-program mode, auto-erase mode, and status read mode, a status polling procedure is used, and in status read mode, detailed internal signals are output after execution of an auto-program or auto-erase operation.

6.8.2 **Socket Adapter and Memory Map**

In Writer mode, a socket adapter for the relevant kind of package is attached to the PROM programmer. The socket adapter performs 144-pin to 32-pin conversion for the HD64F3857, and 100-pin to 32-pin conversion for the HD64F3854. The socket adaptor ptoduct code is given in table 6.9.

Figure 6.15 shows the memory map in Writer mode, and figures 6.16 (a) and (b) show the socket adapter pin interconnections for the HD64F3857 and the HD64F3854.

Table 6.9 Socket Adapter Part No.

| Part No. | Package | Socket Adapter Part No. |
|-----------|-------------------------|--------------------------------------|
| HD64F3857 | 144-pin TQFP (TFP-144) | Details available from Renesas Sales |
| | 144-pin QFP (FP-144H) | |
| HD64F3854 | 100-pin TQFP (TFP-100G) | _ |
| | 100-pin QFP (FP-100B) | _ |

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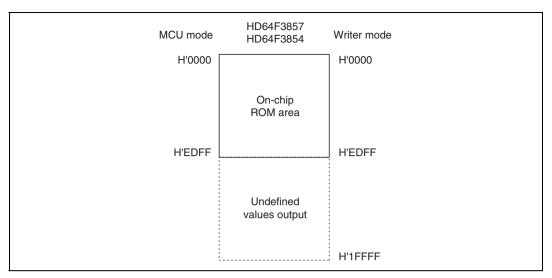


Figure 6.15 Memory Map in Writer Mode



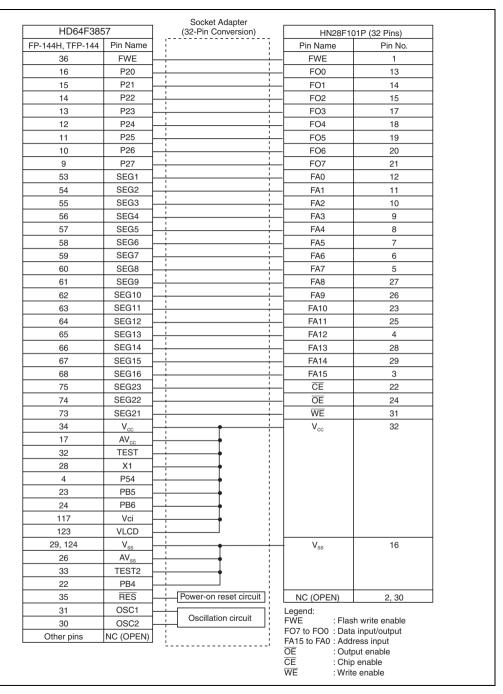


Figure 6.16 (a) HD64F3857 Socket Adapter Pin Interconnections

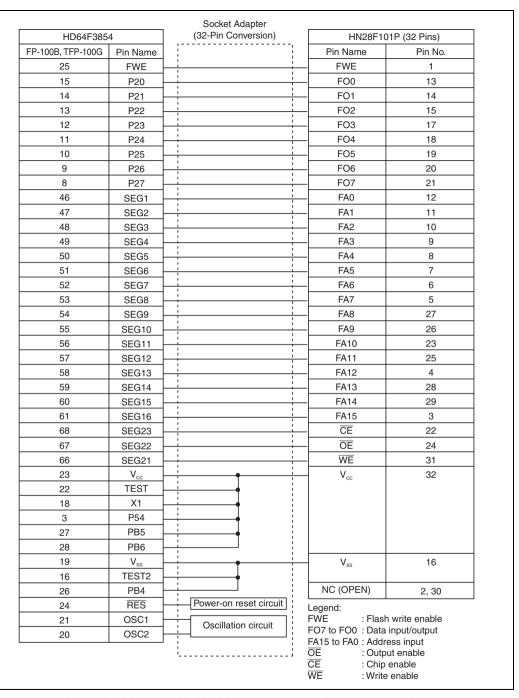


Figure 6.16 (b) HD64F3854 Socket Adapter Pin Interconnections

Writer Mode Operation 6.8.3

Table 6.10 shows how the different operating modes are set when using Writer mode, and table 6.11 lists the commands used in Writer mode. Details of each mode are given below.

Memory Read Mode: Memory read mode supports byte reads.

Auto-Program Mode: Auto-program mode supports programming of 128 bytes at a time. Status polling is used to confirm the end of auto-programming.

Auto-Erase Mode: Auto-erase mode supports automatic erasing of the entire flash memory. Status polling is used to confirm the end of auto-erasing.

Status Read Mode: Status polling is used for auto-programming and auto-erasing, and normal termination can be confirmed by reading the FO₃ signal. In status read mode, error information is output if an error occurs.

Table 6.10 Settings for Operating Modes In Writer Mode

| | Pin Names** | | | | | | | |
|----------------|-------------|----|----|----|-------------|-------------------|--|--|
| Mode | FWE | CE | ŌĒ | WE | FO0 to FO7 | FA0 to FA15 | | |
| Read | H/L | L | L | Н | Data output | Ain | | |
| Output disable | H/L | L | Н | Н | Hi-Z | X | | |
| Command write | H/L*3 | L | Н | L | Data input | Ain* ² | | |
| Chip disable*1 | H/L | Н | Х | Х | Hi-Z | X | | |

Legend:

L: Low level

H: High level

Undefined X٠

Hi-Z: High impedance

Notes: 1. Chip disable is not a standby state; internally, it is an operation state.

- 2. Ain indicates that there is also address input in auto-program mode.
- 3. For command writes in auto-program and auto-erase modes, input a high level to the FWE pin.
- 4. Pin names are those assigned in Writer mode. See figure 6.16 (a) for the H8/3857F, and figure 6.16 (b) for the H8/3854F.

Table 6.11 Writer Mode Commands

| Command Name | Number of Cycles | 1st Cycle | | | 2nd Cycle | | |
|-------------------|---------------------|-----------|---------|------|-----------|---------|------|
| | | Mode | Address | Data | Mode | Address | Data |
| Memory read mode | 1 + n | write | Х | H'00 | read | RA | Dout |
| Auto-program mode | 129 | write | Χ | H'40 | write | WA | Din |
| Auto-erase mode | 2 | write | Χ | H'20 | write | Х | H'20 |
| Status read mode | 3 | write | Х | H'71 | write | Χ | H'71 |

Legend:

RA: Read address

WA: Programming address

Dout: Read data

Din: Programming data

Notes: 1. In auto-program mode, 129 cycles are required for command writing by means of a simultaneous 128-byte write.

2. In memory read mode, the number of cycles depends on the number of address write cycles (n).

6.8.4 Memory Read Mode

- After the end of an auto-program, auto-erase, or status read operation, the command wait state
 is entered. To read memory contents, a transition must be made to memory read mode by
 means of a command write before the read is executed.
- 2. Command writes can be performed in memory read mode, just as in the command wait state.
- 3. Once memory read mode has been entered, consecutive reads can be performed.
- 4. After power-on, memory read mode is entered.
- 5. Do not make a setting outside the valid address range.

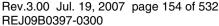




Table 6.12 AC Characteristics in Memory Read Mode (1)

(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

| Item | Symbol | Min | Max | Unit | Notes |
|---------------------|-------------------|-----|-----|------|-------|
| Command write cycle | t _{nxtc} | 20 | _ | μS | |
| CE hold time | t _{ceh} | 0 | _ | ns | |
| CE setup time | t _{ces} | 0 | _ | ns | |
| Data hold time | t _{dh} | 50 | _ | ns | |
| Data setup time | t _{ds} | 50 | _ | ns | |
| Write pulse width | t _{wep} | 70 | _ | ns | |
| WE rise time | t _r | _ | 30 | ns | |
| WE fall time | t, | | 30 | ns | |

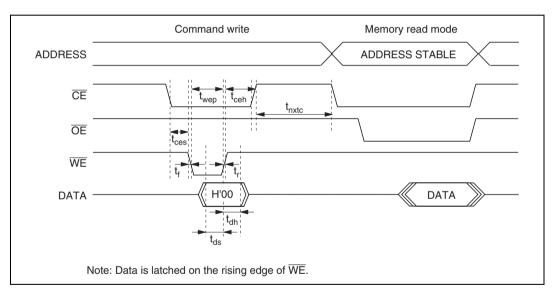


Figure 6.17 Timing Waveforms for Memory Read after Command Write

Table 6.13 AC Characteristics in Transition from Memory Read Mode to Another Mode

(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

| Item | Symbol | Min | Max | Unit | Notes |
|---------------------|-------------------|-----|-----|------|-------|
| Command write cycle | t _{nxtc} | 20 | _ | μS | |
| CE hold time | t _{ceh} | 0 | _ | ns | |
| CE setup time | t _{ces} | 0 | _ | ns | |
| Data hold time | t _{dh} | 50 | _ | ns | |
| Data setup time | t _{ds} | 50 | _ | ns | |
| Write pulse width | t _{wep} | 70 | _ | ns | |
| WE rise time | t _r | _ | 30 | ns | |
| WE fall time | t _f | _ | 30 | ns | |

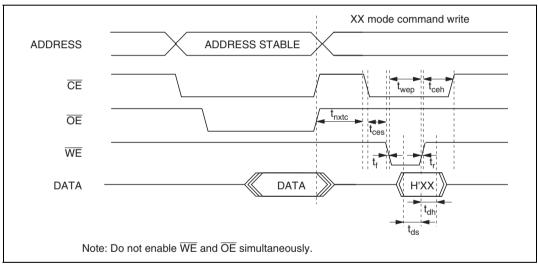


Figure 6.18 Timing Waveforms in Transition from Memory Read Mode to Another Mode

Table 6.14 AC Characteristics in Memory Read Mode (2)

(Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

| Item | Symbol | Min | Max | Unit | Notes |
|---------------------------|------------------|-----|-----|------|-------|
| Access time | t _{acc} | _ | 20 | μS | |
| CE output delay time | t _{ce} | _ | 150 | ns | |
| OE output delay time | t _{oe} | _ | 150 | ns | |
| Output disable delay time | t _{df} | _ | 100 | ns | |
| Data output hold time | t _{oh} | 5 | _ | ns | |

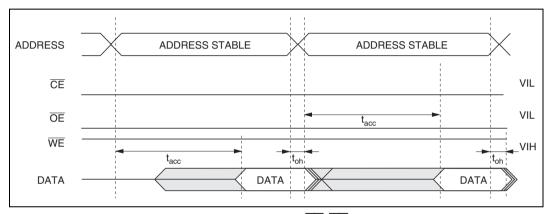


Figure 6.19 Timing Waveforms for \overline{CE} , \overline{OE} Enable State Read

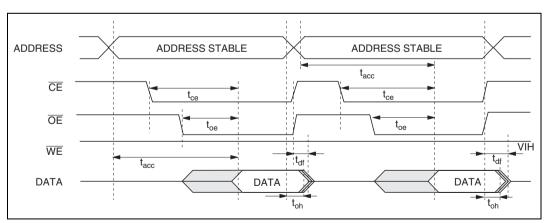


Figure 6.20 Timing Waveforms for CE, OE Clocked Read

6.8.5 Auto-Program Mode

AC Characteristics

Table 6.15 AC Characteristics in Auto-Program Mode

(Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

| Item | Symbol | Min | Max | Unit | Notes |
|----------------------------|--------------------|-----|------|------|-------|
| Command write cycle | t _{nxtc} | 20 | _ | μS | _ |
| CE hold time | t _{ceh} | 0 | _ | ns | |
| CE setup time | t _{ces} | 0 | _ | ns | |
| Data hold time | t _{dh} | 50 | _ | ns | |
| Data setup time | t _{ds} | 50 | _ | ns | |
| Write pulse width | t _{wep} | 70 | _ | ns | |
| Status polling start time | t _{wsts} | 1 | _ | ms | |
| Status polling access time | t_{spa} | _ | 150 | ns | |
| Address setup time | t _{as} | 0 | _ | ns | |
| Address hold time | t _{ah} | 60 | _ | ns | |
| Memory write time | t _{write} | 1 | 3000 | ms | |
| WE rise time | t _r | _ | 30 | ns | |
| WE fall time | t _f | _ | 30 | ns | |
| Write setup time | t _{pns} | 100 | _ | ns | |
| Write end setup time | t _{pnh} | 100 | _ | ns | |

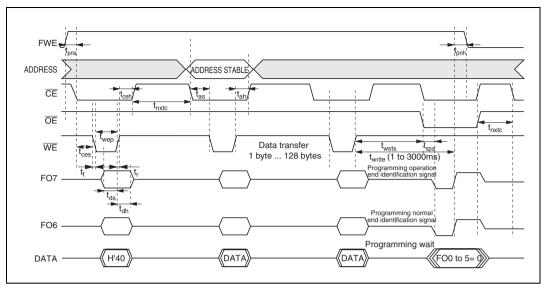


Figure 6.21 Auto-Program Mode Timing Waveforms

Notes on Use of Auto-Program Mode

- 1. In auto-program mode, 128 bytes are programmed simultaneously. This should be carried out by executing 128 consecutive byte transfers.
- 2. A 128-byte data transfer is necessary even when programming fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
- 3. The lower 8 bits of the transfer address must be H'00 or H'80. If a value other than a valid address is input, processing will switch to a memory write operation but a write error will be flagged.
- 4. Memory address transfer is performed in the second cycle (figure 6.20). Do not perform transfer after the second cycle.
- 5. Do not perform a command write during a programming operation.
- 6. Perform one auto-programming operation for a 128-byte block for each address. Characteristics cannot be guaranteed for two or more programming operations.
- 7. Confirm normal end of auto-programming by checking FO₆. Alternatively, status read mode can also be used for this purpose (the FO₇ status polling pin is used to identify the end of an auto-program operation).
- 8. Status polling FO_6 and FO_7 pin information is retained until the next command write. As long as the next command write has not been performed, reading is possible by enabling \overline{CE} and \overline{OE} .

6.8.6 Auto-Erase Mode

AC Characteristics

Table 6.16 AC Characteristics in Auto-Erase Mode

(Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

| Item | Symbol | Min | Max | Unit | Notes |
|----------------------------|--------------------|-----|-------|------|-------|
| Command write cycle | t _{nxtc} | 20 | _ | μS | |
| CE hold time | t _{ceh} | 0 | _ | ns | |
| CE setup time | t _{ces} | 0 | _ | ns | |
| Data hold time | t _{dh} | 50 | _ | ns | |
| Data setup time | t _{ds} | 50 | _ | ns | |
| Write pulse width | t _{wep} | 70 | _ | ns | |
| Status polling start time | t _{ests} | 1 | _ | ms | |
| Status polling access time | t _{spa} | _ | 150 | ns | |
| Memory erase time | t _{erase} | 100 | 40000 | ms | |
| WE rise time | t _r | _ | 30 | ns | |
| WE fall time | t _f | _ | 30 | ns | |
| Erase setup time | t _{ens} | 100 | _ | ns | |
| Erase end setup time | t _{enh} | 100 | _ | ns | |

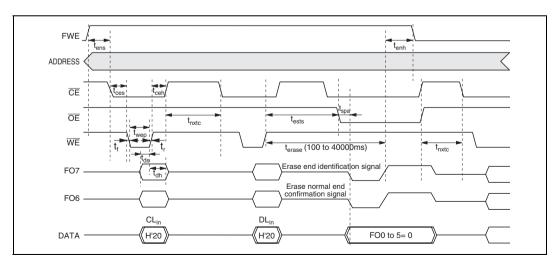


Figure 6.22 Auto-Erase Mode Timing Waveforms



Notes on Use of Auto-Erase Mode

- 1. Auto-erase mode supports only total memory erasing.
- 2. Do not perform a command write during auto-erasing.
- 3. Confirm normal end of auto-erasing by checking FO₆. Alternatively, status read mode can also be used for this purpose (the FO₇ status polling pin is used to identify the end of an auto-erase operation).
- 4. Status polling FO₆ and FO₇ pin information is retained until the next command write. As long as the next command write has not been performed, reading is possible by enabling $\overline{\text{CE}}$ and $\overline{\text{OE}}$.

6.8.7 Status Read Mode

- 1. Status read mode is used to identify what type of abnormal end has occurred. Use this mode when an abnormal end occurs in auto-program mode or auto-erase mode.
- 2. The return code is retained until a command write for other than status read mode is performed.

Table 6.17 AC Characteristics in Status Read Mode

(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

| Item | Symbol | Min | Max | Unit | Notes |
|----------------------|-------------------|-----|-----|------|-------|
| Command write cycle | t _{nxtc} | 20 | _ | μS | |
| CE hold time | t _{ceh} | 0 | _ | ns | |
| CE setup time | t _{ces} | 0 | _ | ns | |
| Data hold time | t _{dh} | 50 | _ | ns | |
| Data setup time | t _{ds} | 50 | _ | ns | |
| Write pulse width | t _{wep} | 70 | _ | ns | |
| OE output delay time | t _{oe} | _ | 150 | ns | |
| Disable delay time | t _{df} | _ | 100 | ns | |
| CE output delay time | t _{ce} | _ | 150 | ns | |
| WE rise time | t _r | _ | 30 | ns | |
| WE fall time | t _r | _ | 30 | ns | |

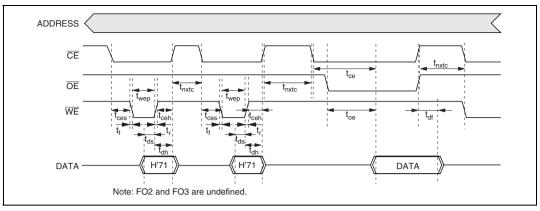


Figure 6.23 Status Read Mode Timing Waveforms

Table 6.18 Status Read Mode Return Codes

| Pin Name | F07 | FO6 | FO5 | FO4 | FO3 | FO2 | FO1 | FO0 |
|---------------|-------------------------------------|-------------------------------------|---|--------------------------------|-----|-----|--------------------------------------|---|
| Attribute | Normal end identification | Command error | Programming error | Erase error | _ | _ | Programming or erase count exceeded | Valid address error |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Indications | Normal end: 0 Abnormal end: 1 | Command error: 1 Otherwise: 0 | Programming error: 1 Otherwise: 0 | Erase error: 1 Otherwise: 0 | _ | _ | Count exceeded: 1 Otherwise: 0 | Valid address error: 1 Otherwise: 0 |

Note: FO₂ and FO₃ are undefined.

6.8.8 Status Polling

- 1. The FO_7 status polling flag indicates the operating status in auto-program or auto-erase mode.
- 2. The FO₆ status polling flag indicates a normal or abnormal end in auto-program or auto-erase mode.

Table 6.19 Status Polling Output Truth Table

| Pin Names | Internal Operation in Progress | Abnormal End | Normal Status Indication | Normal End |
|------------|--------------------------------|--------------|-----------------------------|------------|
| FO7 | 0 | 1 | 0 | 1 |
| FO6 | 0 | 0 | 1 | 1 |
| FO0 to FO5 | 0 | 0 | 0 | 0 |



6.8.9 Writer Mode Transition Time

Commands cannot be accepted during the oscillation stabilization period or the Writer mode setup period. A transition is made to memory read mode after the Writer mode setup time.

Table 6.20 Stipulated Transition Times to Command Wait State

| Item | Symbol | Min | Max | Unit | Notes |
|--|-------------------|-----|-----|------|-------|
| Standby release (oscillation stabilization time) | t _{osc1} | 40 | _ | ms | _ |
| Writer mode setup time | t _{bmv} | 10 | _ | ms | |
| V _{cc} hold time | t _{dwn} | 0 | _ | ms | |

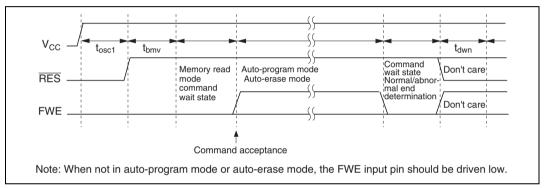


Figure 6.24 Oscillation Stabilization Time, Writer Mode Setup, and Power-Down Sequence

6.8.10 Notes on Memory Programming

- 1. When programming addresses which have previously been programmed, carry out autoerasing before auto-programming.
- 2. When performing programming using a PROM programmer on a chip that has been programmed/erased in an on-board programming mode, auto-erasing is recommended before carrying out auto-programming.
- Notes: 1. The memory is initially in the erased state when the device is shipped by Renesas. For other chips for which the erasure history is unknown, it is recommended that autoerasing be executed to check and supplement the initialization (erase) level.
 - 2. Auto-programming should be performed once only on a particular address block.

6.9 Flash Memory Programming and Erasing Precautions

Precautions concerning the use of on-board programming mode and Writer mode are summarized below.

1. Use the specified voltages and timing for programming and erasing.

Applying a voltage in excess of the rating can permanently damage the device. Use a PROM programmer that supports the Renesas Technology microcomputer device type with 64-kbyte on-chip flash memory.

Do not select the HN28F101 setting for the PROM programmer, and only use the specified socket adapter. Incorrect use may damage the device.

2. Powering on and off

Do not apply a high level to the FWE pin until V_{cc} has stabilized. Also, drive the FWE pin low before turning off V_{cc} .

When applying or disconnecting V_{cc} , fix the FWE pin low and place the flash memory in the hardware protection state.

The power-on and power-off timing requirements should also be satisfied in the event of a power failure and subsequent recovery. Failure to do so may result in overprogramming or overerasing due to MCU runaway, and loss of normal memory cell operation.

3. FWE application/disconnection

FWE application should be carried out when MCU operation is in a stable condition. If MCU operation is not stable, fix the FWE pin low and set the protection state.

The following points must be observed concerning FWE application and disconnection to prevent unintentional programming or erasing of flash memory:

- a. Apply FWE when the V_{CC} voltage has stabilized within its rated voltage range.
- b. Apply FWE when oscillation has stabilized (after the elapse of the oscillation stabilization time).
- c. In boot mode, apply and disconnect FWE during a reset.
- d. In user program mode, FWE can be switched between high and low level regardless of the reset state. FWE input can also be switched during program execution in flash memory.
- e. Do not apply FWE if program runaway has occurred.
- f. Disconnect FWE only when the SWE, ESU, PSU, EV, PV, P, and E bits in FLMCR1 and FLMCR2 are cleared.

Make sure that the SWE, ESU, PSU, EV, PV, P, and E bits are not set by mistake when applying or disconnecting FWE.



- 4. Do not apply a constant high level to the FWE pin
 - To prevent erroneous programming or erasing due to program runaway, etc., apply a high level to the FWE pin only when programming or erasing flash memory. A system configuration in which a high level is constantly applied to the FWE pin should be avoided. Also, while a high level is applied to the FWE pin, the watchdog timer should be activated to prevent overprogramming or overerasing due to program runaway, etc.
- 5. Use the recommended algorithm when programming and erasing flash memory The recommended algorithm enables programming and erasing to be carried out without subjecting the device to voltage stress or sacrificing program data reliability. When setting the P or E bit in FLMCR1, the watchdog timer should be set beforehand as a precaution against program runaway, etc.
- 6. Do not set or clear the SWE bit during program execution in flash memory Clear the SWE bit before executing a program or reading data in flash memory. When the SWE bit is set, data in flash memory can be rewritten, but flash memory should only be accessed for verify operations (verification during programming/erasing).
- 7. Do not use interrupts while flash memory is being programmed or erased All interrupt requests should be disabled during FWE application to give priority to program/erase operations.
- 8. Do not perform additional programming. Erase the memory before reprogramming. In on-board programming, perform only one programming operation on a 32-byte programming unit block. In Writer mode, perform only one programming operation on a 128byte programming unit block. Programming should be carried out with the entire programming unit block erased.
- 9. Before programming, check that the chip is correctly mounted in the PROM programmer. Overcurrent damage to the device can result if the index marks on the PROM programmer socket, socket adapter, and chip are not correctly aligned.
- 10. Do not touch the socket adapter or chip during programming. Touching either of these can cause contact faults and write errors.

6.10 Notes when Converting the F-ZTAT Application Software to the Mask-ROM Versions

Please note the following when converting the F-ZTAT application software to the mask-ROM versions.

The values read from the internal registers for the flash ROM or the mask-ROM version and F-ZTAT version differ as follows.

Status

| Register | Bit | F-ZTAT Version | Mask-ROM Version |
|----------|-----|--|---|
| FLMCR1 | FWE | 0: Application software running 1: Programming | 0: Application software running 1: (Not read) |

Note: This difference applies to all the F-ZTAT versions and all the mask-ROM versions that have different ROM size.



Section 7 RAM

7.1 Overview

The H8/3857 Group and the H8/3854 flash memory version have 2 kbytes of high-speed on-chip static RAM, and the H8/3854 Group mask ROM version has 1 kbyte. The RAM is connected to the CPU by a 16-bit data bus, allowing high-speed 2-state access for both byte data and word data.

Note that the H8/3854 flash memory and mask ROM versions have different ROM and RAM sizes

7.1.1 **Block Diagram**

Figure 7.1 shows a block diagram of the on-chip RAM.

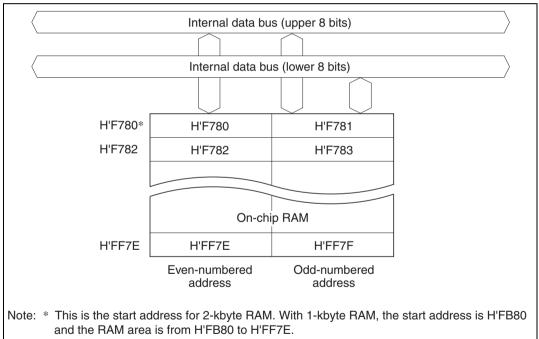


Figure 7.1 RAM Block Diagram

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Section 8 I/O Ports

8.1 Overview

The H8/3857 Group is provided with four 8-bit I/O ports, one 3-bit I/O port, one 8-bit input-only port, and one 1-bit input-only port. The H8/3854 Group is provided with two 8-bit I/O ports, one 3-bit I/O port, one 5-bit I/O port, one 4-bit input-only port, and one 1-bit input-only port. In addition, both group have an I/O port capable of interfacing with the on-chip LCD controller.

H8/3857 Group port functions are listed in table 8.1 (a), and H8/3854 Group port functions in table 8.1 (b).

Each port has a port control register (PCR) that controls input and output, and a port data register (PDR) for storing output data. Input or output can be assigned to individual bits. See section 2.9.2, Notes on Bit Manipulation, for information on executing bit-manipulation instructions to write data in PCR or PDR.

Block diagrams of each port are given in appendix C, I/O Port Block Diagrams.

Table 8.1 (a) H8/3857 Group Port Functions

| Dout | Description | Dina | Other Functions | Function Switching |
|---------|---------------------------------------|--|--|-----------------------|
| Port | Description | Pins | | Register |
| Port 1 | • 8-bit I/O port | P1 ₇ to P1 ₅ / IRQ ₃ to IRQ ₁ / | External interrupts 3 to 1 | PMR1 |
| | • Input pull-up MOS | TMIF, TMIC, | Timer event input TMIF, TMIC, TMIB | TCRF, TMC, |
| | option | TMIB | 2 | TMB |
| | | P1 ₄ /PWM | 14-bit PWM output | PMR1 |
| | | P1 ₃ | None | |
| | | P1 ₂ , P1 ₁ / TMOFH, TMOFL | Timer F output compare | PMR1 |
| | | P1 ₀ /TMOW | Timer A clock output | PMR1 |
| Port 2 | • 8-bit I/O port | P2, to P2, | None | |
| | Open drain output | P2 ₁ /UD | Timer C count-up/down selection | PMR2 |
| | option | | | |
| | High-current port | P2√IRQ₄/ ADTRG | External interrupt 4 and A/D | PMR2 |
| | | ADIRG | converter external trigger | AMR |
| Port 3 | 8-bit I/O port | P3, to P3, | None | |
| | Input pull-up MOS | P3 ₂ /SO ₁ | SCI1 data output (SO ₁), data input | PMR3 |
| | option | P3,/SI, | (SI ₁), clock input/output (SCK ₁) | |
| | High-current port | P3 ₀ /SCK ₁ | | |
| Port 4 | • 1-bit input-only port | | External interrupt 0 | PMR2 |
| | • 3-bit I/O port | P4 ₂ /TXD | SCI3 data output (TXD), data input | SCR3 |
| | | P4,/RXD | (RXD), clock input/output (SCK ₃) | SMR |
| | | P4 ₀ /SCK ₃ | | |
| Port 5 | • 8-bit I/O port | P5, to P5,/ | Wakeup input (\overline{WKP}_7 to \overline{WKP}_0) | PMR5 |
| | Input pull-up MOS | $\overline{\text{WKP}}_7$ to $\overline{\text{WKP}}_0$ | | |
| | option | | | |
| Port 9* | 8-bit I/O port | P9 ₇ to P9 ₀ | None | |
| Port A* | • 4-bit I/O port | PA ₃ to PA ₀ | None | |
| Port B | 8-bit input port | PB ₇ to PB ₀ / AN ₇ to AN ₀ | A/D converter analog input | AMR |

Note: * This I/O port is used to interface to the LCD controller.



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Table 8.1 (b) H8/3854 Group Port Functions

| Port | Description | Pins | Other Functions | Function Switching Register |
|---------|--|--|---|-----------------------------------|
| Port 1 | • 5-bit I/O port | P1 ₇ , P1 ₅ / | External interrupts 3, 1 | PMR1 |
| | Input pull-up MOS option | ĪRQ₃, ĪRQ₁/ TMIF, TMIB | Timer event input TMIF, TMIB | TCRF, TMB |
| | · | P1 ₂ , P1 ₁ / TMOFH, TMOFL | Timer F output compare | PMR1 |
| | | P1 _o /TMOW | Timer A clock output | PMR1 |
| Port 2 | • 8-bit I/O port | P2, to P2, | None | |
| | Open drain output | P2 ₀ /IRQ ₄ / | External interrupt 4 and A/D | PMR2 |
| | option | ADTRG | converter external trigger | AMR |
| | High-current port | | | |
| Port 4 | • 1-bit input-only port | P4 ₃ /IRQ ₀ | External interrupt 0 | PMR2 |
| | • 3-bit I/O port | P4 ₂ /TXD | SCI3 data output (TXD), data input | SCR3 |
| | | P4 ₁ /RXD | (RXD), clock input/output (SCK ₃) | SMR |
| | | P4 ₀ /SCK ₃ | | |
| Port 5 | • 8-bit I/O port | P5, to P5 ₀ / | Wakeup input (WKP, to WKP) | PMR5 |
| | • Input pull-up MOS | $\overline{WKP}_{\scriptscriptstyle 7}$ to $\overline{WKP}_{\scriptscriptstyle 0}$ | | |
| | option | | | |
| Port 9* | • 8-bit I/O port | P9 ₇ to P9 ₀ | None | |
| Port A* | • 4-bit I/O port | PA ₃ to PA ₀ | None | |
| Port B | 4-bit input port | PB ₇ to PB ₄ / AN ₇ to AN ₄ | A/D converter analog input | AMR |

Note: * This I/O port is used to interface to the LCD controller.

8.2 Port 1

Some port 1 functions differ between the H8/3857 Group and the H8/3854 Group.

The P1₆/IRQ₂/TMIC, P1₄/PWM, and P1₃ pins are provided only in the H8/3857 Group, and not in the H8/3854 Group.

8.2.1 Overview

Port 1 is an 8-bit I/O port. The H8/3857 Group port 1 pin configuration is shown in figure 8.1 (a), and the H8/3854 Group port 1 pin configuration in figure 8.1 (b).

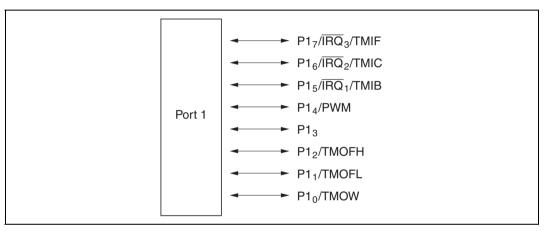


Figure 8.1 (a) H8/3857 Group Port 1 Pin Configuration

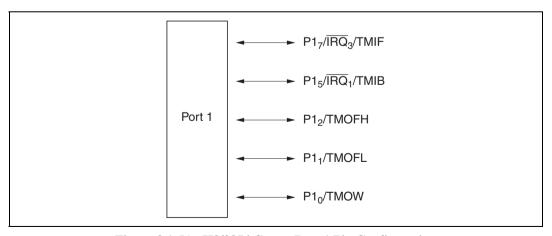


Figure 8.1 (b) H8/3854 Group Port 1 Pin Configuration

Register Configuration and Description 8.2.2

Table 8.2 shows the port 1 register configuration.

Table 8.2 Port 1 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|---------------------------------|-------|-----|---------------|---------|
| Port data register 1 | PDR1 | R/W | H'00 | H'FFD4 |
| Port control register 1 | PCR1 | W | H'00 | H'FFE4 |
| Port pull-up control register 1 | PUCR1 | R/W | H'00 | H'FFE0 |
| Port mode register 1 | PMR1 | R/W | H'00 | H'FFC8 |

Port Data Register 1 (PDR1)

PDR1 is an 8-bit register that stores data for pins P1, through P1,. If port 1 is read while PCR1 bits are set to 1, the values stored in PDR1 are read, regardless of the actual pin states. If port 1 is read while PCR1 bits are cleared to 0, the pin states are read.

Upon reset, PDR1 is initialized to H'00 (H8/3857 Group) or H'58 (H8/3854 Group).

H8/3857 Group

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----------------|-----------------|-----------------|-----------------|-----------------|-----|-----------------|
| | P1, | P1 ₆ | P1 ₅ | P1 ₄ | P1 ₃ | P1 ₂ | P1, | P1 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| H8/3854 Group | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | P1, | _ | P1 ₅ | _ | _ | P1 ₂ | P1, | P1 ₀ |
| Initial value | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | R/W | _ | R/W | _ | _ | R/W | R/W | R/W |

In the H8/3854 Group, bits 6, 4, and 3 are reserved, and must always be set to 1.

Port Control Register 1 (PCR1)

PCR1 is an 8-bit register for controlling whether each of the port 1 pins P1₇ to P1₀ functions as an input pin or output pin. Setting a PCR1 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR1 and in PDR1 are valid only when the corresponding pin is designated in PMR1 as a general I/O pin.

Upon reset, PCR1 is initialized to H'00.

PCR1 is a write-only register. All bits are read as 1.

W

H8/3857 Group

Read/Write

Bit

| | PCR1, | PCR1 ₆ | PCR1₅ | PCR1₄ | PCR1 ₃ | PCR1 ₂ | PCR1, | PCR1₀ | l |
|---------------|-------------------|-------------------|-------------------|-------|-------------------|-------------------|-------------------|-------------------|---|
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | W | W | W | W | W | W | W | W | |
| | | | | | | | | | |
| H8/3854 Group | | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | PCR1 ₇ | _ | PCR1 ₅ | _ | _ | PCR1 ₂ | PCR1 ₁ | PCR1 _o | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |

W

W

W

In the H8/3854 Group, bits 6, 4, and 3 are reserved, and must always be set to 0.

W



Port Pull-Up Control Register 1 (PUCR1)

PUCR1 controls whether the MOS pull-up of each port 1 pin is on or off. When a PCR1 bit is cleared to 0, setting the corresponding PUCR1 bit to 1 turns on the MOS pull-up for the corresponding pin, while clearing the bit to 0 turns off the MOS pull-up.

Upon reset, PUCR1 is initialized to H'00.

| H8/3857 | Group |
|---------|-------|
|---------|-------|

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------------------|--------------------|--------------------|--------------------|--------------------|--------|--------------------|
| | PUCR1, | PUCR1 ₆ | PUCR1 ₅ | PUCR1 ₄ | PUCR1 ₃ | PUCR1 ₂ | PUCR1, | PUCR1 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| H8/3854 Group | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PUCR1, | | PUCR1 ₅ | _ | | PUCR1 ₂ | PUCR1, | PUCR1 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | _ | R/W | _ | _ | R/W | R/W | R/W |

In the H8/3854 Group, bits 6, 4, and 3 are reserved, and must always be set to 0.

Port Mode Register 1 (PMR1)

PMR1 is an 8-bit read/write register, controlling the selection of pin functions for port 1 pins.

Upon reset, PMR1 is initialized to H'00.

H8/3857 Group

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|-----|---|-------|-------|------|
| | IRQ3 | IRQ2 | IRQ1 | PWM | _ | TMOFH | TMOFL | TMOW |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | _ | R/W | R/W | R/W |
| | | | | | | | | |
| H8/3854 Group | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IRQ3 | _ | IRQ1 | _ | _ | TMOFH | TMOFL | TMOW |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | _ | R/W | _ | _ | R/W | R/W | R/W |

In the H8/3854 Group, bits 6, 4, and 3 are reserved, and must always be set to 0.

Bit 7—P1/IRQ /TMIF Pin Function Switch (IRQ3): This bit selects whether pin $P1_7/\overline{IRQ}_3/TMIF$ is used as $P1_7$ or as $\overline{IRQ}_3/TMIF$.

| Bit 7: IRQ3 | Description | |
|-------------|---|-----------------|
| 0 | Functions as P1, I/O pin | (initial value) |
| 1 | Functions as IRQ ₃ /TMIF input pin | |

Rising or falling edge sensing can be designated for IRQ./TMIF. Note:

> For details on TMIF pin settings, see Timer Control Register F (TCRF) in section 9.5.2, Register Descriptions.

Bit 6—P1/IRQ/TMIC Pin Function Switch (IRQ2): This bit selects whether pin $P1_6/\overline{IRQ}_9/TMIC$ is used as $P1_6$ or as $\overline{IRQ}_9/TMIC$.

| Bit 6: IRQ2 | Description | |
|-------------|--------------------------------------|-----------------|
| 0 | Functions as P1 ₆ I/O pin | (initial value) |
| 1 | Functions as IRQ /TMIC input pin | |

Rising or falling edge sensing can be designated for IRQ./TMIC.

For details on TMIC pin settings, see Timer Mode Register C (TMC) in section 9.4.2, Register Descriptions.

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In the H8/3854 Group, bit 6 is reserved, and must always be cleared to 0.

Bit 5—P1/IRQ/TMIB Pin Function Switch (IRQ1): This bit selects whether pin $P1_s/\overline{IRQ}_s/TMIB$ is used as $P1_s$ or as $\overline{IRQ}_s/TMIB$.

| Bit 5: IRQ1 | Description | |
|-------------|--------------------------------------|-----------------|
| 0 | Functions as P1 ₅ I/O pin | (initial value) |
| 1 | Functions as IRQ,/TMIB input pin | |

Rising or falling edge sensing can be designated for IRQ./TMIB.

For details on TMIB pin settings, see Timer Mode Register B (TMB) in section 9.3.2, Register Descriptions.

Bit 4—P1/PWM Pin Function Switch (PWM): This bit selects whether pin P1/PWM is used as P1, or as PWM.

| Bit 4: PWM | Description | |
|------------|-----------------------------|-----------------|
| 0 | Functions as P1, I/O pin | (initial value) |
| 1 | Functions as PWM output pin | _ |

In the H8/3854 Group, bit 4 is reserved, and must always be cleared to 0.

Bit 3—Reserved Bit: Bit 3 is reserved; it should always be cleared to 0.

Bit 2—P1,/TMOFH Pin Function Switch (TMOFH): This bit selects whether pin P1,/TMOFH is used as P1, or as TMOFH.

| Bit 2: TMOFH | Description | |
|--------------|--------------------------------------|-----------------|
| 0 | Functions as P1 ₂ I/O pin | (initial value) |
| 1 | Functions as TMOFH output pin | |

Bit 1—P1,/TMOFL Pin Function Switch (TMOFL): This bit selects whether pin P1,/TMOFL is used as P1, or as TMOFL.

| Bit 1: TMOFL | Description | |
|--------------|-------------------------------|-----------------|
| 0 | Functions as P1, I/O pin | (initial value) |
| 1 | Functions as TMOFL output pin | |

Bit 0—P1,/TMOW Pin Function Switch (TMOW): This bit selects whether pin P1,/TMOW is used as P1_o or as TMOW.

| Bit 0: TMOW | Description | |
|-------------|--------------------------------------|-----------------|
| 0 | Functions as P1 _o I/O pin | (initial value) |
| 1 | Functions as TMOW output pin | |

8.2.3 **Pin Functions**

H8/3857 Group port 1 pin functions are shown in figure 8.3 (a), and H8/3854 Group port 1 pin functions in figure 8.3 (b).

Table 8.3 (a) H8/3857 Group Port 1 Pin Functions

| Pin | Pin Functions and | Selection Method |
|------|-----------------------|------------------|
| FIII | FIII FUIICIIOIIS allu | Selection Method |

P1,/IRQ,/TMIF

The pin function depends on bit IRQ3 in PMR1, bits CKSL2 to CKSL0 in TCRF, and bit PCR1, in PCR1.

| IRQ3 | (|) | 1 | | |
|-------------------|---------------|----------------|----------------|------------------------|--|
| PCR1 ₇ | 0 | 1 | * | | |
| CKSL2 to CKSL0 | ** | ** | Not 0** | 0** | |
| Pin function | P1, input pin | P1, output pin | ĪRQ₃ input pin | ĪRQ₃/TMIF input pin | |

Note: When using as TMIF input pin, clear bit IEN3 in IENR1 to 0, disabling IRQ, interrupts.

P1 /IRQ /TMIC

The pin function depends on bit IRQ2 in PMR1, bits TMC2 to TMC0 in TMC, and bit PCR1, in PCR1.

| IRQ2 | (|) | 1 | | |
|-------------------|---------------------------|----------------------------|----------------------------|------------------------|--|
| PCR1 ₆ | 0 | 1 | * | | |
| TMC2 to TMC0 | ** | ** | Not 111 | 111 | |
| Pin function | P1 ₆ input pin | P1 ₆ output pin | IRQ ₂ input pin | ĪRQ₂/TMIC input pin | |

When using as TMIC input pin, clear bit IEN2 in IENR1 to 0, disabling IRQ, interrupts.



| Pin | Pin Functions an | d Selection Me | thod | | | | | |
|---|--|---------------------------|----------------------------|------------------------------|------------------------|--|--|--|
| P1 ₅ /IRQ ₁ /TMIB | The pin function depends on bit IRQ1 in PMR1, bits TMB2 to TMB0 in TMB, and bit PCR1, in PCR1. | | | | | | | |
| | IRQ1 | (| 0 | 1 | | | | |
| | PCR1₅ | 0 | 1 | * | : | | | |
| | TMB2 to TMB0 | *: | ** | Not 111 | 111 | | | |
| | Pin function | P1 ₅ input pin | P1 ₅ output pin | ĪRQ₁ input pin | ĪRQ₁/TMIB input pin | | | |
| | Note: When usin IRQ1 intern | - | pin, clear bit IE | N1 in IENR1 to (|), disabling | | | |
| P1₄/PWM | The pin function depends on bit PWM in PMR1 and bit PCR1, in PCR1. | | | | | | | |
| | PWM | | 0 | 1 | | | | |
| | PCR1₄ | 0 | 1 | * | | | | |
| | Pin function | P1 ₄ input pin | P1 ₄ output pin | PWM output pin | | | | |
| P1 ₃ | The pin function depends on bit PCR1 ₃ in PCR1. | | | | | | | |
| - | PCR1 ₃ | (| 0 | 1 | | | | |
| | Pin function | P1 ₃ in | put pin | P1 ₃ output pin | | | | |
| P1 ₂ /TMOFH | The pin function depends on bit TMOFH in PMR1 and bit PCR1 ₂ in PCR1. | | | | | | | |
| | TMOFH | (| 0 | 1 | | | | |
| | PCR1 ₂ | 0 | 1 | * | | | | |
| | Pin function | P1 ₂ input pin | P1 ₂ output pin | TMOFH o | utput pin | | | |
| P1,/TMOFL | The pin function depends on bit TMOFL in PMR1 and bit PCR1, in PCR1. | | | | | | | |
| | TMOFL | (| 0 | 1 | | | | |
| | PCR1, | 0 | 1 | * | : | | | |
| | Pin function | P1, input pin | P1, output pin | TMOFL o | utput pin | | | |
| P1 ₀ /TMOW | The pin function de | epends on bit T | MOW in PMR1 a | and bit PCR1 _o in | PCR1. | | | |
| | TMOW | (|) | 1 | | | | |
| | PCR1₀ | 0 | 1 | * | | | | |
| | Pin function | P1₀ input pin | P1 ₀ output pin | TMOW o | utput pin | | | |

Legend: * Don't care

| Table 8.3 (b) | H8/3854 Grou | p Port 1 Pin | Functions |
|----------------------|--------------|--------------|------------------|
|----------------------|--------------|--------------|------------------|

| Table 8.3 (b) | H8/3854 Group Port 1 Pin Functions | | | | | | | | |
|---|---|---------------------------|----------------------------|------------------|------------------------|--|--|--|--|
| Pin | Pin Functions and Selection Method | | | | | | | | |
| P1 _/ IRQ ₃ /TMIF | The pin function depends on bit IRQ3 in PMR1, bits CKSL2 to CKSL0 in TCRF, and bit $PCR1_7$ in $PCR1$. | | | | | | | | |
| | IRQ3 | (|) | 1 | | | | | |
| | PCR1 ₇ 0 1 * | | | | | | | | |
| | CKSL2 to CKSL0 | *: | ** | Not 0** | 0** | | | | |
| | Pin function | P1, input pin | P1, output pin | ĪRQ₃ input pin | ĪRQ₃/TMIF input pin | | | | |
| | Note: When using IRQ ₃ interru | | pin, clear bit IE | N3 in IENR1 to | 0, disabling | | | | |
| P1 ₅ /IRQ ₁ /TMIB | The pin function de bit PCR15 in PCR1 | | RQ1 in PMR1, bi | ts TMB2 to TME | 30 in TMB, and | | | | |
| | IRQ1 | (|) | 1 | | | | | |
| | PCR1₅ | 0 1 | | * | | | | | |
| | TMB2 to TMB0 | *** | | Not 111 | 111 | | | | |
| | Pin function | P1 _s input pin | P1 _s output pin | ĪRQ₁ input pin | IRQ₁/TMIB input pin | | | | |
| | Note: When using IRQ1 interr | - | pin, clear bit IE | N1 in IENR1 to | 0, disabling | | | | |
| P1 ₂ /TMOFH | The pin function de | epends on bit T | MOFH in PMR1 | and bit PCR12 i | n PCR1. | | | | |
| | TMOFH | (|) | 1 | | | | | |
| | PCR1 ₂ | 0 | 1 | * | k | | | | |
| | Pin function | P1 ₂ input pin | P1 ₂ output pin | TMOFH | output pin | | | | |
| P1₁/TMOFL | The pin function depends on bit TMOFL in PMR1 and bit PCR1, in PCR1. | | | | | | | | |
| | TMOFL | (|) | 1 | | | | | |
| | PCR1, | 0 | 1 | * | * | | | | |
| | Pin function | P1₁ input pin | P1, output pin | TMOFL output pin | | | | | |
| P1 ₀ /TMOW | The pin function de | epends on bit T | MOW in PMR1 a | and bit PCR1₀ in | PCR1. | | | | |
| | TMOW | (|) | - | | | | | |
| | PCR1 _o | 0 | 1 | k | k | | | | |
| | 1 | l | 1 | | | | | | |

Legend: * Don't care

P1_o output pin

TMOW output pin

P1_o input pin

Pin function

8.2.4 Pin States

H8/3857 Group port 1 pin states in each operating mode are shown in table 8.4 (a), and H8/3854 Group port 1 pin states in each operating mode in table 8.4 (b).

Table 8.4 (a) H8/3857 Group Port 1 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|---|-----------|---------|----------|------------|----------|------------|------------|
| P1 _/ /ĪRQ ₃ /TMIF | High- | Retains | Retains | High- | Retains | Functional | Functional |
| P1 ₆ /IRQ ₂ /TMIC | impedance | • | previous | impedance* | previous | | |
| P1 ₅ /IRQ ₁ /TMIB | | state | state | | state | | |
| P1₄/PWM | | | | | | | |
| P1 ₃ | | | | | | | |
| P1 ₂ /TMOFH | | | | | | | |
| P1₁/TMOFL | | | | | | | |
| P1 ₀ /TMOW | | | | | | | |

Note: * A high-level signal is output when the MOS pull-up is in the on state.

Table 8.4 (b) H8/3854 Group Port 1 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|------|--------------------|------------------------------|------------------------------|---------------------|-------|------------|------------|
| 73 | High- impedance | Retains previous state | Retains previous state | High- impedance* | | Functional | Functional |

Note: * A high-level signal is output when the MOS pull-up is in the on state.

8.2.5 MOS Input Pull-Up

Port 1 has a built-in MOS input pull-up function that can be controlled by software. When a PCR1 bit is cleared to 0, setting the corresponding PUCR1 bit to 1 turns on the MOS input pull-up for that pin. The MOS input pull-up function is in the off state after a reset.

| PCR1 _n | (|) | 1 |
|--------------------|-----|----|-----|
| PUCR1 _n | 0 | 1 | * |
| MOS input pull-up | Off | On | Off |

Legend: * Don't care

Notes: H8/3857 Group: n = 7 to 0

H8/3854 Group: n = 7, 5, 2 to 0

8.3 Port 2

Some port 2 functions differ between the H8/3857 Group and the H8/3854 Group.

The UD function multiplexed with the P2₁ pin is provided only in the H8/3857 Group, and not in the H8/3854 Group.

POF1 in PMR2 is also a function of the H8/3857 Group only.

8.3.1 Overview

Port 2 is an 8-bit I/O port. The H8/3857 Group port 2 pin configuration is shown in figure 8.2 (a), and the H8/3854 Group port 2 pin configuration in figure 8.2 (b).

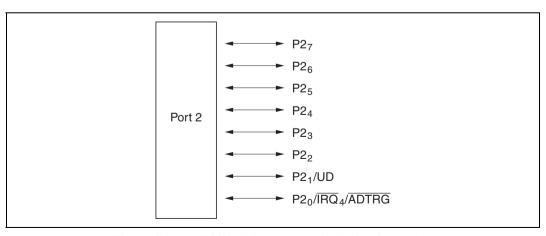


Figure 8.2 (a) H8/3857 Group Port 2 Pin Configuration

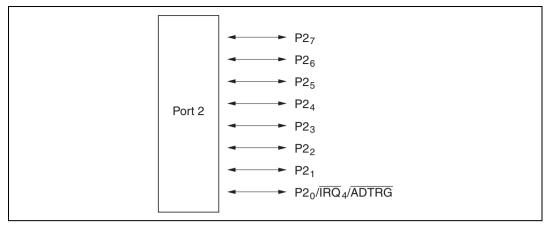


Figure 8.2 (b) H8/3854 Group Port 2 Pin Configuration

8.3.2 Register Configuration and Description

Table 8.5 shows the port 2 register configuration.

Table 8.5 Port 2 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|-------------------------|-------|-----|---------------|---------|
| Port data register 2 | PDR2 | R/W | H'00 | H'FFD5 |
| Port control register 2 | PCR2 | W | H'00 | H'FFE5 |
| Port mode register 2 | PMR2 | R/W | H'C0 | H'FFC9 |
| Port mode register 4 | PMR4 | R/W | H'00 | H'FFCB |

Port Data Register 2 (PDR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----------------|-----------------|-----------------|-----------------|-----------------|-----|-----------------|
| | P2, | P2 ₆ | P2 ₅ | P2 ₄ | P2 ₃ | P2 ₂ | P2, | P2 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PDR2 is an 8-bit register that stores data for pins $P2_{7}$ through $P2_{0}$. If port 2 is read while PCR2 bits are set to 1, the values stored in PDR2 are read, regardless of the actual pin states. If port 2 is read while PCR2 bits are cleared to 0, the pin states are read.

Upon reset, PDR2 is initialized to H'00.

Port Control Register 2 (PCR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------------------|-------------------|-------|-------------------|-------------------|-------------------|-------------------|-------|
| | PCR2 ₇ | PCR2 ₆ | PCR2₅ | PCR2 ₄ | PCR2 ₃ | PCR2 ₂ | PCR2 ₁ | PCR2₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

PCR2 is an 8-bit register for controlling whether each of the port 2 pins $P2_{7}$ to $P2_{0}$ functions as an input pin or output pin. Setting a PCR2 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR2 and in PDR2 are valid only when the corresponding pin is designated in PMR2 as a general I/O pin.

Upon reset, PCR2 is initialized to H'00.

PCR2 is a write-only register. All bits are read as 1.

Port Mode Register 2 (PMR2)

PMR2 is an 8-bit read/write register, controlling the selection of pin functions for pins P2₀, P2₁*, and P4₃, controlling the PMOS on/off option for pins P3₂/SO₁*.

Upon reset, PMR2 is initialized to H'C0.

Note: * P2₁ pin function switching and the P3₂/SO₁ pin are H8/3857 Group functions only, and are not provided in the H8/3854 Group.

H8/3857 Group

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|-----|-----|------|------|-----|------|
| | _ | _ | _ | _ | IRQ0 | POF1 | UD | IRQ4 |
| Initial value | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| H8/3854 Group | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | _ | IRQ0 | | _ | IRQ4 |
| Initial value | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |

R/W

R/W

In the H8/3854 Group, bits 2 and 1 are reserved, and must always be cleared to 0.

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Read/Write



Bits 7 and 6—Reserved Bits: Bits 7 and 6 are reserved; they are always read as 1, and cannot be modified.

Bits 5 and 4—Reserved Bits: Bits 5 and 4 are reserved; they should always be cleared to 0.

Bit 3—P4₃ \sqrt{IRQ}_0 **Pin Function Switch (IRQ0):** This bit selects whether pin P4₃ \sqrt{IRQ}_0 is used as P4₃ or as \overline{IRQ}_0 .

| Bit 3: IRQ0 | Description | |
|-------------|--|-----------------|
| 0 | Functions as P4 ₃ input pin | (initial value) |
| 1 | Functions as IRQ₀ input pin | |

Note: Rising or falling edge sensing can be selected for the \overline{IRQ}_0 pin.

Bit 2—P3₂/SO₁ Pin PMOS Control (POF1): This bit controls the on/off state of the PMOS transistor in the P3₂/SO₁ pin output buffer.

| Bit 2: POF1 | Description | |
|-------------|------------------------|-----------------|
| 0 | CMOS output | (initial value) |
| 1 | NMOS open-drain output | |

In the H8/3854 Group, bit 2 is reserved, and must always be cleared to 0.

Bit 1—P2₁/UD Pin Function Switch (UD): This bit selects whether pin P2₁/UD is used as P2₁ or as UD.

| Bit 1: UD | Description | |
|-----------|---------------------------|-----------------|
| 0 | Functions as P2, I/O pin | (initial value) |
| 1 | Functions as UD input pin | _ |

In the H8/3854 Group, bit 1 is reserved, and must always be cleared to 0.

setting.

Bit 0: P2₀/ \overline{IRQ}_4 / \overline{ADTRG} Pin Function Switch (IRQ4): This bit selects whether pin P2₀/ \overline{IRQ}_4 / \overline{ADTRG} is used as P2₀ or as \overline{IRQ}_4 / \overline{ADTRG} .

| Bit 0: | IRQ4 Description |
|--------|--|
| 0 | Functions as P2 ₀ I/O pin (initial value) |
| 1 | Functions as IRQ ₄ /ADTRG input pin |
| Note: | Rising or falling edge sensing can be selected for the \overline{IRQ}_4 pin. |
| | See section 12.3.2, Start of A/D Conversion by External Trigger Input, for the ADTRG pin |

Port Mode Register 4 (PMR4)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | NMOD7 | NMOD6 | NMOD5 | NMOD4 | NMOD3 | NMOD2 | NMOD1 | NMOD0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W |

PMR4 is an 8-bit read/write register, used to select CMOS output or NMOS open drain output for each port 2 pin.

Upon reset, PMR4 is initialized to H'00.

Bit n—NMOS Open-Drain Output Select (NMODn): This bit selects NMOS open-drain output when pin $P2_n$ is used as an output pin.

| Bit n: NMODn | Description | |
|--------------|------------------------|-----------------|
| 0 | CMOS output | (initial value) |
| 1 | NMOS open-drain output | |

Note: n = 7 to 0



input pin

Pin Functions 8.3.3

H8/3857 Group port 2 pin functions are shown in figure 8.6 (a), and H8/3854 Group port 2 pin functions in figure 8.6 (b).

Table 8.6 (a) H8/3857 Group Port 2 Pin Functions

| Pin | Pin Functions and Selection Method | | | | | | |
|--|---|---------------------------|----------------------------|---------------------|------------|--|--|
| P2, to P2 | Input or output is selected as follows by the bit settings in PCR2. | | | | | | |
| | PCR2n | (|) | - | 1 | | |
| | Pin function | P2 _n in | put pin | P2 _n out | put pin | | |
| | Note: $n = 7 \text{ to } 2$ | 02 | | | | | |
| P2₁/UD | The pin function of | lepends on bit L | JD in PMR2 and | bit PCR2, in PC | CR2. | | |
| | UD 0 1 | | | | | | |
| | PCR2 ₁ | 0 | 1 | > | * | | |
| | Pin function | P2 ₁ input pin | P2, output pin | UD in | out pin | | |
| P2 ₀ /IRQ ₄ /ADTRG | The pin function depends on bit IRQ4 in PMR2, bit TRGE in AMR, and bit PCR2 _o in PCR2. | | | | | | |
| | IRQ4 0 1 | | | | | | |
| | PCR2₀ | 0 1 * | | | | | |
| | TRGE | , | * | 0 | 1 | | |
| | Pin function | P2 ₀ input pin | P2 _o output pin | ĪRQ₄ input pin | ĪRQ₄/ADTRG | | |

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When using as ADTRG input pin, clear bit IEN4 in IENR1 to 0, disabling Note: IRQ₄ interrupts.

Legend: * Don't care

| Table 8.6 (b) | H8/3854 Group Port 2 Pin | Functions |
|----------------------|--------------------------|------------------|
|----------------------|--------------------------|------------------|

| Pin | Pin Functions an | Pin Functions and Selection Method | | | | | |
|------------|---|------------------------------------|----------------------------|--|--|--|--|
| P2, to P2, | Input or output is selected as follows by the bit settings in PCR2. | | | | | | |
| | PCR2n | 0 | 1 | | | | |
| | Pin function | P2 _n input pin | P2 _n output pin | | | | |
| | Note: n = 7 to 1 | | | | | | |

 $P2_{0}/\overline{IRQ_{4}}/\overline{ADTRG}$ The pin function depends on bit IRQ4 in PMR2, bit TRGE in AMR, and bit PCR2, in PCR2.

| IRQ4 | (|) | 1 | | |
|--------------|---------------------------|----------------------------|----------------|-------------------------|--|
| PCR2₀ | 0 1 | | * | ķ | |
| TRGE | * | | 0 | 1 | |
| Pin function | P2 _o input pin | P2 _o output pin | ĪRQ₄ input pin | IRQ₄/ADTRG input pin | |

Note: When using as $\overline{\text{ADTRG}}$ input pin, clear bit IEN4 in IENR1 to 0, disabling IRQ₄ interrupts.

Legend: * Don't care

8.3.4 Pin States

H8/3857 Group port 2 pin states in each operating mode are shown in table 8.7 (a), and H8/3854 Group port 2 pin states in each operating mode in table 8.7 (b).

Table 8.7 (a) H8/3857 Group Port 2 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|---------------------------------|-----------|-------------------|-------------------|-----------|-------------------|------------|------------|
| P2, to P2 | High- | Retains | Retains | High- | | Functional | Functional |
| P2 ₁ /UD | impedance | previous state | previous state | impedance | previous state | | |
| P2 _₀ /ĪRQ₄/ ADTRG | | | | | | | |

Table 8.7 (b) H8/3854 Group Port 2 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|----------------------------------|--------------------|------------------------------|------------------------------|--------------------|------------------------------|------------|------------|
| P2, to P2, P2,/IRQ,/ ADTRG | High- impedance | Retains previous state | Retains previous state | High- impedance | Retains previous state | Functional | Functional |

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8.4 Port 3 (H8/3857 Group Only)

Port 3 is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

8.4.1 Overview

Port 3 is an 8-bit I/O port, configured as shown in figure 8.3.

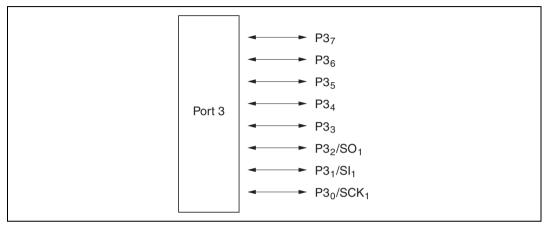


Figure 8.3 Port 3 Pin Configuration

Register Configuration and Description 8.4.2

Table 8.8 shows the port 3 register configuration.

Port 3 Registers Table 8.8

| Name | Abbr. | R/W | Initial Value | Address |
|---------------------------------|-------|-----|---------------|---------|
| Port data register 3 | PDR3 | R/W | H'00 | H'FFD6 |
| Port control register 3 | PCR3 | W | H'00 | H'FFE6 |
| Port pull-up control register 3 | PUCR3 | R/W | H'00 | H'FFE1 |
| Port mode register 3 | PMR3 | R/W | H'00 | H'FFCA |

Port Data Register 3 (PDR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| | P3 ₇ | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 _o |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W |

PDR3 is an 8-bit register that stores data for port 3 pins P3₇ to P3₀. If port 3 is read while PCR3 bits are set to 1, the values stored in PDR3 are read, regardless of the actual pin states. If port 3 is read while PCR3 bits are cleared to 0, the pin states are read.

Upon reset, PDR3 is initialized to H'00.

Port Control Register 3 (PCR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------------------|-------------------|-------|-------|-------------------|-------------------|-------------------|-------|
| | PCR3 ₇ | PCR3 ₆ | PCR3₅ | PCR3₄ | PCR3 ₃ | PCR3 ₂ | PCR3 ₁ | PCR3₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

PCR3 is an 8-bit register for controlling whether each of the port 3 pins $P3_7$ to $P3_0$ functions as an input pin or output pin. Setting a PCR3 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR3 and in PDR3 are valid only when the corresponding pin is designated in PMR3 as a general I/O pin.

Upon reset, PCR3 is initialized to H'00.

PCR3 is a write-only register. All bits are read as 1.

Port Pull-Up Control Register 3 (PUCR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------|--------------------|
| | PUCR3 ₇ | PUCR3 ₆ | PUCR3 ₅ | PUCR3 ₄ | PUCR3 ₃ | PUCR3 ₂ | PUCR3, | PUCR3 _o |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PUCR3 bits control the on/off state of pin $P3_7$ – $P3_0$ MOS pull-ups. When a PCR3 bit is cleared to 0, setting the corresponding PUCR3 bit to 1 turns on the MOS pull-up for the corresponding pin, while clearing the bit to 0 turns off the MOS pull-up.



Upon reset, PUCR3 is initialized to H'00.

Port Mode Register 3 (PMR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-----|-----|------|
| | _ | | _ | _ | _ | SO1 | SI1 | SCK1 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | _ | _ | R/W | R/W | R/W |

PMR3 is an 8-bit read/write register, controlling the selection of pin functions for port 3 pins.

Upon reset, PMR3 is initialized to H'00.

Bits 7 to 3—Reserved Bits: Bits 7 to 3 are reserved; they should always be cleared to 0.

Bit 2—P3,/SO, Pin Function Switch (SO1): This bit selects whether pin P3,/SO, is used as P3, or as SO₁.

| Bit 2: SO1 | Description | |
|------------|---|-----------------|
| 0 | Functions as P3 ₂ I/O pin | (initial value) |
| 1 | Functions as SO ₁ output pin | |

Bit 1—P3,/SI, Pin Function Switch (SI1): This bit selects whether pin P3,/SI, is used as P3, or as SI₁.

| Bit 1: SI1 | Description | |
|------------|----------------------------|-----------------|
| 0 | Functions as P3, I/O pin | (initial value) |
| 1 | Functions as SI, input pin | |

Bit 0—P3₀/SCK₁ Pin Function Switch (SCK1): This bit selects whether pin P3₀/SCK₁ is used as P3₀ or as SCK₁.

| Bit 0: SCK1 | Description | |
|-------------|--------------------------------------|-----------------|
| 0 | Functions as P3 ₀ I/O pin | (initial value) |
| 1 | Functions as SCK, I/O pin | |

8.4.3 Pin Functions

Table 8.9 shows the port 3 pin functions.

Table 8.9 Port 3 Pin Functions

| Pin | Pin Functions an | d Selection Me | thod | | | |
|-----------------------------------|---|---------------------------|-------------------------------|------------------------------|----------------|--|
| P3, to P3, | The pin function d | epends on the c | orresponding bi | t in PCR3. | | |
| | PCR3 _n | (|) | 1 | | |
| | Pin function | P3 _n in | put pin | P3 _n out | put pin | |
| | Note: $n = 7 \text{ to } 3$ | 3 | | | | |
| P3 ₂ /SO ₁ | The pin function d | epends on bit S | O1 in PMR3 and | d bit PCR3 ₂ in P | CR3. | |
| | SO1 | (|) | - | 1 | |
| | PCR3 ₂ | 0 | 1 | ; | k | |
| | Pin function | P3 ₂ input pin | P3 ₂ output pin | SO, ou | tput pin | |
| P3,/SI, | The pin function d | epends on bit S | I1 in PMR3 and | bit PCR3, in PC | R3. | |
| | SI1 | (|) | 1 | | |
| | PCR3, | 0 1 | | ; | k | |
| | Pin function | P3, input pin | P3, output pin | SI₁ inp | out pin | |
| P3 ₀ /SCK ₁ | The pin function dependence of PCR3, in PCR3. | epends on bit S | CK1 in PMR3, b | it CKS3 in SCR | 1, and bit | |
| | SCK1 | (|) | - | 1 | |
| | CKS3 | : | * | 0 | 1 | |
| | PCR3 _o | 0 | 1 | * | * | |
| | Pin function | P3₀ input pin | P3 ₀ output pin | SCK₁ output pin | SCK, input pin | |

Legend: * Don't care

Pin States 8.4.4

Table 8.10 shows the port 3 pin states in each operating mode.

Table 8.10 Port 3 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|--|--------------------|------------------------------|------------------------------|---------------------|-------|------------|------------|
| P3, to P3, P3,/SO, P3,/SI, P3,/SCK, | High- impedance | Retains previous state | Retains previous state | High- impedance* | | Functional | Functional |

A high-level signal is output when the MOS pull-up is in the on state. Note:

MOS Input Pull-Up 8.4.5

Port 3 has a built-in MOS input pull-up function that can be controlled by software. When a PCR3 bit is cleared to 0, setting the corresponding PUCR3 bit to 1 turns on the MOS pull-up for that pin. The MOS pull-up function is in the off state after a reset.

| PCR3 _n | (|) | 1 |
|--------------------|-----|----|-----|
| PUCR3 _n | 0 | 1 | * |
| MOS input pull-up | Off | On | Off |

Legend: * Don't care Note: n = 7 to 0

8.5 Port 4

Port 4 functions are common to the H8/3857 Group and H8/3854 Group.

8.5.1 Overview

Port 4 consists of a 3-bit I/O port and a 1-bit input port, and is configured as shown in figure 8.4.

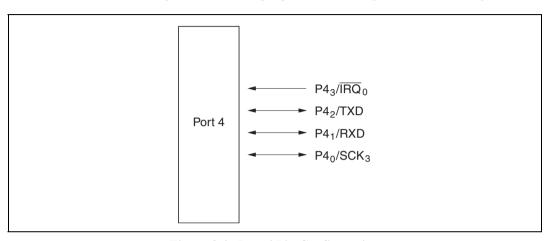


Figure 8.4 Port 4 Pin Configuration

Register Configuration and Description 8.5.2

Table 8.11 shows the port 4 register configuration.

Table 8.11 Port 4 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|-------------------------|-------|-----|---------------|---------|
| Port data register 4 | PDR4 | R/W | H'F8 | H'FFD7 |
| Port control register 4 | PCR4 | W | H'F8 | H'FFE7 |



Port Data Register 4 (PDR4)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|-----------------|-----------------|-----------------|-----------------|
| | | | _ | _ | P4 ₃ | P4 ₂ | P4 ₁ | P4 _o |
| Initial value | 1 | 1 | 1 | 1 | Undefined | 0 | 0 | 0 |
| Read/Write | _ | | _ | | R | R/W | R/W | R/W |

PDR4 is an 8-bit register that stores data for port 4 pins P4, to P4₀. If port 4 is read while PCR4 bits are set to 1, the values stored in PDR4 are read, regardless of the actual pin states. If port 4 is read while PCR4 bits are cleared to 0, the pin states are read.

The pin state is always read from bit 3 (P4₂).

Upon reset, PDR4 is initialized to H'F8.

Port Control Register 4 (PCR4)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-------------------|-------------------|-------|
| | | | _ | _ | _ | PCR4 ₂ | PCR4 ₁ | PCR4₀ |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | | | W | W | W |

PCR4 controls whether each of the port 4 pins P4, to P4₀ functions as an input pin or output pin. Setting a PCR4 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR4 and in PDR4 are valid only when the corresponding pin is designated in SCR3 as a general I/O pin.

Upon reset, PCR4 is initialized to H'F8.

PCR4 is a write-only register. All bits are read as 1.

8.5.3 Pin Functions

Table 8.12 shows the port 4 pin functions.

Table 8.12 Port 4 Pin Functions

| Pin | Pin Functions an | Pin Functions and Selection Method | | | | | | | |
|-----------------------------------|---------------------|--|-------------------------------|-----------------|----------|----------------------------|--|--|--|
| P4 ₃ /IRQ ₀ | The pin function de | epends on the I | RQ0 bit setting i | n PMR2 | 2. | | | | |
| | IRQ0 | (| 1 | | | | | | |
| | Pin function | P4 ₃ in | put pin | | ĪRQ₀ ir | put pin | | | |
| P4 ₂ /TXD | The pin function de | he pin function depends on bit TE in SCR3 and bit PCR4, in PCR4. | | | | | | | |
| | TE 0 1 | | | | | | | | |
| | PCR4 ₂ | 0 | 1 | | : | * | | | |
| | Pin function | P4 ₂ input pin | P4 ₂ output pin | | TXD ou | itput pin | | | |
| P4,/RXD | The pin function de | epends on bit R | E in SCR3 and | bit PCR | 4, in PC | R4. | | | |
| | RE | (| | 1 | | | | | |
| | PCR4 ₁ | 0 1 | | > | | * | | | |
| | Pin function | P4, input pin | P4, output pin | | RXD ir | put pin | | | |
| P4 ₀ /SCK ₃ | The pin function do | | CKE1 and CKE0 |) in SCF | 3, bit C | OM in SMR, | | | |
| | CKE1 | | 0 | | | 1 | | | |
| | CKE0 | | 0 | | 1 | * | | | |
| | СОМ | (| 0 | 1 | * | * | | | |
| | PCR4₀ | 0 | 1 | * | | * | | | |
| | Pin function | P4 ₀ input pin | P4 _o output pin | SCK₃ output pin | | SCK ₃ input pin | | | |

Legend: * Don't care



Pin States 8.5.4

Table 8.13 shows the port 4 pin states in each operating mode.

Table 8.13 Port 4 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|--|--------------------|------------------------------|------------------------------|--------------------|------------------------------|------------|------------|
| P4 ₃ /IRQ ₀ P4 ₂ /TXD P4 ₁ /RXD P4 ₀ /SCK ₃ | High- impedance | Retains previous state | Retains previous state | High- impedance | Retains previous state | Functional | Functional |

8.6 Port 5

Port 5 functions are common to the H8/3857 Group and H8/3854 Group.

8.6.1 Overview

Port 5 is an 8-bit I/O port, configured as shown in figure 8.5.

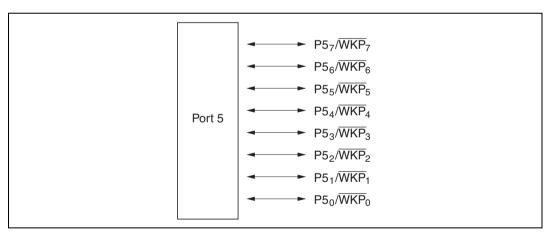


Figure 8.5 Port 5 Pin Configuration

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8.6.2 Register Configuration and Description

Table 8.14 shows the port 5 register configuration.

Table 8.14 Port 5 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|---------------------------------|-------|-----|---------------|---------|
| Port data register 5 | PDR5 | R/W | H'00 | H'FFD8 |
| Port control register 5 | PCR5 | W | H'00 | H'FFE8 |
| Port pull-up control register 5 | PUCR5 | R/W | H'00 | H'FFE2 |
| Port mode register 5 | PMR5 | R/W | H'00 | H'FFCC |

Port Data Register 5 (PDR5)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------------|-----------------|-----------------|-----|-----------------|-----------------|-----|-----|
| | P5 ₇ | P5 ₆ | P5 ₅ | P5₄ | P5 ₃ | P5 ₂ | P5, | P5₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PDR5 is an 8-bit register that stores data for port 5 pins P5₇ to P5₀. If port 5 is read while PCR5 bits are set to 1, the values stored in PDR5 are read, regardless of the actual pin states. If port 5 is read while PCR5 bits are cleared to 0, the pin states are read.

Upon reset, PDR5 is initialized to H'00.

Port Control Register 5 (PCR5)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------------------|-------------------|-------|-------|-------------------|-------------------|-------------------|-------|
| | PCR5 ₇ | PCR5 ₆ | PCR5₅ | PCR5₄ | PCR5 ₃ | PCR5 ₂ | PCR5 ₁ | PCR5₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

PCR5 is an 8-bit register for controlling whether each of the port 5 pins P5₇ to P5₀ functions as an input pin or output pin. Setting a PCR5 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin.

Upon reset, PCR5 is initialized to H'00.

PCR5 is a write-only register. All bits are read as 1.

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Port Pull-up Control Register 5 (PUCR5)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------|--------------------|
| | PUCR5 ₇ | PUCR5 ₆ | PUCR5 ₅ | PUCR5 ₄ | PUCR5 ₃ | PUCR5 ₂ | PUCR5, | PUCR5 _☉ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PUCR5 bits control the on/off state of pin P5,-P5, MOS pull-ups. When a PCR5 bit is cleared to 0, setting the corresponding PUCR5 bit to 1 turns on the MOS pull-up for the corresponding pin, while clearing the bit to 0 turns off the MOS pull-up.

Upon reset, PUCR5 is initialized to H'00.

Port Mode Register 5 (PMR5)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------------------|-------------------------------|------------------|------------------|------------------|------------------|------------------|------------------|
| | WKP ₇ | $WKP_{\scriptscriptstyle{6}}$ | WKP ₅ | WKP ₄ | WKP ₃ | WKP ₂ | WKP ₁ | WKP _₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PMR5 is an 8-bit read/write register, controlling the selection of pin functions for port 5 pins.

Upon reset, PMR5 is initialized to H'00.

Bit n—P5, WKP, Pin Function Switch (WKPn): This bit selects whether pin P5, WKP, is used as P5_n or as \overline{WKP}_n .

| Bit n: WKPn | Description | |
|-------------|--|-----------------|
| 0 | Functions as P5 _n I/O pin | (initial value) |
| 1 | Functions as $\overline{WKP}_{_{\scriptscriptstyle{n}}}$ input pin | |

Note: n = 7 to 0

8.6.3 Pin Functions

Table 8.15 shows the port 5 pin functions.

Table 8.15 Port 5 Pin Functions

Pin Pin Functions and Selection Method

P5₇/WKP₇ to P5₀/WKP₀

The pin function depends on bit WKPn in PMR5 and bit PCR5, in PCR5.

| WKPn | (|) | 1 |
|-------------------|---------------------------|-------------------------------|----------------------------|
| PCR5 _n | 0 | 1 | * |
| Pin function | P5 _n input pin | P5 _n output pin | WKP _n input pin |

Legend: * Don't care

Note: n = 7 to 0

8.6.4 Pin States

Table 8.16 shows the port 5 pin states in each operating mode.

Table 8.16 Port 5 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|--|--------------------|------------------------------|----------|---------------------|-------|------------|------------|
| P5 ₇ /WKP ₇ to P5 ₀ /WKP ₀ | High- impedance | Retains previous state | | High- impedance* | | Functional | Functional |

Note: * A high-level signal is output when the MOS pull-up is in the on state.

8.6.5 MOS Input Pull-Up

Port 5 has a built-in MOS input pull-up function that can be controlled by software. When a PCR5 bit is cleared to 0, setting the corresponding PUCR5 bit to 1 turns on the MOS pull-up for that pin. The MOS pull-up function is in the off state after a reset.

| PCR5 _n | (|) | 1 |
|--------------------|-----|----|-----|
| PUCR5 _n | 0 | 1 | * |
| MOS input pull-up | Off | On | Off |

Legend: * Don't care Note: n = 7 to 0

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Port 9 [Chip-Internal I/O port] 8.7

Port 9 functions are common to the H8/3857 Group and H8/3854 Group.

8.7.1 Overview

Port 9 is an 8-bit I/O port that interfaces to the on-chip LCD controller. The port 9 pin configuration is shown in figure 8.6.

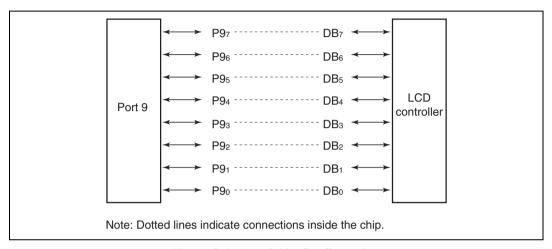


Figure 8.6 Port 9 Pin Configuration

Register Configuration and Description 8.7.2

Table 8.17 shows the port 9 register configuration.

Table 8.17 Port 9 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|-------------------------|-------|-----|---------------|---------|
| Port data register 9 | PDR9 | R/W | H'00 | H'FFDC |
| Port control register 9 | PCR9 | W | H'00 | H'FFEC |

Port Data Register 9 (PDR9)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----|-----------------|
| | P9 ₇ | P9 ₆ | P9 ₅ | P9 ₄ | P9 ₃ | P9 ₂ | P9, | P9 _o |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PDR9 is an 8-bit register that stores data for port 9 pins $P9_7$ to $P9_0$. If port 9 is read while PCR9 bits are set to 1, the values stored in PDR9 are read. If port 9 is read while PCR9 bits are cleared to 0, the pin states are read.

Upon reset, PDR9 is initialized to H'00.

Port Control Register 9 (PCR9)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------------------|-------------------|-------|-------|-------------------|-------------------|-------------------|-------|
| | PCR9 ₇ | PCR9 ₆ | PCR9₅ | PCR9₄ | PCR9 ₃ | PCR9 ₂ | PCR9 ₁ | PCR9₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

PCR9 is an 8-bit register for controlling whether each of the port 9 pins $P9_7$ to $P9_0$ functions as an input or output pin. Setting a PCR9 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin.

Upon reset, PCR9 is initialized to H'00.

PCR9 is a write-only register. All bits are read as 1.

8.7.3 Pin Functions

Table 8.18 shows the port 9 pin functions.

Table 8.18 Port 9 Pin Functions

| Pin | Pin Functions and | d Selection Method | | | | | | |
|------------------------|--|--------------------|---|--|--|--|--|--|
| P9, to P9 ₀ | P9 ₀ The pin function depends on the corresponding bit in PCR9. | | | | | | | |
| | PCR9 _n | 0 | 1 | | | | | |
| | Pin function P9, input pin P9, output pin | | | | | | | |

Note: n = 7 to 0

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8.7.4 **Pin States**

Table 8.19 shows the port 9 pin states in each operating mode.

Table 8.19 Port 9 Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|------------------------------------|--------------------|------------------------------|----------|--------------------|------------------------------|------------|------------|
| P9 ₇ to P9 ₀ | High- impedance | Retains previous state | | High- impedance | Retains previous state | Functional | Functional |

8.8 Port A [Chip-Internal I/O port]

Port A functions are common to the H8/3857 Group and H8/3854 Group.

8.8.1 Overview

Port A is a 4-bit I/O port that interfaces to the on-chip LCD controller. The port A pin configuration is shown in figure 8.7.

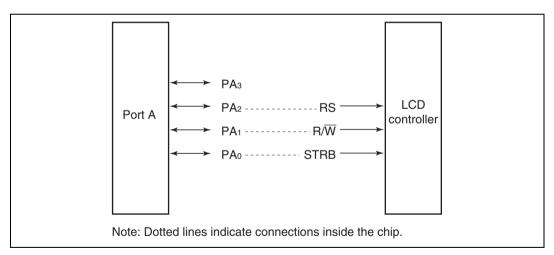


Figure 8.7 Port A Pin Configuration

8.8.2 Register Configuration and Description

Table 8.20 shows the port A register configuration.

Table 8.20 Port A Registers

| Name | Abbr. | R/W | Initial Value | Address |
|-------------------------|-------|-----|---------------|---------|
| Port data register A | PDRA | R/W | H'F0 | H'FFDD |
| Port control register A | PCRA | W | H'F0 | H'FFED |

Port Data Register A (PDRA)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|--------|----------|-----------------|-----------------|
| | | | _ | _ | PA_3 | PA_{2} | PA ₁ | PA _o |
| Initial value | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | — | _ | R/W | R/W | R/W | R/W |

PDRA is an 8-bit register that stores data for port A pins PA₃ to PA₀. If port A is read while PCRA bits are set to 1, the values stored in PDRA are read. If port A is read while PCRA bits are cleared to 0, the pin states are read.

Upon reset, PDRA is initialized to H'F0.

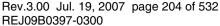
Port Control Register A (PCRA)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|-------|-------------------|-------------------|-------|
| | _ | _ | _ | _ | PCRA₃ | PCRA ₂ | PCRA ₁ | PCRA₀ |
| Initial value | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | | W | W | W | W |

PCRA is an 8-bit register for controlling whether each of the port A pins PA_3 to PA_0 functions as an input or output pin. Setting a PCRA bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin.

Upon reset, PCRA is initialized to H'F0.

PCRA is a write-only register. All bits are read as 1.





Pin Functions 8.8.3

Table 8.21 gives the port A pin functions.

Table 8.21 Port A Pin Functions

| Pin | Pin Functions and Selection Method | | | | | | |
|------------------------------------|------------------------------------|--|----------------------------|--|--|--|--|
| PA ₃ to PA ₀ | The pin function de | epends on the corresponding bit in PCRA. | | | | | |
| | PCRA _n | 0 | 1 | | | | |
| | Pin function | PA _n input pin | PA _n output pin | | | | |

Note: n = 3 to 0

8.8.4 **Pin States**

Table 8.22 shows the port A pin states in each operating mode.

Table 8.22 Port A Pin States

| Pins | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|------------------------------------|--------------------|------------------------------|------------------------------|--------------------|------------------------|------------|------------|
| PA ₃ to PA ₀ | High- impedance | Retains previous state | Retains previous state | High- impedance | Retains previous state | Functional | Functional |

8.9 Port B

Some port B functions differ between the H8/3857 Group and the H8/3854 Group.

Pins PB_3 to PB_0/AN_3 to AN_0 are provided only in the H8/3857 Group, and not in the H8/3854 Group.

8.9.1 Overview

Port B is an 8-bit input-only port. The H8/3857 Group port B pin configuration is shown in figure 8.8 (a), and the H8/3854 Group port B pin configuration in figure 8.8 (b).

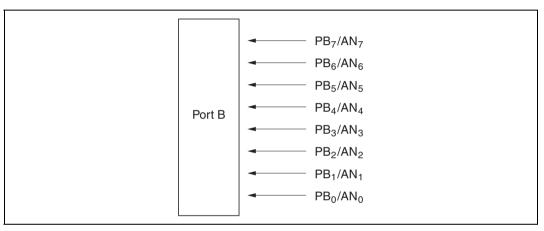


Figure 8.8 (a) H8/3857 Group Port B Pin Configuration

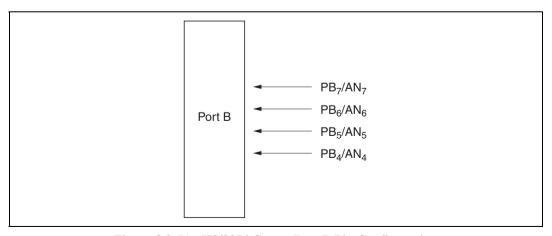


Figure 8.8 (b) H8/3854 Group Port B Pin Configuration

Register Configuration and Description 8.9.2

Table 8.23 shows the port B register configuration.

Table 8.23 Port B Register

| Name | Abbr. | R/W | Address |
|----------------------|-------|-----|---------|
| Port data register B | PDRB | R | H'FFDE |

Port Data Register B (PDRB)

110/0057 0.....

Reading PDRB always gives the pin states. However, if a port B pin is selected as an analog input channel for the A/D converter by AMR bits CH3 to CH0, that pin reads 0 regardless of the input voltage.

| H8/3857 Group | | | | | | | | | |
|---------------|-----------------|-----------------|-----|-----------------|-----------------|-----------------|-----------------|-----|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | PB ₇ | PB ₆ | PB₅ | PB ₄ | PB ₃ | PB ₂ | PB ₁ | PB₀ | |
| | | | | | | | | | |
| Read/Write | R | R | R | R | R | R | R | R | |
| | | | | | | | | | |
| H8/3854 Group | | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | PB ₇ | PB ₆ | PB₅ | PB ₄ | | _ | | _ | |
| | | | | | | | | | |
| Read/Write | R | R | R | R | | | | | |

In the H8/3854 Group, bits 3 to 0 are reserved.

Section 9 Timers

9.1 Overview

The H8/3857 Group is provided with four timers (timers A, B, C, and F), and the H8/3854 Group with three (timers A, B, and F). The H8/3857F and H8/3854F also have an on-chip watchdog timer for flash memory programming control.

Table 9.1 outlines the functions of timers A, B, C, F, and the watchdog timer.

Table 9.1 Timer Functions

| Name | Functions | Internal Clock | Event Input Pin | Waveform Output Pin | Remarks |
|---------------------|---|---|--------------------|------------------------|--------------------------|
| Timer A | 8-bit timer | φ/8 to φ/8192 | _ | _ | _ |
| | Interval timer | (8 choices) | | | |
| | 8-bit timer | $\phi_{\text{w}}/128$ | _ | _ | |
| | Time base | (choice of 4 overflow periods) | | | |
| | 8-bit timer | φ/4 to φ/32, | _ | TMOW | |
| | Clock output | $\phi_{W}/4$ to $\phi_{W}/32$ (8 choices) | | | |
| Timer B | 8-bit timer | φ/4 to φ/8192 | TMIB | _ | |
| | Interval timer | (7 choices) | | | |
| | Event counter | | | | |
| Timer C*1 | 8-bit timer | φ/4 to φ/8192, | TMIC | | Counting |
| | Interval timer | $\phi_{W}/4$ (7 choices) | | | direction can be |
| | Event counter | | | | controlled by |
| | • Choice of up- or down-counting | | | | software or hardware |
| Timer F | 16-bit timer | φ/2 to φ/32 | TMIF | TMOFL | |
| | Event counter | (4 choices) | | TMOFH | |
| | Can be used as two independent 8-bit timers | | | | |
| | Output compare | | | | |
| | Generates reset signal | φ/64 to φ/8192 | _ | _ | Provided only in |
| timer* ² | on overflow of 8-bit counter | (8 choices) | | | H8/3857F and H8/3854F |

Notes: 1. Timer C is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

2. The watchdog timer is used by the flash memory programming control program.

9.2 Timer A

9.2.1 Overview

Timer A is an 8-bit timer with interval timing and real-time clock time-base functions. The clock time-base function is available when a 32.768-kHz crystal oscillator is connected. A clock signal divided from 32.768 kHz or from the system clock can be output at the TMOW pin.

Features

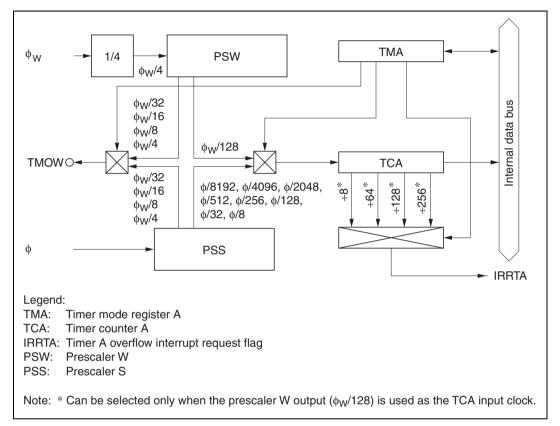
Features of timer A are given below.

- Choice of eight internal clock sources (\$\phi/8192\$, \$\phi/4096\$, \$\phi/2048\$, \$\phi/512\$, \$\phi/256\$, \$\phi/128\$, \$\phi/32\$, \$\phi/8\$).
- Choice of four overflow periods (1 s, 0.5 s, 0.25 s, 31.25 ms) when timer A is used as a clock time base (using a 32.768 kHz crystal oscillator).
- An interrupt is requested when the counter overflows.
- Any of eight clock signals can be output from pin TMOW: 32.768 kHz divided by 32, 16, 8, or 4 (1 kHz, 2 kHz, 4 kHz, 8 kHz), or the system clock divided by 32, 16, 8, or 4.



Block Diagram

Figure 9.1 shows a block diagram of timer A.



 $Figure \ 9.1 \quad Block \ Diagram \ of \ Timer \ A$

Pin Configuration

Table 9.2 shows the timer A pin configuration.

Table 9.2 Pin Configuration

| Name | Abbr. | I/O | Function |
|--------------|-------|--------|--|
| Clock output | TMOW | Output | Output of waveform generated by timer A output circuit |

Register Configuration

Table 9.3 shows the register configuration of timer A.

Timer A Registers Table 9.3

| Name | Abbr. | R/W | Initial Value | Address |
|-----------------------|-------|-----|---------------|---------|
| Timer mode register A | TMA | R/W | H'10 | H'FFB0 |
| Timer counter A | TCA | R | H'00 | H'FFB1 |

9.2.2 **Register Descriptions**

Timer Mode Register A (TMA)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|---|------|------|------|------|
| | TMA7 | TMA6 | TMA5 | _ | TMA3 | TMA2 | TMA1 | TMA0 |
| Initial value | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | | R/W | R/W | R/W | R/W |

TMA is an 8-bit read/write register for selecting the prescaler, input clock, and output clock.

Upon reset, TMA is initialized to H'10.

Bits 7 to 5—Clock Output Select (TMA7 to TMA5): Bits 7 to 5 choose which of eight clock signals is output at the TMOW pin. The system clock divided by 32, 16, 8, or 4 can be output in active mode and sleep mode. A 32.768 kHz signal divided by 32, 16, 8, or 4 can be output in active mode, sleep mode, and subactive mode.

| Bit 7: TMA7 | Bit 6: TMA6 | Bit 5: TMA5 | Clock Output | |
|-------------|-------------|-------------|--------------------|-----------------|
| 0 | 0 | 0 | φ/32 | (initial value) |
| | | 1 | ф/16 | |
| | 1 | 0 | φ/8 | |
| | | 1 | φ/4 | |
| 1 | 0 | 0 | φ _w /32 | |
| | | 1 | φ _w /16 | |
| | 1 | 0 | φ _w /8 | |
| | | 1 | φ _w /4 | |

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Bit 4—Reserved Bit: Bit 4 is reserved; it is always read as 1, and cannot be modified.

Bits 3 to 0—Internal Clock Select (TMA3 to TMA0): Bits 3 to 0 select the clock input to TCA.

| | | | | Description | ı |
|----------------|----------------|----------------|----------------|--|-----------------|
| Bit 3: TMA3 | Bit 2: TMA2 | Bit 1: TMA1 | Bit 0: TMA0 | Prescaler and Divider Ratio or Overflow Period | Function |
| 0 | 0 | 0 | 0 | PSS, \$\dagger{9} (initial value) | Interval timer |
| | | | 1 | PSS, 6/4096 | |
| | | 1 | 0 | PSS, 6/2048 | |
| | | | 1 | PSS, _{\$\phi\$} /512 | |
| | 1 | 0 | 0 | PSS, ₀ /256 | |
| | | | 1 | PSS, φ/128 | |
| | | 1 | 0 | PSS, 6/32 | <u> </u> |
| | | | 1 | PSS, _ф /8 | <u> </u> |
| 1 | 0 | 0 | 0 | PSW, 1 s | Clock time base |
| | | | 1 | PSW, 0.5 s | <u> </u> |
| | | 1 | 0 | PSW, 0.25 s | |
| | | | 1 | PSW, 0.03125 s | <u> </u> |
| | 1 | 0 | 0 | PSW and TCA are reset | |
| | | | 1 | | |
| | | 1 | 0 | _ | |
| | | | 1 | | |

Timer Counter A (TCA)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TCA7 | TCA6 | TCA5 | TCA4 | TCA3 | TCA2 | TCA1 | TCA0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

TCA is an 8-bit read-only up-counter, which is incremented by internal clock input. The clock source for input to this counter is selected by bits TMA3 to TMA0 in timer mode register A (TMA). TCA values can be read by the CPU in active mode, but cannot be read in subactive mode. When TCA overflows, the IRRTA bit in interrupt request register 1 (IRR1) is set to 1.

TCA is cleared by setting bits TMA3 and TMA2 of TMA to 11.

Upon reset, TCA is initialized to H'00.

9.2.3 Timer Operation

Interval Timer Operation: When bit TMA3 in timer mode register A (TMA) is cleared to 0, timer A functions as an 8-bit interval timer.

Upon reset, TCA is cleared to H'00 and bit TMA3 is cleared to 0, so up-counting and interval timing resume immediately. The clock input to timer A is selected by bits TMA2 to TMA0 in TMA; any of eight internal clock signals output by prescaler S can be selected.

After the count value in TCA reaches H'FF, the next clock signal input causes timer A to overflow, setting bit IRRTA to 1 in interrupt request register 1 (IRR1). If IENTA = 1 in interrupt enable register 1 (IENR1), a CPU interrupt is requested.*

At overflow, TCA returns to H'00 and starts counting up again. In this mode timer A functions as an interval timer that generates an overflow output at intervals of 256 input clock pulses.

Note: * For details on interrupts, see section 3.3, Interrupts.

Real-Time Clock Time Base Operation: When bit TMA3 in TMA is set to 1, timer A functions as a real-time clock time base by counting clock signals output by prescaler W.

The overflow period of timer A is set by bits TMA1 and TMA0 in TMA. A choice of four periods is available. In time base operation (TMA3 = 1), setting bit TMA2 to 1 clears both TCA and prescaler W to their initial values of H'00.

Clock Output: Setting bit TMOW in port mode register 1 (PMR1) to 1 causes a clock signal to be output at pin TMOW. Eight different clock output signals can be selected by means of bits TMA7 to TMA5 in TMA. The system clock divided by 32, 16, 8, or 4 can be output in active mode and sleep mode. A 32.768 kHz signal divided by 32, 16, 8, or 4 can be output in active mode, sleep mode, and subactive mode.



9.2.4 **Timer A Operation States**

Table 9.4 summarizes the timer A operation states.

Table 9.4 **Timer A Operation States**

| Oper | ation Mode | Reset | Active | Sleep | Watch | Sub- active | Sub- sleep | Standby |
|------|-----------------|-------|-----------|-----------|-----------|----------------|---------------|----------|
| TCA | Interval | Reset | Functions | Functions | Halted | Halted | Halted | Halted |
| | Clock time base | Reset | Functions | Functions | Functions | Functions | Functions | Halted |
| TMA | | Reset | Functions | Retained | Retained | Functions | Retained | Retained |

Note: When real-time clock time base function is selected as the internal clock of TCA in active mode or sleep mode, the internal clock is not synchronous with the system clock, so it is synchronized by a synchronizing circuit. This may result in a maximum error of 1/\(\phi \) (s) in the count cycle.

9.3 Timer B

9.3.1 Overview

Timer B is an 8-bit timer that increments each time a clock pulse is input. This timer has two operation modes, interval and auto reload.

Features

Features of timer B are given below.

- Choice of seven internal clock sources ($\phi/8192$, $\phi/2048$, $\phi/512$, $\phi/256$, $\phi/64$, $\phi/16$, $\phi/4$) or an external clock (can be used to count external events).
- An interrupt is requested when the counter overflows.

Block Diagram

Figure 9.2 shows a block diagram of timer B.

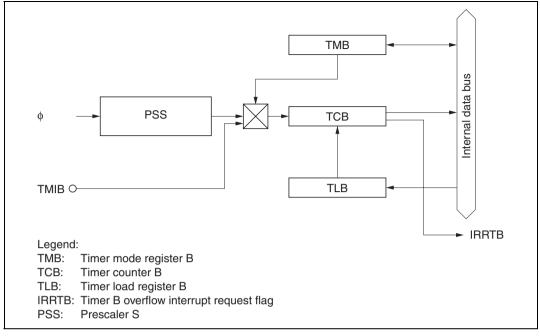


Figure 9.2 Block Diagram of Timer B

Pin Configuration

Table 9.5 shows the timer B pin configuration.

Table 9.5 Pin Configuration

| Name | Abbr. | I/O | Function |
|---------------------|-------|-------|--------------------|
| Timer B event input | TMIB | Input | Event input to TCB |

Register Configuration

Table 9.6 shows the register configuration of timer B.

Table 9.6 Timer B Registers

| Name | Abbr. | R/W | Initial Value | Address |
|-----------------------|-------|-----|---------------|---------|
| Timer mode register B | TMB | R/W | H'78 | H'FFB2 |
| Timer counter B | TCB | R | H'00 | H'FFB3 |
| Timer load register B | TLB | W | H'00 | H'FFB3 |

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9.3.2 Register Descriptions

Timer Mode Register B (TMB)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|------|------|------|
| | TMB7 | _ | _ | _ | _ | TMB2 | TMB1 | TMB0 |
| Initial value | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | R/W | _ | _ | | _ | R/W | R/W | R/W |

TMB is an 8-bit read/write register for selecting the auto-reload function and input clock.

Upon reset, TMB is initialized to H'78.

Bit 7—Auto-Reload Function Select (TMB7): Bit 7 selects whether timer B is used as an interval timer or auto-reload timer.

| Bit 7: TMB7 | Description | |
|-------------|----------------------------------|-----------------|
| 0 | Interval timer function selected | (initial value) |
| 1 | Auto-reload function selected | |

Bits 6 to 3—Reserved Bits: Bits 6 to 3 are reserved; they always read 1, and cannot be modified.

Bits 2 to 0—Clock Select (TMB2 to TMB0): Bits 2 to 0 select the clock input to TCB. For external event counting, either the rising or falling edge can be selected.

| Bit 2: TMB2 | Bit 1: TMB1 | Bit 0: TMB0 | Description |
|-------------|-------------|-------------|--|
| 0 | 0 | 0 | Internal clock: $\phi/8192$ (initial value) |
| | | 1 | Internal clock: $\phi/2048$ |
| | 1 | 0 | Internal clock: φ/512 |
| | | 1 | Internal clock: φ/256 |
| 1 | 0 | 0 | Internal clock: φ/64 |
| | | 1 | Internal clock: φ/16 |
| | 1 | 0 | Internal clock: φ/4 |
| | | 1 | External event (TMIB): rising or falling edge* |

Note: * The edge of the external event signal is selected by bit IEG1 in the IRQ edge select register (IEGR). See section 3.3.2, Interrupt Control Registers, for details on the IRQ edge select register. Be sure to set bit IRQ1 in port mode register 1 (PMR1) to 1 before setting bits TMB2 to TMB0 to 111.

Timer Counter B (TCB)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TCB7 | TCB6 | TCB5 | TCB4 | TCB3 | TCB2 | TCB1 | TCB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

TCB is an 8-bit read-only up-counter, which is incremented by internal clock or external event input. The clock source for input to this counter is selected by bits TMB2 to TMB0 in timer mode register B (TMB). TCB values can be read by the CPU at any time.

When TCB overflows from H'FF to H'00 or to the value set in TLB, the IRRTB bit in interrupt request register 2 (IRR2) is set to 1.

TCB is allocated to the same address as timer load register B (TLB).

Upon reset, TCB is initialized to H'00.

Timer Load Register B (TLB)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TLB7 | TLB6 | TLB5 | TLB4 | TLB3 | TLB2 | TLB1 | TLB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

TLB is an 8-bit write-only register for setting the reload value of timer counter B.

When a reload value is set in TLB, the same value is loaded into timer counter B (TCB) as well, and TCB starts counting up from that value. When TCB overflows during operation in auto-reload mode, the TLB value is loaded into TCB. Accordingly, overflow periods can be set within the range of 1 to 256 input clocks.

The same address is allocated to TLB as to TCB.

Upon reset, TLB is initialized to H'00.



9.3.3 **Timer Operation**

Interval timer Operation: When bit TMB7 in timer mode register B (TMB) is cleared to 0, timer B functions as an 8-bit interval timer.

Upon reset, TCB is cleared to H'00 and bit TMB7 is cleared to 0, so up-counting and interval timing resume immediately. The clock input to timer B is selected from seven internal clock signals output by prescaler S, or an external clock input at pin TMIB. The selection is made by bits TMB2 to TMB0 of TMB.

After the count value in TCB reaches H'FF, the next clock signal input causes timer B to overflow, setting bit IRRTB to 1 in interrupt request register 2 (IRR2). If IENTB = 1 in interrupt enable register 2 (IENR2), a CPU interrupt is requested.*

At overflow, TCB returns to H'00 and starts counting up again.

During interval timer operation (TMB7 = 0), when a value is set in timer load register B (TLB), the same value is set in TCB.

Note: * For details on interrupts, see section 3.3, Interrupts.

Auto-Reload Timer Operation: Setting bit TMB7 in TMB to 1 causes timer B to function as an 8-bit auto-reload timer. When a reload value is set in TLB, the same value is loaded into TCB, becoming the value from which TCB starts its count.

After the count value in TCB reaches H'FF, the next clock signal input causes timer B to overflow. The TLB value is then loaded into TCB, and the count continues from that value. The overflow period can be set within a range from 1 to 256 input clocks, depending on the TLB value.

The clock sources and interrupts in auto-reload mode are the same as in interval mode.

In auto-reload mode (TMB7 = 1), when a new value is set in TLB, the TLB value is also set in TCB.

Event Counter Operation: Timer B can operate as an event counter, counting rising or falling edges of an external event signal input at pin TMIB. External event counting is selected by setting bits TMB2 to TMB0 in timer mode register B to all 1s (111).

When timer B is used to count external event input, bit IRQ1 in port mode register 1 (PMR1) should be set to 1, and bit IEN1 in interrupt enable register 1 (IENR1) should be cleared to 0 to disable IRQ, interrupt requests.



9.3.4 Timer B Operation States

Table 9.7 summarizes the timer B operation states.

Table 9.7 Timer B Operation States

| Oper | ation Mode | Reset | Active | Sleep | Watch | Sub- active | Sub- sleep | Standby |
|------|-------------|-------|-----------|-----------|----------|----------------|---------------|----------|
| TCB | Interval | Reset | Functions | Functions | Halted | Halted | Halted | Halted |
| | Auto reload | Reset | Functions | Functions | Halted | Halted | Halted | Halted |
| TMB | | Reset | Functions | Retained | Retained | Retained | Retained | Retained |

9.4 Timer C (H8/3857 Group Only)

9.4.1 Overview

Timer C is an 8-bit timer that increments or decrements each time a clock pulse is input. This timer has two operation modes, interval and auto reload.

Timer C is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

Features

The main features of timer C are given below.

- Choice of seven internal clock sources ($\phi/8192$, $\phi/2048$, $\phi/512$, $\phi/64$, $\phi/16$, $\phi/4$, $\phi_w/4$) or an external clock (can be used to count external events).
- An interrupt is requested when the counter overflows.
- Can be switched between up- and down-counting by software or hardware.
- When $\phi_w/4$ is selected as the internal clock source, or when an external clock is selected, timer C can function in subactive mode and subsleep mode.



Block Diagram

Figure 9.3 shows a block diagram of timer C.

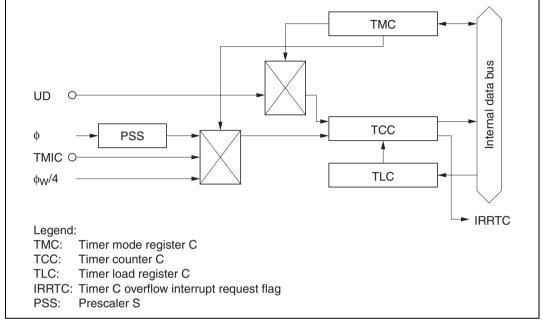


Figure 9.3 Block Diagram of Timer C

Pin Configuration

Table 9.8 shows the timer C pin configuration.

Pin Configuration Table 9.8

| Name | Abbr. | I/O | Function |
|-------------------------|-------|-------|---------------------------------|
| Timer C event input | TMIC | Input | Event input to TCC |
| Timer C up/down control | UD | Input | Selection of counting direction |

Register Configuration

Table 9.9 shows the register configuration of timer C.

Table 9.9 Timer C Registers

| Name | Abbr. | R/W | Initial Value | Address |
|-----------------------|-------|-----|---------------|---------|
| Timer mode register C | TMC | R/W | H'18 | H'FFB4 |
| Timer counter C | TCC | R | H'00 | H'FFB5 |
| Timer load register C | TLC | W | H'00 | H'FFB5 |

9.4.2 Register Descriptions

Timer Mode Register C (TMC)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|---|---|------|------|------|
| | TMC7 | TMC6 | TMC5 | | | TMC2 | TMC1 | TMC0 |
| Initial value | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | _ | _ | R/W | R/W | R/W |

TMC is an 8-bit read/write register for selecting the auto-reload function, counting direction, and input clock.

Upon reset, TMC is initialized to H'18.

Bit 7—Auto-Reload Function Select (TMC7): Bit 7 selects whether timer C is used as an interval timer or auto-reload timer.

| Bit 7: TMC7 | Description | |
|-------------|----------------------------------|-----------------|
| 0 | Interval timer function selected | (initial value) |
| 1 | Auto-reload function selected | |

Bits 6 and 5—Counter Up/Down Control (TMC6, TMC5): These bits select the counting direction of timer counter C (TCC), or allow hardware to control the counting direction using pin UD.

| Bit 6: TMC6 | Bit 5: TMC5 | Description |
|-------------|-------------|---|
| 0 | 0 | TCC is an up-counter (initial value) |
| | 1 | TCC is a down-counter |
| 1 | * | TCC up/down control is determined by input at pin UD. TCC is a down-counter if the UD input is high, and an upcounter if the UD input is low. |

Legend: * Don't care

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Bits 4 and 3—Reserved Bits: Bits 4 and 3 are reserved; they are always read as 1, and cannot be modified

Bits 2 to 0—Clock Select (TMC2 to TMC0): Bits 2 to 0 select the clock input to TCC. For external clock counting, either the rising or falling edge can be selected.

| Bit 2: TMC2 | Bit 1: TMC1 | Bit 0: TMC0 | Description |
|-------------|-------------|-------------|--|
| 0 | 0 | 0 | Internal clock: $\phi/8192$ (initial value) |
| | | 1 | Internal clock: φ/2048 |
| | 1 | 0 | Internal clock: φ/512 |
| | | 1 | Internal clock: φ/64 |
| 1 | 0 | 0 | Internal clock: φ/16 |
| | | 1 | Internal clock: φ/4 |
| | 1 | 0 | Internal clock: $\phi_w/4$ |
| | | 1 | External event (TMIC): rising or falling edge* |

Note: * The edge of the external event signal is selected by bit IEG2 in the IRQ edge select register (IEGR). See section 3.3.2, Interrupt Control Registers for details on the IRQ edge select register. Be sure to set bit IRQ2 in port mode register 1 (PMR1) to 1 before setting bits TMC2 to TMC0 to 111.

Timer Counter C (TCC)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TCC7 | TCC6 | TCC5 | TCC4 | TCC3 | TCC2 | TCC1 | TCC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

TCC is an 8-bit read-only up-/down-counter, which is incremented or decremented by internal or external clock input. The clock source for input to this counter is selected by bits TMC2 to TMC0 in timer mode register C (TMC). TCC values can be read by the CPU at any time.

When TCC overflows (from H'FF to H'00 or to the value set in TLC) or underflows (from H'00 to H'FF or to the value set in TLC), the IRRTC bit in interrupt request register 2 (IRR2) is set to 1.

TCC is allocated to the same address as timer load register C (TLC).

Upon reset, TCC is initialized to H'00.

Timer Load Register C (TLC)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TLC7 | TLC6 | TLC5 | TLC4 | TLC3 | TLC2 | TLC1 | TLC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

TLC is an 8-bit write-only register for setting the reload value of TCC.

When a reload value is set in TLC, the same value is loaded into timer counter C (TCC) as well, and TCC starts counting up or down from that value. When TCC overflows or underflows during operation in auto-reload mode, the TLC value is loaded into TCC. Accordingly, overflow and underflow periods can be set within the range of 1 to 256 input clocks.

The same address is allocated to TLC as to TCC.

Upon reset, TLC is initialized to H'00.

9.4.3 Timer Operation

Interval Timer Operation: When bit TMC7 in timer mode register C (TMC) is cleared to 0, timer C functions as an 8-bit interval timer.

Upon reset, timer counter C (TCC) is initialized to H'00 and TMC to H'18. After a reset, the counter continues uninterrupted incrementing as an interval up-counter. The clock input to timer C is selected from seven internal clock signals output by prescalers S and W, or an external clock input at pin TMIC. The selection is made by bits TMC2 to TMC0 in TMC.

Either software or hardware can control whether TCC counts up or down. The selection is made by TMC bits TMC6 and TMC5.

After the count value in TCC reaches H'FF (H'00), the next clock signal input causes timer C to overflow (underflow), setting bit IRRTC to 1 in interrupt request register 2 (IRR2). If IENTC = 1 in interrupt enable register 2 (IENR2), a CPU interrupt is requested.*

At overflow or underflow, TCC returns to H'00 or H'FF and starts counting up or down again.

During interval timer operation (TMC7 = 0), when a value is set in timer load register C (TLC), the same value is set in TCC.

Note: * For details on interrupts, see section 3.3, Interrupts.



Auto-Reload Timer Operation: Setting bit TMC7 in TMC to 1 causes timer C to function as an 8-bit auto-reload timer. When a reload value is set in TLC, the same value is loaded into TCC, becoming the value from which TCC starts its count.

After the count value in TCC reaches H'FF (H'00), the next clock signal input causes timer C to overflow (underflow). The TLC value is then loaded TCC, and the count continues from that value. The overflow (underflow) period can be set within a range from 1 to 256 input clocks, depending on the TLC value.

The clock sources, up/down control, and interrupts in auto-reload mode are the same as in interval mode.

In auto-reload mode (TMC7 = 1), when a new value is set in TLC, the TLC value is also set in TCC.

Event Counter Operation: Timer C can operate as an event counter, counting an event signal input at pin TMIC. External event counting is selected by setting TMC bits TMC2 to TMC0 to all 1s (111). TCC counts up or down at the rising or falling edge of the input at pin TMIC.

When timer C is used to count external event inputs, bit IRQ2 in port mode register 1 (PMR1) should be set to 1, and bit IEN2 in interrupt enable register 1 (IENR1) should be cleared to 0 to disable IRQ, interrupt requests.

TCC Up/Down Control by Hardware: The counting direction of timer C can be controlled by input at pin UD. When bit TMC6 in TMC is set to 1, high-level input at the UD pin selects down-counting, while low-level input selects up-counting.

When using input at pin UD for this control function, set the UD bit in port mode register 2 (PMR2) to 1.

9.4.4 Timer C Operation States

Table 9.10 summarizes the timer C operation states.

Table 9.10 Timer C Operation States

| Operation Mode | | Reset | Active | Sleep | Watch | Sub- active | Sub- sleep | Standby |
|----------------|----------------|-------|-----------|-----------|----------|-----------------------|-----------------------|----------|
| TCC | Interval | Reset | Functions | Functions | Halted | Functions/ Halted* | Functions/ Halted* | Halted |
| TCC | Auto reload | Reset | Functions | Functions | Halted | Functions/ Halted* | Functions/ Halted* | Halted |
| TMC | | Reset | Functions | Retained | Retained | Functions | Retained | Retained |

Note: * When $\phi_w/4$ is selected as the internal clock of TCC in active mode or sleep mode, the internal clock is not synchronous with the system clock, so it is synchronized by a synchronizing circuit. This may result in a maximum error of $1/\phi$ (s) in the count cycle. When timer C is operated in subactive mode or subsleep mode, either an external clock or the $\phi_w/4$ internal clock must be selected. The counter will not operate in these modes if another clock is selected. If the internal $\phi_w/4$ clock is selected when $\phi_w/8$ is being used as the subclock ϕ_{SUB} , the lower 2 bits of the counter will operate on the same cycle, with the least significant bit not being counted.

9.5 Timer F

9.5.1 Overview

Timer F is a 16-bit timer with an output compare function. Compare match signals can be used to reset the counter, request an interrupt, or toggle the output. Timer F can also be used for external event counting, and can operate as two independent 8-bit timers, timer FH and timer FL.

Features

Features of timer F are given below.

- Choice of four internal clock sources ($\phi/32$, $\phi/16$, $\phi/4$, $\phi/2$) or an external clock (can be used as an external event counter).
- Output from pin TMOFH is toggled by one compare match signal (the initial value of the toggle output can be set).
- Counter can be reset by the compare match signal.
- Two interrupt sources: counter overflow and compare match.
- Can operate as two independent 8-bit timers (timer FH and timer FL) in 8-bit mode.



Timer FH

- 8-bit timer (clocked by timer FL overflow signals when timer F operates as a 16-bit timer).
- Choice of four internal clocks ($\phi/32$, $\phi/16$, $\phi/4$, $\phi/2$).
- Output from pin TMOFH is toggled by one compare match signal (the initial value of the toggle output can be set).
- Counter can be reset by the compare match signal.
- Two interrupt sources: counter overflow and compare match.

Timer FL

- 8-bit timer/event counter
- Choice of four internal clocks ($\phi/32$, $\phi/16$, $\phi/4$, $\phi/2$) or event input at pin TMIF.
- Output from pin TMOFL is toggled by one compare match signal (the initial value of the toggle output can be set).
- Counter can be reset by the compare match signal.
- Two interrupt sources: counter overflow and compare match.

Block Diagram

Figure 9.4 shows a block diagram of timer F.

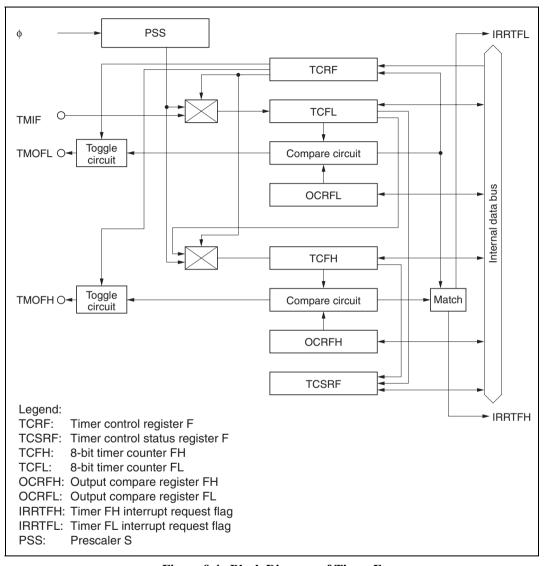


Figure 9.4 Block Diagram of Timer F

Pin Configuration

Table 9.11 shows the timer F pin configuration.

Table 9.11 Pin Configuration

| Name | Abbr. | I/O | Function |
|---------------------|-------|--------|------------------------|
| Timer F event input | TMIF | Input | Event input to TCFL |
| Timer FH output | TMOFH | Output | Timer FH toggle output |
| Timer FL output | TMOFL | Output | Timer FL toggle output |

Register Configuration:

Table 9.12 shows the register configuration of timer F.

Table 9.12 Timer F Registers

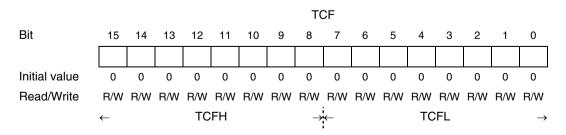
| Name | Abbr. | R/W | Initial Value | Address |
|---------------------------------|-------|-----|---------------|---------|
| Timer control register F | TCRF | W | H'00 | H'FFB6 |
| Timer control/status register F | TCSRF | R/W | H'00 | H'FFB7 |
| 8-bit timer counter FH | TCFH | R/W | H'00 | H'FFB8 |
| 8-bit timer counter FL | TCFL | R/W | H'00 | H'FFB9 |
| Output compare register FH | OCRFH | R/W | H'FF | H'FFBA |
| Output compare register FL | OCRFL | R/W | H'FF | H'FFBB |

9.5.2 Register Descriptions

16-Bit Timer Counter (TCF)

8-Bit Timer Counter (TCFH)

8-Bit Timer Counter (TCFL)



TCF is a 16-bit read/write up-counter consisting of two cascaded 8-bit timer counters, TCFH and TCFL. TCF can be used as a 16-bit counter, with TCFH as the upper 8 bits and TCFL as the lower 8 bits of the counter, or TCFH and TCFL can be used as independent 8-bit counters.

TCFH and TCFL can be read and written by the CPU, but in 16-bit mode, data transfer with the CPU takes place via a temporary register (TEMP). For details see section 9.5.3, Interface with the CPU.

Upon reset, TCFH and TCFL are each initialized to H'00.

• 16-bit mode (TCF)

16-bit mode is selected by clearing bit CKSH2 to 0 in timer control register F (TCRF). The TCF input clock is selected by TCRF bits CKSL2 to CKSL0.

TCFH can be cleared by a compare match signal. This designation is made in bit CCLRH in TCSRF.

When TCF overflows from H'FFFF to H'0000, the overflow flag (OVFH) in TCSRF is set to 1. If bit OVIEH in TCSRF is set to 1 when an overflow occurs, bit IRRTFH in interrupt request register 2 (IRR2) will be set to 1; and if bit IENTFH in interrupt enable register 2 (IENR2) is set to 1, a CPU interrupt will be requested.

• 8-bit mode (TCFH, TCFL)

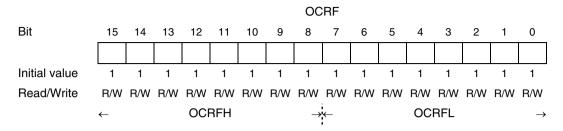
When bit CKSH2 in timer control register F (TCRF) is set to 1, timer F functions as two separate 8-bit counters, TCFH and TCFL. The TCFH (TCFL) input clock is selected by TCRF bits CKSH2 to CKSH0 (CKSL2 to CKSL0).

TCFH (TCFL) can be cleared by a compare match signal. This designation is made in bit CCLRH (CCLRL) in TCSRF.

When TCFH (TCFL) overflows from H'FF to H'00, the overflow flag OVFH (OVFL) in TCSRF is set to 1. If bit OVIEH (OVIEL) in TCSRF is set to 1 when an overflow occurs, bit IRRTFH (IRRTHL) in interrupt request register 2 (IRR2) will be set to 1; and if bit IENTFH (IENTFL) in interrupt enable register 2 (IENR2) is set to 1, a CPU interrupt will be requested.



16-Bit Output Compare Register (OCRF) 8-Bit Output Compare Register (OCRFH) 8-Bit Output Compare Register (OCRFL)



OCRF is a 16-bit read/write output compare register consisting of two 8-bit read/write registers OCRFH and OCRFL. It can be used as a 16-bit output compare register, with OCRFH as the upper 8 bits and OCRFL as the lower 8 bits of the register, or OCRFH and OCRFL can be used as independent 8-bit registers.

OCRFH and OCRFL can be read and written by the CPU, but in 16-bit mode, data transfer with the CPU takes place via a temporary register (TEMP). For details see section 9.5.3, Interface with the CPU.

Upon reset, OCRFH and OCRFL are each initialized to H'FF.

• 16-bit mode (OCRF)

16-bit mode is selected by clearing bit CKSH2 to 0 in timer control register F (TCRF). The OCRF contents are always compared with the 16-bit timer counter (TCF). When the contents match, the compare match flag (CMFH) in TCSRF is set to 1. Also, IRRTFH in interrupt request register 2 (IRR2) is set to 1. If bit IENTFH in interrupt enable register 2 (IENR2) is set to 1, a CPU interrupt is requested.

Output for pin TMOFH can be toggled by compare match. The output level can also be set to high or low by bit TOLH of timer control register F (TCRF).

• 8-bit mode (OCRFH, OCRFL)

Setting bit CKSH2 in TCRF to 1 results in two 8-bit registers, OCRFH and OCRFL.

The OCRFH contents are always compared with TCFH, and the OCRFL contents are always compared with TCFL. When the contents match, the compare match flag (CMFH or CMFL) in TCSRF is set to 1. Also, bit IRRTFH (IRRTFL) in interrupt request register 2 (IRR2) set to 1. If bit IENTFH (IENTFL) in interrupt enable register 2 (IENR2) is set to 1 at this time, a CPU interrupt is requested.

The output at pin TMOFH (TMOFL) can be toggled by compare match. The output level can also be set to high or low by bit TOLH (TOLL) of the timer control register (TCRF).

Timer Control Register F (TCRF)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|-------|-------|-------|------|-------|-------|-------|
| | TOLH | CKSH2 | CKSH1 | CKSH0 | TOLL | CKSL2 | CKSL1 | CKSL0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

TCRF is an 8-bit write-only register. It is used to switch between 16-bit mode and 8-bit mode, to select among four internal clocks and an external clock, and to select the output level at pins TMOFH and TMOFL.

Upon reset, TCRF is initialized to H'00.

Bit 7—Toggle Output Level H (TOLH): Bit 7 sets the output level at pin TMOFH. The setting goes into effect immediately after this bit is written.

| Bit 7: TOLH | Description | |
|-------------|-------------|-----------------|
| 0 | Low level | (initial value) |
| 1 | High level | |

Bits 6 to 4—Clock Select H (CKSH2 to CKSH0): Bits 6 to 4 select the input to TCFH from four internal clock signals or the overflow of TCFL.

| Bit 6: CKSH2 | Bit 5: CKSH1 | Bit 4: CKSH0 | Description |
|--------------|--------------|--------------|---|
| 0 | * | * | 16-bit mode selected. TCFL overflow signals are counted (initial value) |
| 1 | 0 | 0 | Internal clock: $\phi/32$ |
| | | 1 | Internal clock: $\phi/16$ |
| | 1 | 0 | Internal clock: φ/4 |
| | | 1 | Internal clock: φ/2 |

Legend: * Don't care

Bit 3—Toggle Output Level L (TOLL): Bit 3 sets the output level at pin TMOFL. The setting goes into effect immediately after this bit is written.

| Description | |
|-------------|-----------------|
| Low level | (initial value) |
| High level | |
| | Low level |

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Bits 2 to 0—Clock Select L (CKSL2 to CKSL0): Bits 2 to 0 select the input to TCFL from four internal clock signals or external event input.

| Bit 2: CKSL2 | Bit 1: CKSL1 | Bit 0: CKSL0 | Description |
|--------------|--------------|--------------|--|
| 0 | * | * | External event (TMIF). Rising or falling edge is counted* ¹ (initial value) |
| 1 | 0 | 0 | Internal clock: $\phi/32$ |
| | | 1 | Internal clock: $\phi/16$ |
| | 1 | 0 | Internal clock: $\phi/4$ |
| | | 1 | Internal clock: $\phi/2$ |

Legend: * Don't care

Note:

1. The edge of the external event signal is selected by bit IEG3 in the IRQ edge select register (IEGR). See section 3.3.2, Interrupt Control Registers for details on the IRQ edge select register. Note that switching the TMIF pin function by changing bit IRQ3 in port mode register 1 (PMR1) from 0 to 1 or from 1 to 0 while the TMIF pin is at the low level may cause the timer F counter to be incremented.

Timer Control/Status Register F (TCSRF)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------------|--------------|-----------|-------|------|------|-------|-------|
| | OVFH | CMFH | OVIEH | CCLRH | OVFL | CMFL | OVIEL | CCLRL |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W* | R/W* | R/W | R/W | R/W* | R/W* | R/W | R/W |
| Note: * Only | 0 can be w | ritten to cl | ear flag. | | | | | |

TCSRF is an 8-bit read/write register. It is used for counter clear selection, overflow and compare match indication, and enabling of interrupts caused by timer overflow.

Upon reset, TCSRF is initialized to H'00.

Bit 7—Timer overflow flag H (OVFH): Bit 7 is a status flag indicating TCFH overflow (H'FF to H'00). This flag is set by hardware and cleared by software. It cannot be set by software.

| Bit 7: OVFH | Description | |
|-------------|--|-----------------|
| 0 | Clearing condition: After reading OVFH = 1, cleared by writing 0 to OVFH | (initial value) |
| 1 | Setting condition: Set when the value of TCFH goes from H'FF to H'00 | |

Bit 6—Compare Match Flag H (CMFH): Bit 6 is a status flag indicating a compare match between TCFH and OCRFH. This flag is set by hardware and cleared by software. It cannot be set by software.

| Bit 6: CMFH | Description | |
|-------------|--|-----------------|
| 0 | Clearing condition: After reading CMFH = 1, cleared by writing 0 to CMFH | (initial value) |
| 1 | Setting condition: Set when the TCFH value matches OCRFH value | |

Bit 5—Timer Overflow Interrupt Enable H (OVIEH): Bit 5 enables or disables TCFH overflow interrupts.

| Bit 5: OVIEH | Description | |
|--------------|----------------------------------|-----------------|
| 0 | TCFH overflow interrupt disabled | (initial value) |
| 1 | TCFH overflow interrupt enabled | |

Bit 4—Counter Clear H (CCLRH): In 16-bit mode, bit 4 selects whether or not TCF is cleared when a compare match occurs between TCF and OCRF.

In 8-bit mode, bit 4 selects whether or not TCFH is cleared when a compare match occurs between TCFH and OCRFH.

| Bit 4: CCLRH | Description | |
|--------------|---|-----------------|
| 0 | 16-bit mode: TCF clearing by compare match disabled | (initial value) |
| | 8-bit mode: TCFH clearing by compare match disabled | |
| 1 | 16-bit mode: TCF clearing by compare match enabled | |
| | 8-bit mode: TCFH clearing by compare match enabled | |

Bit 3—Timer Overflow Flag L (OVFL): Bit 3 is a status flag indicating TCFL overflow (H'FF to H'00). This flag is set by hardware and cleared by software. It cannot be set by software.

| Bit 3: OVFL | Description | |
|-------------|--|-----------------|
| 0 | Clearing condition: After reading OVFL = 1, cleared by writing 0 to OVFL | (initial value) |
| 1 | Setting condition: Set when the value of TCFL goes from H'FF to H'00 | |



Bit 2—Compare Match Flag L (CMFL): Bit 2 is a status flag indicating a compare match between TCFL and OCRFL. This flag is set by hardware and cleared by software. It cannot be set by software.

| Bit 2: CMFL | Description | |
|-------------|--|-----------------|
| 0 | Clearing condition: After reading CMFL = 1, cleared by writing 0 to CMFL | (initial value) |
| 1 | Setting condition: Set when the TCFL value matches the OCRFL value | |

Bit 1—Timer Overflow Interrupt Enable L (OVIEL): Bit 1 enables or disables TCFL overflow interrupts.

| Bit 1: OVIEL | Description | |
|--------------|----------------------------------|-----------------|
| 0 | TCFL overflow interrupt disabled | (initial value) |
| 1 | TCFL overflow interrupt enabled | _ |

Bit 0—Counter Clear L (CCLRL): Bit 0 selects whether or not TCFL is cleared when a compare match occurs between TCFL and OCRFL.

| Bit 0: CCLRL | Description | |
|--------------|---|-----------------|
| 0 | TCFL clearing by compare match disabled | (initial value) |
| 1 | TCFL clearing by compare match enabled | |

9.5.3 Interface with the CPU

TCF and OCRF are 16-bit read/write registers, whereas the data bus between the CPU and on-chip peripheral modules has an 8-bit width. For this reason, when the CPU accesses TCF or OCRF, it makes use of an 8-bit temporary register (TEMP).

In 16-bit mode, when reading or writing TCF or writing OCRF, always use two consecutive byte size MOV instructions, and always access the upper byte first. Data will not be transferred properly if only the upper byte or only the lower byte is accessed. In 8-bit mode there is no such restriction on the order of access.

Write Access: When the upper byte is written, the upper-byte data is loaded into the TEMP register. Next when the lower byte is written, the data in TEMP goes to the upper byte of the register, and the lower-byte data goes directly to the lower byte of the register. Figure 9.5 shows a TCF write operation when H'AA55 is written to TCF.

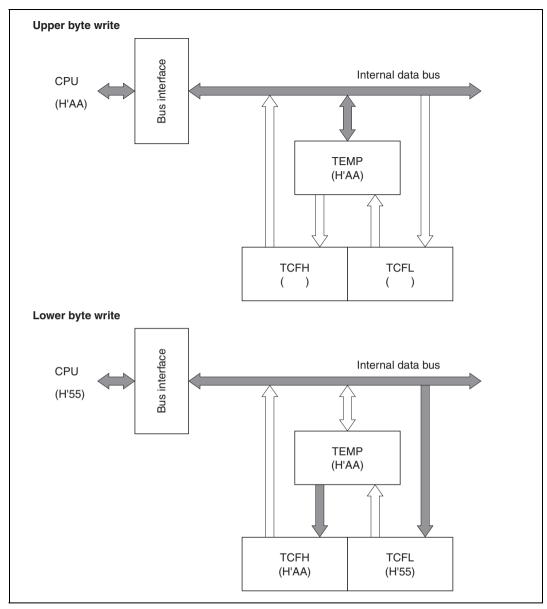


Figure 9.5 TCF Write Operation (CPU \rightarrow TCF)

Read Access: When the upper byte of TCF is read, the upper-byte data is sent directly to the CPU, and the lower byte is loaded into TEMP. Next when the lower byte is read, the lower byte in TEMP is sent to the CPU.

When the upper byte of OCRF is read, the upper-byte data is sent directly to the CPU. Next when the lower byte is read, the lower-byte data is sent directly to the CPU.

Figure 9.6 shows a TCF read operation when H'AAFF is read from TCF.

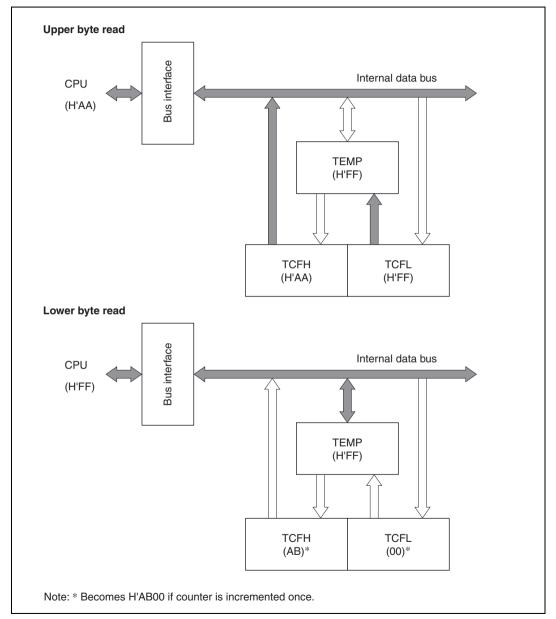


Figure 9.6 TCF Read Operation (TCF \rightarrow CPU)

9.5.4 Timer Operation

Timer F is a 16-bit timer/counter that increments with each input clock. The value set in output compare register F is constantly compared with the value of timer counter F, and when they match the counter can be cleared, an interrupt can be requested, and the port output can be toggled. Timer F can also be used as two independent 8-bit timers.

Timer F Operation: Timer F can operate in either 16-bit timer mode or 8-bit timer mode. These modes are described below.

• 16-bit timer mode

Timer F operates in 16-bit timer mode when the CKSH2 bit in timer control register F (TCRF) is cleared to 0.

A reset initializes timer counter F (TCF) to H'0000, output compare register F (OCRF) to H'FFFF, and timer control register F (TCRF) and timer control status register F (TCSRF) to H'00. Timer F begins counting external event input signals (TMIF). The edge of the external event signal is selected by the IEG3 bit in the IRQ edge select register (IEGR).

Any of four internal clocks output by prescaler S, or an external clock, can be selected as the timer F operating clock by bits CKSL2 to CKSL0 in TCRF.

TCF is continuously compared with the contents of OCRF. When these two values match, the CMFH bit in TCSRF is set to 1. At this time if IENTFH of IENR2 is 1, a CPU interrupt is requested and the output at pin TMOFH is toggled. If the CCLRH bit in TCSRF is 1, timer F is cleared. The output at pin TMOFH can also be set by the TOLH bit in TCRF.

If timer F overflows (from H'FFFF to H'0000), the OVFH bit in TCSRF is set. At this time, if the OVIEH bit in TCSRF and the IENTFH bit in IENR2 are both 1, a CPU interrupt is requested.

• 8-bit timer mode

When the CKSH2 bit in TCRF is set to 1, timer F operates as two independent 8-bit timers, TCFH and TCFL. The input clock of TCFH/TCFL is selected by bits CKSH2 to CKSH0/CKSL2 to CKSL0 in TCRF.

When TCFH/TCFL and the contents of OCRFH/OCRFL match, the CMFH/CMFL bit in TCSRF is set to 1. If the IENTFH/IENTFL bit in IENR2 is 1, a CPU interrupt is requested and the output at pin TMOFH/TMOFL is toggled. If the CCLRH/CCLRL bit in TCRF is 1, TCFH/TCFL is cleared. The output at pin TMOFH/TMOFL can also be set by the TOLH/TOLL bit in TCRF.

When TCFH/TCFL overflows from H'FF to H'00, the OVFH/OVFL bit in TCSRF is set to 1. At this time, if the OVIEH/OVIEL bit in TCSRF and the IENTFH/IENTFL bit in IENR2 are both 1, a CPU interrupt is requested.



TCF Count Timing: TCF is incremented by each pulse of the input clock (internal or external clock).

Internal clock

The settings of bits CKSH2 to CKSH0 or bits CKSL2 to CKSL0 in TCRF select one of four internal clock signals divided from the system clock (ϕ), namely, ϕ /32, ϕ /16, ϕ /4, or ϕ /2.

External clock

External clock input is selected by clearing bit CKSL2 to 0 in TCRF. Either rising or falling edges of the clock input can be counted. The edge of an external event is selected by bit IEG3 in the interrupt controller's IEGR register. An external event pulse width of at least two system clock (ϕ) cycles is necessary for correct operation of the counter.

TMOFH and **TMOFL** Output Timing: The outputs at pins TMOFH and TMOFL are the values set in bits TOLH and TOLL in TCRF. When a compare match occurs, the output value is inverted. Figure 9.7 shows the output timing.

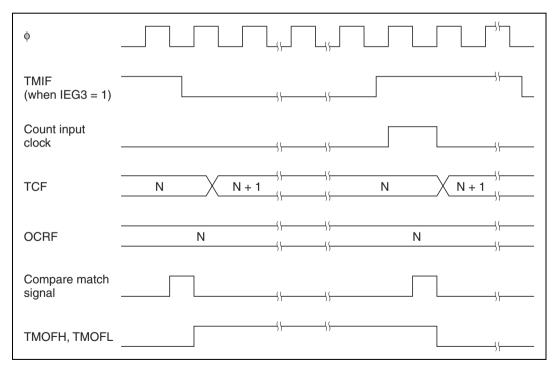


Figure 9.7 TMOFH, TMOFL Output Timing

TCF Clear Timing: TCF can be cleared at compare match with OCRF.

Timer Overflow Flag (OVF) Set Timing: OVF is set to 1 when TCF overflows (goes from H'FFFF to H'0000).

Compare Match Flag Set Timing: The compare match flags (CMFH or CMFL) are set to 1 when a compare match occurs between TCF and OCRF. A compare match signal is generated in the final state in which the values match (when TCF changes from the matching count value to the next value). When TCF and OCRF match, a compare match signal is not generated until the next counter clock pulse.

Timer F Operation States: Table 9.13 summarizes the timer F operation states.

Table 9.13 Timer F Operation States

| Operation Mode | Reset | Active | Sleep | Watch | Sub- active | Sub- sleep | Standby |
|----------------|-------|-----------|-----------|----------|----------------|---------------|----------|
| TCF | Reset | Functions | Functions | Halted | Halted | Halted | Halted |
| OCRF | Reset | Functions | Retained | Retained | Retained | Retained | Retained |
| TCRF | Reset | Functions | Retained | Retained | Retained | Retained | Retained |
| TCSRF | Reset | Functions | Retained | Retained | Retained | Retained | Retained |

9.5.5 Application Notes

The following conflicts can arise in timer F operation.

• 16-bit timer mode

The output at pin TMOFH toggles when all 16 bits match and a compare match signal is generated. If the compare match signal occurs at the same time as new data is written in TCRF by a MOV instruction, however, the new value written in bit TOLH will be output at pin TMOFH. The TMOFL output in 16-bit mode is indeterminate, so this output should not be used. Use the pin as a general input or output port.

If an OCRFL write occurs at the same time as a compare match signal, the compare match signal is inhibited. If a compare match occurs between the written data and the counter value, however, a compare match signal will be generated at that point. The compare match signal is output in synchronization with the TCFL clock, so if this clock is stopped no compare match signal will be generated, even if a compare match occurs.

Compare match flag CMFH is set when all 16 bits match and a compare match signal is generated; bit CMFL is set when the setting conditions are met for the lower 8 bits.

The overflow flag (OVFH) is set when TCF overflows; bit OVFL is set if the setting conditions are met when the lower 8 bits overflow. If a write to TCFL occurs at the same time as an overflow signal, the overflow signal is not output.



8-bit timer mode

TCFH and OCRFH

The output at pin TMOFH toggles when there is a compare match. If the compare match signal occurs at the same time as new data is written in TCRF by a MOV instruction, however, the new value written in bit TOLH will be output at pin TMOFH.

If an OCRFH write occurs at the same time as a compare match signal, the compare match signal is inhibited. If a compare match occurs between the written data and the counter value, however, a compare match signal will be generated at that point. The compare match signal is output in synchronization with the TCFH clock.

If a TCFH write occurs at the same time as an overflow signal, the overflow signal is not output.

TCFL and OCRFL

The output at pin TMOFL toggles when there is a compare match. If the compare match signal occurs at the same time as new data is written in TCRF by a MOV instruction, however, the new value written in bit TOLL will be output at pin TMOFL.

If an OCRFL write occurs at the same time as a compare match signal, the compare match signal is inhibited. If a compare match occurs between the written data and the counter value, however, a compare match signal will be generated at that point. The compare match signal is output in synchronization with the TCFL clock, so if this clock is stopped no compare match signal will be generated, even if a compare match occurs.

If a TCFL write occurs at the same time as an overflow signal, the overflow signal is not output.

9.6 Watchdog Timer [H8/3857F and H8/3854F Only]

9.6.1 Overview

The watchdog timer (WDT) is equipped with an 8-bit counter that is incremented by an input clock. An internal chip reset can be executed if the counter overflows because it is not updated normally due to a system crash, etc.

This watchdog timer is used by the flash memory programming control program.

Features

Features of the watchdog timer are given below.

- Choice of eight internal clock sources (φ/64, φ/128, φ/256, φ/512, φ/1024, φ/2048, φ/4096, φ/8192)
- Reset signal generated on counter overflow

An overflow period of 1 to 256 times the selected clock can be set.

Block Diagram

Figure 9.8 shows a block diagram of the watchdog timer.

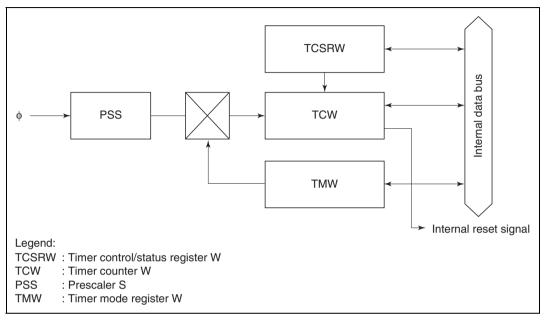


Figure 9.8 Block Diagram of Watchdog Timer

Register Configuration

Table 9.14 shows the watchdog timer register configuration. These registers are valid only in the F-ZTAT version. In the mask ROM version, read accesses to the corresponding addresses will always return 1, and writes are invalid.

Table 9.14 Watchdog Timer Registers

| Name | Abbr. | R/W | Initial Value | Address |
|---------------------------------|-------|-----|---------------|---------|
| Timer control/status register W | TCSRW | R/W | H'AA | H'FF90 |
| Timer counter W | TCW | R/W | H'00 | H'FF91 |
| Timer mode register W | TMW | R/W | H'FF | H'FF92 |

9.6.2 **Register Descriptions**

Timer Control/Status Register W (TCSRW)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|--------|------|--------|------|--------|------|--------|
| | B6WI | TCWE | B4WI | TCSRWE | B2WI | WDON | BOWI | WRST |
| Initial value | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 |
| Read/Write | R | R/(W)* | R | R/(W)* | R | R/(W)* | R | R/(W)* |

Note: * Can be written to only when the write condition is satisfied. For the write conditions, see the individual bit descriptions.

TCSRW is an 8-bit read/write register that performs TCSRW and TCW write control and watchdog timer operation control, and indicates the operation status.

Bit 7—Bit 6 Write Inhibit (B6WI): Bit 7 controls writing of data to bit 6 of TCSRW.

Bit 7: B6WI Description

| 0 | Writing to bit 6 is enabled | |
|---|------------------------------|-----------------|
| 1 | Writing to bit 6 is disabled | (initial value) |

This bit is always read as 1. Data is not stored if written to this bit.

Bit 6—Timer Counter W Write Enable (TCWE): Bit 6 controls writing of 8-bit data to TCW.

Bit 6: TCWE Description

| 0 | Writing of 8-bit data to TCW is disabled | (initial value) |
|---|--|-----------------|
| 1 | Writing of 8-bit data to TCW is enabled | _ |

Bit 5—Bit 4 Write Inhibit (B4WI): Bit 5 controls writing of data to bit 4 of TCSRW.

Description Bit 5: B4WI

| 0 | Writing to bit 4 is enabled | |
|---|------------------------------|-----------------|
| 1 | Writing to bit 4 is disabled | (initial value) |

RENESAS

This bit is always read as 1. Data is not stored if written to this bit.

Bit 4—Timer Control/Status Register W Write Enable (TCSRWE): Bit 4 controls writing of data to bits 2 and 0 of TCSRW.

Bit 4: TCSRWE Description

| 0 | Writing to bits 2 and 0 is disabled | (initial valu |
|---|-------------------------------------|---------------|
| 1 | Writing to bits 2 and 0 is enabled | |

Bit 3—Bit 2 Write Inhibit (B2WI): Bit 3 controls writing of data to bit 2 of TCSRW.

Bit 3: B2WI Description

| 0 | Writing to bit 2 is enabled | |
|---|------------------------------|-----------------|
| 1 | Writing to bit 2 is disabled | (initial value) |

This bit is always read as 1. Data is not stored if written to this bit.

Bit 2—Watchdog Timer On (WDON): Bit 2 controls watchdog timer operation.

Bit 2: WDON Description

| 0 | Watchdog timer operation is disabled (in | itial value) |
|---|--|--------------|
| | [Clearing condition] | |
| | In a reset, or when 0 is written to WDON while writing 0 to B2WI when TC | SRWE = 1 |
| 1 | Watchdog timer operation is enabled | |
| | [Setting condition] | |
| | When 1 is written to WDON while writing 0 to B2WI when TCSRWE = 1 | |

The count-up starts when this bit is set to 1, and stops when it is cleared to 0.

Bit 1—Bit 0 Write Inhibit (B0WI): Bit 1 controls writing of data to bit 0 of timer control/status register W.

Bit 1: B0WI Description

| 0 | Writing to bit 0 is enabled | |
|---|------------------------------|-----------------|
| 1 | Writing to bit 0 is disabled | (initial value) |

This bit is always read as 1. Data is not stored if written to this bit.



Bit 0—Watchdog Timer Reset (WRST): Bit 0 indicates that TCW has overflowed and an internal reset signal has been generated. The internal reset signal generated by the overflow resets the entire chip.

WRST is cleared by a reset via the \overline{RES} pin or by a 0 write by software.

Bit 0: WRST Description

| 0 | [Clearing conditions] (initial value) |
|---|---|
| | Reset by RES pin |
| | When 0 is written to WRST while writing 0 to B0WI when TCSRWE = 1 |
| 1 | [Setting condition] |
| | When TCW overflows and an internal reset signal is generated |

Timer Counter W (TCW)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TCW7 | TCW6 | TCW5 | TCW4 | TCW3 | TCW2 | TCW1 | TCW0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W |

TCW is an 8-bit read/write up-counter that is incremented by an input internal clock. The TCW value can be read or written by the CPU at any time.

When TCW overflows (from H'FF to H'00), an internal reset signal is generated and WRST in TCSRW is set to 1. Upon reset, TCW is initialized to H'00.

Timer Mode Register W (TMW)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|------|------|------|
| | _ | _ | _ | | _ | CKS2 | CKS1 | CKS0 |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | _ | _ | _ | _ | _ | R/W | R/W | R/W |

TMW is an 8-bit read/write register that selects the input clock.

Upon reset, TMW is initialized to H'FF.

Bits 7 to 3—Reserved Bits: Bits 7 to 3 are reserved; they are always read as 1 and cannot be modified.

Bits 2 to 0—Clock Select 2 to 0 (CKS2 to CKS0): Bits 2 to 0 select the clock to be input to TCW.

| Bit 2: CKS2 | Bit 1: CKS1 | Bit 0: CKS0 | Description | |
|----------------|----------------|----------------|-----------------------------|-----------------|
| 0 | 0 | 0 | Internal clock: $\phi/64$ | _ |
| | | 1 | Internal clock: $\phi/128$ | |
| | 1 | 0 | Internal clock: $\phi/256$ | |
| | | 1 | Internal clock: $\phi/512$ | |
| 1 | 0 | 0 | Internal clock: $\phi/1024$ | |
| | | 1 | Internal clock: $\phi/2048$ | |
| | 1 | 0 | Internal clock: $\phi/4096$ | |
| | | 1 | Internal clock: $\phi/8192$ | (initial value) |

9.6.3 Operation

The watchdog timer is provided with an 8-bit counter that increments with each input clock pulse. If 1 is written to WDON while writing 0 to B2WI when TCSRWE in TCSRW is set to 1, TCW begins counting up. When a clock pulse is input after the TCW count value has reached H'FF, the watchdog timer overflows and an internal reset signal is generated one base clock (ϕ) cycle later. The internal reset signal is output for a period of 512 ϕ_{osc} clock cycles. TCW is a writable counter, and when a value is set in TCW, the count-up starts from that value. An overflow period in the range of 1 to 256 input clock cycles can therefore be set, according to the TCW value.

Figure 9.9 shows an example of watchdog timer operation.



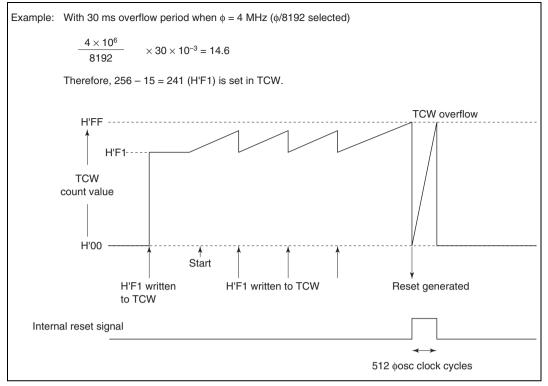


Figure 9.9 Example of Watchdog Timer Operation

9.6.4 Watchdog Timer Operating Modes

Watchdog timer operating modes are shown in table 9.15.

Table 9.15 Watchdog Timer Operating Modes

| Operating mode | Reset | Active | Sleep | Watch | Subactive | Subsleep | Standby |
|----------------|-------|-----------|-----------|----------|-----------|----------|----------|
| TCW | Reset | Functions | Functions | Halted | Halted | Halted | Halted |
| TCSRW | Reset | Functions | Functions | Retained | Retained | Retained | Retained |
| TMW | Reset | Functions | Retained | Retained | Retained | Retained | Retained |

Section 10 Serial Communication Interface

10.1 Overview

The H8/3857 Group is provided with a two-channel serial communication interface (SCI), and the H8/3854 Group with a single-channel SCI. Table 10.1 summarizes the functions and features of the SCI channels.

Table 10.1 Serial Communication Interface Functions

| Channel | Functions | Features | | | |
|---------|---|---|--|--|--|
| SCI1* | Synchronous serial transfer Choice of 8-bit or 16-bit data | Choice of 8 internal clocks (φ/1024 to φ/2) or external clock | | | |
| | length | Open drain output possible | | | |
| | Continuous clock output | Interrupt requested at completion of transfer | | | |
| SCI3 | Synchronous serial transfer | Built-in baud rate generator | | | |
| | 8-bit data transfer | Receive error detection | | | |
| | • Send, receive, or simultaneous | Break detection | | | |
| | send/receive | Interrupt requested at completion of | | | |
| | Asynchronous serial transfer | transfer or error | | | |
| | Multiprocessor communication function | | | | |
| | Choice of 7-bit or 8-bit data length | | | | |
| | Choice of 1-bit or 2-bit stop bit length | | | | |
| | Parity addition | | | | |

Note: * SCI1 is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

10.2 SCI1 (H8/3857 Group Only)

10.2.1 Overview

Serial communication interface 1 (SCII) performs synchronous serial transfer of 8-bit or 16-bit data.

SCI1 is a function of the H8/3857 Group only, and is not provided in the H8/3854 Group.

Features

Features of SCI1 are as follows.

- Choice of 8-bit or 16-bit transfer data length
- Choice of eight internal clock sources (φ/1024, φ/256, φ/64, φ/32, φ/16, φ/8, φ/4, φ/2) or an external clock
- Interrupt requested at completion of transfer

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Block Diagram

Figure 10.1 shows a block diagram of SCI1.

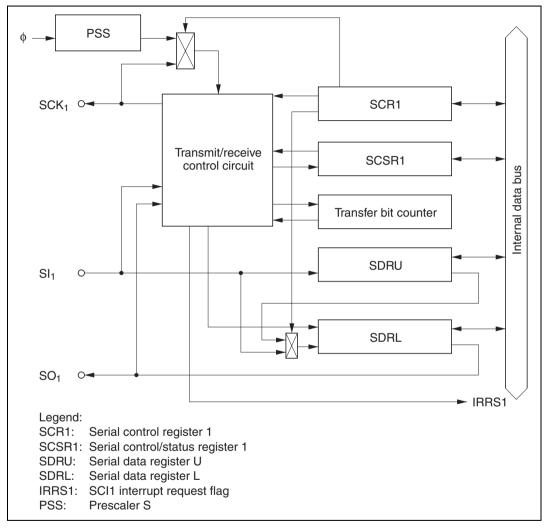


Figure 10.1 SCI1 Block Diagram

Pin Configuration

Table 10.2 shows the SCI1 pin configuration.

Table 10.2 Pin Configuration

| Name | Abbr. | I/O | Function |
|----------------------|-----------------|--------|----------------------------|
| SCI1 clock pin | SCK, | I/O | SCI1 clock input or output |
| SCI1 data input pin | SI ₁ | Input | SCI1 receive data input |
| SCI1 data output pin | SO ₁ | Output | SCI1 transmit data output |

Register Configuration

Table 10.3 shows the SCI1 register configuration.

Table 10.3 SCI1 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|----------------------------------|-------|-----|---------------|---------|
| Serial control register 1 | SCR1 | R/W | H'00 | H'FFA0 |
| Serial control status register 1 | SCSR1 | R/W | H'80 | H'FFA1 |
| Serial data register U | SDRU | R/W | Undefined | H'FFA2 |
| Serial data register L | SDRL | R/W | Undefined | H'FFA3 |

10.2.2 Register Descriptions

Serial Control Register 1 (SCR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-----|-----|------|------|------|------|
| | SNC1 | SNC0 | _ | _ | CKS3 | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

SCR1 is an 8-bit read/write register for selecting the operation mode, the transfer clock source, and the prescaler division ratio.

Upon reset, SCR1 is initialized to H'00. Writing to this register during a transfer stops the transfer.

Bits 7 and 6—Operation Mode Select 1, 0 (SNC1, SNC0): Bits 7 and 6 select the operation mode.

| Bit 7: SNC1 | Bit 6: SNC0 | Description | |
|-------------|-------------|----------------------------------|-----------------|
| 0 | 0 | 8-bit synchronous transfer mode | (initial value) |
| | 1 | 16-bit synchronous transfer mode | |
| 1 | 0 | Continuous clock output mode*1 | |
| | 1 | Reserved* ² | |

Notes: 1. Pins SI, and SO, should be used as general input or output ports.

2. Don't set bits SNC1 and SNC0 to 11.

Bits 5 and 4—Reserved Bits: Bits 5 and 4 are reserved; they should always be cleared to 0.

Bit 3—Clock Source Select 3 (CKS3): Bit 3 selects the clock source and sets pin SCK₁ as an input or output pin.

| Bit 3: CKS3 | Description | |
|-------------|---|-----------------|
| 0 | Clock source is prescaler S, and pin SCK, is output pin | (initial value) |
| 1 | Clock source is external clock, and pin SCK, is input pin | |

Bits 2 to 0—Clock Select 2 to 0 (CKS2 to CKS 0): When CKS3 = 0, bits 2 to 0 select the prescaler division ratio and the serial clock cycle.

| | | | | Serial C | Clock Cycle |
|-------------|-------------|-------------|---------------------------|-----------|-------------|
| Bit 2: CKS2 | Bit 1: CKS1 | Bit 0: CKS0 | Prescaler Division | φ = 5 MHz | φ = 2.5 MHz |
| 0 | 0 | 0 | φ/1024 (initial value) | 204.8 μs | 409.6 μs |
| | | 1 | ф/256 | 51.2 μs | 102.4 μs |
| | 1 | 0 | φ/64 | 12.8 μs | 25.6 μs |
| | | 1 | ф/32 | 6.4 μs | 12.8 μs |
| 1 | 0 | 0 | φ/16 | 3.2 μs | 6.4 μs |
| | | 1 | φ/8 | 1.6 μs | 3.2 μs |
| | 1 | 0 | φ/4 | 0.8 μs | 1.6 μs |
| | | 1 | φ/2 | _ | 0.8 μs |
| | | | | | |

Serial Control/Status Register 1 (SCSR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|-----|--------|---|---|---|-----|-----|
| | _ | SOL | ORER | _ | _ | _ | _ | STF |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | R/W | R/(W)* | _ | _ | _ | R/W | R/W |

Note: * Only a write of 0 for flag clearing is possible.

SCSR1 is an 8-bit read/write register indicating operation status and error status.

Upon reset, SCSR1 is initialized to H'80.

Do not read or write to SCSR1 during a transfer operation, as this will cause erroneous operation.

Bit 7—Reserved Bit: Bit 7 is reserved; it is always read as 1, and cannot be modified.

Bit 6—Extended Data Bit (SOL): Bit 6 sets the SO₁ output level. When read, SOL returns the output level at the SO₁ pin. After completion of a transmission, SO₁ continues to output the value of the last bit of transmitted data. The SO₁ output can be changed by writing to SOL before or after a transmission. The SOL bit setting remains valid only until the start of the next transmission. To control the level of the SO₁ pin after transmission ends, it is necessary to write to the SOL bit at the end of each transmission. Do not write to this register while transmission is in progress, because that may cause a malfunction.

| Bit 6: SOL | Description | |
|------------|---|-----------------|
| 0 | Read: SO, pin output level is low | (initial value) |
| | Write: SO, pin output level changes to low | |
| 1 | Read: SO, pin output level is high | |
| | Write: SO, pin output level changes to high | |

Bit 5—Overrun Error Flag (ORER): When an external clock is used, bit 5 indicates the occurrence of an overrun error. If a clock pulse is input after transfer completion, this bit is set to 1 indicating an overrun. If noise occurs during a transfer, causing an extraneous pulse to be superimposed on the normal serial clock, incorrect data may be transferred.

| Bit 5: ORER | Description |
|-------------|--|
| 0 | Clearing condition: After reading ORER = 1, cleared by writing 0 to ORER (initial value) |
| 1 | Setting condition: Set if a clock pulse is input after transfer is complete, when an external clock is used |

Bits 4 to 2—Reserved Bits: Bits 4 to 2 are reserved; they are always read as 0, and cannot be modified.

Bit 1—Reserved Bit: Bit 1 is reserved; it should always be cleared to 0.

Bit 0—Start Flag (STF): Bit 0 controls the start of a transfer. Setting this bit to 1 causes SCI1 to start transferring data.

This bit remains set to 1 during transfer or while waiting for a start bit, and is cleared to 0 upon completion of the transfer.

| Bit 0: STF | Description | |
|------------|--|-----------------|
| 0 | Read: Indicates that transfer is stopped | (initial value) |
| | Write: Invalid | |
| 1 | Read: Indicates transfer in progress | |
| | Write: Starts a transfer operation | |

Serial Data Register U (SDRU)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | SDRU7 | SDRU6 | SDRU5 | SDRU4 | SDRU3 | SDRU2 | SDRU1 | SDRU0 |
| Initial value | Undefined |
| Read/Write | R/W |

SDRU is an 8-bit read/write register. It is used as the data register for the upper 8 bits in 16-bit transfer (SDRL is used for the lower 8 bits).

Data written to SDRU is output to SDRL starting from the least significant bit (LSB). This data is then replaced by LSB-first data input at pin SI₁, which is shifted in the direction from the most significant bit (MSB) toward the LSB.

SDRU must be written or read only after data transmission or reception is complete. If this register is written or read while a data transfer is in progress, the data contents are not guaranteed.

The SDRU value upon reset is not fixed.

Serial Data Register L (SDRL)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | SDRL7 | SDRL6 | SDRL5 | SDRL4 | SDRL3 | SDRL2 | SDRL1 | SDRL0 |
| Initial value | Undefined |
| Read/Write | R/W |

SDRL is an 8-bit read/write register. It is used as the data register in 8-bit transfer, and as the data register for the lower 8 bits in 16-bit transfer (SDRU is used for the upper 8 bits).

In 8-bit transfer, data written to SDRL is output from pin SO₁ starting from the least significant bit (LSB). This data is than replaced by LSB-first data input at pin SI₁, which is shifted in the direction from the most significant bit (MSB) toward the LSB.

In 16-bit transfer, operation is the same as for 8-bit transfer, except that input data is fed in via SDRU.

SDRL must be written or read only after data transmission or reception is complete. If this register is read or written while a data transfer is in progress, the data contents are not guaranteed.

The SDRL value upon reset is not fixed.

10.2.3 Operation

Data can be sent and received in an 8-bit or 16-bit format, synchronized to an internal or external serial clock. Overrun errors can be detected when an external clock is used.

Clock

The serial clock can be selected from a choice of eight internal clocks and an external clock. When an internal clock source is selected, pin SCK_1 becomes the clock output pin. When continuous clock output mode is selected (SCR1 bits SNC1 and SNC0 are set to 10), the clock signal (ϕ /1024



to $\phi/2$) selected in bits CKS2 to CKS0 is output continuously from pin SCK₁. When an external clock is used, pin SCK₁ is the clock input pin.

Data Transfer Format

Figure 10.2 shows the data transfer format. Data is sent and received starting from the least significant bit, in LSB-first format. Transmit data is output from one falling edge of the serial clock until the next falling edge. Receive data is latched at the rising edge of the serial clock.

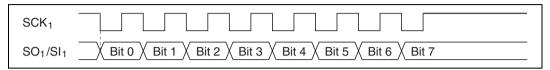


Figure 10.2 Transfer Format

Data Transfer Operations

Transmitting: A transmit operation is carried out as follows.

- Set bits SO1 and SCK1 in PMR3 TO 1 so that the respective pins function as SO₁ and SCK₁. If necessary, set bit POF1 in port mode register 2 (PMR2) for NMOS open drain output at pin SO₁.
- Clear bit SNC1 in SCR1 to 0, and set bit SNC0 to 1 or 0, designating 8- or 16-bit synchronous transfer mode. Select the serial clock in bits CKS3 to CKS0. Writing data to SCR1 initializes the internal state of SCI1.
- Write transmit data in SDRL and SDRU, as follows.
 - 8-bit transfer mode: SDRL
 - 16-bit transfer mode: Upper byte in SDRU, lower byte in SDRL
- Set the SCSR1 start flag (STF) to 1. SCI1 starts operating and outputs transmit data at pin SO₁.
- After data transmission is complete, bit IRRS1 in interrupt request register 1 (IRR1) is set to 1.

When an internal clock is used, a serial clock is output from pin SCK_1 in synchronization with the transmit data. After data transmission is complete, the serial clock is not output until the next time the start flag is set to 1. During this time, pin SO_1 continues to output the value of the last bit transmitted.

When an external clock is used, data is transmitted in synchronization with the serial clock input at pin SCK₁. After data transmission is complete, an overrun occurs if the serial clock continues to be input; no data is transmitted and the SCSR1 overrun error flag (bit ORER) is set to 1.

While transmission is stopped, the output value of pin SO₁ can be changed by rewriting bit SOL in SCSR1.

Receiving: A receive operation is carried out as follows.

- Set bits SI1 and SCK1 in PMR3 to 1 so that the respective pins function as SI, and SCK₁.
- Clear bit SNC1 in SCR1 to 0, and set bit SNC0 to 1 or 0, designating 8- or 16-bit synchronous transfer mode. Select the serial clock in bits CKS3 to CKS0. Writing data to SCR1 initializes the internal state of SCI1.
- Set the SCSR1 start flag (STF) to 1. SCI1 starts operating and receives data at pin SI₁.
- After data reception is complete, bit IRRS1 in interrupt request register 1 (IRR1) is set to 1.
- Read the received data from SDRL and SDRU, as follows.
 - 8-bit transfer mode: SDRL
 - 16-bit transfer mode: Upper byte in SDRU, lower byte in SDRL
- After data reception is complete, an overrun occurs if the serial clock continues to be input; no data is received and the SCSR1 overrun error flag (bit ORER) is set to 1.

Simultaneous transmit/receive: A simultaneous transmit/receive operation is carried out as follows.

- Set bits SO1, SI1, and SCK1 in PMR3 to 1 so that the respective pins function as SO₁, SI₁, and SCK₁. If necessary, set bit POF1 in port mode register 2 (PMR2) for NMOS open drain output at pin SO₁.
- Clear bit SNC1 in SCR1 to 0, and set bit SNC0 to 1 or 0, designating 8- or 16-bit synchronous transfer mode. Select the serial clock in bits CKS3 to CKS0. Writing data to SCR1 initializes the internal state of SCI1.
- Write transmit data in SDRL and SDRU, as follows.
 - 8-bit transfer mode: SDRL
 - 16-bit transfer mode: Upper byte in SDRU, lower byte in SDRL
- Set the SCSR1 start flag (STF) to 1. SCI1 starts operating. Transmit data is output at pin SO₁. Receive data is input at pin SI₁.
- After data transmission and reception are complete, bit IRRS1 in IRR1 is set to 1.
- Read the received data from SDRL and SDRU, as follows.
 - 8-bit transfer mode: SDRL
 - 16-bit transfer mode: Upper byte in SDRU, lower byte in SDRL

When an internal clock is used, a serial clock is output from pin SCK_1 in synchronization with the transmit data. After data transmission is complete, the serial clock is not output until the next time the start flag is set to 1. During this time, pin SO_1 continues to output the value of the last bit transmitted.



When an external clock is used, data is transmitted and received in synchronization with the serial clock input at pin SCK₁. After data transmission and reception are complete, an overrun occurs if the serial clock continues to be input; no data is transmitted or received and the SCSR1 overrun error flag (bit ORER) is set to 1.

While transmission is stopped, the output value of pin SO₁ can be changed by rewriting bit SOL in SCSR1.

10.2.4 Interrupts

SCI1 can generate an interrupt at the end of a data transfer.

When an SCI1 transfer is complete, bit IRRS1 in interrupt request register 1 (IRR1) is set to 1. SCI1 interrupt requests can be enabled or disabled by bit IENS1 of interrupt enable register 1 (IENR1).

For further details, see section 3.3, Interrupts.

10.2.5 Application Notes

Note the following points when using SCI1.

When an External Clock is Input to the SCK₁ Pin: When SCK₁ is designated as an input pin and an external clock is selected as the clock source, do not input the external clock before writing 1 to the STF bit in SCSR1 to start the transfer operation.

Confirming the End of Serial Transfer: Do not read or write to SCSR1 during serial transfer. The following two methods can be used to confirm the end of serial transfer:

- Using SCI1 interrupt exception handling
 Set the IENS1 bit to 1 in IENR1 and execute interrupt exception handling.
- Using IRR1 polling
 With SCI1 interrupts disabled (IENS1 = 0 in IENR1), confirm that the IRRS1 bit in IRR1 has been set to 1.

10.3 SCI3

10.3.1 Overview

Serial communication interface 3 (SCI3) has both synchronous and asynchronous serial data communication capabilities. It also has a multiprocessor communication function for serial data communication among two or more processors.

Features

SCI3 features are listed below.

- · Selection of asynchronous or synchronous mode
 - Asynchronous mode

Serial data communication is performed using an asynchronous method in which synchronization is established character by character.

SCI3 can communicate with a UART (universal asynchronous receiver/transmitter), ACIA (asynchronous communication interface adapter), or other chip that employs standard asynchronous serial communication. It can also communicate with two or more other processors using the multiprocessor communication function. There are twelve selectable serial data communication formats

- Data length: seven or eight bits
- Stop bit length: one or two bits
- Parity: even, odd, or none
- Multiprocessor bit: one or none
- Receive error detection: parity, overrun, and framing errors
- Break detection: by reading the RXD level directly when a framing error occurs
- Synchronous mode

Serial data communication is synchronized with a clock signal. SCI3 can communicate with other chips having a clocked synchronous communication function.

- Data length: eight bits
- Receive error detection: overrun errors
- Full duplex communication

The transmitting and receiving sections are independent, so SCI3 can transmit and receive simultaneously. Both sections use double buffering, so continuous data transfer is possible in both the transmit and receive directions.

- Built-in baud rate generator with selectable bit rates.
- Internal or external clock may be selected as the transfer clock source.



• There are six interrupt sources: transmit end, transmit data empty, receive data full, overrun error, framing error, and parity error.

Block Diagram

Figure 10.3 shows a block diagram of SCI3.

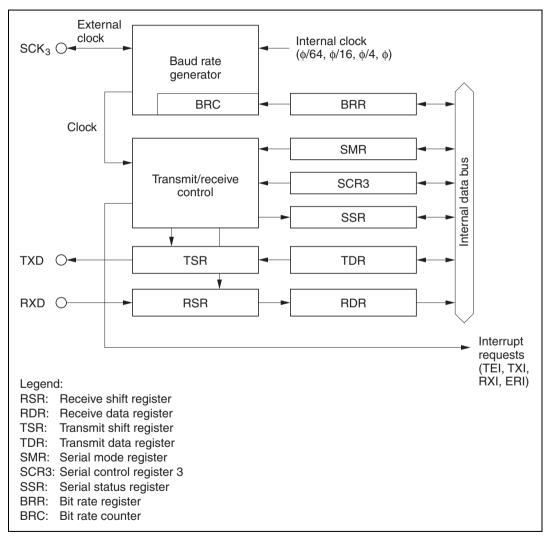


Figure 10.3 SCI3 Block Diagram

Pin Configuration

Table 10.4 shows the SCI3 pin configuration.

Table 10.4 Pin Configuration

| Name | Abbr. | I/O | Function |
|---------------------------|-------|--------|---------------------------|
| SCI3 clock | SCK₃ | I/O | SCI3 clock input/output |
| SCI3 receive data input | RXD | Input | SCI3 receive data input |
| SCI3 transmit data output | TXD | Output | SCI3 transmit data output |

Register Configuration

Table 10.5 shows the SCI3 internal register configuration.

Table 10.5 SCI3 Registers

| Name | Abbr. | R/W | Initial Value | Address |
|---------------------------|-------|-----|---------------|---------|
| Serial mode register | SMR | R/W | H'00 | H'FFA8 |
| Bit rate register | BRR | R/W | H'FF | H'FFA9 |
| Serial control register 3 | SCR3 | R/W | H'00 | H'FFAA |
| Transmit data register | TDR | R/W | H'FF | H'FFAB |
| Serial status register | SSR | R/W | H'84 | H'FFAC |
| Receive data register | RDR | R | H'00 | H'FFAD |
| Transmit shift register | TSR | * | _ | _ |
| Receive shift register | RSR | * | _ | _ |
| Bit rate counter | BRC | * | _ | |

Legend:

—: Cannot be read or written.

10.3.2 Register Descriptions

Receive Shift Register (RSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|---|---|---|---|---|---|---|---|
| | | | | | | | | |
| Read/Write | _ | _ | _ | _ | _ | _ | _ | _ |

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The receive shift register (RSR) is for receiving serial data.

Serial data is input in LSB (bit 0) order into RSR from pin RXD, converting it to parallel data. After each byte of data has been received, the byte is automatically transferred to the receive data register (RDR).

RSR cannot be read or written directly by the CPU.

Receive Data Register (RDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | RDR7 | RDR6 | RDR5 | RDR4 | RDR3 | RDR2 | RDR1 | RDR0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

The receive data register (RDR) is an 8-bit register for storing received serial data.

Each time a byte of data is received, the received data is transferred from the receive shift register (RSR) to RDR, completing a receive operation. Thereafter RSR again becomes ready to receive new data. RSR and RDR form a double buffer mechanism that allows data to be received continuously.

RDR is exclusively for receiving data and cannot be written by the CPU.

RDR is initialized to H'00 upon reset or in standby mode, watch mode, subactive mode, or subsleep mode.

Transmit Shift Register (TSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|------------|---|---|---|---|---|---|---|---|--|
| | | | | | | | | | |
| Read/Write | | | | | _ | _ | | | |

The transmit shift register (TSR) is for transmitting serial data.

Transmit data is first transferred from the transmit data register (TDR) to TSR, then is transmitted from pin TXD, starting from the LSB (bit 0).

After one byte of data has been sent, the next byte is automatically transferred from TDR to TSR, and the next transmission begins. If no data has been written to TDR (1 is set in TDRE), there is no data transfer from TDR to TSR.

TSR cannot be read or written directly by the CPU.

Transmit Data Register (TDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | TDR7 | TDR6 | TDR5 | TDR4 | TDR3 | TDR2 | TDR1 | TDR0 |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W |

The transmit data register (TDR) is an 8-bit register for holding transmit data.

When SCI3 detects that the transmit shift register (TSR) is empty, it shifts transmit data written in TDR to TSR and starts serial data transmission. While TSR is transmitting serial data, the next byte to be transmitted can be written to TDR, realizing continuous transmission.

TDR can be read or written by the CPU at all times.

TDR is initialized to H'FF upon reset or in standby mode, watch mode, subactive mode, or subsleep mode.

Serial Mode Register (SMR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|------|-----|------|------|
| | COM | CHR | PE | PM | STOP | MP | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

The serial mode register (SMR) is an 8-bit register for setting the serial data communication format and for selecting the clock source of the baud rate generator. SMR can be read and written by the CPU at any time.

SMR is initialized to H'00 upon reset or in standby mode, watch mode, subactive mode, or subsleep mode.

Bit 7—Communication Mode (COM): Bit 7 selects asynchronous mode or synchronous mode as the serial data communication mode.

| Bit 7: COM | Description | |
|------------|-------------------|-----------------|
| 0 | Asynchronous mode | (initial value) |
| 1 | Synchronous mode | |

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Bit 6—Character Length (CHR): Bit 6 selects either 7 bits or 8 bits as the data length in asynchronous mode. In synchronous mode the data length is always 8 bits regardless of the setting here.

| Bit 6: CHR | Description | | |
|------------|-------------|----------------|--------------|
| 0 | 8-bit data | (initial value |) |
| 1 | 7-bit data* | | _ |

Note: * When 7-bit data is selected as the character length in asynchronous mode, the MSB (bit 7) in the transmit data register is not transmitted.

Bit 5—Parity Enable (PE): In asynchronous mode, bit 5 selects whether or not a parity bit is to be added to transmitted data and checked in received data. In synchronous mode there is no adding or checking of parity regardless of the setting here.

| Bit 5: PE | Description | |
|-----------|---|-----------------|
| 0 | Parity bit adding and checking disabled | (initial value) |
| 1 | Parity bit adding and checking enabled* | |

Note: * When PE is set to 1, then either odd or even parity is added to transmit data, depending on the setting of the parity mode bit (PM). When data is received, it is checked for odd or even parity as designated in bit PM.

Bit 4—Parity Mode (PM): In asynchronous mode, bit 4 selects whether odd or even parity is to be added to transmitted data and checked in received data. The PM setting is valid only if bit PE is set to 1, enabling parity adding/checking. In synchronous mode, or if parity adding/checking is disabled in asynchronous mode, the PM setting is invalid.

| Bit 4: PM | Description | |
|-----------|---------------------------|-----------------|
| 0 | Even parity* ¹ | (initial value) |
| 1 | Odd parity* ² | |

- Notes: 1. When even parity is designated, a parity bit is added to the transmitted data so that the sum of 1s in the resulting data is an even number. When data is received, the sum of 1s in the data plus parity bit is checked to see if the result is an even number.
 - 2. When odd parity is designated, a parity bit is added to the transmitted data so that the sum of 1s in the resulting data is an odd number. When data is received, the sum of 1s in the data plus parity bit is checked to see if the result is an odd number.

Bit 3—Stop Bit Length (STOP): Bit 3 selects 1 bit or 2 bits as the stop bit length in asynchronous mode. This setting is valid only in asynchronous mode. In synchronous mode a stop bit is not added, so this bit is ignored.

| Bit 3: STOP | Description | |
|-------------|---------------|-----------------|
| 0 | 1 stop bit*1 | (initial value) |
| 1 | 2 stop bits*2 | |

Notes: 1. When data is transmitted, one 1 bit is added at the end of each transmitted character as the stop bit.

2. When data is transmitted, two 1 bits are added at the end of each transmitted character as the stop bits.

When data is received, only the first stop bit is checked regardless of the stop bit length. If the second stop bit value is 1 it is treated as a stop bit; if it is 0, it is treated as the start bit of the next character.

Bit 2—Multiprocessor Mode (MP): Bit 2 enables or disables the multiprocessor communication function. When the multiprocessor communication function is enabled, the parity enable (PE) and parity mode (PM) settings are ignored. The MP bit is valid only in asynchronous mode; it should be cleared to 0 in synchronous mode.

See section 10.3.6, Multiprocessor Communication Function for details on the multiprocessor communication function.

| Bit 2: MP | Description | |
|-----------|--|-----------------|
| 0 | Multiprocessor communication function disabled | (initial value) |
| 1 | Multiprocessor communication function enabled | |

Bits 1 and 0—Clock Select 1, 0 (CKS1, CKS0): Bits 1 and 0 select the clock source for the built-in baud rate generator. A choice of $\phi/64$, $\phi/16$, $\phi/4$, or ϕ is made in these bits.

See Bit Rate Register (BRR) in section 10.3.2, Register Descriptions, below for information on the clock source and bit rate register settings, and their relation to the baud rate.

| Bit 1: CKS1 | Bit 0: CKS0 | Description | |
|-------------|-------------|-------------|-----------------|
| 0 | 0 | φ clock | (initial value) |
| | 1 | φ/4 clock | |
| 1 | 0 | φ/16 clock | |
| | 1 | φ/64 clock | |

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Serial Control Register 3 (SCR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|------|------|------|------|
| | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Serial control register 3 (SCR3) is an 8-bit register that controls SCI3 transmit and receive operations, enables or disables serial clock output in asynchronous mode, enables or disables interrupts, and selects the serial clock source. SCR3 can be read and written by the CPU at any time.

SCR3 is initialized to H'00 upon reset or in standby mode, watch mode, subactive mode, or subsleep mode.

Bit 7—Transmit Interrupt Enable (TIE): Bit 7 enables or disables the transmit data empty interrupt (TXI) request when data is transferred from TDR to TSR and the transmit data register empty bit (TDRE) in the serial status register (SSR) is set to 1. The TXI interrupt can be cleared by clearing bit TDRE to 0, or by clearing bit TIE to 0.

| Bit 7: TIE | Description | |
|------------|--|-----------------|
| 0 | Transmit data empty interrupt request (TXI) disabled | (initial value) |
| 1 | Transmit data empty interrupt request (TXI) enabled | |

Bit 6—Receive Interrupt Enable (RIE): Bit 6 enables or disables the receive error interrupt (ERI), and the receive data full interrupt (RXI) requested when data is transferred from RSR to RDR and the receive data register full bit (RDRF) in the serial status register (SSR) is set to 1. There are three kinds of receive error: overrun, framing, and parity. RXI and ERI interrupts can be cleared by clearing SSR flag RDRF, or flags FER, PER, and OER to 0, or by clearing bit RIE to 0.

| Bit 6: RIE | Description | |
|------------|---|------------------------------|
| 0 | Receive data full interrupt request (RXI) and receive error interrup (ERI) disabled | t request (initial value) |
| 1 | Receive data full interrupt request (RXI) and receive error interrup (ERI) enabled | t request |

Bit 5—Transmit Enable (TE): Bit 5 enables or disables the start of a transmit operation.

| Bit 5: TE | Description | |
|-----------|---|-----------------|
| 0 | Transmit operation disabled*1 (TXD is a general I/O port) | (initial value) |
| 1 | Transmit operation enabled*2 (TXD is the transmit data pin) | |

Notes: 1. The transmit data register empty bit (TDRE) in the serial status register (SSR) is fixed at 1.

In this state, writing transmit data in TDR clears bit TDRE in SSR to 0 and starts serial data transmission.

Before setting TE to 1 it is necessary to set the transmit format in SMR. When performing simultaneous transmission and reception in synchronous mode, TE and RE should be set to 1 simultaneously by a single instruction when they are both cleared to 0.

Bit 4—Receive Enable (RE): Bit 4 enables or disables the start of a receive operation.

| Bit 4: RE | Description | |
|-----------|---|-----------------|
| 0 | Receive operation disabled*1 (RXD is a general I/O port) | (initial value) |
| 1 | Receive operation enabled*2 (RXD is the receive data pin) | |

Notes: 1. When RE is cleared to 0, this has no effect on the SSR flags RDRF, FER, PER, and OER, which retain their states.

Serial data receiving begins when, in this state, a start bit is detected in asynchronous mode, or serial clock input is detected in synchronous mode.

Before setting RE to 1 it is necessary to set the receive format in SMR. When performing simultaneous transmission and reception in synchronous mode, TE and RE should be set to 1 simultaneously by a single instruction when they are both cleared to 0.

Bit 3—Multiprocessor Interrupt Enable (MPIE): Bit 3 enables or disables multiprocessor interrupt requests. This setting is valid only in asynchronous mode, and only when the multiprocessor mode bit (MP) in the serial mode register (SMR) is set to 1. This bit is ignored when COM is set to 1 or when bit MP is cleared to 0.

| Bit 3: MPIE | Description |
|-------------|--|
| 0 | Multiprocessor interrupt request disabled (ordinary receive operation) |
| | (initial value) |
| | Clearing condition: |
| | Multiprocessor bit receives a data value of 1 |
| 1 | Multiprocessor interrupt request enabled* |

Note: * SCI3 does not transfer receive data from RSR to RDR, does not detect receive errors, and does not set status flags RDRF, FER, and OER in SSR. Until a multiprocessor bit



value of 1 is received, the receive data full interrupt (RXI) and receive error interrupt (ERI) are disabled and serial status register (SSR) flags RDRF, FER, and OER are not set. When the multiprocessor bit receives a 1, the MPBR bit of SSR is set to 1, MPIE is automatically cleared to 0, RXI and ERI interrupts are enabled (provided bits TIE and RIE in SCR3 are set to 1), and setting of the RDRF, FER, and OER flags is enabled.

Bit 2—Transmit End Interrupt Enable (TEIE): Bit 2 enables or disables the transmit end interrupt (TEI) requested if there is no valid transmit data in TDR when the MSB is transmitted.

| Bit 2: TEIE | Description | | |
|-------------|---------------------------------------|-----------------|--|
| 0 | Transmit end interrupt (TEI) disabled | (initial value) | |
| 1 | Transmit end interrupt (TEI) enabled* | _ | |

Note: * A TEI interrupt can be cleared by clearing the SSR bit TDRE to 0 and clearing the transmit end bit (TEND) to 0, or by clearing bit TEIE to 0.

Bits 1 and 0—Clock Enable 1, 0 (CKE1, CKE0): Bits 1 and 0 select the clock source and enable or disable clock output at pin SCK₃. The combination of bits CKE1 and CKE0 determines whether pin SCK₃ is a general I/O port, a clock output pin, or a clock input pin.

Note that the CKE0 setting is valid only when operation is in asynchronous mode using an internal clock (CKE1 = 0). This bit is invalid in synchronous mode or when using an external clock (CKE1 = 1). In synchronous mode and in external clock mode, clear CKE0 to 0. After setting bits CKE1 and CKE0, the operation mode must first be set in the serial mode register (SMR).

See table 10.12 in section 10.3.3, Operation, for details on clock source selection.

| Bit 1: CKE1 | Bit 0: CKE0 | Communication Mode | Clock Source | SCK ₃ Pin Function |
|-------------|-------------|---------------------------|----------------|-------------------------------|
| 0 | 0 | Asynchronous | Internal clock | I/O port*1 |
| | | Synchronous | Internal clock | Serial clock output*1 |
| 0 | 1 | Asynchronous | Internal clock | Clock output*2 |
| | | Synchronous | Reserved | Reserved |
| 1 | 0 | Asynchronous | External clock | Clock input*3 |
| | | Synchronous | External clock | Serial clock input |
| 1 | 1 | Asynchronous | Reserved | Reserved |
| | | Synchronous | Reserved | Reserved |

Notes: 1. Initial value

- 2. A clock is output with the same frequency as the bit rate.
- 3. Input a clock with a frequency 16 times the bit rate.

Serial Status Register (SSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|------|------|------|
| | TDRE | RDRF | OER | FER | PER | TEND | MPBR | MPBT |
| Initial value | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R | R | R/W |

Note: * Only 0 can be written for flag clearing.

The serial status register (SSR) is an 8-bit register containing status flags for indicating SCI3 states, and containing the multiprocessor bits.

SSR can be read and written by the CPU at any time, but the CPU cannot write a 1 to the status flags TDRE, RDRF, OER, PER, and FER. To clear these flags to 0 it is first necessary to read a 1. Bit 2 (TEND) and bit 1 (MPBR) are read-only bits and cannot be modified.

SSR is initialized to H'84 upon reset or in standby mode, watch mode, subactive mode, or subsleep mode.

Bit 7—Transmit Data Register Empty (TDRE): Bit 7 is a status flag indicating that data has been transferred from TDR to TSR.

| Bit 7: TDRE | Description |
|-------------|--|
| 0 | Indicates that transmit data written to TDR has not been transferred to TSR |
| | Clearing conditions: After reading TDRE = 1, cleared by writing 0 to TDRE. When data is written to TDR by an instruction. |
| 1 | Indicates that no transmit data has been written to TDR, or the transmit data written to TDR has been transferred to TSR (initial value) |
| | Setting conditions: When bit TE in SCR3 is cleared to 0. When data is transferred from TDR to TSR. |

Bit 6—Receive Data Register Full (RDRF): Bit 6 is a status flag indicating whether there is receive data in RDR.

| Bit 6: RDRF | Description | | | |
|-------------|--|---|--|--|
| 0 | Indicates there is no receive data in RDR (initial value) | | | |
| | Clearing conditions: After reading RDRF = 1, cleared by writing 0 to RDRF. When data is read from RDR by an instruction. | | | |
| 1 | Indicates that there is receive data in RDR | _ | | |
| | Setting condition: When receiving ends normally, with receive data transferred from RSR to RDR | } | | |

Note: If a receive error is detected at the end of receiving, or if bit RE in serial control register 3 (SCR3) is cleared to 0, RDR and RDRF are unaffected and keep their previous states. An overrun error (OER) occurs if receiving of data is completed while bit RDRF remains set to 1. If this happens, receive data will be lost.

Bit 5—Overrun Error (OER): Bit 5 is a status flag indicating that an overrun error has occurred during data receiving.

| Bit 5: OER | Description |
|------------|---|
| 0 | Indicates that data receiving is in progress or has been completed* (initial value) |
| | Clearing condition: After reading OER = 1, cleared by writing 0 to OER |
| 1 | Indicates that an overrun error occurred in data receiving*2 |
| | Setting condition: When data receiving is completed while RDRF is set to 1 |

- Notes: 1. When bit RE in serial control register 3 (SCR3) is cleared to 0, OER is unaffected and keeps its previous state.
 - 2. RDR keeps the data received prior to the overrun; data received after that is lost. While OER is set to 1, data receiving cannot be continued. In synchronous mode, data transmitting cannot be continued either.

Bit 4—Framing Error (FER): Bit 4 is a status flag indicating that a framing error has occurred during asynchronous receiving.

| Bit 4: FER | Description |
|------------|---|
| 0 | Indicates that data receiving is in progress or has been completed* (initial value) |
| | Clearing condition: After reading FER = 1, cleared by writing 0 to FER |
| 1 | Indicates that a framing error occurred in data receiving |
| | Setting condition: The stop bit at the end of receive data is checked for a value of 1 and found to be 0^{\ast^2} |

- Notes: 1. When bit RE in serial control register 3 (SCR3) is cleared to 0, FER is unaffected and keeps its previous state.
 - 2. When two stop bits are used only the first stop bit is checked, not the second. When a framing error occurs, receive data is transferred to RDR but RDRF is not set. While FER is set to 1, data receiving cannot be continued. In synchronous mode, data transmitting cannot be continued either.

Bit 3—Parity Error (PER): Bit 3 is a status flag indicating that a parity error has occurred during asynchronous receiving.

| Bit 3: PER | Description | | | | |
|------------|--|--|--|--|--|
| 0 | Indicates that data receiving is in progress or has been completed* (initial value) | | | | |
| | Clearing condition: After reading PER = 1, cleared by writing 0 to PER | | | | |
| 1 | Indicates that a parity error occurred in data receiving*2 | | | | |
| | Setting condition: When the sum of 1s in received data plus the parity bit does not match the parity mode bit (PM) setting in the serial mode register (SMR) | | | | |

- Notes: 1. When bit RE in serial control register 3 (SCR3) is cleared to 0, PER is unaffected and keeps its previous state.
 - 2. When a parity error occurs, receive data is transferred to RDR but RDRF is not set. While PER is set to 1, data receiving cannot be continued. In synchronous mode, data transmitting cannot be continued either.

Bit 2—Transmit End (TEND): Bit 2 is a status flag indicating that TDRE was set to 1 when the last bit of a transmitted character was sent. TEND is a read-only bit and cannot be modified directly.

| Bit 2: TEND | Description | |
|-------------|---|-----------------|
| 0 | Indicates that transmission is in progress | |
| | Clearing conditions: After reading TDRE = 1, cleared by writing 0 to TDRE. When data is written to TDR by an instruction. | |
| 1 | Indicates that a transmission has ended | (initial value) |
| | Setting conditions: When bit TE in SCR3 is cleared to 0. If TDRE is set to 1 when the last bit of a transmitted character | is sent. |

Bit 1—Multiprocessor Bit Receive (MPBR): Bit 1 holds the multiprocessor bit in data received in asynchronous mode using a multiprocessor format. MPBR is a read-only bit and cannot be modified.

| Bit 1: MPBR | Description | |
|-------------|---|-----------------|
| 0 | Indicates reception of data in which the multiprocessor bit is 0* | (initial value) |
| 1 | Indicates reception of data in which the multiprocessor bit is 1 | _ |

Note: * If bit RE is cleared to 0 while a multiprocessor format is in use, MPBR retains its previous state.

Bit 0—Multiprocessor Bit Transmit (MPBT): Bit 0 holds the multiprocessor bit to be added to transmitted data when a multiprocessor format is used in asynchronous mode. Bit MPBT is ignored when synchronous mode is chosen, when the multiprocessor communication function is disabled, or when data transmission is disabled.

| Bit 0: MPBT | Description | |
|-------------|--|-----------------|
| 0 | The multiprocessor bit in transmit data is 0 | (initial value) |
| 1 | The multiprocessor bit in transmit data is 1 | _ |

Bit Rate Register (BRR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | BRR7 | BRR6 | BRR5 | BRR4 | BRR3 | BRR2 | BRR1 | BRR0 |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W |

The bit rate register (BRR) is an 8-bit register which, together with the baud rate generator clock selected by bits CKS1 and CKS0 in the serial mode register (SMR), sets the transmit/receive bit rate.

BRR can be read or written by the CPU at any time.

BRR is initialized to H'FF upon reset or in standby mode, watch mode, subactive mode, or subsleep mode.

Table 10.6 gives examples of how BRR is set in asynchronous mode. The values in table 10.6 are for active (high-speed) mode.

Table 10.6 BRR Settings and Bit Rates in Asynchronous Mode

| | | 2 | | | 2.457 | 76 | | 4 | | | 4.1943 | 304 |
|-------------------|---|-----|--------------|---|-------|--------------|---|-----|--------------|---|--------|--------------|
| Bit Rate (bits/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 1 | 70 | +0.03 | 1 | 86 | +0.31 | 1 | 141 | +0.03 | 1 | 148 | -0.04 |
| 150 | 0 | 207 | +0.16 | 0 | 255 | 0 | 1 | 103 | +0.16 | 1 | 108 | +0.21 |
| 300 | 0 | 103 | +0.16 | 0 | 127 | 0 | 0 | 207 | +0.16 | 0 | 217 | +0.21 |
| 600 | 0 | 51 | +0.16 | 0 | 63 | 0 | 0 | 103 | +0.16 | 0 | 108 | +0.21 |
| 1200 | 0 | 25 | +0.16 | 0 | 31 | 0 | 0 | 51 | +0.16 | 0 | 54 | -0.70 |
| 2400 | 0 | 12 | +0.16 | 0 | 15 | 0 | 0 | 25 | +0.16 | 0 | 26 | +1.14 |
| 4800 | _ | _ | _ | 0 | 7 | 0 | 0 | 12 | +0.16 | 0 | 13 | -2.48 |
| 9600 | _ | _ | _ | 0 | 3 | 0 | _ | _ | _ | 0 | 6 | -2.48 |
| 19200 | _ | _ | _ | 0 | 1 | 0 | _ | _ | _ | _ | _ | _ |
| 31250 | 0 | 0 | 0 | _ | _ | _ | 0 | 1 | 0 | _ | _ | _ |
| 38400 | _ | _ | _ | 0 | 0 | 0 | _ | _ | _ | _ | _ | |

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OSC (MHz)

| | | 4.91 | 52 | | 6 | | | 7.372 | В | | 8 | |
|-------------------|---|------|--------------|---|-----|--------------|---|-------|--------------|---|-----|--------------|
| Bit Rate (bits/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 1 | 174 | -0.26 | 1 | 212 | +0.03 | 2 | 64 | +0.70 | 2 | 70 | +0.03 |
| 150 | 1 | 127 | 0 | 1 | 155 | +0.16 | 1 | 191 | 0 | 1 | 207 | +0.16 |
| 300 | 0 | 255 | 0 | 1 | 77 | +0.16 | 1 | 95 | 0 | 1 | 103 | +0.16 |
| 600 | 0 | 127 | 0 | 0 | 155 | +0.16 | 0 | 191 | 0 | 0 | 207 | +0.16 |
| 1200 | 0 | 63 | 0 | 0 | 77 | +0.16 | 0 | 95 | 0 | 0 | 103 | +0.16 |
| 2400 | 0 | 31 | 0 | 0 | 38 | +0.16 | 0 | 47 | 0 | 0 | 51 | +0.16 |
| 4800 | 0 | 15 | 0 | 0 | 19 | -2.34 | 0 | 23 | 0 | 0 | 25 | +0.16 |
| 9600 | 0 | 7 | 0 | 0 | 9 | -2.34 | 0 | 11 | 0 | 0 | 12 | +0.16 |
| 19200 | 0 | 3 | 0 | 0 | 4 | -2.34 | 0 | 5 | 0 | _ | _ | _ |
| 31250 | _ | _ | _ | 0 | 2 | 0 | _ | _ | _ | 0 | 3 | 0 |
| 38400 | 0 | 1 | 0 | _ | _ | _ | 0 | 2 | 0 | | _ | _ |

| | , | | | | | | |
|-------------------|---|-------|--------------|---|-----|--------------|--|
| | | 9.830 |)4 | | | | |
| Bit Rate (bits/s) | n | N | Error (%) | n | N | Error (%) | |
| 110 | 2 | 86 | +0.31 | 2 | 88 | -0.25 | |
| 150 | 1 | 255 | 0 | 2 | 64 | +0.16 | |
| 300 | 1 | 127 | 0 | 1 | 129 | +0.16 | |
| 600 | 0 | 255 | 0 | 1 | 64 | +0.16 | |
| 1200 | 0 | 127 | 0 | 0 | 129 | +0.16 | |
| 2400 | 0 | 63 | 0 | 0 | 64 | +0.16 | |
| 4800 | 0 | 31 | 0 | 0 | 32 | -1.36 | |
| 9600 | 0 | 15 | 0 | 0 | 15 | +1.73 | |
| 19200 | 0 | 7 | 0 | 0 | 7 | +1.73 | |
| 31250 | 0 | 4 | -1.70 | 0 | 4 | 0 | |
| 38400 | 0 | 3 | 0 | 0 | 3 | +1.73 | |

Notes: 1. Settings should be made so that error is within 1%.

2. BRR setting values are derived by the following equation.

$$N = \frac{OSC}{64 \times 2^{2n} \times B} \times 10^6 - 1$$

B: Bit rate (bits/s)

BRR baud rate generator setting (0 \leq N \leq 255)

OSC: Value of ϕ_{OSC} (MHz)

Baud rate generator input clock number (n = 0 to 3)

(The relation between n and the clock is shown in table 10.7.)

3. The error values in table 10.6 were derived by performing the following calculation and rounding off to two decimal places.

Error (%) =
$$\frac{B-R}{R} \times 100$$

B: Bit rate found from n, N, and OSC

R: Bit rate listed in left column of table 10.6

The meaning of n is shown in table 10.7.

Table 10.7 Relation between n and Clock

| | | | SMR Setting | |
|---|-------|------|-------------|--|
| n | Clock | CKS1 | CKS0 | |
| 0 | ф | 0 | 0 | |
| 1 | φ/4 | 0 | 1 | |
| 2 | φ/16 | 1 | 0 | |
| 3 | φ/64 | 1 | 1 | |

Table 10.8 shows the maximum bit rate for selected frequencies in asynchronous mode. Values in table 10.8 are for active (high-speed) mode.

 Table 10.8
 Maximum Bit Rate at Selected Frequencies (Asynchronous Mode)

| | | | Setting |
|-----------|---------------------------|---|---------|
| OSC (MHz) | Maximum Bit Rate (bits/s) | n | N |
| 2 | 31250 | 0 | 0 |
| 2.4576 | 38400 | 0 | 0 |
| 4 | 62500 | 0 | 0 |
| 4.194304 | 65536 | 0 | 0 |
| 4.9152 | 76800 | 0 | 0 |
| 6 | 93750 | 0 | 0 |
| 7.3728 | 115200 | 0 | 0 |
| 8 | 125000 | 0 | 0 |
| 9.8304 | 153600 | 0 | 0 |
| 10 | 156250 | 0 | 0 |

Table 10.9 shows typical BRR settings in synchronous mode. Values in table 10.9 are for active (high-speed) mode.

Table 10.9 Typical BRR Settings and Bit Rates (Synchronous Mode)

| | OSC (| (MHz) |
|--|-------|-------|
|--|-------|-------|

| Bit Rate | 2 | | | 4 | | 8 | 10 | | |
|----------|---|-----|---|-----|---|-----|----|-----|--|
| (bits/s) | n | N | n | N | n | N | n | N | |
| 110 | _ | _ | _ | _ | _ | _ | _ | _ | |
| 250 | 1 | 249 | 2 | 124 | 2 | 249 | _ | _ | |
| 500 | 1 | 124 | 1 | 249 | 2 | 124 | _ | _ | |
| 1 K | 0 | 249 | 1 | 124 | 1 | 249 | _ | _ | |
| 2.5 K | 0 | 99 | 0 | 199 | 1 | 99 | 1 | 124 | |
| 5 K | 0 | 49 | 0 | 99 | 0 | 199 | 0 | 249 | |
| 10 K | 0 | 24 | 0 | 49 | 0 | 99 | 0 | 124 | |
| 25 K | 0 | 9 | 0 | 19 | 0 | 39 | 0 | 49 | |
| 50 K | 0 | 4 | 0 | 9 | 0 | 19 | 0 | 24 | |
| 100 K | _ | _ | 0 | 4 | 0 | 9 | _ | _ | |
| 250 K | 0 | 0* | 0 | 1 | 0 | 3 | 0 | 4 | |
| 500 K | | | 0 | 0* | 0 | 1 | _ | _ | |
| 1 M | | | | | 0 | 0* | _ | _ | |
| 2.5 M | | | | | | | | | |

Legend:

Blank: Cannot be set

—: Can be set, but error will result

*: Continuous transfer not possible at this setting

BRR setting values are derived by the following equation.

$$N = \frac{OSC}{8 \times 2^{2n} \times B} \times 10^6 - 1$$

Legend:

B: Bit rate (bits/s)

N: BRR band rate generator setting $(0 \le N \le 255)$

OSC: Value of ϕ OSC (MHz)

n: Baud rate generator input clock number (n = 0, 1, 2, 3)

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The meaning of n is shown in table 10.10.

Table 10.10 Relation between n and Clock

| | | SMR Setting | | | | | | |
|---|-------|-------------|------|--|--|--|--|--|
| n | Clock | CKS1 | CKS0 | | | | | |
| 0 | ф | 0 | 0 | | | | | |
| 1 | ф/4 | 0 | 1 | | | | | |
| 2 | ф/16 | 1 | 0 | | | | | |
| 3 | ф/64 | 1 | 1 | | | | | |

10.3.3 Operation

SCI3 supports serial data communication in both asynchronous mode, where each character transferred is synchronized separately, and synchronous mode, where transfer is synchronized by clock pulses.

The choice of asynchronous mode or synchronous mode, and the communication format, is made in the serial mode register (SMR), as shown in table 10.11. The SCI3 clock source is determined by bit COM in SMR and bits CKE1 and CKE0 in serial control register 3 (SCR3), as shown in table 10.12.

Asynchronous Mode:

- Data length: choice of 7 bits or 8 bits
- Options include addition of parity bit, multiprocessor bit, and one or two stop bits (transmit/receive format and character length are determined by this combination of options).
- Framing error (FER), parity error (PER), overrun error (OER), and line breaks can be detected when data is received.
- Clock source: Choice of internal clocks or an external clock
 - When an internal clock is selected: Operates on baud rate generator clock. A clock can be output with the same frequency as the bit rate.
 - When an external clock is selected: A clock input with a frequency 16 times the bit rate is required (internal baud rate generator is not used).

Synchronous Mode:

- Transfer format: 8 bits
- Overrun error can be detected when data is received.
- Clock source: Choice of internal clocks or an external clock

When an internal clock is selected: Operates on baud rate generator clock, and outputs a serial clock.

When an external clock is selected: The internal baud rate generator is not used. Operation is synchronous with the input clock.

Table 10.11 SMR Settings and SCI3 Communication Format

| SMR Setting | | | | | | Communication Format | | | | |
|---------------|---------------|--------------|--------------|----------------|------------------|-----------------------------|-------------------------|---------------|--------------------|--|
| Bit 7: COM | Bit 6: CHR | Bit 2: MP | Bit 5: PE | Bit 3: STOP | Mode | Data Length | Multipro- cessor Bit | Parity Bit | Stop Bit Length | |
| 0 | 0 | 0 | 0 | 0 | Asynchronous | 8-bit data | No | No | 1 bit | |
| | | | | 1 | mode | | | | 2 bits | |
| | | | 1 | 0 | - | | | Yes | 1 bit | |
| | | | | 1 | - | | | | 2 bits | |
| | 1 | =' | 0 | 0 | - | 7-bit data | - | No | 1 bit | |
| | | | | 1 | - | | | | 2 bits | |
| | | | 1 | 0 | - | | | Yes | 1 bit | |
| | | | | 1 | - | | | | 2 bits | |
| | 0 | 1 | * | 0 | Asynchronous | 8-bit data | Yes | No | 1 bit | |
| | | | * | 1 | mode | | | | 2 bits | |
| | 1 | - | * | 0 | (multiprocessor | 7-bit data | = | | 1 bit | |
| | | | * | 1 | - format) | | | | 2 bits | |
| 1 | * | 0 | * | * | Synchronous mode | 8-bit data | No | _ | None | |

Legend: * Don't care

Table 10.12 SMR and SCR3 Settings and Clock Source Selection

| SMR | S | CR3 | | Transmit/Receive Clock | | | | |
|---------------|----------------|----------------|--------------|------------------------|--|--|--|--|
| Bit 7: COM | Bit 1: CKE1 | Bit 0: CKE0 | Mode | Clock Source | Pin SCK ₃ Function | | | |
| 0 | 0 | 0 | Asynchronous | Internal | I/O port (SCK ₃ function not used) | | | |
| | | 1 | 1 mode | | Outputs clock with same frequency as bit rate | | | |
| | 1 | 0 | _ | External | Clock should be input with frequency 16 times the desired bit rate | | | |
| 1 | 0 | 0 | Synchronous | Internal | Outputs a serial clock | | | |
| | 1 | 0 | mode | External | Inputs a serial clock | | | |
| 0 | 1 | 1 | Reserved | (illegal set | ttings) | | | |
| 1 | 0 | 1 | | | | | | |
| 1 | 1 | 1 | _ | | | | | |

Continuous Transmit/Receive Operation Using Interrupts: Continuous transmit and receive operations are possible with SCI3, using the RXI or TXI interrupts. Table 10.13 explains this use of these interrupts.

Table 10.13 Transmit/Receive Interrupts

| Interrupt | Flag | Interrupt Conditions | Remarks |
|-----------|--------------|--|--|
| RXI | RDRF RIE | When serial data is received normally and receive data is transferred from RSR to RDR, RDRF is set to 1. If RIE is 1 at this time, RXI is enabled and an interrupt occurs. (See figure 10.4.) | The RXI interrupt handler routine should read the receive data from RDR and clear RDRF to 0. Continuous receiving is possible if these operations are completed before the next data has been completely received in RSR. |
| TXI | TDRE TIE | When TSR empty (previous transmission complete) is detected and the transmit data set in TDR is transferred to TSR, TDRE is set to 1. If TIE is 1 at this time, TXI is enabled and an interrupt occurs. (See figure 10.5.) | The TXI interrupt handler routine should write the next transmit data to TDR and clear TDRE to 0.Continuous transmission is possible if these operations are completed before the data transferred to TSR has been completely transmitted. |
| TEI | TEND TEIE | When the last bit of the TSR transmit character has been sent, if TDRE is 1, then 1 is set in TEND. If TEIE is 1 at this time, TEI is enabled and an interrupt occurs. (See figure 10.6.) | TEI indicates that, when the last bit of the TSR transmit character was sent, the next transmit data had not been written to TDR. |

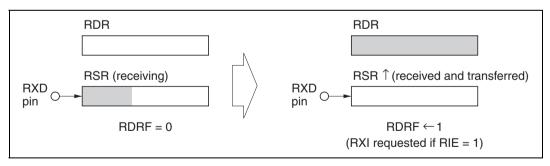


Figure 10.4 RDRF Setting and RXI Interrupt

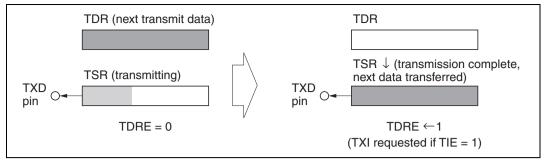


Figure 10.5 TDRE Setting and TXI Interrupt

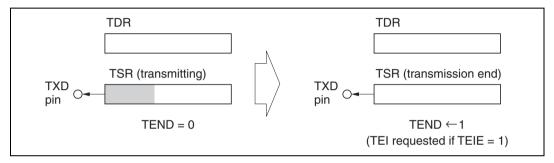


Figure 10.6 TEND Setting and TEI Interrupt

10.3.4 Operation in Asynchronous Mode

In asynchronous communication mode, a start bit indicating the start of communication and a stop bit indicating the end of communication are added to each character that is sent. In this way synchronization is achieved for each character as a self-contained unit.

SCI3 consists of independent transmit and receive modules, giving it the capability of full duplex communication. Both the transmit and receive modules have a double-buffer configuration, allowing data to be read or written during communication operations so that data can be transmitted and received continuously.

Transmit/Receive Formats

Figure 10.7 shows the general format for asynchronous serial communication.

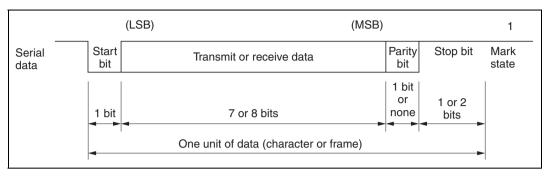


Figure 10.7 Data Format in Asynchronous Serial Communication Mode

The communication line in asynchronous communication mode normally stays at the high level, in the "mark" state. SCI3 monitors the communication line, and begins serial data communication when it detects a "space" (low-level signal), which is regarded as a start bit.

One character consists of a start bit (low level), transmit/receive data (in LSB-first order: starting with the least significant bit), a parity bit (high or low level), and finally a stop bit (high level), in this order.

In asynchronous data receiving, synchronization is with the falling edge of the start bit. SCI3 samples data on the 8th pulse of a clock that has 16 times the frequency of the bit rate, so each bit of data is latched at its center.

Table 10.14 shows the 12 transmit/receive formats formats that can be selected in asynchronous mode. The format is selected in the serial mode register (SMR).

Table 10.14 Serial Communication Formats in Asynchronous Mode

| | SMR | Serial Transfer Format and Frame Length | | | | | | | | | | | | | |
|-----|-----|---|------|---|------------------|---|---|-------|------|---|------|------|----------|------|------|
| CHR | PE | MP | STOP | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |
| 0 | 0 | 0 | 0 | S | | | | 8-bit | data | | | | STOP | • | |
| 0 | 0 | 0 | 1 | S | | | | 8-bit | data | | | | STOP | STOP | |
| 0 | 1 | 0 | 0 | S | | | | 8-bit | data | | | | Р | STOP | |
| 0 | 1 | 0 | 1 | S | 8-bit data P STO | | | | | | STOP | STOP | | | |
| 1 | 0 | 0 | 0 | s | | | | 7-bit | data | | | STOR | - | | |
| 1 | 0 | 0 | 1 | s | | | | 7-bit | data | | | STOF | STOP | | |
| 1 | 1 | 0 | 0 | s | | | | 7-bit | data | | | Р | STOP | | |
| 1 | 1 | 0 | 1 | s | | | | 7-bit | data | | | Р | STOP | STOP | |
| 0 | * | 1 | 0 | s | | | | 8-bit | data | | | | МРВ | STOP | |
| 0 | * | 1 | 1 | S | | | | 8-bit | data | | | | МРВ | STOP | STOP |
| 1 | * | 1 | 0 | S | | | | 7-bit | data | | | МРВ | STOP | • | |
| 1 | * | 1 | 1 | S | | | | 7-bit | data | | | MPB | STOP | STOP | |

Legend: * Don't care

S: Start bit STOP: Stop bit P: Parity bit

MPB: Multiprocessor bit

Clock

The clock source is determined by bit COM in SMR and bits CKE1 and CKE0 in serial control register 3 (SCR3). See table 10.12 for the settings. Either an internal clock source can be used to run the built-in baud rate generator, or an external clock source can be input at pin SCK₃.

When an external clock is input at pin SCK₃, it should have a frequency 16 times the desired bit rate.

When an internal clock source is used, SCK₃ is used as the clock output pin. The clock output has the same frequency as the serial bit rate, and is synchronized as in figure 10.8 so that the rising edge of the clock occurs in the center of each bit of transmit/receive data.

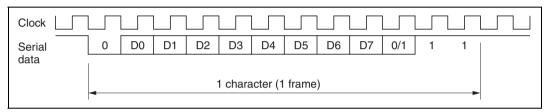


Figure 10.8 Phase Relation of Output Clock and Communication Data in Asynchronous Mode (8-Bit Data, Parity Bit Added, and 2 Stop Bits)

Data Transmit/Receive Operations

SCI3 Initialization: Before data is sent or received, bits TE and RE in serial control register 3 (SCR3) must be cleared to 0, after which initialization can be performed using the procedure shown in figure 10.9.

Note: When modifying the operation mode, transfer format or other settings, always be sure to clear bits TE and RE first. When TE is cleared to 0, bit TDRE will be set to 1. Clearing RE does not clear the status flags RDRF, PER, FER, or OER, or alter the contents of the receive data register (RDR).

When an external clock is used in asynchronous mode, do not stop the clock during operation, including during initialization. When an external clock is used in synchronous mode, do not supply the clock during initialization.

Figure 10.9 shows a typical flow chart for SCI3 initialization.

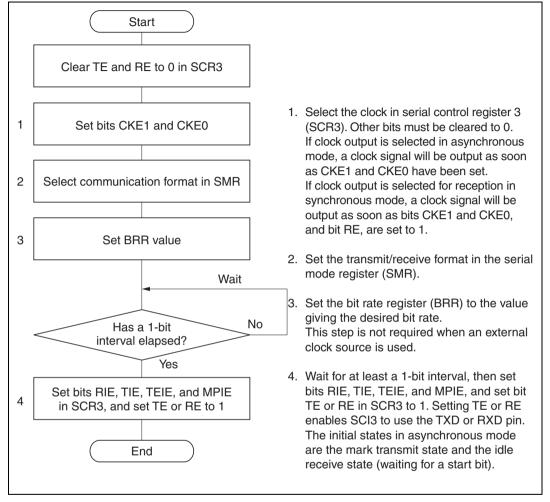


Figure 10.9 Typical Flow Chart when SCI3 Is Initialized

Transmitting: Figure 10.10 shows a typical flow chart for data transmission. After SCI3 initialization, follow the procedure below.

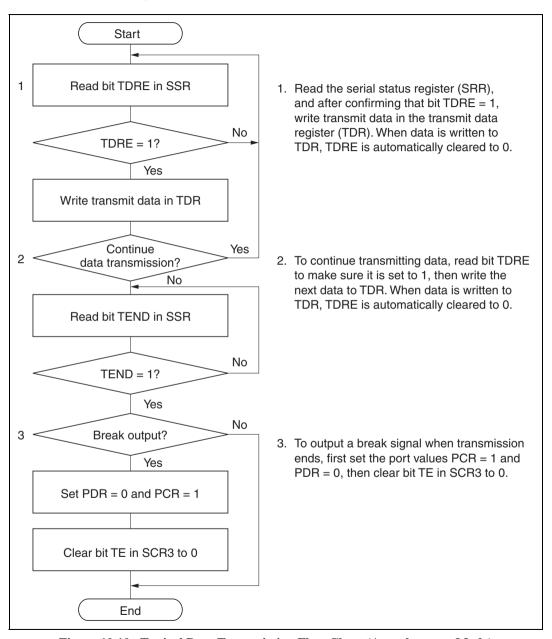


Figure 10.10 Typical Data Transmission Flow Chart (Asynchronous Mode)

SCI3 operates as follows during data transmission.

SCI3 monitors bit TDRE in SSR. When this bit is cleared to 0, SCI3 recognizes that there is data written in the transmit data register (TDR), which it transfers to the transmit shift register (TSR). Then TDRE is set to 1 and transmission starts. If bit TIE in SCR3 is set to 1, a TXI interrupt is requested.

Serial data is transmitted from pin TXD using the communication format outlined in table 10.14. Next, TDRE is checked as the stop bit is being transmitted.

If TDRE is 0, data is transferred from TDR to TSR, and after the stop bit is sent, transmission of the next frame starts. If TDRE is 1, the TEND bit in SSR is set to 1, and after the stop bit is sent the output remains at 1 (mark state). A TEI interrupt is requested in this state if bit TEIE in SCR3 is set to 1

Figure 10.11 shows a typical operation in asynchronous transmission mode.

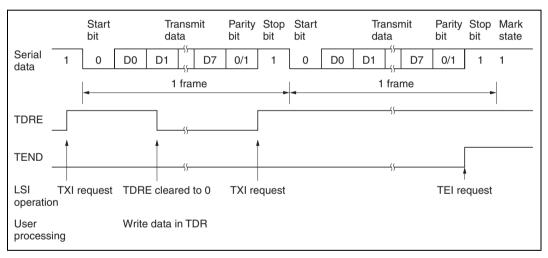


Figure 10.11 Typical Transmit Operation in Asynchronous Mode (8-Bit Data, Parity Bit Added, and 1 Stop Bit)

Receiving: Figure 10.12 shows a typical flow chart for receiving serial data. After SCI3 initialization, follow the procedure below.

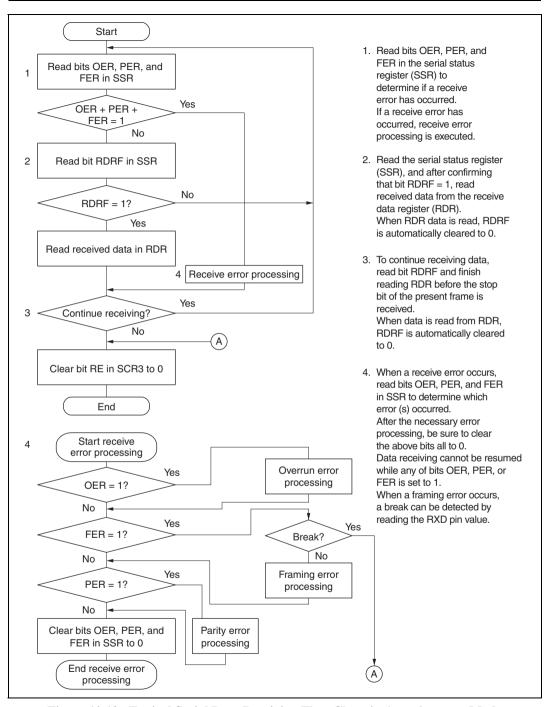


Figure 10.12 Typical Serial Data Receiving Flow Chart in Asynchronous Mode

SCI3 operates as follows when receiving serial data in asynchronous mode.

SCI3 monitors the communication line, and when a start bit (0) is detected it performs internal synchronization and starts receiving. The communication format for data receiving is as outlined in table 10.14. Received data is set in RSR from LSB to MSB, then the parity bit and stop bit(s) are received. After receiving the data, SCI3 performs the following checks:

- Parity check: The number of 1s received is checked to see if it matches the odd or even parity selected in bit PM of SMR.
- Stop bit check: The stop bit is checked for a value of 1. If there are two stop bits, only the first bit is checked.
- Status check: The RDRF bit is checked for a value of 0 to make sure received data can be transferred from RSR to RDR.

If no receive error is detected by the above checks, bit RDRF is set to 1 and the received data is stored in RDR. At that time, if bit RIE in SCR3 is set to 1, an RXI interrupt is requested. If the error check detects a receive error, the appropriate error flag (OER, PER, or FER) is set to 1. RDRF retains the same value as before the data was received. If at this time bit RIE in SCR3 is set to 1, an ERI interrupt is requested.

Table 10.15 gives the receive error detection conditions and the processing of received data in each case.

Note: Data receiving cannot be continued while a receive error flag is set. Before continuing the receive operation it is necessary to clear the OER, FER, PER, and RDRF flags to 0.

Table 10.15 Receive Error Conditions and Received Data Processing

| Receive Error | Abbr. | Detection Conditions | Received Data Processing | | |
|---------------|-------|---|--|--|--|
| Overrun error | OER | Receiving of the next data ends while bit RDRF in SSR is still set to 1 | Received data is not transferred from RSR to RDR | | |
| Framing error | FER | Stop bit is 0 | Received data is transferred from RSR to RDR | | |
| Parity error | PER | Received data does not match the parity (odd/even) set in SMR | Received data is transferred from RSR to RDR | | |



Figure 10.13 shows a typical SCI3 data receive operation in asynchronous mode.

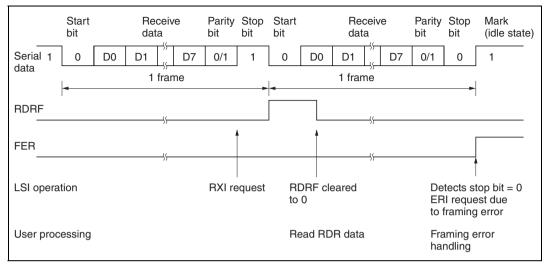


Figure 10.13 Typical Receive Operation in Asynchronous Mode (8-Bit Data, Parity Bit Added, and 1 Stop Bit)

10.3.5 Operation in Synchronous Mode

In synchronous mode, data is sent or received in synchronization with clock pulses. This mode is suited to high-speed serial communication.

SCI3 consists of independent transmit and receive modules, so full duplex communication is possible, sharing the same clock between both modules. Both the transmit and receive modules have a double-buffer configuration. This allows data to be written during a transmit operation so that data can be transmitted continuously, and enables data to be read during a receive operation so that data can be received continuously.

Transmit/Receive Format

Figure 10.14 shows the general communication data format for synchronous communication.

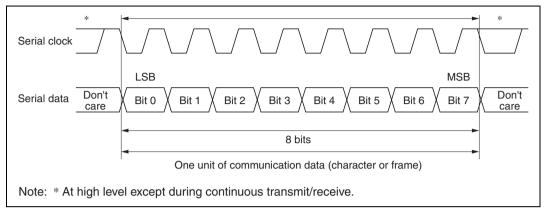


Figure 10.14 Data Format in Synchronous Communication Mode

In synchronous communication, data on the communication line is output from one falling edge of the serial clock until the next falling edge. Data is guaranteed valid at the rising edge of the serial clock.

One character of data starts from the LSB and ends with the MSB. The communication line retains the MSB state after the MSB is output.

In synchronous receive mode, SCI3 latches receive data in synchronization with the rising edge of the serial clock.

The transmit/receive format is fixed at 8-bit data. No parity bit or multiprocessor bit is added in this mode.

Clock

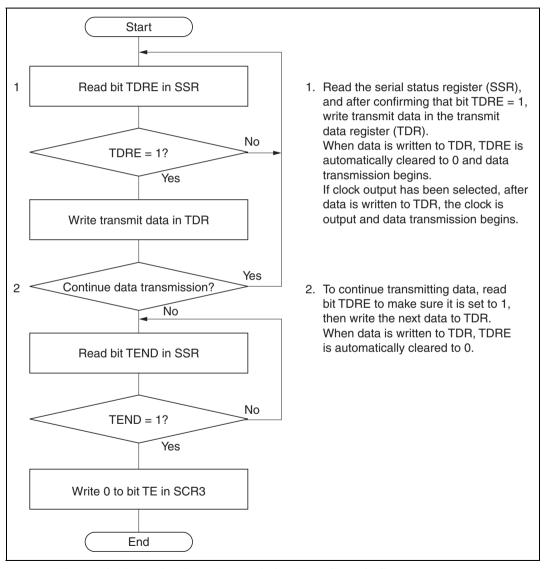
Either an internal clock from the built-in baud rate generator is used, or an external clock is input at pin SCK,. The choice of clock sources is designated by bit COM in SMR and bits CKE1 and CKE0 in serial control register 3 (SCR3). See table 10.12 for details on selecting the clock source.

When operation is based on an internal clock, a serial clock is output at pin SCK_a. Eight clock pulses are output per character of transmit/receive data. When no transmit or receive operation is being performed, the pin is held at the high level.

Data Transmit/Receive Operations

SCI3 Initialization: Before transmitting or receiving data, follow the SCI3 initialization procedure explained under 10.3.4, SCI3 Initialization, and illustrated in figure 10.9.

Transmitting: Figure 10.15 shows a typical flow chart for data transmission. After SCI3 initialization, follow the procedure below.



 $Figure\ 10.15\quad Typical\ Data\ Transmission\ Flow\ Chart\ in\ Synchronous\ Mode$

SCI3 operates as follows during data transmission in synchronous mode.

SCI3 monitors bit TDRE in SSR. When this bit is cleared to 0, SCI3 recognizes that there is data written in the transmit data register (TDR), which it transfers to the transmit shift register (TSR). Then TDRE is set to 1 and transmission starts. If bit TIE in SCR3 is set to 1, a TXI interrupt is requested.

If clock output is selected, SCI3 outputs eight serial clock pulses. If an external clock is used, data is output in synchronization with the clock input.

Serial data is transmitted from pin TXD in order from LSB (bit 0) to MSB (bit 7).

Then TDRE is checked as the MSB (bit 7) is being transmitted. If TDRE is 0, data is transferred from TDR to TSR, and after the MSB (bit 7) is sent, transmission of the next frame starts. If TDRE is 1, the TEND bit in SSR is set to 1, and after the MSB (bit 7) has been sent, the MSB state is maintained. A TEI interrupt is requested in this state if bit TEIE in SCR3 is set to 1.

After data transmission ends, pin SCK₃ is held at the high level.

Note: Data transmission cannot take place while any of the receive error flags (OER, FER, PER) is set to 1. Be sure to confirm that these error flags are cleared to 0 before starting transmission

Figure 10.16 shows a typical SCI3 transmit operation in synchronous mode.

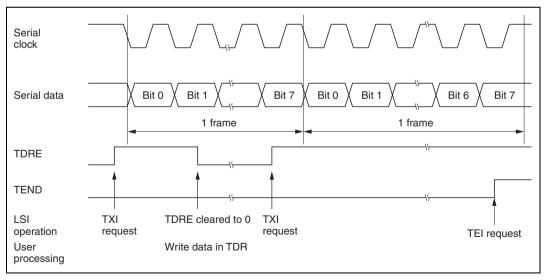


Figure 10.16 Typical SCI3 Transmit Operation in Synchronous Mode

Receiving: Figure 10.17 shows a typical flow chart for receiving data. After SCI3 initialization, follow the procedure below.

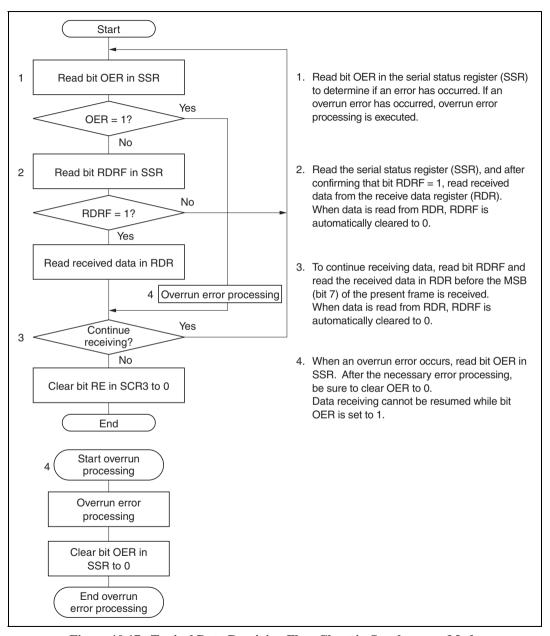


Figure 10.17 Typical Data Receiving Flow Chart in Synchronous Mode

SCI3 operates as follows when receiving serial data in synchronous mode.

SCI3 synchronizes internally with the input or output of the serial clock and starts receiving. Received data is set in RSR from LSB to MSB.

After data has been received, SCI3 checks to confirm that the value of bit RDRF is 0 indicating that received data can be transferred from RSR to RDR. If this check passes, RDRF is set to 1 and the received data is stored in RDR. At this time, if bit RIE in SCR3 is set to 1, an RXI interrupt is requested. If an overrun error is detected, OER is set to 1 and RDRF remains set to 1. Then if bit RIE in SCR3 is set to 1, an ERI interrupt is requested.

For the overrun error detection conditions and receive data processing, see table 10.15.

Note: Data receiving cannot be continued while a receive error flag is set. Before continuing the receive operation it is necessary to clear the OER, FER, PER, and RDRF flags to 0.



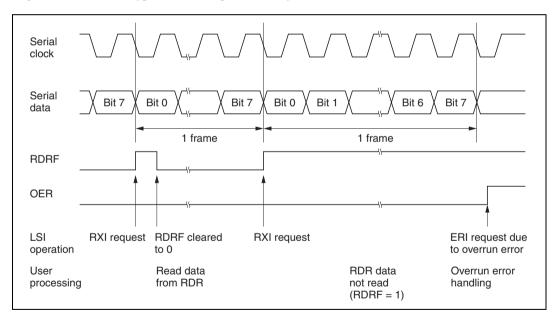


Figure 10.18 Typical Receive Operation in Synchronous Mode

Simultaneous Transmit/Receive: Figure 10.19 shows a typical flow chart for transmitting and receiving simultaneously. After SCI3 synchronization, follow the procedure below.

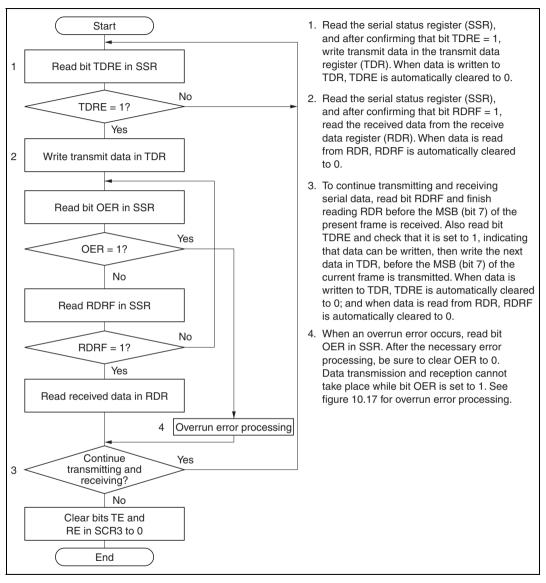


Figure 10.19 Simultaneous Transmit/Receive Flow Chart in Synchronous Mode

- Notes: 1. To switch from transmitting to simultaneous transmitting and receiving, use the following procedure.
 - First confirm that TDRE and TEND are both set to 1 and that SCI3 has finished transmitting. Next clear TE to 0. Then set both TE and RE to 1.
 - 2. To switch from receiving to simultaneous transmitting and receiving, use the following procedure.
 - After confirming that SCI3 has finished receiving, clear RE to 0. Next, after
 confirming that RDRF and the error flags (OER FER, PER) are all 0, set both TE
 and RE to 1.

10.3.6 Multiprocessor Communication Function

The multiprocessor communication function enables several processors to share a single serial communication line. The processors communicate in asynchronous mode using a format with an additional multiprocessor bit (multiprocessor format).

In multiprocessor communication, each receiving processor is addressed by an ID code. A serial communication cycle consists of two cycles: an ID-sending cycle that identifies the receiving processor, and a data-sending cycle. The ID-sending cycle and data-sending cycle are differentiated by the multiprocessor bit. The multiprocessor bit is 1 in an ID-sending cycle, and 0 in a data-sending cycle.

The transmitting processor starts by sending the ID of the receiving processor with which it wants to communicate as data with the multiprocessor bit set to 1. Next the transmitting processor sends transmit data with the multiprocessor bit cleared to 0. When a receiving processor receives data with the multiprocessor bit set to 1, it compares the data with its own ID. If the data matches its ID, the receiving processor continues to receive incoming data. If the data does not match its ID, the receiving processor skips further incoming data until it again receives data with the multiprocessor bit set to 1. Multiple processors can send and receive data in this way.

Figure 10.20 shows an example of communication among different processors using a multiprocessor format.

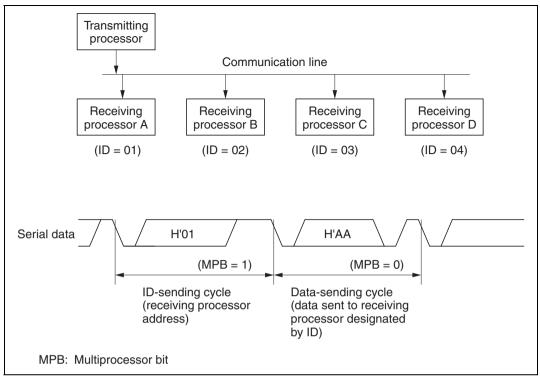


Figure 10.20 Example of Interprocessor Communication Using Multiprocessor Format (Data H'AA Sent to Receiving Processor A)

Four communication formats are available. Parity-bit settings are ignored when a multiprocessor format is selected. For details see table 10.14.

For a description of the clock used in multiprocessor communication, see section 10.3.4, Operation in Asynchronous Mode.

Transmitting Multiprocessor Data: Figure 10.21 shows a typical flow chart for multiprocessor serial data transmission. After SCI3 initialization, follow the procedure below.

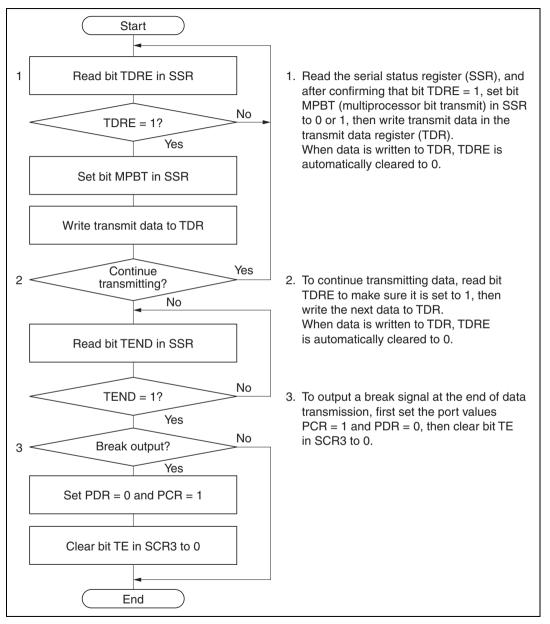


Figure 10.21 Typical Multiprocessor Data Transmission Flow Chart

SCI3 operates as follows during data transmission using a multiprocessor format.

SCI3 monitors bit TDRE in SSR. When this bit is cleared to 0, SCI3 recognizes that there is data written in the transmit data register (TDR), which it transfers to the transmit shift register (TSR). Then TDRE is set to 1 and transmission starts. If bit TIE in SCR3 is set to 1, a TXI interrupt is requested.

Serial data is transmitted from pin TXD using the communication format outlined in table 10.14.

Next, TDRE is checked as the stop bit is being transmitted. If TDRE is 0, data is transferred from TDR to TSR, and after the stop bit is sent, transmission of the next frame starts. If TDRE is 1, the TEND bit in SSR is set to 1, and after the stop bit is sent the output remains at 1 (mark state). A TEI interrupt is requested in this state if bit TEIE in SCR3 is set to 1.

Figure 10.22 shows a typical SCI3 operation in multiprocessor communication mode.

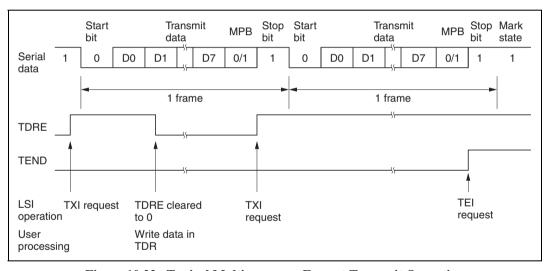


Figure 10.22 Typical Multiprocessor Format Transmit Operation (8-Bit Data, Multiprocessor Bit Added, and 1 Stop Bit)

Receiving Multiprocessor Data: Figure 10.23 shows a typical flow chart for receiving data using a multiprocessor format. After SCI3 initialization, follow the procedure below.

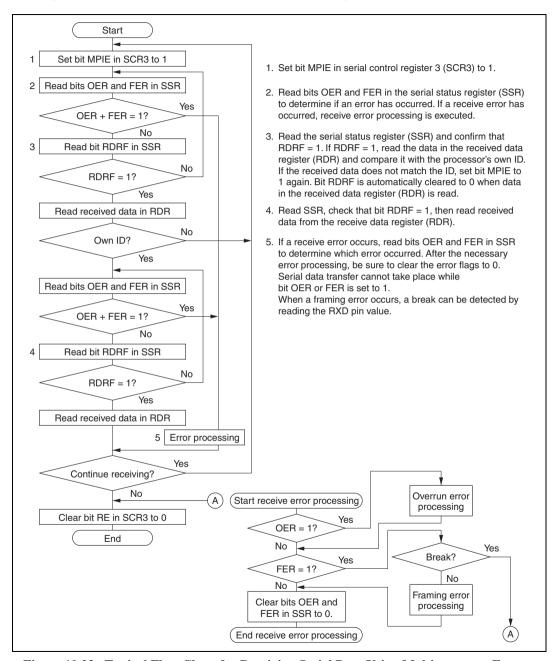


Figure 10.23 Typical Flow Chart for Receiving Serial Data Using Multiprocessor Format

Figure 10.24 gives an example of data reception using a multiprocessor format.

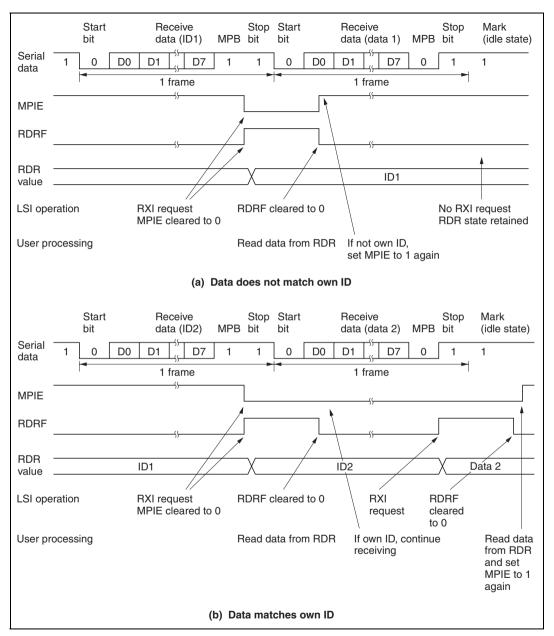


Figure 10.24 Example of Multiprocessor Format Receive Operation (8-Bit Data, Multiprocessor Bit Added, and 1 Stop Bit)

10.3.7 Interrupts

SCI3 has six interrupt sources: transmit end, transmit data empty, receive data full, and the three receive error interrupts (overrun error, framing error, and parity error). All share a common interrupt vector. Table 10.16 describes each interrupt.

Table 10.16 SCI3 Interrupts

| Interrupt | Description | Vector Address |
|-----------|--|-----------------------|
| RXI | Interrupt request due to receive data register full (RDRF) | H'0024 |
| TXI | Interrupt request due to transmit data register empty (TDRE) | _ |
| TEI | Interrupt request due to transmit end (TEND) | _ |
| ERI | Interrupt request due to receive error (OER, FER, or PER) | _ |

The interrupt requests are enabled and disabled by bits TIE and RIE of SCR3.

When bit TDRE in SSR is set to 1, TXI is requested. When bit TEND in SSR is set to 1, TEI is requested. These two interrupt requests occur during data transmission.

The initial value of bit TDRE is 1. Accordingly, if the transmit data empty interrupt request (TXI) is enabled by setting bit TIE to 1 in SCR3 before placing transmit data in TDR, TXI will be requested even though no transmit data has been readied.

Likewise, the initial value of bit TEND in SSR is 1. Accordingly, if the transmit end interrupt request (TEI) is enabled by setting bit TEIE to 1 in SCR3 before placing transmit data in TDR, TEI will be requested even though no data has been transmitted.

These interrupt features can be used to advantage by programming the interrupt handler to move the transmit data into TDR. When this technique is not used, the interrupt enable bits (TIE and TEIE) should not be set to 1 until after TDR has been loaded with transmit data, to avoid unwanted TXI and TEI interrupts.

When bit RDRF in SSR is set to 1, RXI is requested. When any of SSR bits OER, FER, or PER is set to 1, ERI is requested. These two interrupt requests occur during the receiving of data.

Details on interrupts are given in section 3.3, Interrupts.

10.3.8 Application Notes

When using SCI3, attention should be paid to the following matters.

Relation between Bit TDRE and Writing Data to TDR: Bit TDRE in the serial status register (SSR) is a status flag indicating that TDR does not contain new transmit data. TDRE is automatically cleared to 0 when data is written to TDR. When SCI3 transfers data from TDR to TSR, bit TDRE is set to 1.

Data can be written to TDR regardless of the status of bit TDRE. However, if new data is written to TDR while TDRE is cleared to 0, assuming the data held in TDR has not yet been shifted to TSR, it will be lost. For this reason it is advisable to confirm that bit TDRE is set to 1 before each write to TDR and not write to TDR more than once without checking TDRE in between.

Operation when Multiple Receive Errors Occur at the Same Time: When two or more receive errors occur at the same time, the status flags in SSR are set as shown in table 10.17. If an overrun error occurs, data is not transferred from RSR to RDR, and receive data is lost.

Table 10.17 SSR Status Flag States and Transfer of Receive Data

| SSR Status Flags | | _ Receive Data Transfer | | | |
|------------------|-----|-------------------------|-----|-------------------------|--|
| RDRF* | OER | FER | PER | $(RSR \rightarrow RDR)$ | Receive Error Status |
| 1 | 1 | 0 | 0 | Not transferred | Overrun error |
| 0 | 0 | 1 | 0 | Transferred | Framing error |
| 0 | 0 | 0 | 1 | Transferred | Parity error |
| 1 | 1 | 1 | 0 | Not transferred | Overrun error + framing error |
| 1 | 1 | 0 | 1 | Not transferred | Overrun error + parity error |
| 0 | 0 | 1 | 1 | Transferred | Framing error + parity error |
| 1 | 1 | 1 | 1 | Not transferred | Overrun error + framing error + parity error |

Note: * RDRF keeps the same state as before the data was received. However, if due to a late read of received data in one frame an overrun error occurs in the next frame, RDRF is cleared to 0 when RDR is read.

Break Detection and Processing: Break signals can be detected by reading the RXD pin directly when a framing error (FER) is detected. In the break state the input from the RXD pin consists of all 0s, so FER is set and the parity error flag (PER) may also be set. In the break state SCI3 continues to receive, so if the FER bit is cleared to 0 it will be set to 1 again.



Sending a Mark or Break Signal: When TE is cleared to 0 the TXD pin becomes an I/O port, the level and direction (input or output) of which are determined by the PDR and PCR bits. This feature can be used to place the TXD pin in the mark state or send a break signal.

To place the serial communication line in the mark (1) state before TE is set to 1, set the PDR and PCR bits both to 1. Since TE is cleared to 0, TXD becomes a general output port outputting the value 1.

To send a break signal during data transmission, set the PCR bit to 1 and clear the PDR bit to 0, then clear TE to 0. When TE is cleared to 0 the transmitter is initialized, regardless of its current state, so the TXD pin becomes an output port outputting the value 0.

Receive Error Flags and Transmit Operation (Sysnchronous Mode Only): When a receive error flag (OER, PER, or FER) is set to 1, SCI3 will not start transmitting even if TDRE is cleared to 0. Be sure to clear the receive error flags to 0 when starting to transmit. Note that clearing RE to 0 does not clear the receive error flags.

Receive Data Sampling Timing and Receive Margin in Asynchronous Mode: In asynchronous mode SCI3 operates on a base clock with 16 times the bit rate frequency. In receiving, SCI3 synchronizes internally with the falling edge of the start bit, which it samples on the base clock. Receive data is latched at the rising edge of the eighth base clock pulse. See figure 10.25.

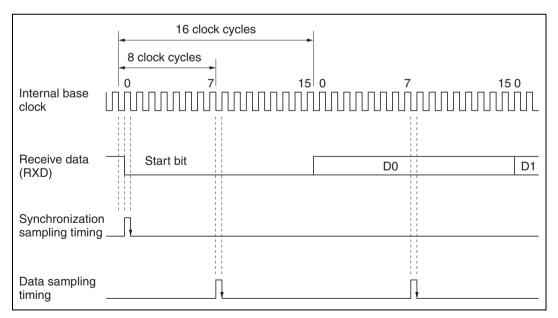


Figure 10.25 Receive Data Sampling Timing in Asynchronous Mode

The receive margin in asynchronous mode can therefore be derived from the following equation.

$$M = \{(0.5 - 1/2N) - (D - 0.5) / N - (L - 0.5) F\} \times 100\%$$
 Equation (1)

M: Receive margin (%)

N: Ratio of clock frequency to bit rate (N = 16)

D: Clock duty cycle (D = 0.5 to 1)

L: Frame length (L = 9 to 12)

F: Absolute value of clock frequency error

In equation (1), if F (absolute value of clock frequency error) = 0 and D (clock duty cycle) = 0.5, the receive margin is 46.875% as given by equation (2) below.

When D = 0.5 and F = 0,

$$M = \{0.5 - 1/(2 \times 16)\} \times 100\% = 46.875\%$$
 Equation (2)

This value is theoretical. In actual system designs a margin of from 20 to 30 percent should be allowed.

Relationship between Bit RDRF and Reading RDR: While SCI3 is receiving, it checks the RDRF flag. When a frame of data has been received, if the RDRF flag is cleared to 0, data receiving ends normally. If RDRF is set to 1, an overrun error occurs.

RDRF is automatically cleared to 0 when the contents of RDR are read. If RDR is read more than once, the second and later reads will be performed with RDRF cleared to 0. While RDRF is 0, if RDR is read when reception of the next frame is just ending, data from the next frame may be read. This is illustrated in figure 10.26.



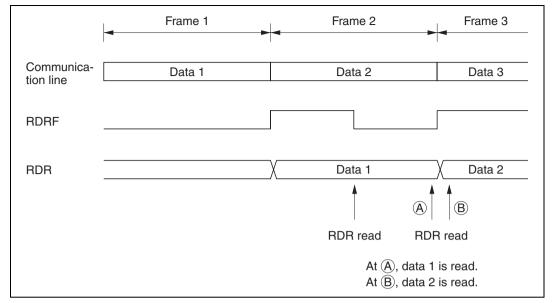


Figure 10.26 Relationship between Data and RDR Read Timing

To avoid the situation described above, after RDRF is confirmed to be 1, RDR should only be read once and should not be read twice or more.

When the same data must be read more than once, the data read the first time should be copied to RAM, for example, and the copied data should be used. An alternative is to read RDR but leave a safe margin of time before reception of the next frame is completed. Specifically, reading of RDR should be completed before bit 7 is transferred in synchronous mode, or before the stop bit is transferred in asynchronous mode.

Caution on Switching of SCK₃ Function: If pin SCK₃ is used as a clock output pin by SCI3 in synchronous mode and is then switched to a general input/output pin (a pin with a different function), the pin outputs a low level signal for half a system clock (ϕ) cycle immediately after it is switched.

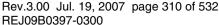
This can be prevented by either of the following methods according to the situation.

1. When an SCK₃ function is switched from clock output to non clock-output When stopping data transfer, issue one instruction to clear bits TE and RE in SCR3 to 0 and to set bits CKE1 and CKE0 to 1 and 0, respectively. In this case, bit COM in SMR should be left 1. The above prevents SCK₃ from being used as a general input/output pin. To avoid an intermediate level of voltage from being applied to SCK₃, the line connected to SCK₃ should be pulled up to the V_{CC} level via a resistor, or supplied with output from an external device.

- 2. When an SCK₃ function is switched from clock output to general input/output When stopping data transfer,
 - a. Issue one instruction to clear bits TE and RE in SCR3 to 0 and to set bits CKE1 and CKE0 to 1 and 0, respectively.
 - b. Clear bit COM in SMR to 0
 - c. Clear bits CKE1 and CKE0 in SCR3 to 0

Note that special care is also needed here to avoid an intermediate level of voltage from being applied to SCK₃.

Caution on Switching TxD Function: If pin TXD is used as a data output pin by SCI3 in synchronous mode and is then switched to a general input/output pin (a pin with a different function), the pin outputs a high level signal for one system clock (ϕ) cycle immediately after it is switched.





Section 11 14-Bit PWM (H8/3857 Group Only)

11.1 Overview

The H8/3857 Group is provided with a 14-bit PWM (pulse width modulator), which can be used as a D/A converter by connecting a low-pass filter. The H8/3854 Group does not have this module.

11.1.1 Features

Features of the 14-bit PWM are as follows.

- Choice of two conversion periods
 - A conversion period of $32,768/\phi$, with a minimum modulation width of $2/\phi$ (PWCR0 = 1), or a conversion period of $16,384/\phi$, with a minimum modulation width of $1/\phi$ (PWCR0 = 0), can be chosen.
- Pulse division method for less ripple

11.1.2 Block Diagram

Figure 11.1 shows a block diagram of the 14-bit PWM.

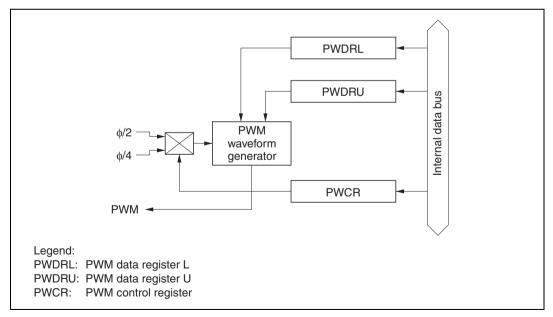


Figure 11.1 Block Diagram of the 14 bit PWM

11.1.3 Pin Configuration

Table 11.1 shows the output pin assigned to the 14-bit PWM.

Table 11.1 Pin Configuration

| Name | Abbr. | I/O | Function |
|----------------|-------|--------|------------------------------------|
| PWM output pin | PWM | Output | Pulse-division PWM waveform output |

11.1.4 Register Configuration

Table 11.2 shows the register configuration of the 14-bit PWM.

Table 11.2 Register Configuration

| Name | Abbr. | R/W | Initial Value | Address |
|----------------------|-------|-----|---------------|---------|
| PWM control register | PWCR | W | H'FE | H'FFD0 |
| PWM data register U | PWDRU | W | H'C0 | H'FFD1 |
| PWM data register L | PWDRL | W | H'00 | H'FFD2 |

11.2 Register Descriptions

11.2.1 PWM Control Register (PWCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|-------|
| | _ | _ | _ | _ | _ | _ | _ | PWCR0 |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| Read/Write | _ | _ | _ | _ | _ | _ | _ | W |

PWCR is an 8-bit write-only register for input clock selection.

Upon reset, PWCR is initialized to H'FE.

Bits 7 to 1—Reserved Bits: Bits 7 to 1 are reserved; they are always read as 1, and cannot be modified.

Bit 0—Clock Select 0 (PWCR0): Bit 0 selects the clock supplied to the 14-bit PWM. This bit is a write-only bit; it is always read as 1.

| Bit 0: PWCR0 | Description |
|--------------|--|
| 0 | The input clock is $\phi/2$ ($t_{\varphi}^*=2/\phi$). The conversion period is 16,384/ ϕ , with a minimum modulation width of 1/ ϕ . (initial value) |
| 1 | The input clock is $\phi/4$ (t_{φ} * = $4/\phi$). The conversion period is 32,768/ ϕ , with a minimum modulation width of 2/ ϕ . |

Note: to: Period of PWM input clock

PWM Data Registers U and L (PWDRU, PWDRL) 11.2.2

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| PWDRU | _ | _ | PWDRU5 | PWDRU4 | PWDRU3 | PWDRU2 | PWDRU1 | PWDRU0 |
| Initial value | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | W | W | W | W | W | W |
| | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PWDRL | PWDRL7 | PWDRL6 | PWDRL5 | PWDRL4 | PWDRL3 | PWDRL2 | PWDRL1 | PWDRL0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

PWDRU and PWDRL form a 14-bit write-only register, with the upper 6 bits assigned to PWDRU and the lower 8 bits to PWDRL. The value written to PWDRU and PWDRL gives the total highlevel width of one PWM waveform cycle.

When 14-bit data is written to PWDRU and PWDRL, the register contents are latched in the PWM waveform generator, updating the PWM waveform generation data. The 14-bit data should always be written in the following sequence, first to PWDRL and then to PWDRU.

- 1. Write the lower 8 bits to PWDRL.
- 2. Write the upper 6 bits to PWDRU.

PWDRU and PWDRL are write-only registers. If they are read, all bits are read as 1.

Upon reset, PWDRU and PWDRL are initialized to H'C000.

11.3 **Operation**

When using the 14-bit PWM, set the registers in the following sequence.

- 1. Set bit PWM in port mode register 1 (PMR1) to 1 so that pin P1/PWM is designated for PWM output.
- 2. Set bit PWCR0 in the PWM control register (PWCR) to select a conversion period of either $32,768/\phi$ (PWCR0 = 1) or $16,384/\phi$ (PWCR0 = 0).
- 3. Set the output waveform data in PWM data registers U and L (PWDRU/L). Be sure to write in the correct sequence, first PWDRL then PWDRU. When data is written to PWDRU, the data in these registers will be latched in the PWM waveform generator, updating the PWM waveform generation in synchronization with internal signals.

One conversion period consists of 64 pulses, as shown in figure 11.2. The total of the highlevel pulse widths during this period (T_u) corresponds to the data in PWDRU and PWDRL. This relation can be represented as follows.

$$T_{H} = (data \ value \ in \ PWDRU \ and \ PWDRL + 64) \times t_{\varphi}/2$$

where t_{ϕ} is the PWM input clock period, either $2/\phi$ (bit PWCR0 = 0) or $4/\phi$ (bit PWCR0 = 1).

Example: Settings in order to obtain a conversion period of 8,192 us:

When bit PWCR0 = 0, the conversion period is $16,384/\phi$, so ϕ must be 2 MHz. In this case $t_{fn} = 128 \mu s$, with $1/\phi$ (resolution) = 0.5 μs .

When bit PWCR0 = 1, the conversion period is $32,768/\phi$, so ϕ must be 4 MHz. In this case tfn = 128 μ s, with 2/ ϕ (resolution) = 0.5 μ s.

Accordingly, for a conversion period of 8,192 μs, the system clock frequency (φ) must be 2 MHz or 4 MHz.

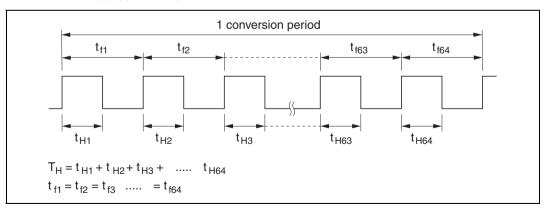


Figure 11.2 PWM Output Waveform

Section 12 A/D Converter

12.1 Overview

The H8/3857 Group and H8/3854 Group include a resistance-ladder-based successive-approximation analog-to-digital converter. The maximum number of analog input channels is eight in the H8/3857 Group and four in the H8/3854 Group.

12.1.1 Features

The A/D converter has the following features.

- 8-bit resolution
- Input channels
 - 8 in H8/3857 Group
 - 4 in H8/3854 Group
- Conversion time: approx. 12.4 µs per channel (at 5 MHz operation)
- Built-in sample-and-hold function
- Interrupt requested on completion of A/D conversion
- A/D conversion can be started by external trigger input

12.1.2 Block Diagram

Figure 12.1 shows a block diagram of the A/D converter.

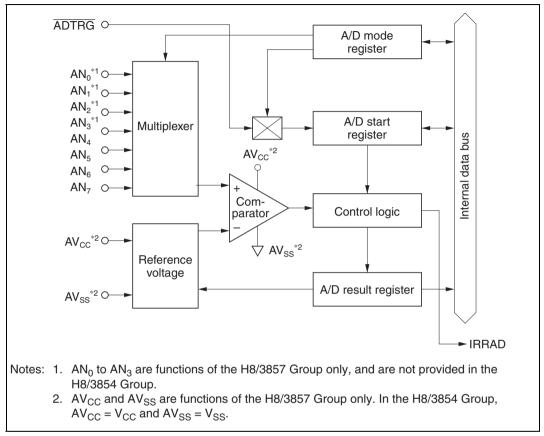


Figure 12.1 Block Diagram of the A/D Converter

12.1.3 Pin Configuration

Table 12.1 shows the A/D converter pin configuration.

Table 12.1 Pin Configuration

| Name | Abbr. | I/O | Function |
|----------------------------|------------------|-------|--|
| Analog power supply pin* | AV _{cc} | Input | Power supply and reference voltage of analog part |
| Analog ground pin* | AV _{ss} | Input | Ground and reference voltage of analog part |
| Analog input pin 0* | AN _o | Input | Analog input channel 0 |
| Analog input pin 1* | AN, | Input | Analog input channel 1 |
| Analog input pin 2* | AN ₂ | Input | Analog input channel 2 |
| Analog input pin 3* | AN ₃ | Input | Analog input channel 3 |
| Analog input pin 4 | AN ₄ | Input | Analog input channel 4 |
| Analog input pin 5 | AN ₅ | Input | Analog input channel 5 |
| Analog input pin 6 | AN ₆ | Input | Analog input channel 6 |
| Analog input pin 7 | AN ₇ | Input | Analog input channel 7 |
| External trigger input pin | ADTRG | Input | External trigger input for starting A/D conversion |

Note: * The analog power supply pin, analog ground pin, and analog input pins 0 to 3 are functions of the H8/3857 Group only, and are not provided in the H8/3854 Group. In the H8/3854 Group, the analog power supply pin is the power supply pin (V_{cc}) , and the analog ground pin is the ground pin (V_{sc}) .

12.1.4 Register Configuration

Table 12.2 shows the A/D converter register configuration.

Table 12.2 Register Configuration

| Name | Abbr. | R/W | Initial Value | Address |
|---------------------|-------|-----|---------------|---------|
| A/D mode register | AMR | R/W | H'30 | H'FFC4 |
| A/D start register | ADSR | R/W | H'7F | H'FFC6 |
| A/D result register | ADRR | R | Undefined | H'FFC5 |



12.2 Register Descriptions

12.2.1 A/D Result Register (ADRR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | ADR7 | ADR6 | ADR5 | ADR4 | ADR3 | ADR2 | ADR1 | ADR0 |
| Initial value | Undefined |
| Read/Write | R | R | R | R | R | R | R | R |

The A/D result register (ADRR) is an 8-bit read-only register for holding the results of analog-to-digital conversion.

ADRR can be read by the CPU at any time, but the ADRR values during A/D conversion are not fixed.

After A/D conversion is complete, the conversion result is stored in ADRR as 8-bit data; this data is held in ADRR until the next conversion operation starts.

ADRR is not cleared on reset.

12.2.2 A/D Mode Register (AMR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|------|---|---|-----|-----|-----|-----|
| | CKS | TRGE | _ | _ | CH3 | CH2 | CH1 | CH0 |
| Initial value | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | | _ | R/W | R/W | R/W | R/W |

AMR is an 8-bit read/write register for specifying the A/D conversion speed, external trigger option, and the analog input pins.

Upon reset, AMR is initialized to H'30.

Bit 7—Clock Select (CKS): Bit 7 sets the A/D conversion speed.

| | | Conversion Time | | | |
|------------|--------------------------|-----------------|-----------|---|--|
| Bit 7: CKS | Conversion Period | φ = 2 MHz | φ = 5 MHz | | |
| 0 | 62/φ (initial value) | 31 μs | 12.4 μs | _ | |
| 1 | 31/φ | 15.5 μs | * | _ | |

Note: * Operation is not guaranteed if the conversion time is less than 12.4 μ s. Set bit 7 for a value of at least 12.4 μ s.

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Bit 6—External Trigger Select (TRGE): Bit 6 enables or disables the start of A/D conversion by external trigger input.

| Bit 6: TRGE | Description |
|-------------|---|
| 0 | Disables start of A/D conversion by external trigger (initial value) |
| 1 | Enables start of A/D conversion by rising or falling edge of external trigger at pin ADTRG* |

Note: * The external trigger (ADTRG) edge is selected by bit INTEG4 of the IRQ edge select register (IEGR). See Interrupt Edge Select Register (IEGR) in section 3.3.2, Interrupt Control Registers, for details.

Bits 5 and 4—Reserved Bits: Bits 5 and 4 are reserved; they are always read as 1, and cannot be modified.

Bits 3 to 0—Channel Select (CH3 to CH0): Bits 3 to 0 select the analog input channel.

The channel selection should be made while bit ADSF is cleared to 0.

| Bit 3: CH3 | Bit 2: CH2 | Bit 1: CH1 | Bit 0: CH0 | Analog Input Channel | |
|---------------|---------------|---------------|---------------|--------------------------------|-----------------|
| 0 | 0 | * | * | No channel selected | (initial value) |
| | 1 | 0 | 0 | AN ₀ * ¹ | |
| | | | 1 | AN ₁ * ¹ | |
| | | 1 | 0 | AN ₂ *1 | |
| | | | 1 | AN ₃ * ¹ | |
| 1 | 0 | 0 | 0 | AN ₄ | |
| | | | 1 | AN ₅ | |
| | | 1 | 0 | AN ₆ | |
| | | | 1 | AN ₇ | |
| 1 | 1 | * | * | Reserved | |

Legend: * Don't care

Note: 1. Channels AN_0 to AN_3 are functions of the H8/3857 Group only, and must not be selected in the H8/3854 Group.

12.2.3 A/D Start Register (ADSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|---|---|
| | ADSF | | _ | | _ | _ | _ | — |
| Initial value | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | | _ | _ | _ | _ | _ | _ |

The A/D start register (ADSR) is an 8-bit read/write register for starting and stopping A/D conversion.

A/D conversion is started by writing 1 to the A/D start flag (ADSF) or by input of the designated edge of the external trigger signal, which also sets ADSF to 1. When conversion is complete, the converted data is set in the A/D result register (ADRR), and at the same time ADSF is cleared to 0.

Bit 7—A/D Start Flag (ADSF): Bit 7 controls and indicates the start and end of A/D conversion.

| Bit 7: ADSF | Description | | |
|-------------|--|--|--|
| 0 | Read: Indicates the completion of A/D conversion (initial va | | |
| | Write: Stops A/D conversion | | |
| 1 | Read: Indicates A/D conversion in progress | | |
| | Write: Starts A/D conversion | | |

Bits 6 to 0—Reserved Bits: Bits 6 to 0 are reserved; they are always read as 1, and cannot be modified.



12.3 Operation

12.3.1 A/D Conversion Operation

The A/D converter operates by successive approximations, and yields its conversion result as 8-bit data.

A/D conversion begins when software sets the A/D start flag (bit ADSF) to 1. Bit ADSF keeps a value of 1 during A/D conversion, and is cleared to 0 automatically when conversion is complete.

The completion of conversion also sets bit IRRAD in interrupt request register 2 (IRR2) to 1. An A/D conversion end interrupt is requested if bit IENAD in interrupt enable register 2 (IENR2) is set to 1.

If the conversion time or input channel needs to be changed in the A/D mode register (AMR) during A/D conversion, bit ADSF should first be cleared to 0, stopping the conversion operation, in order to avoid malfunction.

12.3.2 Start of A/D Conversion by External Trigger Input

The A/D converter can be made to start A/D conversion by input of an external trigger signal. External trigger input is enabled at pin \overline{ADTRG} when bit IRQ4 in port mode register 2 (PMR2) is set to 1, and bit TRGE in AMR is set to 1. Then when the input signal edge designated in bit IEG4 of the IRQ edge select register (IEGR) is detected at pin \overline{ADTRG} , bit ADSF in ADSR will be set to 1, starting A/D conversion.

Figure 12.2 shows the timing.

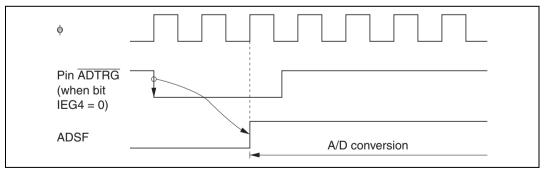


Figure 12.2 External Trigger Input Timing

12.4 Interrupts

When A/D conversion ends (ADSF changes from 1 to 0), bit IRRAD in interrupt request register 2 (IRR2) is set to 1.

A/D conversion end interrupts can be enabled or disabled by means of bit IENAD in interrupt enable register 2 (IENR2).

For further details see section 3.3, Interrupts.

12.5 Typical Use

An example of how the A/D converter can be used is given below, using channel 1 (pin AN1) as the analog input channel. Figure 12.3 shows the operation timing.

- Bits CH3 to CH0 of the A/D mode register (AMR) are set to 0101, making pin AN₁ the analog input channel. A/D interrupts are enabled by setting bit IENAD to 1, and A/D conversion is started by setting bit ADSF to 1.
- When A/D conversion is complete, bit IRRAD is set to 1, and the A/D conversion result is stored in the A/D result register (ADRR). At the same time ADSF is cleared to 0, and the A/D converter goes to the idle state.
- Bit IENAD = 1, so an A/D conversion end interrupt is requested.
- The A/D interrupt handling routine starts.
- The A/D conversion result is read and processed.
- The A/D interrupt handling routine ends.

If ADSF is set to 1 again afterward, A/D conversion starts and steps 2 through 6 take place.

Figures 12.4 and 12.5 show flow charts of procedures for using the A/D converter.



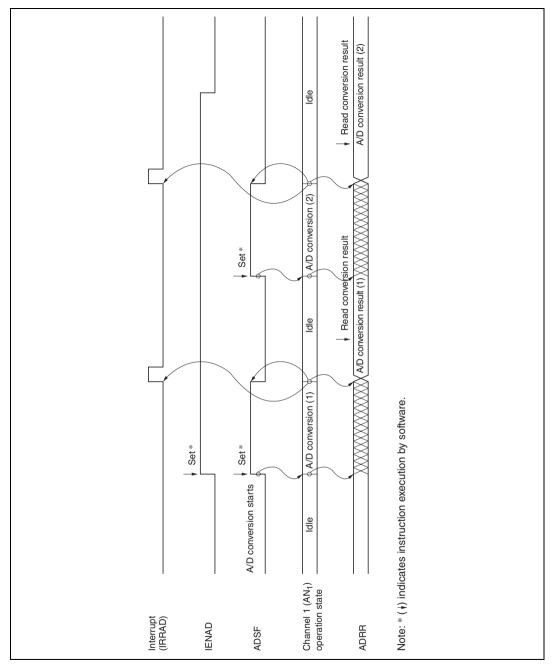


Figure 12.3 Typical A/D Converter Operation Timing

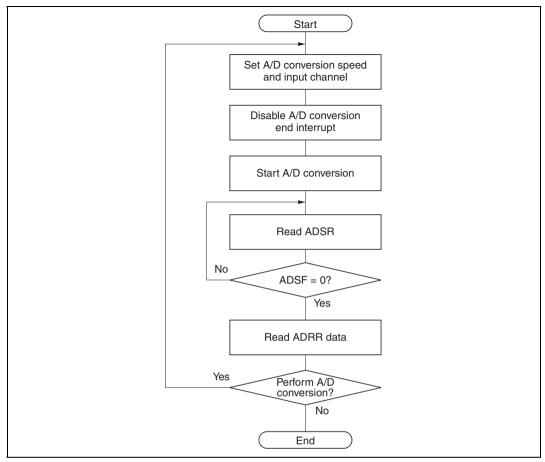


Figure 12.4 Flow Chart of Procedure for Using A/D Converter (1) (Polling by Software)

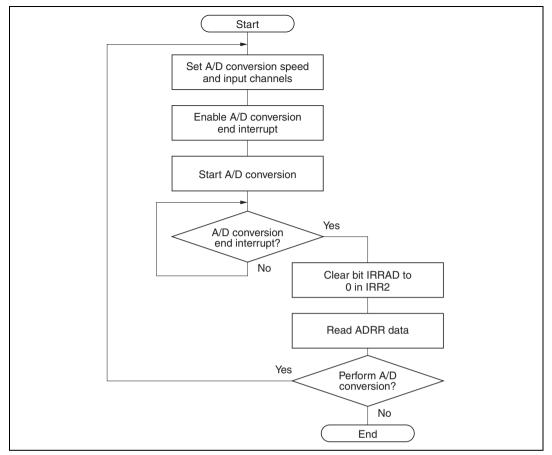


Figure 12.5 Flow Chart of Procedure for Using A/D Converter (2) (Interrupts Used)

12.6 Application Notes

- Data in the A/D result register (ADRR) should be read only when the A/D start flag (ADSF) in the A/D start register (ADSR) is cleared to 0.
- Changing the digital input signal at an adjacent pin during A/D conversion may adversely affect conversion accuracy.



Section 13 Dot Matrix LCD Controller (H8/3857 Group)

13.1 Overview

The LCD controller has built-in display RAM, and performs dot matrix LCD display. One bit of display RAM data corresponds to illumination or non-illumination of one dot on the LCD panel, making possible displays with an extremely high degree of freedom.

The LCD controller incorporates all the functions required for LCD display, allowing a dot matrix display of up to 40×32 dots.

I/O ports are used for the interface with the CPU, offering excellent software heritability when using a combination of MPU and LCD driver.

This module operates on the subclock, making it ideal for use in small portable devices.

13.1.1 Features

- Built-in bit-mapped display RAM (2084 bits)
 Maximum of 1280 display bits (selectable from 40 × 32 bits, 56 × 16 bits, 64 × 8 bits, 40 × 16 bits, or 40 × 8 bits)
- Choice of 1/8, 1/16, or 1/32 duty
- Low power consumption enabling extended drive on battery power Subclock operation
 Module standby
- Built-in 2X or 3X LCD power supply step-up circuit
- Comprehensive display control functions
 Display data read/write, display on/off control, vertical display scrolling, arbitrary area blinking, read-modify-write
- CPU interface
 - I/O port interface
- Built-in contrast control circuit
- Built-in LCD power supply bleeder resistances and voltage follower type op-amp circuits

RENESAS

13.1.2 Block Diagram

Figure 13.1 shows a block diagram of the LCD controller.

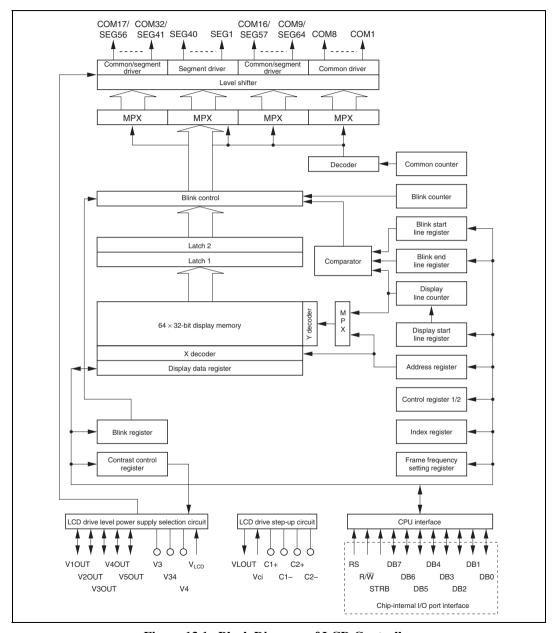


Figure 13.1 Block Diagram of LCD Controller

13.1.3 Pin Configuration

Table 13.1 shows the pins assigned to the LCD controller.

Table 13.1 Pin Configuration

| Pin Name | Abbr. | I/O | Function |
|--|----------------------|--------|---|
| Common output pins | COM1 to COM32 | Output | LCD common drive pins |
| Segment output pins | SEG1 to SEG64 | Output | LCD segment drive pins |
| LCD bias setting pins | V3, V4 | Input | LCD bias setting |
| LCD test pin | V34 | Input | Internal resistance test pins, shorted to V3 |
| LCD step-up capacitance connection pins | C1+, C1– C2+, C2– | _ | For connection of external capacitances for LCD step-up |
| LCD drive power supply level | V1OUT to V5OUT | I/O | LCD drive power supply level input/output pins |
| LCD step-up circuit reference power supply | V _{Ci} | Input | Reference input voltage for LCD step-up circuit, also functioning as step-up circuit power supply |
| LCD step-up power supply output pin | VLOUT | Output | LCD step-up voltage output pin |
| LCD drive power supply | V _{LCD} | Input | LCD drive power supply input pin |

13.1.4 Register Configuration

The LCD controller has one index register and ten control registers, all of which are accessed via an I/O port interface. Except for the display data register (LR4), these registers cannot be read. The LCD controller register configuration is shown in table 13.2.

Table 13.2 Register Configuration

| | | | | | Index | Regis | ter |
|----------------------------------|-------|-----|----|-----|-------|-------|-----|
| Name | Abbr. | R/W | RS | IR3 | IR2 | IR1 | IR0 |
| Index register | IR | W | 0 | _ | _ | _ | _ |
| Control register 1 | LR0 | W | 1 | 0 | 0 | 0 | 0 |
| Control register 2 | LR1 | W | | | | | 1 |
| Address register | LR2 | W | | | | 1 | 0 |
| Frame frequency setting register | LR3 | W | | | | | 1 |
| Display data register | LR4 | R/W | | | 1 | 0 | 0 |
| Display start line register | LR5 | W | | | | | 1 |
| Blink register | LR6 | W | | | | 1 | 0 |
| Blink start line register | LR8 | W | _ | 1 | 0 | 0 | 0 |
| Blink end line register | LR9 | W | _ | | | | 1 |
| Contrast control register | LRA | W | | | | 1 | 0 |

13.2 Register Descriptions

13.2.1 Index Register (IR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|-----|-----|-----|-----|
| | | _ | _ | _ | IR3 | IR2 | IR1 | IR0 |
| Initial value | _ | _ | _ | _ | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | _ | W | W | W | W |

IR is an 8-bit write-only register that selects one of the LCD controller's ten control registers. IR is selected when RS is 0.

Upon reset, IR is initialized to H'00.

Bits 7 to 4—Reserved Bits: Bits 7 to 4 are reserved; they should always be cleared to 0.

Bits 3 to 0—Index Register (IR3 to IR0): Bits 3 to 0 are used to select one of the LCD controller's ten control registers. The correspondence between the settings of IR3 to IR0 and the selected registers is shown in table 13.2. Other settings are invalid.

13.2.2 Control Register 1 (LR0)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---------------|---|---|------|-----|---|-----|-------|-------|--|
| | _ | _ | LSBY | PWR | _ | SOB | DDTY1 | DDTY0 | |
| Initial value | _ | _ | 0 | 0 | _ | 0 | 0 | 0 | |
| Read/Write | _ | _ | W | W | _ | W | W | W | |

LR0 is an 8-bit write-only register that performs LCD module standby mode setting, step-up circuit control, switching between character display and graphic display, and drive duty selection.

Upon reset, LR0 is initialized to H'00.

Bits 7 and 6—Reserved Bits: Bits 7 and 6 are reserved; they should always be cleared to 0.

Bit 5—Module Standby (LSBY): Bit 5 is the module standby setting bit. When LSBY is set to 1, the LCD controller enters standby mode. At this time, the state of the PWR bit is not affected, but the DISP and OPON bits in LR1 are reset.

Bit 5: LSBY Description

| 0 | LCD controller operates normally | (initial value) |
|---|---|------------------|
| 1 | Step-up and internal operations halt, display is turned off, and LCD costandby mode | ontroller enters |

Bit 4—Step-Up Circuit Operation Setting (PWR): Bit 4 selects operation or halting of the step-up circuit.

Bit 4: PWR Description

| 0 | Step-up circuit halts | (initial value) |
|---|--------------------------|-----------------|
| 1 | Step-up circuit operates | |

Bit 3—Reserved Bit: Bit 3 is reserved; it should always be cleared to 0.

Bit 2—Display Mode Select (SOB): Bit 2 selects either character display mode or graphic display mode.

| Bit 2: SOB | Description | | | | | |
|------------|---|--|--|--|--|--|
| 0 | Character display mode | | | | | |
| | Bits 4 to 0 of one display memory data byte are output to the segment pins | | | | | |
| | (initial value) | | | | | |
| 1 | Graphic display mode | | | | | |
| | All bits in one display memory data byte are output to the segment pins | | | | | |
| | The X address that can be output is in the range H'0 to H'4 in the case of 1/32 duty, H'0 to H'6 in the case of 1/16 duty, and H'0 to H'7 in the case of 1/8 duty | | | | | |

Bits 1 and 0—Display Duty Select (DDTY1, DDTY0): Bits 1 and 0 select a display duty of 1/32, 1/16, or 1/8.

Bit 1: DDTY1 Bit 0: DDTY0 Description

| 0 | 0 | 1/32 duty selected | (initial value) |
|---|---|--|-----------------|
| | 1 | 1/16 duty selected | |
| | | Y address H'10 to H'1F display data is invalid | |
| 1 | * | 1/8 duty selected | |
| | | Y address H'8 to H'1F display data is invalid | |

Legend: * Don't care



13.2.3 Control Register 2 (LR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|------|---|------|-----|---|-----|-----|
| | | DISP | _ | OPON | RMW | | INC | BLK |
| Initial value | _ | 0 | _ | 0 | 0 | _ | 0 | 0 |
| Read/Write | _ | W | _ | W | W | _ | W | W |

LR1 is an 8-bit write-only register that selects operation or halting of LCD display and the op-amp circuits, performs read-modify-write mode setting, and selects the address to be incremented in the display memory.

Upon reset, LR1 is initialized to H'00.

Bit 7—Reserved Bit: Bit 7 is reserved; it should always be cleared to 0.

Bit 6—LCD Operation Setting (DISP): Bit 6 selects operation or halting of the LCD display. When the LSBY bit in LR0 is set to 1, DISP is cleared.

Bit 6: DISP Description

| 0 | LCD is turned off. All LCD outputs go to the V _{ss} level | (initial value) |
|---|--|-----------------|
| 1 | LCD is turned on | _ |

Bit 5—Reserved Bit: Bit 5 is reserved; it should always be cleared to 0.

Bit 4—Op-Amp Circuit Operation Setting (OPON): Bit 4 selects operation or halting of the opamp circuits. When the LCD drive power supply level is applied to V1OUT to V5OUT from an external source, OPON must be cleared to 0.

When the LSBY bit in LR0 is set to 1, OPON is cleared.

Bit 4: OPON Description

| 0 | Built-in op-amps are halted, and output becomes high-impedance. LCI voltage can be input from external source | drive (initial value) |
|---|---|--------------------------|
| 1 | Built-in op-amps operate | |

Bit 3—Read-Modify-Write Setting (RMW): Bit 3 selects whether display memory X or Y address incrementing is carried out after a write/read access, or only after a write access (read-modify-write mode).

Bit 3: RMW Description

| 0 | Address is incremented after write/read access to display memory | (initial value) |
|---|---|-----------------|
| 1 | Read-modify-write mode is set | |
| | In this mode, address is incremented only after write access to display | memory |

Bit 2—Reserved Bit: Bit 2 is reserved; it should always be cleared to 0.

Bit 1—Increment Address Select (INC): Bit 1 selects either the X address or the Y address as the address to be incremented after the display memory access specified by the RMW bit. The selected address is cleared after a display memory access with the maximum value for the valid display data area; in this case the other address is incremented.

Bit 1: INC Description

| | • | | | | |
|---|--|--|--|--|--|
| 0 | Incrementing of display memory Y address has priority; X address is incremented | | | | |
| | after Y address overflow (initial value | | | | |
| 1 | Incrementing of display memory X address has priority; Y address is incremented after X address overflow | | | | |

Bit 0—Blink Operation Setting (BLK): Bit 0 enables or disables the blink function. If BLK is set to 1 while the DISP bit is set to 1 and LCD display is operating, the blink function is enabled and blinking operates in the range set by BK7 to BK0 in LR6, BSL4 to BSL0 in LR8, and BEL4 to BEL0 in LR9.

Bit 0: BLK Description

| 0 | Blinking is disabled | (initial value) |
|---|----------------------|-----------------|
| 1 | Blinking is enabled | |



Address Register (LR2) 13.2.4

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| | XA2 | XA1 | XA0 | YA4 | YA3 | YA2 | YA1 | YA0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

LR2 is an 8-bit write-only register that sets the display memory X- and Y-direction addresses accessed by the CPU.

Upon reset, LR2 is initialized to H'00.

Bits 7 to 5—X Address Setting (XA2 to XA0): Bits 7 to 5 set the display memory X-direction address. A value from H'0 to H'7 can be set, but if the SOB bit in LR0 is set to 1, display data H'7 is invalid with 1/16 duty, and display data from H'5 to H'7 is invalid with 1/32 duty.

When the INC bit in LR1 is set to 1, the address is automatically incremented after the access specified by the RMW bit in LR1, and is cleared after an access with the maximum value for the valid display data area. When INC is 0 and YA4 to YA0 represent the maximum value for the valid display data area, the address is incremented after the access specified by RMW.

Bits 4 to 0—Y Address Setting (YA4 to YA0): Bits 4 to 0 set the display memory Y-direction address. A value from H'00 to H'1F can be set, but display data from H'10 to H'1F is invalid with 1/16 duty, and display data from H'08 to H'1F is invalid with 1/8 duty.

When the INC bit in LR1 is cleared to 0, the address is automatically incremented after the access specified by the RMW bit in LR1, and is cleared after an access with the maximum value for the valid display data area. When INC is 1 and XA2 to XA0 represent the maximum value for the valid display data area, the address is incremented after the access specified by RMW.

13.2.5 Frame Frequency Setting Register (LR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|-----|-----|-----|-----|-----|-----|
| | | _ | FS5 | FS4 | FS3 | FS2 | FS1 | FS0 |
| Initial value | _ | _ | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | | _ | W | W | W | W | W | W |

LR3 is an 8-bit write-only register that sets the frame frequency.

Upon reset, LR3 is initialized to H'00.

Bits 7 and 6—Reserved Bits: Bits 7 and 6 are reserved; they should always be cleared to 0.

Bits 5 to 0—Frame Frequency Setting (FS5 to FS0): Bits 5 to 0 control the subclock division ratio and set the LCD frame frequency. The relationship between the LCD frame frequency f_F (Hz), the subclock frequency f_W (Hz), the division ratio r, and the LCD duty 1/N is as follows:

$$f_F = \frac{f_W}{r \times N}$$

Set a division ratio suitable for the characteristics of the LCD panel used. The correspondence between register settings and division ratios is shown in table 13.3.



Table 13.3 Register Settings and Division Ratios

| | | | FS | | | _Division | | | I | FS | | | _Division | | | | FS | | | _Division | | | | FS | | | Division |
|---|---|---|----|---|---|-----------|---|---|---|----|---|---|-----------|---|---|---|----|---|---|-----------|---|---|---|----|---|---|----------|
| 5 | 4 | 3 | 2 | 1 | 0 | Ratio r | 5 | 4 | 3 | 2 | 1 | 0 | Ratio r | 5 | 4 | 3 | 2 | 1 | 0 | Ratio r | 5 | 4 | 3 | 2 | 1 | 0 | Ratio r |
| 0 | 0 | 0 | 0 | 0 | 0 | 2 | 0 | 1 | 0 | 0 | 0 | 0 | 34 | 1 | 0 | 0 | 0 | 0 | 0 | 66 | 1 | 1 | 0 | 0 | 0 | 0 | 98 |
| 0 | 0 | 0 | 0 | 0 | 1 | 4 | 0 | 1 | 0 | 0 | 0 | 1 | 36 | 1 | 0 | 0 | 0 | 0 | 1 | 68 | 1 | 1 | 0 | 0 | 0 | 1 | 100 |
| 0 | 0 | 0 | 0 | 1 | 0 | 6 | 0 | 1 | 0 | 0 | 1 | 0 | 38 | 1 | 0 | 0 | 0 | 1 | 0 | 70 | 1 | 1 | 0 | 0 | 1 | 0 | 102 |
| 0 | 0 | 0 | 0 | 1 | 1 | 8 | 0 | 1 | 0 | 0 | 1 | 1 | 40 | 1 | 0 | 0 | 0 | 1 | 1 | 72 | 1 | 1 | 0 | 0 | 1 | 1 | 104 |
| 0 | 0 | 0 | 1 | 0 | 0 | 10 | 0 | 1 | 0 | 1 | 0 | 0 | 42 | 1 | 0 | 0 | 1 | 0 | 0 | 74 | 1 | 1 | 0 | 1 | 0 | 0 | 106 |
| 0 | 0 | 0 | 1 | 0 | 1 | 12 | 0 | 1 | 0 | 1 | 0 | 1 | 44 | 1 | 0 | 0 | 1 | 0 | 1 | 76 | 1 | 1 | 0 | 1 | 0 | 1 | 108 |
| 0 | 0 | 0 | 1 | 1 | 0 | 14 | 0 | 1 | 0 | 1 | 1 | 0 | 46 | 1 | 0 | 0 | 1 | 1 | 0 | 78 | 1 | 1 | 0 | 1 | 1 | 0 | 110 |
| 0 | 0 | 0 | 1 | 1 | 1 | 16 | 0 | 1 | 0 | 1 | 1 | 1 | 48 | 1 | 0 | 0 | 1 | 1 | 1 | 80 | 1 | 1 | 0 | 1 | 1 | 1 | 112 |
| 0 | 0 | 1 | 0 | 0 | 0 | 18 | 0 | 1 | 1 | 0 | 0 | 0 | 50 | 1 | 0 | 1 | 0 | 0 | 0 | 82 | 1 | 1 | 1 | 0 | 0 | 0 | 114 |
| 0 | 0 | 1 | 0 | 0 | 1 | 20 | 0 | 1 | 1 | 0 | 0 | 1 | 52 | 1 | 0 | 1 | 0 | 0 | 1 | 84 | 1 | 1 | 1 | 0 | 0 | 1 | 116 |
| 0 | 0 | 1 | 0 | 1 | 0 | 22 | 0 | 1 | 1 | 0 | 1 | 0 | 54 | 1 | 0 | 1 | 0 | 1 | 0 | 86 | 1 | 1 | 1 | 0 | 1 | 0 | 118 |
| 0 | 0 | 1 | 0 | 1 | 1 | 24 | 0 | 1 | 1 | 0 | 1 | 1 | 56 | 1 | 0 | 1 | 0 | 1 | 1 | 88 | 1 | 1 | 1 | 0 | 1 | 1 | 120 |
| 0 | 0 | 1 | 1 | 0 | 0 | 26 | 0 | 1 | 1 | 1 | 0 | 0 | 58 | 1 | 0 | 1 | 1 | 0 | 0 | 90 | 1 | 1 | 1 | 1 | 0 | 0 | 122 |
| 0 | 0 | 1 | 1 | 0 | 1 | 28 | 0 | 1 | 1 | 1 | 0 | 1 | 60 | 1 | 0 | 1 | 1 | 0 | 1 | 92 | 1 | 1 | 1 | 1 | 0 | 1 | 124 |
| 0 | 0 | 1 | 1 | 1 | 0 | 30 | 0 | 1 | 1 | 1 | 1 | 0 | 62 | 1 | 0 | 1 | 1 | 1 | 0 | 94 | 1 | 1 | 1 | 1 | 1 | 0 | 126 |
| 0 | 0 | 1 | 1 | 1 | 1 | 32 | 0 | 1 | 1 | 1 | 1 | 1 | 64 | 1 | 0 | 1 | 1 | 1 | 1 | 96 | 1 | 1 | 1 | 1 | 1 | 1 | 128 |

Examples of subclock frequency, LCD duty, and division ratio settings, and frame frequencies, are shown in table 13.4.

Table 13.4 Sample Frame Frequency Settings

| | | Subclock Frequency (kHz) | | | | | | |
|--------|-------------------------------------|--------------------------|------|---|--|--|--|--|
| Displa | y Duty 1/N | 32.768 | 38.4 | , | | | | |
| 1/8 | Division ratio r | 48 | 56 | | | | | |
| | Frame frequency f _F (Hz) | 85.3 | 85.7 | | | | | |
| 1/16 | Division ratio r | 24 | 28 | | | | | |
| | Frame frequency f _F (Hz) | 85.3 | 85.7 | | | | | |
| 1/32 | Division ratio r | 12 | 14 | | | | | |
| | Frame frequency f _F (Hz) | 85.3 | 85.7 | | | | | |

13.2.6 Display Data Register (LR4)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Initial value | Undefined |
| Read/Write | R/W |

LR4 is an 8-bit read/write register used to perform read/write access to the display memory specified by XA2 to XA0 and YA4 to YA0 in LR2.

In a write to display memory, the write is performed directly to the display memory via this register. In a read, the data is temporarily latched into this register before being output to the bus.

After a reset, the display memory and LR4 contents are undefined.

13.2.7 Display Start Line Register (LR5)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|-----|-----|-----|-----|-----|
| | _ | _ | _ | ST4 | ST3 | ST2 | ST1 | ST0 |
| Initial value | _ | _ | _ | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | | _ | W | W | W | W | W |

LR5 is an 8-bit write-only register that specifies the line at which display starts.

Upon reset, LR5 is initialized to H'00.

Bits 7 to 5—Reserved Bits: Bits 7 to 5 are reserved; they should always be cleared to 0.

Bits 4 to 0—Display Start Line Setting (ST4 to ST0): Bits 4 to 0 specify the line at which display starts. Set a value of [display start line -1].

Changing the setting in this register enables vertical scrolling to be implemented. The possible settings are 0 to 31 for 1/32 duty, 0 to 15 for 1/16 duty, and 0 to 7 for 1/8 duty. Display will not be performed normally if these ranges are exceeded.



Blink Register (LR6) 13.2.8

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| | BK7 | BK6 | BK5 | BK4 | ВК3 | BK2 | BK1 | BK0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

LR6 is an 8-bit write-only register that specifies blink areas. An area is made to blink by writing 1 to the corresponding bit in this register. There are no restrictions on areas that can blink simultaneously, and the entire screen can be made to blink by writing 1 to all the bits. The setting in this register is valid only when the BLK bit in LR1 is set to 1.

The blink areas corresponding to the register bits depend on the value of the SOB bit in LRO, as shown below.

| SOB | BK7 | BK6 | BK5 | BK4 | ВК3 | BK2 | BK1 | BK0 |
|-----|-------------------|-------------------|-----|-----|-------------------|-----|------------------|-----------------|
| 0 | | SEG31 to SEG35 | | | SEG16 to SEG20 | | | SEG1 to SEG5 |
| 1 | SEG57 to SEG64 | | | | SEG25 to SEG32 | | SEG9 to SEG16 | SEG1 to SEG8 |

Upon reset, LR6 is initialized to H'00.

13.2.9 Blink Start Line Register (LR8)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|------|------|------|------|------|
| | | _ | | BSL4 | BSL3 | BSL2 | BSL1 | BSL0 |
| Initial value | _ | _ | _ | 0 | 0 | 0 | 0 | 0 |
| Read/Write | _ | | _ | W | W | W | W | W |

LR8 is an 8-bit write-only register that specifies the start line of an area made to blink.

Upon reset, LR8 is initialized to H'00.

Bits 7 to 5—Reserved Bits: Bits 7 to 5 are reserved; they should always be cleared to 0.

Bits 4 to 0—Blink Start Line Setting (BSL4 to BSL0): Bits 4 to 0 specify the start line of an area made to blink. Set a value of [blink start line -1].

The possible settings are 0 to 31 for 1/32 duty, 0 to 15 for 1/16 duty, and 0 to 7 for 1/8 duty. Normal operation is not guaranteed if these ranges are exceeded.

13.2.10 Blink End Line Register (LR9)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|------|------|------|------|------|
| | _ | _ | _ | BEL4 | BEL3 | BEL2 | BEL1 | BEL0 |
| Initial value | _ | _ | _ | 0 | 0 | 0 | 0 | 0 |
| Read/Write | | | _ | W | W | W | W | W |

LR9 is an 8-bit write-only register that specifies the end line of an area made to blink.

Upon reset, LR9 is initialized to H'00.

Bits 7 to 5—Reserved Bits: Bits 7 to 5 are reserved; they should always be cleared to 0.

Bits 4 to 0—Blink End Line Setting (BEL4 to BEL0): Bits 4 to 0 specify the end line of an area made to blink. Set a value of [blink end line -1].

The possible settings are 0 to 31 for 1/32 duty, 0 to 15 for 1/16 duty, and 0 to 7 for 1/8 duty. Normal operation is not guaranteed if these ranges are exceeded.

13.2.11 Contrast Control Register (LRA)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---------------|---|---|---|---|------|------|------|------|--|
| | | | | | CCR3 | CCR2 | CCR1 | CCR0 | |
| Initial value | _ | _ | _ | _ | 0 | 0 | 0 | 0 | |
| Read/Write | | _ | | | W | W | W | W | |

LRA is an 8-bit write-only register that specifies the contrast control resistance value.

Upon reset, LRA is initialized to H'00.

Bits 7 to 4—Reserved Bits: Bits 7 to 4 are reserved; they should always be cleared to 0.



Bits 3 to 0—Contrast Control Setting (CCR3 to CCR0): Bits 3 to 0 specify the value of the contrast control resistance between the $V_{\tiny LCD}$ and V1 levels. By adjusting the contrast control resistance between the $V_{\tiny LCD}$ and V1 levels, it is possible to adjust the contrast of the LCD panel. The contrast control resistance can be set in the range from 0.1R to 1.6R, where R is the LCD bleeder resistance.

| Bit 3: CCR3 | Bit 2: CCR2 | Bit 1: CCR1 | Bit 0: CCR0 | Contrast Control Resistance | |
|----------------|----------------|----------------|----------------|-----------------------------|-----------------|
| 0 | 0 | 0 | 0 | 1.6R | (initial value) |
| | | | 1 | 1.5R | |
| | | 1 | 0 | 1.4R | |
| | | | 1 | 1.3R | |
| | 1 | 0 | 0 | 1.2R | |
| | | | 1 | 1.1R | |
| | | 1 | 0 | 1.0R | |
| | | | 1 | 0.9R | |
| 1 | 0 | 0 | 0 | 0.8R | |
| | | | 1 | 0.7R | |
| | | 1 | 0 | 0.6R | |
| | | | 1 | 0.5R | |
| | 1 | 0 | 0 | 0.4R | |
| | | | 1 | 0.3R | |
| | | 1 | 0 | 0.2R | |
| | | | 1 | 0.1R | |

13.3 Operation

13.3.1 System Overview

The LCD controller operates at 1/32, 1/16, or 1/8 duty. The display size is a maximum of 40×32 dots (4 rows of 8 columns with a 5×8 -dot font). As the LCD controller operates on the subclock to perform display control, the time, etc., can be constantly displayed. As this module includes a built-in 2X or 3X LCD power supply step-up circuit, an LCD system can be configured with just a few external parts (resistors and capacitors). Also, since data in the display RAM is retained even in module standby mode, and step-up operation is not performed, low power consumption can be achieved without affecting the display.

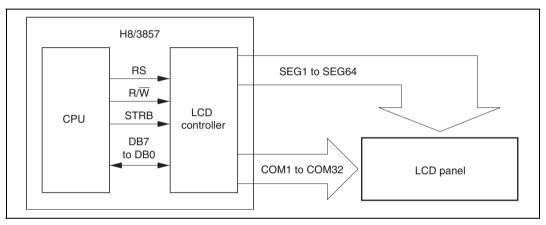


Figure 13.2 System Block Diagram

13.3.2 CPU Interface

The LCD controller's registers are not included in the memory map shown in figure 2.16 (a). They are controlled from the CPU by means of chip-internal LCD pins DB7 to DB0, RS, R/ \overline{W} , and STRB, via chip-internal I/O ports 9 and A. The pin configuration is shown in table 13.5, and an example of the timing for access to registers in the LCD controller is shown in figure 13.3. For information on port 9 and port A, see the descriptions in section 8, I/O Ports.

Table 13.5 Pin Configuration

| Pin Name | Abbr. | I/O | Function |
|-----------------------|---|-------|--|
| Data bus pins | DB7 to DB0 | I/O | When $R/\overline{W}=0$, these pins input data to be written to a register; when $R/\overline{W}=1$, they output data read from a register |
| Register selector pin | RS | Input | When $R/S = 0$, the index register is selected; when $RS = 1$, a control register is selected |
| Read/write select pin | e R/\overline{W} Input When $R/\overline{W} = 0$, write access is selected | | When $R/\overline{W} = 0$, write access is selected; when $R/\overline{W} = 1$, read access is selected |
| Strobe pin | STRB | Input | At the fall of STRB, read or write access, as selected by R/\overline{W} , is performed on the register selected by RS |

Writing to Index Register

When RS and R/\overline{W} are both cleared to 0, data DB7 to DB0 is written to the index register (IR) at the falling edge of STRB. Do not change RS or R/\overline{W} at the fall of STRB.

Reading and Writing to Control Registers

To access a control register, data indicating the number of the register to be accessed must be written to the index register (IR) before making the access. The register number data to be written to IR is shown in table 13.2. As the register number written to IR is retained until IR is written to again, if the same control register is accessed repeatedly, it is not necessary to write to IR each time.

In a write to a control register, when RS has been set to 1 and R/\overline{W} cleared to 0, data DB7 to DB0 is written to the control register specified by the index register (IR) at the falling edge of STRB.

Except for the display data register (LR4), control registers cannot be read. In a read of LR4, when the LR4 register number is written to the index register (IR), and RS and R/\overline{W} are both set to 1, DB7 to DB0 are set to output mode, and the display memory data at the address specified by the address register (LR2) is output from DB7 to DB0 at the rising edge of STRB. If a read is also performed in the next cycle, the data output is held until the next rise of STRB, but if a write is

performed in the next cycle, DB7 to DB0 are set to input mode from the point at which R/\overline{W} is cleared to 0, and the output is cleared.

In either case, do not change RS or R/\overline{W} at the fall of STRB.

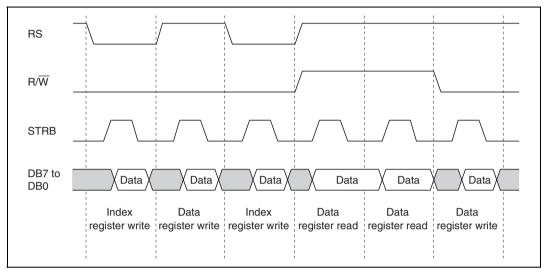


Figure 13.3 Example of Timing Sequence for 8-Bit Data Transfer

Notes on Use of Chip-Internal I/O Ports

For LCD controller interface internal ports 9 and A, port input/output is controlled by means of PCR9 and PCRA in the same way as for ordinary I/O ports, and in output mode, the values set in PDR9 or PDRA are output. Also, LCD controller internal pins RS, R/\overline{W} , and STRB are input-only pins, and DB7 to DB0 input/output is controlled by R/\overline{W} . Therefore, the following points must be noted.

1. After reset release and standby mode release

Since the chip's internal I/O ports go to the high-impedance state in a reset and in standby mode, in initialization after reset or standby mode release, H'06 should be set in PDRA, and H'07 in PCRA. This will set port A to output mode. If the PDRA setting were H'00, there would be a possibility of the index register (IR) being written to.

2. Changing register read/write setting

When an LCD controller register is read $(R/\overline{W}=1)$, DB7 to DB0 output data from the LCD controller side, and so port 9 must be set to input mode. Therefore, H'00 must be written to PCR9, setting port 9 to input mode, before changing the R/\overline{W} setting from 0 to 1. When writing data to an LCD controller register, first change R/\overline{W} from 1 to 0, then write H'FF to PCR9, setting port 9 to output mode.

Examples of display data register (LR4) read/write access when read-modify-write is designated are shown below.

[Set index register to display data register]

| • | Port A | set to | output mode. | RMW set to 1 | |
|---|--------|--------|--------------|--------------|--|

| MOV.W | #H'0100,R1 |
|-------|---|
| MOV.W | #H'04FF,R0 |
| MOV.B | R1L,@PDRA Clear R/\overline{W} to 0 |
| MOV.B | ROH,@PDR9 |
| MOV.B | ROL,@PCR9 Output H'04 from port 9 |
| MOV.B | R1H,@PDRA |
| MOV.B | R1L,@PDRAWrite H'04 to index register |
| | |

[Read display data register]

| MOV.B | R1L,@PCR9 Set port 9 to input mode |
|-------|---|
| MOV.W | #H'0706, R2 |
| MOV.B | R2L,@PDRA Set R/\overline{W} to 1 |
| MOV.B | R2H,@PDRA |
| MOV.B | @PDR9, R0HRead PDR9 into general register |
| MOV.B | R2L,@PDRA |

[Write to display data register]

| MOV.W | #H'0504,R3 |
|-------|---|
| MOV.B | R3L,@PDRA Clear R/\overline{W} to 0 |
| NOT.B | ROH Invert general register data |
| MOV.B | ROH,@PDR9 |
| MOV.B | ROL, @PCR9 Set port 9 to output mode |
| MOV.B | R3H,@PDRA |
| MOV.B | R3L @PDRA Write data to display data register |

13.3.3 LCD Drive Pin Functions

Common/Segment Output Switching

Among the LCD controller's LCD drive outputs, COM9 to COM32 and SEG64 to SEG41 are switched according to the display duty and display mode.

The display duty is set by control register 1 (LR0) bits DDTY1 and DDTY0, and the display mode by bit SOB.

(1) When SOB = 0 (character display mode)

• 1/8 duty (DDTY1 = 1)

Common outputs: COM1 to COM8
Segment outputs: SEG1 to SEG40

Note: COM9/SEG64 to COM16/SEG57 output common signal non-selection waveforms, COM17/SEG56 to COM24/SEG49 output the same waveforms as COM1 to COM8, and COM25/SEG48 to COM32/SEG41 output common signal non-selection waveforms.

• 1/16 duty (DDTY1 = 0, DDTY0 = 1)

Common outputs: COM1 to COM16
Segment outputs: SEG1 to SEG40

Note: COM17/SEG56 to COM32/SEG41 output the same waveforms as COM1 to COM16.

• 1/32 duty (DDTY1 = 0, DDTY0 = 0)

Common outputs: COM1 to COM32 Segment outputs: SEG1 to SEG40

(2) When SOB = 1 (graphic display mode)

• 1/8 duty (DDTY1 = 1)

Common outputs: COM1 to COM8
Segment outputs: SEG1 to SEG64

• 1/16 duty (DDTY1 = 0, DDTY0 = 1)

Common outputs: COM1 to COM16
Segment outputs: SEG1 to SEG56

• 1/32 duty (DDTY1 = 0, DDTY0 = 0)

Common outputs: COM1 to COM32

Segment outputs: SEG1 to SEG40

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Table 13.6 Pin Functions According to Display Mode and Display Duty

| | Function | | | | | | |
|-------------------------------|--------------------------------------|------------------|-------------------|--------------------------------|------------------|-------------------|--|
| | SOB = 0 (Character Display Mode) | | | SOB = 1 (Graphic Display Mode) | | | |
| Pin Name | 1/8 Duty | 1/16 Duty | 1/32 Duty | 1/8 Duty | 1/16 Duty | 1/32 Duty | |
| COM1 to COM8 | COM1 to COM8 | COM1 to COM16 | COM1 to COM16 | COM1 to COM8 | COM1 to COM16 | COM1 to COM16 | |
| COM9/SEG64 to COM16/SEG57 | Common signal non-selection waveform | _ | | SEG64 to SEG57 | _ | | |
| SEG1 to SEG40 | SEG1 to SEG40 | SEG1 to SEG40 | SEG1 to SEG40 | SEG1 to SEG56 | SEG1 to SEG56 | SEG1 to SEG40 | |
| COM32/SEG41 to COM25/SEG48 | Common signal non-selection waveform | COM16 to COM1 | COM32 to COM17 | - | | COM32 to COM17 | |
| COM24/SEG49 to COM17/SEG56 | COM8 to COM1 | _ | | | | | |

Function

13.3.4 Display Memory Configuration and Display

The LCD controller includes 64×32 -bit bit-mapped display memory. As the display memory configuration, a 5-bit \times 8 or 8-bit \times n (n = 5, 7, or 8) X-direction combination can be selected, while the Y-direction configuration is 32 bits. Display data written from the CPU is stored horizontally with the MSB at the left and the LSB at the right, as shown in figure 13.4. On the display, 1 data corresponds to illumination (black), and 0 data to non-illumination (colorless).

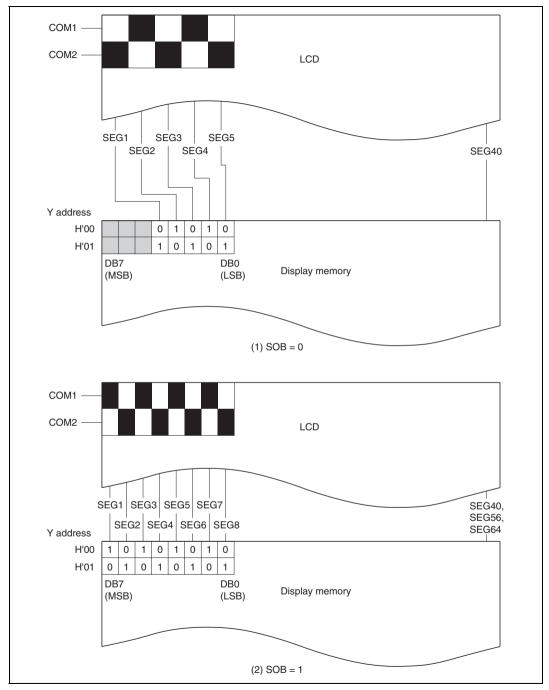


Figure 13.4 Memory Data and Display

13.3.5 Display Data Output

The LCD controller has a character display mode (SOB = 0) in which only 5 bits of each display data byte can be output to perform efficient 5-dot \times 8-dot character output, and a graphic display mode (SOB = 1) in which all the bits of a data byte can be output to perform efficient full-dot graphic display. The relationship between the display duty and output pins in each mode is shown in figure 13.5.

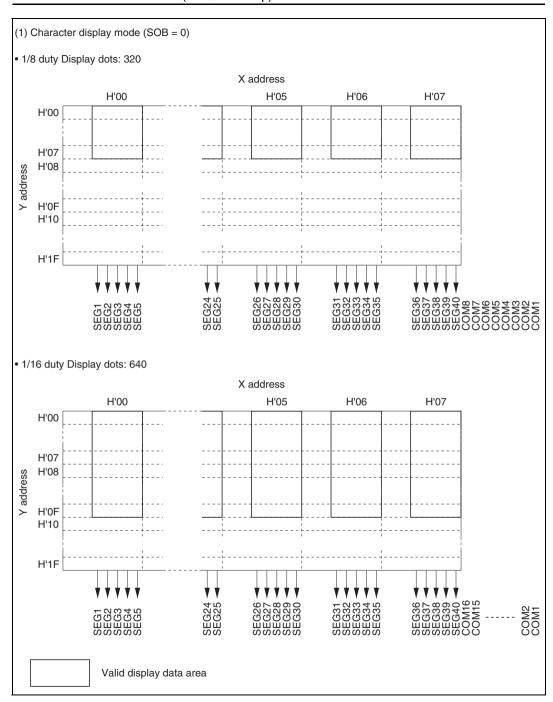


Figure 13.5 Display Duty and Valid Display Data Area (1)

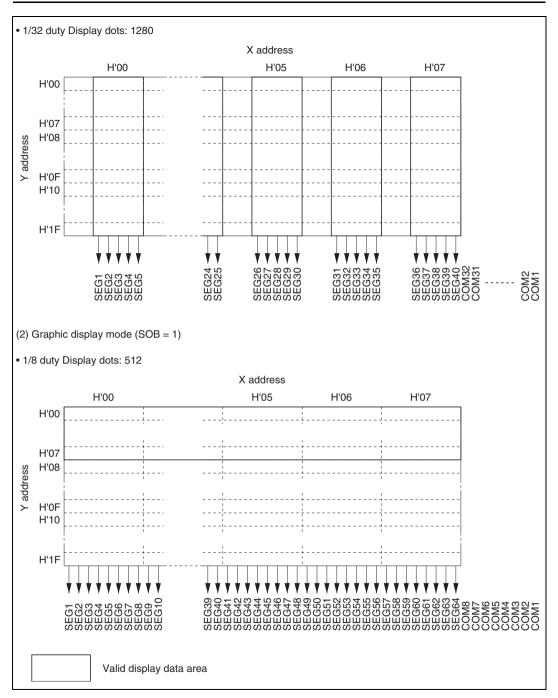


Figure 13.5 Display Duty and Valid Display Data Area (2)

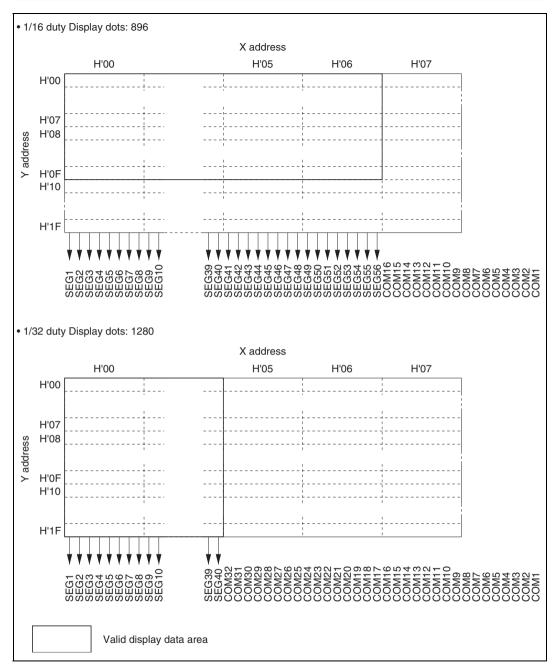


Figure 13.5 Display Duty and Valid Display Data Area (3)

13.3.6 **Register and Display Memory Access**

Register Access

To access a register, RS is first cleared to 0 and the register number of the register to be accessed is set in the index register. Then RS is set to 1, enabling the specified register to be accessed. Some internal registers have nonexistent bits; 0 must be written to these bits. The display data register (LR4) is the only register that can be read.

Display Memory Access

To access the display memory, the address to be accessed is set in the address register (LR2). The memory is then accessed via the display data register (LR4). This access can be performed without awareness of the display-side read. See figure 13.6 for the procedure.

After the respective display data register (LR4) accesses, the X and Y addresses are automatically incremented on the basis of the value set in the INC bit in control register 2 (LR1), and therefore address settings need not be made each time.

With 1/32 duty (DDTY1 = 0, DDTY0 = 0) in graphic display mode (SOB = 1), if INC = 0 the X address remains the same in each read/write access to the display data register (LR4), while the Y address is automatically incremented up to H'1F. After reaching H'1F, the Y address returns to H'00 again, and the X address is simultaneously incremented. If INC = 1, on the other hand, the Y address remains the same in each read/write access to the display data register (LR4), while the X address is automatically incremented up to H'4. After reaching H'4, the X address returns to H'0 again, and the Y address is simultaneously incremented. In this way, consecutive read/write accesses can be made to the entire display memory area.

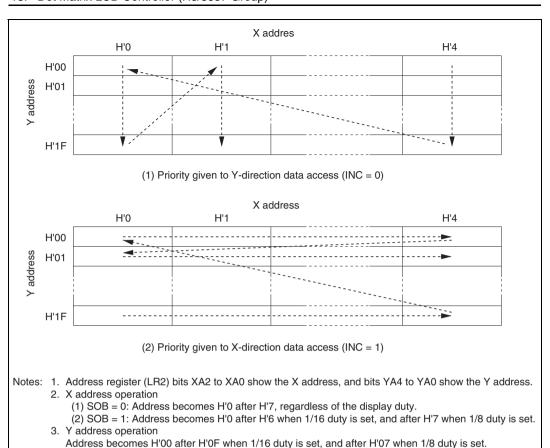


Figure 13.6 Display Memory Access Methods (SOB = 1, 1/32 Duty)

Reading for Display

The LCD controller's display RAM is of the dual-port type, with accesses from the CPU and reads for LCD display independent of each other. This allows flexible interfacing.

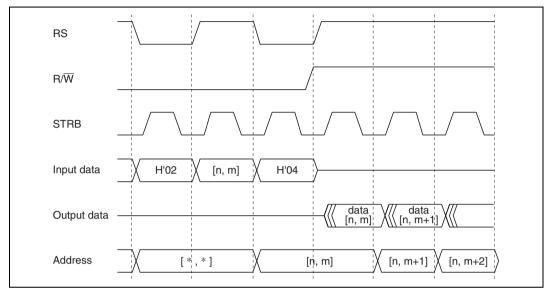


Figure 13.7 Memory Read Procedure

Read-Modify-Write Mode

In the normal state, the X or Y address is incremented after both read and write accesses to the display memory. In read-modify-write mode, the address is incremented only after a write, and remains the same after a read. By using this mode, it is possible to read previously written data, process that data, and then write it back to the same address.

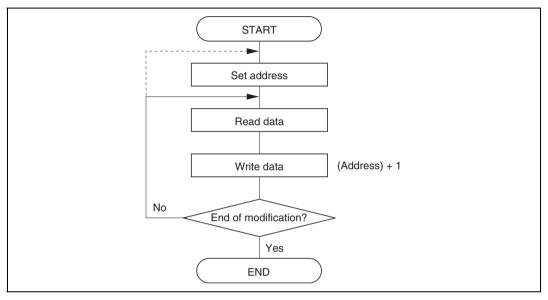


Figure 13.8 Read-Modify-Write Mode Flowchart

13.3.7 Scroll Function

The LCD controller allows vertical scrolling of any number of lines to be performed by specifying the display start line. Figure 13.9 shows the relationship between the display memory and Y address, and the display memory and LCD display after scrolling, for 1/16 duty and 1/8 duty settings. If the display start address is set to H'01, the data at Y address H'00 is displayed in the 16th line. Therefore, when the display is scrolled in order to show the next screen, the data at Y address H'00 must be rewritten with the next display data. This data update should be carried out after the display is scrolled.

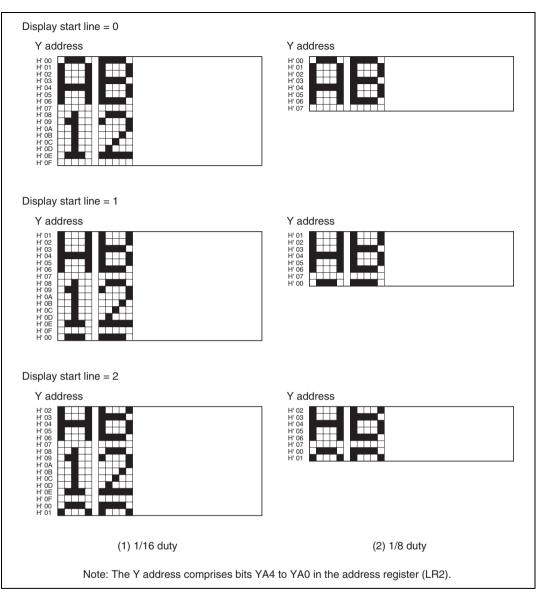


Figure 13.9 Vertical Scrolling

13.3.8 Blink Function

Dot Matrix Display Blinking

The LCD controller can perform blinking display in any area. With an 80 Hz frame frequency, the display goes on and off in a cycle of approximately 1.6 seconds.

To set a blink area, in the horizontal direction the line unit is specified by means of the blink start line register (LR8) and blink end line register (LR9), while in the vertical direction a 5-bit unit (SOB = 0) or 8-bit unit (SOB = 1) is set in the blink register (LR6). When 1 is set in the blink register (LR6), blinking of the corresponding dot is controlled. After making these register settings, blinking is started by setting the BLK bit in control register 2 (LR1) to 1. As the blink area is designated by an absolute specification with respect to the display memory, if the display is scrolled the blink area also shifts accordingly.

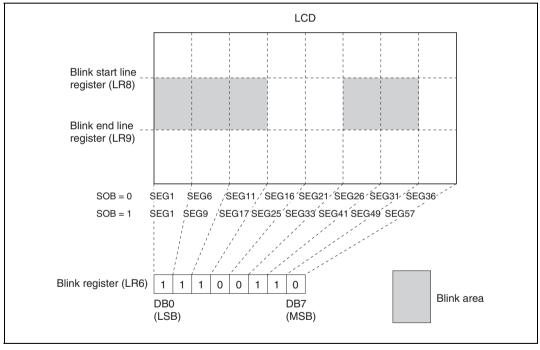


Figure 13.10 Blink Register (LR6) and Blink Locations

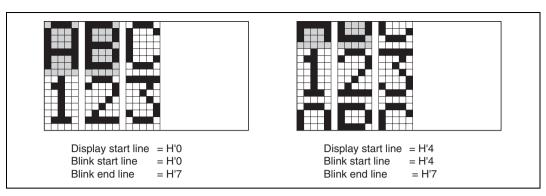


Figure 13.11 Blinking during Display Scrolling (SOB = 0, 1/16 Duty)

13.3.9 Module Standby Mode

The LCD controller has a module standby function that enables low power consumption to be achieved. In module standby mode, the built-in step-up circuit and op-amps are halted, and segment and common outputs go to the V_{ss} (display-off state) level. Display RAM and internal register data is retained, except for the DISP and OPON bits in control register 2 (LR1). The control registers can still be accessed in the module standby state. Figure 13.12 shows the procedures for initiating and clearing module standby mode. The initiation and clearing procedures must be followed exactly in order to protect the display memory contents.

When the CPU is placed in standby mode, set the LSBY bit in control register 1 (LR0) to 1 before executing the standby instruction. After clearing standby mode, follow the module standby clearing procedure to start display.

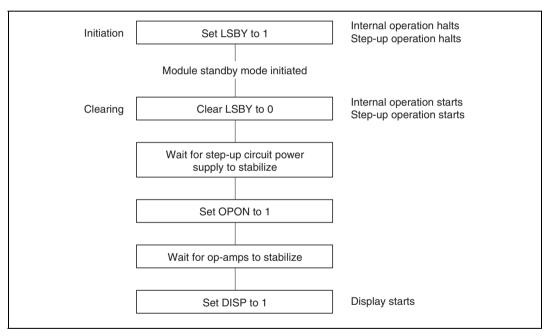


Figure 13.12 Module Standby Mode and Standby Mode Initiation and Clearing Procedures

13.3.10 Power-On and Power-Off Procedures

As the LCD controller incorporates a complete power supply circuit, the procedures shown in figure 13.13 must be followed when powering on and off. Failure to follow these procedures may result in an abnormal display.

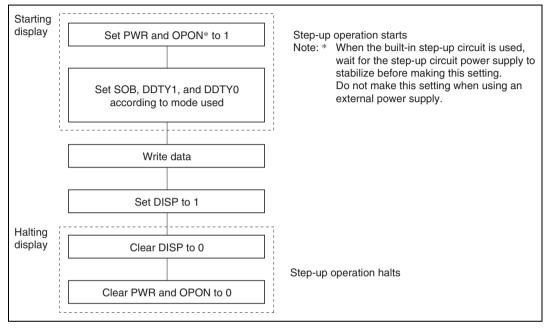


Figure 13.13 Power-On and Power-Off Procedures

13.3.11 Power Supply Circuit

The LCD controller has a built-in 2X or 3X step-up circuit for LCD drive. In standby mode, the power supply circuit is automatically turned off after a maximum of two subclock cycles, and the power consumption of the step-up circuit falls to zero. The power supply circuit can be turned on and off by a command, and an external power supply circuit should be used if the current capacity of the built-in step-up circuit is insufficient.

Step-Up Circuit

By inputting the reference voltage to V_{ci} ($V_{ci} \le V_{cc}$), connecting a capacitor between V_{ss} and VLOUT, C1+ and C1-, and C2+ and C2-, and setting the PWR bit in control register 1 (LR0) to 1, the potential between V_{ci} and V_{cc} is stepped up by a factor of 2 or 3. See figures 13.17 (1) and (2) for the method of connecting the capacitors. As the subclock is used for voltage step-up, step-up will not be performed unless the subclock is supplied. Since V_{ci} is also used for the step-up circuit power supply, an adequate current must be assured.

Step-up cannot be performed below V_{cc} . Apply a V_{ci} voltage that gives a VLOUT level between V_{cc} and 7.0 V.

If the step-up circuit is not used, connect V_{ci} to V_{cc} .

LCD Drive Level Power Supply

Six power supply levels—V1, V2, V3, V3, V4, V5, and V_{ss} —are necessary for LCD drive. The V1 to V_{ss} power supplies are normally generated by means of resistive division. The power supply circuit includes a voltage follower op-amp for each voltage level generated by resistive division.

When 1/4 bias is used for LCD display, the V3 and V4 pins should be shorted; when 1/5 bias is used, the V3 and V4 pins should be left open. The V34 pin is an internal resistance test pin, and should always be shorted to the V3 pin externally.

Contrast Control

The LCD controller provides for the following two methods of contrast control.

Using built-in contrast control circuit
 The LCD controller includes a programmable contrast control circuit. The LCD power supply voltage can be adjusted on the basis of a given step-up circuit voltage by making a selection in the contrast control register (LRA).



By changing step-up circuit reference voltage V_{ci}
 The step-up circuit voltage level can be varied by changing step-up circuit reference voltage V_{ci}.

External Power Supply

- When an external power supply is input to V_{LCD}
 V1 to V5 can be generated by inputting an external power supply to V_{LCD}, and using the built-in op-amps by setting the OPON bit in control register 2 (LR1) to 1. The V_{LCD} input level must be between V_{CC} and 7.0 V.
- When external power supply is input directly to V1 to V5

 A power supply can be applied directly to V1, V2, V3, V4, and V5 from an external source by clearing the PWR bit in control register 1 (LR0) and the OPON bit in control register 2 (LR1) to 0, to halt the built-in step-up circuit and cut the built-in op-amp power supply. The same potential as V1 should be input to V_{LCD}. Apply a voltage not exceeding V_{LCD} to V2 through V5. The input level of V_{LCD} and V1 must be between V_{CC} and 7.0 V.

In either case, inputting a voltage exceeding the maximum rated voltage may adversely affect the reliability of the chip.

13.3.12 LCD Drive Power Supply Voltages

There are six LCD drive power supply voltage values—V1 to V5, and V_{ss} . V1 is the highest voltage, and V_{ss} the lowest. As shown in figure 13.14, the common waveforms are formed from a combination of V1, V2, V5, and V_{ss} , while the segment waveforms are formed from a combination of V1, V3, V4, and V_{ss} . V1 and V_{ss} are shared by both common and segment waveforms, but the intermediate voltages are different.

In figure 13.14, the waveforms of outputs SEG1 to SEG40 differ according to the display data. In this example, LCD panel lines for which COM1 is connected are illuminated, and all other dots are not illuminated.

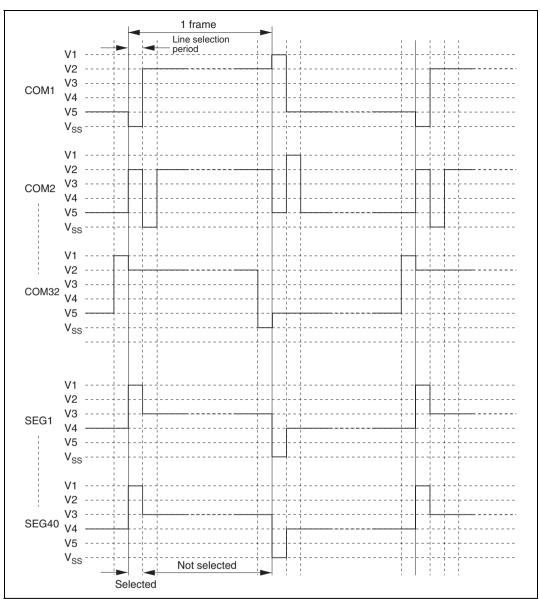


Figure 13.14 LCD Drive Power Supply Waveforms (1/32 Duty)

13.3.13 LCD Voltage Generation Circuit

When Using External Power Supply and Built-In Op-Amps

When the built-in step-up circuit is not used, and the LCD drive voltages are supplied directly from an external power supply, connections should be made as shown in figure 13.15. The $V_{\tiny LCD}$ input level must be between $V_{\tiny CC}$ and 7.0 V.

The LCD controller includes bleeder resistances that generate levels V1 to V5, and voltage follower op-amp circuits. Set the OPON bit in control register 2 (LR1) to 1. Contrast can be controlled by software, using the contrast control register (LRA).

If the capacitance of the LCD panel to be driven is large, capacitors of around 0.1 to 0.5 μ F should be inserted between the V1OUT to V5OUT built-in op-amp outputs and V_{ss} to provide stabilization. In order for the op-amps to operate normally, the contrast control register (LRA) should be set so that the potential difference between $V_{\mbox{\tiny LCD}}$ and V1, and between V5 and V_{ss} , is at least 0.4 V.

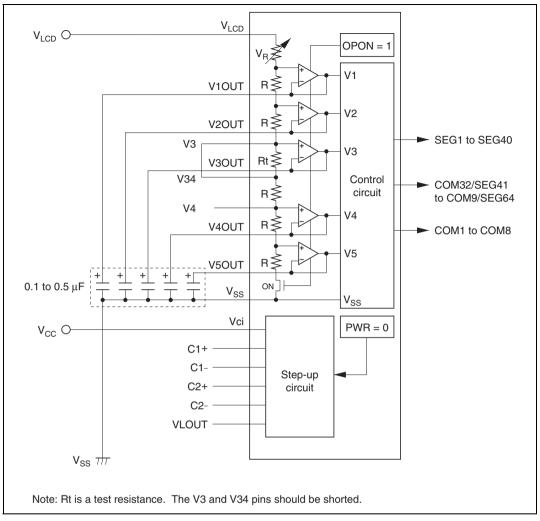


Figure 13.15 Example of Connections when Using Built-In Op-Amps and External LCD Power Supply (1/5 Bias)

When Using External Power Supply but Not Using Built-In Op-Amps

When the built-in step-up circuit and op-amps are not used, and the LCD drive voltages are supplied directly from an external power supply, connections should be made as shown in figure 13.16.

As the built-in step-up circuit and op-amps are not used, the OPON bit in control register 2 (LR1) should be cleared to 0.

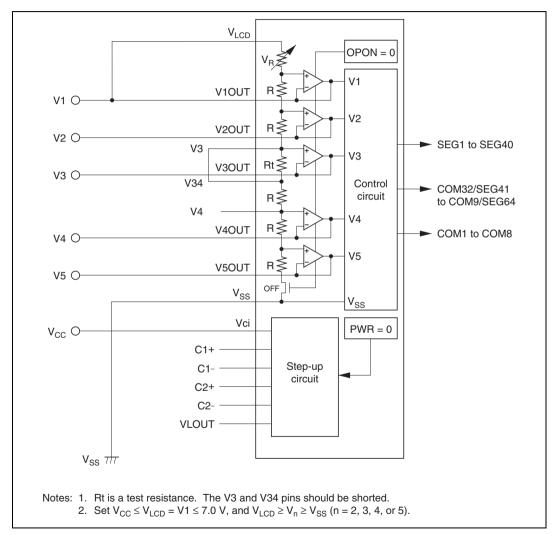


Figure 13.16 Example of Connections when Not Using Built-In Op-Amps and Using External LCD Power Supply (1/5 Bias)

When Using Built-In Step-Up Circuit and Op-Amps

When the built-in step-up circuit is used, connections should be made as shown in figure 13.17 (1) (3X step-up) or figure 13.17 (2) (2X step-up).

The LCD controller includes bleeder resistances that generate levels V1 to V5, and voltage follower op-amp circuits. When the built-in op-amps are used, the OPON bit in control register 2 (LR1) should be set to 1. Contrast can be controlled by software, using the contrast control register (LRA).

If the capacitance of the LCD panel to be driven is large, capacitors of around 0.1 to 0.5 μ F should be inserted between the V1OUT to V5OUT built-in op-amp outputs and V_{ss} to provide stabilization. In order for the op-amps to operate normally, the contrast control register (LRA) should be set so that the potential difference between V_{LCD} and V1, and between V5 and V_{ss} , is at least 0.4 V.

Since the V_{ci} pin is also used for the step-up circuit power supply, ensure that an adequate current can be supplied when carrying out reference voltage adjustment. The V_{ci} input level must not exceed V_{cc} .

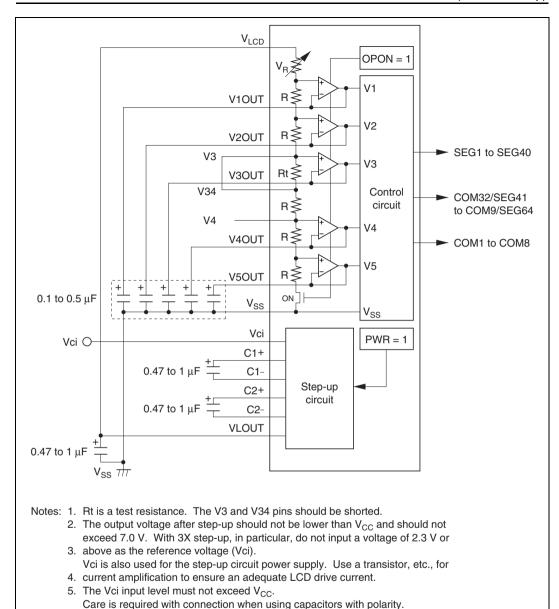


Figure 13.17 Example of Connections when Using Built-In Step-Up Circuit (1) (3X Step-Up, 1/5 Bias)

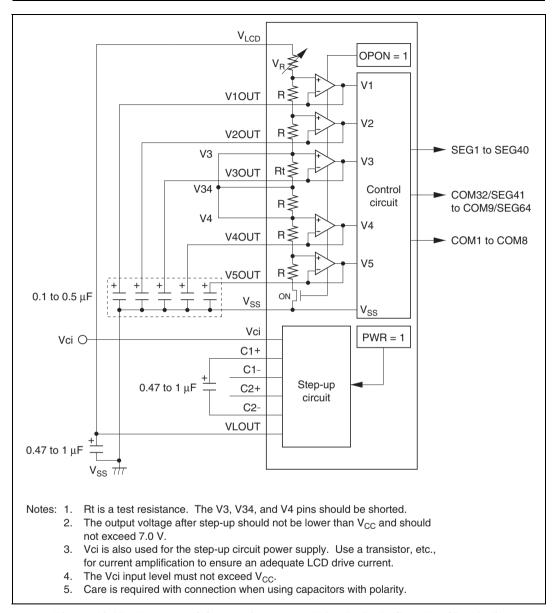


Figure 13.17 Example of Connections when Using Built-In Step-Up Circuit (2) (2X Step-Up, 1/4 Bias)

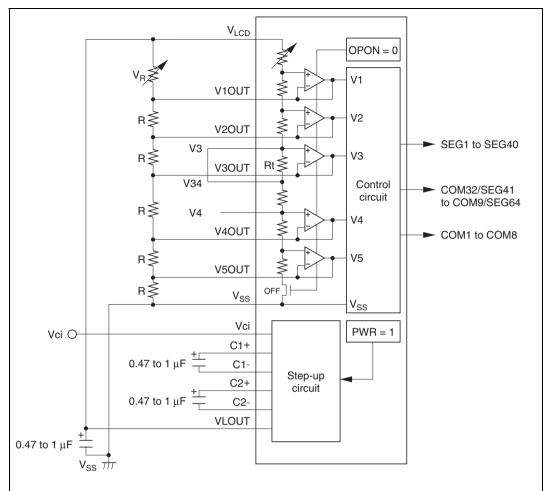
When Using Built-In Step-Up Circuit and Bleeder Resistances

If the drive capability of the built-in op-amps is insufficient for the size of the LCD panel, the V1 to V5 levels can be supplied from external bleeder resistances. In this case, clear the OPON bit in control register 2 (LR1) to 0 to turn the op-amps off. The built-in contrast control circuit cannot be used, so contrast control must be handled by an external circuit.

A 1/4 or 1/5 bias value can be set, according to the method of connecting the external bleeder resistances. Figure 13.18 shows an example of the connections for 1/5 bias drive.

The 2X or 3X step-up circuit can be used.





- Notes: 1. Rt is a test resistance. The V3 and V34 pins should be shorted.
 - 2. A value of around 5 k Ω to 25 k Ω is recommended for external power supply division resistance R.
 - For contrast control, either insert a variable resistance between V_{LCD} and V1, or adjust step-up circuit reference voltage Vci. The built-in contrast control circuit cannot be used.
 - The output voltage after step-up should not be lower than V_{CC} and should not exceed 7.0 V.
 With 3X step-up, in particular, do not input a voltage of 2.3 V or above as the reference voltage
 (Vci).
 - 5. Vci is also used for the step-up circuit power supply. Use a transistor, etc., for current amplification to ensure an adequate LCD drive current.
 - 6. The Vci input level must not exceed V_{CC}.
 - 7. Care is required with connection when using capacitors with polarity.
 - 8. Set V1OUT \leq V_{LCD}.

Figure 13.18 Example of Connections when Using 3X Step-Up Circuit and External Bleeder Resistances (1/5 Bias)

13.3.14 Contrast Control Circuit

Contrast control can be performed by software (electronic control function) by controlling the LCD drive voltage (the potential difference between $V_{\tiny LCD}$ and V1) by means of the contrast control register (LRA). Variable resistance value $V_{\tiny R}$ can be adjusted within the range of 0.1 R to 1.6 R, where R is the value of the basic dividing bleeder resistance between $V_{\tiny LCD}$ and V1. The contrast control settings by bits CCR3 to CCR0 in the contrast control register (LRA) are shown in table 13.7.

To ensure stable operation of the voltage follower op-amp circuits that output levels V1 to V5, the contrast control register (LRA) should be set so that the potential difference between $V_{\tiny LCD}$ and V1, and between V5 and $V_{\tiny SS}$, is at least 0.4 V. The contrast control ranges are shown in table 13.8.

If contrast control cannot be adequately performed by means of on-chip resistance V_R , control can be performed by inserting a resistance between VLOUT and V_{LCD} .

Table 13.7 Contrast Control Settings

| Contrast Control Register (LRA) Variable Resistance | | | | | V1-V _{co} Potential | | | |
|---|------|------|------|-----------------------------|------------------------------|---------------|--|--|
| CCR3 | CCR2 | CCR1 | CCR0 | Value (V _R) | Difference | Display Color | | |
| 0 | 0 | 0 | 0 | 1.6R | Small | Light | | |
| | | | 1 | 1.5R | _ • | † | | |
| | | 1 | 0 | 1.4R | _ | | | |
| | | | 1 | 1.3R | _ | | | |
| | 1 | 0 | 0 | 1.2R | _ | | | |
| | | | 1 | 1.1R | _ | | | |
| | | 1 | 0 | 1.0R | _ | | | |
| | | | 1 | 0.9R | _ | | | |
| 1 | 0 | 0 | 0 | 0.8R | _ | | | |
| | | | 1 | 0.7R | _ | | | |
| | | 1 | 0 | 0.6R | _ | | | |
| | | | 1 | 0.5R | _ | | | |
| | 1 | 0 | 0 | 0.4R | _ | | | |
| | | | 1 | 0.3R | _ | | | |
| | | 1 | 0 | 0.2R | | ₩ | | |
| | | | 1 | 0.1R | Large | Dark | | |

Table 13.8 Contrast Control Ranges

| Bias | LCD Drive Voltage: V _{DR} | Contrast Control Ra | ange |
|-------------------|---|--|--|
| | | LCD drive voltage adjustment range: | $0.758 \times (V_{LCD} - V_{SS}) \le V_{DR} \le 0.980 \times (V_{LCD} - V_{SS})$ |
| 1/5 bias drive | $\frac{5 \times R}{5 \times R + V_R} \times (V_{LCD} - V_{SS})$ | V5–V_{SS} potential difference limit: | $\frac{R}{5 \times R + V_R} \times (V_LCD - V_SS) \ge 0.4 \ [V]$ |
| | | V _{LCD} -V1 potential difference limit: | $\frac{V_{R}}{5 \times R + V_{R}} \times (V_{LCD} - V_{SS}) \ge 0.4 [V]$ |
| | | LCD drive voltage adjustment range: | $0.714 \times (V_{LCD} - V_{SS}) \le V_{DR} \le 0.976 \times (V_{LCD} - V_{SS})$ |
| 1/4 bias drive | $\frac{4 \times R}{4 \times R + V_R} \times (V_{LCD} - V_{SS})$ | V5–V_{SS} potential difference limit: | $\frac{R}{4 \times R + V_R} \times (V_{LCD} - V_{SS}) \ge 0.4 [V]$ |
| | | V_{LCD}-V1 potential difference limit: | $\frac{V_{R}}{4 \times R + V_{R}} \times (V_{LCD} - V_{SS}) \ge 0.4 [V]$ |

13.3.15 LCD Drive Bias Selection Circuit

The ideal bias value that gives the best contrast is calculated using the equation shown below. If drive is performed at a bias value lower than the optimum, contrast will deteriorate, but the LCD drive voltage (the potential difference between V1 and V_{ss}) can be kept low. If the LCD drive voltage is inadequate even with a low V_{ci} voltage and use of the 3X step-up circuit, or if the output voltage falls and the LCD display becomes faint as batteries wear out, for instance, the display can be made clearer by decreasing the LCD drive bias.

Optimum bias value for 1/N duty drive =
$$\frac{1}{\sqrt{N} + 1}$$

Notes: 1. When using 1/5 bias, leave the V3 and V4 pins open.

- 2. When using 1/4 bias, short the V3 and V4 pins.
- 3. The V3 and V34 pins must always be shorted.



Section 14 Dot Matrix LCD Controller (H8/3854 Group)

14.1 Overview

The LCD controller has built-in display RAM, and performs dot matrix LCD display. One bit of display RAM data corresponds to illumination or non-illumination of one dot on the LCD panel, making possible displays with an extremely high degree of freedom.

The LCD controller incorporates all the functions required for LCD display, allowing a dot matrix display of up to 40×16 dots.

I/O ports are used for the interface with the CPU, offering excellent software heritability when using a combination of MPU and LCD driver.

This module operates on the subclock, making it ideal for use in small portable devices.

14.1.1 Features

- Built-in bit-mapped display RAM (640 bits)
 Maximum of 640 display bits (selectable from 40 × 16 bits or 40 × 8 bits)
- Choice of 1/8 or 1/16 duty
- Low power consumption enabling extended drive on battery power Subclock operation
 Module standby
- Comprehensive display control functions
 Display data read/write, display on/off control, read-modify-write
- CPU interface
 I/O port interface
- Built-in LCD power supply bleeder resistance circuit

14.1.2 Block Diagram

Figure 14.1 shows a block diagram of the LCD controller.

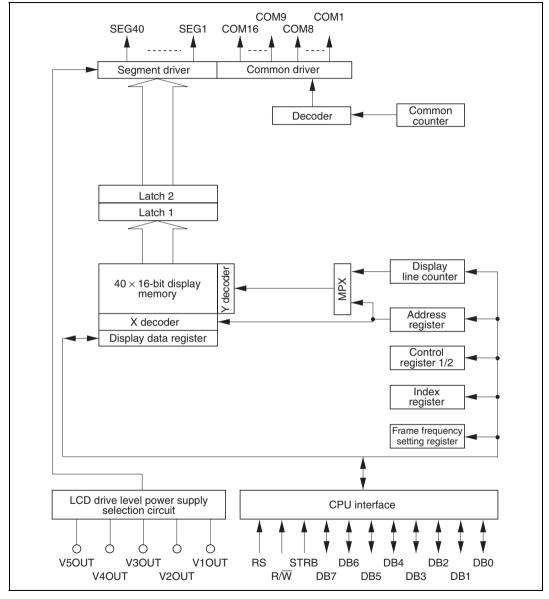


Figure 14.1 Block Diagram of LCD Controller

14.1.3 Pin Configuration

Table 14.1 shows the pins assigned to the LCD controller.

Table 14.1 Pin Configuration

| Pin Name | Abbr. | I/O | Function |
|------------------------------|----------------|--------|--|
| Common output pins | COM1 to COM16 | Output | LCD common drive pins |
| Segment output pins | SEG1 to SEG40 | Output | LCD segment drive pins |
| LCD drive power supply level | V1OUT to V5OUT | I/O | LCD drive power supply level input/output pins |

14.1.4 Register Configuration

The LCD controller has one index register and five control registers, all of which are accessed via an I/O port interface. Except for the display data register (LR4), these registers cannot be read. The LCD controller register configuration is shown in table 14.2.

Table 14.2 Register Configuration

| | | | | Index Register | | |
|----------------------------------|-------|-----|----|----------------|-----|-----|
| Name | Abbr. | R/W | RS | IR2 | IR1 | IR0 |
| Index register | IR | W | 0 | _ | _ | _ |
| Control register 1 | LR0 | W | 1 | 0 | 0 | 0 |
| Control register 2 | LR1 | W | | | | 1 |
| Address register | LR2 | W | | | 1 | 0 |
| Frame frequency setting register | LR3 | W | | | | 1 |
| Display data register | LR4 | R/W | | 1 | 0 | 0 |

14.2 Register Descriptions

14.2.1 Index Register (IR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-----|-----|-----|
| | _ | _ | _ | _ | _ | IR2 | IR1 | IR0 |
| Initial value | _ | _ | _ | _ | _ | 0 | 0 | 0 |
| Read/Write | | | | | | W | W | W |

IR is an 8-bit write-only register that selects one of the LCD controller's five control registers. IR is selected when RS is 0.

Upon reset, IR is initialized to H'00.

Bits 7 to 3—Reserved Bits: Bits 7 to 3 are reserved; they should always be cleared to 0.

Bits 2 to 0—Index Register (IR2 to IR0): Bits 2 to 0 are used to select one of the LCD controller's five control registers. The correspondence between the settings of IR2 to IR0 and the selected registers is shown in table 14.2. Other settings are invalid.

14.2.2 Control Register 1 (LR0)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|------|---|---|---|-------|---|
| | _ | _ | LSBY | _ | _ | _ | DDTY1 | |
| Initial value | _ | _ | 0 | _ | _ | _ | 0 | _ |
| Read/Write | | | W | | | | W | |

LR0 is an 8-bit write-only register that performs LCD module standby mode setting and drive duty selection.

Upon reset, LR0 is initialized to H'00.

Bits 7 and 6—Reserved Bits: Bits 7 and 6 are reserved; they should always be cleared to 0.

Bit 5—Module Standby (LSBY): Bit 5 is the module standby setting bit. When LSBY is set to 1, the LCD controller enters standby mode. At this time, bits DISP, LPS1, and LPS0 in LR1 are reset.

Bit 5: LSBY Description

| 0 | LCD controller operates normally | (initial value) |
|---|---|-----------------|
| 1 | Power supply to built-in bleeder resistances halts, display is turned of controller enters standby mode | f, and LCD |

Bits 4 to 2—Reserved Bits: Bits 4 to 2 are reserved; they should always be cleared to 0.

Bit 1—Display Duty Select (DDTY1): Bit 1 selects a display duty of 1/16 or 1/8.

Bit 1: DDTY1 Description

| 0 | 1/16 duty selected | (initial value) |
|---|--|-----------------|
| 1 | 1/8 duty selected | |
| | Y address H'8 to H'F display data is invalid | |

Bit 0—Reserved Bit: Bit 0 is reserved; it should always be cleared to 0.

14.2.3 Control Register 2 (LR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | _ |
|---------------|---|------|------|------|-----|---|-----|---|---|
| | | DISP | LPS1 | LPS0 | RMW | | INC | | |
| Initial value | _ | 0 | 0 | 0 | 0 | _ | 0 | _ | |
| Read/Write | | W | W | W | W | _ | W | _ | |

LR1 is an 8-bit write-only register that selects operation or halting of LCD display and supply or halting of current to the built-in bleeder resistances, performs read-modify-write mode setting, and selects the address to be incremented in the display memory.

Upon reset, LR1 is initialized to H'00.

Bit 7—Reserved Bit: Bit 7 is reserved; it should always be cleared to 0.

Bit 6—LCD Operation Setting (DISP): Bit 6 selects operation or halting of the LCD display. When the LSBY bit in LR0 is set to 1, DISP is cleared.

| Bit 6: DISP | Description | |
|-------------|---|-----------------|
| 0 | LCD is turned off. All LCD outputs go to the $\rm V_{ss}$ level | (initial value) |
| 1 | LCD is turned on | |

Bits 5 and 4—LCD Power Supply Setting (LPS1, LPS0): Bits 5 and 4 specify use or non-use of the internal power supply as the LCD drive power supply, and of the built-in LCD power supply bleeder resistances. When LPS1 is set to 1, the internal power supply is connected to the bleeder resistances. When LPS0 is set to 1, a power supply divided by the built-in bleeder resistances is supplied. When the LCD drive power supply level is applied to V1OUT through V5OUT from an external source, LPS1 and LPS0 must be cleared to 0.

When the LSBY bit in LR0 is set, LPS1 and LPS0 are cleared.

| ver supply to V1OUT is halted | /' '!' I I \ |
|---|---|
| rei supply to v 1001 is fiaited | (initial value) |
| ver supply voltage is supplied to V1OUT | |
| | ver supply voltage is supplied to V1OUT |

| Bit 4: LPS0 | Description | |
|-------------|---------------------------------------|-----------------|
| 0 | Built-in bleeder resistances not used | (initial value) |
| 1 | Built-in bleeder resistances used | |

Bit 3—Read-Modify-Write Setting (RMW): Bit 3 selects whether display memory X or Y address incrementing is carried out after a write/read access, or only after a write access (read-modify-write mode).

| Bit 3: RMW | Description | |
|------------|--|--|
| 0 | Address is incremented after write/read access to display memory | |
| | (initial value) | |
| 1 | Read-modify-write mode is set | |
| | In this mode, address is incremented only after write access to display memory | |

Bit 2—Reserved Bit: Bit 2 is reserved; it should always be cleared to 0.



Bit 1—Increment Address Select (INC): Bit 1 selects either the X address or the Y address as the address to be incremented after the display memory access specified by the RMW bit. The selected address is cleared after a display memory access with the maximum value for the valid display data area; in this case the other address is incremented.

| Bit 1: INC | Description | | | | | |
|------------|--|--|--|--|--|--|
| 0 | Incrementing of display memory Y address has priority; X address is incremented after Y address overflow (initial value) | | | | | |
| 1 | Incrementing of display memory X address has priority; Y address is incremented after X address overflow | | | | | |

Bit 0—Reserved Bit: Bit 0 is reserved; it should always be cleared to 0.

14.2.4 Address Register (LR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|---|-----|-----|-----|-----|
| | XA2 | XA1 | XA0 | _ | YA3 | YA2 | YA1 | YA0 |
| Initial value | 0 | 0 | 0 | _ | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | _ | W | W | W | W |

LR2 is an 8-bit write-only register that sets the display memory X- and Y-direction addresses accessed by the CPU.

Upon reset, LR2 is initialized to H'00.

Bits 7 to 5—X Address Setting (XA2 to XA0): Bits 7 to 5 set the display memory X-direction address. A value from H'0 to H'4 can be set. Do not perform access in the range H'5 to H'7.

When the INC bit in LR1 is set to 1, the address is automatically incremented after the access specified by the RMW bit in LR1, and is cleared after an H'4 access. When INC is 0 and YA3 to YA0 represent the maximum value for the valid display data area, the address is incremented after the access specified by RMW.

Bit 4—Reserved Bit: Bit 4 is reserved; it should always be cleared to 0.

Bits 3 to 0—Y Address Setting (YA3 to YA0): Bits 3 to 0 set the display memory Y-direction address. A value from H'0 to H'F can be set, but display data from H'8 to H'F is invalid with 1/8 duty.

When the INC bit in LR1 is cleared to 0, the address is automatically incremented after the access specified by the RMW bit in LR1, and is cleared after an access with the maximum value for the

valid display data area. When INC is 1 and the value in XA2 to XA0 is H'4, the address is incremented after the access specified by RMW.

14.2.5 Frame Frequency Setting Register (LR3)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-----|-----|-----|
| | | _ | | _ | | FS2 | FS1 | FS0 |
| Initial value | _ | _ | _ | _ | _ | 0 | 0 | 0 |
| Read/Write | _ | | | _ | _ | W | W | W |

LR3 is an 8-bit write-only register that sets the frame frequency.

Upon reset, LR3 is initialized to H'00.

Bits 7 to 3—Reserved Bits: Bits 7 to 3 are reserved; they should always be cleared to 0.

Bits 2 to 0—Frame Frequency Setting (FS2 to FS0): Bits 2 to 0 control the subclock division ratio and set the LCD frame frequency. The relationship between the LCD frame frequency f_F (Hz), the subclock frequency f_W (Hz), the division ratio r, and the LCD duty 1/N is as follows:

$$f_F = \frac{f_W}{r \times N}$$

Set a division ratio suitable for the characteristics of the LCD panel used. The correspondence between register settings, division ratios, and frame frequencies at each display duty is shown in table 14.3.



Table 14.3 Register Settings, Division Ratios, and Frame Frequencies at Each Display Duty

| | | | | | Display | ay Duty 1/N | | |
|-----|-----|-----|--------------------|--------------------|---------------------------|--------------------------|--------------------|--|
| | | | | | 1/8 | 1 | /16 | |
| | | | | | Subclock Fre | quency f _w (k | Hz) | |
| | | | Division | 32.768 | 38.4 | 32.768 | 38.4 | |
| FS2 | FS1 | FS0 | ratio r | Frame Fre | quency f _F (Hz | <u>z)</u> | | |
| 0 | 0 | 0 | 2 | 2048.0 | 2400.0 | 1024.0 | 1200.0 | |
| | | 1 | 4 | 1024.0 | 1200.0 | 512.0 | 600.0 | |
| | 1 | 0 | 8 | 512.0 | 600.0 | 256.0 | 300.0 | |
| | | 1 | 16 | 256.0 | 300.0 | 128.0 | 150.0 | |
| 1 | 0 | 0 | 32 | 128.0 | 150.0 | 64.0 | 75.0 | |
| | | 1 | 64 | 64.0 | 75.0 | 32.0 | 37.5 | |
| | 1 | 0 | 128 | 32.0 | 37.5 | 16.0 | 18.8 | |
| | | 1 | Setting prohibited | Setting prohibited | Setting prohibited | Setting prohibited | Setting prohibited | |

14.2.6 Display Data Register (LR4)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Initial value | Undefined |
| Read/Write | R/W |

LR4 is an 8-bit read/write register used to perform read/write access to the display memory specified by XA2 to XA0 and YA3 to YA0 in LR2.

In a write to display memory, the write is performed directly to the display memory via this register. In a read, the data is temporarily latched into this register before being output to the bus.

After a reset, the display memory and LR4 contents are undefined.

14.3 Operation

14.3.1 System Overview

The LCD controller operates at 1/16 or 1/8 duty. The display size is a maximum of 40×16 dots. As the LCD controller operates on the subclock to perform display control, the time, etc., can be constantly displayed. Also, since data in the display RAM is retained even in module standby mode, low power consumption can be achieved without affecting the display.

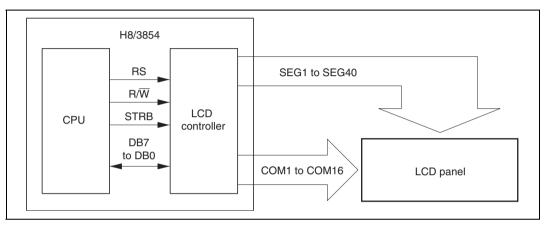


Figure 14.2 System Block Diagram

14.3.2 CPU Interface

The LCD controller's registers are not included in the memory map shown in figure 2.16 (b). They are controlled from the CPU by means of chip-internal LCD pins DB7 to DB0, RS, R/\overline{W} , and STRB, via chip-internal I/O ports 9 and A. The pin configuration is shown in table 14.4, and an example of the timing for access to registers in the LCD controller is shown in figure 14.3. For information on port 9 and port A, see the descriptions in section 8, I/O Ports.

Table 14.4 Pin Configuration

| Pin Name | Abbr. | I/O | Function | |
|-----------------------|------------|-------|--|--|
| Data bus pins | DB7 to DB0 | I/O | When $R/\overline{W} = 0$, these pins input data to be written to a register; when $R/\overline{W} = 1$, they output data read from a register | |
| Register selector pin | RS | Input | When $R/S = 0$, the index register is selected; when $RS = 1$, a control register is selected | |
| Read/write select pin | R/W | Input | When $R/\overline{W} = 0$, write access is selected; when $R/\overline{W} = 1$, read access is selected | |
| Strobe pin | STRB | Input | At the fall of STRB, read or write access, as selected by R/\overline{W} , is performed on the register selected by RS | |

Writing to Index Register

When RS and R/ \overline{W} are both cleared to 0, data DB7 to DB0 is written to the index register (IR) at the falling edge of STRB. Do not change RS or R/ \overline{W} at the fall of STRB.

Reading and Writing to Control Registers

To access a control register, data indicating the number of the register to be accessed must be written to the index register (IR) before making the access. The register number data to be written to IR is shown in table 14.2. As the register number written to IR is retained until IR is written to again, if the same control register is accessed repeatedly, it is not necessary to write to IR each time.

In a write to a control register, when RS has been set to 1 and R/\overline{W} cleared to 0, data DB7 to DB0 is written to the control register specified by the index register (IR) at the falling edge of STRB.

Except for the display data register (LR4), control registers cannot be read. In a read of LR4, when the LR4 register number is written to the index register (IR), and RS and R/\overline{W} are both set to 1, DB7 to DB0 are set to output mode, and the display memory data at the address specified by the address register (LR2) is output from DB7 to DB0 at the falling edge of STRB. If a read is also performed in the next cycle, the data output is held until the next fall of STRB, but if a write is

performed in the next cycle, DB7 to DB0 are set to input mode from the point at which R/\overline{W} is cleared to 0, and the output is cleared.

In either case, do not change RS or R/\overline{W} at the fall of STRB.

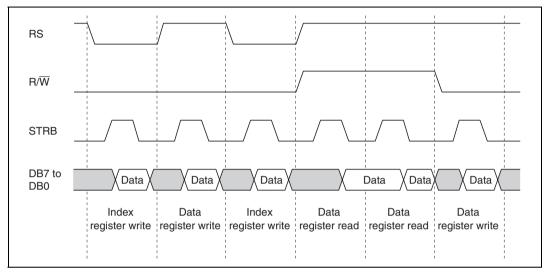


Figure 14.3 Example of Timing Sequence for 8-Bit Data Transfer

Notes on Use of Chip-Internal I/O Ports

For LCD controller interface internal ports 9 and A, port input/output is controlled by means of PCR9 and PCRA in the same way as for ordinary I/O ports, and in output mode, the values set in PDR9 or PDRA are output. Also, LCD controller internal pins RS, R/W, and STRB are input-only pins, and DB7 to DB0 input/output is controlled by R/\overline{W} . Therefore, the following points must be noted.

1. After reset release and standby mode release

Since the chip's internal I/O ports go to the high-impedance state in a reset and in standby mode, in initialization after reset or standby mode release, H'06 should be set in PDRA, and H'07 in PCRA. This will set port A to output mode. If the PDRA setting were H'00, there would be a possibility of the index register (IR) being written to.

2. Changing register read/write setting

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When an LCD controller register is read ($R/\overline{W} = 1$), DB7 to DB0 output data from the LCD controller side, and so port 9 must be set to input mode. Therefore, H'00 must be written to PCR9, setting port 9 to input mode, before changing the R/\overline{W} setting from 0 to 1. When writing data to an LCD controller register, first change R/W from 1 to 0, then write H'FFF to PCR9, setting port 9 to output mode.

Examples of display data register (LR4) read/write access when read-modify-write is designated are shown below.

[Set index register to display data register]

| • | Port A | set to | output n | node, | RMW | set to 1 | 1 |
|---|--------|--------|----------|-------|------------|----------|---|
|---|--------|--------|----------|-------|------------|----------|---|

| MOV.W | #H'0100,R1 |
|-------|---|
| MOV.W | #H'04FF,R0 |
| MOV.B | R1L,@PDRA Clear R/\overline{W} to 0 |
| MOV.B | ROH,@PDR9 |
| MOV.B | ROL,@PCR9 Output H'04 from port 9 |
| MOV.B | R1H,@PDRA |
| MOV.B | R1L,@PDRA Write H'04 to index register |
| | |

[Read display data register]

| MOV.B | R1L,@PCR9 Set port 9 to input mode |
|-------|--|
| W.VOM | #H'0706, R2 |
| MOV.B | R2L,@PDRA Set R/\overline{W} to 1 |
| MOV.B | R2H,@PDRA |
| MOV.B | R2L,@PDRA |
| MOV.B | @PDR9, ROH Read PDR9 into general register |

[Write to display data register]

| W.VOM | #H'0504,R3 |
|-------|---|
| MOV.B | R3L,@PDRA Clear R/\overline{W} to 0 |
| NOT.B | ROH Invert general register data |
| MOV.B | ROH,@PDR9 |
| MOV.B | ROL, @PCR9 Set port 9 to output mode |
| MOV.B | R3H,@PDRA |
| MOV.B | R3L @PDRA Write data to display data register |

14.3.3 LCD Drive Pin Functions

Common/Segment Output

The display duty is set by control register 1 (LR0) bits DDTY1.

• 1/8 duty (DDTY1 = 1)

Common outputs: COM1 to COM8
Segment outputs: SEG1 to SEG40

Note: COM9 to COM16 output common signal non-selection waveforms

• 1/16 duty (DDTY1 = 0)

Common outputs: COM1 to COM16
Segment outputs: SEG1 to SEG40

Table 14.5 Pin Functions According to Display Duty

| | Function | | | | | |
|---------------|--------------------------------------|---------------|--|--|--|--|
| Pin Name | 1/8 Duty | 1/16 Duty | | | | |
| COM1 to COM8 | COM1 to COM8 | COM1 to COM16 | | | | |
| COM9 to COM16 | Common signal non-selection waveform | | | | | |
| SEG1 to SEG40 | SEG1 to SEG40 | SEG1 to SEG40 | | | | |



14.3.4 Display Memory Configuration and Display

The LCD controller includes 40×16 -bit bit-mapped display memory. As the display memory configuration, an 8-bit \times 5 X-direction combination can be selected, while the Y-direction configuration is 16 bits. Display data written from the CPU is stored horizontally with the MSB at the left and the LSB at the right, as shown in figure 14.4. On the display, 1 data corresponds to illumination (black), and 0 data to non-illumination (colorless).

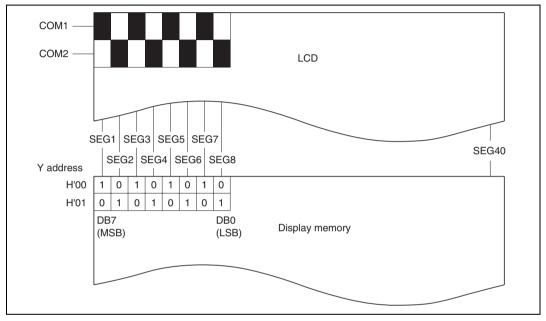


Figure 14.4 Memory Data and Display

14.3.5 Display Data Output

The relationship between the LCD controller display duty and output pins is shown in figure 14.5.

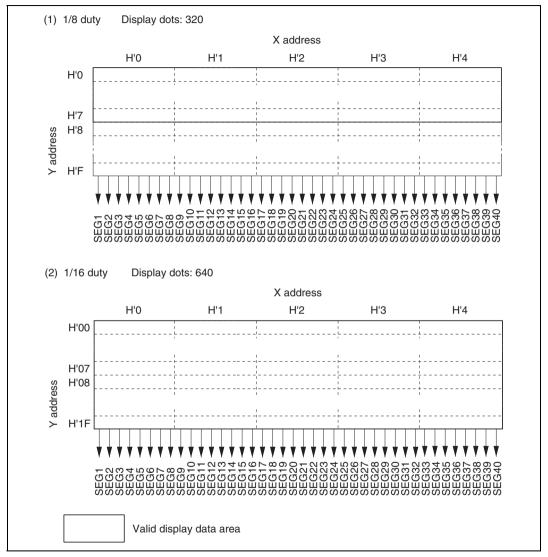


Figure 14.5 Display Duty and Valid Display Data Area

14.3.6 **Register and Display Memory Access**

Register Access

To access a register, RS is first cleared to 0 and the register number of the register to be accessed is set in the index register. Then RS is set to 1, enabling the specified register to be accessed. Some internal registers have nonexistent bits; 0 must be written to these bits. The display data register (LR4) is the only register that can be read.

Display Memory Access

To access the display memory, the address to be accessed is set in the address register (LR2). The memory is then accessed via the display data register (LR4). This access can be performed without awareness of the display-side read. See figure 14.6 for the procedure.

After the respective display data register (LR4) accesses, the X and Y addresses are automatically incremented on the basis of the value set in the INC bit in control register 2 (LR1), and therefore address settings need not be made each time.

With 1/16 duty (DDTY1 = 0), if INC = 0 the X address remains the same in each read/write access to the display data register (LR4), while the Y address is automatically incremented up to H'F. After reaching H'F, the Y address returns to H'O again, and the X address is simultaneously incremented. If INC = 1, on the other hand, the Y address remains the same in each read/write access to the display data register (LR4), while the X address is automatically incremented up to H'4. After reaching H'4, the X address returns to H'0 again, and the Y address is simultaneously incremented. In this way, consecutive read/write accesses can be made to the entire display memory area.

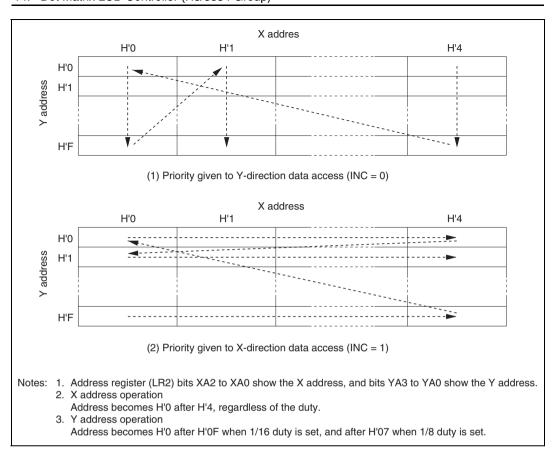


Figure 14.6 Display Memory Access Methods (1/16 Duty)

Reading for Display

Reads for LCD display are performed asynchronously with respect to accesses by the CPU. However, since simultaneous accesses would corrupt data in the RAM, arbitration is carried out within the chip. Basically, accesses by the CPU have priority, and reads for display are performed in the intervals between CPU accesses.

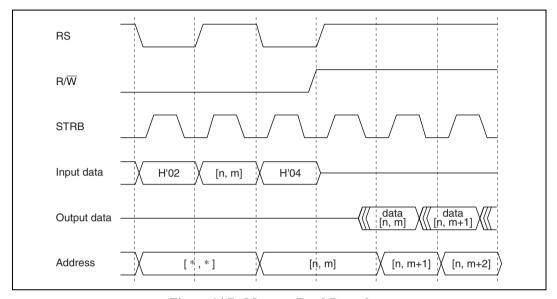


Figure 14.7 Memory Read Procedure

Read-Modify-Write Mode

In the normal state, the X or Y address is incremented after both read and write accesses to the display memory. In read-modify-write mode, the address is incremented only after a write, and remains the same after a read. By using this mode, it is possible to read previously written data, process that data, and then write it back to the same address.

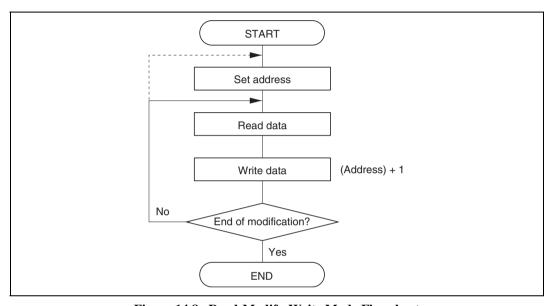


Figure 14.8 Read-Modify-Write Mode Flowchart

14.3.7 Module Standby Mode

The LCD controller has a module standby function that enables low power consumption to be achieved. In module standby mode, the current supply to the built-in bleeder resistances is halted, and segment and common outputs go to the V_{ss} (display-off state) level. Display RAM and internal register data is retained, except for the DISP, LPS1, and LPS0 bits in control register 2 (LR1). The control registers can still be accessed in the module standby state. Figure 14.9 shows the procedures for initiating and clearing module standby mode. The initiation and clearing procedures must be followed exactly in order to protect the display memory contents.

When the CPU is placed in standby mode, set the LSBY bit in control register 1 (LR0) to 1 before executing the standby instruction. After clearing standby mode, follow the module standby clearing procedure to start display.

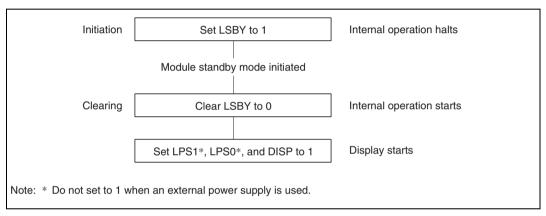


Figure 14.9 Module Standby Mode and Standby Mode Initiation and Clearing Procedures

14.3.8 Power-On and Power-Off Procedures

As the LCD controller incorporates a complete power supply circuit, the procedures shown in figure 14.10 must be followed when powering on and off. Failure to follow these procedures may result in an abnormal display.

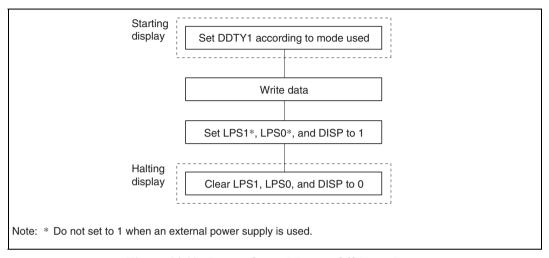


Figure 14.10 Power-On and Power-Off Procedures

14.3.9 Power Supply Circuit

The LCD controller has a built-in bleeder resistance circuit for LCD drive. In standby mode, the voltage circuits are automatically turned off and the power consumption of the power supply circuit falls to zero. The power supply circuit can be turned on and off by a command, and an external power supply circuit should be used if the current capacity of the built-in step-up circuit is insufficient.

LCD Drive Level

Six power supply levels—V1, V2, V3, V3, V4, V5, and V_{ss} —are necessary for LCD drive. The V1 to V_{ss} power supplies are normally generated by means of resistive division.

When 1/4 bias is used for LCD display, the V3OUT and V4OUT pins should be shorted; when 1/5 bias is used, the V3OUT and V4OUT pins should be left open.



External Power Supply

- When external power supply is input directly to pins V1OUT through V5OUT A power supply can be applied directly to V1OUT, V2OUT, V3OUT, V4OUT, and V5OUT from an external source by clearing bits LPS0 and LPS1 to 0 in control register 2 (LR1) to halt the power supply to the built-in bleeder resistance circuit. Apply a voltage not exceeding V_{cc} to pins V1OUT through V5OUT.
- When an external power supply is input to pin V1OUT
 V1 to V5 can be generated by inputting an external power supply to V1OUT, and using the built-in bleeder resistances by setting the LPS1 bit to 1 in control register 2 (LR1). Apply a voltage not exceeding V_{CC} to pin V1OUT.

In either case, inputting a voltage exceeding V_{CC} may adversely affect the reliability of the chip.

14.3.10 LCD Drive Power Supply Voltages

There are six LCD drive power supply voltage values—V1 to V5, and V_{ss} . V1 is the highest voltage, and V_{ss} the lowest. As shown in figure 14.11, the common waveforms are formed from a combination of V1, V2, V5, and V_{ss} , while the segment waveforms are formed from a combination of V1, V3, V4, and V_{ss} . V1 and V_{ss} are shared by both common and segment waveforms, but the intermediate voltages are different.

In figure 14.11, the waveforms of outputs SEG1 to SEG40 differ according to the display data. In this example, LCD panel lines for which COM1 is connected are illuminated, and all other dots are not illuminated.

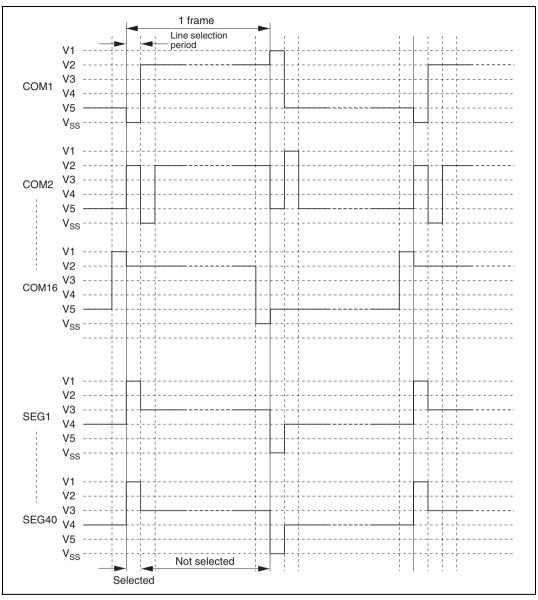


Figure 14.11 LCD Drive Power Supply Waveforms (1/16 Duty)

14.3.11 LCD Voltage Generation Circuit

When Using Internal Power Supply and Built-In Bleeder Resistances

The LCD controller includes bleeder resistances that generate levels V1 to V5. For the LCD drive power supply, drive can be performed using the internal power supply and V_{cc} , or using an external supply. When the internal power supply is used, and the built-in bleeder resistances are employed, bits LPS1 and LPS0 in control register 2 (LR1) should both be set to 1. If the capacitance of the LCD panel to be driven is large, capacitors of around 0.1 to 0.5 μ F should be inserted between V10UT to V50UT and V_{cs} to provide stabilization.

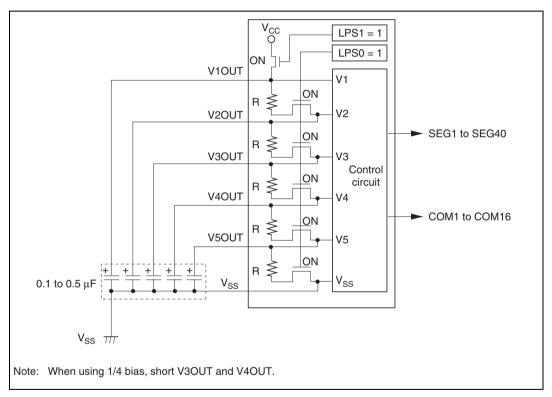


Figure 14.12 When Using Internal Power Supply and Built-In Bleeder Resistances (1/5 Bias)

When Using External Power Supply and Built-In Bleeder Resistances

When an external power supply is supplied from V1OUT and the built-in bleeder resistances are used, clear LPS1 to 0 and set LPS0 to 1 in control register 2 (LR1), and make the connections shown in figure 14.13. The power supply applied to V1OUT must not exceed $V_{\rm cc}$. If the capacitance of the LCD panel to be driven is large, capacitors of around 0.1 to 0.5 μF should be inserted between V1OUT to V5OUT and V_{ss} to provide stabilization.

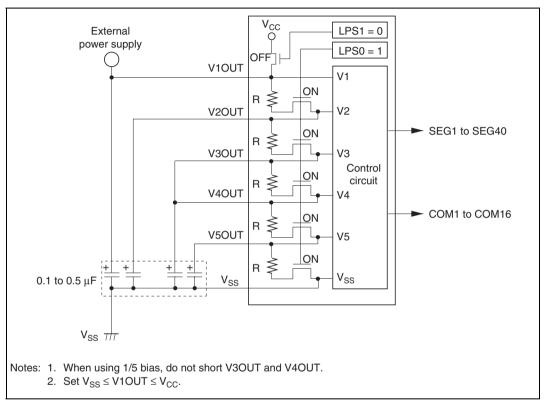


Figure 14.13 When Using External Power Supply and Built-In Bleeder Circuit (1/4 Bias)

When Using External Power Supply and Bleeder Resistances

If the drive capability of the built-in bleeder resistance is insufficient for the size of the LCD panel, the V1 to V5 levels can be supplied from external bleeder resistances. In this case, clear the LPS1 and LPS0 bits in control register 2 (LR1) to 0, and make the connections shown in figure 14.14.

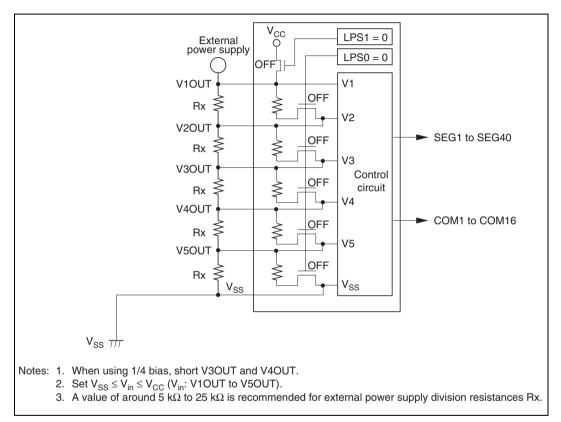


Figure 14.14 When Using External Power Supply and External Bleeder Circuit (1/5 Bias)

14.3.12 LCD Drive Bias Selection Circuit

The ideal bias value that gives the best contrast is calculated using the equation shown below. If drive is performed at a bias value lower than the optimum, contrast will deteriorate, but the LCD drive voltage (the potential difference between V1 and V_{ss}) can be kept low. If the output voltage falls and the LCD display becomes faint as batteries wear out, for instance, the display can be made clearer by decreasing the LCD drive bias.

Optimum bias value for 1/N duty drive =
$$\frac{1}{\sqrt{N} + 1}$$

Notes: 1. When using 1/5 bias, leave the V3OUT and V4OUT pins open.

2. When using 1/4 bias, short the V3OUT and V4OUT pins.



Section 15 Electrical Characteristics (H8/3857 Group)

15.1 H8/3855, H8/3856, and H8/3857 Absolute Maximum Ratings (Standard Specifications)

Table 15.1 shows the absolute maximum ratings.

Table 15.1 Absolute Maximum Ratings

| Item | | Symbol | Value | Unit | Notes |
|-----------------------------|------------------------------------|------------------|-------------------------------|------|-------|
| Power supply voltage | | V _{cc} | -0.3 to +7.0 | V | |
| Analog power supply voltage | | AV _{cc} | -0.3 to +7.0 | V | |
| LCD power supply voltage | | V _{LCD} | -0.3 to +8.0 | V | *1 |
| Programming voltage (FWE) | | V _{in} | -0.3 to V_{cc} +0.3 | V | *2 |
| Input voltage | Except port B and LCD power supply | V _{in} | -0.3 to V _{cc} +0.3 | V | |
| | Port B | AV _{in} | -0.3 to AV _{cc} +0.3 | V | |
| | LCD power supply | V _{in} | -0.3 to V _{LCD} +0.3 | V | *3 |
| Operating temperature | | T _{opr} | -20 to +75 | °C | *4 |
| Storage temperature | | T _{stg} | -55 to +125 | °C | |

Caution: Permanent damage may occur to the chip if maximum ratings are exceeded. Normal operation should be under the conditions specified in Electrical Characteristics.

Exceeding these values can result in incorrect operation and reduced reliability.

Notes: 1. A voltage not lower than V_{cc} must be applied as LCD power supply voltage V_{Lco} .

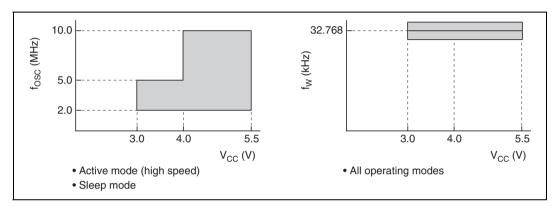
- 2. 12 V must not be applied to the FWE pin, as this will permanently damage the device.
- When the built-in op-amps are not used, and the LCD drive voltages are supplied directly from an external source, this applies to V1OUT, V2OUT, V3OUT, V4OUT, and V5OUT.
- 4. The operating temperature range when programming/erasing flash memory is: $T_a = 0$ °C to +75°C.

15.2 H8/3855, H8/3856, and H8/3857 Electrical Characteristics (Standard Specifications)

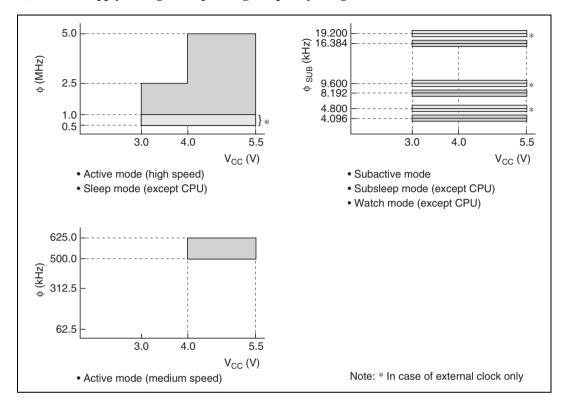
15.2.1 Power Supply Voltage and Operating Range

The power supply voltage and operating range of the H8/3855, H8/3856, and H8/3857 are indicated by the shaded region in the figures below.

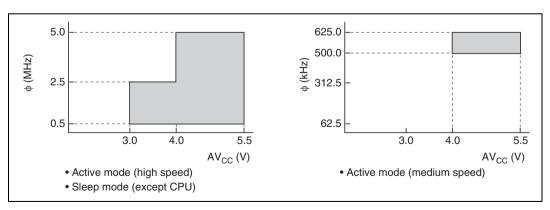
(1) Power Supply Voltage vs. Oscillator Frequency Range



(2) Power Supply Voltage vs. Operating Frequency Range



(3) Analog Power Supply Voltage vs. A/D Converter Operating Range



15.2.2 DC Characteristics

Table 15.2 shows the DC characteristics of the H8/3855, H8/3856, and H8/3857.

Table 15.2 DC Characteristics of H8/3855, H8/3856, and H8/3857 (1)

 $V_{cc} = 3.0 \text{ V}$ to 5.5 V, $AV_{cc} = 3.0 \text{ V}$ to 5.5 V, $V_{ss} = AV_{ss} = 0.0 \text{ V}$, $T_a = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C}^{*4}$, including subactive mode, unless otherwise specified.

| | Symbol | Applicable Pins | Test Conditions | Values | | | |
|-----------------------|-----------------|--|--|----------------------|-----|-----------------------|------------|
| Item | | | | Min | Тур | Max | Unit Notes |
| Input high voltage | V _{IH} | RES, WKP ₀ to WKP ₇ , IRQ ₀ to IRQ ₄ , TMIB, TMIC, TMIF, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 0.8 V _{cc} | _ | V _{cc} +0.3 | V |
| | | TEST2, FWE, SCK,, SCK ₃ , ADTRG | | 0.9 V _{cc} | _ | V _{cc} +0.3 | _ |
| | | UD, SI₁, RXD | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 0.7 V _{cc} | _ | V _{cc} +0.3 | V |
| | | | | 0.8 V _{cc} | _ | V _{cc} +0.3 | _ |
| | | OSC, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | V _{cc} -0.5 | _ | V _{cc} +0.3 | V |
| | | | | V _{cc} -0.3 | _ | V _{cc} +0.3 | _ |
| | | X1 | | V _{cc} -0.3 | _ | V _{cc} +0.3 | V |
| | | P1 ₀ to P1 ₇ , P2 ₀ to P2 ₇ , | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | $0.7~V_{cc}$ | _ | V _{cc} +0.3 | V |
| | | P3 ₀ to P3 ₇ , P4 ₀ to P4 ₃ , P5 ₀ to P5 ₇ | | 0.8 V _{cc} | _ | V _{cc} +0.3 | _ |
| | | PB ₀ to PB ₇ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 0.7 V _{cc} | _ | AV _{cc} +0.3 | 3 V |
| | | | | 0.8 V _{cc} | _ | AV _{cc} +0.3 | 3 |
| Input low voltage | V _{IL} | RES, WKP ₀ to WKP ₇ , IRQ ₀ to IRQ ₄ , TMIB, TMIC, TMIF, | V_{cc} = 4.0 V to 5.5 V | -0.3 | _ | 0.2 V _{cc} | V |
| | | TEST2, FWE, SCK,, SCK ₃ , ADTRG | | -0.3 | _ | 0.1 V _{cc} | _ |
| | | UD, SI₁, RXD | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | -0.3 | _ | 0.3 V _{cc} | V |
| | | | | -0.3 | | 0.2 V _{cc} | |
| | | OSC, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | -0.3 | | 0.5 | V |
| | | | | -0.3 | _ | 0.3 | |

| | | | | | Value | es | | | |
|------------------------------------|-------------------|--|---|----------------------|-------|---------------------|------|----------------------------------|--|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes | |
| Input low | V _{IL} | X1 | | -0.3 | _ | 0.3 | V | | |
| voltage | | P1 ₀ to P1 ₇ , P2 ₀ to P2 ₇ , P3 ₀ to P3 ₇ , | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | -0.3 | _ | 0.3 V _{cc} | V | | |
| | | P4 ₀ to P4 ₃ , P5 ₀ to P5 ₇ , PB ₀ to PB ₇ | | -0.3 | _ | 0.2 V _{cc} | | | |
| Output high voltage | V_{OH} | P1 ₀ to P1 ₇ , P2 ₀ to P2 ₇ , | $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}$ $-I_{OH} = 1.0 \text{ mA}$ | V _{cc} -1.0 | _ | _ | V | | |
| | | P3 ₀ to P3 ₇ , P4 ₀ to P4 ₂ , P5 ₀ to P5 ₇ | $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}$ $-I_{OH} = 0.5 \text{ mA}$ | V _{cc} -0.5 | _ | _ | | | |
| | | 1 30 10 1 37 | -I _{OH} = 0.1 mA | V _{cc} -0.5 | _ | _ | _ | | |
| Output low voltage | V _{oL} | P1 ₀ to P1 ₇ , P4 ₀ to P4 ₂ , | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ $I_{oL} = 1.6 \text{ mA}$ | _ | _ | 0.6 | V | | |
| | | P5 ₀ to P5 ₇ | I _{OL} = 0.4 mA | _ | _ | 0.5 | | | |
| | | P2 ₀ to P2 ₇ , P3 ₀ to P3 ₇ | $V_{\rm cc}$ = 4.0 V to 5.5 V $I_{\rm oL}$ = 10 mA | _ | _ | 1.5 | V | | |
| | | | V_{cc} = 4.0 V to 5.5 V I_{oL} = 1.6 mA | _ | _ | 0.6 | | | |
| | | | I _{OL} = 0.4 mA | _ | _ | 0.5 | | | |
| Input/output leakage current | I _{IL} | $\begin{array}{l} \overline{\text{RES}}, \text{TEST2, FWE,} \\ \text{OSC}_{_{1}}, \\ \text{P1}_{_{0}} \text{to P1}_{_{7}}, \\ \text{P2}_{_{0}} \text{to P2}_{_{7}}, \\ \text{P3}_{_{0}} \text{to P3}_{_{7}}, \\ \text{P4}_{_{0}} \text{to P4}_{_{3}}, \\ \text{P5}_{_{0}} \text{to P5}_{_{7}} \end{array}$ | $V_{in} = 0.5 \text{ V to}$ $V_{cc} = 0.5 \text{ V}$ | _ | _ | 1.0 | μΑ | | |
| | | PB ₀ to PB ₇ | $V_{in} = 0.5 \text{ V to}$ $AV_{cc} - 0.5 \text{ V}$ | _ | _ | 1.0 | μА | _ | |
| Pull-up MOS | $-I_p$ | P1 ₀ to P1 ₇ , | $V_{cc} = 5 \text{ V}, V_{in} = 0 \text{ V}$ | 50.0 | _ | 300.0 | μΑ | | |
| current | | P3 ₀ to P3 ₇ , P5 ₀ to P5 ₇ | $V_{cc} = 3.3 \text{ V},$ $V_{in} = 0 \text{ V}$ | _ | 100 | _ | μА | Reference values | |
| Input capacitance | \mathbf{C}_{in} | All input pins except power supply pins | $f = 1 \text{ MHz}, V_{in} = 0 \text{ V},$ $T_{a} = 25^{\circ}\text{C}$ | _ | _ | 15.0 | pF | | |
| Active mode current dissipation | I _{OPE1} | V _{cc} | Active mode (high speed) $V_{cc} = 5 V$, $f_{osc} = 10 \text{ MHz}$ | | 10.0 | 15.0 | mA | * ¹ * ² | |
| Ī | I _{OPE2} | V _{cc} | Active mode (medium speed) $V_{cc} = 5 V$, $f_{osc} = 10 \text{ MHz}$ | _ | 2.0 | 3.5 | mA | *1 *2 | |

| | | | | | Value | es | | |
|--|-------------------------------|-----------------|---|-----|-------|------|------|----------------------------------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Sleep mode current dissipation | I _{SLEEP} | V _{cc} | $V_{cc} = 5 \text{ V},$ $f_{osc} = 10 \text{ MHz}$ | _ | 4.0 | 7.0 | mA | * ¹ * ² |
| Subactive mode current dissipation | I _{SUB} | V _{cc} | $V_{cc} = 3.3 \text{ V},$ LCD on, (with 2X step-up) 32-kHz crystal oscillator used $(\phi_{\text{SUB}} = \phi_{\text{W}}/2)$ | _ | 70 | 150 | μА | * ¹ * ² |
| | | | $V_{cc} = 3.3 \text{ V},$ LCD on, (with 2X step-up) 32-kHz crystal oscillator used $(\phi_{\text{SUB}} = \phi_{\text{W}}/8)$ | _ | 65 | _ | μА | *1 *2 Reference values |
| | | | $V_{cc} = 3.3 \text{ V},$ LCD not used, 32- kHz crystal oscillator used $(\phi_{SUB} = \phi_W/2)$ | r | 20 | | μА | *1 *2 Reference values |
| Subsleep mode current dissipation | SUBSP | V _{cc} | $V_{\rm cc}$ = 3.3 V, LCD on, (with 2X step-up) 32-kHz crystal oscillator used $(\phi_{\rm SUB} = \phi_{\rm W}/2)$ | _ | 65 | 130 | μА | *1 * ² |
| Watch mode current dissipation | I _{watch} | V _{cc} | V _{cc} = 3.3 V, LCD on, (with 2X step-up) 32-kHz crystal oscillator used | _ | 60 | 90.0 | μΑ | * ¹ * ² |
| | | | V_{∞} = 3.3 V, LCD not used, 32-kHz crystal oscillator used | _ | 7.0 | 15.0 | μА | * ¹ * ² |
| Standby mode current dissipation | I _{STBY} | V _{cc} | 32-kHz crystal oscillator not used | _ | _ | 5.0 | μА | * ¹ * ² |
| Program/ erase current dissipation | FLASH | V _{cc} | $0^{\circ}\text{C} \le \text{T}_{\text{a}} \le 70^{\circ}\text{C}$ $f_{\text{OSC}} = 12 \text{ MHz}$ | _ | 16 | 22 | mA | *1 *2 *3 |
| RAM data retaining voltage | $V_{\scriptscriptstyle{RAM}}$ | V _{cc} | | 2.0 | _ | _ | V | * ¹ * ² |



Notes: 1. Pin states during current measurement

| Mode | Internal State | Pins | LCD Power Supply | Oscillator Pins |
|---------------------------------------|--|-----------------|--|--|
| Active mode (high and medium speed) | Operates | V _{cc} | $V_{LCD} = 6.0 \text{ V}$ | System clock oscillator: Crystal Subclock oscillator: Pin $X_1 = V_{cc}$ |
| Sleep mode | Only timer operates | V _{cc} | V _{LCD} = 6.0 V | _ |
| Subactive mode | Operates | V _{cc} | $V_{LCD} = 6.0 \text{ V}$ (When LCD is not used, $V_{LCD} = V_{CC}$) | System clock oscillator: Crystal Subclock oscillator: Crystal |
| Subsleep mode | Only timer operates, CPU stops | V _{cc} | $V_{LCD} = 6.0 \text{ V}$ | _ |
| Watch mode | Only time-base clock operates, CPU stops | V _{cc} | $V_{LCD} = 6.0 \text{ V}$ (When LCD is not used, $V_{LCD} = V_{CC}$) | _ |
| Standby mode | CPU and timers all stop | V _{cc} | $V_{LCD} = V_{CC}$ | System clock oscillator: Crystal Subclock oscillator: Pin $X_1 = V_{cc}$ |
| Programming/ erasing* ³ | Operates | V _{cc} | $V_{LCD} = V_{CC}$ | System clock oscillator: Crystal Subclock oscillator: Pin $X_1 = V_{cc}$ |

- 2. Excludes current in pull-up MOS transistors and output buffers.
- 3. Applies to F-ZTAT version only.
- 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C .

Table 15.3 DC Characteristics of H8/3855, H8/3856, and H8/3857 (2)

 V_{cc} = 3.0 V to 5.5 V, AV_{cc} = 3.0 V to 5.5 V, V_{ss} = AV_{ss} = 0.0 V, T_a = -20°C to +75°C*², including subactive mode, unless otherwise specified.

| | | | | | Valu | es | | |
|-----------------------|-------------------------|-------------------------------------|--|-----|------|------|------|-------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Allowable output low | I _{OL} | Output pins except in ports 2 and 3 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 2.0 | mA | *1 |
| current (per pin) | | Ports 2 and 3 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 10.0 | | |
| (per piri) | | All output pins | | _ | _ | 0.5 | | |
| output low | ΣI_{OL} | Output pins except in ports 2 and 3 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 20.0 | mA | *1 |
| current (total) | | Ports 2 and 3 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 80.0 | | |
| | | All output pins | | _ | _ | 20.0 | | |
| Allowable output high | -I _{OH} | All output pins | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 2.0 | mA | *1 |
| current (per pin) | | | | _ | _ | 0.2 | | |
| Allowable output high | Σ - I_{OH} | All output pins | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 10.0 | mA | *1 |
| current (total) | | | | _ | _ | 8.0 | | |

Notes: 1. Excludes LCD output pins.

2. The guaranteed temperature as an electrical characteristic for die type products is 75°C.

15.2.3 AC Characteristics

Table 15.4 shows the control signal timing, and tables 15.5 and 15.6 show the serial interface timing, of the H8/3855, H8/3856, and H8/3857.

Table 15.4 Control Signal Timing of H8/3855, H8/3856, and H8/3857

 V_{cc} = 3.0 V to 5.5 V, AV_{cc} = 3.0 V to 5.5 V, V_{ss} = AV_{ss} = 0.0 V, T_a = -20°C to +75°C*³, including subactive mode, unless otherwise specified.

| | | Applicable | | Values | | | | Reference |
|--|---------------------|---|--|--------|--------|--------|---|-------------|
| Item | Symbol | • • | Test Conditions | Min | Тур | Max | Unit | Figure |
| System clock | f _{osc} | OSC1, OSC2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 2.0 | _ | 10.0 | MHz | |
| oscillation frequency | | | | 2.0 | _ | 5.0 | | |
| OSC clock (ϕ_{osc}) | t _{osc} | OSC1, OSC2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 100.0 | _ | 1000.0 | ns | *1 |
| cycle time | | | | 200.0 | _ | 1000.0 | | Figure 15.1 |
| System clock (φ) | t _{cyc} | | | 2 | _ | 16 | t _{osc} | *1 |
| cycle time | | | | _ | _ | 2000.0 | | _ |
| Subclock oscillation frequency | f _w | X1, X2 | | _ | 32.768 | _ | kHz | |
| Watch clock (φ _w) cycle time | t _w | X1, X2 | | _ | 30.5 | _ | μS | |
| Subclock (φ _{SUB}) cycle time | t _{subcyc} | | | 2 | _ | 8 | t _w | *2 |
| Instruction cycle time |) | | | 2 | _ | _ | t _{cyc} t _{subcyc} | |
| Oscillation | t _{rc} | OSC ₁ , OSC ₂ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 40.0 | _ | _ | ms | |
| stabilization time (crystal oscillator) | | | | 60.0 | _ | _ | _ | |
| Oscillation stabilization time | t _{rc} | X ₁ , X ₂ | | 2 | _ | _ | S | |
| External clock high | t _{CPH} | OSC ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 40.0 | _ | _ | ns | Figure 15.1 |
| width | | | | 80.0 | _ | _ | _ | |
| External clock low | t _{CPL} | OSC ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 40.0 | _ | _ | ns | Figure 15.1 |
| width | | | | 80.0 | _ | _ | _ | |
| External clock rise | t _{CPr} | OSC, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 15.0 | ns | Figure 15.1 |
| time | | | | _ | _ | 20.0 | _ | |
| External clock fall | t _{CPf} | OSC ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 15.0 | ns | Figure 15.1 |
| time | | | | | _ | 20.0 | | |

15. Electrical Characteristics (H8/3857 Group)

| | | Applicable Values | | | Values | | | Reference |
|---------------------------------|--------------------------------------|---|------------------------|--------|--------|-------|---|-------------|
| Item | Symbol | Pins | Test Conditions | Min | Тур | Max | Unit | Figure |
| External subclock high width | t _{xH} | X ₁ | | 0.4/fx | _ | _ | S | Figure 15.2 |
| External subclock low width | t _{xL} | X ₁ | | 0.4/fx | _ | _ | S | Figure 15.2 |
| External subclock rise time | t _{xr} | X ₁ | | _ | _ | 100.0 | ns | Figure 15.2 |
| External subclock fall time | t _{xf} | X ₁ | | _ | _ | 100.0 | ns | Figure 15.2 |
| RES pin low width | t _{REL} | RES | | 10 | _ | _ | t _{cyc} | Figure 15.3 |
| Input pin high width | t _{iH} | \overline{IRQ}_{0} to \overline{IRQ}_{4} , \overline{WKP}_{0} to \overline{WKP}_{7} , \overline{ADTRG} , $TMIB$, $TMIC$, $TMIF$ | | 2 | _ | _ | t _{cyc} t _{subcyc} | Figure 15.4 |
| Input pin low width | t _{IL} | IRQ _o to IRQ ₄ , WKP ₀ to WKP ₇ , ADTRG, TMIB, TMIC, TMIF | | 2 | _ | _ | t _{cyc} t _{subcyc} | Figure 15.4 |
| UD pin minimum transition width | t _{udh} t _{udl} | UD | | 4 | _ | _ | t _{cyc} t _{subcyc} | Figure 15.5 |

Notes: 1. A frequency between 1 MHz and 10 MHz is required when an external clock is input.

- 2. Selected with bits SA1 and SA0 in system control register 2 (SYSCR2).
- 3. The guaranteed temperature as an electrical characteristic for die type products is 75°C .



Table 15.5 Serial Interface (SCI1) Timing of H8/3855, H8/3856, and H8/3857

 V_{cc} = 3.0 V to 5.5 V, AV_{cc} = 3.0 V to 5.5 V, V_{ss} = AV_{ss} = 0.0 V, T_a = -20°C to +75°C*, unless otherwise specified.

| | | Applicable | | Values | | | | Reference |
|-------------------------------|-------------------|-----------------|--|--------|-----|-------|-------------------|-------------|
| Item | Symbol | Pins | Test Conditions | Min | Тур | Max | Unit | Figure |
| Input serial clock cycle time | t _{scyc} | SCK, | | 4 | _ | _ | t _{cyc} | Figure 15.6 |
| Input serial clock high width | t _{sckh} | SCK, | | 0.4 | _ | _ | t _{Scyc} | Figure 15.6 |
| Input serial clock low width | t _{sckl} | SCK, | | 0.4 | _ | _ | t _{Scyc} | Figure 15.6 |
| Input serial clock | t _{sckr} | SCK, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 60.0 | ns | Figure 15.6 |
| rise time | | | | _ | _ | 80.0 | | |
| Input serial clock | t _{sckf} | SCK, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 60.0 | ns | Figure 15.6 |
| fall time | | | | _ | _ | 80.0 | | |
| Serial output data | t _{sop} | SO ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 200.0 | ns | Figure 15.6 |
| delay time | | | | _ | _ | 350.0 | | |
| Serial input data | t _{sis} | SI ₁ | V _{cc} = 4.0 V to 5.5 V | 200.0 | _ | _ | ns | Figure 15.6 |
| setup time | | | | 400.0 | _ | _ | | |
| Serial input data | t _{siн} | SI ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 200.0 | _ | _ | ns | Figure 15.6 |
| hold time | | | | 400.0 | _ | _ | | |

Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C.

Table 15.6 Serial Interface (SCI3) Timing of H8/3855, H8/3856, and H8/3857

 V_{cc} = 3.0 V to 5.5 V, AV_{cc} = 3.0 V to 5.5 V, V_{ss} = AV_{ss} = 0.0 V, T_a = -20°C to +75°C*, unless otherwise specified.

| | | | | | Value | s | | Reference |
|-------------|---------------|--------------------|--|-------|-------|-----|-------------------|-------------|
| Item | | Symbol | Test Conditions | Min | Тур | Max | Unit | Figure |
| Input clock | Asynchronous | _t _{scyc} | | 4 | _ | _ | t _{cyc} | Figure 15.7 |
| cycle | Synchronous | | | 6 | _ | _ | | |
| Input clock | pulse width | t _{sckw} | | 0.4 | _ | 0.6 | t _{Scyc} | Figure 15.7 |
| | ta delay time | t _{TXD} | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 1 | t _{cyc} | Figure 15.8 |
| (synchronou | us mode) | | | _ | _ | 1 | _ | |
| | a setup time | t _{RXS} | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 200.0 | _ | _ | ns | Figure 15.8 |
| (synchronou | us mode) | | | 400.0 | _ | _ | | |
| Receive dat | | t _{RXH} | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 200.0 | _ | _ | ns | Figure 15.8 |
| (synchronou | us mode) | | | 400.0 | _ | _ | _ | |

Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C.



15.2.4 A/D Converter Characteristics

Table 15.7 shows the A/D converter characteristics of the H8/3855, H8/3856, and H8/3857.

Table 15.7 A/D Converter Characteristics of H8/3855, H8/3856, and H8/3857

 $V_{cc} = 3.0 \text{ V}$ to 5.5 V, $V_{ss} = AV_{ss} = 0.0 \text{ V}$, $T_a = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C*}^4$, unless otherwise specified.

| Applicable Test Values | | | | _ | Reference | | | |
|-----------------------------------|---------------------|------------------------------------|--------------------------|-----------------------|-----------|-----------------------|------|--------------------------------------|
| Item | Symbol | Pins | Conditions | Min | Тур | Max | Unit | Figure |
| Analog power supply voltage | AV _{cc} | AV _{cc} | | 3.0 | _ | 5.5 | V | *1 |
| Analog input voltage | AV _{IN} | AN ₀ to AN ₇ | | AV _{ss} -0.3 | _ | AV _{cc} +0.3 | V | |
| Analog power supply | Al _{OPE} | AV _{cc} | AV _{CC} = 5.0 V | _ | _ | 1.5 | mA | |
| current | Al _{stop1} | AV _{cc} | AV _{cc} = 5.0 V | _ | 300 | _ | μА | * ² Reference value |
| | Al _{STOP2} | AV _{cc} | | _ | _ | 5.0 | μΑ | *3 |
| Analog input capacitance | C _{AIN} | AN ₀ to AN ₇ | | _ | _ | 30.0 | pF | |
| Allowable signal source impedance | R _{AIN} | | | _ | _ | 5.0 | kΩ | |
| Resolution (data length) | | | | _ | _ | 8 | Bit | |
| Non-linearity error | | | | _ | _ | ±2.0 | LSB | |
| Quantization error | | | | _ | _ | ±0.5 | LSB | |
| Absolute accuracy | | | | _ | _ | ±2.5 | LSB | |
| Conversion time | | | | 12.4 | _ | 124 | μS | |

Notes: 1. Set $AV_{cc} \le V_{cc}$, and set $AV_{cc} = V_{cc}$ when the A/D converter is not used.

- 2. $AI_{\mathtt{STOP1}}$ is the current in active and sleep modes while the A/D converter is idle.
- 3. Al_{STOP2} is the current at reset and in standby, watch, subactive, and subsleep modes while the A/D converter is idle.
- 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C.

15.2.5 LCD Characteristics

Table 15.8 shows the LCD characteristics, and table 15.9 shows the step-up circuit characteristics, of the H8/3855, H8/3856, and H8/3857.

Table 15.8 LCD Characteristics of H8/3855, H8/3856, and H8/3857

 $V_{cc} = 3.0 \text{ V}$ to 5.5 V, $AV_{cc} = 3.0 \text{ V}$ to 5.5 V, $V_{ss} = AV_{ss} = 0.0 \text{ V}$, $T_a = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C*}^4$, including subactive mode, unless otherwise specified.

| | | | | | Value | es | | |
|------------------------------|------------------|------------------|--|-----------------|-------|-----|------|-------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Common driver on-resistance | R _{com} | COM1 to COM32 | $\pm Id = 0.05 \text{ mA},$ $V_{LCD} = 4 \text{ V}$ | _ | 6 | 20 | kΩ | *1 |
| Segment driver on-resistance | R _{SEG} | SEG1 to SEG64 | $\pm Id = 0.05 \text{ mA},$ $V_{LCD} = 4 \text{ V}$ | _ | 6 | 20 | kΩ | *1 |
| LCD power supply current | I _{EE} | V _{LCD} | $V_{LCD} = 5.5 \text{ V},$ $f_x = 32.768 \text{ kHz}$ | _ | 20 | 40 | μΑ | *2 |
| LCD power supply voltage | V _{LCD} | V _{LCD} | | V _{cc} | | 7.0 | V | *3 |

Notes: 1. Applies to the resistance (R_{COM}) between the V1OUT, V2OUT, V5OUT, and V_{SS} pins and the common signal pins (COM1 to COM32), and the resistance (R_{SEG}) between the V1OUT, V3OUT, V4OUT, and V_{SS} pins and the segment signal pins (SEG1 to SEG64), when Id is flowing in the pins.

- This is the current when the built-in op-amps are operating and display is halted (all driver outputs are at the V_{ss} level).
- 3. Specifies the voltage range in which the COM/SEG pin output voltages are within the LCD reference voltage values (V1, V2, V3, V4, V5, and V_{ss}) ± 0.15 V in the unloaded state. A voltage not lower than V_{cc} must be applied to V_{lco} .
- 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C.

Step-Up Circuit Characteristics of H8/3855, H8/3856, and H8/3857

 $V_{cc} = 3.0 \text{ V to } 5.5 \text{ V}, AV_{cc} = 3.0 \text{ V to } 5.5 \text{ V}, V_{ss} = AV_{ss} = 0.0 \text{ V}, T_{s} = -20^{\circ}\text{C to } +75^{\circ}\text{C*}^{2},$ including subactive mode, unless otherwise specified.

| | | Applicable | | | Value | es | | |
|-----------------------------------|-----------------------|-----------------|--|-----|-------|-----|------|------------------------------------|
| Item | Symbol | Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| 2X step-up output voltage | $V_{_{\mathrm{UP2}}}$ | VLOUT | $\begin{split} &V_{\text{CC}} = V_{\text{ci}} = 3.0 \text{ V}, \\ &I_{\text{o}} = 0.03 \text{ mA}, \\ &C = 1 \mu\text{F}, \\ &X1 = 32 \text{ kHz}, \\ &T_{\text{a}} = 25^{\circ}\text{C} \end{split}$ | _ | 5.96 | _ | V | Figure 15.9 Reference values |
| 3X step-up output voltage | V _{UP3} | VLOUT | $V_{cc} = 3.0 \text{ V},$ $V_{ci} = 2.0 \text{ V},$ $I_{o} = 0.03 \text{ mA},$ $C = 1 \mu\text{F},$ X1 = 32 kHz, $T_{a} = 25^{\circ}\text{C}$ | _ | 5.90 | _ | V | Figure 15.9 Reference values |
| Step-up circuit reference voltage | V _{ci} | V _{ci} | $V_{ci} \le V_{CC}$ | 1.6 | _ | 3.5 | V | *1 |

Notes: 1. As $V_{cc} \le VLOUT \le 7.0 \text{ V}$, with 2X step-up $V_{cc}/2 \le V_{cl} \le 3.5 \text{ V}$, and with 3X step-up $V_{cc}/3 \le V_{ci} \le 2.33 \text{ V}.$

> A voltage not exceeding V_{cc} should be input to V_{cl}. If this condition is not observed, there is a risk of permanent damage to the device.

2. The guaranteed temperature as an electrical characteristic for die type products is 75°C.

15.2.6 Flash Memory Characteristics

Table 15.10 shows the flash memory characteristics.

Table 15.10 Flash Memory Characteristics

Conditions: $V_{cc} = 4.5 \text{ V}$ to 5.5 V, $AV_{cc} = 4.5 \text{ V}$ to 5.5 V, $V_{ss} = AV_{ss} = 0.0 \text{ V}$, $T_a = 0^{\circ}\text{C}$ to +75°C (program/erase operating temperature range)

| Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------|--|------------------|-----|-----|------|-------------|--------------------|
| Programming ti | me* ¹ * ² * ⁴ | t _P | _ | 10 | 200 | ms/32 bytes | |
| Erase time*1*3* | 5 | t _E | _ | 100 | 300 | ms/block | |
| Rewrite times | | N _{wec} | _ | _ | 100 | Times | |
| Programming | Wait time after SWE bit setting*1 | х | 10 | _ | _ | μS | |
| | Wait time after PSU bit setting*1 | у | 50 | _ | _ | μS | |
| | Wait time after P bit setting*1*4 | Z | _ | _ | 200 | μS | |
| | Wait time after P bit clearing*1 | α | 10 | _ | _ | μS | |
| | Wait time after PSU bit clearing*1 | β | 10 | _ | _ | μS | |
| | Wait time after PV bit setting*1 | γ | 4 | _ | _ | μS | |
| | Wait time after H'FF dummy write*1 | 3 | 2 | _ | _ | μS | |
| | Wait time after PV bit clearing*1 | η | 4 | _ | _ | μS | |
| | Maximum number of writes*1*4 | N | _ | _ | 1000 | Times | |
| Erasing | Wait time after SWE bit setting*1 | х | 10 | _ | _ | μS | |
| | Wait time after ESU bit setting*1 | у | 200 | _ | _ | μS | |
| | Wait time after E bit setting*1*5 | Z | _ | _ | 5 | ms | |
| | Wait time after E bit clearing*1 | α | 10 | _ | _ | μS | |
| | Wait time after ESU bit clearing*1 | β | 10 | _ | _ | μS | |
| | Wait time after EV bit setting*1 | γ | 20 | _ | _ | μS | |
| | Wait time after H'FF dummy write*1 | 3 | 2 | _ | _ | μS | |
| | Wait time after EV bit clearing*1 | η | 5 | _ | _ | μS | |
| | Maximum number of erases*1*5 | N | _ | _ | 60 | Times | |

Notes: 1. Follow the program/erase algorithms when making the time settings.

- 2. Programming time per 32 bytes. (Indicates the total time during which the P bit is set in flash memory control register 1 (FLMCR1). Does not include the program-verify time.)
- 3. Time to erase one block. (Indicates the time during which the E bit is set in FLMCR1. Does not include the erase-verify time.)
- Maximum programming time (t_p(max) = Wait time after P bit setting (z) × maximum number of writes (N))
- Maximum erase time
 (t_E(max) = Wait time after E bit setting (z) × maximum number of erases (N))



15.3 Operation Timing

Figures 15.1 to 15.8 show timing diagrams.

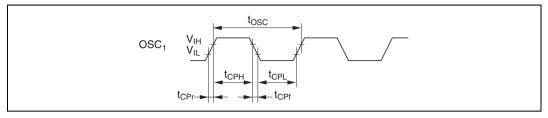


Figure 15.1 System Clock Input Timing

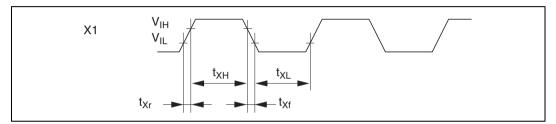


Figure 15.2 Subclock Input Timing

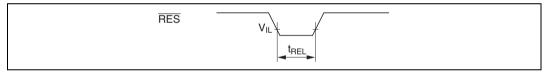


Figure 15.3 RES Pin Low Width Timing

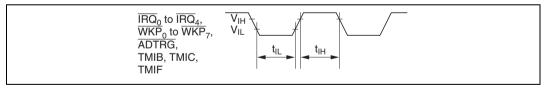


Figure 15.4 Input Timing

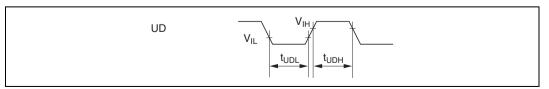


Figure 15.5 UD Pin Minimum Transition Width Timing

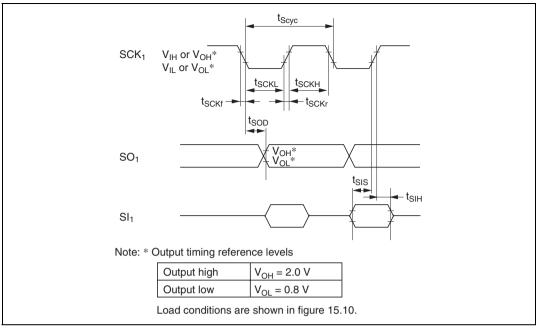


Figure 15.6 SCI1 Input/Output Timing

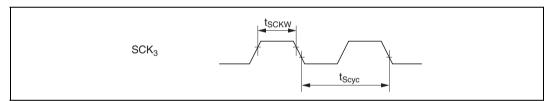


Figure 15.7 SCK3 Input Clock Timing

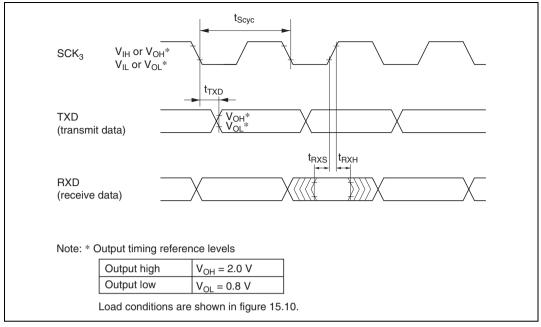


Figure 15.8 SCI3 Input/Output Timing in Synchronous Mode

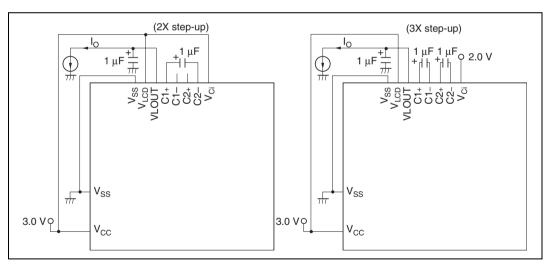


Figure 15.9 Step-Up Circuit Characteristics Test Circuits

15.4 Output Load Circuit

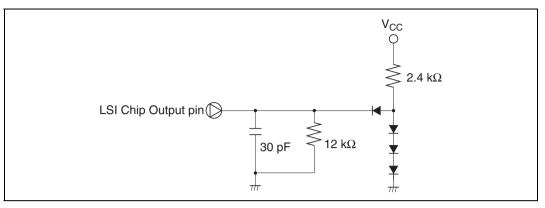


Figure 15.10 Output Load Conditions

15.5 Usage Note

Although both the F-ZTAT and mask ROM versions fully meet the electrical specifications listed in this manual, there may be differences in the actual values of the electrical characteristics, operating margins, noise margins, and so forth, due to differences in the fabrication process, the on-chip ROM, and the layout patterns.

If the F-ZTAT version is used to carry out system evaluation and testing, therefore, when switching to the mask ROM version the same evaluation and testing procedures should also be conducted on the mask ROM version.

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Section 16 Electrical Characteristics (H8/3854 Group)

16.1 H8/3852, H8/3853, and H8/3854 Absolute Maximum Ratings (Standard Specifications)

Table 16.1 shows the absolute maximum ratings.

Table 16.1 Absolute Maximum Ratings

| Item | | Symbol | Value | Unit | Notes |
|---------------------------|-------------------------|------------------|------------------------------|------|-------|
| Power supply v | roltage | V _{cc} | -0.3 to +7.0 | V | |
| Programming voltage (FWE) | | V _{in} | -0.3 to V _{cc} +0.3 | V | *1 |
| Input voltage | Except LCD power supply | V _{in} | -0.3 to V _{cc} +0.3 | V | |
| | LCD power supply | V _{in} | -0.3 to V _{cc} +0.3 | V | *2 |
| Operating temperature | | T _{opr} | –20 to +75 | °C | *3 |
| Storage temperature | | T _{sta} | -55 to +125 | °C | |

Permanent damage may occur to the chip if maximum ratings are exceeded. Normal Caution: operation should be under the conditions specified in Electrical Characteristics. Exceeding these values can result in incorrect operation and reduced reliability.

Notes: 1. 12 V must not be applied to the FWE pin, as this will permanently damage the device.

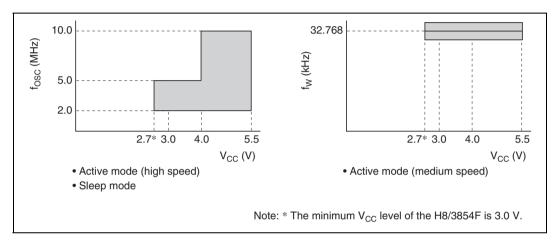
- 2. When the internal power supply and internal bleeder resistances are not used, and the LCD drive voltages are supplied directly from an external source, this applies to V10UT, V20UT, V30UT, V40UT, and V50UT.
- 3. The operating temperature range when programming/erasing flash memory is: T₂ = 0°C to +75°C.

16.2 H8/3852, H8/3853, and H8/3854 Electrical Characteristics (Standard Specifications)

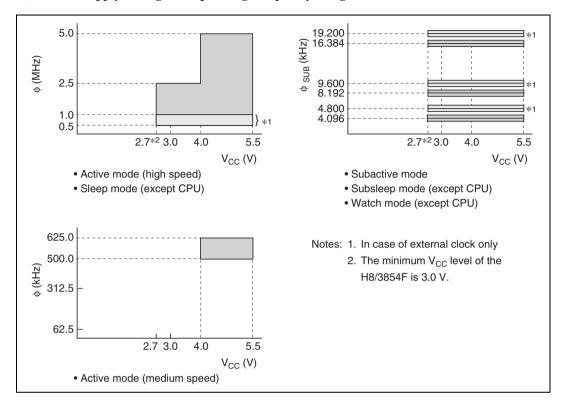
16.2.1 Power Supply Voltage and Operating Range

The power supply voltage and operating range of the H8/3852, H8/3853, and H8/3854 are indicated by the shaded region in the figures below.

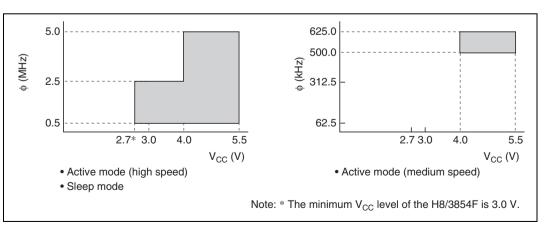
(1) Power Supply Voltage vs. Oscillator Frequency Range



(2) Power Supply Voltage vs. Operating Frequency Range



(3) Power Supply Voltage vs. A/D Converter Operating Range



16.2.2 DC Characteristics

Table 16.2 shows the DC characteristics of the H8/3852, H8/3853, and H8/3854.

Table 16.2 DC Characteristics of H8/3852, H8/3853, and H8/3854 (1)

 V_{cc} = 2.7 V to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, V_{cc} = 3.0 V to 5.5 V of H8/3854F, V_{ss} = 0.0 V, T_a = -20°C to +75°C*⁴, including subactive mode, unless otherwise specified.

| | | | | Values | | | |
|-----------------------|-----------------|---|--|----------------------|-----|----------------------|------------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit Notes |
| Input high voltage | V _{IH} | $\begin{array}{c} \overline{\text{RES}}, \\ \overline{\text{WKP}}_0 \text{ to } \overline{\text{WKP}}_7, \\ \overline{\text{IRQ}}_0, \overline{\text{IRQ}}_1, \\ \overline{\text{IRQ}}_3, \overline{\text{IRQ}}_4, \end{array}$ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 0.8 V _{cc} | _ | V _{cc} +0.3 | V |
| | | TMIB, TMIF, TEST2, FWE, SCK ₃ , ADTRG | | 0.9 V _{cc} | _ | V _{cc} +0.3 | _ |
| | | RXD | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 0.7 V _{cc} | _ | V _{cc} +0.3 | V |
| | | | | 0.8 V _{cc} | _ | V _{cc} +0.3 | |
| | | OSC, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | V _{cc} -0.5 | _ | V _{cc} +0.3 | V |
| | | | | V _{cc} -0.3 | _ | V _{cc} +0.3 | |
| | | X1 | | V _{cc} -0.3 | _ | V _{cc} +0.3 | V |
| | | P1 ₀ to P1 ₂ , P1 ₅ , P1 ₇ , | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 0.7 V _{cc} | _ | V _{cc} +0.3 | V |
| | | P2 ₀ to P2 ₇ , P4 ₀ to P4 ₃ , P5 ₀ to P5 ₇ , PB ₄ to PB ₇ | | 0.8 V _{cc} | _ | V _{cc} +0.3 | |
| Input low voltage | V _{IL} | RES, WKP ₀ to WKP ₇ , IRQ ₀ , IRQ ₁ , IRQ ₃ , IRQ ₄ , | V _{cc} = 4.0 V to 5.5 V | -0.3 | _ | 0.2 V _{cc} | V |
| | | TMIB, TMIF, TEST2, FWE, SCK ₃ , ADTRG | | -0.3 | _ | 0.1 V _{cc} | _ |
| | | RXD | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | -0.3 | _ | 0.3 V _{cc} | V |
| | | | | -0.3 | _ | 0.2 V _{cc} | _ |
| | | OSC, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | -0.3 | | 0.5 | V |
| | | | | -0.3 | _ | 0.3 | |

| | | | | | Value | es | | |
|------------------------------------|-----------------|--|--|----------------------|-------|---------------------|------|------------------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Input low | V _{IL} | X1 | | -0.3 | _ | 0.3 | ٧ | |
| voltage | | P1 ₀ to P1 ₂ , P1 ₅ , P1 ₇ , P2 ₀ to P2 ₇ , | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | -0.3 | _ | 0.3 V _{cc} | V | |
| | | P4 ₀ to P4 ₃ , P5 ₀ to P5 ₇ , PB ₄ to PB ₇ | | -0.3 | _ | 0.2 V _{cc} | _ | |
| Output high V voltage | V _{OH} | P1 ₀ to P1 ₂ , P1 ₅ , P1 ₇ , | $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}$ $-I_{OH} = 1.0 \text{ mA}$ | V _{cc} -1.0 | _ | _ | V | |
| Ü | | P2 ₀ to P2 ₇ , P4 ₀ to P4 ₂ , P5 ₀ to P5 ₇ | $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}$ $-I_{OH} = 0.5 \text{ mA}$ | V _{cc} -0.5 | _ | _ | _ | |
| | | 1 30 10 1 37 | -I _{он} = 0.1 mA | V _{cc} -0.5 | _ | _ | | |
| Output low voltage | V _{oL} | P1 ₀ to P1 ₂ , P1 ₅ , P1 ₇ , | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ $I_{oL} = 1.6 \text{ mA}$ | _ | _ | 0.6 | V | |
| • | | P4 ₀ to P4 ₂ , P5 ₀ to P5 ₇ | I _{oL} = 0.4 mA | _ | _ | 0.5 | | |
| | | P2 ₀ to P2 ₇ | $V_{\rm cc}$ = 4.0 V to 5.5 V $I_{\rm ol}$ = 10 mA | _ | _ | 1.5 | | |
| | | | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ $I_{oL} = 1.6 \text{ mA}$ | _ | _ | 0.6 | _ | |
| | | | I _{OL} = 0.4 mA | _ | _ | 0.5 | | |
| Input/output leakage current | I _{IL} | RES, TEST2, FWE, OSC,, P1 ₀ to P1 ₂ , P1 ₅ , P1 ₇ , P2 ₀ to P2 ₇ , P4 ₀ to P4 ₉ , P5 ₀ to P5 ₇ , PB ₄ to PB ₇ | $V_{in} = 0.5 \text{ V to}$ $V_{cc} = 0.5 \text{ V}$ | _ | _ | 1.0 | μΑ | |
| Pull-up MOS | -I _p | P1 ₀ to P1 ₂ , | $V_{cc} = 5 \text{ V}, V_{in} = 0 \text{ V}$ | 50.0 | _ | 300.0 | μА | |
| current | | P1 ₅ , P1 ₇ , | $V_{cc} = 3.3 \text{ V},$ $V_{in} = 0 \text{ V}$ | _ | 100 | _ | μА | Reference values |
| Input capacitance | C _{in} | All input pins except power supply pins | $f = 1 \text{ MHz}, V_{in} = 0 \text{ V},$ $T_{a} = 25^{\circ}\text{C}$ | _ | _ | 15.0 | pF | |

| Valu | | | | Value | es | | | |
|--|--------------------|-----------------|--|-------|------|------|------|--|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Active mode current dissipation | I _{OPE1} | V _{cc} | Active mode (high speed) $V_{cc} = 5 V$, $f_{osc} = 10 \text{ MHz}$ A/D not used | _ | 10.0 | 15.0 | mA | * ¹ * ² |
| | I _{OPE3} | V _{cc} | Active mode (high speed) $V_{cc} = 5 V$, $f_{osc} = 10 \text{ MHz}$ A/D operating | _ | _ | 16.5 | mA | * ¹ * ² |
| | OPE2 | V _{cc} | Active mode (medium speed) $V_{cc} = 5 V$, $f_{osc} = 10 \text{ MHz}$ A/D not used | _ | 2.0 | 3.5 | mA | * ¹ * ² |
| Sleep mode current dissipation | I _{SLEEP} | V _{cc} | $V_{cc} = 5 \text{ V},$ $f_{osc} = 10 \text{ MHz}$ A/D not used | _ | 4.3 | 7.0 | mA | * ¹ * ² |
| Subactive mode current dissipation | I _{SUB} | V _{cc} | $V_{cc} = 5.0 \text{ V},$ LCD on, 32-kHz crystal oscillator used $(\phi_{SUB} = \phi_W/2)$ | _ | 80 | 160 | μА | * ¹ * ² * ⁵ |
| | | | V_{cc} = 5.0 V, LCD on, 32-kHz crystal oscillator used (ϕ_{sub} = ϕ_{w} /8) | _ | 70 | _ | μА | *1 *2 *5 Reference values |
| | | | V_{cc} = 3.3 V, LCD not used, 32- kHz crystal oscillator used (ϕ_{SUB} = ϕ_{W} /2) | _ | 20 | _ | μΑ | *1 *2 Reference values |
| Subsleep mode current dissipation | I _{SUBSP} | V _{cc} | $V_{cc} = 5.0 \text{ V},$ LCD on, 32-kHz crystal oscillator used $(\phi_{SUB} = \phi_W/2)$ | _ | 50 | 100 | μА | * ¹ * ² * ⁵ |
| Watch mode current dissipation | I _{watch} | V _{cc} | V _∞ = 5.0 V, LCD on, 32-kHz crystal oscillator used | _ | 40 | 80 | μА | * ¹ * ² * ⁵ |
| | | | V_{cc} = 3.3 V, LCD not used, 32-kHz crystal oscillator used | _ | 7.0 | 15.0 | μА | * ¹ * ² |
| Standby mode current dissipation | I _{STBY} | V _{cc} | 32-kHz crystal oscillator not used | _ | _ | 5.0 | μА | * ¹ * ² |

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| | | | | | Value | es | | |
|--|--------------------|-----------------|--|-----|-------|-----|------|-------------------------------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Program/ erase current dissipation | I _{FLASH} | V _{cc} | $0^{\circ}\text{C} \le \text{T}_{\text{a}} \le 70^{\circ}\text{C}$ $\text{f}_{\text{OSC}} = 12 \text{ MHz}$ | _ | 16 | 22 | mA | *1 *2 *3 |
| RAM data retaining voltage | V _{RAM} | V _{cc} | | 2.0 | _ | _ | V | * ¹ * ² |

Notes: 1. Pin states during current measurement

| Mode Internal State Pins | | Pins | Oscillator Pins |
|---------------------------------------|--|-----------------|---|
| Active mode (high and medium speed) | Operates | V _{cc} | System clock oscillator: Crystal Subclock oscillator: Pin $X_1 = V_{cc}$ |
| Sleep mode | Only timer operates | V _{cc} | |
| Subactive mode | Operates | V _{cc} | System clock oscillator: Crystal Subclock oscillator: Crystal |
| Subsleep mode | Only timer operates, CPU stops | V _{cc} | |
| Watch mode | Only time-base clock operates, CPU stops | V _{cc} | |
| Standby mode | CPU and timers all stop | V _{cc} | System clock oscillator: Crystal Subclock oscillator: Pin X, = V _{cc} |
| Programming/ erasing* ³ | Operates | V _{cc} | System clock oscillator: Crystal Subclock oscillator: Pin X, = V _{cc} |

- 2. Excludes current in pull-up MOS transistors and output buffers.
- 3. Applies to F-ZTAT version only.
- 4. The guaranteed temperature as an electrical characteristic for die type products is 75°C.
- 5. When power is supplied to the built-in bleeder resistances from V_{cc} (LPS0 = LPS1 = 1 in LR2).

Table 16.3 DC Characteristics of H8/3852, H8/3853, and H8/3854 (2)

 V_{cc} = 2.7 V to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, V_{cc} = 3.0 V to 5.5 V of H8/3854F, V_{ss} = 0.0 V, T_a = -20°C to +75°C*², including subactive mode, unless otherwise specified.

| | | | | | Valu | es | | |
|-----------------------|---------------------------------------|------------------------------|--|-----|------|------|------|-------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Allowable output low | I _{OL} | Output pins except in port 2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 2.0 | mA | *1 |
| current (per pin) | | Port 2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 10.0 | | |
| (per piri) | | All output pins | | _ | _ | 0.5 | | |
| Allowable output low | ΣI_{OL} | Output pins except in port 2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 20.0 | mA | *1 |
| current (total) |) | Port 2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 80.0 | | |
| | | All output pins | | _ | _ | 20.0 | | |
| Allowable output high | -I _{OH} | All output pins | V _{cc} = 4.0 V to 5.5 V | _ | _ | 2.0 | mA | *1 |
| current (per pin) | | | | _ | _ | 0.2 | _ | |
| Allowable output high | Σ – \mathbf{I}_{OH} | All output pins | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | | 10.0 | mA | *1 |
| current (total) |) | | | _ | _ | 8.0 | | |

Notes: 1. Excludes LCD output pins.

2. The guaranteed temperature as an electrical characteristic for die type products is 75°C .

16.2.3 AC Characteristics

Table 16.4 shows the control signal timing, and table 16.5 shows the serial interface timing, of the H8/3852, H8/3853, and H8/3854.

Table 16.4 Control Signal Timing of H8/3852, H8/3853, and H8/3854

 V_{cc} = 2.7 V to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, V_{cc} = 3.0 V to 5.5 V of H8/3854F, V_{ss} = 0.0 V, T_a = -20°C to +75°C*³, including subactive mode, unless otherwise specified.

| | | Applicable | | | Values | 3 | | Reference |
|---|---------------------|-------------------------------------|--|-------|--------|--------|------------------|-------------|
| Item | Symbol | • • | Test Conditions | Min | Тур | Max | Unit | Figure |
| System clock | f _{osc} | OSC1, OSC2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 2.0 | _ | 10.0 | MHz | |
| oscillation frequency | | | | 2.0 | _ | 5.0 | _ | |
| OSC clock (ϕ_{osc}) | t _{osc} | OSC1, OSC2 | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 100.0 | _ | 1000.0 | ns | *1 |
| cycle time | | | | 200.0 | _ | 1000.0 | | Figure 16.1 |
| System clock (φ) | t _{cyc} | | | 2 | _ | 16 | t _{osc} | *1 |
| cycle time | | | | _ | _ | 2000.0 | | _ |
| Subclock oscillation frequency | f _w | X1, X2 | | _ | 32.768 | _ | kHz | |
| Watch clock (φ _w) cycle time | t _w | X1, X2 | | _ | 30.5 | _ | μS | |
| Subclock ($\phi_{\text{\tiny SUB}}$) cycle time | t _{subcyc} | | | 2 | _ | 8 | t _w | *2 |
| Instruction cycle time |) | | | 2 | _ | _ | t _{cyc} | |
| Oscillation | t _{rc} | OSC ₁ , OSC ₂ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 40.0 | _ | _ | ms | |
| stabilization time (crystal oscillator) | | | | 60.0 | _ | _ | | |
| Oscillation stabilization time | t _{rc} | X ₁ , X ₂ | | 2 | _ | _ | S | |
| External clock high | t _{CPH} | OSC ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 40.0 | _ | _ | ns | Figure 16.1 |
| width | | | | 80.0 | _ | _ | _ | |
| External clock low | t _{CPL} | OSC, | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 40.0 | _ | _ | ns | Figure 16.1 |
| width | | | | 80.0 | _ | _ | _ | |
| External clock rise | t _{CPr} | OSC ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | _ | _ | 15.0 | ns | Figure 16.1 |
| time | | | | _ | _ | 20.0 | _ | |
| External clock fall | t _{CPf} | OSC ₁ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | | | 15.0 | ns | Figure 16.1 |
| time | | | | _ | _ | 20.0 | | |

16. Electrical Characteristics (H8/3854 Group)

| | | Applicable | Applicable | | Value | es | | Reference | |
|------------------------------|------------------|--|------------------------|--------|-------|-------|---|-------------|--|
| Item | Symbol | Pins | Test Conditions | Min | Тур | Max | Unit | Figure | |
| External subclock high width | t _{xH} | X ₁ | | 0.4/fx | _ | _ | S | Figure 16.2 | |
| External subclock low width | t _{xL} | X ₁ | | 0.4/fx | _ | _ | S | Figure 16.2 | |
| External subclock rise time | t _{xr} | X ₁ | | _ | _ | 100.0 | ns | Figure 16.2 | |
| External subclock fall time | t _{xf} | X, | | _ | _ | 100.0 | ns | Figure 16.2 | |
| RES pin low width | t _{REL} | RES | | 10 | _ | _ | t _{cyc} | Figure 16.3 | |
| Input pin high width | t _{iH} | IRQ ₀ , IRQ ₁ , IRQ ₃ , IRQ ₄ , WKP ₀ to WKP ₇ , ADTRG, TMIB, TMIF | | 2 | _ | _ | t _{cyc} t _{subcyc} | Figure 16.4 | |
| Input pin low width | t _{ıL} | IRQ ₀ , IRQ ₁ , IRQ ₃ , IRQ ₄ , WKP ₀ to WKP ₇ , ADTRG, TMIB, TMIF | | 2 | _ | _ | t _{cyc} t _{subcyc} | Figure 16.4 | |

Notes: 1. A frequency between 1 MHz and 10 MHz is required when an external clock is input.

- 2. Selected with bits SA1 and SA0 in system control register 2 (SYSCR2).
- 3. The guaranteed temperature as an electrical characteristic for die type products is 75°C.

Table 16.5 Serial Interface (SCI3) Timing of H8/3852, H8/3853, and H8/3854

 $V_{cc} = 2.7 \text{ V}$ to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, $V_{cc} = 3.0 \text{ V}$ to 5.5 V of H8/3854F, $V_{ss} = 0.0 \text{ V}$, $T_a = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C}^*$, unless otherwise specified.

| | | | | | Value | es | | Reference |
|---------------|---------------|-------------------|--|-------|-------|-----|-------------------|-------------|
| Item | | Symbol | Test Conditions | Min | Тур | Max | Unit | Figure |
| | Asynchronous | t _{scyc} | | 4 | _ | _ | t _{cyc} | Figure 16.5 |
| cycle | Synchronous | _ | | 6 | _ | _ | | |
| Input clock p | oulse width | t _{sckw} | | 0.4 | _ | 0.6 | t _{scyc} | Figure 16.5 |
| | ta delay time | t _{TXD} | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | | _ | 1 | t _{cyc} | Figure 16.6 |
| (synchronou | ıs mode) | | | _ | _ | 1 | | |
| | a setup time | t _{RXS} | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 200.0 | _ | _ | ns | Figure 16.6 |
| (synchronou | ıs mode) | | | 400.0 | — | — | | |
| Receive dat | | t _{RXH} | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | 200.0 | _ | _ | ns | Figure 16.6 |
| (synchronou | ıs mode) | | | 400.0 | _ | _ | | |

Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C.

16.2.4 A/D Converter Characteristics

Table 16.6 shows the A/D converter characteristics of the H8/3852, H8/3853, and H8/3854.

Table 16.6 A/D Converter Characteristics of H8/3852, H8/3853, and H8/3854

 V_{cc} = 2.7 V to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, V_{cc} = 3.0 V to 5.5 V of H8/3854F, V_{ss} = 0.0 V, T_a = -20°C to +75°C*, unless otherwise specified.

| | | Applicable | Test | Values | | | Reference |
|-----------------------------------|------------------|------------------------------------|------------|----------------------|-----|----------------------|-------------|
| Item | Symbol | Pins | Conditions | Min | Тур | Max | Unit Figure |
| Analog input voltage | AV_{IN} | AN ₄ to AN ₇ | | V _{ss} -0.3 | _ | V _{cc} +0.3 | V |
| Analog input capacitance | C _{AIN} | AN ₄ to AN ₇ | | _ | _ | 30.0 | pF |
| Allowable signal source impedance | R _{AIN} | | | _ | _ | 5.0 | kΩ |
| Resolution (data length) | | | | _ | _ | 8 | Bit |
| Non-linearity error | | | | _ | _ | ±2.0 | LSB |
| Quantization error | | | | _ | _ | ±0.5 | LSB |
| Absolute accuracy | | | | _ | _ | ±2.5 | LSB |
| Conversion time | | | | 12.4 | _ | 124 | μS |

Note: * The guaranteed temperature as an electrical characteristic for die type products is 75°C.

Values

16.2.5 LCD Characteristics

Table 16.7 shows the LCD characteristics of the H8/3852, H8/3853, and H8/3854.

Table 16.7 LCD Characteristics of H8/3852, H8/3853, and H8/3854

 V_{cc} = 2.7 V to 5.5 V of the mask ROM version of H8/3852, H8/3853, and H8/3854, V_{cc} = 3.0 V to 5.5 V of H8/3854F, V_{ss} = 0.0 V, T_a = -20°C to +75°C*², including subactive mode, unless otherwise specified.

| | | | | | value | es | | |
|---|------------------|-----------------|---|-----|-------|-----|------|-------|
| Item | Symbol | Applicable Pins | Test Conditions | Min | Тур | Max | Unit | Notes |
| Common driver on-resistance | R _{com} | COM1 to COM16 | $\pm Id = 0.05 \text{ mA},$ $V_{cc} = 4 \text{ V}$ | _ | 6 | 20 | kΩ | *1 |
| Segment driver on-resistance | R _{SEG} | SEG1 to SEG40 | $\pm Id = 0.05 \text{ mA},$ $V_{cc} = 4 \text{ V}$ | _ | 6 | 20 | kΩ | *1 |
| LCD power supply bleeder resistance | R _{LCD} | | $V_{cc} = 5.0 \text{ V},$ $f_{x} = 32.768 \text{ kHz}$ | 200 | 400 | 700 | kΩ | |

- Notes: 1. Applies to the resistance (R_{COM}) between the V1OUT, V2OUT, V5OUT, and V_{SS} pins and the common signal pins (COM1 to COM16), and the resistance (R_{SEG}) between the V1OUT, V3OUT, V4OUT, and V_{SS} pins and the segment signal pins (SEG1 to SEG40), when Id is flowing in the pins.
 - The voltage applied to V1OUT through V5OUT must not exceed V_{cc}.
 - 2. The guaranteed temperature as an electrical characteristic for die type products is 75°C.

16.2.6 Flash Memory Characteristics

Table 16.8 shows the flash memory characteristics.

Table 16.8 Flash Memory Characteristics

Conditions: $V_{cc} = 4.5 \text{ V}$ to 5.5 V, $V_{ss} = 0.0 \text{ V}$, $T_a = 0^{\circ}\text{C}$ to +75°C (program/erase operating temperature range)

| Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|------------------------|------------------------------------|------------------|-----|-----|------|-------------|--------------------|
| Programming time*1*2*4 | | t _P | _ | 10 | 200 | ms/32 bytes | |
| Erase time*1*3*5 | | t _E | _ | 100 | 300 | ms/block | |
| Rewrite times | | N _{wec} | _ | _ | 100 | Times | |
| Programming | Wait time after SWE bit setting*1 | х | 10 | _ | _ | μS | |
| | Wait time after PSU bit setting*1 | у | 50 | _ | _ | μS | |
| | Wait time after P bit setting*1*4 | z | _ | _ | 200 | μS | |
| | Wait time after P bit clearing*1 | α | 10 | _ | _ | μS | |
| | Wait time after PSU bit clearing*1 | β | 10 | _ | _ | μS | |
| | Wait time after PV bit setting*1 | γ | 4 | _ | — | μS | |
| | Wait time after H'FF dummy write*1 | 3 | 2 | _ | — | μS | |
| | Wait time after PV bit clearing*1 | η | 4 | _ | _ | μS | |
| | Maximum number of writes*1*4 | N | _ | _ | 1000 | Times | |
| Erasing | Wait time after SWE bit setting*1 | x | 10 | _ | _ | μS | |
| | Wait time after ESU bit setting*1 | у | 200 | _ | _ | μS | |
| | Wait time after E bit setting*1*5 | z | _ | _ | 5 | ms | |
| | Wait time after E bit clearing*1 | α | 10 | _ | _ | μS | |
| | Wait time after ESU bit clearing*1 | β | 10 | _ | _ | μS | |
| | Wait time after EV bit setting*1 | γ | 20 | _ | _ | μS | |
| | Wait time after H'FF dummy write*1 | 3 | 2 | _ | _ | μS | |
| | Wait time after EV bit clearing*1 | η | 5 | _ | _ | μS | |
| | Maximum number of erases*1*5 | N | _ | _ | 60 | Times | |

Notes: 1. Follow the program/erase algorithms when making the time settings.

- 2. Programming time per 32 bytes. (Indicates the total time during which the P bit is set in flash memory control register 1 (FLMCR1). Does not include the program-verify time.)
- 3. Time to erase one block. (Indicates the time during which the E bit is set in FLMCR1. Does not include the erase-verify time.)
- 4. Maximum programming time $(t_p(max) = Wait time after P bit setting (z) \times maximum number of writes (N))$
- Maximum erase time (t_E(max) = Wait time after E bit setting (z) × maximum number of erases (N))



16.3 Operation Timing

Figures 16.1 to 16.6 show timing diagrams.

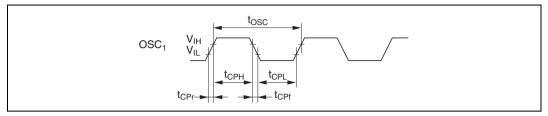


Figure 16.1 System Clock Input Timing

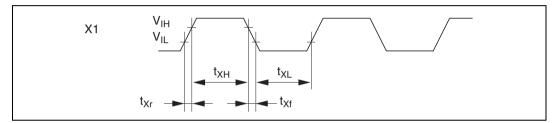


Figure 16.2 Subclock Input Timing

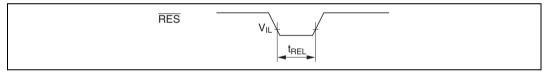


Figure 16.3 RES Pin Low Width Timing

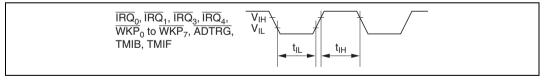


Figure 16.4 Input Timing

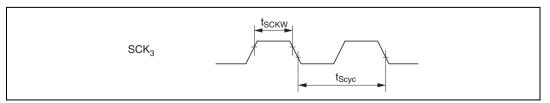


Figure 16.5 SCK3 Input Clock Timing

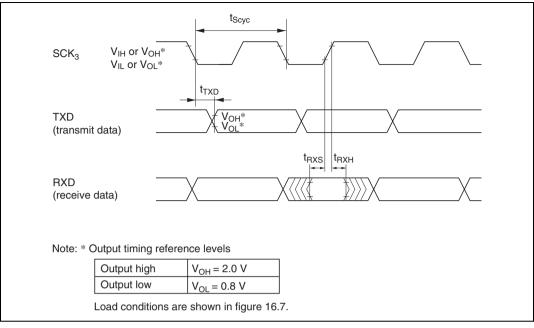


Figure 16.6 SCK3 Input/Output Timing in Synchronous Mode

16.4 Output Load Circuit

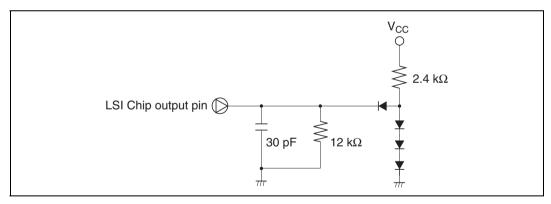


Figure 16.7 Output Load Conditions

16.5 Usage Note

Although both the F-ZTAT and mask ROM versions fully meet the electrical specifications listed in this manual, there may be differences in the actual values of the electrical characteristics, operating margins, noise margins, and so forth, due to differences in the fabrication process, the on-chip ROM, and the layout patterns.

If the F-ZTAT version is used to carry out system evaluation and testing, therefore, when switching to the mask ROM version the same evaluation and testing procedures should also be conducted on the mask ROM version.

Appendix A CPU Instruction Set

A.1 Instructions

Operation Notation

| Description | |
|---|--|
| General register (destination) (8 or 16 bits) | |
| General register (source) (8 or 16 bits) | |
| General register (8 or 16 bits) | |
| Condition code register | |
| N (negative) flag in CCR | |
| Z (zero) flag in CCR | |
| V (overflow) flag in CCR | |
| C (carry) flag in CCR | |
| Program counter | |
| Stack pointer | |
| Immediate data (3, 8, or 16 bits) | |
| Displacement (8 or 16 bits) | |
| Absolute address (8 or 16 bits) | |
| Addition | |
| Subtraction | |
| Multiplication | |
| Division | |
| Logical AND | |
| Logical OR | |
| Exclusive logical OR | |
| Move | |
| Logical complement | |
| | |

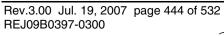
Condition Code Notation

| Symbol | Description |
|----------|--|
| ‡ | Modified according to the instruction result |
| * | Not fixed (value not guaranteed) |
| 0 | Always cleared to 0 |
| _ | Not affected by the instruction execution result |

Table A.1 Instruction Set

| | | | Addressing Mode/ Instruction Length (Byte | | | | | s) | С | one | ditic | on (| Coc | le | | | | |
|-----------------------|--------------|---|--|----|-----|-------------|-----------|-----------|------------|-------|---------|------|-----|----------|----------|---|---|---------------|
| Mnemonic | Operand Size | Operation | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | I | н | N | z | v | С | No. of States |
| MOV.B #xx:8, Rd | В | #xx:8 → Rd8 | 2 | | | | | | | | | _ | _ | ‡ | ‡ | 0 | | 2 |
| MOV.B Rs, Rd | В | Rs8 → Rd8 | | 2 | | | | | | | | | _ | ‡ | ‡ | 0 | | 2 |
| MOV.B @Rs, Rd | В | @Rs16 → Rd8 | | | 2 | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.B @(d:16, Rs), Rd | В | @(d:16, Rs16)→ Rd8 | | | | 4 | | | | | | | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.B @Rs+, Rd | В | @Rs16 → Rd8 Rs16+1 → Rs16 | | | | | 2 | | | | | | | \$ | \$ | 0 | | 6 |
| MOV.B @aa:8, Rd | В | @aa:8 → Rd8 | | | | | | 2 | | | | _ | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.B @aa:16, Rd | В | @aa:16 → Rd8 | | | | | | 4 | | | | _ | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.B Rs, @Rd | В | Rs8 → @ Rd16 | | | 2 | | | | | | | | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.B Rs, @(d:16, Rd) | В | Rs8 → @ (d:16, Rd16) | | | | 4 | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.B Rs, @-Rd | В | Rd16–1 → Rd16 Rs8 → @Rd16 | | | | | 2 | | | | | | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.B Rs, @aa:8 | В | Rs8 → @aa:8 | | | | | | 2 | | | | _ | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.B Rs, @aa:16 | В | Rs8 → @aa:16 | | | | | | 4 | | | | _ | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.W #xx:16, Rd | W | #xx:16 → Rd | 4 | | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.W Rs, Rd | W | Rs16 → Rd16 | | 2 | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| MOV.W @Rs, Rd | W | @Rs16 → Rd16 | | | 2 | | | | | | | | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.W @(d:16, Rs), Rd | W | @(d:16, Rs16) → Rd16 | | | | 4 | | | | | | | _ | ‡ | ‡ | 0 | | 6 |
| MOV.W @Rs+, Rd | W | @Rs16 → Rd16 Rs16+2 → Rs16 | | | | | 2 | | | | | | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.W @aa:16, Rd | W | @aa:16 → Rd16 | | | | | | 4 | | | | _ | _ | ‡ | ‡ | 0 | _ | 6 |
| MOV.W Rs, @Rd | W | Rs16 → @Rd16 | | | 2 | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 4 |
| MOV.W Rs, @(d:16, Rd) | W | Rs16 → @(d:16, Rd16) | | | | 4 | | | | | | | _ | ‡ | ‡ | 0 | | 6 |
| MOV.W Rs, @-Rd | W | Rd16–2 \rightarrow Rd16 Rs16 \rightarrow @Rd16 | | | | | 2 | | | | | | | ‡ | ‡ | 0 | | 6 |
| MOV.W Rs, @aa:16 | W | Rs16 → @aa:16 | | | | | | 4 | | | | _ | _ | ‡ | ‡ | 0 | | 6 |
| POP Rd | W | $@SP \rightarrow Rd16$ SP+2 → SP | | | | | 2 | | | | | _ | _ | ‡ | ‡ | 0 | | 6 |

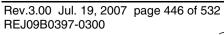
| | | | Addressing Mode/ Instruction Length (Bytes) Condition Code | | | | | | | | | le | | | | | | |
|------------------|--------------|---|--|----|-----|-------------|-----------|-----------|------------|-------|---------|----|-----------|-----------|-----------|----------|----------|---------------|
| Mnemonic | Operand Size | Operation | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | ı | н | N | z | v | С | No. of States |
| PUSH Rs | W | $SP-2 \rightarrow SP$ Rs16 \rightarrow @SP | | | | | 2 | | | | | | | ‡ | ‡ | 0 | | 6 |
| ADD.B #xx:8, Rd | В | Rd8+#xx:8 \rightarrow Rd8 | 2 | | | | | | | | | _ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| ADD.B Rs, Rd | В | Rd8+Rs8 → Rd8 | | 2 | | | | | | | | _ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| ADD.W Rs, Rd | W | Rd16+Rs16 → Rd16 | | 2 | | | | | | | | _ | (1) | ‡ | ‡ | ‡ | ‡ | 2 |
| ADDX.B #xx:8, Rd | В | Rd8+#xx:8 +C \rightarrow Rd8 | 2 | | | | | | | | | _ | ‡ | ‡ | (2) | ‡ | ‡ | 2 |
| ADDX.B Rs, Rd | В | $Rd8+Rs8+C \rightarrow Rd8$ | | 2 | | | | | | | | _ | ‡ | \$ | (2) | ‡ | ‡ | 2 |
| ADDS.W #1, Rd | W | Rd16+1 → Rd16 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| ADDS.W #2, Rd | W | Rd16+2 → Rd16 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| INC.B Rd | В | Rd8+1 → Rd8 | | 2 | | | | | | | | _ | _ | ‡ | ‡ | ‡ | _ | 2 |
| DAA.B Rd | В | Rd8 decimal adjust → Rd8 | | 2 | | | | | | | | _ | * | ‡ | ‡ | * | (3) | 2 |
| SUB.B Rs, Rd | В | Rd8–Rs8 → Rd8 | | 2 | | | | | | | | _ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| SUB.W Rs, Rd | W | Rd16-Rs16 → Rd16 | | 2 | | | | | | | | _ | (1) | \$ | ‡ | ‡ | ‡ | 2 |
| SUBX.B #xx:8, Rd | В | Rd8-#xx:8 -C \rightarrow Rd8 | 2 | | | | | | | | | _ | ‡ | ‡ | (2) | ‡ | ‡ | 2 |
| SUBX.B Rs, Rd | В | Rd8-Rs8 -C \rightarrow Rd8 | | 2 | | | | | | | | _ | ‡ | ‡ | (2) | ‡ | ‡ | 2 |
| SUBS.W #1, Rd | W | Rd16−1 → Rd16 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| SUBS.W #2, Rd | W | Rd16–2 → Rd16 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| DEC.B Rd | В | Rd8−1 → Rd8 | | 2 | | | | | | | | _ | | ‡ | ‡ | ‡ | _ | 2 |
| DAS.B Rd | В | Rd8 decimal adjust → Rd8 | | 2 | | | | | | | | _ | * | ‡ | ‡ | * | _ | 2 |
| NEG.B Rd | В | 0 −Rd \rightarrow Rd | | 2 | | | | | | | | _ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| CMP.B #xx:8, Rd | В | Rd8-#xx:8 | 2 | | | | | | | | | | \$ | ‡ | \$ | ‡ | ‡ | 2 |
| CMP.B Rs, Rd | В | Rd8-Rs8 | | 2 | | | | | | | | _ | \$ | \$ | ‡ | ‡ | ‡ | 2 |
| CMP.W Rs, Rd | W | Rd16-Rs16 | | 2 | | | | | | | | _ | (1) | ‡ | \$ | ‡ | ‡ | 2 |
| MULXU.B Rs, Rd | В | Rd8 × Rs8 → Rd16 | | 2 | | | | | | | | | _ | | | | | 14 |





| | | | In | | | | | _ | lode h (B | | s) | С | one | ditic | on (| Coc | le | |
|-----------------|--------------|--|-----------|----|-----|-------------|-----------|-----------|--------------|-------|---------|---|-----|----------|----------|----------|----------|---------------|
| Mnemonic | Operand Size | Operation | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | ı | Н | N | z | v | С | No. of States |
| DIVXU.B Rs, Rd | В | $Rd16 \div Rs8 \rightarrow Rd16$ (RdH: remainder, RdL: quotient) | | 2 | | | | | | | | | _ | (5) | (6) | | | 14 |
| AND.B #xx:8, Rd | В | $Rd8 {\scriptstyle \wedge} \#xx: 8 \to Rd8$ | 2 | | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| AND.B Rs, Rd | В | Rd8∧Rs8 → Rd8 | | 2 | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| OR.B #xx:8, Rd | В | Rd8∨#xx:8 → Rd8 | 2 | | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| OR.B Rs, Rd | В | Rd8∨Rs8 → Rd8 | | 2 | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| XOR.B #xx:8, Rd | В | Rd8⊕#xx:8 → Rd8 | 2 | | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| XOR.B Rs, Rd | В | Rd8⊕Rs8 → Rd8 | | 2 | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| NOT.B Rd | В | $\overline{Rd} \to Rd$ | | 2 | | | | | | | | _ | _ | ‡ | ‡ | 0 | _ | 2 |
| SHAL.B Rd | В | C - 0 - 0 | | 2 | | | | | | | | | | ‡ | ‡ | ‡ | ‡ | 2 |
| SHAR.B Rd | В | b ₇ b ₀ | | 2 | | | | | | | | | | \$ | \$ | 0 | ‡ | 2 |
| SHLL.B Rd | В | b ₇ b ₀ | | 2 | | | | | | | | | | \$ | \$ | 0 | ‡ | 2 |
| SHLR.B Rd | В | 0 | | 2 | | | | | | | | | | 0 | ‡ | 0 | \$ | 2 |
| ROTXL.B Rd | В | b ₇ b ₀ | | 2 | | | | | | | | | | \$ | ‡ | 0 | ‡ | 2 |
| ROTXR.B Rd | В | b ₇ b ₀ C | | 2 | | | | | | | | | | ‡ | ‡ | 0 | ‡ | 2 |
| ROTL.B Rd | В | D ₇ b ₀ | | 2 | | | | | | | | | | \$ | \$ | 0 | \$ | 2 |
| ROTR.B Rd | В | b ₇ b ₀ | | 2 | | | | | | | | | | \$ | \$ | 0 | \$ | 2 |

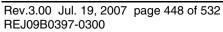
| | | | In | | | | sing Ler | | | | s) | С | one | ditic | on (| Cod | le | |
|-------------------|--------------|---|-----------|----|-----|-------------|-------------|-----------|------------|-------|---------|---|-----|-------|----------|-----|----|---------------|
| Mnemonic | Operand Size | Operation | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | ı | н | N | z | v | С | No. of States |
| BSET #xx:3, Rd | В | (#xx:3 of Rd8) ← 1 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| BSET #xx:3, @Rd | В | (#xx:3 of @Rd16) ← 1 | | | 4 | | | | | | | _ | _ | _ | _ | _ | _ | 8 |
| BSET #xx:3, @aa:8 | В | (#xx:3 of @aa:8) ← 1 | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 8 |
| BSET Rn, Rd | В | (Rn8 of Rd8) ← 1 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| BSET Rn, @Rd | В | (Rn8 of @Rd16) ← 1 | | | 4 | | | | | | | _ | _ | _ | _ | _ | _ | 8 |
| BSET Rn, @aa:8 | В | (Rn8 of @aa:8) ← 1 | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 8 |
| BCLR #xx:3, Rd | В | (#xx:3 of Rd8) ← 0 | | 2 | | | | | | | | | _ | _ | _ | _ | | 2 |
| BCLR #xx:3, @Rd | В | (#xx:3 of @Rd16) ← 0 | | | 4 | | | | | | | _ | _ | _ | _ | _ | _ | 8 |
| BCLR #xx:3, @aa:8 | В | (#xx:3 of @aa:8) ← 0 | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 8 |
| BCLR Rn, Rd | В | (Rn8 of Rd8) ← 0 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| BCLR Rn, @Rd | В | (Rn8 of @Rd16) ← 0 | | | 4 | | | | | | | _ | _ | _ | _ | _ | _ | 8 |
| BCLR Rn, @aa:8 | В | (Rn8 of @aa:8) ← 0 | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 8 |
| BNOT #xx:3, Rd | В | (#xx:3 of Rd8) ← (#xx:3 of Rd8) | | 2 | | | | | | | | _ | | | | | | 2 |
| BNOT #xx:3, @Rd | В | (#xx:3 of @Rd16) ← (#xx:3 of @Rd16) | | | 4 | | | | | | | _ | _ | _ | _ | _ | | 8 |
| BNOT #xx:3, @aa:8 | В | (#xx:3 of @aa:8) ← (#xx:3 of @aa:8) | | | | | | 4 | | | | _ | _ | _ | _ | _ | | 8 |
| BNOT Rn, Rd | В | $ \frac{(\text{Rn8 of Rd8}) \leftarrow}{(\overline{\text{Rn8 of Rd8}})} $ | | 2 | | | | | | | | | | | | | _ | 2 |
| BNOT Rn, @Rd | В | (Rn8 of @Rd16) ← (Rn8 of @Rd16) | | | 4 | | | | | | | | | | | | _ | 8 |
| BNOT Rn, @aa:8 | В | (Rn8 of @aa:8) ← (Rn8 of @aa:8) | | | | | | 4 | | | | | _ | _ | _ | _ | _ | 8 |
| BTST #xx:3, Rd | В | $(\overline{\#xx:3}\ \overline{of}\ \overline{Rd8}) \to Z$ | | 2 | | | | | | | | _ | _ | _ | ‡ | _ | _ | 2 |
| BTST #xx:3, @Rd | В | $(\overline{\#xx:3} \ \overline{of} \ \overline{@Rd16}) \rightarrow Z$ | | | 4 | | | | | | | _ | _ | _ | ‡ | _ | _ | 6 |
| BTST #xx:3, @aa:8 | В | $(\overline{\#xx:3} \ \overline{of} \ \overline{@aa:8}) \rightarrow Z$ | | | | | | 4 | | | | _ | _ | _ | ‡ | _ | _ | 6 |
| BTST Rn, Rd | В | $(\overline{Rn8} \ \overline{of} \ \overline{Rd8}) \rightarrow Z$ | | 2 | | | | | | | | _ | _ | _ | ‡ | _ | _ | 2 |
| BTST Rn, @Rd | В | $(\overline{Rn8} \ \overline{of} \ \overline{@Rd16}) \rightarrow Z$ | | | 4 | | | | | | | _ | _ | _ | ‡ | _ | _ | 6 |
| BTST Rn, @aa:8 | В | $(\overline{Rn8} \ \overline{of} \ \overline{@aa:8}) \rightarrow Z$ | | | | | | 4 | | | | _ | _ | _ | ‡ | _ | | 6 |





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|--------------------|--------------|--|-----------|----|-----|-------------|-----------|-----------|--------------|-------|---------|---|-----|-------|------|-----|----------|---------------|
| Mnemonic | Operand Size | Operation | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | ı | н | N | z | v | С | No. of States |
| BLD #xx:3, Rd | В | $(\#xx:3 \text{ of Rd8}) \rightarrow C$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |
| BLD #xx:3, @Rd | В | (#xx:3 of @Rd16) → C | | | 4 | | | | | | | _ | | | _ | _ | ‡ | 6 |
| BLD #xx:3, @aa:8 | В | (#xx:3 of @aa:8) → C | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BILD #xx:3, Rd | В | $\overline{\text{(\#xx:3 of Rd8)}} \rightarrow C$ | | 2 | | | | | | | | | | | | | ‡ | 2 |
| BILD #xx:3, @Rd | В | $(\#xx:3 \ \overline{of} \ @Rd16) \rightarrow C$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BILD #xx:3, @aa:8 | В | $(\#xx:3 \ of \ @aa:8) \rightarrow C$ | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BST #xx:3, Rd | В | $C \rightarrow (\#xx:3 \text{ of Rd8})$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| BST #xx:3, @Rd | В | $C \rightarrow (\#xx:3 \text{ of } @ \text{Rd}16)$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | _ | 8 |
| BST #xx:3, @aa:8 | В | C → (#xx:3 of @aa:8) | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 8 |
| BIST #xx:3, Rd | В | $\overline{C} \rightarrow (\#xx:3 \text{ of Rd8})$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| BIST #xx:3, @Rd | В | $\overline{C} \rightarrow (\#xx:3 \text{ of } @ \text{Rd}16)$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | _ | 8 |
| BIST #xx:3, @aa:8 | В | $\overline{C} \rightarrow (\#xx:3 \text{ of } @aa:8)$ | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 8 |
| BAND #xx:3, Rd | В | $C \land (\#xx:3 \text{ of Rd8}) \rightarrow C$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |
| BAND #xx:3, @Rd | В | $C \land (\#xx:3 \text{ of } @ \text{Rd}16) \rightarrow C$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BAND #xx:3, @aa:8 | В | $C \land (\#xx:3 \text{ of } @aa:8) \rightarrow C$ | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BIAND #xx:3, Rd | В | $C \land (\overline{\#xx:3} \ \overline{of} \ \overline{Rd8}) \to C$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |
| BIAND #xx:3, @Rd | В | $C \land (\overline{\#xx:3} \ \overline{of} \ \overline{@Rd16}) \to C$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BIAND #xx:3, @aa:8 | В | $C \land (\overline{\#xx:3} \ \overline{of} \ \overline{@aa:8}) \to C$ | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BOR #xx:3, Rd | В | $C\lor(\#xx:3 \text{ of Rd8}) \to C$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |
| BOR #xx:3, @Rd | В | $C\lor(\#xx:3 \text{ of } @ \text{Rd}16) \to C$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BOR #xx:3, @aa:8 | В | $C\lor(\#xx:3 \text{ of } @aa:8) \rightarrow C$ | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BIOR #xx:3, Rd | В | $C\lor(\overline{\#xx:3}\ \overline{of}\ \overline{Rd8})\to C$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |
| BIOR #xx:3, @Rd | В | $C\lor(\overline{\#xx:3}\ \overline{of}\ \overline{@Rd16})\to C$ | | | 4 | | | | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BIOR #xx:3, @aa:8 | В | $C \lor (\overline{\#xx:3} \ \overline{of} \ \overline{@aa:8}) \to C$ | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BXOR #xx:3, Rd | В | C⊕(#xx:3 of Rd8) → C | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |
| BXOR #xx:3, @Rd | В | C⊕(#xx:3 of @Rd16) → C | | | 4 | | | | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BXOR #xx:3, @aa:8 | В | C⊕(#xx:3 of @aa:8) → C | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BIXOR #xx:3, Rd | В | $C \oplus (\overline{\#xx:3} \ \overline{of} \ \overline{Rd8}) \to C$ | | 2 | | | | | | | | _ | _ | _ | _ | _ | ‡ | 2 |

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|--------------------|--------------|--|----------------------------|-----------|----|-----|-------------|-----------|-----------|-------------|-------|---------|---|-----|-------|------|-----|----------|---------------|
| Mnemonic | Operand Size | Operation | Branching Condition | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | ı | н | N | z | v | С | No. of States |
| BIXOR #xx:3, @Rd | В | C⊕(#xx:3 o | f @Rd16) → C | | | 4 | | | | | | | _ | _ | | | | ‡ | 6 |
| BIXOR #xx:3, @aa:8 | В | C⊕(#xx:3 o | f @aa:8) → C | | | | | | 4 | | | | _ | _ | _ | _ | _ | ‡ | 6 |
| BRA d:8 (BT d:8) | _ | PC ← PC+ | d:8 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BRN d:8 (BF d:8) | | PC ← PC+2 | 2 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BHI d:8 | _ | If | $C \lor Z = 0$ | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BLS d:8 | _ | condition | C ∨ Z = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BCC d:8 (BHS d:8) | _ | is true | C = 0 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BCS d:8 (BLO d:8) | _ | then | C = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BNE d:8 | _ | PC ← | Z = 0 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BEQ d:8 | _ | PC+d:8 | Z = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BVC d:8 | _ | else next; | V = 0 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BVS d:8 | _ | | V = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BPL d:8 | _ | | N = 0 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BMI d:8 | _ | | N = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BGE d:8 | _ | | N⊕V = 0 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BLT d:8 | _ | | N⊕V = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BGT d:8 | _ | | $Z \vee (N \oplus V) = 0$ | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| BLE d:8 | _ | | Z ∨ (N⊕V) = 1 | | | | | | | 2 | | | _ | _ | _ | _ | _ | _ | 4 |
| JMP @Rn | _ | PC ← Rn16 | 3 | | | 2 | | | | | | | _ | _ | _ | _ | _ | _ | 4 |
| JMP @aa:16 | _ | PC ← aa:16 | 6 | | | | | | 4 | | | | _ | _ | _ | _ | _ | _ | 6 |
| JMP @@aa:8 | _ | PC ← @aa | :8 | | | | | | | | 2 | | _ | _ | _ | _ | _ | _ | 8 |
| BSR d:8 | | $SP-2 \rightarrow SF$ PC \rightarrow @SF PC \leftarrow PC+6 | • | | | | | | | 2 | | | | _ | _ | _ | _ | | 6 |
| JSR @Rn | | $SP-2 \rightarrow SF$ $PC \rightarrow @SF$ $PC \leftarrow Rn16$ |) | | | 2 | | | | | | | | | | | | _ | 6 |
| JSR @aa:16 | | $SP-2 \rightarrow SF$ $PC \rightarrow @SF$ $PC \leftarrow aa:10$ | @SP Rn16 → SP @SP | | | | | | 4 | | | | | | | | | | 8 |





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|-----------------|--------------|---|-----------|----|-----|-------------|------------|-----------|------------|-------|---------|----------|----------|----------|----------|----------|-----------|---------------|
| Mnemonic | Operand Size | Operation | #xx: 8/16 | Rn | @Rn | @(d:16, Rn) | @-Rn/@Rn+ | @aa: 8/16 | @(d:8, PC) | @ @aa | Implied | ı | н | N | z | v | С | No. of States |
| JSR @@aa:8 | | $SP-2 \rightarrow SP$ $PC \rightarrow @SP$ $PC \leftarrow @aa:8$ | | | | | | | | 2 | | | | | | | | 8 |
| RTS | | PC ← @SP SP+2 → SP | | | | | | | | | 2 | | _ | | _ | _ | | 8 |
| RTE | | $\begin{array}{l} CCR \leftarrow @SP \\ SP+2 \rightarrow SP \\ PC \leftarrow @SP \\ SP+2 \rightarrow SP \end{array}$ | | | | | | | | | 2 | ‡ | ‡ | ‡ | ‡ | ‡ | \$ | 10 |
| SLEEP | | Transit to power-down state | | | | | | | | | 2 | | _ | | | _ | | 2 |
| LDC #xx:8, CCR | В | #xx:8 → CCR | 2 | | | | | | | | | ‡ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| LDC Rs, CCR | В | Rs8 → CCR | | 2 | | | | | | | | ‡ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| STC CCR, Rd | В | CCR → Rd8 | | 2 | | | | | | | | _ | _ | _ | _ | _ | _ | 2 |
| ANDC #xx:8, CCR | В | CCR∧#xx:8 → CCR | 2 | | | | | | | | | ‡ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| ORC #xx:8, CCR | В | CCR∨#xx:8 → CCR | 2 | | | | | | | | | ‡ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| XORC #xx:8, CCR | В | CCR⊕#xx:8 → CCR | 2 | | | | | | | | | ‡ | ‡ | ‡ | ‡ | ‡ | ‡ | 2 |
| NOP | | PC ← PC+2 | | | | | | | | | 2 | _ | _ | _ | _ | _ | _ | 2 |
| EEPMOV | | if R4L \neq 0 Repeat @R5 \rightarrow @R6 R5+1 \rightarrow R5 R6+1 \rightarrow R6 R4L-1 \rightarrow R4L Until R4L = 0 else next; | | | | | | | | | 4 | | | | | | | (4) |

Notes: (1) Set to 1 when there is a carry or borrow from bit 11; otherwise cleared to 0.

- (2) If the result is zero, the previous value of the flag is retained; otherwise the flag is cleared to 0.
- (3) Set to 1 if decimal adjustment produces a carry; otherwise retains value prior to arithmetic operation.
- (4) The number of states required for execution is 4n + 9 (n = value of R4L).
- (5) Set to 1 if the divisor is negative; otherwise cleared to 0.
- (6) Set to 1 if the divisor is zero; otherwise cleared to 0.

A.2 Operation Code Map

Table A.2 is an operation code map. It shows the operation codes contained in the first byte of the instruction code (bits 15 to 8 of the first instruction word).

Instruction when first bit of byte 2 (bit 7 of first instruction word) is 0.

Instruction when first bit of byte 2 (bit 7 of first instruction word) is 1.



Table A.2 Operation Code Map

Note: * The PUSH and POP instructions are identical in machine language to MOV instructions.

A.3 Number of Execution States

The tables here can be used to calculate the number of states required for instruction execution. Table A.4 indicates the number of states required for each cycle (instruction fetch, data read/write, etc.) in instruction execution, and table A.3 indicates the number of cycles of each type occurring in each instruction. The total number of states required for execution of an instruction can be calculated from these two tables as follows:

Execution states =
$$I \times S_1 + J \times S_2 + K \times S_k + L \times S_1 + M \times S_M + N \times S_N$$

Examples: When instruction is fetched from on-chip ROM, and an on-chip RAM is accessed.

BSET #0, @FF00

From table A.4:

$$I = L = 2$$
, $J = K = M = N = 0$

From table A.3:

$$S_{1} = 2, S_{1} = 2$$

Number of states required for execution = $2 \times 2 + 2 \times 2 = 8$

When instruction is fetched from on-chip ROM, branch address is read from on-chip ROM, and on-chip RAM is used for stack area.

JSR @@ 30

From table A.4:

$$I = 2$$
, $J = K = 1$, $L = M = N = 0$

From table A.3:

$$S_{1} = S_{1} = S_{K} = 2$$

Number of states required for execution = $2 \times 2 + 1 \times 2 + 1 \times 2 = 8$



Number of Cycles in Each Instruction Table A.3

| Execution Status | | Ad | ccess Location |
|---------------------|----------------|----------------|---------------------------|
| (Instruction Cycle) | | On-Chip Memory | On-Chip Peripheral Module |
| Instruction fetch | Sı | 2 | _ |
| Branch address read | S _J | _ | |
| Stack operation | S _K | _ | |
| Byte data access | S _L | _ | 2 or 3* |
| Word data access | S _M | _ | |
| Internal operation | S _N | 1 | |

Note: Depends on which on-chip module is accessed. See section 2.9.1, Notes on Data Access for details.

Table A.4 Number of Cycles in Each Instruction

| Instruction | Mnemonic | Instruction Fetch I | Branch Addr. Read J | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------|-------------------|---------------------------|---------------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| ADD | ADD.B #xx:8, Rd | 1 | | | | | |
| | ADD.B Rs, Rd | 1 | | | | | |
| | ADD.W Rs, Rd | 1 | | | | | |
| ADDS | ADDS.W #1, Rd | 1 | | | | | |
| | ADDS.W #2, Rd | 1 | | | | | |
| ADDX | ADDX.B #xx:8, Rd | 1 | | | | | |
| | ADDX.B Rs, Rd | 1 | | | | | |
| AND | AND.B #xx:8, Rd | 1 | | | | | |
| | AND.B Rs, Rd | 1 | | | | | |
| ANDC | ANDC #xx:8, CCR | 1 | | | | | |
| BAND | BAND #xx:3, Rd | 1 | | | | | |
| | BAND #xx:3, @Rd | 2 | | | 1 | | |
| | BAND #xx:3, @aa:8 | 2 | | | 1 | | |
| Всс | BRA d:8 (BT d:8) | 2 | | | | | |
| | BRN d:8 (BF d:8) | 2 | | | | | |
| | BHI d:8 | 2 | | | | | |
| | BLS d:8 | 2 | | | | | |
| | BCC d:8 (BHS d:8) | 2 | | | | | |
| | BCS d:8 (BLO d:8) | 2 | | | | | |
| | BNE d:8 | 2 | | | | | |
| | BEQ d:8 | 2 | | | | | |
| | BVC d:8 | 2 | | | | | |
| | BVS d:8 | 2 | | | | | |
| | BPL d:8 | 2 | | | | | |
| | BMI d:8 | 2 | | | | | |
| | BGE d:8 | 2 | | | | | |
| | BLT d:8 | 2 | | | | | |
| | BGT d:8 | 2 | | | | | |
| | BLE d:8 | 2 | | | | | |
| BCLR | BCLR #xx:3, Rd | 1 | | | | | |
| | BCLR #xx:3, @Rd | 2 | | | 2 | | |
| | BCLR #xx:3, @aa:8 | 2 | | | 2 | | |
| - | BCLR Rn, Rd | 1 | | | | | |

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| Instruction | Mnemonic | Instruction Fetch I | Branch Addr. Read J | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------|--------------------|---------------------------|---------------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| BCLR | BCLR Rn, @Rd | 2 | | | 2 | | |
| | BCLR Rn, @aa:8 | 2 | | | 2 | | |
| BIAND | BIAND #xx:3, Rd | 1 | | | | | |
| | BIAND #xx:3, @ Rd | 2 | | | 1 | | |
| | BIAND #xx:3, @aa:8 | 2 | | | 1 | | |
| BILD | BILD #xx:3, Rd | 1 | | | | | |
| | BILD #xx:3, @Rd | 2 | | | 1 | | |
| | BILD #xx:3, @aa:8 | 2 | | | 1 | | |
| BIOR | BIOR #xx:3, Rd | 1 | | | | | |
| | BIOR #xx:3, @Rd | 2 | | | 1 | | |
| | BIOR #xx:3, @aa:8 | 2 | | | 1 | | |
| BIST | BIST #xx:3, Rd | 1 | | | | | |
| | BIST #xx:3, @Rd | 2 | | | 2 | | |
| | BIST #xx:3, @aa:8 | 2 | | | 2 | | |
| BIXOR | BIXOR #xx:3, Rd | 1 | | | | | |
| | BIXOR #xx:3, @Rd | 2 | | | 1 | | |
| | BIXOR #xx:3, @aa:8 | 2 | | | 1 | | |
| BLD | BLD #xx:3, Rd | 1 | | | | | |
| | BLD #xx:3, @Rd | 2 | | | 1 | | |
| | BLD #xx:3, @aa:8 | 2 | | | 1 | | |
| BNOT | BNOT #xx:3, Rd | 1 | | | | | |
| | BNOT #xx:3, @Rd | 2 | | | 2 | | |
| | BNOT #xx:3, @aa:8 | 2 | | | 2 | | |
| | BNOT Rn, Rd | 1 | | | | | |
| | BNOT Rn, @Rd | 2 | | | 2 | | |
| | BNOT Rn, @aa:8 | 2 | | | 2 | | |
| BOR | BOR #xx:3, Rd | 1 | | | | | |
| | BOR #xx:3, @Rd | 2 | | | 1 | | |
| | BOR #xx:3, @aa:8 | 2 | | | 1 | | |
| BSET | BSET #xx:3, Rd | 1 | | | | | |
| | BSET #xx:3, @Rd | 2 | | | 2 | | |
| | BSET #xx:3, @aa:8 | 2 | | | 2 | | |
| | BSET Rn, Rd | 1 | | | | | |
| | BSET Rn, @Rd | 2 | | | 2 | | |

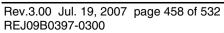
| Instruction | Mnemonic | Instruction Fetch I | Branch Addr. Read J | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------|-----------------------------|---------------------------|---------------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| BSET | BSET Rn, @aa:8 | 2 | | | 2 | | |
| BSR | BSR d:8 | 2 | | 1 | | | |
| BST | BST #xx:3, Rd | 1 | | | | | |
| | BST #xx:3, @Rd | 2 | | | 2 | | |
| | BST #xx:3, @aa:8 | 2 | | | 2 | | |
| BTST | BTST #xx:3, Rd | 1 | | | | | |
| | BTST #xx:3, @Rd | 2 | | | 1 | | |
| | BTST #xx:3, @aa:8 | 2 | | | 1 | | |
| | BTST Rn, Rd | 1 | | | | | |
| | BTST Rn, @Rd | 2 | | | 1 | | |
| | BTST Rn, @aa:8 | 2 | | | 1 | | |
| BXOR | BXOR #xx:3, Rd | 1 | | | | | |
| | BXOR #xx:3, @Rd | 2 | | | 1 | | |
| | BXOR #xx:3, @aa:8 | 2 | | | 1 | | |
| CMP | CMP. B #xx:8, Rd | 1 | | | | | |
| | CMP. B Rs, Rd | 1 | | | | | |
| | CMP.W Rs, Rd | 1 | | | | | |
| DAA | DAA.B Rd | 1 | | | | | |
| DAS | DAS.B Rd | 1 | | | | | |
| DEC | DEC.B Rd | 1 | | | | | |
| DIVXU | DIVXU.B Rs, Rd | 1 | | | | | 12 |
| EEPMOV | EEPMOV | 2 | | | 2n + 2* | | 1 |
| INC | INC.B Rd | 1 | | | | | |
| JMP | JMP @Rn | 2 | | | | | |
| | JMP @aa:16 | 2 | | | | | 2 |
| | JMP @@aa:8 | 2 | 1 | | | | 2 |
| JSR | JSR @Rn | 2 | | 1 | | | |
| | JSR @aa:16 | 2 | | 1 | | | 2 |
| | JSR @@aa:8 | 2 | 1 | 1 | | | |
| LDC | LDC #xx:8, CCR | 1 | | | | | |
| | LDC Rs, CCR | 1 | | | | | |
| MOV | MOV.B #xx:8, Rd | 1 | | | | | |
| | MOV.B Rs, Rd | 1 | | | | | |
| Note: * | n: Initial value in Reeach. | 4L. The sour | ce and desti | nation opera | ands are ac | cessed n + | 1 times |

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| | | Instruction Fetch | Addr. Read | | Byte Data Access | Word Data Access | Operation |
|-------------|--------------------------|----------------------|------------|---|---------------------|---------------------|-----------|
| Instruction | Mnemonic | I | J | K | L | М | N |
| MOV | MOV.B @Rs, Rd | 1 | | | 1 | | |
| | MOV.B @(d:16, Rs), Rd | 2 | | | 1 | | |
| | MOV.B @Rs+, Rd | 1 | | | 1 | | 2 |
| | MOV.B @aa:8, Rd | 1 | | | 1 | | |
| | MOV.B @aa:16, Rd | 2 | | | 1 | | |
| | MOV.B Rs, @Rd | 1 | | | 1 | | |
| | MOV.B Rs, @(d:16, Rd) | 2 | | | 1 | | |
| | MOV.B Rs, @-Rd | 1 | | | 1 | | 2 |
| | MOV.B Rs, @aa:8 | 1 | | | 1 | | |
| | MOV.B Rs, @aa:16 | 2 | | | 1 | | |
| | MOV.W #xx:16, Rd | 2 | | | | | |
| | MOV.W Rs, Rd | 1 | | | | | |
| | MOV.W @Rs, Rd | 1 | | | | 1 | |
| | MOV.W @(d:16, Rs), Rd | 2 | | | | 1 | |
| | MOV.W @Rs+, Rd | 1 | | | | 1 | 2 |
| | MOV.W @aa:16, Rd | 2 | | | | 1 | |
| | MOV.W Rs, @Rd | 1 | | | | 1 | |
| | MOV.W Rs, @(d:16, Rd) | 2 | | | | 1 | |
| | MOV.W Rs, @-Rd | 1 | | | | 1 | 2 |
| | MOV.W Rs, @aa:16 | 2 | | | | 1 | |
| MULXU | MULXU.B Rs, Rd | 1 | | | | | 12 |
| NEG | NEG.B Rd | 1 | | | | | |
| NOP | NOP | 1 | | | | | |
| NOT | NOT.B Rd | 1 | | | | | |
| OR | OR.B #xx:8, Rd | 1 | | | | | |
| | OR.B Rs, Rd | 1 | | | | | |
| ORC | ORC #xx:8, CCR | 1 | | | | | |
| ROTL | ROTL.B Rd | 1 | | | | | |
| ROTR | ROTR.B Rd | 1 | | | | | |

| Instruction | Mnemonic | Instruction Fetch I | Branch Addr. Read J | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------|------------------|---------------------------|---------------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| ROTXL | ROTXL.B Rd | 1 | | | | | |
| ROTXR | ROTXR.B Rd | 1 | | | | | |
| RTE | RTE | 2 | | 2 | | | 2 |
| RTS | RTS | 2 | | 1 | | | 2 |
| SHAL | SHAL.B Rd | 1 | | | | | |
| SHAR | SHAR.B Rd | 1 | | | | | |
| SHLL | SHLL.B Rd | 1 | | | | | |
| SHLR | SHLR.B Rd | 1 | | | | | |
| SLEEP | SLEEP | 1 | | | | | |
| STC | STC CCR, Rd | 1 | | | | | |
| SUB | SUB.B Rs, Rd | 1 | | | | | |
| | SUB.W Rs, Rd | 1 | | | | | |
| SUBS | SUBS.W #1, Rd | 1 | | | | | |
| | SUBS.W #2, Rd | 1 | | | | | |
| POP | POP Rd | 1 | | 1 | | | 2 |
| PUSH | PUSH Rs | 1 | | 1 | | | 2 |
| SUBX | SUBX.B #xx:8, Rd | 1 | | | | | |
| | SUBX.B Rs, Rd | 1 | | | | | |
| XOR | XOR.B #xx:8, Rd | 1 | | | | | |
| | XOR.B Rs, Rd | 1 | | | | | |
| XORC | XORC #xx:8, CCR | 1 | | | | | |





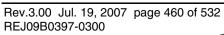
Appendix B Internal I/O Registers

B.1 Register Addresses

B.1.1 H8/3857 Group Addresses

| Address | Register | | | | Bit I | Names | | | | Module |
|---------|-------------------|-------|-------|-------|--------|-------|-------|-------|-------|----------|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'80 | FLMCR1* | ¹FWE | SWE | _ | _ | EV | PV | E | Р | Flash |
| H'81 | FLMCR2* | FLER | _ | _ | _ | _ | _ | ESU | PSU | memory |
| H'82 | | | | | | | | | | _ |
| H'83 | EBR*1 | _ | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 | _ |
| H'84 | | | | | | | | | | _ |
| H'85 | | | | | | | | | | _ |
| H'86 | | | | | | | | | | _ |
| H'87 | | | | | | | | | | _ |
| H'88 | | | | | | | | | | _ |
| H'89 | MDCR*1 | _ | _ | _ | _ | _ | _ | TSDS2 | TSDS1 | _ |
| H'8A | | | | | | | | | | _ |
| H'8B | | | | | | | | | | _ |
| H'8C | | | | | | | | | | _ |
| H'8D | | | | | | | | | | _ |
| H'8E | | | | | | | | | | _ |
| H'8F | SYSCR3* | 1 | _ | _ | _ | FLSHE | _ | _ | _ | _ |
| H'90 | TCSRW* | B6WI | TCWE | B4WI | TCSRWE | B2WI | WDON | B0WI | WRST | Watchdog |
| H'91 | TCW*2 | TCW7 | TCW6 | TCW5 | TCW4 | TCW3 | TCW2 | TCW1 | TCW0 | timer |
| H'92 | TMW* ² | _ | _ | _ | _ | _ | CKS2 | CKS1 | CKS0 | _ |
| H'93 | | | | | | | | | | |
| H'94 | | | | | | | | | | _ |
| H'95 | | | | | | | | | | _ |
| H'96 | | | | | | | | | | _ |
| H'97 | | | | | | | | | | _ |
| H'98 | | | | | | | | | | _ |
| H'99 | | | | | | | | | | _ |
| H'9A | | | | | | | | | | _ |
| H'9B | | | | | | | | | | |

| Addres | s Register | | | | Bit | Names | | | | Module |
|--------|------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|--------------|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'9C | | | | | | | | | | |
| H'9D | | | | | | | | | | _ |
| H'9E | | | | | | | | | | _ |
| H'9F | | | | | | | | | | _ |
| H'A0 | SCR1 | SNC1 | SNC0 | _ | _ | CKS3 | CKS2 | CKS1 | CKS0 | SCI1 |
| H'A1 | SCSR1 | _ | SOL | ORER | _ | _ | _ | _ | STF | _ |
| H'A2 | SDRU | SDRU7 | SDRU6 | SDRU5 | SDRU4 | SDRU3 | SDRU2 | SDRU1 | SDRU0 | _ |
| H'A3 | SDRL | SDRL7 | SDRL6 | SDRL5 | SDRL4 | SDRL3 | SDRL2 | SDRL1 | SDRL0 | _ |
| H'A4 | | | | | | | | | | |
| H'A5 | | | | | | | | | | _ |
| H'A6 | | | | | | | | | | _ |
| H'A7 | | | | | | | | | | _ |
| H'A8 | SMR | СОМ | CHR | PE | PM | STOP | MP | CKS1 | CKS0 | SCI3 |
| H'A9 | BRR | BRR7 | BRR6 | BRR5 | BRR4 | BRR3 | BRR2 | BRR1 | BRR0 | _ |
| H'AA | SCR3 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | _ |
| H'AB | TDR | TDR7 | TDR6 | TDR5 | TDR4 | TDR3 | TDR2 | TDR1 | TDR0 | _ |
| H'AC | SSR | TDRE | RDRF | OER | FER | PER | TEND | MPBR | MPBT | _ |
| H'AD | RDR | RDR7 | RDR6 | RDR5 | RDR4 | RDR3 | RDR2 | RDR1 | RDR0 | _ |
| H'AE | | | | | | | | | | |
| H'AF | | | | | | | | | | _ |
| H'B0 | TMA | TMA7 | TMA6 | TMA5 | _ | TMA3 | TMA2 | TMA1 | TMA0 | Timer A |
| H'B1 | TCA | TCA7 | TCA6 | TCA5 | TCA4 | TCA3 | TCA2 | TCA1 | TCA0 | _ |
| H'B2 | TMB | TMB7 | _ | _ | _ | _ | TMB2 | TMB1 | TMB0 | Timer B |
| H'B3 | TCB/TLB | TCB7/ TLB7 | TCB6/ TLB6 | TCB5/ TLB5 | TCB4/ TLB4 | TCB3/ TLB3 | TCB2/ TLB2 | TCB1/ TLB1 | TCB0/ TLB0 | _ |
| H'B4 | TMC | TMC7 | TMC6 | TMC5 | _ | _ | TMC2 | TMC1 | TMC0 | Timer C |
| H'B5 | TCC/TLC | TCC7/ TLC7 | TCC6/ TLC6 | TCC5/ TLC5 | TCC4/ TLC4 | TCC3/ TLC3 | TCC2/ TLC2 | TCC1/ TLC1 | TCC0/ TLC0 | _ |
| H'B6 | TCRF | TOLH | CKSH2 | CKSH1 | CKSH0 | TOLL | CKSL2 | CKSL1 | CKSL0 | Timer F |
| H'B7 | TCSRF | OVFH | CMFH | OVIEH | CCLRH | OVFL | CMFL | OVIEL | CCLRL | _ |
| H'B8 | TCFH | TCFH7 | TCFH6 | TCFH5 | TCFH4 | TCFH3 | TCFH2 | TCFH1 | TCFH0 | _ |





| Name | Module | | | | lames | Bit N | | | | Register | Address |
|---|-----------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|----------|---------|
| H'BA OCREH OCREH OCREH6 OCREH5 OCREH4 OCREH3 OCREH2 OCREH1 OCREH0 H'BB OCREL OCREL7 OCREL6 OCREL5 OCREL4 OCREL3 OCREL2 OCREL1 OCREL0 H'BC H'BC H'BC H'BC H'BC H'BC H'BC H'CO H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — HOF MORE ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C7 H'C8 H'C9 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — HOF MORE ADR5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'C6 ADR8 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'C9 H'CD H'CE H'C6 PWCR — PWCR0 — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, P1, P1 | Name | Bit 0 | Bit 1 | Bit 2 | Bit 3 | Bit 4 | Bit 5 | Bit 6 | Bit 7 | • | |
| H'BB OCRFL OCRFL7 OCRFL6 OCRFL5 OCRFL4 OCRFL3 OCRFL2 OCRFL1 OCRFL0 H'BC H'BC H'BC H'BC H'BB H'BE H'BF H'C0 H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — TMOFH TMOFL TMOW H'C7 H'C7 H'C8 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — — S01 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CC H'CC H'CC H'CC H'CC H'CC H'CC H'C | Timer F | TCFL0 | TCFL1 | TCFL2 | TCFL3 | TCFL4 | TCFL5 | TCFL6 | TCFL7 | TCFL | H'B9 |
| H'BC H'BD H'BE H'BF H'C0 H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — — | | OCRFH0 | OCRFH1 | OCRFH2 | OCRFH3 | OCRFH4 | OCRFH5 | OCRFH6 | OCRFH7 | OCRFH | H'BA |
| H'BD H'BE H'BF H'CO H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — TMOFH TMOFL TMOW H'C7 H'C8 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — SO1 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CD H'CC H'CF H'CD H'CF H'CF H'D0 PWCR — — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, P1, P1 | | OCRFL0 | OCRFL1 | OCRFL2 | OCRFL3 | OCRFL4 | OCRFL5 | OCRFL6 | OCRFL7 | OCRFL | H'BB |
| H'BE H'BF H'CO H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — — | | | | | | | | | | | H'BC |
| H'BF H'C0 H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — — | | | | | | | | | | | H'BD |
| H'C0 H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — — | | | | | | | | | | | H'BE |
| H'C1 H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — H'C7 H'C7 H'C8 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — SO1 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CC H'CC H'CC PMCR — — — — — — PWCR0 H'CC PMCR — — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, P1, P1 | | | | | | | | | | | H'BF |
| H'C2 H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — — | | | | | | | | | | | H'C0 |
| H'C3 H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — — — — — — — — — — | | | | | | | | | | | H'C1 |
| H'C4 AMR CKS TRGE — — CH3 CH2 CH1 CH0 H'C5 ADRR ADR7 ADR6 ADR5 ADR4 ADR3 ADR2 ADR1 ADR0 H'C6 ADSR ADSF — — — — — — — — — — H'C7 H'C8 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — SO1 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CC H'CE H'CF H'D0 PWCR — — — — — — — — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, | | | | | | | | | | | H'C2 |
| H'C5 | | | | | | | | | | | H'C3 |
| HCS | A/D | CH0 | CH1 | CH2 | СНЗ | _ | _ | TRGE | CKS | AMR | H'C4 |
| H'C7 H'C8 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — — S01 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CD H'CE H'CF H'D0 PWCR — — — — — — — PWCR0 H'D1 PWDRU — PWDRL5 PWDRL4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, P1, | converter | ADR0 | ADR1 | ADR2 | ADR3 | ADR4 | ADR5 | ADR6 | ADR7 | ADRR | H'C5 |
| H'C8 PMR1 IRQ3 IRQ2 IRQ1 PWM — TMOFH TMOFL TMOW H'C9 PMR2 — — — — IRQ0 POF1 UD IRQ4 H'CA PMR3 — — — — — SO1 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CE H'CE — — — — — PWCR0 WKP2 WKP1 WKP0 H'CE H'CE — — — — — — PWCR0 WKP2 WKP1 WKP0 H'CE H'D4 PWDRU — — — — — — PWCR0 — — PWCR0 PWDRU PWDRU PWDRU PWDRU< | | _ | _ | _ | _ | _ | _ | _ | ADSF | ADSR | H'C6 |
| H'C9 PMR2 — — — — — — — — — — SO1 VII SCK1 H'CA PMR3 — — — — — — — — SO1 VII SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CD H'CE H'CF H'D0 PWCR — — — — — — — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, P1, | | | | | | | | | | | H'C7 |
| H'CA PMR3 — — — — — SO1 SI1 SCK1 H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CE | I/O ports | TMOW | TMOFL | TMOFH | _ | PWM | IRQ1 | IRQ2 | IRQ3 | PMR1 | H'C8 |
| H'CB PMR4 NMOD7 NMOD6 NMOD5 NMOD4 NMOD3 NMOD2 NMOD1 NMOD0 H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CD H'CE < | | IRQ4 | UD | POF1 | IRQ0 | _ | _ | _ | _ | PMR2 | H'C9 |
| H'CC PMR5 WKP7 WKP6 WKP5 WKP4 WKP3 WKP2 WKP1 WKP0 H'CD H'CE H'CE H'CF H'D6 H'D7 H'D8 H' | | SCK1 | SI1 | SO1 | _ | _ | _ | _ | _ | PMR3 | H'CA |
| H'CD H'CE H'CF H'D0 PWCR — — — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, | | NMOD0 | NMOD1 | NMOD2 | NMOD3 | NMOD4 | NMOD5 | NMOD6 | NMOD7 | PMR4 | H'CB |
| H'CE H'CF H'D0 PWCR — — — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, | | WKP0 | WKP1 | WKP2 | WKP3 | WKP4 | WKP5 | WKP6 | WKP7 | PMR5 | H'CC |
| H'CF H'D0 PWCR — — — — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, | | | | | | | | | | | H'CD |
| H'D0 PWCR — — — — PWCR0 H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, | | | | | | | | | | | H'CE |
| H'D1 PWDRU — PWDRU5 PWDRU4 PWDRU3 PWDRU2 PWDRU1 PWDRU0 H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, | | | | | | | | | | | H'CF |
| H'D2 PWDRL PWDRL7 PWDRL6 PWDRL5 PWDRL4 PWDRL3 PWDRL2 PWDRL1 PWDRL0 H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, | 14-bit | PWCR0 | _ | _ | _ | _ | _ | _ | _ | PWCR | H'D0 |
| H'D3 H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, | PWM | PWDRU0 | PWDRU1 | PWDRU2 | PWDRU3 | PWDRU4 | PWDRU5 | _ | _ | PWDRU | H'D1 |
| H'D4 PDR1 P1, P1, P1, P1, P1, P1, P1, P1, | | PWDRL0 | PWDRL1 | PWDRL2 | PWDRL3 | PWDRL4 | PWDRL5 | PWDRL6 | PWDRL7 | PWDRL | H'D2 |
| | | | | | | | | | | | H'D3 |
| H'D5 PDR2 P2, P2, P2, P2, P2, P2, P2, P2, | I/O ports | P1 ₀ | P1 ₁ | P1 ₂ | P1 ₃ | P1 ₄ | P1 ₅ | P1 ₆ | P1, | PDR1 | H'D4 |
| | | P2 ₀ | P2 ₁ | P2 ₂ | P2 ₃ | P2 ₄ | P2 ₅ | P2 ₆ | P2, | PDR2 | H'D5 |
| H'D6 PDR3 P3, P3, P3, P3, P3, P3, P3, P3, P3, | | P3 ₀ | P3, | P3 ₂ | P3 ₃ | P3 ₄ | P3 ₅ | P3 ₆ | P3, | PDR3 | H'D6 |
| H'D7 PDR4 — — P4 ₃ P4 ₂ P4 ₁ P4 ₀ | | P4 ₀ | P4 ₁ | P4 ₂ | P4 ₃ | _ | _ | _ | _ | PDR4 | H'D7 |
| H'D8 PDR5 P5, P5, P5, P5, P5, P5, P5, P5, P5, P5 | | P5 ₀ | P5 ₁ | P5 ₂ | P5 ₃ | P5 ₄ | P5 ₅ | P5 ₆ | P5 ₇ | PDR5 | H'D8 |
| H'D9 | | | | | | | | | | | H'D9 |

| Address | Register | | | | Bit I | Names | | | | Module |
|---------|----------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|-------------------|-------------------|-----------|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'DA | | | | | | | | | | I/O ports |
| H'DB | | | | | | | | | | _ |
| H'DC | PDR9 | P9, | P9 ₆ | P9 ₅ | P9 ₄ | P9 ₃ | P9 ₂ | P9 ₁ | P9 ₀ | _ |
| H'DD | PDRA | _ | _ | _ | _ | PA ₃ | PA ₂ | PA ₁ | PA₀ | = |
| H'DE | PDRB | PB ₇ | PB ₆ | PB ₅ | PB ₄ | PB ₃ | PB ₂ | PB ₁ | PB₀ | _ |
| H'DF | | | | | | | | | | = |
| H'E0 | PUCR1 | PUCR1 ₇ | PUCR1 ₆ | PUCR1 ₅ | PUCR1 ₄ | PUCR1 ₃ | PUCR1 ₂ | PUCR1, | PUCR1₀ | = |
| H'E1 | PUCR3 | PUCR3 ₇ | PUCR3 ₆ | PUCR3 ₅ | PUCR3 ₄ | PUCR3 ₃ | PUCR3 ₂ | PUCR3, | PUCR3₀ | = |
| H'E2 | PUCR5 | PUCR5, | PUCR5 ₆ | PUCR5₅ | PUCR5 ₄ | PUCR5 ₃ | PUCR5 ₂ | PUCR5, | PUCR5₀ | _ |
| H'E3 | | | | | | | | | | = |
| H'E4 | PCR1 | PCR1 ₇ | PCR1 ₆ | PCR1₅ | PCR1₄ | PCR1 ₃ | PCR1 ₂ | PCR1₁ | PCR1₀ | _ |
| H'E5 | PCR2 | PCR2, | PCR2 ₆ | PCR2 ₅ | PCR2 ₄ | PCR2 ₃ | PCR2 ₂ | PCR2 ₁ | PCR2₀ | _ |
| H'E6 | PCR3 | PCR3 ₇ | PCR3 ₆ | PCR3 ₅ | PCR3₄ | PCR3 ₃ | PCR3 ₂ | PCR3 ₁ | PCR3₀ | = |
| H'E7 | PCR4 | _ | _ | _ | _ | _ | PCR4 ₂ | PCR4 ₁ | PCR4₀ | = |
| H'E8 | PCR5 | PCR5 ₇ | PCR5 ₆ | PCR5 ₅ | PCR5₄ | PCR5 ₃ | PCR5 ₂ | PCR5 ₁ | PCR5₀ | = |
| H'E9 | | | | | | | | | | = |
| H'EA | | | | | | | | | | = |
| H'EB | | | | | | | | | | = |
| H'EC | PCR9 | PCR9 ₇ | PCR9 ₆ | PCR9 ₅ | PCR9₄ | PCR9 ₃ | PCR9 ₂ | PCR9 ₁ | PCR9 ₀ | = |
| H'ED | PCRA | _ | _ | _ | _ | PCRA ₃ | PCRA ₂ | PCRA ₁ | PCRA₀ | = |
| H'EE | | | | | | | | | | = |
| H'EF | | | | | | | | | | _ |
| H'F0 | SYSCR1 | SSBY | STS2 | STS1 | STS0 | LSON | _ | _ | _ | System |
| H'F1 | SYSCR2 | _ | _ | _ | NESEL | DTON | MSON | SA1 | SA0 | control |
| H'F2 | IEGR | _ | _ | _ | IEG4 | IEG3 | IEG2 | IEG1 | IEG0 | = |
| H'F3 | IENR1 | IENTA | IENS1 | IENWP | IEN4 | IEN3 | IEN2 | IEN1 | IEN0 | _ |
| H'F4 | IENR2 | IENDT | IENAD | _ | _ | IENTFH | IENTFL | IENTC | IENTB | = |
| H'F5 | | | | | | | | | | _ |
| H'F6 | IRR1 | IRRTA | IRRS1 | _ | IRRI4 | IRRI3 | IRRI2 | IRRI1 | IRRI0 | _ |
| H'F7 | IRR2 | IRRDT | IRRAD | _ | _ | IRRTFH | IRRTFL | IRRTC | IRRTB | _ |
| H'F8 | | | | | | | | | | _ |
| H'F9 | IWPR | IWPF7 | IWPF6 | IWPF5 | IWPF4 | IWPF3 | IWPF2 | IWPF1 | IWPF0 | _ |

| Addres | ss Registe | er | | | Bi | t Names | | | Bit Names | | | | | | | | |
|--------|------------|-------|-------|-------|-------|---------|-------|-------|-----------|------|--|--|--|--|--|--|--|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name | | | | | | | |
| H'FA | | | | | | | | | | | | | | | | | |
| H'FB | | | | | | | | | | | | | | | | | |
| H'FC | | | | | | | | | | | | | | | | | |
| H'FD | | | | | | | | | | | | | | | | | |
| H'FE | | | | | | | | | | | | | | | | | |
| H'FF | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | |

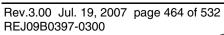
Legend:

SCI1: Serial communication interface 1 SCI3: Serial communication interface 3

- Notes: 1. Applies to the F-ZTAT version. In the mask ROM version, a read access to the address of a register other than MDCR will always return 0, a read access to the MDCR address will return an undefined value, and writes are invalid.
 - 2. Applies to the F-ZTAT version. In the mask ROM version, read accesses to the corresponding addresses will always return 1, and writes are invalid.

B.1.2 H8/3854 Group Addresses

| Address | Register | | | | Bit N | lames | | | | Module |
|---------|-------------------|-------------------|-------|-------|--------|-------|-------|-------|-------|--------------|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'80 | FLMCR1* | ¹FWE | SWE | _ | _ | EV | PV | E | Р | Flash |
| H'81 | FLMCR2* | ¹ FLER | _ | _ | _ | _ | _ | ESU | PSU | memory |
| H'82 | | | | | | | | | | |
| H'83 | EBR*1 | _ | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 | |
| H'84 | | | | | | | | | | |
| H'85 | | | | | | | | | | _ |
| H'86 | | | | | | | | | | _ |
| H'87 | | | | | | | | | | |
| H'88 | | | | | | | | | | |
| H'89 | MDCR*1 | _ | _ | _ | _ | _ | _ | TSDS2 | TSDS1 | _ |
| H'8A | | | | | | | | | | |
| H'8B | | | | | | | | | | _ |
| H'8C | | | | | | | | | | _ |
| H'8D | | | | | | | | | | |
| H'8E | | | | | | | | | | _ |
| H'8F | SYSCR3* | 1 | _ | _ | _ | FLSHE | _ | _ | _ | _ |
| H'90 | TCSRW* | B6WI | TCWE | B4WI | TCSRWE | B2WI | WDON | B0WI | WRST | Watchdog |
| H'91 | TCW*2 | TCW7 | TCW6 | TCW5 | TCW4 | TCW3 | TCW2 | TCW1 | TCW0 | timer |
| H'92 | TMW* ² | _ | _ | _ | — | _ | CKS2 | CKS1 | CKS0 | |
| H'93 | | | | | | | | | | _ |
| H'94 | | | | | | | | | | _ |
| H'95 | | | | | | | | | | |
| H'96 | | | | | | | | | | _ |
| H'97 | | | | | | | | | | _ |
| H'98 | | | | | | | | | | |
| H'99 | | | | | | | | | | _ |
| H'9A | | | | | | | | | | |
| H'9B | | | | | | | | | | _ |
| H'9C | | | | | | | | | | - |
| H'9D | | | | | | | | | | _ |
| H'9E | | | | | | | | | | _ |
| H'9F | | | | | | | | | | _ |





| Address | Register | | | | Bit N | lames | | | | Module |
|---------|----------|----------|----------|----------|-----------|----------|----------|-----------|----------|----------|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'A0 | | | | | | | | | | |
| H'A1 | | | | | | | | | | - |
| H'A2 | | | | | | | | | | - |
| H'A3 | | | | | | | | | | - |
| H'A4 | | | | | | | | | | - |
| H'A5 | | | | | | | | | | - |
| H'A6 | | | | | | | | | | - |
| H'A7 | | | | | | | | | | - |
| H'A8 | SMR | COM | CHR | PE | PM | STOP | MP | CKS1 | CKS0 | SCI3 |
| H'A9 | BRR | BRR7 | BRR6 | BRR5 | BRR4 | BRR3 | BRR2 | BRR1 | BRR0 | - |
| H'AA | SCR3 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | - |
| H'AB | TDR | TDR7 | TDR6 | TDR5 | TDR4 | TDR3 | TDR2 | TDR1 | TDR0 | - |
| H'AC | SSR | TDRE | RDRF | OER | FER | PER | TEND | MPBR | MPBT | - |
| H'AD | RDR | RDR7 | RDR6 | RDR5 | RDR4 | RDR3 | RDR2 | RDR1 | RDR0 | - |
| H'AE | | | | | | | | | | |
| H'AF | | | | | | | | | | - |
| H'B0 | TMA | TMA7 | TMA6 | TMA5 | _ | TMA3 | TMA2 | TMA1 | TMA0 | Timer A |
| H'B1 | TCA | TCA7 | TCA6 | TCA5 | TCA4 | TCA3 | TCA2 | TCA1 | TCA0 | - |
| H'B2 | TMB | TMB7 | _ | _ | _ | _ | TMB2 | TMB1 | TMB0 | Timer B |
| H'B3 | TCB/TLB | | TCB6/ | TCB5/ | TCB4/ | TCB3/ | TCB2/ | TCB1/ | TCB0/ | - |
| H'B4 | | TLB7 | TLB6 | TLB5 | TLB4 | TLB3 | TLB2 | TLB1 | TLB0 | |
| H'B5 | | | | | | | | | | <u>-</u> |
| H'B6 | TCRF | TOLH | CKSH2 | CKSH1 | CKSH0 | TOLL | CKSL2 | CKSL1 | CKSL0 | Timer F |
| H'B7 | TCSRF | OVFH | CMFH | OVIEH | CCLRH | OVFL | CMFL | OVIEL | CCLRL | - |
| H'B8 | TCFH | TCFH7 | TCFH6 | TCFH5 | TCFH4 | TCFH3 | TCFH2 | TCFH1 | TCFH0 | - |
| H'B9 | TCFL | TCFL7 | TCFL6 | TCFL5 | TCFL4 | TCFL3 | TCFL2 | TCFL1 | TCFL0 | - |
| H'BA | OCRFH | | | | | | | | OCRFH0 | - |
| H'BB | OCRFL | | OCRFL6 | | | | | | | - |
| H'BC | OOME | 00111 27 | 00111 20 | 00111 23 | OOI II L4 | 00111 20 | OOTII LE | OOI II ET | 00111 20 | |
| H'BD | | | | | | | | | | - |
| H'BE | | | | | | | | | | - |
| H'BF | | | | | | | | | | - |
| H'C0 | | | | | | | | | | - |
| H'C1 | | | | | | | | | | - |
| | | | | | | | | | | |

| Auuless | Register | | | | Bit I | Names | | | | Module |
|---------|----------|--------------------|--------------------|--------------------|-----------------|--------------------|--------------------|--------------------|--------------------|-----------|
| | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'C2 | | | | | | | | | | |
| H'C3 | | | | | | | | | | _ |
| H'C4 | AMR | CKS | TRGE | _ | _ | СНЗ | CH2 | CH1 | CH0 | A/D |
| H'C5 | ADRR | ADR7 | ADR6 | ADR5 | ADR4 | ADR3 | ADR2 | ADR1 | ADR0 | converter |
| H'C6 | ADSR | ADSF | _ | _ | _ | _ | _ | _ | _ | _ |
| H'C7 | | | | | | | | | | |
| H'C8 | PMR1 | IRQ3 | _ | IRQ1 | _ | _ | TMOFH | TMOFL | TMOW | I/O ports |
| H'C9 | PMR2 | _ | _ | _ | _ | IRQ0 | _ | _ | IRQ4 | _ |
| H'CA | | | | | | | | | | _ |
| H'CB | PMR4 | NMOD7 | NMOD6 | NMOD5 | NMOD4 | NMOD3 | NMOD2 | NMOD1 | NMOD0 | _ |
| H'CC | PMR5 | WKP7 | WKP6 | WKP5 | WKP4 | WKP3 | WKP2 | WKP1 | WKP0 | _ |
| H'CD | | | | | | | | | | |
| H'CE | | | | | | | | | | _ |
| H'CF | | | | | | | | | | _ |
| H'D0 | | | | | | | | | | - |
| H'D1 | | | | | | | | | | _ |
| H'D2 | | | | | | | | | | _ |
| H'D3 | | | | | | | | | | _ |
| H'D4 | PDR1 | P1, | _ | P1 ₅ | _ | _ | P1 ₂ | P1, | P1 _o | I/O ports |
| H'D5 | PDR2 | P2, | P2 ₆ | P2 ₅ | P2 ₄ | P2 ₃ | P2 ₂ | P2 ₁ | P2 ₀ | _ |
| H'D6 | | | | | | | | | | _ |
| H'D7 | PDR4 | _ | _ | _ | _ | P4 ₃ | P4 ₂ | P4 ₁ | P4 _o | _ |
| H'D8 | PDR5 | P5, | P5 ₆ | P5 ₅ | P5 ₄ | P5 ₃ | P5 ₂ | P5 ₁ | P5 ₀ | = |
| H'D9 | | | | | | | | | | _ |
| H'DA | | | | | | | | | | _ |
| H'DB | | | | | | | | | | = |
| H'DC | PDR9 | P9, | P9 ₆ | P9 ₅ | P9 ₄ | P9 ₃ | P9 ₂ | P9 ₁ | P9 ₀ | _ |
| H'DD | PDRA | _ | _ | _ | _ | PA ₃ | PA ₂ | PA ₁ | PA₀ | _ |
| H'DE | PDRB | PB ₇ | PB ₆ | PB ₅ | PB ₄ | _ | _ | _ | _ | = |
| H'DF | | | | | | | | | | - |
| H'E0 | PUCR1 | PUCR1, | _ | PUCR1 ₅ | _ | _ | PUCR1 ₂ | PUCR1, | PUCR1 ₀ | _ |
| H'E1 | | | | | | | | | | - |
| H'E2 | PUCR5 | PUCR5 ₇ | PUCR5 ₆ | PUCR5₅ | PUCR5₄ | PUCR5 ₃ | PUCR5 ₂ | PUCR5 ₁ | PUCR5₀ | _ |
| H'E3 | | | | | | | | | | = |

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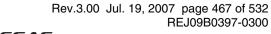
| Address | Register | | | | Bit | Names | | | | Module |
|---------|----------|-------------------|-------------------|-------|-------------------|-------------------|-------------------|-------------------|-------|-----------|
| (low) | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Name |
| H'E4 | PCR1 | PCR1 ₇ | _ | PCR1₅ | _ | _ | PCR1 ₂ | PCR1₁ | PCR1₀ | I/O ports |
| H'E5 | PCR2 | PCR2 ₇ | PCR2 ₆ | PCR2₅ | PCR2₄ | PCR2 ₃ | PCR2 ₂ | PCR2 ₁ | PCR2₀ | _ |
| H'E6 | | | | | | | | | | _ |
| H'E7 | PCR4 | _ | _ | _ | _ | _ | PCR4 ₂ | PCR4 ₁ | PCR4₀ | _ |
| H'E8 | PCR5 | PCR5 ₇ | PCR5 ₆ | PCR5₅ | PCR5₄ | PCR5₃ | PCR5 ₂ | PCR5 ₁ | PCR5₀ | _ |
| H'E9 | | | | | | | | | | _ |
| H'EA | | | | | | | | | | _ |
| H'EB | | | | | | | | | | _ |
| H'EC | PCR9 | PCR9 ₇ | PCR9 ₆ | PCR9₅ | PCR9 ₄ | PCR9₃ | PCR9 ₂ | PCR9 ₁ | PCR9₀ | _ |
| H'ED | PCRA | _ | _ | _ | _ | PCRA ₃ | PCRA ₂ | PCRA ₁ | PCRA₀ | _ |
| H'EE | | | | | | | | | | _ |
| H'EF | | | | | | | | | | _ |
| H'F0 | SYSCR1 | SSBY | STS2 | STS1 | STS0 | LSON | _ | _ | _ | System |
| H'F1 | SYSCR2 | _ | _ | _ | NESEL | DTON | MSON | SA1 | SA0 | control |
| H'F2 | IEGR | _ | _ | _ | IEG4 | IEG3 | _ | IEG1 | IEG0 | _ |
| H'F3 | IENR1 | IENTA | _ | IENWP | IEN4 | IEN3 | _ | IEN1 | IEN0 | _ |
| H'F4 | IENR2 | IENDT | IENAD | _ | _ | IENTFH | IENTFL | _ | IENTB | _ |
| H'F5 | | | | | | | | | | _ |
| H'F6 | IRR1 | IRRTA | _ | _ | IRRI4 | IRRI3 | _ | IRRI1 | IRRI0 | _ |
| H'F7 | IRR2 | IRRDT | IRRAD | _ | _ | IRRTFH | IRRTFL | _ | IRRTB | _ |
| H'F8 | | | | | | | | | | _ |
| H'F9 | IWPR | IWPF7 | IWPF6 | IWPF5 | IWPF4 | IWPF3 | IWPF2 | IWPF1 | IWPF0 | _ |
| H'FA | | | | | | | | | | |
| H'FB | | | | | | | | | | _ |
| H'FC | | | | | | | | | | _ |
| H'FD | | | | | | | | | | _ |
| H'FE | | | | | | | | | | _ |
| H'FF | | | | | | | | | | _ |

Legend:

SCI3: Serial communication interface 3

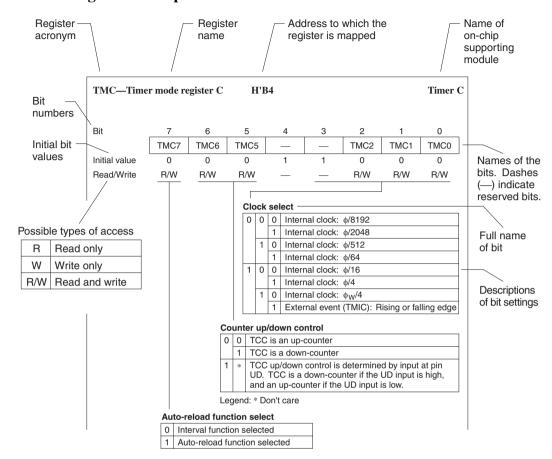
Notes: 1. Applies to the F-ZTAT version. In the mask ROM version, a read access to the address of a register other than MDCR will always return 0, a read access to the MDCR address will return an undefined value, and writes are invalid.

2. Applies to the F-ZTAT version. In the mask ROM version, read accesses to the corresponding addresses will always return 1, and writes are invalid.

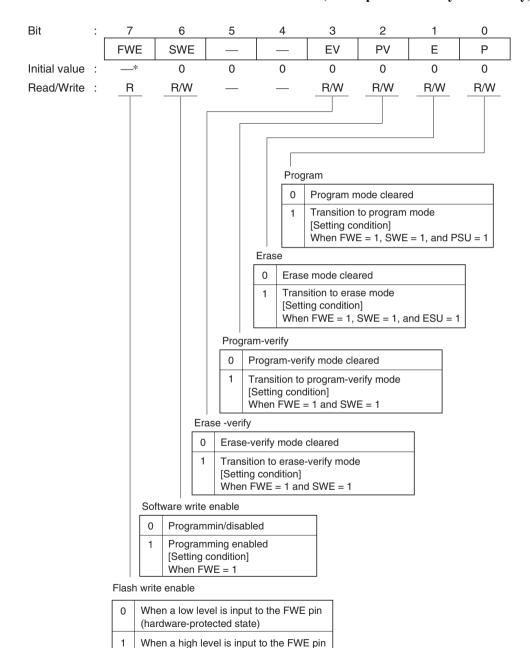




B.2 Register Descriptions

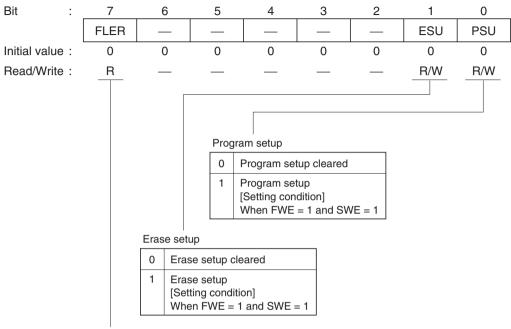


FLMCR1—Flash memory control register 1 H'80 Flash memory (On-chip flash memory version only)



Note: * Determined by the state of the FWE pin.

FLMCR2—Flash memory control register 2 H'81 Flash memory (On-chip flash memory version only)



Flash memory error

| 0 | Flash memory is operating normally Flash memory program/erase protection (error protection) is disabled [Clearing condition] Reset or hardware standby mode |
|---|---|
| 1 | An error occurred during flash memory programming/erasing Flash memory program/erase protection (error protection) is enabled [Setting condition] See section 6.6.3, Error Protection |

EBR—Erase block register

H'83 Flash memory (On-chip flash memory version only)

| Bit | : | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|---|-----|-----|-----|-----|-----|-----|-----|
| | | _ | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 |
| Initial value | : ' | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | : | _ | R/W |

Flash memory erase blocks

| Block (Size) | Addresses |
|-----------------|------------------|
| EB0 (1 kbyte) | H'0000 to H'03FF |
| EB1 (1 kbyte) | H'0400 to H'07FF |
| EB2 (1 kbyte) | H'0800 to H'0BFF |
| EB3 (1 kbyte) | H'0C00 to H'0FFF |
| EB4 (28 kbytes) | H'1000 to H'7FFF |
| EB5 (16 kbytes) | H'8000 to H'BFFF |
| EB6 (12 kbytes) | H'C000 to H'EDFF |

MDCR—Mode control register H'89 Flash memory (On-chip flash memory version only) Bit 5 3 2 1 0 TSDS2 TSDS1 ___* 0 0 0 0 0 0 Initial value: Read/Write: R R

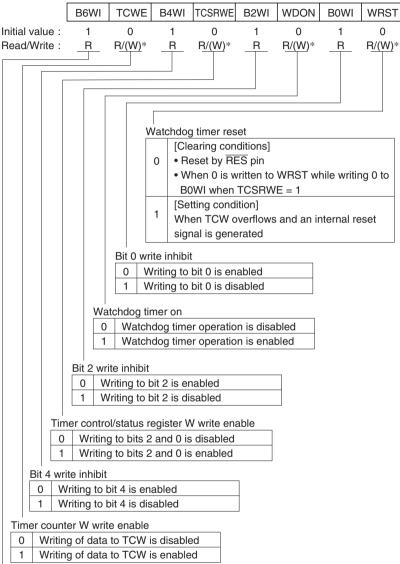
Test pin monitor bits

Note: * Determined by the TEST and TEST2 pins.

SYSCR3—System control register 3 H'8F Flash memory (On-chip flash memory version only) Bit 7 6 5 4 3 2 **FLSHE** Initial value: 0 0 0 0 0 0 0 0 Read/Write: R/W Flash memory control register enable 0 Flash memory control registers are unselected 1 Flash memory control registers are selected



H'90 TCSRW—Timer control/status register W Flash memory (On-chip flash memory version only) 7 5 2 0 Bit 6 4 3 1 B6WI **TCWE** B4WI **TCSRWE** B2WI **WDON BOWI WRST**



Bit 6 write inhibit

| 0 | Writing to bit 6 is enabled |
|---|------------------------------|
| 1 | Writing to bit 6 is disabled |

Note: * Can be written to only when the write condition is satisfied.

| TCW—Tin | ner (| counter W | 7 | | H'91 | | | | Flash memory | | |
|--------------|-------|-----------|------|------|------------------------------|------|------|------|--------------|--|--|
| | | | | | (On-chip flash memory versio | | | | | | |
| Bit | : | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | | TCW7 | TCW6 | TCW5 | TCW4 | TCW3 | TCW2 | TCW1 | TCW0 | | |
| Initial valu | ıe: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| Read/Wri | te: | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | | |
| | | | | | | | | | | | |
| | | | | | Count valu | e | | | | | |

| TMW—Timer | mode reg | ister W | | H'9 | | hip flash n | Flash memory memory version only) | | |
|---------------------------------|----------|---------|-----|-----|-----|-------------|-----------------------------------|----------|--|
| Bit : | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | | _ | _ | _ | _ | CKS2 | CKS1 | CKS0 | |
| Initial value : Read/Write : | | 1 — | 1 — | 1 — | 1 — | 1 R/W | 1 R/W | 1 R/W | |

| Clock | selec | t |
|-------|-------|---|
| | _ | Г |

| Bit 2 | Bit 1 | Bit 0 | Description |
|-------|-------|-------|---|
| CKS2 | CKS1 | CKS0 | Description |
| 0 | 0 | 0 | Internal clock: $\phi/64$ |
| 0 | 0 | 1 | Internal clock: $\phi/128$ |
| 0 | 1 | 0 | Internal clock: φ/256 |
| 0 | 1 | 1 | Internal clock: φ/512 |
| 1 | 0 | 0 | Internal clock: $\phi/1024$ |
| 1 | 0 | 1 | Internal clock: $\phi/2048$ |
| 1 | 1 | 0 | Internal clock: $\phi/4096$ |
| 1 | 1 | 1 | Internal clock: $\phi/8192$ (initial value) |

Note: TMW is an 8-bit read/write register that selects the input clock. Upon reset, TMW is initialized to H'FF.

SCR1—Serial control register 1

H'A0 SCI1 (H8/3857 Group only)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-----|-----|------|------|------|------|
| | SNC1 | SNC0 | _ | _ | CKS3 | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |

Clock Select (CKS2 to CKS0)

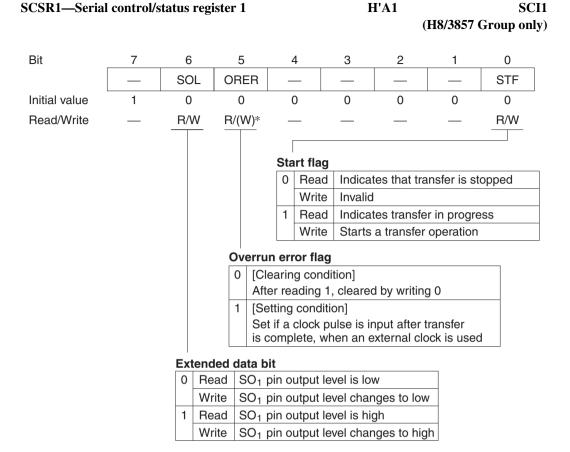
| Clock Select (CNS2 to CNS0) | | | | | | | | | | | |
|-----------------------------|-------|-------|-----------|-----------|-------------|--|--|--|--|--|--|
| | | | | Serial Cl | ock Cycle | | | | | | |
| Bit 2 | Bit 1 | Bit 0 | Prescaler | Synch | ronous | | | | | | |
| CKS2 | CKS1 | CKS0 | Division | φ = 5 MHz | φ = 2.5 MHz | | | | | | |
| 0 | 0 | 0 | φ/1024 | 204.8 μs | 409.6 μs | | | | | | |
| | | 1 | φ/256 | 51.2 μs | 102.4 μs | | | | | | |
| | 1 | 0 | φ/64 | 12.8 μs | 25.6 μs | | | | | | |
| | | 1 | φ/32 | 6.4 μs | 12.8 μs | | | | | | |
| 1 | 0 | 0 | φ/16 | 3.2 μs | 6.4 μs | | | | | | |
| | | 1 | φ/8 | 1.6 μs | 3.2 μs | | | | | | |
| | 1 | 0 | φ/4 | 0.8 μs | 1.6 μs | | | | | | |
| | | 1 | φ/2 | _ | 0.8 μs | | | | | | |

Clock source select

| 0 | Clock source is prescaler S, and pin SCK ₁ is output pin |
|---|---|
| 1 | Clock source is external clock, and pin SCK ₁ is input pin |

Operation mode select

| 0 | 0 | 8-bit synchronous transfer mode |
|---|---|----------------------------------|
| | 1 | 16-bit synchronous transfer mode |
| 1 | 0 | Continuous clock output mode |
| | 1 | Reserved |



Note: *Only a write of 0 for flag clearing is possible.

SDRU—Serial data register U

H'A2 SCI1 (H8/3857 Group only)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
|---------------|--|-----------|-----------|-----------|-----------|-----------|-----------|-----------|--|--|--|
| | SDRU7 | SDRU6 | SDRU5 | SDRU4 | SDRU3 | SDRU2 | SDRU1 | SDRU0 | | | |
| Initial value | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | | | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | | | |
| | | | | | | | | | | | |
| | Used to set transmit data and store receive data | | | | | | | | | | |
| | 8-bit transfer mode: Not used 16-bit transfer mode: Upper 8 bits of data | | | | | | | | | | |

SDRL—Serial data register L

H'A3 SCI1 (H8/3857 Group only)

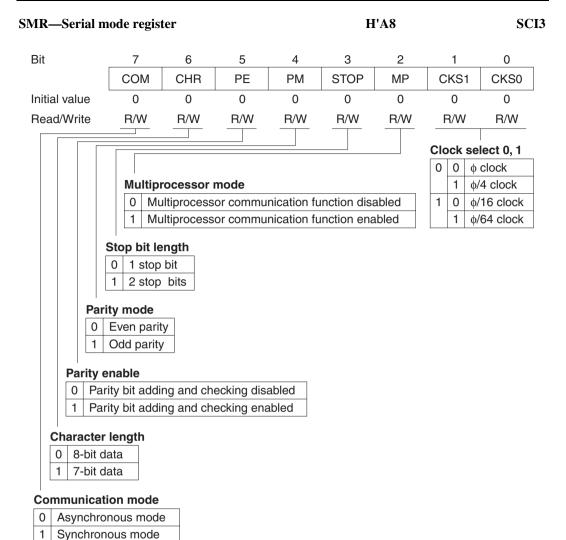
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | SDRL7 | SDRL6 | SDRL5 | SDRL4 | SDRL3 | SDRL2 | SDRL1 | SDRL0 |
| Initial value | Undefined |
| Read/Write | R/W |
| | | | | | | | | |

Used to set transmit data and store receive data

8-bit transfer mode: 8-bit data

RENESAS

16-bit transfer mode: Lower 8 bits of data



| BRR—Bit rate register | | | | | H'A9 | | | | SCI3 | |
|-----------------------|------|------|------|------|------|------|------|------|------|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | BRR7 | BRR6 | BRR5 | BRR4 | BRR3 | BRR2 | BRR1 | BRR0 | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | | |
| Read/Write | R/W | | |

REJ09B0397-0300



SCR3—Serial control register 3

H'AA

SCI3

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|------|------|------|------|
| | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |

Clock enable

| Bit 1 | Bit 0 | | Description | |
|-------|-------|--------------------|--|--|
| CKE1 | CKE0 | Communication Mode | Clock Source | SCK ₃ Pin Function |
| 0 | 0 | Asynchronous | Internal clock | I/O port |
| | | Synchronous | Internal clock | Serial clock output |
| | 1 | Asynchronous | Internal clock | Clock output |
| | | Synchronous | Reserved (Do not set this combination) | Reserved (Do not set this combination) |
| 1 | 0 | Asynchronous | External clock | Clock input |
| | | Synchronous | External clock | Serial clock input |
| | 1 | Asynchronous | Reserved (Do not set this combination) | Reserved (Do not set this combination) |
| | | Synchronous | Reserved (Do not set this combination) | Reserved (Do not set this combination) |

Transmit end interrupt enable

| 0 | Transmit end interrupt (TEI) disabled |
|---|---------------------------------------|
| 1 | Transmit end interrupt (TEI) enabled |

Multiprocessor interrupt enable

- 0 Multiprocessor interrupt request disabled (ordinary receive operation) [Clearing condition]
 - Multiprocessor bit receives a data value of 1
- Multiprocessor interrupt request enabled
 Until a multiprocessor bit value of 1 is received, the receive data full interrupt (RXI) and receive error interrupt (ERI) are disabled, and serial status register (SSR) flags RDRF, FER, and OER are not set.

Receive enable

- 0 Receive operation disabled (RXD is a general I/O port)
- 1 Receive operation enabled (RXD is the receive data pin)

Transmit enable

- 0 Transmit operation disabled (TXD is a general I/O port)
- 1 Transmit operation enabled (TXD is the transmit data pin)

Receive interrupt enable

- 0 Receive data full interrupt request (RXI) and receive error interrupt request (ERI) disabled
- 1 Receive data full interrupt request (RXI) and receive error interrupt request (ERI) enabled

Transmit interrupt enable

- 0 Transmit data empty interrupt request (TXI) disabled
- 1 Transmit data empty interrupt request (TXI) enabled

| ΓDR—Transmit data register | | | | | | H'AB | | | CI3 |
|----------------------------|------|------|------|------|------|------|------|------|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | TDR7 | TDR6 | TDR5 | TDR4 | TDR3 | TDR2 | TDR1 | TDR0 | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | _ |
| Read/Write | R/W | |
| | | | | | | | | | |

Data to be transferred to TSR



SSR—Serial status register

H'AC

SCI3

| Bit | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
|-----------------|--|----------------|-------------------------------|---------------------|----------------------------------|--------------|------------------------------|----------|-----------------|--|--|--|
| | | TDRE | RDRF | OER | FER | PER | TEND | MPBR | MPBT | | | |
| Initial va | lue | 0 | 0 | | | | | | | | | |
| Read/W | ad/Write $R/(W)^*$ $R/(W)^*$ $R/(W)^*$ $R/(W)^*$ $R/(W)^*$ R | | | | | | | | | | | |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| 1 1 1 1 1 1 6 | _ · | essor bit re | | دنداد دمد ماه مامند | | | processor bi | | amait data ia O | | | |
| | | | of data in wh | | | | | | nsmit data is 0 | | | |
| Tra | ansmit e | | | | | | | | | | | |
| | | | ission is in pr | ogress | | | | | | | | |
| | [Clearing | conditions] | After readir When data | | , cleared by v TDR by an in | | DRE. | | | | | |
| 1 | Indicates | that a trans | mission has | | | | | | | | | |
| | [Setting of | conditions] | | | ntrol register the last bit o | | 0. ed character i | is sent. | | | | |
| Pari | ty error | | | | | | | | | | | |
| | • | hat data rece | eiving is in pro | ogress or has | been compl | eted | | | | | | |
|)] [[| Clearing o | condition] | After reading | PER = 1, cle | eared by writi | ng 0 | | | | | | |
| 1 1 1 11 1 | | | error occurred | | - | | | | | | | |
| [9 | Setting co | | | | | | bit does not egister (SMR | | | | | |
| Frami | ing error | | | | | | | | | | | |
| | | at data receiv | ing is in prog | ress or has b | peen complet | ed | | | | | | |
| [CI | earing co | ndition] A | fter reading F | ER = 1, clea | red by writing | g 0 | | | | | | |
| | | 0 | error occurred | | 0 | | | _ | | | | |
| | etting con | dition] II | he stop bit at | the end of re | eceive data is | checked and | d found to be | 0 | | | | |
| Overru | n error | | | | | | | | | | | |
| | | | ng is in progre | | | | | | | | | |
| ' | aring cond | | er reading OE | | | 0 | | | | | | |
| 1 11 1 | | | error occurred | | O | | DDDE:- | | | | | |
| | ting condi | uonj vvn | en reception | or the next s | eriai dala is c | completed wr | nile RDRF is s | set to 1 | | | | |
| | data regi | | | | | | | | | | | |
| 11 | | | data in RDR | | | | | | | | | |
| [Clear | ing condit | | reading RDF n data is read | | | | | | | | | |
| | | | e data in RD | | | | | | | | | |
| [Settin | ng condition | on] Whe | n receiving e | nds normally, | with receive | data transfe | rred from RSI | R to RDR | | | | |
| । Transmit c | data regi | ster empty | | | | | | | | | | |

0 Indicates that transmit data written to TDR has not been transferred to TSR [Clearing conditions] After reading TDRE = 1, cleared by writing 0. When data is written to TDR by an instruction. 1 Indicates that no transmit data has been written to TDR, or the transmit data written to TDR has been transferred to TSR [Setting conditions] When bit TE in serial control register 3 (SCR3) is 0. When data is transferred from TDR to TSR.

Note: *Only a write of 0 for flag clearing is possible.

RDR—Receive data register

H'AD

SCI3

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | RDR7 | RDR6 | RDR5 | RDR4 | RDR3 | RDR2 | RDR1 | RDR0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

| TI | 11 | D | n |
|----|----|----|---|
| п | | ימ | " |

Timer A

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|---|------|------|------|------|
| | TMA7 | TMA6 | TMA5 | _ | TMA3 | TMA2 | TMA1 | TMA0 |
| Initial value | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | _ | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| | | | | | | | | |

Clock output select

|--|

| 0 | 0 | φ/32 |
|---|-----|---------------------------|
| | 1 | φ/16 |
| 1 | 0 | φ/8 |
| | 1 | φ/4 |
| 0 | 0 | φ _W /32 |
| | 1 | φ _W /16 |
| 1 | 0 | φ _W /8 |
| | 1 | φw/4 |
| | 1 0 | 1 1 0 1 0 0 1 |

| TMA3 | TMA2 | TMA1 | TMA0 | Prescaler a | and Divider Ratio | Function |
|------|------|------|------|-------------|-------------------|----------|
| 0 | 0 | 0 | 0 | PSS | φ/8192 | Interval |
| | | | 1 | PSS | φ/4096 | timer |
| | | 1 | 0 | PSS | φ/2048 | |
| | | | 1 | PSS | φ/512 | |
| | 1 | 0 | 0 | PSS | φ/256 | |
| | | | 1 | PSS | ф/128 | |
| | | 1 | 0 | PSS | ф/32 | |
| | | | 1 | PSS | ф/8 | |
| 1 | 0 | 0 | 0 | PSW | 1 s | Time |
| | | | 1 | PSW | 0.5 s | base |
| | | 1 | 0 | PSW | 0.25 s | |
| | | | 1 | PSW | 0.03125 s | |
| | 1 | 0 | 0 | PSW and | TCA are reset | |
| | | | 1 | | | |
| | | 1 | 0 | | | |
| | | | 1 | | | |

| TCA—Timer co | ounter A | | | | H | | Timer A | |
|---------------|-----------|--------|------|------|---------|------|---------|---------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | TCA7 | TCA6 | TCA5 | TCA4 | TCA3 | TCA2 | TCA1 | TCA0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |
| | | | | Coun | t value | | | |
| TMB—Timer n | node regi | ster B | | | Н | I'B2 | | Timer B |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |

Auto-reload function select

Initial value

Read/Write

| 0 | Interval timer function selected |
|---|----------------------------------|
| 1 | Auto-reload function selected |

TMB7

0

R/W

Clock select

| 0 | 0 | 0 | Internal clock: $\phi/8192$ |
|---|---|---|---|
| | | 1 | Internal clock: $\phi/2048$ |
| | 1 | 0 | Internal clock: $\phi/512$ |
| | | 1 | Internal clock: $\phi/256$ |
| 1 | 0 | 0 | Internal clock: $\phi/64$ |
| | | 1 | Internal clock: $\phi/16$ |
| | 1 | 0 | Internal clock: $\phi/4$ |
| | | 1 | External event (TMIB): Rising or falling edge |

TMB2

0

R/W

TMB1

0

R/W

TMB0

0

R/W

| TCB—Timer co | ounter B | | Н | Timer B | | | | | |
|---------------|----------|------|------|---------|---------|------|------|------|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | TCB7 | TCB6 | TCB5 | TCB4 | TCB3 | TCB2 | TCB1 | TCB0 | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | - |
| Read/Write | R | R | R | R | R | R | R | R | |
| | | | | | | | | | |
| | | | | Coun | t value | | | | |

| TLB—Timer lo | oad registe | er B | | | Н | Timer B | | |
|---------------|-------------|------|------|------|------|---------|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | TLB7 | TLB6 | TLB5 | TLB4 | TLB3 | TLB2 | TLB1 | TLB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

Reload value



TMC—Timer mode register C

H'B4

Timer C (H8/3857 Group only)

| Bit | 7 | 6 | | 5 | | | 4 | 3 | | 2 | 1 | | 0 |
|-----------------|-------------|----------|---|------|----|-----|-----------------------|-----------|------|-------------------|----------|-------|-----------|
| | TMC7 | TMC6 | Т | TMC5 | | _ | | | | TMC2 | TMC | 1 | TMC0 |
| Initial value | 0 | 0 | | 0 | | | 1 | 1 | | 0 | 0 | | 0 |
| Read/Write | R/W | R/W | F | R/W | | | | _ | | R/W | R/V | V | R/W |
| | | | | | | | | | | | | | |
| | | | | Clo | ck | sel | ect | | | | | | |
| | | | | 0 | 0 | 0 | Interi | nal clock | K: (| ¢/8192 | | | |
| | | | | | | 1 | Interi | nal clock | K: (| þ/2048 | | | |
| Auto-reload fur | ction sele | ect | | | 1 | 0 | Inter | nal clock | K: (| ∮/512 | | | |
| 0 Interval time | er function | selected | | | | 1 | Inter | nal clock | k: (| ∮/64 | | | |
| 1 Auto-reload | function s | elected | | 1 | 0 | 0 | Inter | nal clock | K: (| ∮/16 | | | |
| | | | | | | 1 | 1 Internal clock: φ/4 | | | | | | |
| | | | | | 1 | 0 | Inter | nal clock | k: (| ¢ _W /4 | | | |
| | | | | | | 1 | Exte | nal ever | nt (| TMIC): | Rising o | r fal | ling edge |

Counter up/down control

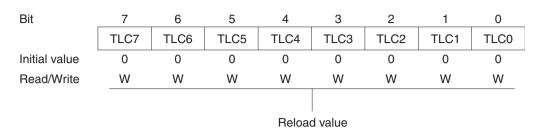
| 0 | 0 | TCC is an up-counter |
|---|---|---|
| | 1 | TCC is a down-counter |
| 1 | * | TCC up/down operation is hardware-controlled by input at the UD pin. TCC is a down-counter if the UD input is high, and an up-counter if the UD input is low. |

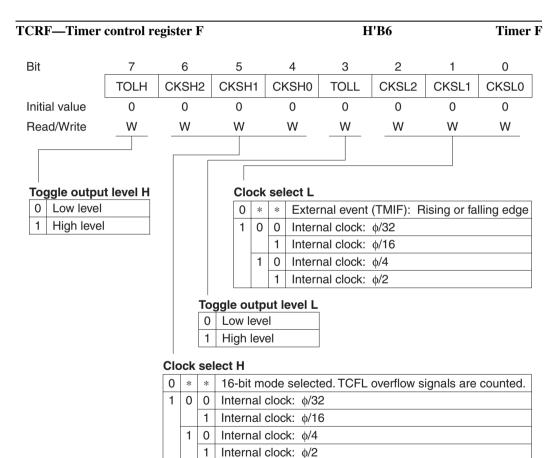
Legend: * Don't care

| TCC—Timer c | ounter C | | | Н | Timer C | | | |
|---------------|----------|------|------|------|---------|------|-----------|-------------|
| | | | | | | (] | H8/3857 (| Group only) |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | TCC7 | TCC6 | TCC5 | TCC4 | TCC3 | TCC2 | TCC1 | TCC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |
| | | | | | | | | |
| | | | | Coun | value | | | |

TLC-Timer load register C

| H'B5 | Timer C |
|------|----------------------|
| | (H8/3857 Group only) |





Legend: * Don't care



| CSRF—Time | r control/s | status reg | ister F | | I | H'B7 | | Timer F |
|--|--|---|--|------------|---|--|-----------|---------------------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | OVFH | CMFH | OVIEH | CCLRH | OVFL | CMFL | OVIEL | CCLRL |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/W | R/W | R/(W)* | R/(W)* | R/W | R/W |
| Could be a considered by the constant of the country of the countr | Compa Compa O [CI Aft I [Se Wh Fimer ove O [Cleari After ri I [Settin When Inter clear 16-bit mode 8-bit mode 16-bit mode | TCFL ov TCFL TCFL TCFL TCFL TCFL TCFL TCFL TCFL | erflow intererflow | 0 T | by writing the OCRFL writing 0 to the occupant of the occupant of the occupant of the occupant of the occupant | OVFL bled sabled bled abled abled abled abled | pare mato | ch disabled ch enabled |
| | - | = 1, clear | ed by writi | ng 0 to OV | /FH | | | |
| 1 [Setting c When the | ondition] value of T | CFH goes | from H'F | F to H'00 | | | | |

Note: * Only a write of 0 for flag clearing is possible.

| • | 0111011/011 | - 9 | | | | | | | | |
|---|-------------|-------------|--------|--------|---------|---------|--------|---------|--|--|
| TCFH—8-bit ti | imer coun | ter FH | | | H'B8 | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | TCFH7 | TCFH6 | TCFH5 | TCFH4 | TCFH3 | TCFH2 | TCFH1 | TCFH0 | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | | |
| | | | | Count | t value | | | | | |
| TCFL—8-bit ti | mer coun | ter FL | | | Н | ['B9 | | Timer F | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | TCFL7 | TCFL6 | TCFL5 | TCFL4 | TCFL3 | TCFL2 | TCFL1 | TCFL0 | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | | |
| | | | | Count | t value | | | | | |
| OCRFH—Out | put compa | are registe | er FH | | Н | Timer F | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | OCRFH7 | OCRFH6 | OCRFH5 | OCRFH4 | OCRFH3 | OCRFH2 | OCRFH1 | OCRFH0 | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | | |
| OCRFL—Outp | out compa | re registe | er FL | | Н | I'BB | | Timer F | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | OCRFL7 | OCRFL6 | OCRFL5 | OCRFL4 | OCRFL3 | OCRFL2 | OCRFL1 | OCRFL0 | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | | |

R/W

R/W

R/W

Read/Write



R/W

R/W

R/W

R/W

R/W

AMR—A/D mode register

H'C4

A/D converter

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|------|--------------|--|----------------------|--|--|--|
| CKS | TRGE | _ | _ | СНЗ | CH2 | CH1 | CH0 |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| R/W | R/W | _ | _ | R/W | R/W | R/W | R/W |
| | 0 | CKS TRGE 0 0 | CKS TRGE — 0 0 1 | CKS TRGE — — 0 0 1 1 | CKS TRGE — — CH3 0 0 1 1 0 | CKS TRGE — — CH3 CH2 0 0 1 1 0 0 | CKS TRGE — — CH3 CH2 CH1 0 0 1 1 0 0 0 |

Channel select

| Onami | ei seiec | , L | | |
|-------|----------|-------|-------|----------------------|
| Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| СНЗ | CH2 | CH1 | CH0 | Analog input channel |
| 0 | 0 | * | * | No channel selected |
| | 1 | 0 | 0 | AN ₀ *1 |
| | | | 1 | AN ₁ *1 |
| | | 1 | 0 | AN ₂ *1 |
| | | | 1 | AN ₃ *1 |
| 1 | 0 | 0 | 0 | AN ₄ |
| | | | 1 | AN ₅ |
| | | 1 | 0 | AN ₆ |
| | | | 1 | AN ₇ |
| 1 | 1 | * | * | Reserved |

External trigger select

| 0 | Disables start of A/D conversion by external trigger |
|---|---|
| 1 | Enables start of A/D conversion by rising or falling edge |
| | of external trigger at pin ADTRG |

Clock select

| Bit 7 | | Conversion Time | | | | |
|-------|-------------------|-----------------|-----------|--|--|--|
| CKS | Conversion Period | φ = 2 MHz | φ = 5 MHz | | | |
| 0 | 62/¢ | 31 μs | 12.4 μs | | | |
| 1 | 31/φ | 15.5 μs | *2 | | | |

Legend: * Don't care

Notes:

1. AN₀ to AN₃ can be selected in the H8/3857 Group only. They must not be selected in the H8/3854 Group.

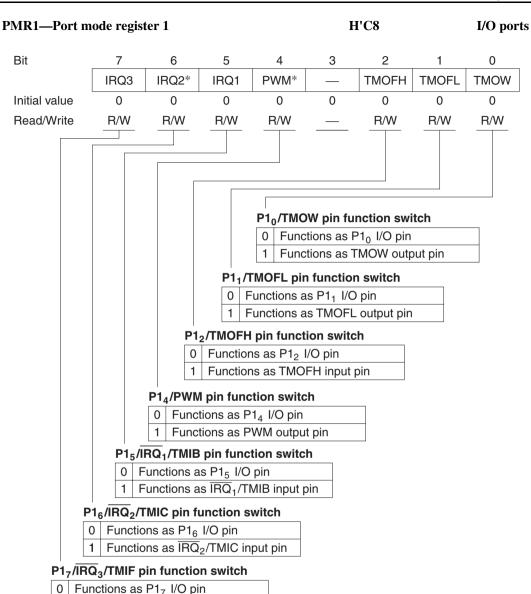
2. Operation is not guaranteed if the conversion time is less than 12.4 $\mu s.$ Set bit 7 for a value of at least 12.4 $\mu s.$

| ADRR—A/D re | esult reg | gister | | | | H'C5 | | | A/D converter | |
|-------------------------|-----------|--|-------|-----------|-----------|------------|-----------|-----------|---------------|--|
| Bit | 7 | 6 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | ADR7 | 7 AD | R6 | ADR5 | ADR4 | ADR3 | ADR2 | ADR1 | ADR0 | |
| Initial value | Undefin | ed Unde | fined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | |
| Read/Write | R | F | ? | R | R | R | R | R | R | |
| | | | | | | | | | | |
| | | | | | A/D conve | rsion resu | t | | | |
| | | | | | | | | | | |
| ADSR—A/D start register | | | | | | Н | 'C6 | A/I | O converter | |
| | | | | | | | | | | |
| Bit | 7 | - 6 | 3 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | ADSF | - | _ | _ | _ | _ | _ | _ | _ | |
| Initial value | 0 | 1 | | 1 | 1 | 1 | 1 | 1 | 1 | |
| Read/Write | R/W | _ | _ | _ | _ | _ | _ | _ | _ | |
| | | | | | | | | | | |
| | A/D | status | flag | | | | | _ | | |
| | 0 | 0 Read Indicates the completion of A/D conversion | | | | | | | | |
| | | Write | Ston | s A/D con | version | • | • | | | |
| | | Write Stops A/D conversion 1 Read Indicates A/D convers | | | | | | | | |

Starts A/D conversion

Write

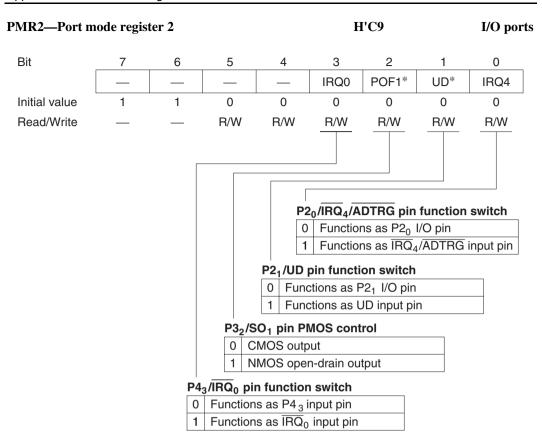




Note: * IRQ2 and PWM are functions of the H8/3857 Group only.

In the H8/3854 Group these bits are reserved, and must always be cleared to 0.

Functions as IRQ₃/TMIF input pin



Note: * POF1 and UD are functions of the H8/3857 Group only.
In the H8/3854 Group these bits are reserved, and must always be cleared to 0.

I/O ports

H'CA

| | | | | | | (] | H8/3857 (| Group only) | | |
|---------------|---|---|--|-------------------------|------------------------|--------------------------|-----------|-------------|--|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | _ | _ | _ | _ | _ | SO1 | SI1 | SCK1 | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| Read/Write | _ | _ | _ | _ | _ | R/W | R/W | R/W | | |
| | | | P3 ₀ /SCK ₁ pin function switch 0 Functions as P3 ₀ I/O pin 1 Functions as SCK ₁ I/O pin | | | | | | | |
| | | | | | | ion switch | | | | |
| | | | | | | P3 ₁ I/O pin | | | | |
| | | | | 1 Fun | ctions as S | SI ₁ input pi | n | | | |
| | | | P3 ₂ | /SO ₁ pin fu | unction sv | vitch | | | | |
| | | | 0 | Functions a | as P3 ₂ I/O | pin | | | | |
| | | | 1 Functions as SO ₁ output pin | | | | | | | |

PMR3—Port mode register 3

| PMR4—Port n | node regis | ter 4 | | | H | I/O ports | | |
|---------------|------------|-------|-------------------|---------|----------|-------------|-------|-------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | NMOD7 | NMOD6 | NMOD5 | NMOD4 | NMOD3 | NMOD2 | NMOD1 | NMOD0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| | | | 0 P2 _r | has CMC | S output | | | |
| | | | 1 P2 _r | has NMC | S open-d | rain output | : | |

| PMR5—Port m | ode regis | ter 5 | Н | | I/O ports | S | | | | |
|---------------|--|---|-----------------|----------------------|------------------|------------------|------------------|------------------|--|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | WKP ₇ | WKP ₆ | WKP_5 | WKP ₄ | WKP ₃ | WKP ₂ | WKP ₁ | WKP ₀ | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | | |
| | | | | | | | | | | |
| | | | P5 _n | /WKP _n pi | n functio | n switch | | | | |
| | 0 Functions as P5 _n I/O pin | | | | | | | | | |
| | | 1 Functions as WKP _n input pin | | | | | | | | |

| PWCR—PWM | control 1 | register | | | F | I'D0 (| | 14-bit PWM Group only |
|---------------|-----------|----------------------------|---|---|---|-------------|------------|--------------------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | _ | _ | _ | _ | _ | _ | _ | PWCR0 |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| Read/Write | _ | _ | _ | _ | _ | _ | _ | W |
| | | select — | | | | | | |
| | | ne input clo th a minim | | | | ersion peri | od is 16,0 | 384/φ, |
| | | ne input clo th a minim | | | | ersion peri | od is 32,7 | 768/ф, |

Note: *to: Period of PWM input clock

| PWDRU—PW | M data re | gister U | | | Н | 'D1 | 1 | 14-bit PWM | |
|---------------|-----------|----------|--------|--------|--------|--------|-----------|-------------|--|
| | | | | | | (1 | H8/3857 (| Group only) | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | | _ | PWDRU5 | PWDRU4 | PWDRU3 | PWDRU2 | PWDUR1 | PWDRU0 | |
| Initial value | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | _ | | W | W | W | W | W | W | |
| | | | | | | | | | |

Upper 6 bits of data for generating PWM waveform

| PWDRL—PWM data register I | PWDRL | —PWM | data | register | L |
|---------------------------|--------------|------|------|----------|---|
|---------------------------|--------------|------|------|----------|---|

H'D2

14-bit PWM (H8/3857 Group only)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | PWDRL7 | PWDRL6 | PWDRL5 | PWDRL4 | PWDRL3 | PWDRL2 | PWDRL1 | PWDRL0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |
| | | | | | | | | |

Lower 8 bits of data for generating PWM waveform

| PDR1—Port d | ata regist | er 1 | I | I/O po | rts | | | | |
|---------------|-----------------|-------------------|-----------------|-------------------|-------------------|-----------------|-----------------|-----------------|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | P1 ₇ | P1 ₆ * | P1 ₅ | P1 ₄ * | P1 ₃ * | P1 ₂ | P1 ₁ | P1 ₀ | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | • |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |

Note: * P1₆, P1₄, and P1₃ are functions of the H8/3857 Group only.
In the H8/3854 Group these bits are reserved, and must always be set to 1.

| PDR2—Port da | | Н | I/O ports | | | | | | |
|---------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | _ |
| | P2 ₇ | P2 ₆ | P2 ₅ | P2 ₄ | P2 ₃ | P2 ₂ | P2 ₁ | P2 ₀ | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | _ |
| Read/Write | R/W | |

| PDR3—Port data register 3 | H'D6 | I/O ports |
|---------------------------|------|----------------------|
| | | (H8/3857 Group only) |

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| | P3 ₇ | P3 ₆ | P3 ₅ | P3 ₄ | P3 ₃ | P3 ₂ | P3 ₁ | P3 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W |

| PDR4—Port da | ıta registe | er 4 | | | Н | 'D7 | | I/O ports | |
|---------------|--------------------------------|-----------------|-----------------|-----------------|-------------------|-------------------|-------------------|-------------------|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | _ | _ | _ | _ | P4 ₃ | P4 ₂ | P4 ₁ | P4 ₀ | |
| Initial value | 1 | 1 | 1 | 1 | Undefined | 0 | 0 | 0 | |
| Read/Write | _ | _ | _ | _ | R | R/W | R/W | R/W | |
| PDR5—Port da | PDR5—Port data register 5 H'D8 | | | | | | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | P5 ₇ | P5 ₆ | P5 ₅ | P5 ₄ | P5 ₃ | P5 ₂ | P5 ₁ | P5 ₀ | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |
| PDR9—Port da | ıta registe | er 9 | | | Н | 'DC | | I/O ports | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | P9 ₇ | P9 ₆ | P9 ₅ | P9 ₄ | P9 ₃ | P9 ₂ | P9 ₁ | P9 ₀ | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |
| PDRA—Port da | ata regist | er A | | | Н | 'DD | | I/O ports | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | _ | _ | _ | _ | PA ₃ | PA ₂ | PA ₁ | PA ₀ | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | _ | _ | _ | _ | R/W | R/W | R/W | R/W | |
| PDRB—Port da | ata registe | er B | | | Н | 'DE | | I/O ports | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | PB ₇ | PB ₆ | PB ₅ | PB ₄ | PB ₃ * | PB ₂ * | PB ₁ * | PB ₀ * | |
| Read/Write | R | R | R | R | R | R | R | R | |
| | | | | | | | | | |

Note: * PB $_3$ to PB $_0$ are functions of the H8/3857 Group only. In the H8/3854 Group these bits are reserved.

| PUCR1—Port | PUCR1—Port pull-up control register 1 | | | | | H'E0 | | | |
|---------------|---------------------------------------|---------|--------------------|---------|---------|--------------------|--------------------|--------------------|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | PUCR1 ₇ | PUCR16* | PUCR1 ₅ | PUCR14* | PUCR13* | PUCR1 ₂ | PUCR1 ₁ | PUCR1 ₀ | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |

Note: * PUCR1₆, PUCR1₄, and PUCR1₃ are functions of the H8/3857 Group only. In the H8/3854 Group these bits are reserved, and must always be cleared to 0.

| PUCR3—Port | pull-up co | ntrol regi | ister 3 | | H | 'E1 | | I/O port |
|--|-----------------------|---------------------------------------|--------------------|---------------------|---------------------|--------------------|--------------------|--------------------|
| | | | | | | (] | H8/3857 (| Group only |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PUCR3 ₇ | PUCR3 ₆ | PUCR3 ₅ | PUCR3 ₄ | PUCR3 ₃ | PUCR3 ₂ | PUCR3 ₁ | PUCR3 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | ead/Write R/W R/W R/W | | R/W | R/W | R/W | R/W | R/W | |
| PUCR5—Port pull-up control register 5 H'E2 | | | | | | | | I/O port |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PUCR5 ₇ | PUCR5 ₇ PUCR5 ₆ | | PUCR5 ₄ | PUCR5 ₃ | PUCR5 ₂ | PUCR5 ₁ | PUCR5 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| PCR1—Port c | ontrol regi | ster 1 | | | Н | 'E4 | | I/O port |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PCR1 ₇ | PCR1 ₆ * | PCR1 ₅ | PCR1 ₄ * | PCR1 ₃ * | PCR1 ₂ | PCR1 ₁ | PCR1 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |
| | | | | P | ort 1 inpu | t/output s | elect | |

| 0 | Input pin |
|---|------------|
| 1 | Output pin |

Note: * PCR1₆, PCR1₄, and PCR1₃ are functions of the H8/3857 Group only. In the H8/3854 Group these bits are reserved, and must always be cleared to 0.

| PCR2—Port co | ntrol regi | ster 2 | | | H'E5 | | | | | | |
|---------------|------------------------------|---|-------------------|-------------------|-------------------|-------------------|-------------------|--------------------------|--|--|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | PCR2 ₇ | PCR2 ₆ | PCR2 ₅ | PCR2 ₄ | PCR2 ₃ | PCR2 ₂ | PCR2 ₁ | PCR2 ₀ | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | | |
| Read/Write | W | W | W | W | W | W | W | W | | | |
| | | Port 2 input/output select O Input pin 1 Output pin | | | | | | | | | |
| PCR3—Port co | PCR3—Port control register 3 | | | | | | H8/3857 (| I/O ports Group only) | | | |
| | | | | | | ` | | 1 0/ | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | PCR3 ₇ | PCR3 ₆ | PCR3 ₅ | PCR3 ₄ | PCR3 ₃ | PCR3 ₂ | PCR3 ₁ | PCR3 ₀ | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | | |
| Read/Write | W | W | W | W | W | W | W | W | | | |
| | | | | P (| | n | select | | | | |
| PCR4—Port co | ntrol regi | ster 4 | | | Н | ['E7 | | I/O ports | | | |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | | | | _ | _ | PCR4 ₂ | PCR4 ₁ | PCR4 ₀ | | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | | | |

| Port 4 | input/output | select |
|--------|--------------|--------|
|--------|--------------|--------|

W

| (|) | Input pin |
|---|---|------------|
| 1 | | Output pin |

Read/Write



| PCR5—Port co | ontrol regi | ster 5 | | | Н | | I/O ports | |
|------------------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PCR5 ₇ | PCR5 ₆ | PCR5 ₅ | PCR5 ₄ | PCR5 ₃ | PCR5 ₂ | PCR5 ₁ | PCR5 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |
| | | | | P | ∣ ort 5 inpu | t/output s | elect | |
| | | | | (| Input p | in | | |
| | | | | - | 1 Output | pin | | |
| PCR9—Port control register 9 | | | | | H | I'EC | | I/O ports |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PCR9 ₇ | PCR9 ₆ | PCR9 ₅ | PCR9 ₄ | PCR9 ₃ | PCR9 ₂ | PCR9 ₁ | PCR9 ₀ |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |
| | | | | Р | ∣ ort 9 inpu | t/output s | elect | |
| | | | | (| | | | |
| | | | | - | 1 Output | pin | | |
| PCRA—Port co | ontrol reg | ister A | | | H | I'ED | | I/O ports |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | _ | _ | _ | _ | PCRA ₃ | PCRA ₂ | PCRA ₁ | PCRA ₀ |
| Initial value | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | _ | _ | _ | _ | W | W | W | W |
| | | | | | F | ort A inpu | ut/output | select |
| | | | | | | 0 Input p | | |
| | | | | | | 1 Output | pin | |

| SYSCR1—Syste | YSCR1—System control register 1 | | | | | | H | I'F0 | Sys | System control | |
|-----------------------------|--|----------------------------|-------|-----|------|----------|---------------------------|-------------|-------------|------------------------|--|
| Bit | 7 | 6 | 5 | | | 4 | 3 | 2 | 1 | 0 | |
| | SSBY | STS2 | STS | 31 | 5 | STS0 | LSON | _ | _ | _ | |
| Initial value | 0 | 0 | 0 | | | 0 | 0 | 1 | 1 | 1 | |
| Read/Write | R/W | R/W | R/V | ٧ | | R/W | R/W | _ | _ | _ | |
| | | | | | | | | | | | |
| | | | | | L | ow sp | eed on fla | ıg | | | |
| | 0 The CPU operates on the system clock (φ) | | | | | | | | clock (φ) | | |
| | | | | | | 1 The | e CPU ope | rates on th | ne subclo | ck (¢ _{SUB}) | |
| Standby timer select 2 to 0 | | | | | | | | | | | |
| | | | 0 | 0 | 0 | | ime = 8,19 | | | | |
| | | | | | 1 | | ime = 0, 13 ime = 16,3 | | | | |
| | | | | 1 | 0 | | ime = 10,5 ime = 32,7 | | | | |
| | | | | | 1 | | ime = 52,7 ime = 65,5 | | | | |
| | | | 1 | * | * | | ime = 03,5 | | | | |
| | | | | ** | ٠,٠ | vvait | 1116 – 101 | ,012 States | 3 | | |
| | Softw | are stand | by | | | | | | | | |
| | | Vhen a SLE nade to slee | | | ctio | n is exe | ecuted in a | active mod | e, a transi | ition is | |
| | | Vhen a SLE | | | | n is ex | ecuted in s | subactive r | node, a tra | ansition is | |
| | n | nade to sub | sleep | mod | de. | | | | | | |
| | | Vhen a SLE nade to star | | | | | | active mod | e, a transi | ition is | |
| | | Vhen a SLE nade to wat | | | ctio | n is exe | ecuted in s | subactive r | node, a tra | ansition is | |

Legend: * Don't care

SYSCR2—System control register 2 H'F1 System control Bit 7 4 3 2 6 5 0 **NESEL** DTON **MSON** SA1 SA0 Initial value 1 1 1 0 0 O 0 n Read/Write R/W R/W R/W R/W R/W Medium speed on flag Subactive mode clock select 0 Operates in active (high-speed) mode $\phi_W/8$ Operates in active (medium-speed) mode 1 $\phi_W/4$ 1 * $\phi w/2$ Direct transfer on flag When a SLEEP instruction is executed in active mode, a transition is made to standby mode, watch mode, or sleep mode. When a SLEEP instruction is executed in subactive mode, a transition is made to watch mode or subsleep mode. When a SLEEP instruction is executed in active (high-speed) mode, a direct transition is made to active (medium-speed) mode if SSBY = 0, MSON = 1, and LSON = 0, or to subactive mode if SSBY = 1, TMA3 = 1, and LSON = 1. When a SLEEP instruction is executed in active (medium-speed) mode, a direct transition is made to active (high-speed) mode if SSBY = 0, MSON = 0, and LSON = 0, or to subactive mode if SSBY = 1, TMA3 = 1, and LSON = 1. When a SLEEP instruction is executed in subactive mode, a direct

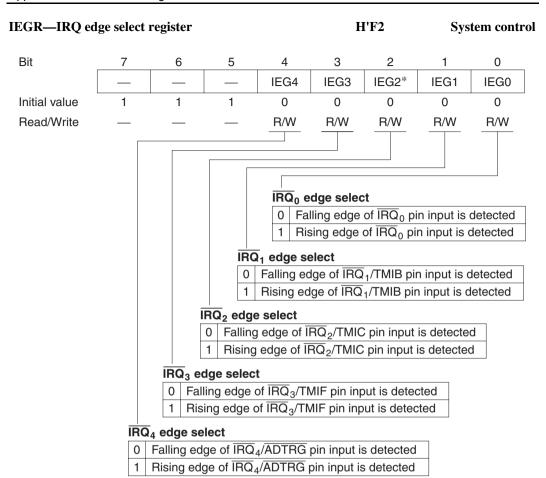
transition is made to active (high-speed) mode if SSBY = 1, TMA3 = 1, LSON = 0, and MSON = 0, or to active (medium-speed) mode if SSBY = 1, TMA3 = 1.

Noise elimination sampling frequency select

LSON = 0, and MSON = 1.

| (| О | Sampling rate is $\phi_{OSC}/16$ |
|---|---|----------------------------------|
| | 1 | Sampling rate is ϕ_{OSC} /4 |

Legend: * Don't care

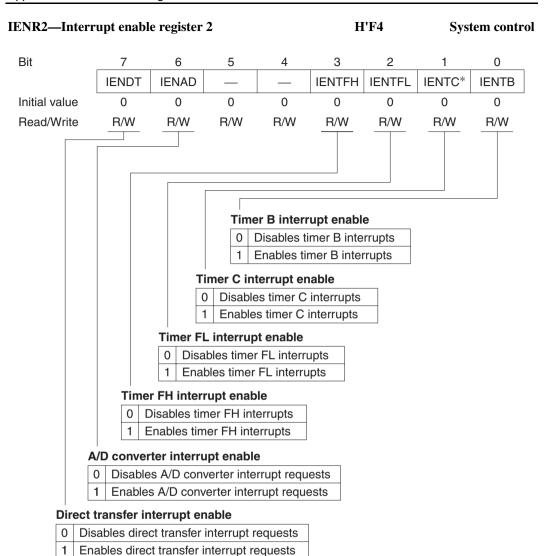


Note: * IEG2 is a function of the H8/3857 Group only.
In the H8/3854 Group this bit is reserved, and must always be cleared to 0.

| IENR1—Interrupt enable register 1 | | | | | | | H'F3 | | System control | |
|-----------------------------------|-------|-----------|--------------|-------------|-----------------------|---------------------|------------------|----------------|----------------|--|
| Bit | _ | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | | IENTA | IENS1* | IENWP | IEN4 | IEN3 | IEN2* | IEN1 | IEN0 | |
| Initial value | e | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | Э | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |
| | | | | | | | | | | |
| | | | | IR | Q ₄ to IRQ | o interrup | ot enable | | | |
| | | | | 0 | Disables | interrupt | request IR | Q _n | | |
| | | | | 1 | Enables | interrupt | request IR | Q _n | | |
| | | | | No | te: n = 4 t | to 0 | | | | |
| | | Wake | up interru | ıpt enable | • | | | | | |
| | | 0 [| Disables int | errupt req | uests from | WKP ₇ to | WKP ₀ | | | |
| | | 1 E | nables int | errupt requ | uests from | WKP ₇ to | WKP ₀ | | | |
| | SC | l1 interr | upt enable | Э | | | | | | |
| | 0 | 1 | s SCI1 int | | | | | | | |
| | 1 | Enable | s SCI1 inte | errupts | | | | | | |
| Tim | ner A | interrup | t enable | | | | | | | |
| 0 | | | er A interru | pts | | | | | | |
| 1 | | | r A interru | | | | | | | |

Note: * IENS1 and IEN2 are functions of the H8/3857 Group only.

In the H8/3854 Group these bits are reserved, and must always be cleared to 0.



Note: * IENTC is a function of the H8/3857 Group only.
In the H8/3854 Group this bit is reserved, and must always be cleared to 0.

| IRR1—Interrup | t request | register | 1 |
|---------------|-----------|----------|---|
|---------------|-----------|----------|---|

H'F6

System control

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|---------|---|-------|-------|---------|-------|-------|
| | IRRTA | IRRS1*1 | _ | IRRI4 | IRRI3 | IRRI2*1 | IRRI1 | IRRI0 |
| Initial value | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W*2 | R/W*2 | _ | R/W*2 | R/W*2 | R/W*2 | R/W*2 | R/W*2 |

IRQ₄ to IRQ₀ interrupt request flag

- 0 [Clearing conditions]
 - When IRRI4 = 1, it is cleared by writing 0 When 0 is written to IRRI4 when IRRI4 = 1

The same also applies to IRRI3—IRRI0

1 | [Setting conditions]

When pin $\overline{\text{IRQ}}_4$ is set to interrupt input and the designated signal edge is detected

When pin $\overline{\text{IRQ}}_4$ is set to interrupt input and the designated edge is input at this pin The same also applies to IRRI3—IRRI0

SCI1 interrupt request flag

| | 0 | [Clearing condition] |
|---|---|--|
| | | When IRRS1 = 1, it is cleared by writing 0 |
| ĺ | 1 | [Setting condition] |
| | | When an SCI1 transfer is completed |

Timer A interrupt request flag

| 0 | [Clearing condition] When IRRTA = 1, it is cleared by writing 0 |
|---|---|
| 1 | [Setting condition] |
| | When the timer A counter overflows from H'FF to H'00 |

Notes: 1. IRRS1 and IRRI2 are functions of the H8/3857 Group only.
In the H8/3854 Group these bits are reserved, and are always 0.

2. Only a write of 0 for flag clearing is possible.

| IRR2—Inter | rupt reque | st register | · 2 |] | H'F7 System | | | |
|---|---|-------------------------|--|--|---|--|---|-----------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IRRDT | IRRAD | _ | _ | IRRTFH | IRRTFL | IRRTC*1 | IRRTB |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W*2 | R/W*2 | _ | _ | R/W*2 | R/W*2 | R/W*2 | R/W*2 |
| | Timer C 0 [Cle 1 [Settir I [Settir I [Settir I [Settir I [Settir I [Settir I [Settir | ing condition condition | request flag When If When c 8-bit mo matches | When IRI When the H'FF to H flag hen IRRTo hen the tir underflow ag n IRRTFL n counter bit mode RRTFH = ounter FH ode, or whe s 16-bit ou | C = 1, it is ner C cour rs from H'0 = 1, it is cle FL matche 1, it is clea matches cen 16-bit c rtput compa | cleared by one of the country of the | vriting 0 ows from H vriting 0 ompare registrophy | gister FL |
| A/D c | OCRFH) in 16-bit mode A/D converter interrupt request flag | | | | | | | |
| 0 [Clearing condition] When IRRAD = 1, it is cleared by writing 0 | | | | | | | | |
| | Setting cond | | | conversion | is comple | ted and Al | DSF is res | et |
| | ansfer inter | | | 1 it is als | arad by ye | iting 0 | | |
| | aring condition | n] A SLE | | ction is ex | ecuted wh | | = 1 and a | direct |

Notes: 1. IRRTC is a function of the H8/3857 Group only.
In the H8/3854 Group this bit is reserved, and is always 0.

2. Only a write of 0 for flag clearing is possible.

| IWPR—Wakeup interrupt request register | | | | | | 'F9 | System control | | |
|--|-------|-------|-------|-------|-------|-------|----------------|-------|--|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | IWPF7 | IWPF6 | IWPF5 | IWPF4 | IWPF3 | IWPF2 | IWPF1 | IWPF0 | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Read/Write | R/W* | R/W* | |
| | | | | | | | | | |
| | | | | | | | | | |

Wakeup interrupt request flag

| 0 | [Clearing condition] |
|---|--|
| | When IWPFn = 1, it is cleared by writing 0 |
| 1 | [Setting condition] |
| | When pin $\overline{\text{WKP}}_n$ is set to interrupt input and a falling signal edge is detected |

Note: n = 7 to 0

Note: * Only a write of 0 for flag clearing is possible.

Appendix C I/O Port Block Diagrams

C.1 Block Diagram of Port 1

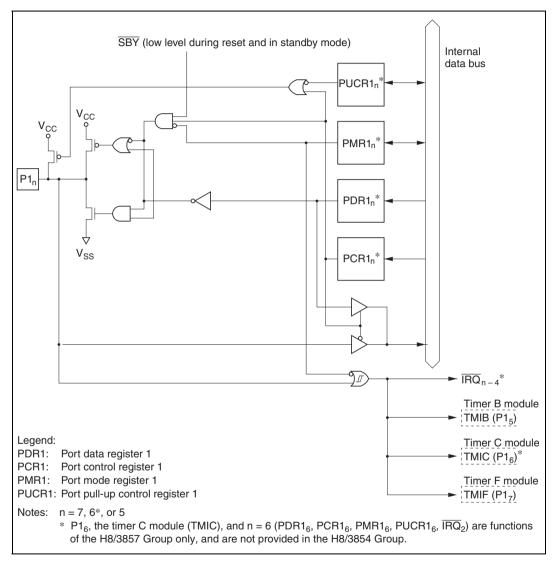


Figure C.1 (a) Port 1 Block Diagram (Pins P1, to P1;: H8/3857 Group, Pins P1,, P1;: H8/3854 Group)

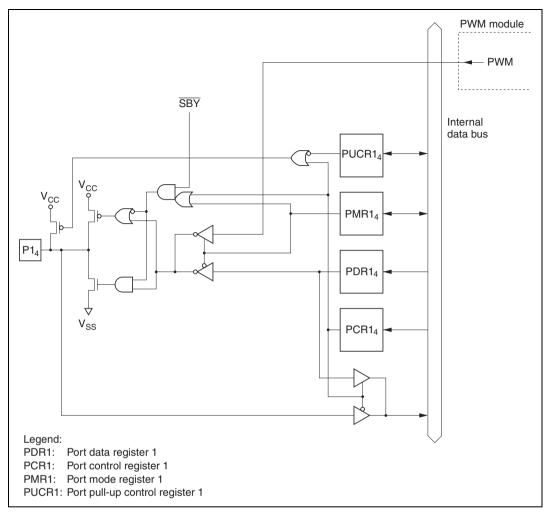


Figure C.1 (b) Port 1 Block Diagram (Pin P1₄: Function of H8/3857 Group Only)

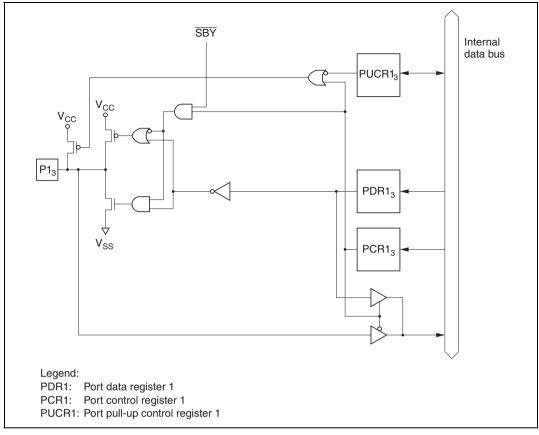
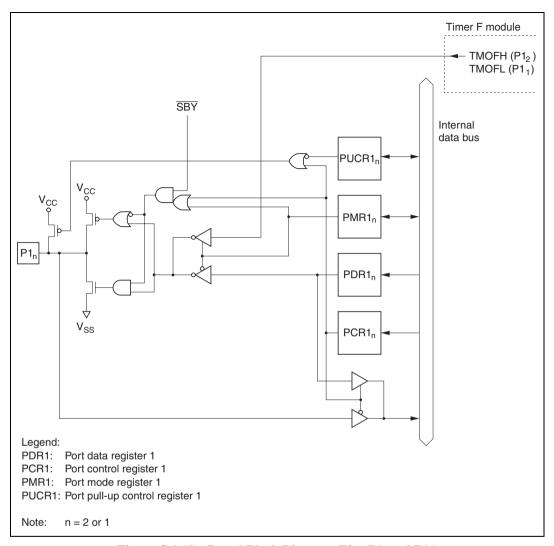


Figure C.1 (c) Port 1 Block Diagram (Pin P1₃: Function of H8/3857 Group Only)



 $Figure~C.1~(d)~~Port~1~Block~Diagram~(Pins~P1_{_2}~and~P1_{_1})\\$

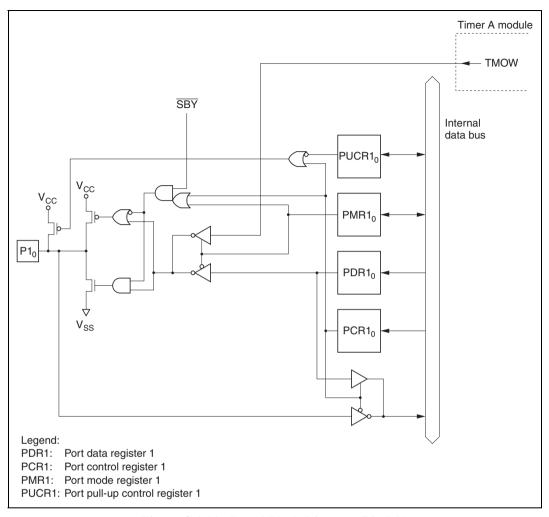


Figure C.1 (e) Port 1 Block Diagram (Pin P1₀)

C.2 Block Diagram of Port 2

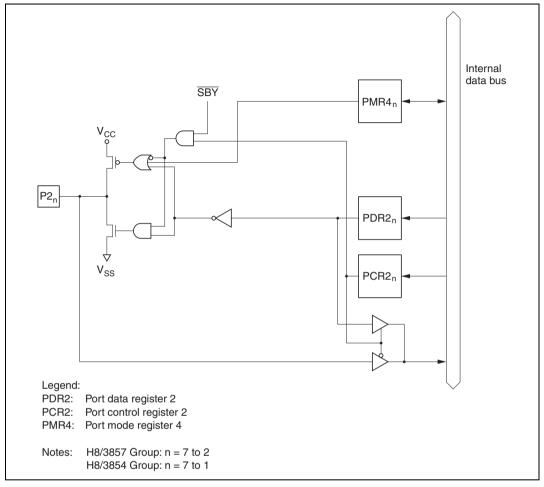


Figure C.2 (a) Port 2 Block Diagram (Pins P2, to P2,: H8/3857 Group; Pins P2, to P2,: H8/3854 Group)

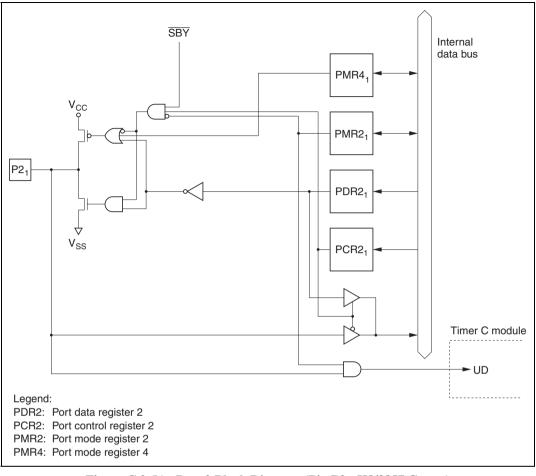
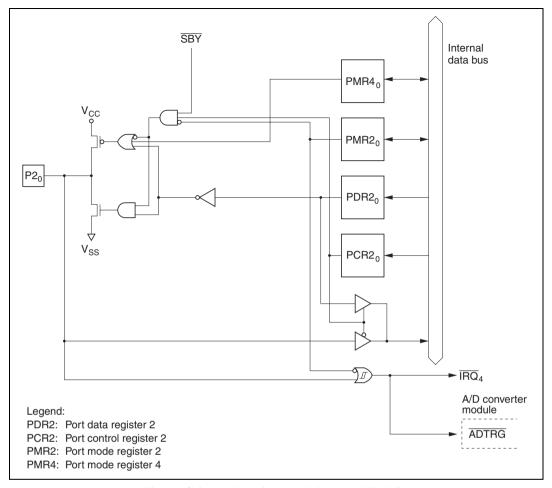


Figure C.2 (b) Port 2 Block Diagram (Pin P2₁: H8/3857 Group)





 $Figure~C.2~(c)~~Port~2~Block~Diagram~(Pin~P2_{_0})\\$

C.3 Block Diagram of Port 3 (H8/3857 Group Only)

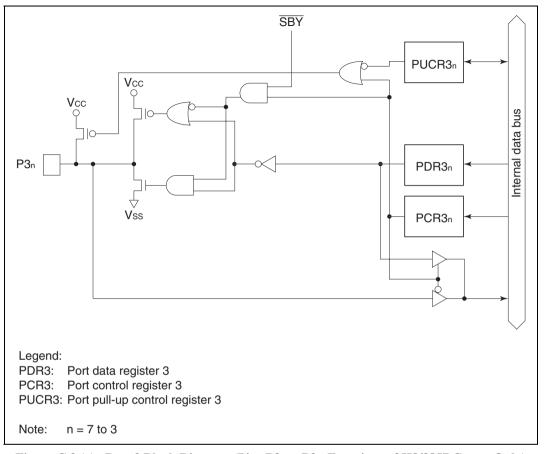


Figure C.3 (a) Port 3 Block Diagram (Pins P3, to P3; Functions of H8/3857 Group Only)

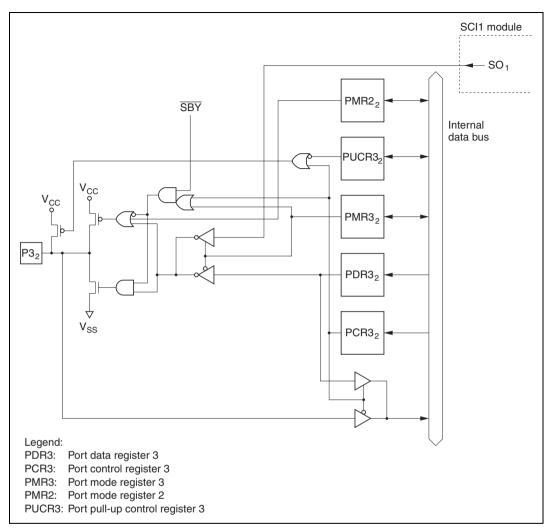


Figure C.3 (b) Port 3 Block Diagram (Pin P3₂: Function of H8/3857 Group Only)

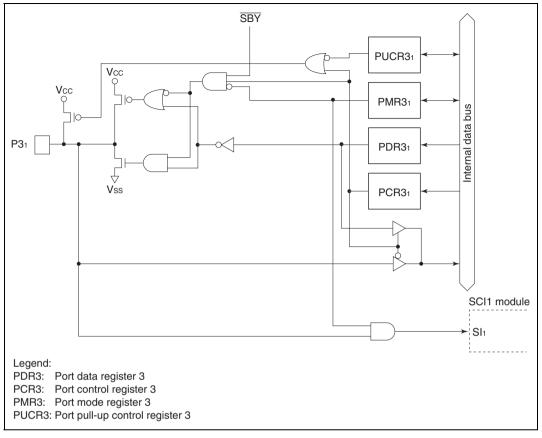


Figure C.3 (c) Port 3 Block Diagram (Pin P3₁: Function of H8/3857 Group Only)

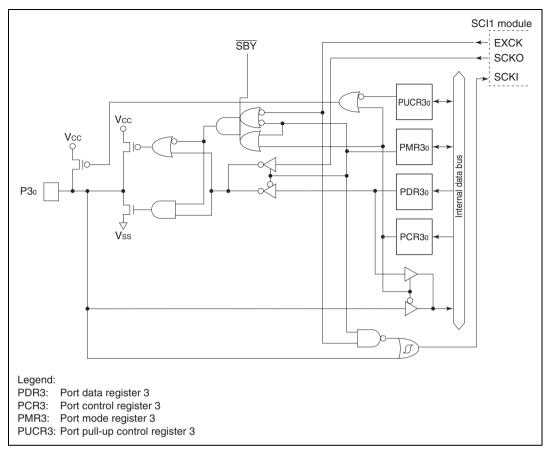


Figure C.3 (d) Port 3 Block Diagram (Pin P3₀: Function of H8/3857 Group Only)

C.4 Block Diagram of Port 4

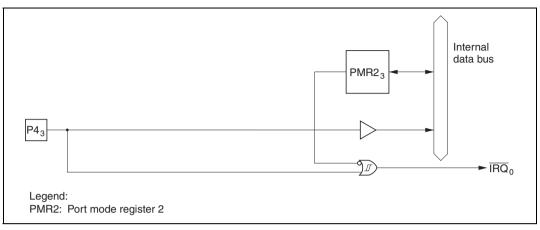


Figure C.4 (a) Port 4 Block Diagram (Pin P4₃)

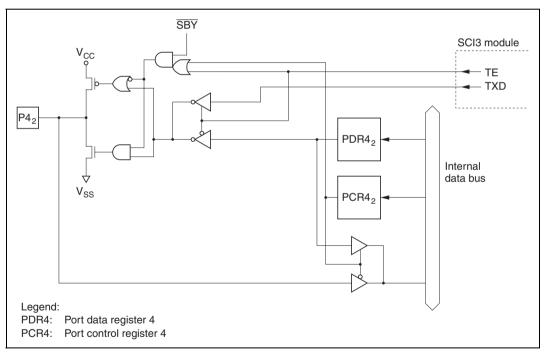


Figure C.4 (b) Port 4 Block Diagram (Pin P4₂)

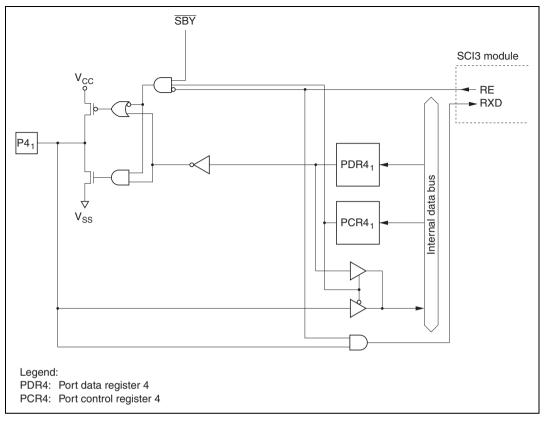


Figure C.4 (c) Port 4 Block Diagram (Pin $P4_1$)

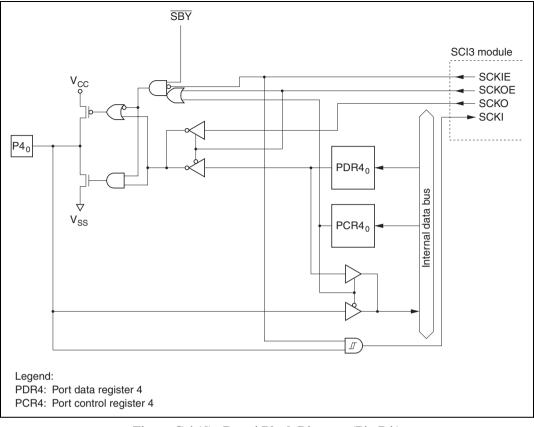


Figure C.4 (d) Port 4 Block Diagram (Pin P4₀)

C.5 Block Diagram of Port 5

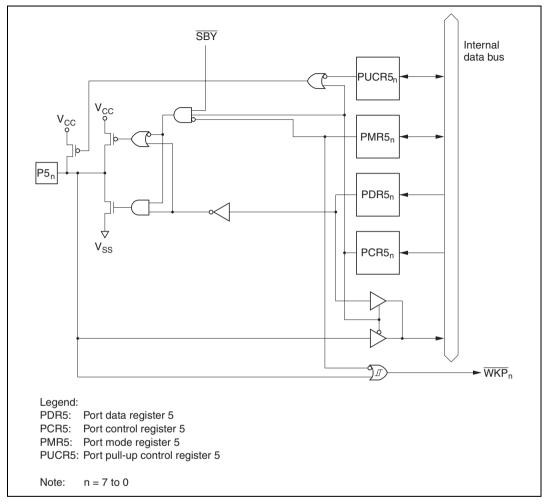


Figure C.5 Port 5 Block Diagram

C.6 Block Diagram of Port 9

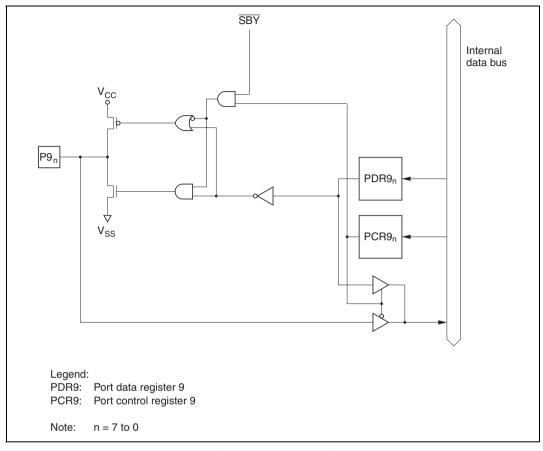


Figure C.6 Port 9 Block Diagram

C.7 Block Diagram of Port A

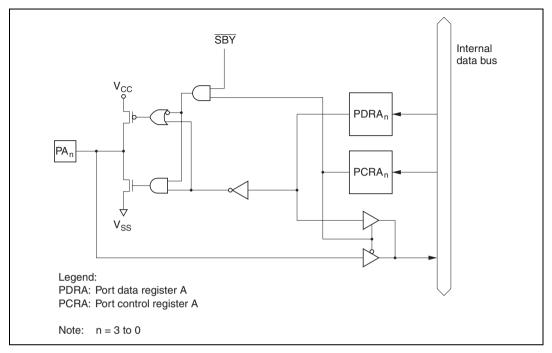


Figure C.7 Port A Block Diagram

C.8 Block Diagram of Port B

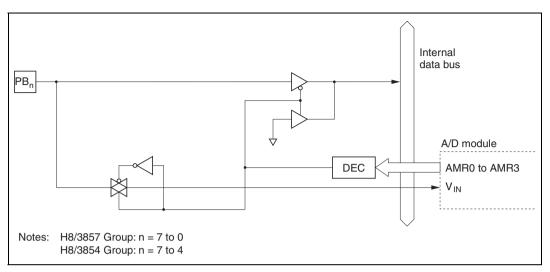


Figure C.8 Port B Block Diagram (Pins PB, to PB,: H8/3857 Group, Pins PB, to PB,: H8/3854 Group)

Appendix D Port States in the Different Processing States

Table D.1 Port States Overview

| Port | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|---|-------------------|----------------|----------------|-------------------|----------------|----------------|----------------|
| P1, to P1,*1 | High impedance | Retained | Retained | High impedance*2 | Retained | Functions | Functions |
| P2, to P2 ₀ | High impedance | Retained | Retained | High impedance | Retained | Functions | Functions |
| P3, to P3,*1 | High impedance | Retained | Retained | High impedance*2 | Retained | Functions | Functions |
| P4 ₃ to P4 ₀ | High impedance | Retained | Retained | High impedance | Retained | Functions | Functions |
| P5, to P5 ₀ | High impedance | Retained | Retained | High impedance*2 | Retained | Functions | Functions |
| P9, to P9 ₀ | High impedance | Retained | Retained | High impedance | Retained | Functions | Functions |
| PA ₃ to PA ₀ | High impedance | Retained | Retained | High impedance | Retained | Functions | Functions |
| PB ₇ to PB ₀ * ¹ | - | High impedance | High impedance | High impedance | High impedance | High impedance | High impedance |

Notes: 1. P1₆, P1₄, P1₃, P3₇ to P3₀, and PB₃ to PB₀ are functions of the H8/3857 Group only, and are not provided in the H8/3854 Group.

^{2.} High level output when MOS pull-up is in on state.

Appendix E List of Product Codes

Table E.1 H8/3857 Group Product Code Lineup

| Product Type | | | Part No. | Mask Code | Package |
|--------------|----------------------|--------------------|-------------------------|------------------|------------------------|
| H8/3857F | F-ZTAT versions | Standard models | HD64F3857FQ | HD64F3857FQ | 144-pin QFP (FP-144H) |
| | | | HD64F3857TG HD64F3857TG | | 144-pin TQFP (TFP-144) |
| | | | HCD64F3857 | _ | Die |
| H8/3857 | Mask ROM versions | Standard models | HD6433857FQ | HD6433857(***)FQ | 144-pin QFP (FP-144H) |
| | | | HD6433857TG | HD6433857(***)TG | 144-pin TQFP (TFP-144) |
| | | | HCD6433857 | _ | Die |
| H8/3856 | Mask ROM versions | Standard models | HD6433856FQ | HD6433856(***)FQ | 144-pin QFP (FP-144H) |
| | | | HD6433856TG | HD6433856(***)TG | 144-pin TQFP (TFP-144) |
| | | | HCD6433856 | _ | Die |
| H8/3855 | Mask ROM versions | Standard models | HD6433855FQ | HD6433855(***)FQ | 144-pin QFP (FP-144H) |
| | | | HD6433855TG | HD6433855(***)TG | 144-pin TQFP (TFP-144) |
| | | | HCD6433855 | _ | Die |

Table E.2 H8/3854 Group Product Code Lineup

| Product Type | | | Mask Code | Package | |
|-----------------------|---|--|--|--|--|
| F-ZTAT versions | Standard models | HD64F3854H | HD64F3854H | 100-pin QFP (FP-100B) | |
| | | HD64F3854W | HD64F3854W | 100-pin TQFP (TFP-100G) | |
| | | HCD64F3854 | _ | Die | |
| Mask ROM versions* | Standard models | HD6433854H | HD6433854(***)H | 100-pin QFP (FP-100B) | |
| | | HD6433854W | HD6433854(***)W | 100-pin TQFP (TFP-100G) | |
| | | HCD6433854 | _ | Die | |
| Mask ROM versions* | Standard models | HD6433853H | HD6433853(***)H | 100-pin QFP (FP-100B) | |
| | | HD6433853W | HD6433853(***)W | 100-pin TQFP (TFP-100G) | |
| | | HCD6433853 | _ | Die | |
| Mask ROM versions* | Standard models | HD6433852H | HD6433852(***)H | 100-pin QFP (FP-100B) | |
| | | HD6433852W | HD6433852(***)W | 100-pin TQFP (TFP-100G) | |
| | | HCD6433852 | _ | Die | |
| | F-ZTAT versions Mask ROM versions* Mask ROM versions* | F-ZTAT Standard models Mask ROM Standard models Mask ROM Standard models Mask ROM Standard models Mask ROM Standard models | F-ZTAT versions and standard versions and standard versions* | F-ZTAT versions Models MD64F3854H HD64F3854H HD64F3854W HD64F3854W HCD64F3854W HCD64F3854W HCD64F3854W HD64F3854W HCD64F3854W HCD64F3854W HCD64F3854W HD64F3854W HCD64F3854W HD64F3855W HD64F3855W HD64F3855W HCD64F3855W HD64F3855W HD64FFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFF | |

Notes: For mask ROM versions, (***) is the ROM code.

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^{*} Under development

Appendix F Package Dimensions

The package dimention that is shown in the Renesas Semiconductor Package Data Book has priority.

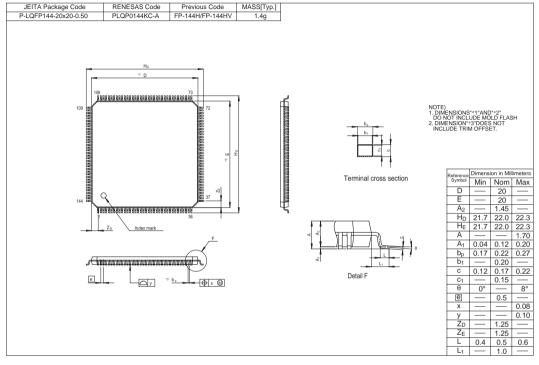


Figure F.1 FP-144H Package Dimensions

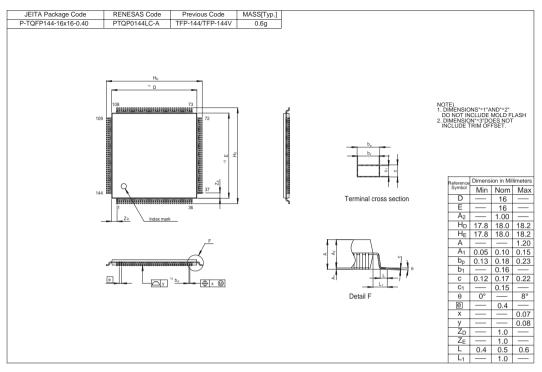


Figure F.2 TFP-144 Package Dimensions

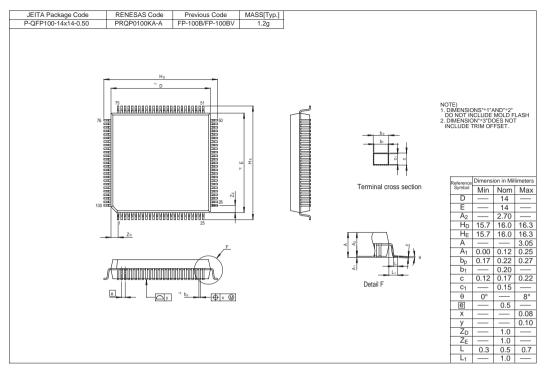


Figure F.3 FP-100B Package Dimensions

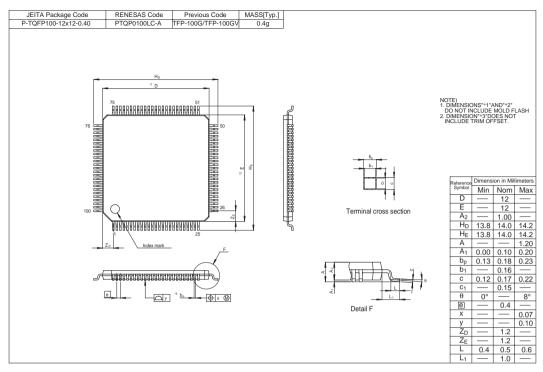


Figure F.4 TFP-100G Package Dimensions

Renesas 8-Bit Single-Chip Microcomputer Hardware Manual H8/3857 Group, H8/3857 F-ZTAT™, H8/3854 Group, H8/3854 F-ZTAT™

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